

PIC18F87J90 Family Data Sheet

64/80-Pin, High-Performance Microcontrollers with LCD Driver and nanoWatt Technology

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the
 intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not
 mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION. QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights.

Trademarks

The Microchip name and logo, the Microchip logo, Accuron, dsPIC, KEELOQ, KEELOQ logo, MPLAB, PIC, PICmicro, PICSTART, rfPIC, SmartShunt and UNI/O are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

FilterLab, Linear Active Thermistor, MXDEV, MXLAB, SEEVAL, SmartSensor and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Analog-for-the-Digital Age, Application Maestro, CodeGuard, dsPICDEM, dsPICDEM.net, dsPICworks, dsSPEAK, ECAN, ECONOMONITOR, FanSense, In-Circuit Serial Programming, ICSP, ICEPIC, Mindi, MiWi, MPASM, MPLAB Certified logo, MPLIB, MPLINK, mTouch, PICkit, PICDEM, PICDEM.net, PICtail, PIC³² logo, PowerCal, PowerInfo, PowerMate, PowerTool, REAL ICE, rfLAB, Select Mode, Total Endurance, WiperLock and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries

 $\ensuremath{\mathsf{SQTP}}$ is a service mark of Microchip Technology Incorporated in the U.S.A.

All other trademarks mentioned herein are property of their respective companies.

© 2009, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

Printed on recycled paper.

QUALITY MANAGEMENT SYSTEM

CERTIFIED BY DNV

ISO/TS 16949:2002

Microchip received ISO/TS-16949:2002 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELoQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.



64/80-Pin, High-Performance Microcontrollers with LCD Driver and nanoWatt Technology

LCD Driver and Keypad Interface Features:

- Direct LCD Panel Drive Capability:
 - Can drive LCD panel while in Sleep mode
- Up to 48 Segments and 192 Pixels, Software Selectable
- Programmable LCD Timing module:
 - Multiple LCD timing sources available
 - Up to four commons: static, 1/2, 1/3 or 1/4 multiplex
 - Static, 1/2 or 1/3 bias configuration
- On-Chip LCD Boost Voltage Regulator for Contrast Control
- Charge Time Measurement Unit (CTMU) for Capacitive Touch Sensing
- · ADC for Resistive Touch Sensing

Low-Power Features:

- Power-Managed modes:
 - Run: CPU On, Peripherals On
 - Idle: CPU Off, Peripherals On
 - Sleep: CPU Off, Peripherals Off
- Two-Speed Oscillator Start-up

Flexible Oscillator Structure:

- Two Crystal modes, 4-25 MHz
- · Two External Clock modes, up to 48 MHz
- 4x Phase Lock Loop (PLL)
- · Internal Oscillator Block with PLL:
 - Eight user-selectable frequencies from 31.25 kHz to 8 MHz
- Secondary Oscillator using Timer1 at 32 kHz
- Fail-Safe Clock Monitor:
 - Allows for safe shutdown if peripheral clock fails

Peripheral Highlights:

- High-Current Sink/Source 25 mA/25 mA (PORTB and PORTC)
- Up to Four External Interrupts
- Four 8-Bit/16-Bit Timer/Counter modules
- Two Capture/Compare/PWM (CCP) modules
- Master Synchronous Serial Port (MSSP) module with Two Modes of Operation:
 - 3-Wire/4-Wire SPI (supports all four SPI modes)
 - I²C™ Master and Slave mode
- One Addressable USART module
- One Enhanced Addressable USART module:
 - LIN/J2602 support
 - Auto-wake-up on Start bit and Break character
 - Auto-Baud Detect (ABD)
- 10-Bit, up to 12-Channel A/D Converter:
 - Auto-acquisition
 - Conversion available during Sleep
- Two Analog Comparators
- Programmable Reference Voltage for Comparators
- Hardware Real-Time Clock and Calendar (RTCC) with Clock, Calendar and Alarm Functions
- Charge Time Measurement Unit (CTMU):
 - Capacitance measurement
 - Time measurement with 1 ns typical resolution

Special Microcontroller Features:

- 10,000 Erase/Write Cycle Flash Program Memory, Typical
- Flash Retention 20 Years, Minimum
- Self-Programmable under Software Control
- Word Write Capability for Flash Program Memory for Data EEPROM Emulators

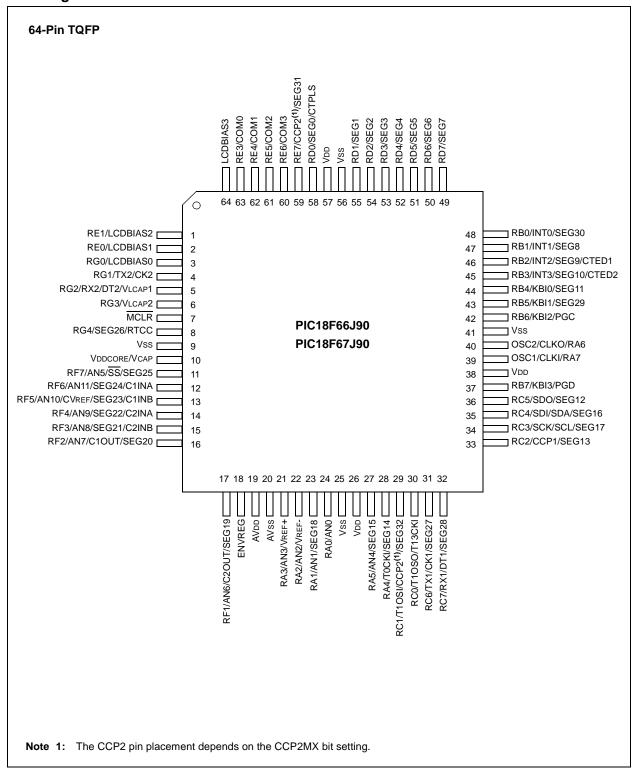
	Flash	SRAM		<u>~</u> ±		Bit		MSSP		A/D lels)	ators	JVD		
Device	Program Memory (Bytes)	Data Memory (Bytes)	1/0	LCD (Pixels)	Timers 8/16-B	ССР	SPI	Master I ² C™	EUSAR	10-Bit A (Channe	Compara	BOR/LV	RTCC	СТМО
PIC18F66J90	64K	3,923	51	132	1/3	2	Yes	Yes	1/1	12	2	Yes	Yes	Yes
PIC18F67J90	128K	3,923	51	132	1/3	2	Yes	Yes	1/1	12	2	Yes	Yes	Yes
PIC18F86J90	64K	3,923	67	192	1/3	2	Yes	Yes	1/1	12	2	Yes	Yes	Yes
PIC18F87J90	128K	3,923	67	192	1/3	2	Yes	Yes	1/1	12	2	Yes	Yes	Yes

Special Microcontroller Features (Continued):

- Priority Levels for Interrupts
- 8 x 8 Single-Cycle Hardware Multiplier
- Extended Watchdog Timer (WDT):
 - Programmable period from 4 ms to 131s

- In-Circuit Serial Programming[™] (ICSP[™]) via Two Pins
- In-Circuit Debug via Two Pins
- Operating Voltage Range: 2.0V to 3.6V
- 5.5V Tolerant Input (digital pins only)
- Selectable Open-Drain Configuration for Serial Communication and CCP Pins for Driving Outputs up to 5V
- On-Chip 2.5V Regulator

Pin Diagrams - PIC18F6XJ90



Pin Diagrams - PIC18F8XJ90

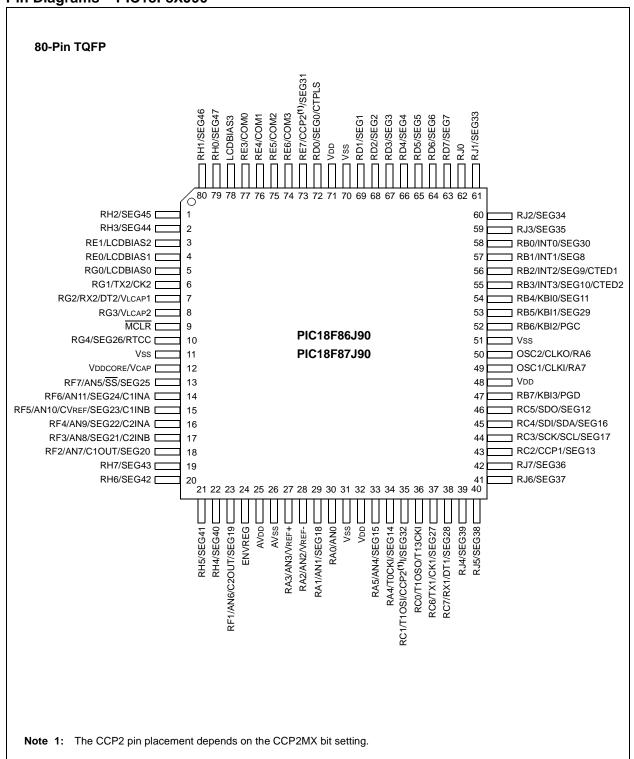


Table of Contents

1.0	Device Overview	7
2.0	Oscillator Configurations	29
3.0	Power-Managed Modes	39
4.0	Reset	47
5.0	Memory Organization	59
6.0	Flash Program Memory	83
7.0	8 x 8 Hardware Multiplier	93
8.0	Interrupts	95
9.0	I/O Ports	111
10.0	Timer0 Module	133
11.0	Timer1 Module	137
12.0	Timer2 Module	143
13.0	Timer3 Module	145
14.0	Real-Time Clock and Calendar (RTCC)	149
15.0	Capture/Compare/PWM (CCP) Modules	167
16.0	Liquid Crystal Display (LCD) Driver Module	177
17.0	Master Synchronous Serial Port (MSSP) Module	205
18.0		
19.0	Addressable Universal Synchronous Asynchronous Receiver Transmitter (AUSART)	269
20.0	10-bit Analog-to-Digital Converter (A/D) Module	283
21.0	Comparator Module	293
22.0	Comparator Voltage Reference Module	299
23.0	Charge Time Measurement Unit (CTMU)	
24.0	Special Features of the CPU	319
25.0	Instruction Set Summary	333
26.0	Development Support	383
27.0		
28.0	Packaging Information	421
	endix A: Revision History	
Appe	endix B: Migration From PIC18F85J90 to PIC18F87J90	427
The I	Microchip Web Site	439
Custo	tomer Change Notification Service	439
Custo	omer Support	439
Read	der Response	440
Prod	luct Identification System	441

TO OUR VALUED CUSTOMERS

It is our intention to provide our valued customers with the best documentation possible to ensure successful use of your Microchip products. To this end, we will continue to improve our publications to better suit your needs. Our publications will be refined and enhanced as new volumes and updates are introduced.

If you have any questions or comments regarding this publication, please contact the Marketing Communications Department via E-mail at **docerrors@microchip.com** or fax the **Reader Response Form** in the back of this data sheet to (480) 792-4150. We welcome your feedback.

Most Current Data Sheet

To obtain the most up-to-date version of this data sheet, please register at our Worldwide Web site at:

http://www.microchip.com

You can determine the version of a data sheet by examining its literature number found on the bottom outside corner of any page. The last character of the literature number is the version number, (e.g., DS30000A is version A of document DS30000).

Errata

An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

To determine if an errata sheet exists for a particular device, please check with one of the following:

- Microchip's Worldwide Web site; http://www.microchip.com
- · Your local Microchip sales office (see last page)

When contacting a sales office, please specify which device, revision of silicon and data sheet (include literature number) you are using.

Customer Notification System

Register on our web site at www.microchip.com to receive the most current information on all of our products.

1.0 DEVICE OVERVIEW

This document contains device-specific information for the following devices:

- PIC18F66J90
- PIC18F86J90
- PIC18F67J90
- PIC18F87J90

This family combines the traditional advantages of all PIC18 microcontrollers – namely, high computational performance and a rich feature set – with a versatile on-chip LCD driver, while maintaining an extremely competitive price point. These features make the PIC18F87J90 family a logical choice for many high-performance applications where price is a primary consideration.

1.1 Core Features

1.1.1 nanoWatt TECHNOLOGY

All of the devices in the PIC18F87J90 family incorporate a range of features that can significantly reduce power consumption during operation. Key items include:

- Alternate Run Modes: By clocking the controller from the Timer1 source or the internal RC oscillator, power consumption during code execution can be reduced by as much as 90%.
- Multiple Idle Modes: The controller can also run
 with its CPU core disabled but the peripherals still
 active. In these states, power consumption can be
 reduced even further, to as little as 4% of normal
 operation requirements.
- On-the-Fly Mode Switching: The power-managed modes are invoked by user code during operation, allowing the user to incorporate power-saving ideas into their application's software design.

1.1.2 OSCILLATOR OPTIONS AND FEATURES

All of the devices in the PIC18F87J90 family offer six different oscillator options, allowing users a range of choices in developing application hardware. These include:

- Two Crystal modes, using crystals or ceramic resonators.
- Two External Clock modes, offering the option of a divide-by-4 clock output.
- A Phase Lock Loop (PLL) frequency multiplier, available to the External Oscillator modes which allows clock speeds of up to 40 MHz. PLL can also be used with the internal oscillator.
- An internal oscillator block which provides an 8 MHz clock (±2% accuracy) and an INTRC source (approximately 31 kHz, stable over temperature and VDD), as well as a range of six user-selectable clock frequencies, between 125 kHz to 4 MHz, for a total of eight clock frequencies. This option frees the two oscillator pins for use as additional general purpose I/O.

The internal oscillator block provides a stable reference source that gives the family additional features for robust operation:

- Fail-Safe Clock Monitor: This option constantly
 monitors the main clock source against a reference
 signal provided by the internal oscillator. If a clock
 failure occurs, the controller is switched to the
 internal oscillator, allowing for continued low-speed
 operation or a safe application shutdown.
- Two-Speed Start-up: This option allows the internal oscillator to serve as the clock source from Power-on Reset, or wake-up from Sleep mode, until the primary clock source is available.

1.1.3 MEMORY OPTIONS

The PIC18F87J90 family provides ample room for application code, from 64 Kbytes to 128 Kbytes of code space. The Flash cells for program memory are rated to last up to 10,000 erase/write cycles. Data retention without refresh is conservatively estimated to be greater than 20 years.

The Flash program memory is readable and writable. During normal operation, the PIC18F87J90 family also provides plenty of room for dynamic application data with up to 3,923 bytes of data RAM.

1.1.4 EXTENDED INSTRUCTION SET

The PIC18F87J90 family implements the optional extension to the PIC18 instruction set, adding 8 new instructions and an Indexed Addressing mode. Enabled as a device configuration option, the extension has been specifically designed to optimize re-entrant application code originally developed in high-level languages, such as 'C'.

1.1.5 EASY MIGRATION

Regardless of the memory size, all devices share the same rich set of peripherals, allowing for a smooth migration path as applications grow and evolve.

The consistent pinout scheme used throughout the entire family also aids in migrating to the next larger device. This is true when moving between the 64-pin members, between the 80-pin members, or even jumping from 64-pin to 80-pin devices.

The PIC18F87J90 family is also largely pin compatible with other PIC18 families, such as the PIC18F8720 and PIC18F8722, the PIC18F85J11, and the PIC18F8490 and PIC18F85J90 families of microcontrollers with LCD drivers. This allows a new dimension to the evolution of applications, allowing developers to select different price points within Microchip's PIC18 portfolio, while maintaining a similar feature set.

1.2 LCD Driver

The on-chip LCD driver includes many features that make the integration of displays in low-power applications easier. These include an integrated voltage regulator with charge pump that allows contrast control in software and display operation above device VDD.

1.3 Other Special Features

- Communications: The PIC18F87J90 family incorporates a range of serial communication peripherals, including an Addressable USART, a separate Enhanced USART that supports LIN specification 1.2, and one Master SSP module capable of both SPI and I²C™ (Master and Slave) modes of operation.
- CCP Modules: All devices in the family incorporate two Capture/Compare/PWM (CCP) modules. Up to four different time bases may be used to perform several different operations at once.
- 10-Bit A/D Converter: This module incorporates programmable acquisition time, allowing for a channel to be selected and a conversion to be initiated without waiting for a sampling period and thus, reducing code overhead.
- Charge Time Measurement Unit (CTMU): The CTMU is a flexible analog module that provides accurate differential time measurement between pulse sources, as well as asynchronous pulse generation.

Together with other on-chip analog modules, the CTMU can precisely measure time, measure capacitance or relative changes in capacitance, or generate output pulses that are independent of the system clock.

- Extended Watchdog Timer (WDT): This
 enhanced version incorporates a 16-bit prescaler,
 allowing an extended time-out range that is stable
 across operating voltage and temperature. See
 Section 27.0 "Electrical Characteristics" for
 time-out periods.
- Real Time Clock and Calendar Module (RTCC):
 The RTCC module is intended for applications requiring that accurate time be maintained for extended periods of time with minimum to no intervention from the CPU.

The module is a 100-year clock and calendar with automatic leap-year detection. The range of the clock is from 00:00:00 (midnight) on January 1, 2000 to 23:59:59 on December 31, 2099.

1.4 Details on Individual Family Members

Devices in the PIC18F87J90 family are available in 64-pin and 80-pin packages. Block diagrams for the two groups are shown in Figure 1-1 and Figure 1-2.

The devices are differentiated from each other in four ways:

- Flash program memory (two sizes, 64 Kbytes for PIC18FX6J90 devices and 128 Kbytes for PIC18FX7J90 devices).
- 2. Data RAM (3,923 bytes RAM for both PIC18FX6J90 and PIC18FX7J90 devices).
- I/O ports (7 bidirectional ports on PIC18F6XJ90 devices, 9 bidirectional ports on PIC18F8XJ90 devices).
- LCD Pixels: 132 pixels (33 SEGs x 4 COMs) can be driven by 64-pin devices; 192 pixels (48 SEGs x 4 COMs) can be driven by 80-pin devices.

All other features for devices in this family are identical. These are summarized in Table 1-1 and Table 1-2.

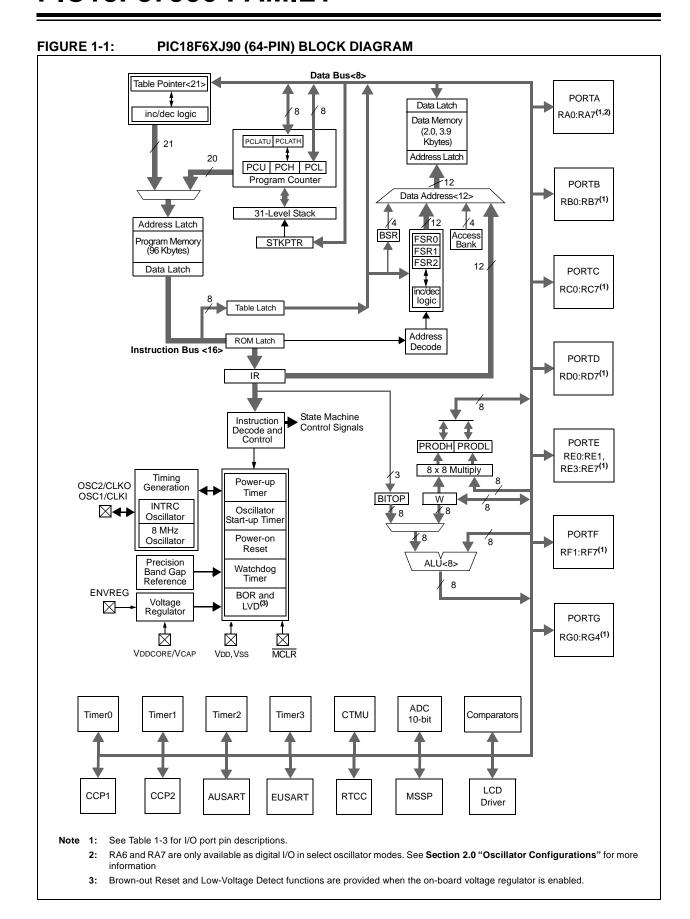
The pinouts for all devices are listed in Table 1-3 and Table 1-4.

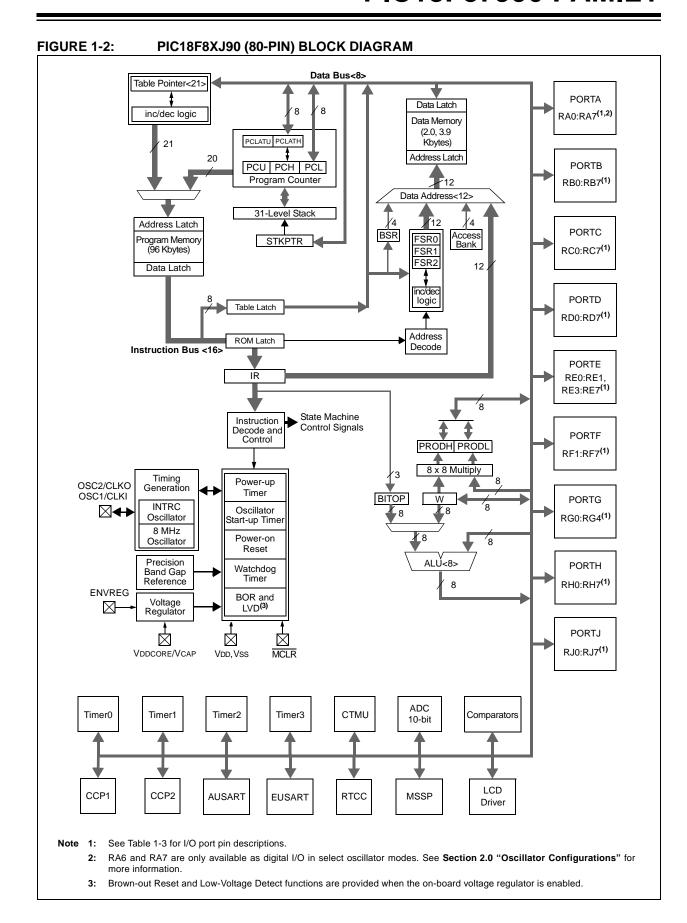
TABLE 1-1: DEVICE FEATURES FOR THE PIC18F6XJ90 (64-PIN DEVICES)

Features	PIC18F66J90	PIC18F67J90			
Operating Frequency	DC – 48 MHz				
Program Memory (Bytes)	64K	128K			
Program Memory (Instructions)	32,768	65,536			
Data Memory (Bytes)	3,923	3,923			
Interrupt Sources	2	9			
I/O Ports	Ports A, B, 0	C, D, E, F, G			
LCD Driver (available pixels to drive)	132 (33 SEGs x 4 COMs)				
Timers	4				
Comparators	2				
СТМИ	Yes				
RTCC	Yes				
Capture/Compare/PWM Modules	2				
Serial Communications	MSSP, Addressable USART, Enhanced USART				
10-Bit Analog-to-Digital Module	12 Input (Channels			
Resets (and Delays)	POR, BOR, RESET Instruction, Stack Full, Stack Underflow, MCLR, WDT (PWRT, OST)				
Instruction Set	75 Instructions, 83 with Extended Instruction Set enabled				
Packages	64-Pin TQFP				

TABLE 1-2: DEVICE FEATURES FOR THE PIC18F8XJ90 (80-PIN DEVICES)

Features	PIC18F86J90	PIC18F87J90				
Operating Frequency	DC – 48 MHz					
Program Memory (Bytes)	64K	128K				
Program Memory (Instructions)	32,768	65,536				
Data Memory (Bytes)	3,923	3,923				
Interrupt Sources	29	9				
I/O Ports	Ports A, B, C, I	D, E, F, G, H, J				
LCD Driver (available pixels to drive)	192 (48 SEGs x 4 COMs)					
Timers	4					
Comparators	2					
СТМИ	Yes					
RTCC	Yes					
Capture/Compare/PWM Modules	2					
Serial Communications	MSSP, Addressable USART, Enhanced USART					
10-Bit Analog-to-Digital Module	12 Input (12 Input Channels				
Resets (and Delays)	POR, BOR, RESET Instruction, Stack Full, Stack Underflow, MCLR, WDT (PWRT, OST)					
Instruction Set	75 Instructions, 83 with Extended Instruction Set enabled					
Packages	80-Pin TQFP					





Preliminary

TABLE 1-3: PIC18F6XJ90 PINOUT I/O DESCRIPTIONS

Din Name	Pin Number	Pin	Buffer	Description
Pin Name	TQFP	Туре	Туре	Description
MCLR	7	I	ST	Master Clear (input) or programming voltage (input). This pin is an active-low Reset to the device.
OSC1/CLKI/RA7 OSC1 CLKI	39	1	CMOS CMOS	Oscillator crystal or external clock input. Oscillator crystal input. External clock source input. Always associated with pin function OSC1. (See related OSC1/CLKI, OSC2/CLKO pins.)
RA7		I/O	TTL	General purpose I/O pin.
OSC2/CLKO/RA6 OSC2	40	0	_	Oscillator crystal or clock output. Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode.
CLKO		0	_	In EC modes, OSC2 pin outputs CLKO, which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate.
RA6		I/O	TTL	General purpose I/O pin.
				PORTA is a bidirectional I/O port.
RA0/AN0 RA0 AN0	24	I/O I	TTL Analog	Digital I/O. Analog input 0.
RA1/AN1/SEG18 RA1 AN1 SEG18	23	I/O I O	TTL Analog Analog	Digital I/O. Analog input 1. SEG18 output for LCD.
RA2/AN2/VREF- RA2 AN2 VREF-	22	I/O I I	TTL Analog Analog	Digital I/O. Analog input 2. A/D reference voltage (low) input.
RA3/AN3/VREF+ RA3 AN3 VREF+	21	I/O I I	TTL Analog Analog	Digital I/O. Analog input 3. A/D reference voltage (high) input.
RA4/T0CKI/SEG14 RA4 T0CKI SEG14	28	I/O I O	ST ST Analog	Digital I/O. Timer0 external clock input. SEG14 output for LCD.
RA5/AN4/SEG15 RA5 AN4 SEG15	27	I/O I O	TTL Analog Analog	Digital I/O. Analog input 4. SEG15 output for LCD.
RA6				See the OSC2/CLKO/RA6 pin.
RA7				See the OSC1/CLKI/RA7 pin.

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels
I = Input

Analog = Analog input O = Output

P = Power

OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

TABLE 1-3: PIC18F6XJ90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Din Nama	Pin Number	Pin	Buffer	Description		
Pin Name	TQFP	Type Type		Description		
				PORTB is a bidirectional I/O port. PORTB can be software programmed for internal weak pull-ups on all inputs.		
RB0/INT0/SEG30 RB0 INT0 SEG30	48	I/O I O	TTL ST Analog	Digital I/O. External interrupt 0. SEG30 output for LCD.		
RB1/INT1/SEG8 RB1 INT1 SEG8	47	I/O I O	TTL ST Analog	Digital I/O. External interrupt 1. SEG8 output for LCD.		
RB2/INT2/SEG9/CTED1 RB2 INT2 CTED1 SEG9	46	I/O I I O	TTL ST ST Analog	Digital I/O. External interrupt 2. CTMU Edge 1 input. SEG9 output for LCD.		
RB3/INT3/SEG10/CTED2 RB3 INT3 SEG10 CTED2	45	I/O I O I	TTL ST Analog ST	Digital I/O. External interrupt 3. SEG10 output for LCD. CTMU Edge 2 input.		
RB4/KBI0/SEG11 RB4 KBI0 SEG11	44	I/O I O	TTL TTL Analog	Digital I/O. Interrupt-on-change pin. SEG11 output for LCD.		
RB5/KBI1/SEG29 RB5 KBI1 SEG29	43	I/O I O	TTL TTL Analog	Digital I/O. Interrupt-on-change pin. SEG29 output for LCD.		
RB6/KBI2/PGC RB6 KBI2 PGC	42	I/O I I/O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. In-Circuit Debugger and ICSP™ programming clock pin.		
RB7/KBI3/PGD RB7 KBI3 PGD	37	I/O I I/O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. In-Circuit Debugger and ICSP programming data pin.		

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

Analog = Analog input

I = Input P = Power O = Output
OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

TABLE 1-3: PIC18F6XJ90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Din Nama	Pin Number	er Pin Buffer	Decembrish			
Pin Name	TQFP	Туре	Туре	Description		
				PORTC is a bidirectional I/O port.		
RC0/T1OSO/T13CKI RC0 T1OSO T13CKI	30	I/O O I	ST — ST	Digital I/O. Timer1 oscillator output. Timer1/Timer3 external clock input.		
RC1/T1OSI/CCP2/SEG32 RC1 T1OSI CCP2 ⁽¹⁾ SEG32	29	I/O I I/O O	ST CMOS ST Analog	Digital I/O. Timer1 oscillator input. Capture2 input/Compare2 output/PWM2 output. SEG32 output for LCD.		
RC2/CCP1/SEG13 RC2 CCP1 SEG13	33	I/O I/O O	ST ST Analog	Digital I/O. Capture 1 input/Compare 1 output/PWM1 output. SEG13 output for LCD.		
RC3/SCK/SCL/SEG17 RC3 SCK SCL SEG17	34	I/O I/O I/O O	ST ST ST Analog	Digital I/O. Synchronous serial clock input/output for SPI mode. Synchronous serial clock input/output for I ² C™ mode. SEG17 output for LCD.		
RC4/SDI/SDA/SEG16 RC4 SDI SDA SEG16	35	I/O I I/O O	ST ST ST Analog	Digital I/O. SPI data in. I ² C data I/O. SEG16 output for LCD.		
RC5/SDO/SEG12 RC5 SDO SEG12	36	I/O O O	ST — Analog	Digital I/O. SPI data out. SEG12 output for LCD.		
RC6/TX1/CK1/SEG27 RC6 TX1 CK1 SEG27	31	I/O O I/O O	ST — ST Analog	Digital I/O. EUSART asynchronous transmit. EUSART synchronous clock (see related RX1/DT1). SEG27 output for LCD.		
RC7/RX1/DT1/SEG28 RC7 RX1 DT1 SEG28	32	I/O I I/O O	ST ST ST Analog	Digital I/O. EUSART asynchronous receive. EUSART synchronous data (see related TX1/CK1). SEG28 output for LCD.		

 Legend:
 TTL
 = TTL compatible input
 CMOS
 = CMOS compatible input or output

 ST
 = Schmitt Trigger input with CMOS levels
 Analog
 = Analog input

 I
 = Input
 O
 = Output

P = Power OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

TABLE 1-3: PIC18F6XJ90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description		
Pin Name	TQFP	Туре	Туре	Description		
				PORTD is a bidirectional I/O port.		
RD0/SEG0/CTPLS RD0 SEG0 CTPLS	58	I/O O O	ST Analog —	Digital I/O. SEG0 output for LCD. CTMU pulse generator output.		
RD1/SEG1 RD1 SEG1	55	I/O O	ST Analog	Digital I/O. SEG1 output for LCD.		
RD2/SEG2 RD2 SEG2	54	I/O O	ST Analog	Digital I/O. SEG2 output for LCD.		
RD3/SEG3 RD3 SEG3	53	I/O O	ST Analog	Digital I/O. SEG3 output for LCD.		
RD4/SEG4 RD4 SEG4	52	I/O O	ST Analog	Digital I/O. SEG4 output for LCD.		
RD5/SEG5 RD5 SEG5	51	I/O O	ST Analog	Digital I/O. SEG5 output for LCD.		
RD6/SEG6 RD6 SEG6	50	I/O O	ST Analog	Digital I/O. SEG6 output for LCD.		
RD7/SEG7 RD7 SEG7	49	I/O O	ST Analog	Digital I/O. SEG7 output for LCD.		

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

Analog = Analog input

I = Input

O = Output

P = Power OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

TABLE 1-3: PIC18F6XJ90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description	
Pin Name	TQFP	Туре	Туре	Description	
				PORTE is a bidirectional I/O port.	
RE0/LCDBIAS1 RE0 LCDBIAS1	2	I/O I	ST Analog	Digital I/O. BIAS1 input for LCD.	
RE1/LCDBIAS2 RE1 LCDBIAS2	1	I/O I	ST Analog	Digital I/O. BIAS2 input for LCD.	
LCDBIAS3	64	ı	Analog	BIAS3 input for LCD.	
RE3/COM0 RE3 COM0	63	I/O O	ST Analog	Digital I/O. COM0 output for LCD.	
RE4/COM1 RE4 COM1	62	I/O O	ST Analog	Digital I/O. COM1 output for LCD.	
RE5/COM2 RE5 COM2	61	I/O O	ST Analog	Digital I/O. COM2 output for LCD.	
RE6/COM3 RE6 COM3	60	I/O O	ST Analog	Digital I/O. COM3 output for LCD.	
RE7/CCP2/SEG31 RE7 CCP2 ⁽²⁾ SEG31	59	I/O I/O O	ST ST Analog	Digital I/O. Capture 2 input/Compare 2 output/PWM2 output. SEG31 output for LCD.	

Legend: TTL = TTL compatible input

= Schmitt Trigger input with CMOS levels

= Input

= Power

CMOS = CMOS compatible input or output

Analog = Analog input

0 = Output

OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

TABLE 1-3: PIC18F6XJ90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Din Nama	Pin Number	Pin	Buffer	Description	
Pin Name	TQFP	Туре	Туре	Description	
RF1/AN6/C2OUT/SEG19 RF1 AN6 C2OUT SEG19	17	I/O I O	ST Analog — Analog	PORTF is a bidirectional I/O port. Digital I/O. Analog input 6. Comparator 2 output. SEG19 output for LCD.	
RF2/AN7/C1OUT/SEG20 RF2 AN7 C1OUT SEG20	16	I/O I O O	ST Analog — Analog	Digital I/O. Analog input 7. Comparator 1 output. SEG20 output for LCD.	
RF3/AN8/SEG21/C2INB RF3 AN8 SEG21 C2INB	15	I/O I O I	ST Analog Analog Analog	Digital I/O. Analog input 8. SEG21 output for LCD. Comparator 2 input B.	
RF4/AN9/SEG22/C2INA RF4 AN9 SEG22 C2INA	14	I/O I O I	ST Analog Analog Analog	Digital I/O. Analog input 9. SEG22 output for LCD Comparator 2 input A.	
RF5/AN10/CVREF/ SEG23/C1INB RF5 AN10 CVREF SEG23 C1INB	13	I/O I O O I	ST Analog Analog Analog Analog	Digital I/O. Analog input 10. Comparator reference voltage output. SEG23 output for LCD. Comparator 1 input B.	
RF6/AN11/SEG24/C1INA RF6 AN11 SEG24 C1INA	12	I/O I O I	ST Analog Analog Analog	Digital I/O. Analog input 11. SEG24 output for LCD Comparator 1 input A.	
RF7/AN5/SS/SEG25 RF7 AN5 SS SEG25	11	I/O O I O	ST Analog TTL Analog	Digital I/O. Analog input 5. SPI slave select input. SEG25 output for LCD.	

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

= Schmitt Trigger input with CMOS levels Analog = Analog input = Input

О = Output

= Power

OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

TABLE 1-3: PIC18F6XJ90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description		
FIII Name	TQFP	Type	Туре	Description		
				PORTG is a bidirectional I/O port.		
RG0/LCDBIAS0 RG0 LCDBIAS0	3	I/O I	ST Analog	Digital I/O. BIAS0 input for LCD.		
RG1/TX2/CK2 RG1 TX2 CK2	4	I/O O I/O	ST — ST	Digital I/O. AUSART asynchronous transmit. AUSART synchronous clock (see related RX2/DT2).		
RG2/RX2/DT2/VLCAP1 RG2 RX2 DT2 VLCAP1	5	I/O /O 	ST ST ST Analog	Digital I/O. AUSART asynchronous receive. AUSART synchronous data (see related TX2/CK2). LCD charge pump capacitor input.		
RG3/VLCAP2 RG3 VLCAP2	6	I/O I	ST Analog	Digital I/O. LCD charge pump capacitor input.		
RG4/SEG26/RTCC RG4 SEG26 RTCC	8	I/O O O	ST Analog —	Digital I/O. SEG26 output for LCD. RTCC output		
Vss	9, 25, 41, 56	Р	_	Ground reference for logic and I/O pins.		
VDD	26, 38, 57	Р	_	Positive supply for logic and I/O pins.		
AVss	20	Р	_	Ground reference for analog modules.		
AVDD	19	Р	_	Positive supply for analog modules.		
ENVREG	18	I	ST	Enable for on-chip voltage regulator.		
VDDCORE/VCAP VDDCORE	10	Р	_	Core logic power or external filter capacitor connection. Positive supply for microcontroller core logic (regulator disabled).		
VCAP		Р		External filter capacitor connection (regulator enabled).		

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

Analog = Analog input

= Input

O = Output

P = Power

OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

TABLE 1-4: PIC18F8XJ90 PINOUT I/O DESCRIPTIONS

Pin Name	Pin Number	Pin	Buffer	Description
Pin Name	TQFP	Туре	Туре	Description
MCLR	9	I	ST	Master Clear (input) or programming voltage (input). This pin is an active-low Reset to the device.
OSC1/CLKI/RA7 OSC1 CLKI	49		CMOS CMOS	Oscillator crystal or external clock input. Oscillator crystal input. External clock source input. Always associated with pin function OSC1. (See related OSC1/CLKI, OSC2/CLKO pins.)
RA7	50	I/O	TTL	General purpose I/O pin.
OSC2/CLKO/RA6 OSC2	50	0	_	Oscillator crystal or clock output. Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode.
CLKO		0	_	In EC modes, OSC2 pin outputs CLKO, which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate.
RA6		I/O	TTL	General purpose I/O pin.
				PORTA is a bidirectional I/O port.
RAO/ANO RAO ANO	30	I/O I	TTL Analog	Digital I/O. Analog input 0.
RA1/AN1/SEG18 RA1 AN1 SEG18	29	I/O I O	TTL Analog Analog	Digital I/O. Analog input 1. SEG18 output for LCD.
RA2/AN2/VREF- RA2 AN2 VREF-	28	I/O I I	TTL Analog Analog	Digital I/O. Analog input 2. A/D reference voltage (low) input.
RA3/AN3/VREF+ RA3 AN3 VREF+	27	I/O I I	TTL Analog Analog	Digital I/O. Analog input 3. A/D reference voltage (high) input.
RA4/T0CKI/SEG14 RA4 T0CKI SEG14	34	I/O I O	ST ST Analog	Digital I/O. Timer0 external clock input. SEG14 output for LCD.
RA5/AN4/SEG15 RA5 AN4 SEG15	33	I/O I O	TTL Analog Analog	Digital I/O. Analog input 4. SEG15 output for LCD.
RA6				See the OSC2/CLKO/RA6 pin.
RA7				See the OSC1/CLKI/RA7 pin.

Legend: TTL = TTL compatible input CMOS

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels
I = Input

Analog = Analog input
O = Output

P = Power

OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

PIC18F8XJ90 PINOUT I/O DESCRIPTIONS (CONTINUED) **TABLE 1-4:**

Din Name	Pin Number	Pin	Buffer	Deparintion
Pin Name	TQFP	Туре	Туре	Description
				PORTB is a bidirectional I/O port. PORTB can be software programmed for internal weak pull-ups on all inputs.
RB0/INT0/SEG30 RB0 INT0 SEG30	58	I/O I O	TTL ST Analog	Digital I/O. External interrupt 0. SEG30 output for LCD.
RB1/INT1/SEG8 RB1 INT1 SEG8	57	I/O I O	TTL ST Analog	Digital I/O. External interrupt 1. SEG8 output for LCD.
RB2/INT2/SEG9/CTED1 RB2 INT2 SEG9 CTED1	56	I/O I O I	TTL ST Analog ST	Digital I/O. External interrupt 2. SEG9 output for LCD. CTMU Edge 1 input.
RB3/INT3/SEG10/ CTED2 RB3 INT3 SEG10 CTED2	55	I/O O 	TTL ST Analog ST	Digital I/O. External interrupt 3. SEG10 output for LCD. CTMU Edge 2 input.
RB4/KBI0/SEG11 RB4 KBI0 SEG11	54	I/O I O	TTL TTL Analog	Digital I/O. Interrupt-on-change pin. SEG11 output for LCD.
RB5/KBI1/SEG29 RB5 KBI1 SEG29	53	I/O I O	TTL TTL Analog	Digital I/O. Interrupt-on-change pin. SEG29 output for LCD.
RB6/KBI2/PGC RB6 KBI2 PGC	52	I/O I I/O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. In-Circuit Debugger and ICSP™ programming clock pin.
RB7/KBI3/PGD RB7 KBI3 PGD	47	I/O I I/O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. In-Circuit Debugger and ICSP programming data pin.

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

= Schmitt Trigger input with CMOS levels

Analog = Analog input

= Input

0 = Output

= Power

OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

TABLE 1-4: PIC18F8XJ90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Deparintion
Pin Name	TQFP	Туре	Туре	Description
				PORTC is a bidirectional I/O port.
RC0/T1OSO/T13CKI RC0 T1OSO T13CKI	36	I/O O I	ST — ST	Digital I/O. Timer1 oscillator output. Timer1/Timer3 external clock input.
RC1/T1OSI/CCP2/SEG32 RC1 T1OSI CCP2 ⁽¹⁾ SEG32	35	I/O I I/O O	ST CMOS ST Analog	Digital I/O. Timer1 oscillator input. Capture 2 input/Compare 2 output/PWM2 output. SEG32 output for LCD.
RC2/CCP1/SEG13 RC2 CCP1 SEG13	43	I/O I/O O	ST ST Analog	Digital I/O. Capture 1 input/Compare 1 output/PWM1 output. SEG13 output for LCD.
RC3/SCK/SCL/SEG17 RC3 SCK SCL SEG17	44	I/O I/O I/O O	ST ST ST Analog	Digital I/O. Synchronous serial clock input/output for SPI mode. Synchronous serial clock input/output for I ² C™ mode. SEG17 output for LCD.
RC4/SDI/SDA/SEG16 RC4 SDI SDA SEG16	45	I/O I I/O O	ST ST ST Analog	Digital I/O. SPI data in. I ² C data I/O. SEG16 output for LCD.
RC5/SDO/SEG12 RC5 SDO SEG12	46	I/O O O	ST — Analog	Digital I/O. SPI data out. SEG12 output for LCD.
RC6/TX1/CK1/SEG27 RC6 TX1 CK1 SEG27	37	I/O O I/O O	ST — ST Analog	Digital I/O. EUSART asynchronous transmit. EUSART synchronous clock (see related RX1/DT1). SEG27 output for LCD.
RC7/RX1/DT1/SEG28 RC7 RX1 DT1 SEG28	38	I/O I I/O O	ST ST ST Analog	Digital I/O. EUSART asynchronous receive. EUSART synchronous data (see related TX1/CK1). SEG28 output for LCD.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels Analog = Analog input
I = Input O = Output

P = Power OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

TABLE 1-4: PIC18F8XJ90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Din Name	Pin Number	Pin	Buffer	Description
Pin Name	TQFP	Туре	Туре	Description
				PORTD is a bidirectional I/O port.
RD0/SEG0/CTPLS RD0 SEG0 CTPLS	72	I/O O O	ST Analog ST	Digital I/O. SEG0 output for LCD. CTMU pulse generator output.
RD1/SEG1 RD1 SEG1	69	I/O O	ST Analog	Digital I/O. SEG1 output for LCD.
RD2/SEG2 RD2 SEG2	68	I/O O	ST Analog	Digital I/O. SEG2 output for LCD.
RD3/SEG3 RD3 SEG3	67	I/O O	ST Analog	Digital I/O. SEG3 output for LCD.
RD4/SEG4 RD4 SEG4	66	I/O O	ST Analog	Digital I/O. SEG4 output for LCD.
RD5/SEG5 RD5 SEG5	65	I/O O	ST Analog	Digital I/O. SEG5 output for LCD.
RD6/SEG6 RD6 SEG6	64	I/O O	ST Analog	Digital I/O. SEG6 output for LCD.
RD7/SEG7 RD7 SEG7	63	I/O O	ST Analog	Digital I/O. SEG7 output for LCD.

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output = Schmitt Trigger input with CMOS levels Analog = Analog input

= Input = Output

= Power OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

TABLE 1-4: PIC18F8XJ90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description
Fill Name	TQFP	Type	Туре	Description
				PORTE is a bidirectional I/O port.
RE0/LCDBIAS1 RE0 LCDBIAS1	4	I/O I	ST Analog	Digital I/O. BIAS1 input for LCD.
RE1/LCDBIAS2 RE1 LCDBIAS2	3	I/O I	ST Analog	Digital I/O. BIAS2 input for LCD.
LCDBIAS3	78	ı	Analog	BIAS3 input for LCD.
RE3/COM0 RE3 COM0	77	I/O O	ST Analog	Digital I/O. COM0 output for LCD.
RE4/COM1 RE4 COM1	76	I/O O	ST Analog	Digital I/O. COM1 output for LCD.
RE5/COM2 RE5 COM2	75	I/O O	ST Analog	Digital I/O. COM2 output for LCD.
RE6/COM3 RE6 COM3	74	I/O O	ST Analog	Digital I/O. COM3 output for LCD.
RE7/CCP2/SEG31 RE7 CCP2 ⁽²⁾ SEG31	73	I/O I/O O	ST ST Analog	Digital I/O. Capture 2 input/Compare 2 output/PWM2 output. SEG31 output for LCD.

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels Analog = Analog input I = Input O = Output

P = Power OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

PIC18F8XJ90 PINOUT I/O DESCRIPTIONS (CONTINUED) **TABLE 1-4:**

Din Name	Pin Number	Pin	Buffer	Description
Pin Name	TQFP	Туре	Туре	Description
				PORTF is a bidirectional I/O port.
RF1/AN6/C2OUT/SEG19 RF1 AN6 C2OUT SEG19	23	I/O I O O	ST Analog — Analog	Digital I/O. Analog input 6. Comparator 2 output. SEG19 output for LCD.
RF2/AN7/C1OUT/SEG20 RF2 AN7 C1OUT SEG20	18	I/O I O O	ST Analog — Analog	Digital I/O. Analog input 7. Comparator 1 output. SEG20 output for LCD.
RF3/AN8/SEG21/C2INB RF3 AN8 SEG21 C2INB	17	I/O I O I	ST Analog Analog Analog	Digital I/O. Analog input 8. SEG21 output for LCD. Comparator 2 input B.
RF4/AN9/SEG22/C2INA RF4 AN9 SEG22 C2INA	16	I/O I O I	ST Analog Analog Analog	Digital I/O. Analog input 9. SEG22 output for LCD. Comparator 2 input A.
RF5/AN10/CVREF/ SEG23/C1INB RF5 AN10 CVREF SEG23 C1INB	15	I/O I O O I	ST Analog Analog Analog Analog	Digital I/O. Analog input 10. Comparator reference voltage output. SEG23 output for LCD. Comparator 1 input B.
RF6/AN11/SEG24/C1INA RF6 AN11 SEG24 C1INA	14	I/O I O I	ST Analog Analog Analog	Digital I/O. Analog input 11. SEG24 output for LCD. Comparator 1 input A.
RF7/AN5/SS/SEG25 RF7 AN5 SS SEG25	13	I/O O I O	ST Analog TTL Analog	Digital I/O. Analog input 5. SPI slave select input. SEG25 output for LCD.

Legend: TTL = TTL compatible input

= Schmitt Trigger input with CMOS levels

Analog = Analog input = Input 0 = Output

= Power OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for CCP2 when the CCP2MX Configuration bit is cleared.

CMOS = CMOS compatible input or output

TABLE 1-4: PIC18F8XJ90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description
Pili Name	TQFP	Type	Туре	Description
				PORTG is a bidirectional I/O port.
RG0/LCDBIAS0 RG0 LCDBIAS0	5	I/O I	ST Analog	Digital I/O. BIAS0 input for LCD.
RG1/TX2/CK2 RG1 TX2 CK2	6	I/O O I/O	ST — ST	Digital I/O. AUSART asynchronous transmit. AUSART synchronous clock (see related RX2/DT2).
RG2/RX2/DT2/VLCAP1 RG2 RX2 DT2 VLCAP1	7	I/O I I/O I	ST ST ST Analog	Digital I/O. AUSART asynchronous receive. AUSART synchronous data (see related TX2/CK2). LCD charge pump capacitor input.
RG3/VLCAP2 RG3 VLCAP2	8	I/O I	ST Analog	Digital I/O. LCD charge pump capacitor input.
RG4/SEG26/RTCC RG4 SEG26 RTCC	10	I/O O O	ST Analog —	Digital I/O. SEG26 output for LCD. RTCC output.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels Analog = Analog input
I = Input O = Output

P = Power OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

TABLE 1-4: PIC18F8XJ90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Din Nome	Pin Number	Pin	Buffer	Description
Pin Name	TQFP	Туре	Туре	Description
				PORTH is a bidirectional I/O port.
RH0/SEG47 RH0 SEG47	79	I/O O	ST Analog	Digital I/O. SEG47 output for LCD.
RH1/SEG46 RH1 SEG46	80	I/O O	ST Analog	Digital I/O. SEG46 output for LCD.
RH2/SEG45 RH2 SEG45	1	I/O O	ST Analog	Digital I/O. SEG45 output for LCD.
RH3/SEG44 RH3 SEG44	2	I/O O	ST Analog	Digital I/O. SEG44 output for LCD.
RH4/SEG40 RH4 SEG40	22	I/O O	ST Analog	Digital I/O. SEG40 output for LCD.
RH5/SEG41 RH5 SEG41	21	I/O O	ST Analog	Digital I/O. SEG41 output for LCD.
RH6/SEG42 RH6 SEG42	20	I/O O	ST Analog	Digital I/O. SEG42 output for LCD.
RH7/SEG43 RH7 SEG43	19	I/O O	ST Analog	Digital I/O. SEG43 output for LCD.

Legend: TTL = TTL compatible input

ST = Schmitt Trigger input with CMOS levels

I = Input P = Power

CMOS = CMOS compatible input or output

Analog = Analog input

O = Output

OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

TABLE 1-4: PIC18F8XJ90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Decarinties	
rin name	TQFP	Туре	Туре	Description	
				PORTJ is a bidirectional I/O port.	
RJ0	62	I/O	ST	Digital I/O.	
RJ1/SEG33 RJ1 SEG33	61	I/O O	ST Analog	Digital I/O. SEG33 output for LCD.	
RJ2/SEG34 RJ2 SEG34	60	I/O O	ST Analog	Digital I/O. SEG34 output for LCD.	
RJ3/SEG35 RJ3 SEG35	59	I/O O	ST Analog	Digital I/O. SEG35 output for LCD.	
RJ4/SEG39 RJ4 SEG39	39	I/O O	ST Analog	Digital I/O. SEG39 output for LCD.	
RJ5/SEG38 RJ5 SEG38	40	I/O O	ST Analog	Digital I/O SEG38 output for LCD.	
RJ6/SEG37 RJ6 SEG37	41	I/O O	ST Analog	Digital I/O. SEG37 output for LCD.	
RJ7/SEG36 RJ7 SEG36	42	I/O O	ST Analog	Digital I/O. SEG36 output for LCD.	
Vss	11, 31, 51, 70	Р	_	Ground reference for logic and I/O pins.	
VDD	32, 48, 71	Р	_	Positive supply for logic and I/O pins.	
AVss	26	Р		Ground reference for analog modules.	
AVDD	25	Р	_	Positive supply for analog modules.	
ENVREG	24	ı	ST	Enable for on-chip voltage regulator.	
VDDCORE/VCAP VDDCORE	12	P	_	Core logic power or external filter capacitor connection. Positive supply for microcontroller core logic (regulator disabled).	
VCAP		Р	_	External filter capacitor connection (regulator enabled).	

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

Analog = Analog input

I = Input

O = Output

P = Power

OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for CCP2 when the CCP2MX Configuration bit is set.

NOTES:

2.0 OSCILLATOR CONFIGURATIONS

2.1 Oscillator Types

The PIC18F87J90 family of devices can be operated in eight different oscillator modes:

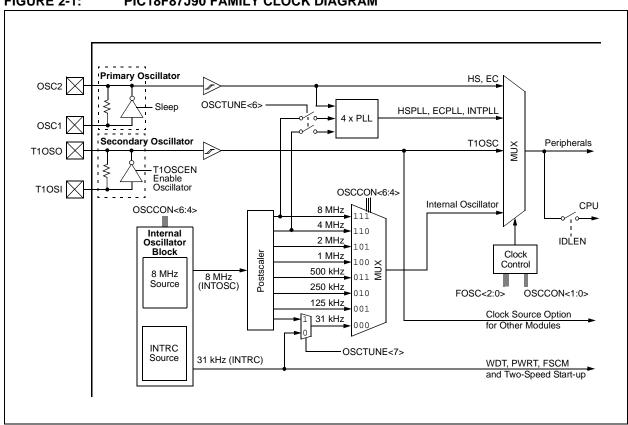
- ECPLL OSC1/OSC2 as primary; ECPLL oscillator with PLL enabled, CLKO on RA6
- 2. EC OSC1/OSC2 as primary; external clock with Fosc/4 output
- HSPLL OSC1/OSC2 as primary; high-speed crystal/resonator with software PLL control
- 4. HS OSC1/OSC2 as primary; high-speed crystal/resonator
- INTPLL1 Internal oscillator block with software PLL control, Fosc/4 output on RA6 and I/O on RA7
- 6. INTIO1 Internal oscillator block with Fosc/4 output on RA6 and I/O on RA7
- INTPLL2 Internal oscillator block with software PLL control and I/O on RA6 and RA7
- 8. INTIO2 Internal oscillator block with I/O on RA6 and RA7

All of these modes are selected by the user by programming the FOSC<2:0> Configuration bits.

In addition, PIC18F87J90 family devices can switch between different clock sources, either under software control or automatically under certain conditions. This allows for additional power savings by managing device clock speed in real time without resetting the application.

The clock sources for the PIC18F87J90 family of devices are shown in Figure 2-1.

FIGURE 2-1: PIC18F87J90 FAMILY CLOCK DIAGRAM



2.2 Control Registers

The OSCCON register (Register 2-1) controls the main aspects of the device clock's operation. It selects the oscillator type to be used, which of the power-managed modes to invoke and the output frequency of the INTOSC source. It also provides status on the oscillators.

The OSCTUNE register (Register 2-2) controls the tuning and operation of the internal oscillator block. It also implements the PLLEN bits which control the operation of the Phase Locked Loop (PLL) (see Section 2.4.3 "PLL Frequency Multiplier").

REGISTER 2-1: OSCCON: OSCILLATOR CONTROL REGISTER⁽¹⁾

R/W-0	R/W-1	R/W-1	R/W-0	R ⁽²⁾	R-0	R/W-0	R/W-0
IDLEN	IRCF2 ⁽³⁾	IRCF1 ⁽³⁾	IRCF0 ⁽³⁾	OSTS	IOFS	SCS1 ⁽⁵⁾	SCS0 ⁽⁵⁾
bit 7							bit 0

 Legend:
 R = Readable bit
 W = Writable bit
 U = Unimplemented bit, read as '0'

 -n = Value at POR
 '1' = Bit is set
 '0' = Bit is cleared
 x = Bit is unknown

bit 7 IDLEN: Idle Enable bit

1 = Device enters an Idle mode when a SLEEP instruction is executed

0 = Device enters Sleep mode when a SLEEP instruction is executed

bit 6-4 IRCF<2:0>: INTOSC Source Frequency Select bits⁽³⁾

111 = 8 MHz (INTOSC drives clock directly)

110 = 4 MHz (default)

101 **= 2 MHz**

100 = 1 MHz

011 = 500 kHz

010 = 250 kHz

001 = 125 kHz

000 = 31 kHz (from either INTOSC/256 or INTRC)⁽⁴⁾

bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit⁽²⁾

1 = Oscillator Start-up Timer (OST) time-out has expired; primary oscillator is running

0 = Oscillator Start-up Timer (OST) time-out is running; primary oscillator is not ready

bit 2 IOFS: INTOSC Frequency Stable bit

1 = Fast RC oscillator frequency is stable

0 = Fast RC oscillator frequency is not stable

bit 1-0 SCS<1:0>: System Clock Select bits⁽⁵⁾

11 = Internal oscillator block

10 = Primary oscillator

01 = Timer1 oscillator

00 = Default primary oscillator (as defined by FOSC<2:0> Configuration bits)

Note 1: Default (legacy) SFR at this address; available when WDTCON<4>=0.

2: Reset state depends on state of the IESO Configuration bit.

3: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.

4: Source selected by the INTSRC bit (OSCTUNE<7>), see text.

5: Modifying these bits will cause an immediate clock source switch.

REGISTER 2-2: OSCTUNE: OSCILLATOR TUNING REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
INTSRC	PLLEN	TUN5	TUN4	TUN3	TUN2	TUN1	TUN0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 INTSRC: Internal Oscillator Low-Frequency Source Select bit

1 = 31.25 kHz device clock derived from 8 MHz INTOSC source (divide-by-256 enabled)

0 = 31 kHz device clock derived from INTRC 31 kHz oscillator

bit 6 PLLEN: Frequency Multiplier PLL Enable bit

1 = PLL enabled0 = PLL disabled

bit 5-0 **TUN<5:0>:** Fast RC Oscillator (INTOSC) Frequency Tuning bits

011111 = Maximum frequency

•

000001

000000 = Center frequency. Fast RC oscillator is running at the calibrated frequency.

111111

•

100000 = Minimum frequency

2.3 Clock Sources and Oscillator Switching

Essentially, PIC18F87J90 family devices have three independent clock sources:

- · Primary oscillators
- · Secondary oscillators
- · Internal oscillator

The **primary oscillators** can be thought of as the main device oscillators. These are any external oscillators connected to the OSC1 and OSC2 pins, and include the External Crystal and Resonator modes and the External Clock modes. If selected by the FOSC<2:0> Configuration bits, the internal oscillator block (either the 31 kHz INTRC or the 8 MHz INTOSC source) may be considered a primary oscillator. The particular mode is defined by the FOSC Configuration bits. The details of these modes are covered in **Section 2.4 "External Oscillator Modes"**.

The **secondary oscillators** are external clock sources that are not connected to the OSC1 or OSC2 pins. These sources may continue to operate even after the controller is placed in a power-managed mode. PIC18F87J90 family devices offer the Timer1 oscillator as a secondary oscillator source. This oscillator, in all power-managed modes, is often the time base for

functions such as a Real-Time Clock (RTC). The Timer1 oscillator is discussed in greater detail in **Section 11.0** "Timer1 Module".

In addition to being a primary clock source in some circumstances, the **internal oscillator** is available as a power-managed mode clock source. The INTRC source is also used as the clock source for several special features, such as the WDT and Fail-Safe Clock Monitor. The internal oscillator block is discussed in more detail in **Section 2.5** "Internal Oscillator Block".

The PIC18F87J90 family includes features that allow the device clock source to be switched from the main oscillator, chosen by device configuration, to one of the alternate clock sources. When an alternate clock source is enabled, various power-managed operating modes are available.

2.3.1 CLOCK SOURCE SELECTION

The System Clock Select bits, SCS<1:>0 (OSCCON<1:0>), select the clock source. The available clock sources are the primary clock defined by the FOSC<2:0> Configuration bits, the secondary clock (Timer1 oscillator) and the internal oscillator. The clock source changes after one or more of the bits is written to, following a brief clock transition interval.

The OSTS (OSCCON<3>) and T1RUN (T1CON<6>) bits indicate which clock source is currently providing the device clock. The OSTS bit indicates that the Oscillator Start-up Timer (OST) has timed out and the primary clock is providing the device clock in primary clock modes. The T1RUN bit indicates when the Timer1 oscillator is providing the device clock in secondary clock modes. In power-managed modes, only one of these bits will be set at any time. If neither of these bits is set, the INTRC is providing the clock, or the internal oscillator has just started and is not yet stable

The IDLEN bit determines if the device goes into Sleep mode or one of the Idle modes when the SLEEP instruction is executed.

The use of the flag and control bits in the OSCCON register is discussed in more detail in **Section 3.0** "Power-Managed Modes".

- Note 1: The Timer1 oscillator must be enabled to select the secondary clock source. The Timer1 oscillator is enabled by setting the T1OSCEN bit in the Timer1 Control register (T1CON<3>). If the Timer1 oscillator is not enabled, then any attempt to select a secondary clock source when executing a SLEEP instruction will be ignored.
 - 2: It is recommended that the Timer1 oscillator be operating and stable before executing the SLEEP instruction or a very long delay may occur while the Timer1 oscillator starts.

2.3.1.1 System Clock Selection and Device Resets

Since the SCS bits are cleared on all forms of Reset, this means the primary oscillator defined by the FOSC<2:0> Configuration bits is used as the primary clock source on device Resets. This could either be the internal oscillator block by itself, or one of the other primary clock source (HS, EC, HSPLL, ECPLL1/2 or INTPLL1/2).

In those cases when the internal oscillator block, without PLL, is the default clock on Reset, the Fast RC oscillator (INTOSC) will be used as the device clock source. It will initially start at 1 MHz, the postscaler selection that corresponds to the Reset value of the IRCF<2:0> bits ('100').

Regardless of which primary oscillator is selected, INTRC will always be enabled on device power-up. It serves as the clock source until the device has loaded its configuration values from memory. It is at this point that the FOSC Configuration bits are read and the oscillator selection of the operational mode is made.

Note that either the primary clock source, or the internal oscillator, will have two bit setting options for the possible values of the SCS<1:0> bits at any given time.

2.3.2 OSCILLATOR TRANSITIONS

PIC18F87J90 family devices contain circuitry to prevent clock "glitches" when switching between clock sources. A short pause in the device clock occurs during the clock switch. The length of this pause is the sum of two cycles of the old clock source and three to four cycles of the new clock source. This formula assumes that the new clock source is stable.

Clock transitions are discussed in greater detail in **Section 3.1.2 "Entering Power-Managed Modes"**.

2.4 External Oscillator Modes

2.4.1 CRYSTAL OSCILLATOR/CERAMIC RESONATORS (HS MODES)

In HS or HSPLL Oscillator modes, a crystal or ceramic resonator is connected to the OSC1 and OSC2 pins to establish oscillation. Figure 2-2 shows the pin connections.

The oscillator design requires the use of a crystal rated for parallel resonant operation.

Note: Use of a crystal rated for series resonant operation may give a frequency out of the crystal manufacturer's specifications.

TABLE 2-1: CAPACITOR SELECTION FOR CERAMIC RESONATORS

Typical Capacitor Values Used:									
Mode	Mode Freq. OSC1 OSC2								
HS	8.0 MHz 16.0 MHz	27 pF 22 pF	27 pF 22 pF						

Capacitor values are for design guidance only.

Different capacitor values may be required to produce acceptable oscillator operation. The user should test the performance of the oscillator over the expected VDD and temperature range for the application. Refer to the following application notes for oscillator specific information:

- AN588, "PIC® Microcontroller Oscillator Design Guide"
- AN826, "Crystal Oscillator Basics and Crystal Selection for rfPIC® and PIC® Devices"
- AN849, "Basic PIC® Oscillator Design"
- AN943, "Practical PIC® Oscillator Analysis and Design"
- AN949, "Making Your Oscillator Work"

See the notes following Table 2-2 for additional information.

TABLE 2-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR

Osc Type	Crystal Freg.	Typical Capacitor Values Tested:			
	rieq.	C1	C2		
HS	4 MHz	27 pF	27 pF		
	8 MHz	22 pF	22 pF		
	20 MHz	15 pF	15 pF		

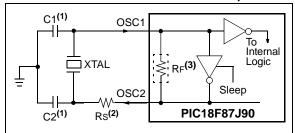
Capacitor values are for design guidance only.

Different capacitor values may be required to produce acceptable oscillator operation. The user should test the performance of the oscillator over the expected VDD and temperature range for the application.

Refer to the Microchip application notes cited in Table 2-1 for oscillator specific information. Also see the notes following this table for additional information.

- **Note 1:** Higher capacitance increases the stability of oscillator but also increases the start-up time.
 - 2: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.
 - **3:** Rs may be required to avoid overdriving crystals with low drive level specification.
 - **4:** Always verify oscillator performance over the VDD and temperature range that is expected for the application.

FIGURE 2-2: CRYSTAL/CERAMIC
RESONATOR OPERATION
(HS OR HSPLL
CONFIGURATION)



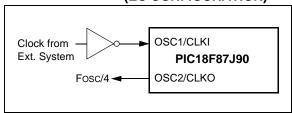
- Note 1: See Table 2-1 and Table 2-2 for initial values of C1 and C2.
 - A series resistor (Rs) may be required for AT strip cut crystals.
 - 3: RF varies with the oscillator mode chosen.

2.4.2 EXTERNAL CLOCK INPUT (EC MODES)

The EC and ECPLL Oscillator modes require an external clock source to be connected to the OSC1 pin. There is no oscillator start-up time required after a Power-on Reset or after an exit from Sleep mode.

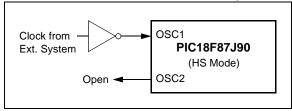
In the EC Oscillator mode, the oscillator frequency divided by 4 is available on the OSC2 pin. This signal may be used for test purposes or to synchronize other logic. Figure 2-3 shows the pin connections for the EC Oscillator mode.

FIGURE 2-3: EXTERNAL CLOCK INPUT OPERATION (EC CONFIGURATION)



An external clock source may also be connected to the OSC1 pin in the HS mode, as shown in Figure 2-4. In this configuration, the divide-by-4 output on OSC2 is not available. Current consumption in this configuration will be somewhat higher than EC mode, as the internal oscillator's feedback circuitry will be enabled (in EC mode, the feedback circuit is disabled).

FIGURE 2-4: EXTERNAL CLOCK INPUT OPERATION (HS OSC CONFIGURATION)



2.4.3 PLL FREQUENCY MULTIPLIER

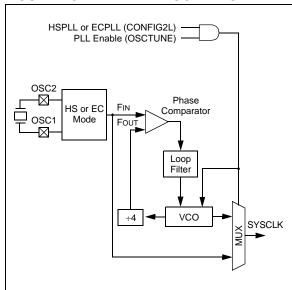
A Phase Locked Loop (PLL) circuit is provided as an option for users who want to use a lower frequency oscillator circuit, or to clock the device up to its highest rated frequency from a crystal oscillator. This may be useful for customers who are concerned with EMI due to high-frequency crystals, or users who require higher clock speeds from an internal oscillator.

2.4.3.1 HSPLL and ECPLL Modes

The HSPLL and ECPLL modes provide the ability to selectively run the device at 4 times the external oscillating source to produce frequencies up to 40 MHz.

The PLL is enabled by programming the FOSC<2:0> Configuration bits to either '111' (for ECPLL) or '101' (for HSPLL). In addition, the PLLEN bit (OSCTUNE<6>) must also be set. Clearing PLLEN disables the PLL, regardless of the chosen oscillator configuration. It also allows additional flexibility for controlling the application's clock speed in software.

FIGURE 2-5: PLL BLOCK DIAGRAM



2.4.3.2 PLL and INTOSC

The PLL is also available to the internal oscillator block when the internal oscillator block is configured as the primary clock source. In this configuration, the PLL is enabled in software and generates a clock output of up to 32 MHz. The operation of INTOSC with the PLL is described in **Section 2.5.2 "INTPLL Modes"**.

2.5 Internal Oscillator Block

The PIC18F87J90 family of devices includes an internal oscillator block which generates two different clock signals; either can be used as the microcontroller's clock source. This may eliminate the need for an external oscillator circuit on the OSC1 and/or OSC2 pins.

The main output is the Fast RC oscillator, or INTOSC, an 8 MHz clock source which can be used to directly drive the device clock. It also drives a postscaler, which can provide a range of clock frequencies from 31 kHz to 4 MHz. INTOSC is enabled when a clock frequency from 125 kHz to 8 MHz is selected. The INTOSC output can also be enabled when 31 kHz is selected, depending on the INTSRC bit (OSCTUNE<7>).

The other clock source is the internal RC oscillator (INTRC), which provides a nominal 31 kHz output. INTRC is enabled if it is selected as the device clock source; it is also enabled automatically when any of the following are enabled:

- · Power-up Timer
- · Fail-Safe Clock Monitor
- · Watchdog Timer
- Two-Speed Start-up

These features are discussed in greater detail in Section 24.0 "Special Features of the CPU".

The clock source frequency (INTOSC direct, INTOSC with postscaler or INTRC direct) is selected by configuring the IRCF bits of the OSCCON register. The default frequency on device Resets is 4 MHz.

2.5.1 INTIO MODES

Using the internal oscillator as the clock source eliminates the need for up to two external oscillator pins, which can then be used for digital I/O. Two distinct oscillator configurations, which are determined by the FOSC Configuration bits, are available:

- In INTIO1 mode, the OSC2 pin outputs Fosc/4, while OSC1 functions as RA7 (see Figure 2-6) for digital input and output.
- In INTIO2 mode, OSC1 functions as RA7 and OSC2 functions as RA6 (see Figure 2-7), both for digital input and output.

FIGURE 2-6: INTIO1 OSCILLATOR MODE

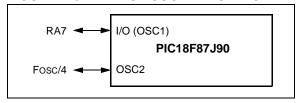
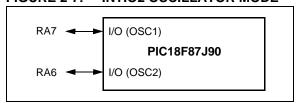


FIGURE 2-7: INTIO2 OSCILLATOR MODE



2.5.2 INTPLL MODES

The 4x Phase Locked Loop (PLL) can be used with the internal oscillator block to produce faster device clock speeds than are normally possible with the internal oscillator sources. When enabled, the PLL produces a clock speed of 16 MHz or 32 MHz.

PLL operation is controlled through software. The control bit, PLLEN (OSCTUNE<6>), is used to enable or disable its operation. The PLL is available only to INTOSC when the device is configured to use one of the INTPLL modes as the primary clock source (FOSC<2:0> = 011 or 001). Additionally, the PLL will only function when the selected output frequency is either 4 MHz or 8 MHz (OSCCON<6:4> = 111 or 110).

Like the INTIO modes, there are two distinct INTPLL modes available:

- In INTPLL1 mode, the OSC2 pin outputs Fosc/4, while OSC1 functions as RA7 for digital input and output. Externally, this is identical in appearance to INTIO1 (Figure 2-6).
- In INTPLL2 mode, OSC1 functions as RA7 and OSC2 functions as RA6, both for digital input and output. Externally, this is identical to INTIO2 (Figure 2-7).

2.5.3 INTERNAL OSCILLATOR OUTPUT FREQUENCY AND TUNING

The internal oscillator block is calibrated at the factory to produce an INTOSC output frequency of 8 MHz. It can be adjusted in the user's application by writing to TUN<5:0> (OSCTUNE<5:0>) in the OSCTUNE register (Register 2-2).

When the OSCTUNE register is modified, the INTOSC frequency will begin shifting to the new frequency. The oscillator will stabilize within 1 ms. Code execution continues during this shift and there is no indication that the shift has occurred.

The INTRC oscillator operates independently of the INTOSC source. Any changes in INTOSC across voltage and temperature are not necessarily reflected by changes in INTRC or vice versa. The frequency of INTRC is not affected by OSCTUNE.

2.5.4 INTOSC FREQUENCY DRIFT

The INTOSC frequency may drift as VDD or temperature changes, and can affect the controller operation in a variety of ways. It is possible to adjust the INTOSC frequency by modifying the value in the OSCTUNE register. Depending on the device, this may have no effect on the INTRC clock source frequency.

Tuning INTOSC requires knowing when to make the adjustment, in which direction it should be made, and in some cases, how large a change is needed. Three compensation techniques are shown here.

2.5.4.1 Compensating with the EUSART

An adjustment may be required when the EUSART begins to generate framing errors or receives data with errors while in Asynchronous mode. Framing errors indicate that the device clock frequency is too high. To adjust for this, decrement the value in OSCTUNE to reduce the clock frequency. On the other hand, errors in data may suggest that the clock speed is too low. To compensate, increment OSCTUNE to increase the clock frequency.

2.5.4.2 Compensating with the Timers

This technique compares device clock speed to some reference clock. Two timers may be used; one timer is clocked by the peripheral clock, while the other is clocked by a fixed reference source, such as the Timer1 oscillator.

Both timers are cleared, but the timer clocked by the reference generates interrupts. When an interrupt occurs, the internally clocked timer is read and both timers are cleared. If the internally clocked timer value is much greater than expected, then the internal oscillator block is running too fast. To adjust for this, decrement the OSCTUNE register.

2.5.4.3 Compensating with the CCP Module in Capture Mode

A CCP module can use free-running Timer1 (or Timer3), clocked by the internal oscillator block and an external event with a known period (i.e., AC power frequency). The time of the first event is captured in the CCPRxH:CCPRxL registers and is recorded for use later. When the second event causes a capture, the time of the first event is subtracted from the time of the second event. Since the period of the external event is known, the time difference between events can be calculated.

If the measured time is much greater than the calculated time, the internal oscillator block is running too fast. To compensate, decrement the OSCTUNE register. If the measured time is much less than the calculated time, the internal oscillator block is running too slow. To compensate, increment the OSCTUNE register.

2.6 Effects of Power-Managed Modes on the Various Clock Sources

When PRI_IDLE mode is selected, the designated primary oscillator continues to run without interruption. For all other power-managed modes, the oscillator using the OSC1 pin is disabled. The OSC1 pin (and OSC2 pin if used by the oscillator) will stop oscillating.

In secondary clock modes (SEC_RUN and SEC_IDLE), the Timer1 oscillator is operating and providing the device clock. The Timer1 oscillator may also run in all power-managed modes if required to clock Timer1 or Timer3.

In RC_RUN and RC_IDLE modes, the internal oscillator provides the device clock source. The 31 kHz INTRC output can be used directly to provide the clock and may be enabled to support various special features, regardless of the power-managed mode (see Section 24.2 "Watchdog Timer (WDT)" through Section 24.5 "Fail-Safe Clock Monitor" for more information on WDT, Fail-Safe Clock Monitor and Two-Speed Start-up).

If the Sleep mode is selected, all clock sources are stopped. Since all the transistor switching currents have been stopped, Sleep mode achieves the lowest current consumption of the device (only leakage currents).

Enabling any on-chip feature that will operate during Sleep will increase the current consumed during Sleep. The INTRC is required to support WDT operation. The

Timer1 oscillator may be operating to support a Real-Time Clock (RTC). Other features may be operating that do not require a device clock source (i.e., MSSP slave, INTx pins and others). Peripherals that may add significant current consumption are listed in Section 27.2 "DC Characteristics: Power-Down and Supply Current PIC18F87J90 Family (Industrial)".

2.7 Power-up Delays

Power-up delays are controlled by two timers, so that no external Reset circuitry is required for most applications. The delays ensure that the device is kept in Reset until the device power supply is stable under normal circumstances and the primary clock is operating and stable. For additional information on power-up delays, see **Section 4.6** "Power-up Timer (PWRT)".

The first timer is the Power-up Timer (PWRT), which provides a fixed delay on power-up (parameter 33, Table 27-11); it is always enabled.

The second timer is the Oscillator Start-up Timer (OST), intended to keep the chip in Reset until the crystal oscillator is stable (HS modes). The OST does this by counting 1024 oscillator cycles before allowing the oscillator to clock the device.

There is a delay of interval TCSD (parameter 38, Table 27-11), following POR, while the controller becomes ready to execute instructions.

TABLE 2-3: OSC1 AND OSC2 PIN STATES IN SLEEP MODE

Oscillator Mode	OSC1 Pin	OSC2 Pin
EC, ECPLL	Floating, pulled by external clock	At logic low (clock/4 output)
HS, HSPLL	Feedback inverter disabled at quiescent voltage level	Feedback inverter disabled at quiescent voltage level
INTOSC, INTPLL1/2	I/O pin RA6, direction controlled by TRISA<6>	I/O pin RA6, direction controlled by TRISA<7>

Note: See **Section 4.0 "Reset"** for time-outs due to Sleep and MCLR Reset.

NOTES:

3.0 POWER-MANAGED MODES

The PIC18F87J90 family devices provide the ability to manage power consumption by simply managing clocking to the CPU and the peripherals. In general, a lower clock frequency and a reduction in the number of circuits being clocked constitutes lower consumed power. For the sake of managing power in an application, there are three primary modes of operation:

- Run mode
- · Idle mode
- · Sleep mode

These modes define which portions of the device are clocked and at what speed. The Run and Idle modes may use any of the three available clock sources (primary, secondary or internal oscillator block); the Sleep mode does not use a clock source.

The power-managed modes include several power-saving features offered on previous PIC® devices. One is the clock switching feature, offered in other PIC18 devices, allowing the controller to use the Timer1 oscillator in place of the primary oscillator. Also included is the Sleep mode, offered by all PIC devices, where all device clocks are stopped.

3.1 Selecting Power-Managed Modes

Selecting a power-managed mode requires two decisions: if the CPU is to be clocked or not and which clock source is to be used. The IDLEN bit (OSCCON<7>) controls CPU clocking, while the SCS<1:0> bits (OSCCON<1:0>) select the clock source. The individual modes, bit settings, clock sources and affected modules are summarized in Table 3-1.

3.1.1 CLOCK SOURCES

The SCS<1:0> bits allow the selection of one of three clock sources for power-managed modes. They are:

- the primary clock, as defined by the FOSC<2:0> Configuration bits
- the secondary clock (Timer1 oscillator)
- the internal oscillator

3.1.2 ENTERING POWER-MANAGED MODES

Switching from one power-managed mode to another begins by loading the OSCCON register. The SCS<1:0> bits select the clock source and determine which Run or Idle mode is to be used. Changing these bits causes an immediate switch to the new clock source, assuming that it is running. The switch may also be subject to clock transition delays. These are discussed in **Section 3.1.3 "Clock Transitions and Status Indicators"** and subsequent sections.

Entry to the power-managed Idle or Sleep modes is triggered by the execution of a SLEEP instruction. The actual mode that results depends on the status of the IDLEN bit.

Depending on the current mode and the mode being switched to, a change to a power-managed mode does not always require setting all of these bits. Many transitions may be done by changing the oscillator select bits, or changing the IDLEN bit, prior to issuing a SLEEP instruction. If the IDLEN bit is already configured correctly, it may only be necessary to perform a SLEEP instruction to switch to the desired mode.

TABLE 3-1: POWER-MANAGED MODES

	osc	OSCCON bits		e Clocking	Assistant Class and Casillaton Casses						
Mode	IDLEN<7>(1)	SCS<1:0>	CPU	Peripherals	Available Clock and Oscillator Source						
Sleep	0	N/A	Off	Off	None – All clocks are disabled						
PRI_RUN	N/A	10	Clocked	Clocked	Primary – HS, EC, HSPLL, ECPLL; this is the normal full power execution mode						
SEC_RUN	N/A	01	Clocked	Clocked	Secondary - Timer1 Oscillator						
RC_RUN	N/A	11	Clocked	Clocked	Internal Oscillator						
PRI_IDLE	1	10	Off	Clocked	Primary – HS, EC, HSPLL, ECPLL						
SEC_IDLE	1	01	Off	Clocked	Secondary - Timer1 Oscillator						
RC_IDLE	1	11	Off	Clocked	Internal Oscillator						

Note 1: IDLEN reflects its value when the SLEEP instruction is executed.

3.1.3 CLOCK TRANSITIONS AND STATUS INDICATORS

The length of the transition between clock sources is the sum of two cycles of the old clock source and three to four cycles of the new clock source. This formula assumes that the new clock source is stable.

Two bits indicate the current clock source and its status: OSTS (OSCCON<3>) and T1RUN (T1CON<6>). In general, only one of these bits will be set while in a given power-managed mode. When the OSTS bit is set, the primary clock is providing the device clock. When the T1RUN bit is set, the Timer1 oscillator is providing the clock. If neither of these bits is set, INTRC is clocking the device.

Note: Executing a SLEEP instruction does not necessarily place the device into Sleep mode. It acts as the trigger to place the controller into either the Sleep mode, or one of the Idle modes, depending on the setting of the IDLEN bit.

3.1.4 MULTIPLE SLEEP COMMANDS

The power-managed mode that is invoked with the SLEEP instruction is determined by the setting of the IDLEN bit at the time the instruction is executed. If another SLEEP instruction is executed, the device will enter the power-managed mode specified by IDLEN at that time. If IDLEN has changed, the device will enter the new power-managed mode specified by the new setting.

3.2 Run Modes

In the Run modes, clocks to both the core and peripherals are active. The difference between these modes is the clock source.

3.2.1 PRI RUN MODE

The PRI_RUN mode is the normal, full power execution mode of the microcontroller. This is also the default mode upon a device Reset unless Two-Speed Start-up is enabled (see Section 24.4 "Two-Speed Start-up" for details). In this mode, the OSTS bit is set (see Section 2.2 "Control Registers").

3.2.2 SEC_RUN MODE

result.

The SEC_RUN mode is the compatible mode to the "clock switching" feature offered in other PIC18 devices. In this mode, the CPU and peripherals are clocked from the Timer1 oscillator. This gives users the option of lower power consumption while still using a high-accuracy clock source.

SEC_RUN mode is entered by setting the SCS<1:0> bits to '01'. The device clock source is switched to the Timer1 oscillator (see Figure 3-1), the primary oscillator is shut down, the T1RUN bit (T1CON<6>) is set and the OSTS bit is cleared.

Note: The Timer1 oscillator should already be running prior to entering SEC_RUN mode. If the T10SCEN bit is not set when the SCS<1:0> bits are set to '01', entry to SEC_RUN mode will not occur. If the Timer1 oscillator is enabled, but not yet running, device clocks will be delayed until the oscillator has started. In such situations, initial oscillator operation is far from stable and unpredictable operation may

On transitions from SEC_RUN mode to PRI_RUN mode, the peripherals and CPU continue to be clocked from the Timer1 oscillator while the primary clock is started. When the primary clock becomes ready, a clock switch back to the primary clock occurs (see

Figure 3-2). When the clock switch is complete, the T1RUN bit is cleared, the OSTS bit is set and the primary clock is providing the clock. The IDLEN and SCS bits are not affected by the wake-up; the Timer1 oscillator continues to run.



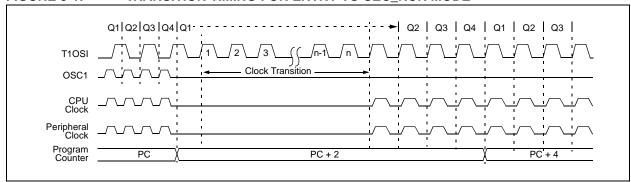
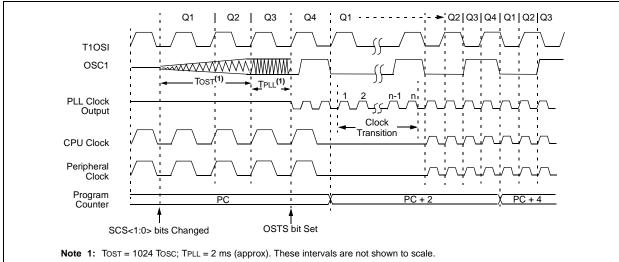


FIGURE 3-2: TRANSITION TIMING FROM SEC_RUN MODE TO PRI_RUN MODE (HSPLL)



3.2.3 RC_RUN MODE

In RC_RUN mode, the CPU and peripherals are clocked from the internal oscillator; the primary clock is shut down. This mode provides the best power conservation of all the Run modes while still executing code. It works well for user applications which are not highly timing sensitive or do not require high-speed clocks at all times.

This mode is entered by setting SCS bits to '11'. When the clock source is switched to the INTRC (see Figure 3-3), the primary oscillator is shut down and the OSTS bit is cleared.

On transitions from RC_RUN mode to PRI_RUN mode, the device continues to be clocked from the INTRC while the primary clock is started. When the primary clock becomes ready, a clock switch to the primary clock occurs (see Figure 3-4). When the clock switch is complete, the OSTS bit is set and the primary clock is providing the device clock. The IDLEN and SCS bits are not affected by the switch. The INTRC source will continue to run if either the WDT or the Fail-Safe Clock Monitor is enabled.

FIGURE 3-3: TRANSITION TIMING TO RC_RUN MODE

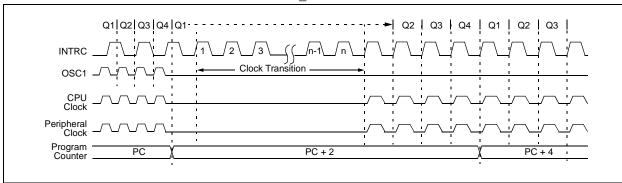
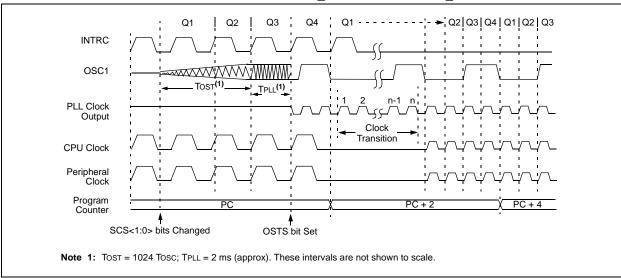


FIGURE 3-4: TRANSITION TIMING FROM RC_RUN MODE TO PRI_RUN MODE



3.3 Sleep Mode

The power-managed Sleep mode is identical to the legacy Sleep mode offered in all other PIC devices. It is entered by clearing the IDLEN bit (the default state on device Reset) and executing the SLEEP instruction. This shuts down the selected oscillator (Figure 3-5). All clock source status bits are cleared.

Entering the Sleep mode from any other mode does not require a clock switch. This is because no clocks are needed once the controller has entered Sleep. If the WDT is selected, the INTRC source will continue to operate. If the Timer1 oscillator is enabled, it will also continue to run.

When a wake event occurs in Sleep mode (by interrupt, Reset or WDT time-out), the device will not be clocked until the clock source selected by the SCS<1:0> bits becomes ready (see Figure 3-6), or it will be clocked from the internal oscillator if either the Two-Speed Start-up or the Fail-Safe Clock Monitor is enabled (see Section 24.0 "Special Features of the CPU"). In either case, the OSTS bit is set when the primary clock is providing the device clocks. The IDLEN and SCS bits are not affected by the wake-up.

3.4 Idle Modes

The Idle modes allow the controller's CPU to be selectively shut down while the peripherals continue to operate. Selecting a particular Idle mode allows users to further manage power consumption.

If the IDLEN bit is set to a '1' when a SLEEP instruction is executed, the peripherals will be clocked from the clock source selected using the SCS<1:0> bits; however, the CPU will not be clocked. The clock source status bits are not affected. Setting IDLEN and executing a SLEEP instruction provides a quick method of switching from a given Run mode to its corresponding Idle mode.

If the WDT is selected, the INTRC source will continue to operate. If the Timer1 oscillator is enabled, it will also continue to run.

Since the CPU is not executing instructions, the only exits from any of the Idle modes are by interrupt, WDT time-out or a Reset. When a wake event occurs, CPU execution is delayed by an interval of TcsD (parameter 38, Table 27-11) while it becomes ready to execute code. When the CPU begins executing code, it resumes with the same clock source for the current Idle mode. For example, when waking from RC_IDLE mode, the internal oscillator block will clock the CPU and peripherals (in other words, RC_RUN mode). The IDLEN and SCS bits are not affected by the wake-up.

While in any Idle mode or the Sleep mode, a WDT time-out will result in a WDT wake-up to the Run mode currently specified by the SCS<1:0> bits.



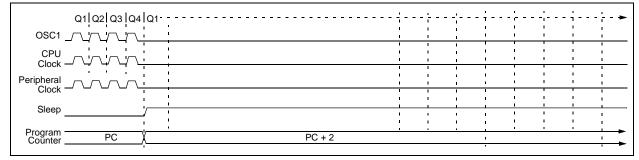
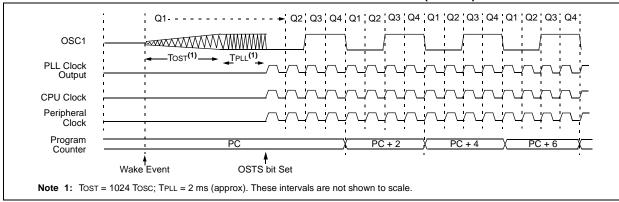


FIGURE 3-6: TRANSITION TIMING FOR WAKE FROM SLEEP (HSPLL)



3.4.1 PRI_IDLE MODE

This mode is unique among the three low-power Idle modes, in that it does not disable the primary device clock. For timing-sensitive applications, this allows for the fastest resumption of device operation with its more accurate primary clock source, since the clock source does not have to "warm up" or transition from another oscillator.

PRI_IDLE mode is entered from PRI_RUN mode by setting the IDLEN bit and executing a SLEEP instruction. If the device is in another Run mode, set IDLEN first, then set the SCS bits to '10' and execute SLEEP. Although the CPU is disabled, the peripherals continue to be clocked from the primary clock source specified by the FOSC<1:0> Configuration bits. The OSTS bit remains set (see Figure 3-7).

When a wake event occurs, the CPU is clocked from the primary clock source. A delay of interval, Tcsp, is required between the wake event and when code execution starts. This is required to allow the CPU to become ready to execute instructions. After the wake-up, the OSTS bit remains set. The IDLEN and SCS bits are not affected by the wake-up (see Figure 3-8).

3.4.2 SEC IDLE MODE

In SEC_IDLE mode, the CPU is disabled but the peripherals continue to be clocked from the Timer1 oscillator. This mode is entered from SEC_RUN by setting the IDLEN bit and executing a SLEEP instruction. If the device is in another Run mode, set IDLEN first, then set SCS<1:0> to '01' and execute SLEEP. When the clock source is switched to the Timer1 oscillator, the primary oscillator is shut down, the OSTS bit is cleared and the T1RUN bit is set.

When a wake event occurs, the peripherals continue to be clocked from the Timer1 oscillator. After an interval of TCSD, following the wake event, the CPU begins executing code being clocked by the Timer1 oscillator. The IDLEN and SCS bits are not affected by the wake-up; the Timer1 oscillator continues to run (see Figure 3-8).

Note: The Timer1 oscillator should already be running prior to entering SEC_IDLE mode. If the T10SCEN bit is not set when the SLEEP instruction is executed, the SLEEP instruction will be ignored and entry to SEC_IDLE mode will not occur. If the Timer1 oscillator is enabled, but not yet running, peripheral clocks will be delayed until the oscillator has started. In such situations, initial oscillator operation is far from stable and unpredictable operation may result.



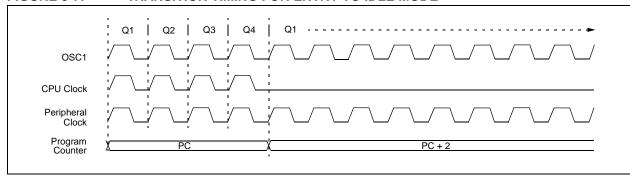
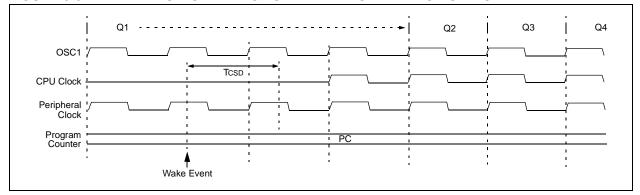


FIGURE 3-8: TRANSITION TIMING FOR WAKE FROM IDLE TO RUN MODE



3.4.3 RC IDLE MODE

In RC_IDLE mode, the CPU is disabled but the peripherals continue to be clocked from the internal oscillator. This mode allows for controllable power conservation during Idle periods.

From RC_RUN, this mode is entered by setting the IDLEN bit and executing a SLEEP instruction. If the device is in another Run mode, first set IDLEN, then clear the SCS bits and execute SLEEP. When the clock source is switched to the INTRC, the primary oscillator is shut down and the OSTS bit is cleared.

When a wake event occurs, the peripherals continue to be clocked from the INTOSC. After a delay of TCSD, following the wake event, the CPU begins executing code being clocked by the INTOSC. The IDLEN and SCS bits are not affected by the wake-up. The INTOSC source will continue to run if either the WDT or the Fail-Safe Clock Monitor is enabled.

3.5 Exiting Idle and Sleep Modes

An exit from Sleep mode, or any of the Idle modes, is triggered by an interrupt, a Reset or a WDT time-out. This section discusses the triggers that cause exits from power-managed modes. The clocking subsystem actions are discussed in each of the power-managed mode sections (see Section 3.2 "Run Modes", Section 3.3 "Sleep Mode" and Section 3.4 "Idle Modes").

3.5.1 EXIT BY INTERRUPT

Any of the available interrupt sources can cause the device to exit from an Idle mode, or the Sleep mode, to a Run mode. To enable this functionality, an interrupt source must be enabled by setting its enable bit in one of the INTCON or PIE registers. The exit sequence is initiated when the corresponding interrupt flag bit is set.

On all exits from Idle or Sleep modes by interrupt, code execution branches to the interrupt vector if the GIE/GIEH bit (INTCON<7>) is set. Otherwise, code execution continues or resumes without branching (see **Section 8.0 "Interrupts"**).

A fixed delay of interval TCSD following the wake event is required when leaving Sleep and Idle modes. This delay is required for the CPU to prepare for execution. Instruction execution resumes on the first clock cycle following this delay.

3.5.2 EXIT BY WDT TIME-OUT

A WDT time-out will cause different actions depending on which power-managed mode the device is in when the time-out occurs.

If the device is not executing code (all Idle modes and Sleep mode), the time-out will result in an exit from the power-managed mode (see Section 3.2 "Run Modes" and Section 3.3 "Sleep Mode"). If the device is executing code (all Run modes), the time-out will result in a WDT Reset (see Section 24.2 "Watchdog Timer (WDT)").

The Watchdog Timer and postscaler are cleared by one of the following events:

- executing a SLEEP or CLRWDT instruction
- the loss of a currently selected clock source (if the Fail-Safe Clock Monitor is enabled)

3.5.3 EXIT BY RESET

Exiting an Idle or Sleep mode by Reset automatically forces the device to run from the INTRC.

3.5.4 EXIT WITHOUT AN OSCILLATOR START-UP DELAY

Certain exits from power-managed modes do not invoke the OST at all. There are two cases:

- PRI_IDLE mode, where the primary clock source is not stopped; and
- the primary clock source is either the EC or ECPLL mode.

In these instances, the primary clock source either does not require an oscillator start-up delay, since it is already running (PRI_IDLE), or normally does not require an oscillator start-up delay (EC). However, a fixed delay of interval TCSD following the wake event is still required when leaving Sleep and Idle modes to allow the CPU to prepare for execution. Instruction execution resumes on the first clock cycle following this delay.

NOTES:

4.0 RESET

The PIC18F87J90 family of devices differentiates between various kinds of Reset:

- Power-on Reset (POR)
- · MCLR Reset during normal operation
- MCLR Reset during power-managed modes
- Watchdog Timer (WDT) Reset (during execution)
- Brown-out Reset (BOR)
- Configuration Mismatch (CM)
- RESET Instruction
- · Stack Full Reset
- · Stack Underflow Reset

This section discusses Resets generated by MCLR, POR and BOR and covers the operation of the various start-up timers. Stack Reset events are covered in Section 5.1.4.4 "Stack Full and Underflow Resets". WDT Resets are covered in Section 24.2 "Watchdog Timer (WDT)".

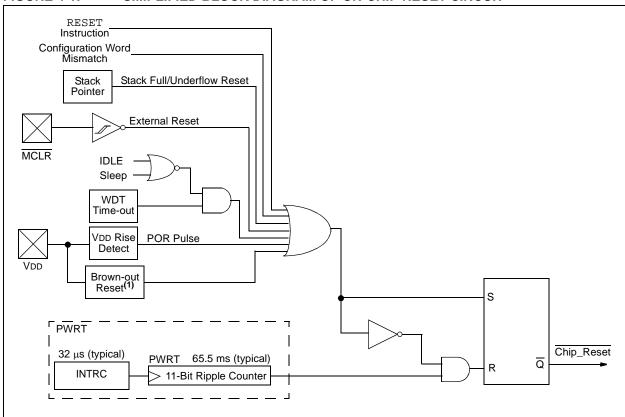
A simplified block diagram of the on-chip Reset circuit is shown in Figure 4-1.

4.1 RCON Register

Device Reset events are tracked through the RCON register (Register 4-1). The lower five bits of the register indicate that a specific Reset event has occurred. In most cases, these bits can only be set by the event and must be cleared by the application after the event. The state of these flag bits, taken together, can be read to indicate the type of Reset that just occurred. This is described in more detail in **Section 4.7 "Reset State of Registers"**.

The RCON register also has a control bit for setting interrupt priority (IPEN). Interrupt priority is discussed in **Section 8.0 "Interrupts"**.

FIGURE 4-1: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



Note 1: The ENVREG pin must be tied high to enable Brown-out Reset. The Brown-out Reset is provided by the on-chip voltage regulator when there is insufficient source voltage to maintain regulation.

REGISTER 4-1: RCON: RESET CONTROL REGISTER

R/W-0	U-0	R/W-1	R/W-1	R-1	R-1	R/W-0	R/W-0
IPEN	_	CM	RI	TO	PD	POR	BOR
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 **IPEN:** Interrupt Priority Enable bit

1 = Enable priority levels on interrupts

0 = Disable priority levels on interrupts (PIC16XXXX Compatibility mode)

bit 6 **Unimplemented:** Read as '0'

bit 5 CM: Configuration Mismatch Flag bit

1 = A configuration mismatch has not occurred

0 = A configuration mismatch has occurred (Must be set in software after a Configuration Mismatch

Reset occurs.)

bit 4 RESET Instruction Flag bit

1 = The RESET instruction was not executed (set by firmware only)

0 = The RESET instruction was executed causing a device Reset (must be set in software after a

Brown-out Reset occurs)

bit 3 TO: Watchdog Time-out Flag bit

1 = Set by power-up, CLRWDT instruction or SLEEP instruction

0 = A WDT time-out occurred

bit 2 PD: Power-Down Detection Flag bit

1 = Set by power-up or by the CLRWDT instruction

0 = Set by execution of the SLEEP instruction

bit 1 POR: Power-on Reset Status bit

1 = A Power-on Reset has not occurred (set by firmware only)

0 = A Power-on Reset occurred (must be set in software after a Power-on Reset occurs)

bit 0 BOR: Brown-out Reset Status bit

1 = A Brown-out Reset has not occurred (set by firmware only)

0 = A Brown-out Reset occurred (must be set in software after a Brown-out Reset occurs)

Note 1: It is recommended that the POR bit be set after a Power-on Reset has been detected, so that subsequent Power-on Resets may be detected.

2: If the on-chip voltage regulator is disabled, BOR remains '0' at all times. See Section 4.4.1 "Detecting BOR" for more information.

3: Brown-out Reset is said to have occurred when BOR is '0' and POR is '1' (assuming that POR was set to '1' by software immediately after a Power-on Reset).

4.2 Master Clear (MCLR)

The MCLR pin provides a method for triggering a hard external Reset of the device. A Reset is generated by holding the pin low. PIC18 extended microcontroller devices have a noise filter in the MCLR Reset path which detects and ignores small pulses.

The MCLR pin is not driven low by any internal Resets, including the WDT.

4.3 Power-on Reset (POR)

A Power-on Reset condition is generated on-chip whenever VDD rises above a certain threshold. This allows the device to start in the initialized state when VDD is adequate for operation.

To take advantage of the POR circuitry, tie the \overline{MCLR} pin through a resistor (1 k Ω to 10 k Ω) to VDD. This will eliminate external RC components usually needed to create a Power-on Reset delay. A minimum rise rate for VDD is specified (parameter D004). For a slow rise time, see Figure 4-2.

When the device starts normal operation (i.e., exits the Reset condition), device operating parameters (voltage, frequency, temperature, etc.) must be met to ensure operation. If these conditions are not met, the device must be held in Reset until the operating conditions are met.

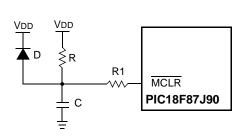
Power-on Reset events are captured by the POR bit (RCON<1>). The state of the bit is set to '0' whenever a Power-on Reset occurs; it does not change for any other Reset event. POR is not reset to '1' by any hardware event. To capture multiple events, the user manually resets the bit to '1' in software following any Power-on Reset.

4.4 Brown-out Reset (BOR)

The PIC18F87J90 family of devices incorporates a simple BOR function when the internal regulator is enabled (ENVREG pin is tied to VDD). The voltage regulator will trigger a Brown-out Reset when output of the regulator to the device core approaches the voltage at which the device is unable to run at full speed. The BOR circuit also keeps the device in Reset as VDD rises, until the regulator's output level is sufficient for full-speed operation.

Once a BOR has occurred, the Power-up Timer will keep the chip in Reset for TPWRT (parameter 33). If VDD drops below the threshold for full-speed operation while the Power-up Timer is running, the chip will go back into a Brown-out Reset and the Power-up Timer will be initialized. Once VDD rises to the point where regulator output is sufficient, the Power-up Timer will execute the additional time delay.

FIGURE 4-2: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP)



- Note 1: External Power-on Reset circuit is required only if the VDD power-up slope is too slow. The diode D helps discharge the capacitor quickly when VDD powers down.
 - 2: $R < 40 \text{ k}\Omega$ is recommended to make sure that the voltage drop across R does not violate the device's electrical specification.
 - 3: $R1 \ge 1$ k Ω will limit any current flowing into \overline{MCLR} from external capacitor C, in the event of \overline{MCLR}/VPP pin breakdown, due to Electrostatic Discharge (ESD) or Electrical Overstress (EOS).

4.4.1 DETECTING BOR

The BOR bit always resets to '0' on any Brown-out Reset or Power-on Reset event. This makes it difficult to determine if a Brown-out Reset event has occurred just by reading the state of BOR alone. A more reliable method is to simultaneously check the state of both POR and BOR. This assumes that the POR bit is reset to '1' in software immediately after any Power-on Reset event. If BOR is '0' while POR is '1', it can be reliably assumed that a Brown-out Reset event has occurred.

If the voltage regulator is disabled, Brown-out Reset functionality is disabled. In this case, the BOR bit cannot be used to determine a Brown-out Reset event. The BOR bit is still cleared by a Power-on Reset event.

4.5 Configuration Mismatch (CM)

The Configuration Mismatch (CM) Reset is designed to detect and attempt to recover from random, memory corrupting events. These include Electrostatic Discharge (ESD) events that can cause widespread, single bit changes throughout the device and result in catastrophic failure.

In PIC18FXXJ Flash devices, the device Configuration registers (located in the configuration memory space) are continuously monitored during operation by comparing their values to complimentary shadow registers. If a mismatch is detected between the two sets of registers, a CM Reset automatically occurs. These events are captured by the CM bit (RCON<5>). The state of the bit is set to '0' whenever a CM event occurs. The bit does not change for any other Reset event.

4.6 Power-up Timer (PWRT)

PIC18F87J90 family devices incorporate an on-chip Power-up Timer (PWRT) to help regulate the Power-on Reset process. The PWRT is always enabled. The main function is to ensure that the device voltage is stable before code is executed.

The Power-up Timer (PWRT) of the PIC18F87J90 family devices is an 11-bit counter which uses the INTRC source as the clock input. This yields an approximate time interval of 2048 x 32 μ s = 65.6 ms. While the PWRT is counting, the device is held in Reset.

The power-up time delay depends on the INTRC clock and will vary from chip to chip due to temperature and process variation. See DC parameter 33 for details.

4.6.1 TIME-OUT SEQUENCE

If enabled, the PWRT time-out is invoked after the POR pulse has cleared. The total time-out will vary based on the status of the PWRT. Figure 4-3, Figure 4-4, Figure 4-5 and Figure 4-6 all depict time-out sequences on power-up with the Power-up Timer enabled.

Since the time-outs occur from the POR pulse, if MCLR is kept low long enough, the PWRT will expire. Bringing MCLR high will begin execution immediately (Figure 4-5). This is useful for testing purposes, or to synchronize more than one PIC18FXXXX device operating in parallel.

FIGURE 4-3: TIME-OUT SEQUENCE ON POWER-UP (MCLR TIED TO VDD, VDD RISE < TPWRT)

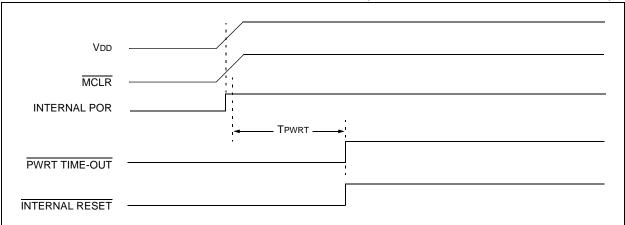
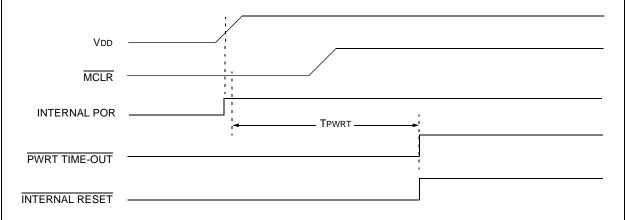


FIGURE 4-4: TIME-OUT SEQUENCE ON POWER-UP (MCLR NOT TIED TO VDD): CASE 1





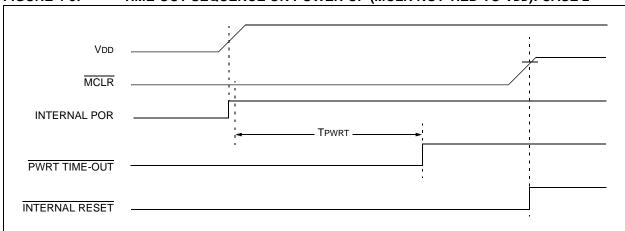
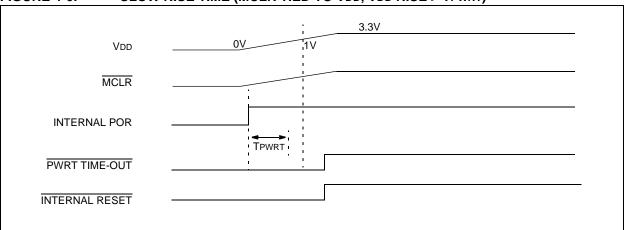


FIGURE 4-6: SLOW RISE TIME (MCLR TIED TO VDD, VDD RISE > TPWRT)



© 2009 Microchip Technology Inc. Preliminary DS39933C-page 51

4.7 Reset State of Registers

Most registers are unaffected by a Reset. Their status is unknown on POR and unchanged by all other Resets. The other registers are forced to a "Reset state" depending on the type of Reset that occurred.

Most registers are not affected by a WDT wake-up, since this is viewed as the resumption of normal operation. Status bits from the RCON register, \overline{Rl} , \overline{TO} , \overline{PD} , \overline{POR} and \overline{BOR} , are set or cleared differently in different Reset situations, as indicated in Table 4-1. These bits are used in software to determine the nature of the Reset.

Table 4-2 describes the Reset states for all of the Special Function Registers. These are categorized by Power-on and Brown-out Resets, Master Clear and WDT Resets and WDT wake-ups.

TABLE 4-1: STATUS BITS, THEIR SIGNIFICANCE AND THE INITIALIZATION CONDITION FOR RCON REGISTER

Condition	Program		RC	ON Regi	ster		STKPTR	Register
Condition	Counter ⁽¹⁾	RI	TO	PD	POR	BOR	STKFUL	STKUNF
Power-on Reset	0000h	1	1	1	0	0	0	0
RESET Instruction	0000h	0	u	u	u	u	u	u
Brown-out Reset	0000h	1	1	1	u	0	u	u
MCLR during power-managed Run modes	0000h	u	1	u	u	u	u	u
MCLR during power-managed Idle modes and Sleep mode	0000h	u	1	0	u	u	u	u
WDT time-out during full power or power-managed Run modes	0000h	u	0	u	u	u	u	u
MCLR during full power execution	0000h	u	u	u	u	u	u	u
Stack Full Reset (STVREN = 1)	0000h	u	u	u	u	u	1	u
Stack Underflow Reset (STVREN = 1)	0000h	u	u	u	u	u	u	1
Stack Underflow Error (not an actual Reset, STVREN = 0)	0000h	u	u	u	u	u	u	1
WDT time-out during power-managed Idle or Sleep modes	PC + 2	u	0	0	u	u	u	u
Interrupt exit from power-managed modes	PC + 2	u	u	0	u	u	u	u

Legend: u = unchanged

Note 1: When the wake-up is due to an interrupt and the GIEH or GIEL bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).

TABLE 4-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS

Register	Applicabl	e Devices	Power-on Reset, Brown-out Reset	MCLR Resets WDT Reset RESET Instruction Stack Resets	Wake-up via WDT or Interrupt
TOSU	PIC18F6XJ90	PIC18F8XJ90	0 0000	0 0000	0 uuuu (1)
TOSH	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu ⁽¹⁾
TOSL	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu (1)
STKPTR	PIC18F6XJ90	PIC18F8XJ90	uu-0 0000	00-0 0000	uu-u uuuu ⁽¹⁾
PCLATU	PIC18F6XJ90	PIC18F8XJ90	0 0000	0 0000	u uuuu
PCLATH	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu
PCL	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	PC + 2 ⁽²⁾
TBLPTRU	PIC18F6XJ90	PIC18F8XJ90	00 0000	00 0000	uu uuuu
TBLPTRH	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu
TBLPTRL	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu
TABLAT	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu
PRODH	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
PRODL	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
INTCON	PIC18F6XJ90	PIC18F8XJ90	0000 000x	0000 000u	uuuu uuuu ⁽³⁾
INTCON2	PIC18F6XJ90	PIC18F8XJ90	1111 1111	1111 1111	uuuu uuuu ⁽³⁾
INTCON3	PIC18F6XJ90	PIC18F8XJ90	1100 0000	1100 0000	uuuu uuuu ⁽³⁾
INDF0	PIC18F6XJ90	PIC18F8XJ90	N/A	N/A	N/A
POSTINC0	PIC18F6XJ90	PIC18F8XJ90	N/A	N/A	N/A
POSTDEC0	PIC18F6XJ90	PIC18F8XJ90	N/A	N/A	N/A
PREINC0	PIC18F6XJ90	PIC18F8XJ90	N/A	N/A	N/A
PLUSW0	PIC18F6XJ90	PIC18F8XJ90	N/A	N/A	N/A
FSR0H	PIC18F6XJ90	PIC18F8XJ90	xxxx	uuuu	uuuu
FSR0L	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
WREG	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
INDF1	PIC18F6XJ90	PIC18F8XJ90	N/A	N/A	N/A
POSTINC1	PIC18F6XJ90	PIC18F8XJ90	N/A	N/A	N/A
POSTDEC1	PIC18F6XJ90	PIC18F8XJ90	N/A	N/A	N/A
PREINC1	PIC18F6XJ90	PIC18F8XJ90	N/A	N/A	N/A
PLUSW1	PIC18F6XJ90	PIC18F8XJ90	N/A	N/A	N/A

- Note 1: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.
 - 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
 - 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
 - **4:** See Table 4-1 for Reset value for specific condition.
 - **5:** Bits 6 and 7 of PORTA, LATA and TRISA are enabled depending on the oscillator mode selected. When not enabled as PORTA pins, they are disabled and read as '0'.

TABLE 4-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

IABLL 4-2.	4-2. INTIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)					
Register	Applicabl	e Devices	Power-on Reset, Brown-out Reset	MCLR Resets WDT Reset RESET Instruction Stack Resets	Wake-up via WDT or Interrupt	
FSR1H	PIC18F6XJ90	PIC18F8XJ90	xxxx	uuuu	uuuu	
FSR1L	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu	
BSR	PIC18F6XJ90	PIC18F8XJ90	0000	0000	uuuu	
INDF2	PIC18F6XJ90	PIC18F8XJ90	N/A	N/A	N/A	
POSTINC2	PIC18F6XJ90	PIC18F8XJ90	N/A	N/A	N/A	
POSTDEC2	PIC18F6XJ90	PIC18F8XJ90	N/A	N/A	N/A	
PREINC2	PIC18F6XJ90	PIC18F8XJ90	N/A	N/A	N/A	
PLUSW2	PIC18F6XJ90	PIC18F8XJ90	N/A	N/A	N/A	
FSR2H	PIC18F6XJ90	PIC18F8XJ90	xxxx	uuuu	uuuu	
FSR2L	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu	
STATUS	PIC18F6XJ90	PIC18F8XJ90	x xxxx	u uuuu	u uuuu	
TMR0H	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu	
TMR0L	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu	
T0CON	PIC18F6XJ90	PIC18F8XJ90	1111 1111	1111 1111	uuuu uuuu	
OSCCON	PIC18F6XJ90	PIC18F8XJ90	0110 q000	0110 q000	uuuu quuu	
LCDREG	PIC18F6XJ90	PIC18F8XJ90	-011 1100	-011 1000	-uuu uuuu	
WDTCON	PIC18F6XJ90	PIC18F8XJ90	00	00	uu	
RCON ⁽⁴⁾	PIC18F6XJ90	PIC18F8XJ90	0-11 11q0	0-0q qquu	u-uu qquu	
TMR1H	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu	
TMR1L	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu	
T1CON	PIC18F6XJ90	PIC18F8XJ90	0000 0000	u0uu uuuu	uuuu uuuu	
TMR2	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu	
PR2	PIC18F6XJ90	PIC18F8XJ90	1111 1111	1111 1111	1111 1111	
T2CON	PIC18F6XJ90	PIC18F8XJ90	-000 0000	-000 0000	-uuu uuuu	
SSPBUF	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu	
SSPADD	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu	
SSPSTAT	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu	
SSPCON1	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu	
SSPCON2	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu	

- Note 1: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.
 - 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
 - **3:** One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
 - **4:** See Table 4-1 for Reset value for specific condition.
 - **5:** Bits 6 and 7 of PORTA, LATA and TRISA are enabled depending on the oscillator mode selected. When not enabled as PORTA pins, they are disabled and read as '0'.

TABLE 4-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices		Power-on Reset, Brown-out Reset	MCLR Resets WDT Reset RESET Instruction Stack Resets	Wake-up via WDT or Interrupt
ADRESH	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
ADRESL	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
ADCON0	PIC18F6XJ90	PIC18F8XJ90	0-00 0000	0-00 0000	u-uu uuuu
ADCON1	PIC18F6XJ90	PIC18F8XJ90	0-00 0000	0-00 0000	u-uu uuuu
ADCON2	PIC18F6XJ90	PIC18F8XJ90	0-00 0000	0-00 0000	u-uu uuuu
LCDDATA4	PIC18F6XJ90	PIC18F8XJ90	x	u	u
LCDDATA4	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA3	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA2	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA1	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA0	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDSE5	PIC18F6XJ90	PIC18F8XJ90	0000 0000	uuuu uuuu	uuuu uuuu
LCDSE4	PIC18F6XJ90	PIC18F8XJ90	0	u	u
LCDSE4	PIC18F6XJ90	PIC18F8XJ90	0000 0000	uuuu uuuu	uuuu uuuu
LCDSE3	PIC18F6XJ90	PIC18F8XJ90	0000 0000	uuuu uuuu	uuuu uuuu
LCDSE2	PIC18F6XJ90	PIC18F8XJ90	0000 0000	uuuu uuuu	uuuu uuuu
LCDSE1	PIC18F6XJ90	PIC18F8XJ90	0000 0000	uuuu uuuu	uuuu uuuu
CVRCON	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu
CMCON	PIC18F6XJ90	PIC18F8XJ90	0000 0111	0000 0111	uuuu uuuu
TMR3H	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR3L	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
T3CON	PIC18F6XJ90	PIC18F8XJ90	0000 0000	uuuu uuuu	uuuu uuuu
SPBRG1	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu
RCREG1	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu
TXREG1	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu
TXSTA1	PIC18F6XJ90	PIC18F8XJ90	0000 0010	0000 0010	uuuu uuuu
RCSTA1	PIC18F6XJ90	PIC18F8XJ90	0000 000x	0000 000x	uuuu uuuu
LCDPS	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu
LCDSE0	PIC18F6XJ90	PIC18F8XJ90	0000 0000	uuuu uuuu	uuuu uuuu
LCDCON	PIC18F6XJ90	PIC18F8XJ90	000- 0000	000- 0000	uuu- uuuu
EECON2	PIC18F6XJ90	PIC18F8XJ90			
EECON1	PIC18F6XJ90	PIC18F8XJ90	0 x00-	0 u00-	0 u00-

- Note 1: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.
 - 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
 - 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
 - **4:** See Table 4-1 for Reset value for specific condition.
 - **5:** Bits 6 and 7 of PORTA, LATA and TRISA are enabled depending on the oscillator mode selected. When not enabled as PORTA pins, they are disabled and read as '0'.

TABLE 4-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices		Power-on Reset, Brown-out Reset	MCLR Resets WDT Reset RESET Instruction Stack Resets	Wake-up via WDT or Interrupt
IPR3	PIC18F6XJ90	PIC18F8XJ90	-111 1111	-111 1111	-uuu 1111
PIR3	PIC18F6XJ90	PIC18F8XJ90	-000 0000	-000 0000	-uuu 0000 ⁽³⁾
PIE3	PIC18F6XJ90	PIC18F8XJ90	-000 0000	-000 0000	-uuu 0000
IPR2	PIC18F6XJ90	PIC18F8XJ90	11 111-	11 111-	uu uuu-
PIR2	PIC18F6XJ90	PIC18F8XJ90	00 000-	00 000-	uu uuu- ⁽³⁾
PIE2	PIC18F6XJ90	PIC18F8XJ90	00 000-	00 000-	uu uuu-
IPR1	PIC18F6XJ90	PIC18F8XJ90	-111 1-11	-111 1-11	-uuu u-uu
PIR1	PIC18F6XJ90	PIC18F8XJ90	-000 0-00	-000 0-00	-uuu u-uu ⁽³⁾
PIE1	PIC18F6XJ90	PIC18F8XJ90	-000 0-00	-000 0-00	-uuu u-uu
OSCTUNE	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu
TRISJ	PIC18F6XJ90	PIC18F8XJ90	1111 1111	1111 1111	uuuu uuuu
TRISH	PIC18F6XJ90	PIC18F8XJ90	1111 1111	1111 1111	uuuu uuuu
TRISG	PIC18F6XJ90	PIC18F8XJ90	0001 1111	0001 1111	uuuu uuuu
TRISF	PIC18F6XJ90	PIC18F8XJ90	1111 111-	1111 111-	uuuu uuu-
TRISE	PIC18F6XJ90	PIC18F8XJ90	1111 1-11	1111 1-11	uuuu u-uu
TRISD	PIC18F6XJ90	PIC18F8XJ90	1111 1111	1111 1111	uuuu uuuu
TRISC	PIC18F6XJ90	PIC18F8XJ90	1111 1111	1111 1111	uuuu uuuu
TRISB	PIC18F6XJ90	PIC18F8XJ90	1111 1111	1111 1111	uuuu uuuu
TRISA ⁽⁵⁾	PIC18F6XJ90	PIC18F8XJ90	1111 1111 ⁽⁵⁾	1111 1111(5)	uuuu uuuu(5)
LATJ	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATH	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATG	PIC18F6XJ90	PIC18F8XJ90	00-x xxxx	00-u uuuu	uu-u uuuu
LATF	PIC18F6XJ90	PIC18F8XJ90	xxxx xxx-	uuuu uuu-	uuuu uuu-
LATE	PIC18F6XJ90	PIC18F8XJ90	xxxx x-xx	uuuu u-uu	uuuu u-uu
LATD	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATC	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATB	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATA ⁽⁵⁾	PIC18F6XJ90	PIC18F8XJ90	XXXX XXXX ⁽⁵⁾	uuuu uuuu(5)	uuuu uuuu(5)
PORTJ	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTH	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTG	PIC18F6XJ90	PIC18F8XJ90	000x xxxx	000u uuuu	000u uuuu
PORTF	PIC18F6XJ90	PIC18F8XJ90	xxxx xxx-	uuuu uuu-	uuuu uuu-

- **Note 1:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.
 - 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
 - 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
 - 4: See Table 4-1 for Reset value for specific condition.
 - **5:** Bits 6 and 7 of PORTA, LATA and TRISA are enabled depending on the oscillator mode selected. When not enabled as PORTA pins, they are disabled and read as '0'.

TABLE 4-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices		Power-on Reset, Brown-out Reset	MCLR Resets WDT Reset RESET Instruction Stack Resets	Wake-up via WDT or Interrupt
PORTE	PIC18F6XJ90	PIC18F8XJ90	XXXX X-XX	uuuu u-uu	uuuu u-uu
PORTD	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTC	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTB	PIC18F6XJ90	PIC18F8XJ90	XXXX XXXX	uuuu uuuu	uuuu uuuu
PORTA ⁽⁵⁾	PIC18F6XJ90	PIC18F8XJ90	xx0x 0000 ⁽⁵⁾	uu0u 0000 ⁽⁵⁾	uuuu uuuu ⁽⁵⁾
SPBRGH1	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu
BAUDCON1	PIC18F6XJ90	PIC18F8XJ90	0100 0-00	0100 0-00	uuuu u-uu
LCDDATA23	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA22	PIC18F6XJ90	PIC18F8XJ90	x	u	u
LCDDATA22	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA21	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA20	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA19	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA18	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA17	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA16	PIC18F6XJ90	PIC18F8XJ90	x	u	u
LCDDATA16	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA15	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA14	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA13	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA12	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA11	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA10	PIC18F6XJ90	PIC18F8XJ90	x	u	u
LCDDATA10	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA9	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA8	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA7	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA6	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
LCDDATA5	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR1H	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR1L	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP1CON	PIC18F6XJ90	PIC18F8XJ90	00 0000	00 0000	uu uuuu
CCPR2H	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
		-			

- **Note 1:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.
 - 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
 - 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
 - **4:** See Table 4-1 for Reset value for specific condition.
 - **5:** Bits 6 and 7 of PORTA, LATA and TRISA are enabled depending on the oscillator mode selected. When not enabled as PORTA pins, they are disabled and read as '0'.

TABLE 4-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices		Power-on Reset, Brown-out Reset	MCLR Resets WDT Reset RESET Instruction Stack Resets	Wake-up via WDT or Interrupt
CCPR2L	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP2CON	PIC18F6XJ90	PIC18F8XJ90	00 0000	00 0000	uu uuuu
SPBRG2	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu
RCREG2	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu
TXREG2	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu
TXSTA2	PIC18F6XJ90	PIC18F8XJ90	0000 -010	0000 -010	uuuu -uuu
RCSTA2	PIC18F6XJ90	PIC18F8XJ90	0000 000x	0000 000x	uuuu uuuu
RTCCFG	PIC18F6XJ90	PIC18F8XJ90	0-00 0000	0-00 0000	u-uu uuuu
RTCCAL	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu
RTCVALH	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
RTCVALL	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
ALRMCFG	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu
ALRMRPT	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu
ALRMVALH	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
ALRMVALL	PIC18F6XJ90	PIC18F8XJ90	xxxx xxxx	uuuu uuuu	uuuu uuuu
CTMUCONH	PIC18F6XJ90	PIC18F8XJ90	0-00 0000	0-00 0000	u-uu uuuu
CTMUCONL	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu
CTMUICONH	PIC18F6XJ90	PIC18F8XJ90	0000 0000	0000 0000	uuuu uuuu
PADCFG1	PIC18F6XJ90	PIC18F8XJ90	00-	00-	uu-

- $\label{eq:unchanged} \begin{tabular}{ll} u = unchanged, x = unknown, $-$ = unimplemented bit, read as `0', q = value depends on condition. \\ Shaded cells indicate conditions do not apply for the designated device. \\ \end{tabular}$
- Note 1: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.
 - 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
 - **3:** One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
 - 4: See Table 4-1 for Reset value for specific condition.
 - **5:** Bits 6 and 7 of PORTA, LATA and TRISA are enabled depending on the oscillator mode selected. When not enabled as PORTA pins, they are disabled and read as '0'.

5.0 MEMORY ORGANIZATION

There are two types of memory in PIC18 Flash microcontroller devices:

- Program Memory
- Data RAM

As Harvard architecture devices, the data and program memories use separate busses; this allows for concurrent access of the two memory spaces.

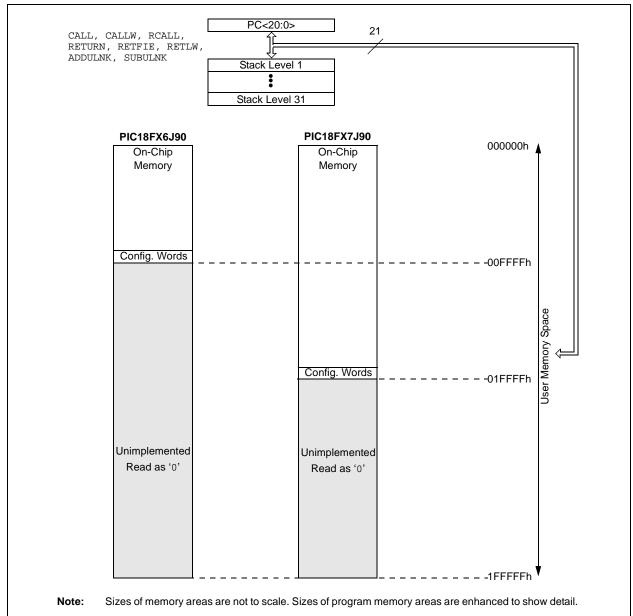
Additional detailed information on the operation of the Flash program memory is provided in **Section 6.0** "Flash Program Memory".

5.1 Program Memory Organization

PIC18 microcontrollers implement a 21-bit program counter which is capable of addressing a 2-Mbyte program memory space. Accessing a location between the upper boundary of the physically implemented memory and the 2-Mbyte address will return all '0's (a NOP instruction).

The entire PIC18F87J90 family offers a range of on-chip Flash program memory sizes, from 64 Kbytes (up to 16,384 single-word instructions) to 128 Kbytes (65,536 single-word instructions). The program memory maps for individual family members are shown in Figure 5-1.

FIGURE 5-1: MEMORY MAPS FOR PIC18F87J90 FAMILY DEVICES



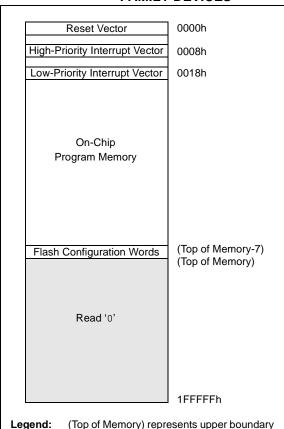
5.1.1 HARD MEMORY VECTORS

All PIC18 devices have a total of three hard-coded return vectors in their program memory space. The Reset vector address is the default value to which the program counter returns on all device Resets; it is located at 0000h.

PIC18 devices also have two interrupt vector addresses for the handling of high-priority and low-priority interrupts. The high-priority interrupt vector is located at 0008h and the low-priority interrupt vector is at 0018h. Their locations in relation to the program memory map are shown in Figure 5-2.

FIGURE 5-2:

HARD VECTOR AND CONFIGURATION WORD LOCATIONS FOR PIC18F87J90 FAMILY FAMILY DEVICES



of on-chip program memory space (see Figure 5-1 for device-specific values). Shaded area represents unimplemented memory. Areas are not shown to scale.

5.1.2 FLASH CONFIGURATION WORDS

Because PIC18F87J90 family devices do not have persistent configuration memory, the top four words of on-chip program memory are reserved for configuration information. On Reset, the configuration information is copied into the Configuration registers.

The Configuration Words are stored in their program memory location in numerical order, starting with the lower byte of CONFIG1 at the lowest address and ending with the upper byte of CONFIG4. For these devices, only Configuration Words, CONFIG1 through CONFIG3, are used; CONFIG4 is reserved. The actual addresses of the Flash Configuration Word for devices in the PIC18F87J90 family are shown in Table 5-1. Their location in the memory map is shown with the other memory vectors in Figure 5-2.

Additional details on the device Configuration Words are provided in **Section 24.1** "Configuration Bits".

TABLE 5-1: FLASH CONFIGURATION WORD FOR PIC18F87J90 FAMILY DEVICES

Device	Program Memory (Kbytes)	Configuration Word Addresses	
PIC18F66J90	64	FFF8h to FFFFh	
PIC18F86J90	04	FFFOII (U FFFFII	
PIC18F67J90	128	1FFF8h to 1FFFFh	
PIC18F87J90	120		

PROGRAM COUNTER 5.1.3

The Program Counter (PC) specifies the address of the instruction to fetch for execution. The PC is 21 bits wide and is contained in three separate 8-bit registers. The low byte, known as the PCL register, is both readable and writable. The high byte, or PCH register, contains the PC<15:8> bits; it is not directly readable or writable. Updates to the PCH register are performed through the PCLATH register. The upper byte is called PCU. This register contains the PC<20:16> bits; it is also not directly readable or writable. Updates to the PCU register are performed through the PCLATU register.

The contents of PCLATH and PCLATU are transferred to the program counter by any operation that writes PCL. Similarly, the upper two bytes of the program counter are transferred to PCLATH and PCLATU by an operation that reads PCL. This is useful for computed offsets to the PC (see Section 5.1.6.1 "Computed GOTO").

The PC addresses bytes in the program memory. To prevent the PC from becoming misaligned with word instructions, the Least Significant bit of PCL is fixed to a value of '0'. The PC increments by 2 to address sequential instructions in the program memory.

The CALL, RCALL, GOTO and program branch instructions write to the program counter directly. For these instructions, the contents of PCLATH and PCLATU are not transferred to the program counter.

5.1.4 RETURN ADDRESS STACK

The return address stack allows any combination of up to 31 program calls and interrupts to occur. The PC is pushed onto the stack when a CALL or RCALL instruction is executed, or an interrupt is Acknowledged. The PC value is pulled off the stack on a RETURN, RETLW or a RETFIE instruction (and on ADDULNK and SUBULNK instructions if the extended instruction set is enabled). PCLATU and PCLATH are not affected by any of the RETURN or CALL instructions.

The stack operates as a 31-word by 21-bit RAM and a 5-bit Stack Pointer, STKPTR. The stack space is not part of either program or data space. The Stack Pointer is readable and writable and the address on the top of the stack is readable and writable through the Top-of-Stack Special Function Registers. Data can also be pushed to, or popped from the stack, using these registers.

A CALL type instruction causes a push onto the stack. The Stack Pointer is first incremented and the location pointed to by the Stack Pointer is written with the contents of the PC (already pointing to the instruction following the CALL). A RETURN type instruction causes a pop from the stack. The contents of the location pointed to by the STKPTR are transferred to the PC and then the Stack Pointer is decremented.

The Stack Pointer is initialized to '00000' after all Resets. There is no RAM associated with the location corresponding to a Stack Pointer value of '00000'; this is only a Reset value. Status bits indicate if the stack is full, has overflowed or has underflowed.

5.1.4.1 Top-of-Stack Access

Only the top of the return address stack (TOS) is readable and writable. A set of three registers, TOSU:TOSH:TOSL, holds the contents of the stack location pointed to by the STKPTR register (Figure 5-3). This allows users to implement a software stack if necessary. After a CALL, RCALL or interrupt (and ADDULNK and SUBULNK instructions if the extended instruction set is enabled), the software can read the pushed value by reading TOSU:TOSH:TOSL registers. These values can be placed on a user-defined software stack. At return time, software can return these values to TOSU:TOSH:TOSL and do a return.

The user must disable the global interrupt enable bits while accessing the stack to prevent inadvertent stack corruption.

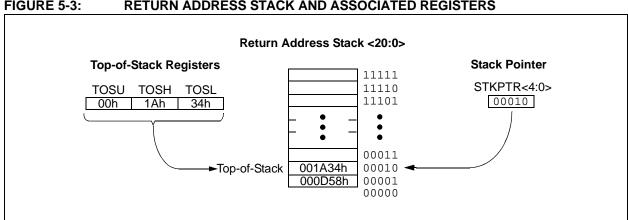


FIGURE 5-3: RETURN ADDRESS STACK AND ASSOCIATED REGISTERS

5.1.4.2 Return Stack Pointer (STKPTR)

The STKPTR register (Register 5-1) contains the Stack Pointer value, the STKFUL (Stack Full) status bit and the STKUNF (Stack Underflow) status bits. The value of the Stack Pointer can be 0 through 31. The Stack Pointer increments before values are pushed onto the stack and decrements after values are popped off the stack. On Reset, the Stack Pointer value will be zero. The user may read and write the Stack Pointer value. This feature can be used by a Real-Time Operating System (RTOS) for return stack maintenance.

After the PC is pushed onto the stack 31 times (without popping any values off the stack), the STKFUL bit is set. The STKFUL bit is cleared by software or by a POR.

The action that takes place when the stack becomes full depends on the state of the STVREN (Stack Overflow Reset Enable) Configuration bit. (Refer to Section 24.1 "Configuration Bits" for a description of the device Configuration bits.) If STVREN is set (default), the 31st push will push the (PC + 2) value onto the stack, set the STKFUL bit and reset the device. The STKFUL bit will remain set and the Stack Pointer will be set to zero.

If STVREN is cleared, the STKFUL bit will be set on the 31st push and the Stack Pointer will increment to 31. Any additional pushes will not overwrite the 31st push and the STKPTR will remain at 31.

When the stack has been popped enough times to unload the stack, the next pop will return a value of zero to the PC and set the STKUNF bit, while the Stack Pointer remains at zero. The STKUNF bit will remain set until cleared by software or until a POR occurs.

Note: Returning a value of zero to the PC on an underflow has the effect of vectoring the program to the Reset vector, where the stack conditions can be verified and appropriate actions can be taken. This is not the same as a Reset, as the contents of the SFRs are not affected.

5.1.4.3 PUSH and POP Instructions

Since the Top-of-Stack is readable and writable, the ability to push values onto the stack and pull values off the stack, without disturbing normal program execution, is a desirable feature. The PIC18 instruction set includes two instructions, PUSH and POP, that permit the TOS to be manipulated under software control. TOSU, TOSH and TOSL can be modified to place data or a return address on the stack.

The PUSH instruction places the current PC value onto the stack. This increments the Stack Pointer and loads the current PC value onto the stack.

The POP instruction discards the current TOS by decrementing the Stack Pointer. The previous value pushed onto the stack then becomes the TOS value.

REGISTER 5-1: STKPTR: STACK POINTER REGISTER

R/C-0	R/C-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
STKFUL ⁽¹⁾	STKUNF ⁽¹⁾	_	SP4	SP3	SP2	SP1	SP0
bit 7							bit 0

Legend:	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 STKFUL: Stack Full Flag bit⁽¹⁾

1 = Stack became full or overflowed

0 = Stack has not become full or overflowed

bit 6 **STKUNF**: Stack Underflow Flag bit⁽¹⁾

1 = Stack underflow occurred 0 = Stack underflow did not occur Unimplemented: Read as '0'

bit 4-0 **SP<4:0>:** Stack Pointer Location bits

Note 1: Bit 7 and bit 6 are cleared by user software or by a POR.

bit 5

5.1.4.4 Stack Full and Underflow Resets

Device Resets on stack overflow and stack underflow conditions are enabled by setting the STVREN bit in Configuration Register 1L. When STVREN is set, a full or underflow condition will set the appropriate STKFUL or STKUNF bit and then cause a device Reset. When STVREN is cleared, a full or underflow condition will set the appropriate STKFUL or STKUNF bit, but not cause a device Reset. The STKFUL or STKUNF bits are cleared by the user software or a Power-on Reset.

5.1.5 FAST REGISTER STACK

A Fast Register Stack is provided for the STATUS, WREG and BSR registers to provide a "fast return" option for interrupts. This stack is only one level deep and is neither readable nor writable. It is loaded with the current value of the corresponding register when the processor vectors for an interrupt. All interrupt sources will push values into the Stack registers. The values in the registers are then loaded back into the working registers if the RETFIE, FAST instruction is used to return from the interrupt.

If both low and high-priority interrupts are enabled, the Stack registers cannot be used reliably to return from low-priority interrupts. If a high-priority interrupt occurs while servicing a low-priority interrupt, the Stack register values stored by the low-priority interrupt will be overwritten. In these cases, users must save the key registers in software during a low-priority interrupt.

If interrupt priority is not used, all interrupts may use the Fast Register Stack for returns from interrupt. If no interrupts are used, the Fast Register Stack can be used to restore the STATUS, WREG and BSR registers at the end of a subroutine call. To use the Fast Register Stack for a subroutine call, a CALL label, FAST instruction must be executed to save the STATUS, WREG and BSR registers to the Fast Register Stack. A RETURN, FAST instruction is then executed to restore these registers from the Fast Register Stack.

Example 5-1 shows a source code example that uses the Fast Register Stack during a subroutine call and return.

EXAMPLE 5-1: FAST REGISTER STACK CODE EXAMPLE

CALL SUB1, FAST	;STATUS, WREG, BSR ;SAVED IN FAST REGISTER ;STACK
SUB1 • RETURN FAST	;RESTORE VALUES SAVED ;IN FAST REGISTER STACK

5.1.6 LOOK-UP TABLES IN PROGRAM MEMORY

There may be programming situations that require the creation of data structures, or look-up tables, in program memory. For PIC18 devices, look-up tables can be implemented in two ways:

- Computed GOTO
- Table Reads

5.1.6.1 Computed GOTO

A computed GOTO is accomplished by adding an offset to the program counter. An example is shown in Example 5-2.

A look-up table can be formed with an ADDWF PCL instruction and a group of RETLW nn instructions. The W register is loaded with an offset into the table before executing a call to that table. The first instruction of the called routine is the ADDWF PCL instruction. The next instruction executed will be one of the RETLW nn instructions that returns the value 'nn' to the calling function.

The offset value (in WREG) specifies the number of bytes that the program counter should advance and should be multiples of 2 (LSb = 0).

In this method, only one data byte may be stored in each instruction location and room on the return address stack is required.

EXAMPLE 5-2: COMPUTED GOTO USING AN OFFSET VALUE

	MOVF	OFFSET,	W
	CALL	TABLE	
ORG	nn00h		
TABLE	ADDWF	PCL	
	RETLW	nnh	
	RETLW	nnh	
	RETLW	nnh	
	•		

5.1.6.2 Table Reads

A better method of storing data in program memory allows two bytes of data to be stored in each instruction location.

Look-up table data may be stored two bytes per program word while programming. The Table Pointer (TBLPTR) specifies the byte address and the Table Latch (TABLAT) contains the data that is read from the program memory. Data is transferred from program memory one byte at a time.

Table read operation is discussed further in **Section 6.1** "Table Reads and Table Writes".

5.2 PIC18 Instruction Cycle

5.2.1 CLOCKING SCHEME

The microcontroller clock input, whether from an internal or external source, is internally divided by four to generate four non-overlapping quadrature clocks (Q1, Q2, Q3 and Q4). Internally, the program counter is incremented on every Q1; the instruction is fetched from the program memory and latched into the Instruction Register (IR) during Q4. The instruction is decoded and executed during the following Q1 through Q4. The clocks and instruction execution flow are shown in Figure 5-4.

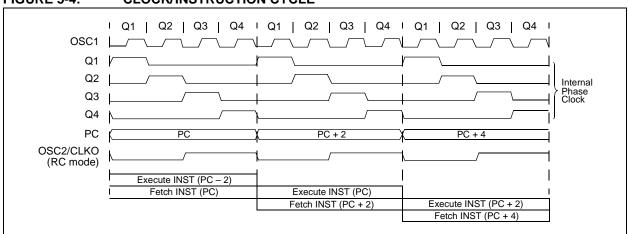
5.2.2 INSTRUCTION FLOW/PIPELINING

An "Instruction Cycle" consists of four Q cycles, Q1 through Q4. The instruction fetch and execute are pipelined in such a manner that a fetch takes one instruction cycle, while the decode and execute take another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction causes the program counter to change (e.g., GOTO), then two cycles are required to complete the instruction (Example 5-3).

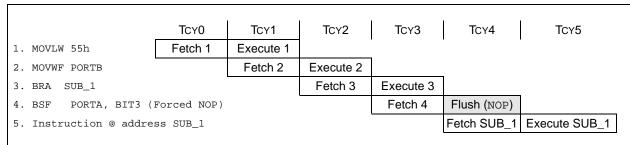
A fetch cycle begins with the Program Counter (PC) incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the Instruction Register (IR) in cycle Q1. This instruction is then decoded and executed during the Q2, Q3 and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).





EXAMPLE 5-3: INSTRUCTION PIPELINE FLOW



All instructions are single cycle, except for any program branches. These take two cycles since the fetch instruction is "flushed" from the pipeline while the new instruction is being fetched and then executed.

5.2.3 INSTRUCTIONS IN PROGRAM MEMORY

The program memory is addressed in bytes. Instructions are stored as two bytes or four bytes in program memory. The Least Significant Byte of an instruction word is always stored in a program memory location with an even address (LSB = 0). To maintain alignment with instruction boundaries, the PC increments in steps of 2 and the LSB will always read '0' (see **Section 5.1.3** "**Program Counter**").

Figure 5-5 shows an example of how instruction words are stored in the program memory.

The CALL and GOTO instructions have the absolute program memory address embedded into the instruction. Since instructions are always stored on word boundaries, the data contained in the instruction is a word address. The word address is written to PC<20:1> which accesses the desired byte address in program memory. Instruction #2 in Figure 5-5 shows how the instruction, GOTO 0006h, is encoded in the program memory. Program branch instructions, which encode a relative address offset, operate in the same manner. The offset value stored in a branch instruction represents the number of single-word instructions that the PC will be offset by. Section 25.0 "Instruction Set Summary" provides further details of the instruction set.

FIGURE 5-5: INSTRUCTIONS IN PROGRAM MEMORY

				LSB = 1	LSB = 0	Word Address
	Drogram N	laman,	Г	LOD = 1	LSB = 0	000000h
	Program M					
	Byte Locat	ions \rightarrow			000002h	
						000004h
						000006h
Instruction 1:	MOVLW	055h		0Fh	55h	000008h
Instruction 2:	GOTO	0006h		EFh	03h	00000Ah
				F0h	00h	00000Ch
Instruction 3:	MOVFF	123h, 4	156h	C1h	23h	00000Eh
				F4h	56h	000010h
						000012h
						000014h

5.2.4 TWO-WORD INSTRUCTIONS

The standard PIC18 instruction set has four two-word instructions: CALL, MOVFF, GOTO and LSFR. In all cases, the second word of the instructions always has '1111' as its four Most Significant bits; the other 12 bits are literal data, usually a data memory address.

The use of '1111' in the 4 MSbs of an instruction specifies a special form of NOP. If the instruction is executed in proper sequence – immediately after the first word – the data in the second word is accessed

and used by the instruction sequence. If the first word is skipped for some reason and the second word is executed by itself, a NOP is executed instead. This is necessary for cases when the two-word instruction is preceded by a conditional instruction that changes the PC. Example 5-4 shows how this works.

Note: See Section 5.5 "Program Memory and the Extended Instruction Set" for information on two-word instructions in the extended instruction set.

EXAMPLE 5-4: TWO-WORD INSTRUCTIONS

CASE 1:							
Object Code	Source Code						
0110 0110 0000 0000	TSTFSZ REG1	; is RAM location 0?					
1100 0001 0010 0011	MOVFF REG1, REG2	; No, skip this word					
1111 0100 0101 0110		; Execute this word as a NOP					
0010 0100 0000 0000	ADDWF REG3	; continue code					
CASE 2:							
Object Code	Source Code						
0110 0110 0000 0000	TSTFSZ REG1	; is RAM location 0?					
1100 0001 0010 0011	MOVFF REG1, REG2	; Yes, execute this word					
1111 0100 0101 0110		; 2nd word of instruction					
0010 0100 0000 0000	ADDWF REG3	; continue code					

5.3 Data Memory Organization

Note:

The operation of some aspects of data memory are changed when the PIC18 extended instruction set is enabled. See Section 5.6 "Data Memory and the Extended Instruction Set" for more information.

The data memory in PIC18 devices is implemented as static RAM. Each register in the data memory has a 12-bit address, allowing up to 4,096 bytes of data memory. The memory space is divided into as many as 16 banks that contain 256 bytes each. PIC18FX6J90 and PIC18FX7J90 devices implement all 16 complete banks, for a total of 4 Kbytes. Figure 5-6 and Figure 5-7 show the data memory organization for the devices.

The data memory contains Special Function Registers (SFRs) and General Purpose Registers (GPRs). The SFRs are used for control and status of the controller and peripheral functions, while GPRs are used for data storage and scratchpad operations in the user's application. Any read of an unimplemented location will read as '0's.

The instruction set and architecture allow operations across all banks. The entire data memory may be accessed by Direct, Indirect or Indexed Addressing modes. Addressing modes are discussed later in this section.

To ensure that commonly used registers (select SFRs and select GPRs) can be accessed in a single cycle, PIC18 devices implement an Access Bank. This is a 256-byte memory space that provides fast access to select SFRs and the lower portion of GPR Bank 0 without using the BSR. **Section 5.3.2 "Access Bank"** provides a detailed description of the Access RAM.

5.3.1 BANK SELECT REGISTER

Large areas of data memory require an efficient addressing scheme to make rapid access to any address possible. Ideally, this means that an entire address does not need to be provided for each read or write operation. For PIC18 devices, this is accomplished with a RAM banking scheme. This divides the memory space into 16 contiguous banks of 256 bytes. Depending on the instruction, each location can be addressed directly by its full 12-bit address, or an 8-bit low-order address and a 4-bit Bank Pointer.

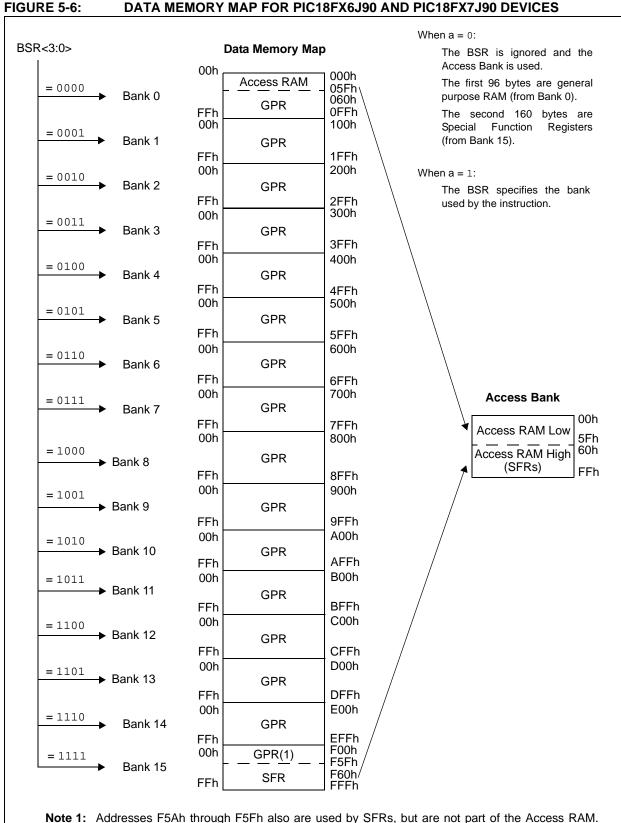
Most instructions in the PIC18 instruction set make use of the Bank Pointer, known as the Bank Select Register (BSR). This SFR holds the 4 Most Significant bits of a location's address; the instruction itself includes the 8 Least Significant bits. Only the four lower bits of the BSR are implemented (BSR<3:0>). The upper four bits are unused; they will always read '0' and cannot be written to. The BSR can be loaded directly by using the MOVLB instruction.

The value of the BSR indicates the bank in data memory. The 8 bits in the instruction show the location in the bank and can be thought of as an offset from the bank's lower boundary. The relationship between the BSR's value and the bank division in data memory is shown in Figure 5-7.

Since up to 16 registers may share the same low-order address, the user must always be careful to ensure that the proper bank is selected before performing a data read or write. For example, writing what should be program data to an 8-bit address of F9h while the BSR is 0Fh, will end up resetting the program counter.

While any bank can be selected, only those banks that are actually implemented can be read or written to. Writes to unimplemented banks are ignored, while reads from unimplemented banks will return '0's. Even so, the STATUS register will still be affected as if the operation was successful. The data memory map in Figure 5-6 indicates which banks are implemented.

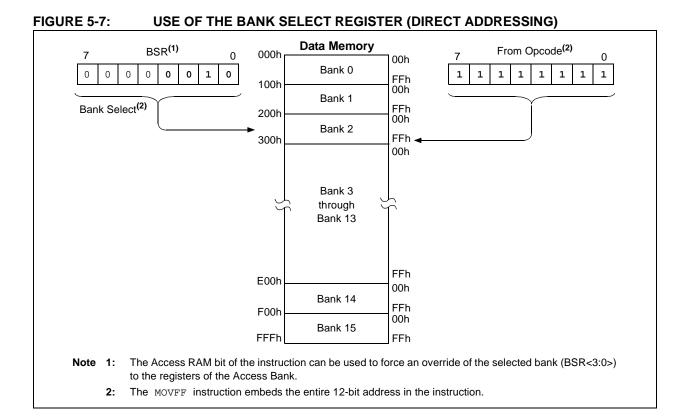
In the core PIC18 instruction set, only the <code>MOVFF</code> instruction fully specifies the 12-bit address of the source and target registers. This instruction ignores the BSR completely when it executes. All other instructions include only the low-order address as an operand and must use either the BSR or the Access Bank to locate their target registers.



DATA MEMORY MAP FOR PIC18FX6J90 AND PIC18FX7J90 DEVICES

registers.

Users must always use the complete address - or load the proper SBR value - to access these



5.3.2 ACCESS BANK

While the use of the BSR with an embedded 8-bit address allows users to address the entire range of data memory, it also means that the user must always ensure that the correct bank is selected. Otherwise, data may be read from, or written to, the wrong location. This can be disastrous if a GPR is the intended target of an operation, but an SFR is written to instead. Verifying and/or changing the BSR for each read or write to data memory can become very inefficient.

To streamline access for the most commonly used data memory locations, the data memory is configured with an Access Bank, which allows users to access a mapped block of memory without specifying a BSR. The Access Bank consists of the first 96 bytes of memory (00h-5Fh) in Bank 0 and the last 160 bytes of memory (60h-FFh) in Bank 15. The lower half is known as the "Access RAM" and is composed of GPRs. The upper half is where the device's SFRs are mapped. These two areas are mapped contiguously in the Access Bank and can be addressed in a linear fashion by an 8-bit address (Figure 5-6).

The Access Bank is used by core PIC18 instructions that include the Access RAM bit (the 'a' parameter in the instruction). When 'a' is equal to '1', the instruction uses the BSR and the 8-bit address included in the opcode for the data memory address. When 'a' is '0',

however, the instruction is forced to use the Access Bank address map; the current value of the BSR is ignored entirely.

Using this "forced" addressing allows the instruction to operate on a data address in a single cycle without updating the BSR first. For 8-bit addresses of 60h and above, this means that users can evaluate and operate on SFRs more efficiently. The Access RAM below 60h is a good place for data values that the user might need to access rapidly, such as immediate computational results or common program variables. Access RAM also allows for faster and more code efficient context saving and switching of variables.

The mapping of the Access Bank is slightly different when the extended instruction set is enabled (XINST Configuration bit = 1). This is discussed in more detail in Section 5.6.3 "Mapping the Access Bank in Indexed Literal Offset Mode".

5.3.3 GENERAL PURPOSE REGISTER FILE

PIC18 devices may have banked memory in the GPR area. This is data RAM which is available for use by all instructions. GPRs start at the bottom of Bank 0 (address 000h) and grow upwards towards the bottom of the SFR area. GPRs are not initialized by a Power-on Reset and are unchanged on all other Resets.

5.3.4 SPECIAL FUNCTION REGISTERS

The Special Function Registers (SFRs) are registers used by the CPU and peripheral modules for controlling the desired operation of the device. These registers are implemented as static RAM. SFRs start at the top of data memory (FFFh) and extend downward to occupy more than the top half of Bank 15 (F60h to FFFh). A list of these registers is given in Table 5-2 and Table 5-3.

The SFRs can be classified into two sets: those associated with the "core" device functionality (ALU, Resets and interrupts) and those related to the peripheral functions. The Reset and Interrupt registers are described in their respective chapters, while the ALU's STATUS register is described later in this section. Registers related to the operation of the peripheral features are described in the chapter for that peripheral.

The SFRs are typically distributed among the peripherals whose functions they control. Unused SFR locations are unimplemented and read as '0's.

TABLE 5-2: SPECIAL FUNCTION REGISTER MAP FOR PIC18F87J90 FAMILY DEVICES

Addr.	Name	Addr.	Name	Addr.	Name	Addr.	Name	Addr.	Name	Addr.	Name
FFFh	TOSU	FDFh	INDF2 ⁽¹⁾	FBFh	LCDDATA4 ⁽³⁾	F9Fh	IPR1	F7Fh	SPBRGH1	F5Fh	RTCCFG
FFEh	TOSH	FDEh	POSTINC2 ⁽¹⁾	FBEh	LCDDATA3	F9Eh	PIR1	F7Eh	BAUDCON1	F5Eh	RTCCAL
FFDh	TOSL	FDDh	POSTDEC2 ⁽¹⁾	FBDh	LCDDATA2	F9Dh	PIE1	F7Dh	LCDDATA23 ⁽³⁾	F5Dh	RTCVALH
FFCh	STKPTR	FDCh	PREINC2 ⁽¹⁾	FBCh	LCDDATA1	F9Ch	(2)	F7Ch	LCDDATA22 ⁽³⁾	F5Ch	RTCVALL
FFBh	PCLATU	FDBh	PLUSW2 ⁽¹⁾	FBBh	LCDDATA0	F9Bh	OSCTUNE	F7Bh	LCDDATA21	F5Bh	ALRMCFG
FFAh	PCLATH	FDAh	FSR2H	FBAh	LCDSE5 ⁽³⁾	F9Ah	TRISJ ⁽³⁾	F7Ah	LCDDATA20	F5Ah	ALRMRPT
FF9h	PCL	FD9h	FSR2L	FB9h	LCDSE4 ⁽³⁾	F99h	TRISH ⁽³⁾	F79h	LCDDATA19	F59h	ALRMVALH
FF8h	TBLPTRU	FD8h	STATUS	FB8h	LCDSE3	F98h	TRISG	F78h	LCDDATA18	F58h	ALRMVALL
FF7h	TBLPTRH	FD7h	TMR0H	FB7h	LCDSE2	F97h	TRISF	F77h	LCDDATA17 ⁽³⁾	F57h	CTMUCONH
FF6h	TBLPTRL	FD6h	TMR0L	FB6h	LCDSE1	F96h	TRISE	F76h	LCDDATA16 ⁽³⁾	F56h	CTMUCONL
FF5h	TABLAT	FD5h		FB5h	CVRCON	F95h	TRISD	F75h	LCDDATA15	F55h	CTMUICONH
FF4h	PRODH	FD4h	(2)	FB4h	CMCON	F94h	TRISC	F74h	LCDDATA14	F54h	PADCFG1
FF3h	PRODL	FD3h	OSCCON	FB3h	TMR3H	F93h	TRISB	F73h	LCDDATA13		
FF2h	INTCON	FD2h	LCDREG	FB2h	TMR3L	F92h	TRISA	F72h	LCDDATA12		
FF1h	INTCON2	FD1h	WDTCON	FB1h		F91h	LATJ ⁽³⁾	F71h	LCDDATA11 ⁽³⁾		
FF0h	INTCON3	FD0h	RCON	FB0h	_(2)	F90h	LATH ⁽³⁾	F70h	LCDDATA10 ⁽³⁾		
FEFh	INDF0 ⁽¹⁾	FCFh	TMR1H	FAFh	SPBRG1	F8Fh	LATG	F6Fh	LCDDATA9		
FEEh	POSTINC0 ⁽¹⁾	FCEh	TMR1L	FAEh	RCREG1	F8Eh	LATF	F6Eh	LCDDATA8		
FEDh	POSTDEC0 ⁽¹⁾	FCDh	T1CON	FADh	TXREG1	F8Dh	LATE	F6Dh	LCDDATA7		
FECh	PREINC0 ⁽¹⁾	FCCh	TMR2	FACh	TXSTA1	F8Ch	LATD	F6Ch	LCDDATA6		
FEBh	PLUSW0 ⁽¹⁾	FCBh	PR2	FABh	RCSTA1	F8Bh	LATC	F6Bh	LCDDATA5 ⁽³⁾		
FEAh	FSR0H	FCAh	T2CON	FAAh	LCDPS	F8Ah	LATB	F6Ah	CCPR1H		
FE9h	FSR0L	FC9h	SSPBUF	FA9h	LCDSE0	F89h		F69h	CCPR1L		
FE8h		FC8h	SSPADD	FA8h	LCDCON	F88h	PORTJ ⁽³⁾	F68h	CCP1CON		
FE7h	INDF1 ⁽¹⁾	FC7h	SSPSTAT	FA7h	EECON2	F87h	PORTH ⁽³⁾	F67h	CCPR2H		
FE6h	POSTINC1 ⁽¹⁾	FC6h	SSPCON1	FA6h	EECON1	F86h	PORTG	F66h	CCPR2L		
FE5h	POSTDEC1 ⁽¹⁾	FC5h	SSPCON2	FA5h	IPR3	F85h	PORTF	F65h	CCP2CON		
FE4h	PREINC1 ⁽¹⁾	FC4h	ADRESH	FA4h	PIR3	F84h	PORTE	F64h	SPBRG2		
FE3h	PLUSW1 ⁽¹⁾	FC3h	ADRESL	FA3h	PIE3	F83h	PORTD	F63h	RCREG2		
FE2h	FSR1H	FC2h	ADCON0	FA2h	IPR2	F82h	PORTC	F62h	TXREG2		
FE1h	FSR1L	FC1h	ADCON1	FA1h	PIR2	F81h	PORTB	F61h	TXSTA2		
FE0h	BSR	FC0h	ADCON2	FA0h	PIE2	F80h	PORTA	F60h	RCSTA2		

Note 1: This is not a physical register.

- 2: Unimplemented registers are read as '0'.
- 3: This register is not available on PIC18F6XJ90 devices.

TABLE 5-3: PIC18F87J90 FAMILY REGISTER FILE SUMMARY

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Details on page	
TOSU	_	0 0000	53, 61								
TOSH	Top-of-Stack	0000 0000	53, 61								
TOSL	Top-of-Stack	0000 0000	53, 61								
STKPTR	STKFUL	uu-0 0000	53, 62								
PCLATU	_	0 0000	53, 61								
PCLATH	Holding Regis	0000 0000	53, 61								
PCL	PC Low Byte	0000 0000	53, 61								
TBLPTRU	— bit 21 Program Memory Table Pointer Upper Byte (TBLPTR<20:16>)									53, 86	
TBLPTRH	Program Men	nory Table Poi	nter High Byte	e (TBLPTR<1	5:8>)				0000 0000	53, 86	
TBLPTRL	Program Men	nory Table Poi	nter Low Byte	(TBLPTR<7:	0>)				0000 0000	53, 86	
TABLAT	Program Men	nory Table Lat	ch						0000 0000	53, 86	
PRODH	Product Regis	ster High Byte							xxxx xxxx	53, 93	
PRODL	Product Regis	ster Low Byte							xxxx xxxx	53, 93	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	53, 97	
INTCON2	RBPU	INTEDG0	INTEDG1	INTEDG2	INTEDG3	TMR0IP	INT3IP	RBIP	1111 1111	53, 98	
INTCON3	INT2IP	INT1IP	INT3IE	INT2IE	INT1IE	INT3IF	INT2IF	INT1IF	1100 0000	53, 99	
INDF0	Uses contents	Uses contents of FSR0 to address data memory – value of FSR0 not changed (not a physical register)									
POSTINC0	Uses contents	s of FSR0 to a	ddress data r	nemory – valu	e of FSR0 pos	st-incremented	d (not a physic	al register)	N/A	53, 78	
POSTDEC0	Uses contents of FSR0 to address data memory – value of FSR0 post-decremented (not a physical register)									53, 78	
PREINC0	Uses contents of FSR0 to address data memory – value of FSR0 pre-incremented (not a physical register)								N/A	53, 78	
PLUSW0	Uses contents of FSR0 to address data memory – value of FSR0 pre-incremented (not a physical register) – value of FSR0 offset by W								N/A	53, 78	
FSR0H	_	_	_	_	Indirect Data	Memory Addre	ess Pointer 0	High Byte	xxxx	53, 77	
FSR0L	Indirect Data	Memory Addre	ess Pointer 0	Low Byte					xxxx xxxx	53, 77	
WREG	Working Regi	ster							xxxx xxxx	53	
INDF1	Uses contents	s of FSR1 to a	ddress data r	nemory – valu	e of FSR1 not	changed (not	a physical re	gister)	N/A	53, 77	
POSTINC1	Uses contents	s of FSR1 to a	ddress data r	nemory – valu	e of FSR1 pos	st-incremented	d (not a physic	al register)	N/A	53, 78	
POSTDEC1	Uses contents	s of FSR1 to a	ddress data n	nemory – valu	e of FSR1 pos	st-decremente	d (not a physi	cal register)	N/A	53, 78	
PREINC1	Uses contents	s of FSR1 to a	ddress data n	nemory – valu	e of FSR1 pre	-incremented	(not a physica	al register)	N/A	53, 78	
PLUSW1	Uses contents value of FSR	s of FSR1 to a 1 offset by W	ddress data r	nemory – valu	e of FSR1 pre	-incremented	(not a physica	al register) –	N/A	53, 78	
FSR1H	— — — Indirect Data Memory Address Pointer 1 High Byte									54, 77	
FSR1L	Indirect Data	Memory Addre	ess Pointer 1	Low Byte					xxxx xxxx	54, 77	
BSR	— — — Bank Select Register									54, 66	
INDF2	Uses contents of FSR2 to address data memory – value of FSR2 not changed (not a physical register)								N/A	54, 77	
POSTINC2	Uses contents of FSR2 to address data memory – value of FSR2 post-incremented (not a physical register)								N/A	54, 78	
POSTDEC2	Uses contents of FSR2 to address data memory – value of FSR2 post-decremented (not a physical register)								N/A	54, 78	
PREINC2	Uses content	s of FSR2 to a	ddress data n	nemory – valu	e of FSR2 pre	-incremented	(not a physica	al register)	N/A	54, 78	
PLUSW2	Uses contents of FSR2 to address data memory – value of FSR2 pre-incremented (not a physical register) – value of FSR2 offset by W									54, 78	
FSR2H	— — — Indirect Data Memory Address Pointer 2 High Byte									54, 77	
FSR2L	Indirect Data Memory Address Pointer 2 Low Byte								xxxx xxxx	54, 77	
STATUS	N OV Z DC C									54, 75	

 $\textbf{Legend:} \quad \textbf{x} = \text{unknown}, \textbf{u} = \text{unchanged}, \textbf{-} = \text{unimplemented}, \textbf{q} = \text{value depends on condition}, \textbf{r} = \text{reserved}, \text{do not modify}$

Note 1: Bit 21 of the PC is only available in Test mode and Serial Programming modes.

^{2:} These registers and/or bits are available only on 80-pin devices; otherwise they are unimplemented and read as '0'. Reset states shown are for 80-pin devices.

^{3:} Alternate names and definitions for these bits when the MSSP module is operating in I²C[™] Slave mode. See **Section 17.4.3.2 "Address Masking"** for details.

^{4:} The PLLEN bit is only available in specific oscillator configurations; otherwise, it is disabled and reads as '0'. See Section 2.4.3 "PLL Frequency Multiplier" for details.

^{5:} RA<7:6> and their associated latch and direction bits are configured as port pins only when the internal oscillator is selected as the default clock source (FOSC2 Configuration bit = 0); otherwise, they are disabled and these bits read as '0'.

TABLE 5-3: PIC18F87J90 FAMILY REGISTER FILE SUMMARY (CONTINUED)

IADLE 3-3		01 07 0 30		<u></u>			100	,		
File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Details on page
TMR0H	Timer0 Regis	ster High Byte							0000 0000	54, 135
TMR0L	Timer0 Regis	ster Low Byte							xxxx xxxx	54, 135
T0CON	TMR00N	T08BIT	T0CS	T0SE	PSA	T0PS2	T0PS1	T0PS0	1111 1111	54, 135
OSCCON	IDLEN	IRCF2	IRCF1	IRCF0	OSTS	IOFS	SCS1	SCS0	0110 q000	30, 54
LCDREG	_	CPEN	BIAS2	BIAS1	BIAS0	MODE13	CKSEL1	CKSEL0	-011 1100	54, 183
WDTCON	REGSLP	_	_	_	_	_	_	SWDTEN	0 0	54, 327
RCON	IPEN	_	CM	RI	TO	PD	POR	BOR	0-11 11q0	48, 54
TMR1H	Timer1 Regis	ter High Byte	I.		u .				xxxx xxxx	54, 141
TMR1L	Timer1 Regis	Firmer1 Register Low Byte							xxxx xxxx	54, 141
T1CON	RD16	T1RUN	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	0000 0000	54, 137
TMR2	Timer2 Regis	ster	I		1				0000 0000	54, 144
PR2	Timer2 Perio	d Register							1111 1111	54, 144
T2CON	_	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	54, 143
SSPBUF	MSSP Recei	ve Buffer/Tran	smit Register	l	l	l	l	1	xxxx xxxx	54, 213, 248
SSPADD	MSSP Addre	ss Register in	I ² C™ Slave n	node. MSSP1	Baud Rate Re	eload Register	in I ² C Master	mode.	0000 0000	54, 248
SSPSTAT	SMP	CKE	D/Ā	Р	S	R/W	UA	BF	0000 0000	54, 206, 215
SSPCON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	54, 207, 216
SSPCON2	N2 GCEN ACKSTAT ACKDT ACKEN RCEN PEN		RSEN	SEN	0000 0000	54, 217,				
	GCEN	ACKSTAT	ADMSK5 ⁽³⁾	ADMSK4 ⁽³⁾	ADMSK3 ⁽³⁾	ADMSK2 ⁽³⁾	ADMSK1 ⁽³⁾	SEN		218
ADRESH	A/D Result R	egister High B	yte						xxxx xxxx	55, 291
ADRESL	A/D Result R	egister Low By	yte .						xxxx xxxx	55, 291
ADCON0	ADCAL	_	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON	0-00 0000	55, 283
ADCON1	TRIGSEL	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	0-00 0000	55, 284
ADCON2	ADFM	_	ACQT2	ACQT1	ACQT0	ADCS2	ADCS1	ADCS0	0-00 0000	55, 285
LCDDATA4	S39C0 ⁽²⁾	S38C0 ⁽²⁾	S37C0 ⁽²⁾	S36C0 ⁽²⁾	S35C0 ⁽²⁾	S34C0 ⁽²⁾	S33C0 ⁽²⁾	S32C0	xxxx xxxx	55, 181
LCDDATA3	S31C0	S30C0	S29C0	S28C0	S27C0	S26C0	S25C0	S24C0	xxxx xxxx	55, 181
LCDDATA2	S23C0	S22C0	S21C0	S20C0	S19C0	S18C0	S17C0	S16C0	xxxx xxxx	55, 181
LCDDATA1	S15C0	S14C0	S13C0	S12C0	S11C0	S10C0	S09C0	S08C0	xxxx xxxx	55, 181
LCDDATA0	S07C0	S06C0	S05C0	S04C0	S03C0	S02C0	S01C0	S00C0	xxxx xxxx	55, 181
LCDSE5 ⁽²⁾	SE47	SE46	SE45	SE44	SE43	SE42	SE41	SE40	0000 0000	55, 181
LCDSE4	SE39 ⁽²⁾	SE38 ⁽²⁾	S37 ⁽²⁾	SE36 ⁽²⁾	SE35 ⁽²⁾	SE34 ⁽²⁾	SE33 ⁽²⁾	SE32	0000 0000	55, 181
LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	0000 0000	55, 181
LCDSE2	SE23	SE22	SE21	SE20	SE19	SE18	SE17	SE16	0000 0000	55, 181
LCDSE1	SE15	SE14	SE13	SE12	SE11	SE10	SE09	SE08	0000 0000	55, 181
CVRCON	CVREN	CVROE	CVRR	CVRSS	CVR3	CVR2	CVR1	CVR0	0000 0000	55, 299
CMCON	C2OUT	C1OUT	C2INV	C1INV	CIS	CM2	CM1	CM0	0000 0111	55, 293
TMR3H	Timer3 Regis	ter High Byte	•	•	•	•	•	•	xxxx xxxx	55, 147
TMR3L	Timer3 Regis	ster Low Byte							xxxx xxxx	55, 147
T3CON	RD16	T3CCP2	T3CKPS1	T3CKPS0	T3CCP1	T3SYNC	TMR3CS	TMR3ON	0000 0000	55, 145
		l .							l .	

 $\textbf{Legend:} \quad x = \text{unknown}, \ u = \text{unchanged}, \ - = \text{unimplemented}, \ q = \text{value depends on condition}, \ r = \text{reserved}, \ do \ not \ modify}$

Note 1: Bit 21 of the PC is only available in Test mode and Serial Programming modes.

^{2:} These registers and/or bits are available only on 80-pin devices; otherwise they are unimplemented and read as '0'. Reset states shown are for 80-pin devices.

^{3:} Alternate names and definitions for these bits when the MSSP module is operating in I²C™ Slave mode. See Section 17.4.3.2 "Address Masking" for details.

^{4:} The PLLEN bit is only available in specific oscillator configurations; otherwise, it is disabled and reads as '0'. See Section 2.4.3 "PLL Frequency Multiplier" for details.

^{5:} RA<7:6> and their associated latch and direction bits are configured as port pins only when the internal oscillator is selected as the default clock source (FOSC2 Configuration bit = 0); otherwise, they are disabled and these bits read as '0'.

TABLE 5-3: PIC18F87J90 FAMILY REGISTER FILE SUMMARY (CONTINUED)

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Details on page
SPBRG1	EUSART Bau	ıd Rate Gener	ator Low Byte						0000 0000	55, 253
RCREG1	EUSART Red	eive Register							0000 0000	55, 261
TXREG1	EUSART Trai	nsmit Register							0000 0000	55, 259
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	0000 0010	55, 250
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x	55, 251
LCDPS	WFT	BIASMD	LCDA	WA	LP3	LP2	LP1	LP0	0000 0000	55, 179
LCDSE0	SE07	SE06	SE05	SE04	SE03	SE02	SE01	SE00	0000 0000	55, 180
LCDCON	LCDEN	SLPEN	WERR		CS1	CS0	LMUX1	LMUX0	000- 0000	55, 178
EECON2	EEPROM Co	ntrol Register	2 (not a physi	cal register)						55, 84
EECON1	_	_	WPROG	FREE	WRERR	WREN	WR	_	00 x00-	55, 84
IPR3	_	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	-111 1111	56, 108
PIR3	_	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	-000 0000	56, 102
PIE3	_	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	-000 0000	56, 105
IPR2	OSCFIP	CMIP	_	_	BCLIP	LVDIP	TMR3IP	_	11 111-	56, 107
PIR2	OSCFIF	CMIF	_		BCLIF	LVDIF	TMR3IF	_	00 000-	56, 101
PIE2	OSCFIE	CMIE	_		BCLIE	LVDIE	TMR3IE	_	00 000-	56, 104
IPR1	_	ADIP	RC1IP	TX1IP	SSPIP	_	TMR2IP	TMR1IP	-111 1-11	56, 106
PIR1	_	ADIF	RC1IF	TX1IF	SSPIF	_	TMR2IF	TMR1IF	-000 0-00	56, 100
PIE1	_	ADIE	RC1IE	TX1IE	SSPIE	_	TMR2IE	TMR1IE	-000 0-00	56, 103
OSCTUNE	INTSRC	PLLEN ⁽⁴⁾	TUN5	TUN4	TUN3	TUN2	TUN1	TUN0	0000 0000	31, 56
TRISJ ⁽²⁾	TRISJ7	TRISJ6	TRISJ5	TRISJ4	TRISJ3	TRISJ2	TRISJ1	TRISJ0	1111 1111	56, 132
TRISH ⁽²⁾	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	1111 1111	56, 130
TRISG	SPIOD	CCP2OD	CCP1OD	TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	0001 1111	56, 128
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	_	1111 111-	56, 126
TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	_	TRISE1	TRISE0	1111 1-11	56, 123
TRISD	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	1111 1111	56, 121
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	1111 1111	56, 119
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	1111 1111	56, 116
TRISA	TRISA7 ⁽⁵⁾	TRISA6 ⁽⁵⁾	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	1111 1111	56, 113
LATJ ⁽²⁾	LATJ7	LATJ6	LATJ5	LATJ4	LATJ3	LATJ2	LATJ1	LATJ0	xxxx xxxx	56, 132
LATH ⁽²⁾	LATH7	LATH6	LATH5	LATH4	LATH3	LATH2	LATH1	LATH0	xxxx xxxx	56, 130
LATG	U2OD	U1OD	_	LATG4	LATG3	LATG2	LATG1	LATG0	00-x xxxx	56, 128
LATF	LATF7	LATF6	LATF5	LATF4	LATF3	LATF2	LATF1	_	xxxx xxx-	56, 126
LATE	LATE7	LATE6	LATE5	LATE4	LATE3	_	LATE1	LATE0	xxxx x-xx	56, 123
LATD	LATD7	LATD6	LATD5	LATD4	LATD3	LATD2	LATD1	LATD0	xxxx xxxx	56, 121
LATC	LATC7	LATC6	LATC5	LATC4	LATC3	LATC2	LATC1	LATC0	xxxx xxxx	56, 119
LATB	LATB7	LATB6	LATB5	LATB4	LATB3	LATB2	LATB1	LATB0	xxxx xxxx	56, 116
LATA	LATA7 ⁽⁵⁾	LATA6 ⁽⁵⁾	LATA5	LATA4	LATA3	LATA2	LATA1	LATA0	xxxx xxxx	56, 113

 $\textbf{Legend:} \quad x = \text{unknown}, \ u = \text{unchanged}, \ - = \text{unimplemented}, \ q = \text{value depends on condition}, \ r = \text{reserved}, \ do \ not \ modify}$

Note 1: Bit 21 of the PC is only available in Test mode and Serial Programming modes.

^{2:} These registers and/or bits are available only on 80-pin devices; otherwise they are unimplemented and read as '0'. Reset states shown are for 80-pin devices.

^{3:} Alternate names and definitions for these bits when the MSSP module is operating in I²C[™] Slave mode. See **Section 17.4.3.2 "Address Masking"** for details.

^{4:} The PLLEN bit is only available in specific oscillator configurations; otherwise, it is disabled and reads as '0'. See Section 2.4.3 "PLL Frequency Multiplier" for details.

^{5:} RA<7:6> and their associated latch and direction bits are configured as port pins only when the internal oscillator is selected as the default clock source (FOSC2 Configuration bit = 0); otherwise, they are disabled and these bits read as '0'.

TABLE 5-3: PIC18F87J90 FAMILY REGISTER FILE SUMMARY (CONTINUED)

IABLE 5-3:	FICT	0001330	FAMILY	/EGISTE	K FILE 30		(CONTI	10LD)		
File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Details on page
PORTJ ⁽²⁾	RJ7	RJ6	RJ5	RJ4	RJ3	RJ2	RJ1	RJ0	xxxx xxxx	56, 132
PORTH ⁽²⁾	RH7	RH6	RH5	RH4	RH3	RH2	RH1	RH0	xxxx xxxx	56, 130
PORTG	RDPU	REPU	RJPU ⁽²⁾	RG4	RG3	RG2	RG1	RG0	000x xxxx	56, 128
PORTF	RF7	RF6	RF5	RF4	RF3	RF2	RF1	_	xxxx xxx-	56, 126
PORTE	RE7	RE6	RE5	RE4	RE3	_	RE1	RE0	xxxx x-xx	57, 123
PORTD	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	xxxx xxxx	57, 121
PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	xxxx xxxx	57, 119
PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	xxxx xxxx	57, 116
PORTA	RA7 ⁽⁵⁾	RA6 ⁽⁵⁾	RA5	RA4	RA3	RA2	RA1	RA0	xx0x 0000	57, 113
SPBRGH1	EUSART Bau	EUSART Baud Rate Generator High Byte								
BAUDCON1	ABDOVF	RCMT	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	0100 0-00	57, 252
LCDDATA23 ⁽²⁾	S47C3	S46C3	S45C3	S44C3	S43C3	S42C3	S41C3	S40C3	xxxx xxxx	57, 181
LCDDATA22	S39C3 ⁽²⁾	S38C3 ⁽²⁾	S37C3 ⁽²⁾	S36C3 ⁽²⁾	S35C3 ⁽²⁾	S34C3 ⁽²⁾	S33C3 ⁽²⁾	S32C3	xxxx xxxx	57, 181
LCDDATA21	S31C3	S30C3	S29C3	S28C3	S27C3	S26C3	S25C3	S24C3	xxxx xxxx	57, 181
LCDDATA20	S23C3	S22C3	S21C3	S20C3	S19C3	S18C3	S17C3	S16C3	xxxx xxxx	57, 181
LCDDATA19	S15C3	S14C3	S13C3	S12C3	S11C3	S10C3	S09C3	S08C3	xxxx xxxx	57, 181
LCDDATA18	S07C3	S06C3	S05C3	S04C3	S03C3	S02C3	S01C3	S00C3	xxxx xxxx	57, 181
LCDDATA17 ⁽²⁾	S47C2	S46C2	S45C2	S44C2	S43C2	S42C2	S41C2	S40C2	xxxx xxxx	57, 181
LCDDATA16	S39C2 ⁽²⁾	S38C2 ⁽²⁾	S37C2 ⁽²⁾	S36C2 ⁽²⁾	S35C2 ⁽²⁾	S34C2 ⁽²⁾	S33C2 ⁽²⁾	S32C2	xxxx xxxx	57, 181
LCDDATA15	S31C2	S30C2	S29C2	S28C2	S27C2	S26C2	S25C2	S24C2	xxxx xxxx	57, 181
LCDDATA14	S23C2	S22C2	S21C2	S20C2	S19C2	S18C2	S17C2	S16C2	xxxx xxxx	57, 181
LCDDATA13	S15C2	S14C2	S13C2	S12C2	S11C2	S10C2	S09C2	S08C2	xxxx xxxx	57, 181
LCDDATA12	S07C2	S06C2	S05C2	S04C2	S03C2	S02C2	S01C2	S00C2	xxxx xxxx	57, 181
LCDDATA11 ⁽²⁾	S47C1	S46C1	S45C1	S44C1	S43C1	S42C1	S41C1	S40C1	xxxx xxxx	57, 181
LCDDATA10	S39C1 ⁽²⁾	S38C1 ⁽²⁾	S37C1 ⁽²⁾	S36C1 ⁽²⁾	S35C1 ⁽²⁾	S34C1 ⁽²⁾	S33C1 ⁽²⁾	S32C1	xxxx xxxx	57, 181
LCDDATA9	S31C1	S30C1	S29C1	S28C1	S27C1	S26C1	S25C1	S24C1	xxxx xxxx	57, 181
LCDDATA8	S23C1	S22C1	S21C1	S20C1	S19C1	S18C1	S17C1	S16C1	xxxx xxxx	57, 181
LCDDATA7	S15C1	S14C1	S13C1	S12C1	S11C1	S10C1	S09C1	S08C1	xxxx xxxx	57, 181
LCDDATA6	S07C1	S06C1	S05C1	S04C1	S03C1	S02C1	S01C1	S00C1	xxxx xxxx	57, 181
LCDDATA5 ⁽²⁾	S47C0	S46C0	S45C0	S44C0	S43C0	S42C0	S41C0	S40C0	xxxx xxxx	57, 181
CCPR1H	Capture/Com	pare/PWM Re	gister 1 High	Byte			I	I	xxxx xxxx	57, 168
CCPR1L		pare/PWM Re							xxxx xxxx	57, 168
CCP1CON		_	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	57, 167
CCPR2H	Capture/Com	pare/PWM Re	gister 2 High	Byte					xxxx xxxx	57, 168
CCPR2L	-	pare/PWM Re							xxxx xxxx	
CCP2CON	_	_	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	00 0000	58, 167
SPBRG2	AUSART Bau	ıd Rate Gener							0000 0000	58, 272
RCREG2	AUSART Red	eive Register							0000 0000	58, 277
TXREG2		nsmit Register							0000 0000	58, 275
TXSTA2	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	58, 270
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x	†
RTCCFG	RTCEN		RTCWREN	RTCSYNC	HALFSEC	RTCOE	RTCPTR1	RTCPTR0	0-00 0000	58, 151
RTCCAL	CAL7	CAL6	CAL5	CAL4	CAL3	CAL2	CAL1	CAL0	0000 0000	58, 152
RTCVALH		l	l	d on RTCPTR	l	J. 1.L.E	J. 1.E.1	J. 120	xxxx xxxx	58, 154
	oo value	gr. r togistei	acw base	S 511 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1						00, 104

Note 1: Bit 21 of the PC is only available in Test mode and Serial Programming modes.

^{2:} These registers and/or bits are available only on 80-pin devices; otherwise they are unimplemented and read as '0'. Reset states shown are for 80-pin devices.

^{3:} Alternate names and definitions for these bits when the MSSP module is operating in I²C[™] Slave mode. See Section 17.4.3.2 "Address Masking" for details.

^{4:} The PLLEN bit is only available in specific oscillator configurations; otherwise, it is disabled and reads as '0'. See Section 2.4.3 "PLL Frequency Multiplier" for details.

^{5:} RA<7:6> and their associated latch and direction bits are configured as port pins only when the internal oscillator is selected as the default clock source (FOSC2 Configuration bit = 0); otherwise, they are disabled and these bits read as '0'.

TABLE 5-3: PIC18F87J90 FAMILY REGISTER FILE SUMMARY (CONTINUED)

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Details on page
RTCVALL	RTCC Value	TCC Value Low Register Window based on RTCPTR<1:0>							xxxx xxxx	58, 154
ALRMCFG	ALRMEN	CHIME	AMASK3	AMASK2	AMASK1	AMASK0	ALRMPTR1	ALRMPTR0	0000 0000	58, 153
ALRMRPT	ARPT7	ARPT6	ARPT5	ARPT4	ARPT3	ARPT2	ARPT1	ARPT0	0000 0000	58, 154
ALRMVALH	Alarm Value High Register Window based on ALRMPTR<1:0>								xxxx xxxx	58, 157
ALRMVALL	Alarm Value L	_ow Register \	Vindow based	on ALRMPTI	R<1:0>				xxxx xxxx	58, 157
CTMUCONH	CTMUEN	_	CTMUSIDL	TGEN	EDGEN	EDGSEQEN	IDISSEN	CTTRIG	0-00 0000	58, 315
CTMUCONL	EDG2POL	EDG2SEL1	EDG2SEL0	EDG1POL	EDG1SEL1	EDG1SEL0	EDG2STAT	EDG1STAT	0000 0000	58, 316
CTMUICON	ITRIM5	ITRIM4	ITRIM3	ITRIM2	ITRIM1	ITRIM0	IRNG1	IRNG0	0000 0000	58, 317
PADCFG1	_	_	_	_	_	RTSECSEL1	RTSECSEL0	_	00-	58, 152

 $\textbf{Legend:} \quad \textbf{x} = \text{unknown}, \textbf{u} = \text{unchanged}, \textbf{-} = \text{unimplemented}, \textbf{q} = \text{value depends on condition}, \textbf{r} = \text{reserved}, \text{do not modify}$

Note 1: Bit 21 of the PC is only available in Test mode and Serial Programming modes.

- 2: These registers and/or bits are available only on 80-pin devices; otherwise they are unimplemented and read as '0'. Reset states shown are for 80-pin devices.
- 3: Alternate names and definitions for these bits when the MSSP module is operating in I²C™ Slave mode. See Section 17.4.3.2 "Address Masking" for details.
- 4: The PLLEN bit is only available in specific oscillator configurations; otherwise, it is disabled and reads as '0'. See Section 2.4.3 "PLL Frequency Multiplier" for details.
- 5: RA<7:6> and their associated latch and direction bits are configured as port pins only when the internal oscillator is selected as the default clock source (FOSC2 Configuration bit = 0); otherwise, they are disabled and these bits read as '0'.

5.3.5 STATUS REGISTER

The STATUS register, shown in Register 5-2, contains the arithmetic status of the ALU. The STATUS register can be the operand for any instruction, as with any other register. If the STATUS register is the destination for an instruction that affects the Z, DC, C, OV or N bits, then the write to these five bits is disabled.

These bits are set or cleared according to the device logic. Therefore, the result of an instruction with the STATUS register as destination may be different than intended. For example, CLRF STATUS will set the Z bit but leave the other bits unchanged. The STATUS

register then reads back as '000u u1uu'. It is recommended, therefore, that only BCF, BSF, SWAPF, MOVFF and MOVWF instructions are used to alter the STATUS register because these instructions do not affect the Z, C, DC, OV or N bits in the STATUS register.

For other instructions not affecting any Status bits, see the instruction set summaries in Table 25-2 and Table 25-3.

Note: The C and DC bits operate as a borrow and digit borrow bit respectively, in subtraction.

REGISTER 5-2: STATUS REGISTER

U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
_	_	_	N	OV	Z	DC ⁽¹⁾	C ⁽²⁾
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n - Value at POP	'1' - Rit is set	'0' - Bit is cleared	v – Rit is unknown

bit 7-5 **Unimplemented:** Read as '0'

bit 4 N: Negative bit

This bit is used for signed arithmetic (2's complement). It indicates whether the result was negative (ALU MSB = 1).

1 = Result was negative 0 = Result was positive

bit 3 **OV:** Overflow bit

This bit is used for signed arithmetic (2's complement). It indicates an overflow of the

7-bit magnitude which causes the sign bit (bit 7) to change state.

1 = Overflow occurred for signed arithmetic (in this arithmetic operation)

0 = No overflow occurred

bit 2 Z: Zero bit

1 = The result of an arithmetic or logic operation is zero

0 = The result of an arithmetic or logic operation is not zero

bit 1 **DC:** Digit Carry/Borrow bit⁽¹⁾

For ADDWF, ADDLW, SUBLW and SUBWF instructions:

1 = A carry-out from the 4th low-order bit of the result occurred

0 = No carry-out from the 4th low-order bit of the result

bit 0 C: Carry/Borrow bit⁽²⁾

For ADDWF, ADDLW, SUBLW and SUBWF instructions:

1 = A carry-out from the Most Significant bit of the result occurred

0 = No carry-out from the Most Significant bit of the result occurred

Note 1: For borrow, the polarity is reversed. A subtraction is executed by adding the 2's complement of the second operand. For rotate (RRF, RLF) instructions, this bit is loaded with either bit 4 or bit 3 of the source register.

2: For borrow, the polarity is reversed. A subtraction is executed by adding the 2's complement of the second operand. For rotate (RRF, RLF) instructions, this bit is loaded with either the high or low-order bit of the source register.

5.4 Data Addressing Modes

Note:

The execution of some instructions in the core PIC18 instruction set are changed when the PIC18 extended instruction set is enabled. See Section 5.6 "Data Memory and the Extended Instruction Set" for more information.

While the program memory can be addressed in only one way – through the program counter – information in the data memory space can be addressed in several ways. For most instructions, the addressing mode is fixed. Other instructions may use up to three modes, depending on which operands are used and whether or not the extended instruction set is enabled.

The addressing modes are:

- Inherent
- Literal
- Direct
- Indirect

An additional addressing mode, Indexed Literal Offset, is available when the extended instruction set is enabled (XINST Configuration bit = 1). Its operation is discussed in greater detail in **Section 5.6.1 "Indexed Addressing with Literal Offset"**.

5.4.1 INHERENT AND LITERAL ADDRESSING

Many PIC18 control instructions do not need any argument at all; they either perform an operation that globally affects the device, or they operate implicitly on one register. This addressing mode is known as Inherent Addressing. Examples include SLEEP, RESET and DAW.

Other instructions work in a similar way, but require an additional explicit argument in the opcode. This is known as Literal Addressing mode, because they require some literal value as an argument. Examples include ADDLW and MOVLW, which respectively, add or move a literal value to the W register. Other examples include CALL and GOTO, which include a 20-bit program memory address.

5.4.2 DIRECT ADDRESSING

Direct Addressing specifies all or part of the source and/or destination address of the operation within the opcode itself. The options are specified by the arguments accompanying the instruction.

In the core PIC18 instruction set, bit-oriented and byte-oriented instructions use some version of Direct Addressing by default. All of these instructions include some 8-bit literal address as their Least Significant Byte. This address specifies either a register address in one of the banks of data RAM (Section 5.3.3 "General Purpose Register File"), or a location in the Access Bank (Section 5.3.2 "Access Bank") as the data source for the instruction.

The Access RAM bit 'a' determines how the address is interpreted. When 'a' is '1', the contents of the BSR (Section 5.3.1 "Bank Select Register") are used with the address to determine the complete 12-bit address of the register. When 'a' is '0', the address is interpreted as being a register in the Access Bank. Addressing that uses the Access RAM is sometimes also known as Direct Forced Addressing mode.

A few instructions, such as MOVFF, include the entire 12-bit address (either source or destination) in their opcodes. In these cases, the BSR is ignored entirely.

The destination of the operation's results is determined by the destination bit 'd'. When 'd' is '1', the results are stored back in the source register, overwriting its original contents. When 'd' is '0', the results are stored in the W register. Instructions without the 'd' argument have a destination that is implicit in the instruction; their destination is either the target register being operated on or the W register.

5.4.3 INDIRECT ADDRESSING

Indirect Addressing allows the user to access a location in data memory without giving a fixed address in the instruction. This is done by using File Select Registers (FSRs) as pointers to the locations to be read or written to. Since the FSRs are themselves located in RAM as Special Function Registers, they can also be directly manipulated under program control. This makes FSRs very useful in implementing data structures such as tables and arrays in data memory.

The registers for Indirect Addressing are also implemented with Indirect File Operands (INDFs) that permit automatic manipulation of the pointer value with auto-incrementing, auto-decrementing or offsetting with another value. This allows for efficient code using loops, such as the example of clearing an entire RAM bank in Example 5-5. It also enables users to perform Indexed Addressing and other Stack Pointer operations for program memory in data memory.

EXAMPLE 5-5: HOW TO CLEAR RAM
(BANK 1) USING
INDIRECT ADDRESSING

	LFSR	FSR0, 100h	;	
NEXT	CLRF	POSTINC0	;	Clear INDF
			;	register then
			;	inc pointer
	BTFSS	FSROH, 1	;	All done with
			;	Bank1?
	BRA	NEXT	;	NO, clear next
CONTIN	UE		;	YES, continue

5.4.3.1 FSR Registers and the INDF Operand

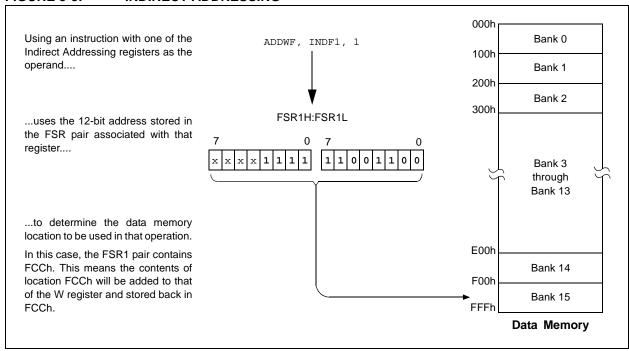
At the core of Indirect Addressing are three sets of registers: FSR0, FSR1 and FSR2. Each represents a pair of 8-bit registers, FSRnH and FSRnL. The four upper bits of the FSRnH register are not used, so each FSR pair holds a 12-bit value. This represents a value that can address the entire range of the data memory in a linear fashion. The FSR register pairs, then, serve as pointers to data memory locations.

Indirect Addressing is accomplished with a set of Indirect File Operands, INDF0 through INDF2. These can be thought of as "virtual" registers: they are mapped in

the SFR space but are not physically implemented. Reading or writing to a particular INDF register actually accesses its corresponding FSR register pair. A read from INDF1, for example, reads the data at the address indicated by FSR1H:FSR1L. Instructions that use the INDF registers as operands actually use the contents of their corresponding FSR as a pointer to the instruction's target. The INDF operand is just a convenient way of using the pointer.

Because Indirect Addressing uses a full 12-bit address, data RAM banking is not necessary. Thus, the current contents of the BSR and the Access RAM bit have no effect on determining the target address.

FIGURE 5-8: INDIRECT ADDRESSING



© 2009 Microchip Technology Inc. Preliminary DS39933C-page 77

5.4.3.2 FSR Registers and POSTINC, POSTDEC, PREINC and PLUSW

In addition to the INDF operand, each FSR register pair also has four additional indirect operands. Like INDF, these are "virtual" registers that cannot be indirectly read or written to. Accessing these registers actually accesses the associated FSR register pair, but also performs a specific action on its stored value. They are:

- POSTDEC: accesses the FSR value, then automatically decrements it by '1' afterwards
- POSTINC: accesses the FSR value, then automatically increments it by '1' afterwards
- PREINC: increments the FSR value by '1', then uses it in the operation
- PLUSW: adds the signed value of the W register (range of -127 to 128) to that of the FSR and uses the new value in the operation

In this context, accessing an INDF register uses the value in the FSR registers without changing them. Similarly, accessing a PLUSW register gives the FSR value offset by the value in the W register; neither value is actually changed in the operation. Accessing the other virtual registers changes the value of the FSR registers.

Operations on the FSRs with POSTDEC, POSTINC and PREINC affect the entire register pair; that is, roll-overs of the FSRnL register from FFh to 00h carry over to the FSRnH register. On the other hand, results of these operations do not change the value of any flags in the STATUS register (e.g., Z, N, OV, etc.).

The PLUSW register can be used to implement a form of Indexed Addressing in the data memory space. By manipulating the value in the W register, users can reach addresses that are fixed offsets from pointer addresses. In some applications, this can be used to implement some powerful program control structure, such as software stacks, inside of data memory.

5.4.3.3 Operations by FSRs on FSRs

Indirect Addressing operations that target other FSRs or virtual registers represent special cases. For example, using an FSR to point to one of the virtual registers will not result in successful operations. As a specific case, assume that the FSR0H:FSR0L registers contain FE7h, the address of INDF1. Attempts to read the value of the INDF1, using INDF0 as an operand, will return 00h. Attempts to write to INDF1, using INDF0 as the operand, will result in a NOP.

On the other hand, using the virtual registers to write to an FSR pair may not occur as planned. In these cases, the value will be written to the FSR pair but without any incrementing or decrementing. Thus, writing to INDF2 or POSTDEC2 will write the same value to the FSR2H:FSR2L.

Since the FSRs are physical registers mapped in the SFR space, they can be manipulated through all direct operations. Users should proceed cautiously when working on these registers, particularly if their code uses Indirect Addressing.

Similarly, operations by Indirect Addressing are generally permitted on all other SFRs. Users should exercise the appropriate caution that they do not inadvertently change settings that might affect the operation of the device.

5.5 Program Memory and the Extended Instruction Set

The operation of program memory is unaffected by the use of the extended instruction set.

Enabling the extended instruction set adds five additional two-word commands to the existing PIC18 instruction set: ADDFSR, CALLW, MOVSF, MOVSS and SUBFSR. These instructions are executed as described in Section 5.2.4 "Two-Word Instructions".

5.6 Data Memory and the Extended Instruction Set

Enabling the PIC18 extended instruction set (XINST Configuration bit = 1) significantly changes certain aspects of data memory and its addressing. Specifically, the use of the Access Bank for many of the core PIC18 instructions is different; this is due to the introduction of a new addressing mode for the data memory space. This mode also alters the behavior of Indirect Addressing using FSR2 and its associated operands.

What does not change is just as important. The size of the data memory space is unchanged, as well as its linear addressing. The SFR map remains the same. Core PIC18 instructions can still operate in both Direct and Indirect Addressing mode; inherent and literal instructions do not change at all. Indirect Addressing with FSR0 and FSR1 also remains unchanged.

5.6.1 INDEXED ADDRESSING WITH LITERAL OFFSET

Enabling the PIC18 extended instruction set changes the behavior of Indirect Addressing using the FSR2 register pair and its associated file operands. Under the proper conditions, instructions that use the Access Bank – that is, most bit-oriented and byte-oriented instructions – can invoke a form of Indexed Addressing using an offset specified in the instruction. This special addressing mode is known as Indexed Addressing with Literal Offset, or Indexed Literal Offset mode.

When using the extended instruction set, this addressing mode requires the following:

- The use of the Access Bank is forced ('a' = 0);
 and
- The file address argument is less than or equal to 5Fh.

Under these conditions, the file address of the instruction is not interpreted as the lower byte of an address (used with the BSR in Direct Addressing) or as an 8-bit address in the Access Bank. Instead, the value is interpreted as an offset value to an Address Pointer specified by FSR2. The offset and the contents of FSR2 are added to obtain the target address of the operation.

5.6.2 INSTRUCTIONS AFFECTED BY INDEXED LITERAL OFFSET MODE

Any of the core PIC18 instructions that can use Direct Addressing are potentially affected by the Indexed Literal Offset Addressing mode. This includes all byte-oriented and bit-oriented instructions, or almost one-half of the standard PIC18 instruction set. Instructions that only use Inherent or Literal Addressing modes are unaffected.

Additionally, byte-oriented and bit-oriented instructions are not affected if they use the Access Bank (Access RAM bit is '1') or include a file address of 60h or above. Instructions meeting these criteria will continue to execute as before. A comparison of the different possible addressing modes when the extended instruction set is enabled is shown in Figure 5-9.

Those who desire to use byte-oriented or bit-oriented instructions in the Indexed Literal Offset mode should note the changes to assembler syntax for this mode. This is described in more detail in **Section 25.2.1** "Extended Instruction Syntax".

FIGURE 5-9: COMPARING ADDRESSING OPTIONS FOR BIT-ORIENTED AND BYTE-ORIENTED INSTRUCTIONS (EXTENDED INSTRUCTION SET ENABLED)

EXAMPLE INSTRUCTION: ADDWF, f, d, a (Opcode: 0010 01da fffff fffff)

When a = 0 and $f \ge 60h$:

The instruction executes in Direct Forced mode. 'f' is interpreted as a location in the Access RAM between 060h and FFFh. This is the same as locations F60h to FFFh (Bank 15) of data memory.

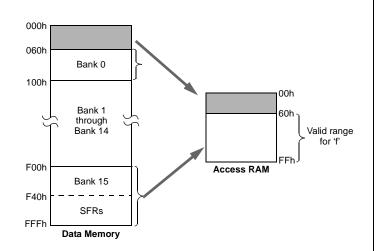
Locations below 060h are not available in this addressing mode.

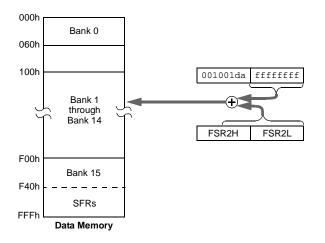
When a = 0 and $f \le 5Fh$:

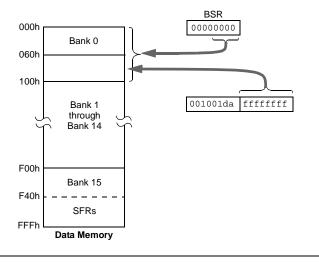
The instruction executes in Indexed Literal Offset mode. 'f' is interpreted as an offset to the address value in FSR2. The two are added together to obtain the address of the target register for the instruction. The address can be anywhere in the data memory space.

When a = 1 (all values of f):

The instruction executes in Direct mode (also known as Direct Long mode). 'f' is interpreted as a location in one of the 16 banks of the data memory space. The bank is designated by the Bank Select Register (BSR). The address can be in any implemented bank in the data memory space.







5.6.3 MAPPING THE ACCESS BANK IN INDEXED LITERAL OFFSET MODE

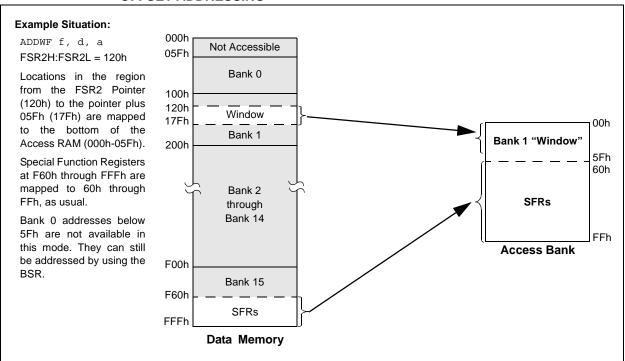
The use of Indexed Literal Offset Addressing mode effectively changes how the lower part of Access RAM (00h to 5Fh) is mapped. Rather than containing just the contents of the bottom part of Bank 0, this mode maps the contents from Bank 0 and a user-defined "window" that can be located anywhere in the data memory space. The value of FSR2 establishes the lower boundary of the addresses mapped into the window, while the upper boundary is defined by FSR2 plus 95 (5Fh). Addresses in the Access RAM above 5Fh are mapped as previously described (see **Section 5.3.2 "Access Bank"**). An example of Access Bank remapping in this addressing mode is shown in Figure 5-10.

Remapping of the Access Bank applies *only* to operations using the Indexed Literal Offset mode. Operations that use the BSR (Access RAM bit is '1') will continue to use Direct Addressing as before. Any Indirect or Indexed Addressing operation that explicitly uses any of the indirect file operands (including FSR2) will continue to operate as standard Indirect Addressing. Any instruction that uses the Access Bank, but includes a register address of greater than 05Fh, will use Direct Addressing and the normal Access Bank map.

5.6.4 BSR IN INDEXED LITERAL OFFSET MODE

Although the Access Bank is remapped when the extended instruction set is enabled, the operation of the BSR remains unchanged. Direct Addressing, using the BSR to select the data memory bank, operates in the same manner as previously described.

FIGURE 5-10: REMAPPING THE ACCESS BANK WITH INDEXED LITERAL OFFSET ADDRESSING



© 2009 Microchip Technology Inc. Preliminary DS39933C-page 81

NOTES:

6.0 FLASH PROGRAM MEMORY

The Flash program memory is readable, writable and erasable during normal operation over the entire VDD range.

A read from program memory is executed on one byte at a time. A write to program memory is executed on blocks of 64 bytes at a time or two bytes at a time. Program memory is erased in blocks of 1024 bytes at a time. A bulk erase operation may not be issued from user code.

Writing or erasing program memory will cease instruction fetches until the operation is complete. The program memory cannot be accessed during the write or erase, therefore, code cannot execute. An internal programming timer terminates program memory writes and erases.

A value written to program memory does not need to be a valid instruction. Executing a program memory location that forms an invalid instruction results in a NOP.

6.1 Table Reads and Table Writes

In order to read and write program memory, there are two operations that allow the processor to move bytes between the program memory space and the data RAM:

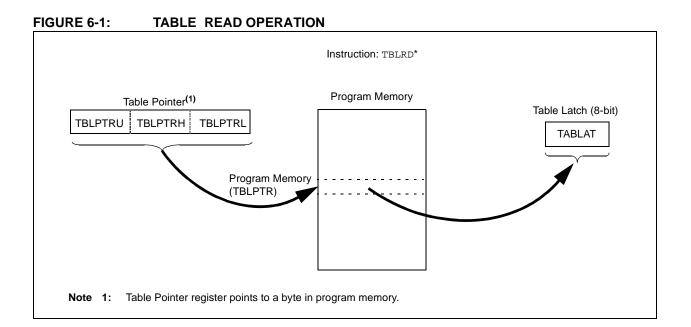
- Table Read (TBLRD)
- Table Write (TBLWT)

The program memory space is 16 bits wide, while the data RAM space is 8 bits wide. Table reads and table writes move data between these two memory spaces through an 8-bit register (TABLAT).

Table read operations retrieve data from program memory and place it into the data RAM space. Figure 6-1 shows the operation of a table read with program memory and data RAM.

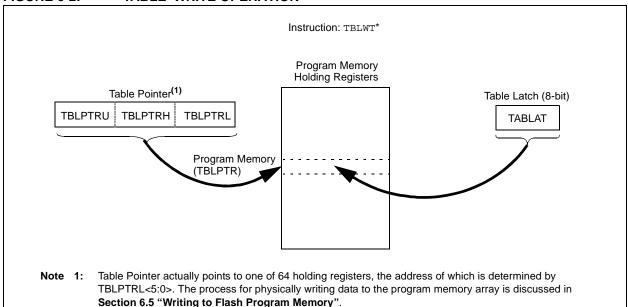
Table write operations store data from the data memory space into holding registers in program memory. The procedure to write the contents of the holding registers into program memory is detailed in **Section 6.5** "Writing to Flash Program Memory". Figure 6-2 shows the operation of a table write with program memory and data RAM.

Table operations work with byte entities. A table block containing data, rather than program instructions, is not required to be word-aligned. Therefore, a table block can start and end at any byte address. If a table write is being used to write executable code into program memory, program instructions will need to be word-aligned.



© 2009 Microchip Technology Inc. Preliminary DS39933C-page 83

FIGURE 6-2: TABLE WRITE OPERATION



6.2 Control Registers

Several control registers are used in conjunction with the TBLRD and TBLWT instructions. These include the:

- EECON1 register
- · EECON2 register
- TABLAT register
- · TBLPTR registers

6.2.1 EECON1 AND EECON2 REGISTERS

The EECON1 register (Register 6-1) is the control register for memory accesses. The EECON2 register is not a physical register; it is used exclusively in the memory write and erase sequences. Reading EECON2 will read all '0's.

The WPROG bit, when set, allows the user to program a single word (two bytes) upon the execution of the WR command. If this bit is cleared, the WR command programs a block of 64 bytes.

The FREE bit, when set, will allow a program memory erase operation. When FREE is set, the erase operation is initiated on the next WR command. When FREE is clear, only writes are enabled.

The WREN bit, when set, will allow a write operation. On power-up, the WREN bit is clear. The WRERR bit is set in hardware when the WR bit is set and cleared when the internal programming timer expires and the write operation is complete.

Note: During normal operation, the WRERR is read as '1'. This can indicate that a write operation was prematurely terminated by a Reset, or a write operation was attempted improperly.

The WR control bit initiates write operations. The bit cannot be cleared, only set, in software. It is cleared in hardware at the completion of the write operation.

REGISTER 6-1: EECON1: EEPROM CONTROL REGISTER 1

U-0	U-0	R/W-0	R/W-0	R/W-x	R/W-0	R/S-0	U-0
_	_	WPROG	FREE	WRERR ⁽¹⁾	WREN	WR	_
bit 7							bit 0

 Legend:
 S = Settable bit (cannot be cleared in software)

 R = Readable bit
 W = Writable bit
 U = Unimplemented bit, read as '0'

 -n = Value at POR
 '1' = Bit is set
 '0' = Bit is cleared
 x = Bit is unknown

bit 7-6 **Unimplemented:** Read as '0'

bit 5 WPROG: One Word-Wide Program bit

1 = Program 2 bytes on the next WR command0 = Program 64 bytes on the next WR command

bit 4 FREE: Flash Erase Enable bit

1 = Performs an erase operation on the next WR command (cleared by completion of erase operation)

0 = Perform write only

bit 3 WRERR: Flash Program Error Flag bit⁽¹⁾

1 = A write operation is prematurely terminated (any Reset during self-timed programming in normal

operation, or an improper write attempt)

0 = The write operation completed

WREN: Flash Program Write Enable bit 1 = Allows write cycles to Flash program memory

0 = Inhibits write cycles to Flash program memory

bit 1 WR: Write Control bit

bit 2

1 = Initiates a program memory erase cycle or write cycle

(The operation is self-timed and the bit is cleared by hardware once write is complete. The WR bit

can only be set (not cleared) in software.)

0 = Write cycle is complete

bit 0 Unimplemented: Read as '0'

Note 1: When a WRERR occurs, the EEPGD and CFGS bits are not cleared. This allows tracing of the error condition.

6.2.2 TABLE LATCH REGISTER (TABLAT)

The Table Latch (TABLAT) is an 8-bit register mapped into the SFR space. The Table Latch register is used to hold 8-bit data during data transfers between program memory and data RAM.

6.2.3 TABLE POINTER REGISTER (TBLPTR)

The Table Pointer (TBLPTR) register addresses a byte within the program memory. The TBLPTR is comprised of three SFR registers: Table Pointer Upper Byte, Table Pointer High Byte and Table Pointer Low Byte (TBLPTRU:TBLPTRH:TBLPTRL). These three registers join to form a 22-bit wide pointer. The low-order 21 bits allow the device to address up to 2 Mbytes of program memory space. The 22nd bit allows access to the device ID, the user ID and the Configuration bits.

The Table Pointer register, TBLPTR, is used by the TBLRD and TBLWT instructions. These instructions can update the TBLPTR in one of four ways based on the table operation. These operations are shown in Table 6-1. These operations on the TBLPTR only affect the low-order 21 bits.

6.2.4 TABLE POINTER BOUNDARIES

TBLPTR is used in reads, writes and erases of the Flash program memory.

When a TBLRD is executed, all 22 bits of the TBLPTR determine which byte is read from program memory into TABLAT.

When a TBLWT is executed, the seven LSbs of the Table Pointer register (TBLPTR<6:0>) determine which of the 64 program memory holding registers is written to. When the timed write to program memory begins (via the WR bit), the 12 MSbs of the TBLPTR (TBLPTR<21:10>) determine which program memory block of 1024 bytes is written to. For more detail, see Section 6.5 "Writing to Flash Program Memory".

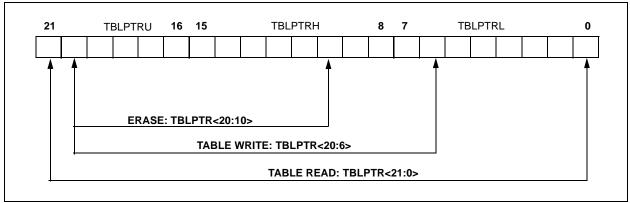
When an erase of program memory is executed, the 12 MSbs of the Table Pointer register point to the 1024-byte block that will be erased. The Least Significant bits are ignored.

Figure 6-3 describes the relevant boundaries of TBLPTR based on Flash program memory operations.

TARI F 6-1.	TARI E POINTER O	PERATIONS WITH TRIAD	AND TBLWT INSTRUCTIONS

Example	Operation on Table Pointer
TBLRD* TBLWT*	TBLPTR is not modified
TBLRD*+ TBLWT*+	TBLPTR is incremented after the read/write
TBLRD*- TBLWT*-	TBLPTR is decremented after the read/write
TBLRD+* TBLWT+*	TBLPTR is incremented before the read/write

FIGURE 6-3: TABLE POINTER BOUNDARIES BASED ON OPERATION



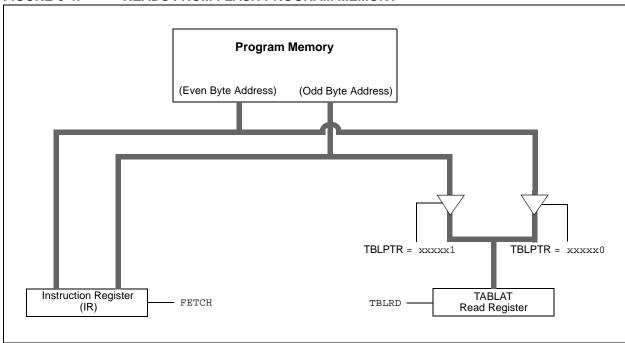
6.3 Reading the Flash Program Memory

The TBLRD instruction is used to retrieve data from program memory and places it into data RAM. Table reads from program memory are performed one byte at a time

TBLPTR points to a byte address in program space. Executing TBLRD places the byte pointed to into TABLAT. In addition, TBLPTR can be modified automatically for the next table read operation.

The internal program memory is typically organized by words. The Least Significant bit of the address selects between the high and low bytes of the word. Figure 6-4 shows the interface between the internal program memory and the TABLAT.

FIGURE 6-4: READS FROM FLASH PROGRAM MEMORY



EXAMPLE 6-1: READING A FLASH PROGRAM MEMORY WORD

	MOVLW	CODE_ADDR_UPPER	;	Load TBLPTR with the base
	MOVWF	TBLPTRU	;	address of the word
	MOVLW	CODE_ADDR_HIGH		
	MOVWF	TBLPTRH		
	MOVLW	CODE_ADDR_LOW		
	MOVWF	TBLPTRL		
READ_WORD				
	TBLRD*+		;	read into TABLAT and increment
	MOVF	TABLAT, W	;	get data
	MOVWF	WORD_EVEN		
	TBLRD*+		;	read into TABLAT and increment
	MOVF	TABLAT, W	;	get data
	MOVWF	WORD_ODD		

© 2009 Microchip Technology Inc. Preliminary DS39933C-page 87

6.4 Erasing Flash Program Memory

The minimum erase block is 512 words or 1024 bytes. Only through the use of an external programmer, or through ICSP control, can larger blocks of program memory be bulk erased. Word erase in the Flash array is not supported.

When initiating an erase sequence from the micro-controller itself, a block of 1024 bytes of program memory is erased. The Most Significant 12 bits of the TBLPTR<21:10> point to the block being erased. TBLPTR<9:0> are ignored.

The EECON1 register commands the erase operation. The WREN bit must be set to enable write operations. The FREE bit is set to select an erase operation. For protection, the write initiate sequence for EECON2 must be used.

A long write is necessary for erasing the internal Flash. Instruction execution is halted while in a long write cycle. The long write will be terminated by the internal programming timer.

6.4.1 FLASH PROGRAM MEMORY ERASE SEQUENCE

The sequence of events for erasing a block of internal program memory location is:

- Load Table Pointer register with address being erased.
- Set the WREN and FREE bits (EECON1<2,4>) to enable the erase operation.
- 3. Disable interrupts.
- 4. Write 55h to EECON2.
- 5. Write 0AAh to EECON2.
- 6. Set the WR bit. This will begin the erase cycle.
- The CPU will stall for duration of the erase for TIW (see parameter D133B).
- 8. Re-enable interrupts.

EXAMPLE 6-2: ERASING FLASH PROGRAM MEMORY

	MOVLW	CODE_ADDR_UPPER	; load TBLPTR with the base
	MOVWF	TBLPTRU	; address of the memory block
	MOVLW	CODE_ADDR_HIGH	
	MOVWF	TBLPTRH	
	MOVLW	CODE_ADDR_LOW	
	MOVWF	TBLPTRL	
ERASE			
	BSF	EECON1, WREN	
	BSF	EECON1, FREE	; enable Erase operation
	BCF	INTCON, GIE	; disable interrupts
Required	MOVLW	55h	
Sequence	MOVWF	EECON2	; write 55h
	MOVLW	0AAh	
	MOVWF	EECON2	; write OAAh
	BSF	EECON1, WR	; start erase (CPU stall)
	BSF	INTCON, GIE	; re-enable interrupts

6.5 Writing to Flash Program Memory

The programming block is 32 words or 64 bytes. Programming one word or two bytes at a time is also supported.

Table writes are used internally to load the holding registers needed to program the Flash memory. There are 64 holding registers used by the table writes for programming.

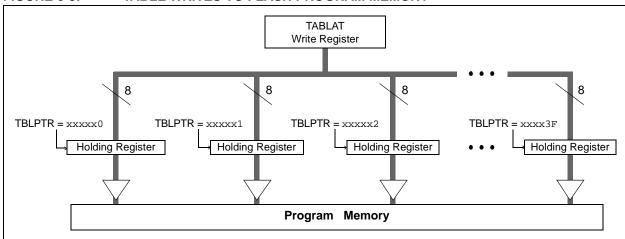
Since the Table Latch (TABLAT) is only a single byte, the TBLWT instruction may need to be executed 64 times for each programming operation (if WPROG = 0). All of the table write operations will essentially be short writes because only the holding registers are written. At the end of updating the 64 holding registers, the EECON1 register must be written to in order to start the programming operation with a long write.

The long write is necessary for programming the internal Flash. Instruction execution is halted while in a long write cycle. The long write will be terminated by the internal programming timer.

The on-chip timer controls the write time. The write/erase voltages are generated by an on-chip charge pump, rated to operate over the voltage range of the device.

- Note 1: Unlike previous PIC18 Flash devices, members of the PIC18F87J90 family do not reset the holding registers after a write occurs. The holding registers must be cleared or overwritten before a programming sequence.
 - 2: To maintain the endurance of the program memory cells, each Flash byte should not be programmed more than one time between erase operations. Before attempting to modify the contents of the target cell a second time, an erase of the target, or a bulk erase of the entire memory, must be performed.

FIGURE 6-5: TABLE WRITES TO FLASH PROGRAM MEMORY



6.5.1 FLASH PROGRAM MEMORY WRITE SEQUENCE

The sequence of events for programming an internal program memory location should be:

- Read 1024 bytes into RAM.
- Update data values in RAM as necessary.
- Load Table Pointer register with address being erased.
- 4. Execute the erase procedure.
- 5. Load Table Pointer register with address of first byte being written, minus 1.
- Write the 64 bytes into the holding registers with auto-increment.
- Set the WREN bit (EECON1<2>) to enable byte writes.

- 8. Disable interrupts.
- 9. Write 55h to EECON2.
- 10. Write 0AAh to EECON2.
- 11. Set the WR bit. This will begin the write cycle.
- 12. The CPU will stall for duration of the write for TIW (parameter D133A).
- 13. Re-enable interrupts.
- 14. Repeat steps 6 through 13 until all 1024 bytes are written to program memory.
- 15. Verify the memory (table read).

An example of the required code is shown in Example 6-3 on the following page.

Note: Before setting the WR bit, the Table Pointer address needs to be within the intended address range of the 64 bytes in the holding register.

EXAMPLE 6-3: WRITING TO FLASH PROGRAM MEMORY

EXAMPLE 6-3:	VVKITING	TO FLASH PROGRA	IVI IVICIVIOR I
	MOVLW MOVWF MOVLW MOVWF	CODE_ADDR_UPPER TBLPTRU CODE_ADDR_HIGH TBLPTRH	; Load TBLPTR with the base address ; of the memory block, minus 1
	MOVLW MOVWF	CODE_ADDR_LOW TBLPTRL	
ERASE_BLOCK	DOE	EEGON1 WEEN	t analyla south a ta mamana
	BSF	EECON1, WREN	; enable write to memory
	BSF	EECON1, FREE	; enable Erase operation
	BCF	INTCON, GIE	; disable interrupts
	MOVLW	55h	1
	MOVWF	EECON2	; write 55h
	MOVLW	0AAh	1
	MOVWF	EECON2	; write OAAh
	BSF	EECON1, WR	; start erase (CPU stall)
	BSF	INTCON, GIE	; re-enable interrupts
	MOVLW	D'16'	
	MOVWF	WRITE_COUNTER	; Need to write 16 blocks of 64 to write ; one erase block of 1024
RESTART_BUFFER			
	MOVLW	D'64'	
	MOVWF	COUNTER	
	MOVLW	BUFFER_ADDR_HIGH	; point to buffer
	MOVWF	FSR0H	
	MOVLW	BUFFER_ADDR_LOW	
	MOVWF	FSR0L	
FILL_BUFFER			
			; read the new data from I2C, SPI,
			; PSP, USART, etc.
WRITE_BUFFER			
	MOVLW	D'64	; number of bytes in holding register
	MOVWF	COUNTER	
WRITE_BYTE_TO_HRE	EGS		
	MOVFF	POSTINCO, WREG	; get low byte of buffer data
	MOVWF	TABLAT	; present data to table latch
	TBLWT+*		<pre>; write data, perform a short write ; to internal TBLWT holding register.</pre>
	DECFSZ	COUNTER	; loop until buffers are full
	BRA	WRITE_BYTE_TO_HREGS	
PROGRAM_MEMORY			
	BSF	EECON1, WREN	; enable write to memory
	BCF	INTCON, GIE	; disable interrupts
	MOVLW	55h	
Required	MOVWF	EECON2	; write 55h
Sequence	MOVLW	0AAh	
	MOVWF	EECON2	; write OAAh
	BSF	EECON1, WR	; start program (CPU stall)
	BSF	INTCON, GIE	; re-enable interrupts
	BCF	EECON1, WREN	; disable write to memory
	DECFSZ	WRITE_COUNTER	; done with one write cycle
	BRA	RESTART_BUFFER	; if not done replacing the erase block
		- '	

6.5.2 FLASH PROGRAM MEMORY WRITE SEQUENCE (WORD PROGRAMMING).

The PIC18F87J90 family of devices has a feature that allows programming a single word (two bytes). This feature is enabled when the WPROG bit is set. If the memory location is already erased, the following sequence is required to enable this feature:

- Load the Table Pointer register with the address of the data to be written
- 2. Write the 2 bytes into the holding registers and perform a table write

- 3. Set WPROG to enable single-word write.
- 4. Set WREN to enable write to memory.
- 5. Disable interrupts.
- 6. Write 55h to EECON2.
- 7. Write 0AAh to EECON2.
- 8. Set the WR bit. This will begin the write cycle.
- 9. The CPU will stall for duration of the write for T_{IW} (see parameter D133A).
- 10. Re-enable interrupts.

EXAMPLE 6-4: SINGLE-WORD WRITE TO FLASH PROGRAM MEMORY

	MOVLW	CODE_ADDR_UPPER	;	Load TBLPTR with the base address
	MOVWF	TBLPTRU		
	MOVLW	CODE_ADDR_HIGH		
	MOVWF	TBLPTRH		
	MOVLW	CODE_ADDR_LOW		
	MOVWF	TBLPTRL		
		D3.773.0		
	MOVLW	DATA0		
	MOVWF	TABLAT		
	TBLWT*+			
	MOVLW	DATA1		
	MOVWF	TABLAT		
	TBLWT*			
PROGRAM_MEMORY				
		EECON1, WPROG		enable single word write
		EECON1, WREN		enable write to memory
		INTCON, GIE	;	disable interrupts
		55h		
Required	MOVWF	EECON2	;	write 55h
Sequence	MOVLW	0AAh		
	MOVWF	EECON2	;	write OAAh
	BSF	EECON1, WR	;	start program (CPU stall)
	BSF	INTCON, GIE	;	re-enable interrupts
	BCF	EECON1, WPROG	;	disable single word write
	BCF	EECON1, WREN	;	disable write to memory

6.5.3 WRITE VERIFY

Depending on the application, good programming practice may dictate that the value written to the memory should be verified against the original value. This should be used in applications where excessive writes can stress bits near the specification limit.

6.5.4 UNEXPECTED TERMINATION OF WRITE OPERATION

If a write is terminated by an unplanned event, such as loss of power or an unexpected Reset, the memory location just programmed should be verified and reprogrammed if needed. If the write operation is interrupted by a MCLR Reset or a WDT time-out Reset during normal operation, the user can check the WRERR bit and rewrite the location(s) as needed.

6.6 Flash Program Operation During Code Protection

See Section 24.6 "Program Verification and Code Protection" for details on code protection of Flash program memory.

TABLE 6-2: REGISTERS ASSOCIATED WITH PROGRAM FLASH MEMORY

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
TBLPTRU	_	— bit 21 Program Memory Table Pointer Upper Byte (TBLPTR<20:16>)							53
TBPLTRH	H Program Memory Table Pointer High Byte (TBLPTR<15:8>)								53
TBLPTRL	Program M	emory Table	Pointer Lov	w Byte (TBL	PTR<7:0>)				53
TABLAT	Program M	emory Table	Latch						53
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53
EECON2	2 EEPROM Control Register 2 (not a physical register)								55
EECON1	_	_	WPROG	FREE	WRERR	WREN	WR	_	55

Legend: — = unimplemented, read as '0'. Shaded cells are not used during Flash program memory access.

7.0 8 x 8 HARDWARE MULTIPLIER

7.1 Introduction

All PIC18 devices include an 8 x 8 hardware multiplier as part of the ALU. The multiplier performs an unsigned operation and yields a 16-bit result that is stored in the product register pair, PRODH:PRODL. The multiplier's operation does not affect any flags in the STATUS register.

Making multiplication a hardware operation allows it to be completed in a single instruction cycle. This has the advantages of higher computational throughput and reduced code size for multiplication algorithms and allows the PIC18 devices to be used in many applications previously reserved for digital signal processors. A comparison of various hardware and software multiply operations, along with the savings in memory and execution time, is shown in Table 7-1.

7.2 Operation

Example 7-1 shows the instruction sequence for an 8×8 unsigned multiplication. Only one instruction is required when one of the arguments is already loaded in the WREG register.

Example 7-2 shows the sequence to do an 8×8 signed multiplication. To account for the sign bits of the arguments, each argument's Most Significant bit (MSb) is tested and the appropriate subtractions are done.

EXAMPLE 7-1: 8 x 8 UNSIGNED MULTIPLY ROUTINE

MOVF ARG1, W ;
MULWF ARG2 ; ARG1 * ARG2 ->
; PRODH:PRODL

EXAMPLE 7-2: 8 x 8 SIGNED MULTIPLY ROUTINE

```
MOVF
       ARG1, W
MULWF
       ARG2
                   ; ARG1 * ARG2 ->
                   ; PRODH: PRODL
BTFSC
       ARG2, SB
                  ; Test Sign Bit
SUBWF
       PRODH, F
                 ; PRODH = PRODH
                             - ARG1
MOVF
       ARG2, W
       ARG1, SB
BTFSC
                   ; Test Sign Bit
SUBWF
       PRODH, F
                   ; PRODH = PRODH
```

TABLE 7-1: PERFORMANCE COMPARISON FOR VARIOUS MULTIPLY OPERATIONS

		Program	Cycles	Time			
Routine	Multiply Method	Memory (Words)	(Max)	@ 48 MHz	@ 10 MHz	@ 4 MHz	
8 x 8 unsigned	Without hardware multiply	13	69	5.7 μs	27.6 μs	69 μs	
o x o unsigned	Hardware multiply	1	1	83.3 ns	400 ns	1 μs	
0 v 0 signed	Without hardware multiply	33	91	7.5 μs	36.4 μs	91 μs	
8 x 8 signed	Hardware multiply	6	6	500 ns	2.4 μs	6 μs	
16 v 16 upoignod	Without hardware multiply	21	242	20.1 μs	96.8 μs	242 μs	
16 x 16 unsigned	Hardware multiply	28	28	2.3 μs	11.2 μs	28 μs	
16 v 16 signed	Without hardware multiply	52	254	21.6 μs	102.6 μs	254 μs	
16 x 16 signed	Hardware multiply	35	40	3.3 μs	16.0 μs	40 μs	

Example 7-3 shows the sequence to do a 16 x 16 unsigned multiplication. Equation 7-1 shows the algorithm that is used. The 32-bit result is stored in four registers (RES3:RES0).

EQUATION 7-1: 16 x 16 UNSIGNED MULTIPLICATION ALGORITHM

```
RES3:RES0 = ARG1H:ARG1L \bullet ARG2H:ARG2L

= (ARG1H \bullet ARG2H \bullet 2<sup>16</sup>) +

(ARG1H \bullet ARG2L \bullet 2<sup>8</sup>) +

(ARG1L \bullet ARG2H \bullet 2<sup>8</sup>) +

(ARG1L \bullet ARG2L)
```

EXAMPLE 7-3: 16 x 16 UNSIGNED MULTIPLY ROUTINE

```
ARG1L,
MOVE
        ARG2L
MULWF
                        ; ARG1L * ARG2L->
                        ; PRODH:PRODL
        PRODH, RES1
MOVFF
MOVFF
        PRODL, RESO
        ARG1H, W
MOVF
                        ; ARG1H * ARG2H->
MULWF
        ARG2H
                        ; PRODH:PRODL
MOVFF
        PRODH, RES3
                        ;
        PRODL, RES2
MOVFF
        ARG1L, W
MOVF
MULWF
        ARG2H
                        ; ARG1L * ARG2H->
                        ; PRODH:PRODL
MOVF
        PRODL, W
ADDWF
        RES1, F
                       ; Add cross
MOVF
        PRODH, W
                        ; products
ADDWFC RES2, F
        WREG
CLRF
ADDWFC RES3, F
        ARG1H, W
MOVF
                        ; ARG1H * ARG2L->
{\tt MULWF}
        ARG2L
                       ; PRODH:PRODL
        PRODL, W
MOVF
ADDWF
        RES1, F
                        ; Add cross
MOVF
        PRODH, W
                        ; products
ADDWFC RES2, F
CLRF
        WREG
                        ;
ADDWFC RES3, F
```

Example 7-4 shows the sequence to do a 16 x 16 signed multiply. Equation 7-2 shows the algorithm used. The 32-bit result is stored in four registers (RES3:RES0). To account for the sign bits of the arguments, the MSb for each argument pair is tested and the appropriate subtractions are done.

EQUATION 7-2: 16 x 16 SIGNED MULTIPLICATION ALGORITHM

```
RES3:RES0= ARG1H:ARG1L • ARG2H:ARG2L

(ARG1H • ARG2H • 2<sup>16</sup>) +

(ARG1H • ARG2L • 2<sup>8</sup>) +

(ARG1L • ARG2H • 2<sup>8</sup>) +

(ARG1L • ARG2L) +

(-1 • ARG2H<7> • ARG1H:ARG1L • 2<sup>16</sup>) +

(-1 • ARG1H<7> • ARG2H:ARG2L • 2<sup>16</sup>)
```

EXAMPLE 7-4: 16 x 16 SIGNED MULTIPLY ROUTINE

```
MOVE
           ARG1L, W
  MULWF
           ARG2L
                          ; ARG1L * ARG2L ->
                          ; PRODH: PRODL
  MOVFF
           PRODH, RES1
           PRODL, RESO
  MOVEE
                          ;
  MOVF
           ARG1H, W
           ARG2H
                          ; ARG1H * ARG2H ->
  MULWF
                          ; PRODH: PRODL
  MOVFF
           PRODH, RES3
           PRODL, RES2
  MOVFF
           ARG1L, W
  MOVE
           ARG2H
                          ; ARG1L * ARG2H ->
  MULWF
                          ; PRODH:PRODL
  MOVF
           PRODL, W
           RES1, F
                          ; Add cross
  ADDWF
  MOVF
           PRODH, W
                          ; products
  ADDWFC
           RES2, F
           WREG
  CLRF
  ADDWFC
          RES3, F
           ARG1H, W
  MOVF
  MULWF
           ARG2L
                          ; ARG1H * ARG2L ->
                          ; PRODH: PRODL
  MOVE
           PRODL, W
  ADDWF
           RES1, F
                          ; Add cross
  MOVF
           PRODH, W
                            products
  ADDWFC
           RES2, F
           WREG
  CLRF
  ADDWFC
          RES3, F
           ARG2H, 7
                          ; ARG2H:ARG2L neg?
  BTFSS
           SIGN_ARG1
                          ; no, check ARG1
  BRA
  MOVE
           ARG1L, W
  SUBWF
           RES2
  MOVF
           ARG1H, W
  SUBWFB
          RES3
SIGN_ARG1
  BTFSS
           ARG1H, 7
                          ; ARG1H:ARG1L neg?
  BRA
           CONT_CODE
                          ; no, done
  MOVF
           ARG2L, W
  SUBWF
           RES2
           ARG2H, W
  MOVF
  SUBWFB RES3
CONT_CODE
   :
```

8.0 INTERRUPTS

Members of the PIC18F87J90 family of devices have multiple interrupt sources and an interrupt priority feature that allows most interrupt sources to be assigned a high-priority level or a low-priority level. The high-priority interrupt vector is at 0008h and the low-priority interrupt vector is at 0018h. High-priority interrupt events will interrupt any low-priority interrupts that may be in progress.

There are thirteen registers which are used to control interrupt operation. These registers are:

- RCON
- INTCON
- INTCON2
- INTCON3
- PIR1, PIR2, PIR3
- PIE1, PIE2, PIE3
- IPR1, IPR2, IPR3

It is recommended that the Microchip header files supplied with MPLAB® IDE be used for the symbolic bit names in these registers. This allows the assembler/compiler to automatically take care of the placement of these bits within the specified register.

In general, interrupt sources have three bits to control their operation. They are:

- Flag bit to indicate that an interrupt event occurred
- Enable bit that allows program execution to branch to the interrupt vector address when the flag bit is set
- Priority bit to select high priority or low priority

The interrupt priority feature is enabled by setting the IPEN bit (RCON<7>). When interrupt priority is enabled, there are two bits which enable interrupts globally. Setting the GIEH bit (INTCON<7>) enables all interrupts that have the priority bit set (high priority). Setting the GIEL bit (INTCON<6>) enables all interrupts that have the priority bit cleared (low priority). When the interrupt flag, enable bit and appropriate global interrupt enable bit are set, the interrupt will vector immediately to address 0008h or 0018h, depending on the priority bit setting. Individual interrupts can be disabled through their corresponding enable bits.

When the IPEN bit is cleared (default state), the interrupt priority feature is disabled and interrupts are compatible with PIC® mid-range devices. In Compatibility mode, the interrupt priority bits for each source have no effect. INTCON<6> is the PEIE bit which enables/disables all peripheral interrupt sources. INTCON<7> is the GIE bit which enables/disables all interrupt sources. All interrupts branch to address 0008h in Compatibility mode.

When an interrupt is responded to, the global interrupt enable bit is cleared to disable further interrupts. If the IPEN bit is cleared, this is the GIE bit. If interrupt priority levels are used, this will be either the GIEH or GIEL bit. High-priority interrupt sources can interrupt a low-priority interrupt. Low-priority interrupts are not processed while high-priority interrupts are in progress.

The return address is pushed onto the stack and the PC is loaded with the interrupt vector address (0008h or 0018h). Once in the Interrupt Service Routine, the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bits must be cleared in software before re-enabling interrupts to avoid recursive interrupts.

The "return from interrupt" instruction, RETFIE, exits the interrupt routine and sets the GIE bit (GIEH or GIEL if priority levels are used) which re-enables interrupts.

For external interrupt events, such as the INTx pins or the PORTB input change interrupt, the interrupt latency will be three to four instruction cycles. The exact latency is the same for one or two-cycle instructions. Individual interrupt flag bits are set regardless of the status of their corresponding enable bit or the GIE bit.

Note: Do not use the MOVFF instruction to modify any of the Interrupt Control registers while any interrupt is enabled. Doing so may cause erratic microcontroller behavior.

TMR0IF TMR0IE TMR0IP RBIF RBIE Wake-up if in Idle or Sleep modes RBIP INTOIF INTOIE -INT1IF INT1IE INT1IP INT2IF INT2IE INT2IP Interrupt to CPU Vector to Location 0008h PIR1<6:3,1:0> — PIE1<6:3,1:0> — IPR1<6:3,1:0> — INT3IF INT3IE INT3IP GIE/GIEH PIR2<7:6,3:1> _ PIE2<7:6 3:1> _ IPR2<7:6,3:1> _ IPEN —d PIR3<6:0> — PIE3<6:0> — IPR3<6:0> — IPEN PEIE/GIEL IPEN High-Priority Interrupt Generation Low-Priority Interrupt Generation PIR1<6:3,1:0> PIE1<6:3,1:0> IPR1<6:3,1:0> PIR2<7:6,3:1> ____ PIE2<7:6,3:1> ___ IPR2<7:6,3:1> ___ Interrupt to CPU Vector to Location 0018h TMR0IF — TMR0IE — TMR0IP IPEN -PIR3<6:0> PIE3<6:0> IPR3<6:0> GIE/GIEH RBIP PEIE/GIEL INT1IF INT1IE INT1IP INT1IP INT2IF INT2IE INT3IP INT3IE INT3IP

FIGURE 8-1: PIC18F87J90 FAMILY INTERRUPT LOGIC

8.1 INTCON Registers

The INTCON registers are readable and writable registers which contain various enable, priority and flag bits

Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global interrupt enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

REGISTER 8-1: INTCON: INTERRUPT CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-x
GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF ⁽¹⁾
bit 7							bit 0

Note:

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 GIE/GIEH: Global Interrupt Enable bit

When IPEN = 0:

1 = Enables all unmasked interrupts

0 = Disables all interrupts

When IPEN = 1:

1 = Enables all high-priority interrupts

0 = Disables all interrupts

bit 6 **PEIE/GIEL:** Peripheral Interrupt Enable bit

When IPEN = 0:

1 = Enables all unmasked peripheral interrupts

0 = Disables all peripheral interrupts

When IPEN = 1:

1 = Enables all low-priority peripheral interrupts

0 = Disables all low-priority peripheral interrupts

bit 5 TMR0IE: TMR0 Overflow Interrupt Enable bit

1 = Enables the TMR0 overflow interrupt

0 = Disables the TMR0 overflow interrupt

bit 4 INT0IE: INT0 External Interrupt Enable bit

1 = Enables the INT0 external interrupt

0 = Disables the INT0 external interrupt

bit 3 RBIE: RB Port Change Interrupt Enable bit

1 = Enables the RB port change interrupt

0 = Disables the RB port change interrupt

bit 2 TMR0IF: TMR0 Overflow Interrupt Flag bit

1 = TMR0 register has overflowed (must be cleared in software)

0 = TMR0 register did not overflow

bit 1 INT0IF: INT0 External Interrupt Flag bit

1 = The INT0 external interrupt occurred (must be cleared in software)

0 = The INT0 external interrupt did not occur

bit 0 **RBIF:** RB Port Change Interrupt Flag bit⁽¹⁾

1 = At least one of the RB<7:4> pins changed state (must be cleared in software)

0 = None of the RB<7:4> pins have changed state

Note 1: A mismatch condition will continue to set this bit. Reading PORTB will end the mismatch condition and allow the bit to be cleared.

REGISTER 8-2: INTCON2: INTERRUPT CONTROL REGISTER 2

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
RBPU	INTEDG0	INTEDG1	INTEDG2	INTEDG3	TMR0IP	INT3IP	RBIP
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 RBPU: PORTB Pull-up Enable bit

1 = All PORTB pull-ups are disabled

0 = PORTB pull-ups are enabled by individual port latch values

bit 6 INTEDG0: External Interrupt 0 Edge Select bit

1 = Interrupt on rising edge0 = Interrupt on falling edge

bit 5 INTEDG1: External Interrupt 1 Edge Select bit

1 = Interrupt on rising edge0 = Interrupt on falling edge

bit 4 INTEDG2: External Interrupt 2 Edge Select bit

1 = Interrupt on rising edge0 = Interrupt on falling edge

bit 3 INTEDG3: External Interrupt 3 Edge Select bit

1 = Interrupt on rising edge0 = Interrupt on falling edge

bit 2 **TMR0IP:** TMR0 Overflow Interrupt Priority bit

1 = High priority0 = Low priority

bit 1 INT3IP: INT3 External Interrupt Priority bit

1 = High priority0 = Low priority

bit 0 RBIP: RB Port Change Interrupt Priority bit

1 = High priority0 = Low priority

Note: Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global interrupt enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

REGISTER 8-3: INTCON3: INTERRUPT CONTROL REGISTER 3

R/W-1	R/W-1	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
INT2IP	INT1IP	INT3IE	INT2IE	INT1IE	INT3IF	INT2IF	INT1IF
bit 7							bit 0

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set

'0' = Bit is cleared x = Bit is unknown

bit 7 INT2IP: INT2 External Interrupt Priority bit

> 1 = High priority 0 = Low priority

Legend:

bit 6

INT1IP: INT1 External Interrupt Priority bit

1 = High priority 0 = Low priority

bit 5 INT3IE: INT3 External Interrupt Enable bit

> 1 = Enables the INT3 external interrupt 0 = Disables the INT3 external interrupt

bit 4 INT2IE: INT2 External Interrupt Enable bit 1 = Enables the INT2 external interrupt

0 = Disables the INT2 external interrupt

bit 3 INT1IE: INT1 External Interrupt Enable bit

> 1 = Enables the INT1 external interrupt 0 = Disables the INT1 external interrupt

INT3IF: INT3 External Interrupt Flag bit bit 2

1 = The INT3 external interrupt occurred (must be cleared in software)

0 = The INT3 external interrupt did not occur

bit 1 INT2IF: INT2 External Interrupt Flag bit

1 = The INT2 external interrupt occurred (must be cleared in software)

0 = The INT2 external interrupt did not occur

bit 0 INT1IF: INT1 External Interrupt Flag bit

1 = The INT1 external interrupt occurred (must be cleared in software)

0 = The INT1 external interrupt did not occur

Note: Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global interrupt enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

Preliminary © 2009 Microchip Technology Inc. DS39933C-page 99

8.2 PIR Registers

The PIR registers contain the individual flag bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are three Peripheral Interrupt Request (Flag) registers (PIR1, PIR2, PIR3).

- Note 1: Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the Global Interrupt Enable bit, GIE (INTCON<7>).
 - 2: User software should ensure the appropriate interrupt flag bits are cleared prior to enabling an interrupt and after servicing that interrupt.

REGISTER 8-4: PIR1: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 1

U-0	R/W-0	R-0	R-0	R/W-0	U-0	R/W-0	R/W-0
_	ADIF	RC1IF	TX1IF	SSPIF	_	TMR2IF	TMR1IF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	Unimplemented: Read as '0'
bit 6	ADIF: A/D Converter Interrupt Flag bit
	1 = An A/D conversion completed (must be cleared in software)0 = The A/D conversion is not complete
bit 5	RC1IF: EUSART Receive Interrupt Flag bit
	1 = The EUSART receive buffer, RCREG1, is full (cleared when RCREG1 is read)0 = The EUSART receive buffer is empty
bit 4	TX1IF: EUSART Transmit Interrupt Flag bit
	1 = The EUSART transmit buffer, TXREG1, is empty (cleared when TXREG1 is written)0 = The EUSART transmit buffer is full
bit 3	SSPIF: Master Synchronous Serial Port Interrupt Flag bit
	1 = The transmission/reception is complete (must be cleared in software)0 = Waiting to transmit/receive
bit 2	Unimplemented: Read as '0'
bit 1	TMR2IF: TMR2 to PR2 Match Interrupt Flag bit
	1 = TMR2 to PR2 match occurred (must be cleared in software)0 = No TMR2 to PR2 match occurred
bit 0	TMR1IF: TMR1 Overflow Interrupt Flag bit
	1 = TMR1 register overflowed (must be cleared in software)0 = TMR1 register did not overflow

REGISTER 8-5: PIR2: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 2

R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	U-0
OSCFIF	CMIF	_	_	BCLIF	LVDIF	TMR3IF	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 OSCFIF: Oscillator Fail Interrupt Flag bit

1 = Device oscillator failed, clock input has changed to INTOSC (must be cleared in software)

0 = Device clock operating

bit 6 CMIF: Comparator Interrupt Flag bit

1 = Comparator input has changed (must be cleared in software)

0 = Comparator input has not changed

bit 5-4 **Unimplemented:** Read as '0'

bit 3 BCLIF: Bus Collision Interrupt Flag bit

1 = A bus collision occurred (must be cleared in software)

0 = No bus collision occurred

bit 2 LVDIF: Low-Voltage Detect Interrupt Flag bit

1 = A low-voltage condition occurred (must be cleared in software)

0 = The device voltage is above the regulator's low-voltage trip point

bit 1 TMR3IF: TMR3 Overflow Interrupt Flag bit

1 = TMR3 register overflowed (must be cleared in software)

0 = TMR3 register did not overflow

bit 0 Unimplemented: Read as '0'

REGISTER 8-6: PIR3: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 3

U-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0
_	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 Unimplemented: Read as '0'

bit 6 LCDIF: LCD Interrupt Flag bit (valid when Type-B waveform with Non-Static mode is selected)

1 = LCD data of all COMs is output (must be cleared in software)

0 = LCD data of all COMs is not yet output

bit 5 RC2IF: AUSART Receive Interrupt Flag bit

1 = The AUSART receive buffer, RCREG2, is full (cleared when RCREG2 is read)

0 = The AUSART receive buffer is empty

bit 4 TX2IF: AUSART Transmit Interrupt Flag bit

1 = The AUSART transmit buffer, TXREG2, is empty (cleared when TXREG2 is written)

0 = The AUSART transmit buffer is full

bit 3 CTMUIF: CTMU Interrupt Flag bit

1 = CTMU interrupt occured (must be cleared in software)

0 = No CTMU interrupt occured

bit 2 CCP2IF: CCP2 Interrupt Flag bit

Capture mode:

1 = A TMR1/TMR3 register capture occurred (must be cleared in software)

0 = No TMR1/TMR3 register capture occurred

Compare mode:

1 = A TMR1/TMR3 register compare match occurred (must be cleared in software)

0 = No TMR1/TMR3 register compare match occurred

PWM mode:

Unused in this mode.

bit 1 **CCP1IF:** CCP1 Interrupt Flag bit

Capture mode:

1 = A TMR1/TMR3 register capture occurred (must be cleared in software)

0 = No TMR1/TMR3 register capture occurred

Compare mode:

1 = A TMR1/TMR3 register compare match occurred (must be cleared in software)

0 = No TMR1/TMR3 register compare match occurred

PWM mode:

Unused in this mode.

bit 0 RTCCIF: RTCC Interrupt Flag bit

1 = RTCC interrupt occured (must be cleared in software)

0 = No RTCC interrupt occured

x = Bit is unknown

8.3 PIE Registers

Legend:

R = Readable bit

The PIE registers contain the individual enable bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are three Peripheral Interrupt Enable registers (PIE1, PIE2, PIE3). When IPEN = 0, the PEIE bit must be set to enable any of these peripheral interrupts.

REGISTER 8-7: PIE1: PERIPHERAL INTERRUPT ENABLE REGISTER 1

W = Writable bit

U-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
_	ADIE	RC1IE	TX1IE	SSPIE	_	TMR2IE	TMR1IE
bit 7							bit 0

U = Unimplemented bit, read as '0'

			'
-n = Value at	POR '1' = Bit is set	: '0	' = Bit is cleared
bit 7	Unimplemented: Read as	0'	
bit 6	ADIE: A/D Converter Interru	ıpt Enable bit	
	1 = Enables the A/D interrup	ot	
	0 = Disables the A/D interru	pt	
bit 5	RC1IE: EUSART Receive Ir	nterrupt Enable bit	
	1 = Enables the EUSART re	•	
	0 = Disables the EUSART re	eceive interrupt	
bit 4	TX1IE: EUSART Transmit Ir	nterrupt Enable bit	
	1 = Enables the EUSART tra	•	
	0 = Disables the EUSART tr	ansmit interrupt	
bit 3	SSPIE: Master Synchronous		upt Enable bit
	1 = Enables the MSSP inter		
	0 = Disables the MSSP inter	•	
bit 2	Unimplemented: Read as '	0'	
bit 1	TMR2IE: TMR2 to PR2 Mat	ch Interrupt Enable	e bit
	1 = Enables the TMR2 to PF		
	0 = Disables the TMR2 to P	R2 match interrupt	t
bit 0	TMR1IE: TMR1 Overflow In	terrupt Enable bit	

1 = Enables the TMR1 overflow interrupt0 = Disables the TMR1 overflow interrupt

© 2009 Microchip Technology Inc. Preliminary DS39933C-page 103

REGISTER 8-8: PIE2: PERIPHERAL INTERRUPT ENABLE REGISTER 2

R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	U-0
OSCFIE	CMIE	_	_	BCLIE	LVDIE	TMR3IE	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 OSCFIE: Oscillator Fail Interrupt Enable bit

1 =Enabled 0 =Disabled

bit 6 CMIE: Comparator Interrupt Enable bit

1 = Enabled
0 = Disabled

bit 5-4 **Unimplemented:** Read as '0'

bit 3 BCLIE: Bus Collision Interrupt Enable bit

1 = Enabled
0 = Disabled

bit 2 LVDIE: Low-Voltage Detect Interrupt Enable bit

1 = Enabled
0 = Disabled

bit 1 TMR3IE: TMR3 Overflow Interrupt Enable bit

1 = Enabled
0 = Disabled

bit 0 **Unimplemented:** Read as '0'

REGISTER 8-9: PIE3: PERIPHERAL INTERRUPT ENABLE REGISTER 3

W = Writable bit

U-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0
_	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE
bit 7							bit 0

-n = Value at POR '1' = Bit is set

Legend:

R = Readable bit

U = Unimplemented bit, read as '0'

'1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 Unimplemented: Read as '0'

bit 6 LCDIE: LCD Interrupt Enable bit (valid when Type-B waveform with Non-Static mode is selected)

1 = Enabled0 = Disabled

bit 5 RC2IE: AUSART Receive Interrupt Enable bit

1 = Enabled0 = Disabled

bit 4 TX2IE: AUSART Transmit Interrupt Enable bit

1 = Enabled0 = Disabled

bit 3 CTMUIE: CTMU Interrupt Enable bit

1 = Enabled0 = Disabled

bit 2 CCP2IE: CCP2 Interrupt Enable bit

1 = Enabled
0 = Disabled

bit 1 **CCP1IE:** CCP1 Interrupt Enable bit

1 = Enables the CCP1 interrupt0 = Disables the CCP1 interrupt

bit 0 RTCCIE: RTCC Interrupt Enable bit

1 = Enabled0 = Disabled

8.4 IPR Registers

The IPR registers contain the individual priority bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are three Peripheral Interrupt Priority registers (IPR1, IPR2, IPR3). Using the priority bits requires that the Interrupt Priority Enable (IPEN) bit be set.

REGISTER 8-10: IPR1: PERIPHERAL INTERRUPT PRIORITY REGISTER 1

U-0	R/W-1	R/W-1	R/W-1	R/W-1	U-0	R/W-1	R/W-1
_	ADIP	RC1IP	TX1IP	SSPIP	_	TMR2IP	TMR1IP
bit 7							bit 0

Legend:						
R = Readable bit		W = Writable bit	U = Unimplemented bit,	read as '0'		
-n = Value at POR		'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		
bit 7	Unimple	mented: Read as '0'				
bit 6	ADIP: A/D Converter Interrupt Priority bit					
	1 = High priority					
	0 = Low	priority				
bit 5	RC1IP: E	USART Receive Interrupt Pr	riority bit			

1 = High priority 0 = Low priority bit 4 **TX1IP:** EUSART Transmit Interrupt Priority bit 1 = High priority 0 = Low priority

bit 3 SSPIP: Master Synchronous Serial Port Interrupt Priority bit

1 = High priority 0 = Low priority

bit 2 **Unimplemented:** Read as '0'

bit 1 TMR2IP: TMR2 to PR2 Match Interrupt Priority bit

1 = High priority0 = Low priority

bit 0 TMR1IP: TMR1 Overflow Interrupt Priority bit

1 = High priority 0 = Low priority

U = Unimplemented bit, read as '0'

REGISTER 8-11: IPR2: PERIPHERAL INTERRUPT PRIORITY REGISTER 2

R/W-1	R/W-1	U-0	U-0	R/W-1	R/W-1	R/W-1	U-0
OSCFIP	CMIP	_	_	BCLIP	LVDIP	TMR3IP	_
bit 7							bit 0

-n = Value at POR '1' = Bit is set

W = Writable bit

'0' = Bit is cleared x = Bit is unknown

bit 7 **OSCFIP:** Oscillator Fail Interrupt Priority bit

> 1 = High priority 0 = Low priority

Legend:

R = Readable bit

bit 6 **CMIP:** Comparator Interrupt Priority bit

> 1 = High priority 0 = Low priority

Unimplemented: Read as '0' bit 5-4

bit 3 **BCLIP:** Bus Collision Interrupt Priority bit

> 1 = High priority 0 = Low priority

bit 2 LVDIP: Low-Voltage Detect Interrupt Priority bit

> 1 = High priority 0 = Low priority

bit 1 TMR3IP: TMR3 Overflow Interrupt Priority bit

> 1 = High priority 0 = Low priority

bit 0 Unimplemented: Read as '0'

REGISTER 8-12: IPR3: PERIPHERAL INTERRUPT PRIORITY REGISTER 3

U-0	R/W-1	R-1	R-1	R/W-1	R/W-1	R/W-1	R/W-1
_	LCDIP	LCDIP RC2IP TX2IP		CTMUIP	CCP2IP	CCP1IP	RTCCIP
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 **Unimplemented:** Read as '0'

bit 6 LCDIP: LCD Interrupt Priority bit (valid when Type-B waveform with Non-Static mode is selected)

1 = High priority0 = Low priority

bit 5 RC2IP: AUSART Receive Priority Flag bit

1 = High priority0 = Low priority

bit 4 TX2IP: AUSART Transmit Interrupt Priority bit

1 = High priority0 = Low priority

bit 3 **CTMUIP:** CTMU Interrupt Priority bit

1 = High priority0 = Low priority

bit CCP2IP: CCP2 Interrupt Priority bit

1 = High priority0 = Low priority

bit CCP1IP: CCP1 Interrupt Priority bit

1 = High priority0 = Low priority

bit 0 RTCCIP: RTCC Interrupt Priority bit

1 = High priority0 = Low priority

x = Bit is unknown

8.5 RCON Register

Legend:

R = Readable bit

-n = Value at POR

The RCON register contains bits used to determine the cause of the last Reset or wake-up from Idle or Sleep modes. RCON also contains the bit that enables interrupt priorities (IPEN).

REGISTER 8-13: RCON: RESET CONTROL REGISTER

W = Writable bit

'1' = Bit is set

R/W-0	U-0	R/W-1	R/W-1	R-1	R-1	R/W-0	R/W-0
IPEN	_	CM	RI	TO	PD	POR	BOR
bit 7							bit 0

U = Unimplemented bit, read as '0'

'0' = Bit is cleared

bit 7	IPEN: Interrupt Priority Enable bit
	1 = Enable priority levels on interrupts
	0 = Disable priority levels on interrupts (PIC16CXXX Compatibility mode)
bit 6	Unimplemented: Read as '0'
bit 5	CM: Configuration Mismatch Flag bit
	1 = A Configuration Mismatch Reset has not occurred
	0 = A Configuration Mismatch Reset has occurred (Must be subsequently set in software.)
bit 4	RI: RESET Instruction Flag bit
	For details of bit operation, see Register 4-1.
bit 3	TO: Watchdog Timer Time-out Flag bit
	For details of bit operation, see Register 4-1.
bit 2	PD: Power-Down Detection Flag bit
	For details of bit operation, see Register 4-1.
bit 1	POR: Power-on Reset Status bit
	For details of bit operation, see Register 4-1.
bit 0	BOR: Brown-out Reset Status bit
	For details of bit operation, see Register 4-1.

8.6 INTx Pin Interrupts

External interrupts on the RB0/INT0, RB1/INT1, RB2/INT2 and RB3/INT3 pins are edge-triggered. If the corresponding INTEDGx bit in the INTCON2 register is set (= 1), the interrupt is triggered by a rising edge; if the bit is clear, the trigger is on the falling edge. When a valid edge appears on the RBx/INTx pin, the corresponding flag bit, INTxIF, is set. This interrupt can be disabled by clearing the corresponding enable bit, INTxIE. Flag bit, INTxIF, must be cleared in software in the Interrupt Service Routine before re-enabling the interrupt.

All external interrupts (INT0, INT1, INT2 and INT3) can wake-up the processor from the power-managed modes if bit INTxIE was set prior to going into the power-managed modes. If the Global Interrupt Enable bit, GIE, is set, the processor will branch to the interrupt vector following wake-up.

Interrupt priority for INT1, INT2 and INT3 is determined by the value contained in the interrupt priority bits, INT1IP (INTCON3<6>), INT2IP (INTCON3<7>) and INT3IP (INTCON2<1>). There is no priority bit associated with INT0. It is always a high-priority interrupt source.

8.7 TMR0 Interrupt

In 8-bit mode (which is the default), an overflow in the TMR0 register (FFh \rightarrow 00h) will set flag bit, TMR0IF. In 16-bit mode, an overflow in the TMR0H:TMR0L register pair (FFFFh \rightarrow 0000h) will set TMR0IF. The interrupt can be enabled/disabled by setting/clearing enable bit, TMR0IE (INTCON<5>). Interrupt priority for Timer0 is determined by the value contained in the interrupt priority bit, TMR0IP (INTCON2<2>). See **Section 10.0 "Timer0 Module"** for further details on the Timer0 module.

8.8 PORTB Interrupt-on-Change

An input change on PORTB<7:4> sets flag bit, RBIF (INTCON<0>). The interrupt can be enabled/disabled by setting/clearing enable bit, RBIE (INTCON<3>). Interrupt priority for PORTB interrupt-on-change is determined by the value contained in the interrupt priority bit, RBIP (INTCON2<0>).

8.9 Context Saving During Interrupts

During interrupts, the return PC address is saved on the stack. Additionally, the WREG, STATUS and BSR registers are saved on the Fast Return Stack. If a fast return from interrupt is not used (see **Section 5.3** "**Data Memory Organization**"), the user may need to save the WREG, STATUS and BSR registers on entry to the Interrupt Service Routine. Depending on the user's application, other registers may also need to be saved. Example 8-1 saves and restores the WREG, STATUS and BSR registers during an Interrupt Service Routine.

EXAMPLE 8-1: SAVING STATUS, WREG AND BSR REGISTERS IN RAM

```
MOVWF
       W TEMP
                                   ; W_TEMP is in virtual bank
MOVFF
       STATUS, STATUS_TEMP
                                   ; STATUS_TEMP located anywhere
MOVFF
       BSR, BSR_TEMP
                                   ; BSR_TMEP located anywhere
; USER ISR CODE
MOVFF
       BSR_TEMP, BSR
                                   ; Restore BSR
MOVF
       W_TEMP, W
                                   ; Restore WREG
       STATUS_TEMP, STATUS
MOVEE
                                   ; Restore STATUS
```

9.0 I/O PORTS

Depending on the device selected and features enabled, there are up to nine ports available. Some pins of the I/O ports are multiplexed with an alternate function from the peripheral features on the device. In general, when a peripheral is enabled, that pin may not be used as a general purpose I/O pin.

Each port has three memory mapped registers for its operation:

- TRIS register (Data Direction register)
- PORT register (reads the levels on the pins of the device)
- · LAT register (Output Latch register)

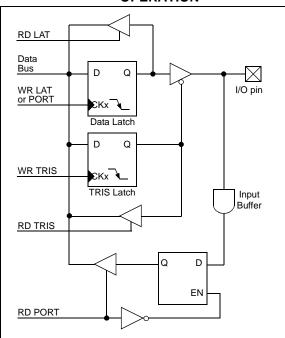
Reading the PORT register reads the current status of the pins, whereas writing to the PORT register writes to the Output Latch (LAT) register.

Setting a TRIS bit (= 1) makes the corresponding PORT pin an input (i.e., put the corresponding output driver in a high-impedance mode). Clearing a TRIS bit (= 0) makes the corresponding PORT pin an output (i.e., put the contents of the corresponding LAT bit on the selected pin).

The Output Latch (LAT register) is useful for read-modify-write operations on the value that the I/O pins are driving. Read-modify-write operations on the LAT register read and write the latched output value for the PORT register.

A simplified model of a generic I/O port, without the interfaces to other peripherals, is shown in Figure 9-1.

FIGURE 9-1: GENERIC I/O PORT OPERATION



9.1 I/O Port Pin Capabilities

When developing an application, the capabilities of the port pins must be considered. Outputs on some pins have higher output drive strength than others. Similarly, some pins can tolerate higher than VDD input levels.

9.1.1 INPUT PINS AND VOLTAGE CONSIDERATIONS

The voltage tolerance of pins used as device inputs is dependent on the pin's input function. Pins that are used as digital only inputs are able to handle DC voltages up to 5.5V, a level typical for digital logic circuits. In contrast, pins that also have analog input functions of any kind can only tolerate voltages up to VDD. Voltage excursions beyond VDD on these pins should be avoided.

Table 9-1 summarizes the input voltage capabilities. Refer to **Section 27.0 "Electrical Characteristics"** for more details.

TABLE 9-1: INPUT VOLTAGE TOLERANCE

PORT or Pin	Tolerated Input	Description	
PORTA<7:0>		Only VDD input levels	
PORTC<1:0>	Vpp	tolerated.	
PORTF<7:1>	VUU		
PORTG<3:2>			
PORTB<7:0>		Tolerates input lev-	
PORTC<7:2>		els above VDD, use-	
PORTD<7:0>		ful for most standard logic.	
PORTE<7:0>	5.5V	logio.	
PORTG<4, 1:0>			
PORTH<7:0> ⁽¹⁾			
PORTJ<7:0>(1)			

Note 1: Not available on PIC18F6XJ90 devices.

9.1.2 PIN OUTPUT DRIVE

When used as digital I/O, the output pin drive strengths vary for groups of pins intended to meet the needs for a variety of applications. In general, there are three classes of output pins in terms of drive capability.

PORTB and PORTC, as well as PORTA<7:6>, are designed to drive higher current loads, such as LEDs. PORTD, PORTE and PORTJ can also drive LEDs but only those with smaller current requirements. PORTF, PORTG and PORTH, along with PORTA<5:0>, have the lowest drive level but are capable of driving normal digital circuit loads with a high input impedance. Regardless of which port it is located on, all output pins in LCD Segment or Common mode have sufficient output to directly drive a display.

Table 9-2 summarizes the output capabilities of the ports. Refer to the "Absolute Maximum Ratings" in Section 27.0 "Electrical Characteristics" for more details.

TABLE 9-2: OUTPUT DRIVE LEVELS FOR VARIOUS PORTS

Low	Medium	High		
PORTA<5:0>	PORTD	PORTA<7:6>		
PORTF	PORTE	PORTB		
PORTG	PORTJ ⁽¹⁾	PORTC		
PORTH ⁽¹⁾				

Note 1: Not available on PIC18F6XJ90 devices.

9.1.3 PULL-UP CONFIGURATION

Four of the I/O ports (PORTB, PORTD, PORTE and PORTJ) implement configurable weak pull-ups on all pins. These are internal pull-ups that allow floating digital input signals to be pulled to a consistent level without the use of external resistors.

The pull-ups are enabled with a single bit for each of the ports: RBPU (INTCON2<7>) for PORTB, and RDPU, REPU and PJPU (PORTG<7:5>) for the other ports.

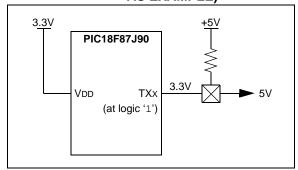
9.1.4 OPEN-DRAIN OUTPUTS

The output pins for several peripherals are also equipped with a configurable, open-drain output option. This allows the peripherals to communicate with external digital logic, operating at a higher voltage level, without the use of level translators.

The open-drain option is implemented on port pins specifically associated with the data and clock outputs of the USARTs, the MSSP module (in SPI mode) and the CCP modules. This option is selectively enabled by setting the open-drain control bit for the corresponding module in TRISG and LATG. Their configuration is discussed in more detail in Section 9.4 "PORTC, TRISC and LATC Registers", Section 9.6 "PORTE, TRISE and LATE Registers" and Section 9.8 "PORTG, TRISG and LATG Registers".

When the open-drain option is required, the output pin must also be tied through an external pull-up resistor provided by the user to a higher voltage level, up to 5V (Figure 9-2). When a digital logic high signal is output, it is pulled up to the higher voltage level.

FIGURE 9-2: USING THE OPEN-DRAIN OUTPUT (USART SHOWN AS EXAMPLE)



9.2 PORTA, TRISA and LATA Registers

PORTA is an 8-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISA and LATA.

RA4/T0CKI is a Schmitt Trigger input. All other PORTA pins have TTL input levels and full CMOS output drivers.

The RA4 pin is multiplexed with the Timer0 clock input and one of the LCD segment drives. RA5 and RA<3:0> are multiplexed with analog inputs for the A/D converter.

The operation of the analog inputs as A/D converter inputs is selected by clearing or setting the PCFG<3:0> control bits in the ADCON1 register. The corresponding TRISA bits control the direction of these pins, even when they are being used as analog inputs. The user must ensure the bits in the TRISA register are maintained set when using them as analog inputs.

Note: RA5 and RA<3:0> are configured as analog inputs on any Reset and are read as '0'. RA4 is configured as a digital input.

OSC2/CLKO/RA6 and OSC1/CLKI/RA7 normally serve as the external circuit connections for the external (primary) oscillator circuit (HS Oscillator modes), or the external clock input and output (EC Oscillator modes). In these cases, RA6 and RA7 are not available as digital I/O and their corresponding TRIS and LAT bits are read as '0'. When the device is configured to use INTOSC or INTRC as the default oscillator mode (FOSC2 Configuration bit is '0'), RA6 and RA7 are automatically configured as digital I/O; the oscillator and clock in/clock out functions are disabled.

RA1, RA4 and RA5 are multiplexed with LCD segment drives, controlled by bits in the LCDSE1 and LCDSE2 registers. I/O port functionality is only available when the LCD segments are disabled.

EXAMPLE 9-1: INITIALIZING PORTA

CLRF	PORTA	; Initialize PORTA by
		; clearing output latches
CLRF	LATA	; Alternate method to
		; clear output data latches
MOVLW	07h	; Configure A/D
MOVWF	ADCON1	; for digital inputs
MOVLW	0BFh	; Value used to initialize
		; data direction
MOVWF	TRISA	; Set RA<7, 5:0> as inputs,
		; RA<6> as output

TABLE 9-3: PORTA FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RA0/AN0	RA0	0	0	DIG	LATA<0> data output; not affected by analog input.
		1	1	TTL	PORTA<0> data input; disabled when analog input enabled.
	AN0	1	I	ANA	A/D input channel 0. Default input configuration on POR; does not affect digital output.
RA1/AN1/SEG18	RA1	0	0	DIG	LATA<1> data output; not affected by analog input.
		1	I	TTL	PORTA<1> data input; disabled when analog input enabled.
	AN1	1	_	ANA	A/D input channel 1. Default input configuration on POR; does not affect digital output.
	SEG18	х	0	ANA	LCD segment 18 output; disables all other pin functions.
RA2/AN2/VREF-	RA2	0	0	DIG	LATA<2> data output; not affected by analog input.
		1	I	TTL	PORTA<2> data input; disabled when analog functions enabled.
	AN2	1	ı	ANA	A/D input channel 2. Default input configuration on POR.
	VREF-	1	-	ANA	A/D and Comparator low reference voltage input.
RA3/AN3/VREF+	RA3	0	0	DIG	LATA<3> data output; not affected by analog input.
		1	ı	TTL	PORTA<3> data input; disabled when analog input enabled.
	AN3	1	-	ANA	A/D input channel 3. Default input configuration on POR.
	VREF+	1	ı	ANA	A/D and Comparator high reference voltage input.
RA4/T0CKI/	RA4	0	0	DIG	LATA<4> data output.
SEG14		1	-	ST	PORTA<4> data input. Default configuration on POR.
	T0CKI	х	I	ST	Timer0 clock input.
	SEG14	х	0	ANA	LCD segment 14 output; disables all other pin functions.
RA5/AN4/SEG15	RA5	0	0	DIG	LATA<5> data output; not affected by analog input.
		1	I	TTL	PORTA<5> data input; disabled when analog input enabled.
	AN4	1	ı	ANA	A/D input channel 4. Default configuration on POR.
	SEG15	х	0	ANA	LCD segment 15 output; disables all other pin functions.
OSC2/CLKO/RA6	OSC2	х	0	ANA	Main oscillator feedback output connection (HS and HSPLL modes).
	CLKO	х	0	DIG	System cycle clock output (Fosc/4) (EC and ECPLL modes).
	RA6	0	0	DIG	LATA<6> data output; disabled when FOSC2 Configuration bit is set.
		1	ı	TTL	PORTA<6> data input; disabled when FOSC2 Configuration bit is set.
OSC1/CLKI/RA7	OSC1	x I ANA Main oscillator input connection (HS and HSPLL mode		Main oscillator input connection (HS and HSPLL modes).	
	CLKI	х	I	ANA	Main external clock source input (EC and ECPLL modes).
	RA7	0	0	DIG	LATA<7> data output; disabled when FOSC2 Configuration bit is set.
		1	ı	TTL	PORTA<7> data input; disabled when FOSC2 Configuration bit is set.

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input, TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

TABLE 9-4: SUMMARY OF REGISTERS ASSOCIATED WITH PORTA

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTA	RA7 ⁽¹⁾	RA6 ⁽¹⁾	RA5	RA4	RA3	RA2	RA1	RA0	57
LATA	LATA7 ⁽¹⁾	LATA6 ⁽¹⁾	LATA5	LATA4	LATA3	LATA2	LATA1	LATA0	56
TRISA	TRISA7 ⁽¹⁾	TRISA6 ⁽¹⁾	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	56
ADCON1	TRIGSEL	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	55
LCDSE1	SE15	SE14	SE13	SE12	SE11	SE10	SE09	SE08	55
LCDSE2	SE23	SE22	SE21	SE20	SE19	SE18	SE17	SE16	55

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PORTA.

Note 1: These bits are enabled depending on the oscillator mode selected. When not enabled as PORTA pins, they are disabled and read as 'x'.

9.3 PORTB, TRISB and LATB Registers

PORTB is an 8-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISB and LATB. All pins on PORTB are digital only and tolerate voltages up to 5.5V.

EXAMPLE 9-2: INITIALIZING PORTB

CLRF	PORTB	; Initialize PORTB by ; clearing output
CLRF	LATB	<pre>; data latches ; Alternate method ; to clear output ; data latches</pre>
MOVLW	0CFh	; Value used to ; initialize data ; direction
MOVWF	TRISB	; Set RB<3:0> as inputs ; RB<5:4> as outputs ; RB<7:6> as inputs

Each of the PORTB pins has a weak internal pull-up. A single control bit can turn on all the pull-ups. This is performed by clearing bit RBPU (INTCON2<7>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on a Power-on Reset.

Four of the PORTB pins (RB<7:4>) have an interrupt-on-change feature. Only pins configured as inputs can cause this interrupt to occur (i.e., any RB7:RB4 pin configured as an output is excluded from the interrupt-on-change comparison). The input pins (of RB<7:4>) are compared with the old value latched on the last read of PORTB. The "mismatch" outputs of RB<7:4> are ORed together to generate the RB Port Change Interrupt with Flag bit, RBIF (INTCON<0>).

This interrupt can wake the device from power-managed modes. The user, in the Interrupt Service Routine, can clear the interrupt in the following manner:

- Any read or write of PORTB (except with the MOVFF (ANY), PORTB instruction). This will end the mismatch condition.
- b) Clear flag bit, RBIF.

A mismatch condition will continue to set flag bit, RBIF. Reading PORTB will end the mismatch condition and allow flag bit, RBIF, to be cleared.

The interrupt-on-change feature is recommended for wake-up on key depression operation and operations where PORTB is only used for the interrupt-on-change feature. Polling of PORTB is not recommended while using the interrupt-on-change feature.

RB<3:2> are multiplexed as CTMU edge inputs.

RB<5:0> also are multiplexed with LCD segment drives, controlled by bits in the LCDSE1 and LCDSE3 registers. I/O port functionality is only available when the LCD segments are disabled.

TABLE 9-5: PORTB FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description		
RB0/INT0/SEG30	RB0	0	0	DIG	LATB<0> data output.		
		1	I	TTL	PORTB<0> data input; weak pull-up when RBPU bit is cleared.		
	INT0	1	I	ST	External interrupt 0 input.		
	SEG30	х	0	ANA	LCD segment 30 output; disables all other pin functions.		
RB1/INT1/SEG8	RB1	0	0	DIG	LATB<1> data output.		
		1	I	TTL	PORTB<1> data input; weak pull-up when RBPU bit is cleared.		
	INT1	1	I	ST	External interrupt 1 input.		
	SEG8	х	0	ANA	LCD segment 8 output; disables all other pin functions.		
RB2/INT2/SEG9/	RB2	0	0	DIG	LATB<2> data output.		
CTED1		1	I	TTL	PORTB<2> data input; weak pull-up when RBPU bit is cleared.		
	INT2	1	I	ST	External interrupt 2 input.		
	SEG9	х	0	ANA	LCD segment 9 output; disables all other pin functions.		
	CTED1	х	I	ST	CTMU Edge 1 input.		
RB3/INT3/SEG10/	RB3	0	0	DIG	LATB<3> data output.		
CTED2		1	I	TTL	PORTB<3> data input; weak pull-up when RBPU bit is cleared.		
	INT3	1	I	ST	External interrupt 3 input.		
	SEG10	х	0	ANA	LCD segment 10 output; disables all other pin functions.		
	CTED2	х	I	ST	CTMU Edge 2 input.		
RB4/KBI0/SEG11	RB4	0	0	DIG	LATB<4> data output.		
		1	I	TTL	PORTB<4> data input; weak pull-up when RBPU bit is cleared.		
	KBI0	1	I	TTL	Interrupt-on-pin change.		
	SEG11	х	0	ANA	LCD segment 11 output; disables all other pin functions.		
RB5/KBI1/SEG29	RB5	0	0	DIG	LATB<5> data output.		
		1	1	TTL	PORTB<5> data input; weak pull-up when RBPU bit is cleared.		
	KBI1	1	I	TTL	Interrupt-on-pin change.		
	SEG29	х	0	ANA	LCD segment 29 output; disables all other pin functions.		
RB6/KBI2/PGC	RB6	0	0	DIG	LATB<6> data output.		
		1	I	TTL	PORTB<6> data input; weak pull-up when RBPU bit is cleared.		
	KBI2	1	I	TTL	Interrupt-on-pin change.		
	PGC	х	I	ST	Serial execution (ICSP™) clock input for ICSP and ICD operation.		
RB7/KBI3/PGD	RB7	0	0	DIG	LATB<7> data output.		
		1	I	TTL	PORTB<7> data input; weak pull-up when RBPU bit is cleared.		
	KBI3	1	I	TTL	Interrupt-on-pin change.		
	PGD	х	0	DIG	Serial execution data output for ICSP and ICD operation.		
		х	I	ST	Serial execution data input for ICSP and ICD operation.		

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input, TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

TABLE 9-6: SUMMARY OF REGISTERS ASSOCIATED WITH PORTB

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	57
LATB	LATB7	LATB6	LATB5	LATB4	LATB3	LATB2	LATB1	LATB0	56
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	56
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53
INTCON2	RBPU	INTEDG0	INTEDG1	INTEDG2	INTEDG3	TMR0IP	INT3IP	RBIP	53
INTCON3	INT2IP	INT1IP	INT3IE	INT2IE	INT1IE	INT3IF	INT2IF	INT1IF	53
LCDSE1	SE15	SE14	SE13	SE12	SE11	SE10	SE09	SE08	55
LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	55

Legend: Shaded cells are not used by PORTB.

9.4 PORTC, TRISC and LATC Registers

PORTC is an 8-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISC and LATC. Only PORTC pins, RC2 through RC7, are digital only pins and can tolerate input voltages up to 5.5V.

PORTC is multiplexed with CCP, MSSP and EUSART peripheral functions (Table 9-7). The pins have Schmitt Trigger input buffers. The pins for CCP, SPI and EUSART are also configurable for open-drain output whenever these functions are active. Open-drain configuration is selected by setting the SPIOD, CCPxOD, and U1OD control bits (TRISG<7:5> and LATG<6>, respectively).

RC1 is normally configured as the default peripheral pin for the CCP2 module. Assignment of CCP2 is controlled by Configuration bit, CCP2MX (default state, CCP2MX = 1).

When enabling peripheral functions, care should be taken in defining TRIS bits for each PORTC pin. Some peripherals override the TRIS bit to make a pin an output, while other peripherals override the TRIS bit to make a pin an input. The user should refer to the corresponding peripheral section for the correct TRIS bit settings.

Note: These pins are configured as digital inputs on any device Reset.

The contents of the TRISC register are affected by peripheral overrides. Reading TRISC always returns the current contents, even though a peripheral device may be overriding one or more of the pins.

RC<7:1> pins are multiplexed with LCD segment drives, controlled by bits in the LCDSE1, LCDSE2, LCDSE3 and LCDSE4 registers. I/O port functionality is only available when the LCD segments are disabled.

EXAMPLE 9-3: INITIALIZING PORTC

CLRF	PORTC	; Initialize PORTC by
		; clearing output
		; data latches
CLRF	LATC	; Alternate method
		; to clear output
		; data latches
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISC	; Set RC<3:0> as inputs
		; RC<5:4> as outputs
		; RC<7:6> as inputs

TABLE 9-7: PORTC FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description	
RC0/T1OSO/	RC0	0	0	DIG	LATC<0> data output.	
T13CKI		1	1	ST	PORTC<0> data input.	
	T1OSO	х	0	ANA	Timer1 oscillator output; enabled when Timer1 oscillator enabled. Disables digital I/O and LCD segment driver.	
	T13CKI	1	I	ST	Timer1/Timer3 counter input.	
RC1/T1OSI/	RC1	0	0	DIG	LATC<1> data output.	
CCP2/SEG32		1	ı	ST	PORTC<1> data input.	
	T1OSI	х	ı	ANA	Timer1 oscillator input.	
	CCP2 ⁽¹⁾	0	0	DIG	CCP2 Compare/PWM output.	
		1	I	ST	CCP2 Capture input.	
	SEG32	х	0	ANA	LCD segment 32 output; disables all other pin functions.	
RC2/CCP1/ SEG13	RC2	0	0	DIG	LATC<2> data output.	
02013	0004	1	1	ST	PORTC<2> data input.	
	CCP1	0	0	DIG	CCP1 Compare/PWM output; takes priority over port data.	
	05040	1	1	ST	CCP1 Capture input.	
Des/cok/col/	SEG13	x	0	ANA	LCD segment 13 output; disables all other pin functions.	
RC3/SCK/SCL/ SEG17	RC3	0	0	DIG	LATC<3> data output. PORTC<3> data input.	
	SCK	0	0	DIG	SPI clock output (MSSP module); takes priority over port data.	
	JOIN	1		ST	SPI clock output (MSSP module).	
	SCL	0	0	DIG	I ² C [™] clock output (MSSP module); takes priority over port data.	
	002	1	ı	I2C	I ² C clock input (MSSP module); input type depends on module setting.	
	SEG17	x	0	ANA	LCD segment 17 output; disables all other pin functions.	
RC4/SDI/SDA/	RC4	0	0	DIG	LATC<4> data output.	
SEG16		1	I	ST	PORTC<4> data input.	
	SDI		I	ST	SPI data input (MSSP module).	
	SDA	1	0	DIG	I ² C data output (MSSP module); takes priority over port data.	
		1	I	I2C	I ² C data input (MSSP module); input type depends on module setting.	
	SEG16	х	0	ANA	LCD segment 16 output; disables all other pin functions.	
RC5/SDO/	RC5	0	0	DIG	LATC<5> data output.	
SEG12		1	I	ST	PORTC<5> data input.	
	SDO	0	0	DIG	SPI data output (MSSP module).	
	SEG12	х	0	ANA	LCD segment 12 output; disables all other pin functions.	
RC6/TX1/CK1/	RC6	0	0	DIG	LATC<6> data output.	
SEG27		1	I	ST	PORTC<6> data input.	
	TX1	1	0	DIG	Synchronous serial data output (EUSART module); takes priority over port data.	
	CK1	1	0	DIG	Synchronous serial data input (EUSART module); user must configure as an input.	
	0.000	1	-	ST	Synchronous serial clock input (EUSART module).	
DOZIDYA IDTA I	SEG27	X	0	ANA		
RC7/RX1/DT1/ SEG28	RC7	0	0	DIG	LATC<7> data output.	
32323	DV4	1	-	ST	PORTC<7> data input.	
	RX1	1	1	ST	Asynchronous serial receive data input (EUSART module).	
	DT1	1	0	DIG	Synchronous serial data output (EUSART module); takes priority over port data.	
	05000	1	1	ST	Synchronous serial data input (EUSART module); user must configure as an input.	
	SEG28	Х	0	ANA	LCD segment 28 output; disables all other pin functions.	

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input, TTL = TTL Buffer Input, $12C = 1^2C/SMBus$ Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

Note 1: Default assignment for CCP2 when CCP2MX Configuration bit is set.

TABLE 9-8: SUMMARY OF REGISTERS ASSOCIATED WITH PORTC

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	57
LATC	LATC7	LATBC6	LATC5	LATCB4	LATC3	LATC2	LATC1	LATC0	56
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	56
LATG	U2OD	U1OD	_	LATG4	LATG3	LATG2	LATG1	LATG0	56
TRISG	SPIOD	CCP2OD	CCP10D	TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	56
LCDSE1	SE15	SE14	SE13	SE12	SE11	SE10	SE09	SE08	55
LCDSE2	SE23	SE22	SE21	SE20	SE19	SE18	SE17	SE16	55
LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	55
LCDSE4	SE39 ⁽¹⁾	SE38 ⁽¹⁾	SE37 ⁽¹⁾	SE36 ⁽¹⁾	SE35 ⁽¹⁾	SE34 ⁽¹⁾	SE33 ⁽¹⁾	SE32	55

Legend: Shaded cells are not used by PORTC.

Note 1: Unimplemented on PIC18F6XJ90 devices, read as '0'.

9.5 PORTD, TRISD and LATD Registers

PORTD is an 8-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISD and LATD. All pins on PORTD are digital only and tolerate voltages up to 5.5V.

All pins on PORTD are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

Note: These pins are configured as digital inputs on any device Reset.

Each of the PORTD pins has a weak internal pull-up. A single control bit can turn off all the pull-ups. This is performed by clearing bit RDPU (PORTG<7>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on all device Resets.

All of the PORTD pins are multiplexed with LCD segment drives, controlled by bits in the LCDSE0 register. RD0 is multiplexed with CTMU Pulse Generator output.

I/O port functionality is only available when the LCD segments are disabled.

EXAMPLE 9-4: INITIALIZING PORTD

CLRF	PORTD	; Initialize PORTD by ; clearing output
CLRF	LATD	<pre>; data latches ; Alternate method</pre>
		; to clear output ; data latches
MOVLW	0CFh	; initialize data
MOVWF	TRISD	; direction ; Set RD<3:0> as inputs ; RD<5:4> as outputs ; RD<7:6> as inputs

TABLE 9-9: PORTD FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RD0/SEG0/	RD0	0	0	DIG	LATD<0> data output.
CTPLS		1	ı	ST	PORTD<0> data input.
	SEG0	х	0	ANA	LCD segment 0 output; disables all other pin functions.
	CTPLS	х	0	DIG	CTMU Pulse Generator output
RD1/SEG1	RD1	0	0	DIG	LATD<1> data output.
		1	1	ST	PORTD<1> data input.
	SEG1	х	0	ANA	LCD segment 1 output; disables all other pin functions.
RD2/SEG2	RD2	0	0	DIG	LATD<2> data output.
		1	I	ST	PORTD<2> data input.
	SEG2	х	0	ANA	LCD segment 2 output; disables all other pin functions.
RD3/SEG3	RD3	0	0	DIG	LATD<3> data output.
		1	ı	ST	PORTD<3> data input.
	SEG3	х	0	ANA	LCD segment 3 output; disables all other pin functions.
RD4/SEG4	RD4	0	0	DIG	LATD<4> data output.
		1	1	ST	PORTD<4> data input.
	SEG4	х	0	ANA	LCD segment 4 output; disables all other pin functions.
RD5/SEG5	RD5	0	0	DIG	LATD<5> data output.
		1	ı	ST	PORTD<5> data input.
	SEG5	х	0	ANA	LCD segment 5 output; disables all other pin functions.
RD6/SEG6	RD6	0	0	DIG	LATD<6> data output.
		1	1	ST	PORTD<6> data input.
	SEG6	х	0	ANA	LCD segment 6 output; disables all other pin functions.
RD7/SEG7	RD7	0	0	DIG	LATD<7> data output.
		1	ı	ST	PORTD<7> data input.
	SEG7	х	ı	ANA	LCD segment 7 output; disables all other pin functions.

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input,

x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

TABLE 9-10: SUMMARY OF REGISTERS ASSOCIATED WITH PORTD

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTD	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	57
LATD	LATD7	LATD6	LATD5	LATD4	LATD3	LATD2	LATD1	LATD0	56
TRISD	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	56
PORTG	RDPU	REPU	RJPU ⁽¹⁾	RG4	RG3	RG2	RG1	RG0	56
LCDSE0	SE07	SE06	SE05	SE04	SE03	SE02	SE01	SE00	55

Legend: Shaded cells are not used by PORTD.

Note 1: Unimplemented on PIC18F6XJ90 devices, read as '0'.

9.6 PORTE, TRISE and LATE Registers

PORTE is a 7-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISE and LATE. All pins on PORTE are digital only and tolerate voltages up to 5.5V.

All pins on PORTE are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output. The RE7 pin is also configurable for open-drain output when CCP2 is active on this pin. Open-drain configuration is selected by setting the CCP2OD control bit (TRISG<6>)

Note: These pins are configured as digital inputs on any device Reset.

Each of the PORTE pins has a weak internal pull-up. A single control bit can turn off all the pull-ups. This is performed by clearing bit, REPU (PORTG<6>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on any device Reset.

Pins RE<6:3> are multiplexed with the LCD common drives. I/O port functions are only available on those PORTE pins depending on which commons are active. The configuration is determined by the LMUX<1:0> control bits (LCDCON<1:0>). The availability is summarized in Table 9-11.

TABLE 9-11: PORTE PINS AVAILABLE IN DIFFERENT LCD DRIVE CONFIGURATIONS

LCDCON <1:0>	Active LCD Commons	PORTE Available for I/O
00	COM0	RE6, RE5, RE4
01	COM0, COM1	RE6, RE5
10	COM0, COM1 and COM2	RE6
11	All (COM0 through COM3)	None

Pins RE1 and RE0 are multiplexed with the functions of LCDBIAS2 and LCDBIAS1. When LCD bias generation is required (i.e., any application where the device is connected to an external LCD), these pins cannot be used as digital I/O.

Note: The pin corresponding to RE2 of other PIC18F parts has the function of LCDBIAS3 in this device. It cannot be used as digital I/O.

RE7 is multiplexed with LCD segment drive (SEG31) controlled by the LCDSE3<7> bit. I/O port function is only available when the segment is disabled.

RE7 can also be configured as the alternate peripheral pin for the CCP2 module. This is done by clearing the CCP2MX Configuration bit.

EXAMPLE 9-5: INITIALIZING PORTE

CLRF	PORTE	; Initialize PORTE by ; clearing output
CLRF	LATE	<pre>; data latches ; Alternate method</pre>
		; to clear output
		; data latches
MOVLW	03h	; Value used to
		; initialize data
		; direction
MOVWF	TRISE	; Set RE<1:0> as inputs
		; RE<7:2> as outputs

TABLE 9-12: PORTE FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RE0/LCDBIAS1	RE0	0	0	DIG	LATE<0> data output.
		1	ı	ST	PORTE<0> data input.
	LCDBIAS1	_	1	ANA	LCD module bias voltage input.
RE1/LCDBIAS2	RE1	0	0	DIG	LATE<1> data output.
		1	-	ST	PORTE<1> data input.
	LCDBIAS2	_	-	ANA	LCD module bias voltage input.
RE3/COM0	RE3	0	0	DIG	LATE<3> data output.
		1	I	ST	PORTE<3> data input.
	COM0	х	0	ANA	LCD Common 0 output; disables all other outputs.
RE4/COM1	RE4	0	0	DIG	LATE<4> data output.
		1	I	ST	PORTE<4> data input.
	COM1	х	0	ANA	LCD Common 1 output; disables all other outputs.
RE5/COM2	RE5	0	0	DIG	LATE<5> data output.
		1	I	ST	PORTE<5> data input.
	COM2	х	0	ANA	LCD Common 2 output; disables all other outputs.
RE6/COM3	RE6	0	0	DIG	LATE<6> data output.
		1	I	ST	PORTE<6> data input.
	COM3	х	0	ANA	LCD Common 3 output; disables all other outputs.
RE7/CCP2/	RE7	0	0	DIG	LATE<7> data output.
SEG31		1	I	ST	PORTE<7> data input.
	CCP2 ⁽¹⁾	0	0	DIG	CCP2 Compare/PWM output; takes priority over port data.
		1	ı	ST	CCP2 Capture input.
	SEG31	х	0	ANA	Segment 31 analog output for LCD; disables digital output.

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input,

x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

Note 1: Alternate assignment for CCP2 when CCP2MX Configuration bit is cleared.

TABLE 9-13: SUMMARY OF REGISTERS ASSOCIATED WITH PORTE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTE	RE7	RE6	RE5	RE4	RE3	_	RE1	RE0	57
LATE	LATE7	LATE6	LATE5	LATE4	LATE3	_	LATE1	LATE0	56
TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	_	TRISE1	TRISE0	56
PORTG	RDPU	REPU	RJPU ⁽¹⁾	RG4	RG3	RG2	RG1	RG0	56
TRISG	SPIOD	CCP2OD	CCP10D	TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	56
LCDCON	LCDEN	SLPEN	WERR	_	CS1	CS0	LMUX1	LMUX0	55
LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	55

Legend: Shaded cells are not used by PORTE.

Note 1: Unimplemented on PIC18F6XJ90 devices, read as '0'.

9.7 PORTF, LATF and TRISF Registers

PORTF is a 7-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISF and LATF. All pins on PORTF are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

PORTF is multiplexed with analog peripheral functions, as well as LCD segments. Pins RF1 through RF6 may be used as comparator inputs or outputs by setting the appropriate bits in the CMCON register. To use RF<6:3> as digital inputs, it is also necessary to turn off the comparators.

- **Note 1:** On device Resets, pins RF6:RF1 are configured as analog inputs and are read as '0'.
 - 2: To configure PORTF as digital I/O, turn off comparators and set ADCON1 value.

PORTF is also multiplexed with LCD segment drives controlled by bits in the LCDSE2 and LCDSE3 registers. I/O port functions are only available when the segments are disabled.

EXAMPLE 9-6: INITIALIZING PORTF

CLRF	PORTF	; Initialize PORTF by ; clearing output ; data latches
CLRF	LATF	; Alternate method
		; to clear output
		; data latches
MOVLW	07h	;
MOVWF	CMCON	; Turn off comparators
MOVLW	0Fh	;
MOVWF	ADCON1	; Set PORTF as digital I/O
MOVLW	0CEh	; Value used to
		; initialize data
		; direction
MOVWF	TRISF	; Set RF3:RF1 as inputs
		; RF5:RF4 as outputs
		; RF7:RF6 as inputs

TABLE 9-14: PORTF FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description			
RF1/AN6/C2OUT/	RF1	0	0	DIG	LATF<1> data output; not affected by analog input.			
SEG19		1	- 1	ST	PORTF<1> data input; disabled when analog input enabled.			
	AN6	1	- 1	ANA	A/D input channel 6. Default configuration on POR.			
	C2OUT	0	0	DIG	Comparator 2 output; takes priority over port data.			
	SEG19	х	0	ANA	LCD segment 19 output; disables all other pin functions.			
RF2/AN7/C1OUT/	RF2	0	0	DIG	LATF<2> data output; not affected by analog input.			
SEG20		1	- 1	ST	PORTF<2> data input; disabled when analog input enabled.			
	AN7	1	- 1	ANA	A/D input channel 7. Default configuration on POR.			
	C1OUT	0	0	DIG	Comparator 1 output; takes priority over port data.			
	SEG20	х	0	ANA	LCD segment 20 output; disables all other pin functions.			
RF3/AN8/SEG21/	RF3	0	0	DIG	LATF<3> data output; not affected by analog input.			
C2INB		1		ST	PORTF<3> data input; disabled when analog input enabled.			
	AN8	1	_	ANA	A/D input channel 8 and Comparator C2+ input. Default input configuration on POR; not affected by analog output.			
	SEG21	х	0	ANA	LCD segment 21 output; disables all other pin functions.			
	C2INB	1	-	ANA	Comparator 2 input B.			
RF4/AN9/SEG22/	RF4	0	0	DIG	LATF<4> data output; not affected by analog input.			
C2INA		1	1	ST	PORTF<4> data input; disabled when analog input enabled.			
	AN9	1	I	ANA	A/D input channel 9 and Comparator C2- input. Default input configuration on POR; does not affect digital output.			
	SEG22	х	0	ANA	LCD segment 22 output; disables all other pin functions.			
	C2INA	1	I	ANA	Comparator 2 input A.			
RF5/AN10/CVREF/ SEG23/C1INB	RF5	0	0	DIG	LATF<5> data output; not affected by analog input. Disabled when CVREF output enabled.			
		1	I	ST	PORTF<5> data input; disabled when analog input enabled. Disabled when CVREF output enabled.			
	AN10	1	I	ANA	A/D input channel 10 and Comparator C1+ input. Default input configuration on POR.			
	CVREF	х	0	ANA	Comparator voltage reference output. Enabling this feature disables digital I/O.			
	SEG23	х	0	ANA	LCD segment 23 output; disables all other pin functions.			
	C1INB	1	1	ANA	Comparator 1 input B.			
RF6/AN11/SEG24/	RF6	0	0	DIG	LATF<6> data output; not affected by analog input.			
C1INA		1	I	ST	PORTF<6> data input; disabled when analog input enabled.			
	AN11	1	I	ANA	A/D input channel 11 and Comparator C1- input. Default input configuration on POR; does not affect digital output.			
	SEG24	х	0	ANA	LCD segment 24 output; disables all other pin functions.			
	C1INA	1	I	ANA	Comparator 1 input A.			
RF7/AN5/SS/	RF7	0	0	DIG	LATF<7> data output; not affected by analog input.			
SEG25		1	I	ST	PORTF<7> data input; disabled when analog input enabled.			
ļ	AN5	1	I	ANA	A/D input channel 5. Default configuration on POR.			
ļ	SS	1	ı	TTL	Slave select input for MSSP module.			
-	SEG25	x	0	ANA	LCD segment 25 output; disables all other pin functions.			

TABLE 9-15: SUMMARY OF REGISTERS ASSOCIATED WITH PORTF

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTF	RF7	RF6	RF5	RF4	RF3	RF2	RF1	_	56
LATF	LATF7	LATF6	LATF5	LATF4	LATF3	LATF2	LATF1	_	56
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1		56
ADCON1	TRIGSEL	1	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	55
CMCON	C2OUT	C1OUT	C2INV	C1INV	CIS	CM2	CM1	CM0	55
CVRCON	CVREN	CVROE	CVRR	CVRSS	CVR3	CVR2	CVR1	CVR0	55
LCDSE2	SE23	SE22	SE21	SE20	SE19	SE18	SE17	SE16	55
LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	55

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PORTF.

9.8 PORTG, TRISG and LATG Registers

PORTG is a 5-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISG and LATG. All pins on PORTG are digital only and tolerate voltages up to 5.5V.

PORTG is multiplexed with both AUSART and LCD functions (Table 9-16). When operating as I/O, all PORTG pins have Schmitt Trigger input buffers. The RG1 pin is also configurable for open-drain output when the AUSART is active. Open-drain configuration is selected by setting the U2OD control bit (LATG<7>).

RG4 is multiplexed with LCD segment drives controlled by bits in the LCDSE2 register and as the RTCC pin. The I/O port function is only available when the segments are disabled.

RG3 and RG2 are multiplexed with VLCAP pins for the LCD charge pump, and RG0 is multiplexed with LCDBIAS0 bias voltage input. When these pins are used for LCD bias generation, the I/O and other functions are unavailable.

When enabling peripheral functions, care should be taken in defining TRIS bits for each PORTG pin. Some peripherals override the TRIS bit to make a pin an output, while other peripherals override the TRIS bit to make a pin an input. The user should refer to the corresponding peripheral section for the correct TRIS bit settings. The pin override value is not loaded into the TRIS register. This allows read-modify-write of the TRIS register without concern due to peripheral overrides.

Although the port itself is only five bits wide, the PORTG<7:5> bits are still implemented to control the weak pull-ups on the I/O ports associated with PORTD, PORTE and PORTJ. Setting these bits enables the respective port pull-ups.

Most of the corresponding TRISG and LATG bits are implemented as open-drain control bits for CCP1, CCP2 and SPI (TRISG<7:5>), and the USARTs (LATG<7:6>). Setting these bits configures the output pin for the corresponding peripheral for open-drain operation. LATG<5> is not implemented.

EXAMPLE 9-7: INITIALIZING PORTG

CLRF	PORTG	; Initialize PORTG by
		; clearing output
		; data latches
CLRF	LATG	; Alternate method
		; to clear output
		; data latches
MOVLW	04h	; Value used to
		; initialize data
		; direction
MOVWF	TRISG	; Set RG1:RG0 as outputs
		; RG2 as input
		; RG4:RG3 as inputs

TABLE 9-16: PORTG FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description		
RG0/LCDBIAS0	RG0	0	0	DIG	LATG<0> data output.		
		1	I	ST	PORTG<0> data input.		
	LCDBIAS0	х	I	ANA	LCD module bias voltage input.		
RG1/TX2/CK2	RG1	0	0	DIG	LATG<1> data output.		
		1	I	ST	PORTG<1> data input.		
	TX2	1	0	DIG	Synchronous serial data output (AUSART module); takes priority over port data.		
CK2 1 O DIG					Synchronous serial data input (AUSART module); user must configure as an input.		
		1	_	ST	Synchronous serial clock input (AUSART module).		
RG2/RX2/DT2/	RG2	0	0	DIG	LATG<2> data output.		
VLCAP1		1	Ι	ST	PORTG<2> data input.		
	RX2	1	I	ST	Asynchronous serial receive data input (AUSART module).		
	DT2	1	0	DIG	Synchronous serial data output (AUSART module); takes priority over port data.		
		1	_	ST	Synchronous serial data input (AUSART module); user must configure as an input.		
	VLCAP1	х	I	ANA	LCD charge pump capacitor input.		
RG3/VLCAP2	RG3	0	0	DIG	LATG<3> data output.		
		1	I	ST	PORTG<3> data input.		
	VLCAP2	х	Ι	ANA	LCD charge pump capacitor input.		
RG4/SEG26/	RG4	0	0	DIG	LATG<4> data output.		
RTCC		1	I	ST	PORTG<4> data input.		
	SEG26	х	0	ANA	LCD segment 26 output; disables all other pin functions.		
	RTCC	х	0	DIG	RTCC output.		

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input,

TABLE 9-17: SUMMARY OF REGISTERS ASSOCIATED WITH PORTG

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTG	RDPU	REPU	RJPU ⁽¹⁾	RG4	RG3	RG2	RG1	RG0	56
LATG	U2OD	U10D	_	LATG4	LATG3	LATG2	LATG1	LATG0	56
TRISG	SPIOD	CCP2OD	CCP10D	TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	56
LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	55

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PORTG.

Note 1: Unimplemented on PIC18F6XJ90 devices, read as '0'.

x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

9.9 PORTH, LATH and TRISH Registers

Note:	PORTH is available only on PIC18F8XJ90
	devices.

PORTH is an 8-bit wide, bidirectional I/O port. The corresponding Data Direction and Output Latch registers are TRISH and LATH. All pins are digital only and tolerate voltages up to 5.5V.

All pins on PORTH are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

All PORTH pins are multiplexed with LCD segment drives controlled by the LCDSE5 register. I/O port functions are only available when the segments are disabled.

EXAMPLE 9-8: INITIALIZING PORTH

CLRF	PORTH	; Initialize PORTH by ; clearing output
		; data latches
CLRF	LATH	; Alternate method
		; to clear output
		; data latches
MOVLW	0Fh	; Configure PORTH as
MOVWF	ADCON1	; digital I/O
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISH	; Set RH3:RH0 as inputs
		; RH5:RH4 as outputs
		; RH7:RH6 as inputs

TABLE 9-18: PORTH FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RH0/SEG47	RH0	0	0	DIG	LATH<0> data output.
		1	I	ST	PORTH<0> data input.
	SEG47	х	0	ANA	LCD segment 47 output; disables all other pin functions.
RH1/SEG46	RH1	0	0	DIG	LATH<1> data output.
		1	1	ST	PORTH<1> data input.
	SEG46	х	0	ANA	LCD segment 46 output; disables all other pin functions.
RH2/SEG45	RH2	0	0	DIG	LATH<2> data output.
		1		ST	PORTH<2> data input.
	SEG45	х	0	ANA	LCD segment 45 output; disables all other pin functions.
RH3/SEG44	RH3	0	0	DIG	LATH<3> data output.
		1	1	ST	PORTH<3> data input.
	SEG44	х	0	ANA	LCD segment 44 output; disables all other pin functions.
RH4/SEG40	RH4	0	0	DIG	LATH<4> data output.
		1	-	ST	PORTH<4> data input.
	SEG40	х	0	ANA	LCD segment 40 output; disables all other pin functions.
RH5/SEG41	RH5	0	0	DIG	LATH<5> data output.
		1		ST	PORTH<5> data input.
	SEG41	х	0	ANA	LCD segment 41 output; disables all other pin functions.
RH6/SEG42	RH6	0	0	DIG	LATH<6> data output.
		1	1	ST	PORTH<6> data input.
	SEG42	х	0	ANA	LCD segment 42 output; disables all other pin functions.
RH7/SEG43	RH7	0	0	DIG	LATH<7> data output.
		1	I	ST	PORTH<7> data input.
	SEG43	х	0	ANA	LCD segment 43 output; disables all other pin functions.

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input,

TABLE 9-19: SUMMARY OF REGISTERS ASSOCIATED WITH PORTH

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTH	RH7	RH6	RH5	RH4	RH3	RH2	RH1	RH0	56
LATH	LATH7	LATH6	LATH5	LATH4	LATH3	LATH2	LATH1	LATH0	56
TRISH	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	56
LCDSE5	SE47	SE46	SE45	SE44	SE43	SE42	SE41	SE40	55

x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

9.10 PORTJ, TRISJ and LATJ Registers

Note: PORTJ is available only on PIC18F8XJ90 devices.

PORTJ is an 8-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISJ and LATJ. All pins on PORTJ are digital only and tolerate voltages up to 5.5V.

All pins on PORTJ are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

Note: These pins are configured as digital inputs on any device Reset.

All PORTJ pins except RJ0 are multiplexed with LCD segment drives controlled by the LCDSE4 register. I/O port functions are only available on these pins when the segments are disabled.

Each of the PORTJ pins has a weak internal pull-up. The pull-ups are provided to keep the inputs at a known state for the external memory interface while powering up. A single control bit can turn off all the pull-ups. This is performed by clearing bit RJPU (PORTG<5>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on any device Reset.

EXAMPLE 9-9: INITIALIZING PORTJ

CLRF	PORTJ	; Initialize PORTJ by
		; clearing output latches
CLRF	LATJ	; Alternate method
		; to clear output latches
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISJ	; Set RJ3:RJ0 as inputs
		; RJ5:RJ4 as output
		; RJ7:RJ6 as inputs

TABLE 9-20: PORTJ FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description			
RJ0	RJ0	0	0	DIG	LATJ<0> data output.			
		1	I	ST	PORTJ<0> data input.			
RJ1/SEG33	RJ1	0	0	DIG	LATJ<1> data output.			
		1	-	ST	PORTJ<1> data input.			
	SEG33	х	0	ANA	LCD segment 33 output; disables all other pin functions.			
RJ2/SEG34	RJ2	0	0	DIG	LATJ<2> data output.			
		1	-	ST	PORTJ<2> data input.			
	SEG34	х	0	ANA	LCD segment 34 output; disables all other pin functions.			
RJ3/SEG35	RJ3	0	0	DIG	LATJ<3> data output.			
		1	-	ST	PORTJ<3> data input.			
	SEG35	х	0	ANA	LCD segment 35 output; disables all other pin functions.			
RJ4/SEG39	RJ4	0	0	DIG	LATJ<4> data output.			
		1	-	ST	PORTJ<4> data input.			
	SEG39	х	0	ANA	LCD segment 39 output; disables all other pin functions.			
RJ5/SEG38	RJ5	0	0	DIG	LATJ<5> data output.			
		1	-	ST	PORTJ<5> data input.			
	SEG38	х	0	ANA	LCD segment 38 output; disables all other pin functions.			
RJ6/SEG37	RJ6	0	0	DIG	LATJ<6> data output.			
		1	-	ST	PORTJ<6> data input.			
	SEG37	х	0	ANA	LCD segment 37 output; disables all other pin functions.			
RJ7/SEG36	RJ7	0	0	DIG	LATJ<7> data output.			
		1	I	ST	PORTJ<7> data input.			
	SEG36	х	0	ANA	LCD segment 36 output; disables all other pin functions.			

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input,

TABLE 9-21: SUMMARY OF REGISTERS ASSOCIATED WITH PORTJ

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTJ	RJ7	RJ6	RJ5	RJ4	RJ3	RJ2	RJ1	RJ0	56
LATJ	LATJ7	LATJ6	LATJ5	LATJ4	LATJ3	LATJ2	LATJ1	LATJ0	56
TRISJ	TRISJ7	TRISJ6	TRISJ5	TRISJ4	TRISJ3	TRISJ2	TRISJ1	TRISJ0	56
PORTG	RDPU	REPU	RJPU ⁽¹⁾	RG4	RG3	RG2	RG1	RG0	56
LCDSE4	SE39	SE38	SE37	SE36	SE35	SE34	SE33	SE32	55

Legend: Shaded cells are not used by PORTJ.

Note 1: Unimplemented on PIC18F6XJ90 devices, read as '0'.

x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

10.0 TIMERO MODULE

The Timer0 module incorporates the following features:

- Software selectable operation as a timer or counter in both 8-bit or 16-bit modes
- · Readable and writable registers
- Dedicated 8-bit, software programmable prescaler
- · Selectable clock source (internal or external)
- · Edge select for external clock
- Interrupt-on-overflow

The TOCON register (Register 10-1) controls all aspects of the module's operation, including the prescale selection; it is both readable and writable.

A simplified block diagram of the Timer0 module in 8-bit mode is shown in Figure 10-1. Figure 10-2 shows a simplified block diagram of the Timer0 module in 16-bit mode.

REGISTER 10-1: T0CON: TIMER0 CONTROL REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
TMR0ON	T08BIT	T0CS	T0SE	PSA	T0PS2	T0PS1	T0PS0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	TMR00N: Timer0 On/Off Control bit
	1 = Enables Timer0 0 = Stops Timer0
bit 6	T08BIT: Timer0 8-Bit/16-Bit Control bit
	1 = Timer0 is configured as an 8-bit timer/counter0 = Timer0 is configured as a 16-bit timer/counter
bit 5	T0CS: Timer0 Clock Source Select bit
	1 = Transition on T0CKI pin
	0 = Internal instruction cycle clock (CLKO)
bit 4	T0SE: Timer0 Source Edge Select bit
	1 = Increment on high-to-low transition on TOCKI pin
	0 = Increment on low-to-high transition on T0CKI pin
bit 3	PSA: Timer0 Prescaler Assignment bit
	 1 = Tlmer0 prescaler is not assigned. Timer0 clock input bypasses prescaler. 0 = Timer0 prescaler is assigned. Timer0 clock input comes from prescaler output.
bit 2-0	T0PS<2:0>: Timer0 Prescaler Select bits
	111 = 1:256 Prescale value
	110 = 1:128 Prescale value
	101 = 1:64 Prescale value
	100 = 1:32 Prescale value 011 = 1:16 Prescale value
	010 = 1:8 Prescale value
	001 = 1:4 Prescale value
	000 = 1:2 Prescale value

10.1 Timer0 Operation

Timer0 can operate as either a timer or a counter. The mode is selected with the ToCS bit (ToCON<5>). In Timer mode (ToCS = 0), the module increments on every clock by default unless a different prescaler value is selected (see **Section 10.3 "Prescaler"**). If the TMR0 register is written to, the increment is inhibited for the following two instruction cycles. The user can work around this by writing an adjusted value to the TMR0 register.

The Counter mode is selected by setting the T0CS bit (= 1). In this mode, Timer0 increments either on every rising or falling edge of pin RA4/T0CKI. The incrementing edge is determined by the Timer0 Source Edge Select bit, T0SE (T0CON<4>); clearing this bit selects the rising edge. Restrictions on the external clock input are discussed below.

An external clock source can be used to drive Timer0, however, it must meet certain requirements to ensure that the external clock can be synchronized with the

internal phase clock (Tosc). There is a delay between synchronization and the onset of incrementing the timer/counter.

10.2 Timer0 Reads and Writes in 16-Bit Mode

TMR0H is not the actual high byte of Timer0 in 16-bit mode. It is actually a buffered version of the real high byte of Timer0, which is not directly readable nor writable (refer to Figure 10-2). TMR0H is updated with the contents of the high byte of Timer0 during a read of TMR0L. This provides the ability to read all 16 bits of Timer0 without having to verify that the read of the high and low byte were valid, due to a rollover between successive reads of the high and low byte.

Similarly, a write to the high byte of Timer0 must also take place through the TMR0H Buffer register. The high byte is updated with the contents of TMR0H when a write occurs to TMR0L. This allows all 16 bits of Timer0 to be updated at once.

FIGURE 10-1: TIMERO BLOCK DIAGRAM (8-BIT MODE)

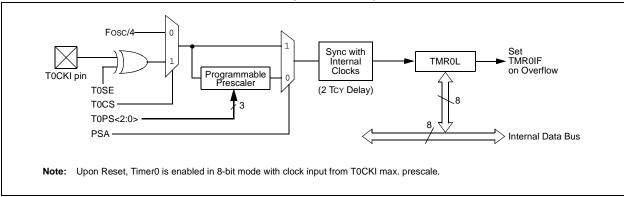
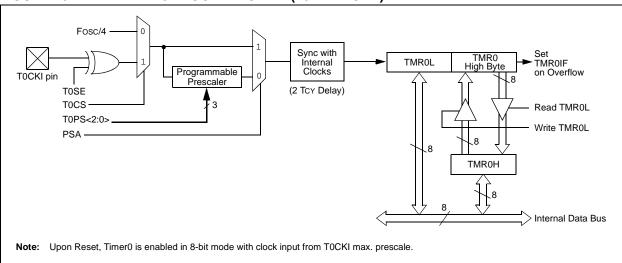


FIGURE 10-2: TIMERO BLOCK DIAGRAM (16-BIT MODE)



10.3 Prescaler

An 8-bit counter is available as a prescaler for the Timer0 module. The prescaler is not directly readable or writable. Its value is set by the PSA and T0PS<2:0> bits (T0CON<3:0>) which determine the prescaler assignment and prescale ratio.

Clearing the PSA bit assigns the prescaler to the Timer0 module. When it is assigned, prescale values from 1:2 through 1:256, in power-of-2 increments, are selectable.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (e.g., CLRF TMR0, MOVWF TMR0, BSF TMR0, etc.) clear the prescaler count.

Note: Writing to TMR0 when the prescaler is assigned to Timer0 will clear the prescaler count but will not change the prescaler assignment.

10.3.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control and can be changed "on-the-fly" during program execution.

10.4 Timer0 Interrupt

The TMR0 interrupt is generated when the TMR0 register overflows from FFh to 00h in 8-bit mode, or from FFFFh to 0000h in 16-bit mode. This overflow sets the TMR0IF flag bit. The interrupt can be masked by clearing the TMR0IE bit (INTCON<5>). Before re-enabling the interrupt, the TMR0IF bit must be cleared in software by the Interrupt Service Routine.

Since Timer0 is shut down in Sleep mode, the TMR0 interrupt cannot awaken the processor from Sleep.

TABLE 10-1: REGISTERS ASSOCIATED WITH TIMERO

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
TMR0L	TMR0L Timer0 Register Low Byte								54
TMR0H	Timer0 Register High Byte							54	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53
T0CON	TMR0ON	T08BIT	T0CS	T0SE	PSA	T0PS2	T0PS1	T0PS0	54
TRISA	TRISA7 ⁽¹⁾	TRISA6 ⁽¹⁾	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	56

Legend: — = unimplemented, read as '0'. Shaded cells are not used by Timer0.

Note 1: RA<7:6> and their associated latch and direction bits are configured as port pins only when the internal oscillator is selected as the default clock source (FOSC2 Configuration bit = 0); otherwise, they are disabled and these bits read as '0'.

NOTES:

11.0 TIMER1 MODULE

The Timer1 timer/counter module incorporates these features:

- Software selectable operation as a 16-bit timer or counter
- Readable and writable 8-bit registers (TMR1H and TMR1L)
- Selectable clock source (internal or external) with device clock or Timer1 oscillator internal options
- Interrupt on overflow
- Reset on CCP Special Event Trigger
- Device clock status flag (T1RUN)

A simplified block diagram of the Timer1 module is shown in Figure 11-1. A block diagram of the module's operation in Read/Write mode is shown in Figure 11-2.

The module incorporates its own low-power oscillator to provide an additional clocking option. The Timer1 oscillator can also be used as a low-power clock source for the microcontroller in power-managed operation.

Timer1 can also be used to provide Real-Time Clock (RTC) functionality to applications with only a minimal addition of external components and code overhead.

Timer1 is controlled through the T1CON Control register (Register 11-1). It also contains the Timer1 Oscillator Enable bit (T1OSCEN). Timer1 can be enabled or disabled by setting or clearing control bit, TMR1ON (T1CON<0>).

REGISTER 11-1: T1CON: TIMER1 CONTROL REGISTER

R/W-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
RD16	T1RUN	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N
bit 7							bit 0

Legend	1:
--------	----

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 RD16: 16-Bit Read/Write Mode Enable bit

1 = Enables register read/write of TImer1 in one 16-bit operation
 0 = Enables register read/write of Timer1 in two 8-bit operations

bit 6 T1RUN: Timer1 System Clock Status bit

1 = Device clock is derived from Timer1 oscillator0 = Device clock is derived from another source

bit 5-4 T1CKPS<1:0>: Timer1 Input Clock Prescale Select bits

11 = 1:8 Prescale value 10 = 1:4 Prescale value 01 = 1:2 Prescale value 00 = 1:1 Prescale value

bit 3 T10SCEN: Timer1 Oscillator Enable bit

1 = Timer1 oscillator is enabled 0 = Timer1 oscillator is shut off

The oscillator inverter and feedback resistor are turned off to eliminate power drain.

bit 2 T1SYNC: Timer1 External Clock Input Synchronization Select bit

When TMR1CS = 1:

1 = Do not synchronize external clock input0 = Synchronize external clock input

When TMR1CS = 0:

This bit is ignored. Timer1 uses the internal clock when TMR1CS = 0.

bit 1 TMR1CS: Timer1 Clock Source Select bit

1 = External clock from pin RC0/T10SO/T13CKI (on the rising edge)

0 = Internal clock (Fosc/4)

bit 0 TMR1ON: Timer1 On bit

1 = Enables Timer1
0 = Stops Timer1

11.1 Timer1 Operation

Timer1 can operate in one of these modes:

- Timer
- · Synchronous Counter
- · Asynchronous Counter

The operating mode is determined by the clock select bit, TMR1CS (T1CON<1>). When TMR1CS is cleared (= 0), Timer1 increments on every internal instruction

cycle (Fosc/4). When the bit is set, Timer1 increments on every rising edge of the Timer1 external clock input or the Timer1 oscillator, if enabled.

When Timer1 is enabled, the RC1/T10SI and RC0/T10SO/T13CKI pins become inputs. This means the values of TRISC<1:0> are ignored and the pins are read as '0'.

FIGURE 11-1: TIMER1 BLOCK DIAGRAM (8-BIT MODE)

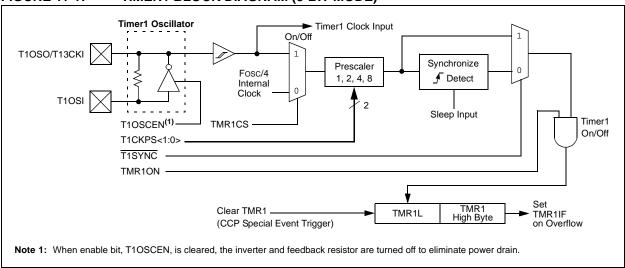
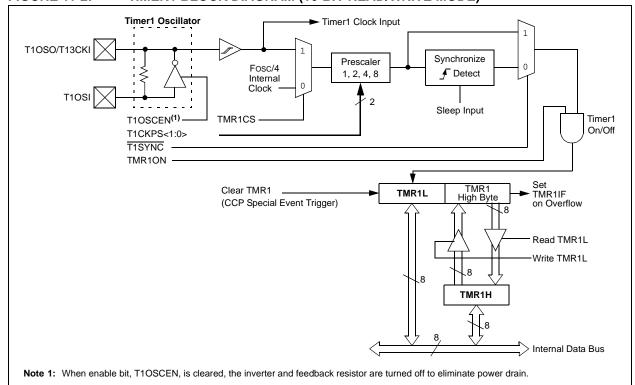


FIGURE 11-2: TIMER1 BLOCK DIAGRAM (16-BIT READ/WRITE MODE)



11.2 Timer1 16-Bit Read/Write Mode

Timer1 can be configured for 16-bit reads and writes (see Figure 11-2). When the RD16 control bit (T1CON<7>) is set, the address for TMR1H is mapped to a buffer register for the high byte of Timer1. A read from TMR1L will load the contents of the high byte of Timer1 into the Timer1 High Byte Buffer register. This provides the user with the ability to accurately read all 16 bits of Timer1 without having to determine whether a read of the high byte, followed by a read of the low byte, has become invalid due to a rollover between reads.

A write to the high byte of Timer1 must also take place through the TMR1H Buffer register. The Timer1 high byte is updated with the contents of TMR1H when a write occurs to TMR1L. This allows a user to write all 16 bits to both the high and low bytes of Timer1 at once.

The high byte of Timer1 is not directly readable or writable in this mode. All reads and writes must take place through the Timer1 High Byte Buffer register. Writes to TMR1H do not clear the Timer1 prescaler. The prescaler is only cleared on writes to TMR1L.

11.3 Timer1 Oscillator

An on-chip crystal oscillator circuit is incorporated between pins T1OSI (input) and T1OSO (amplifier output). It is enabled by setting the Timer1 Oscillator Enable bit, T1OSCEN (T1CON<3>). The oscillator is a low-power circuit rated for 32 kHz crystals. It will continue to run during all power-managed modes. The circuit for a typical LP oscillator is shown in Figure 11-3. Table 11-1 shows the capacitor selection for the Timer1 oscillator.

The user must provide a software time delay to ensure proper start-up of the Timer1 oscillator.

FIGURE 11-3: EXTERNAL COMPONENTS FOR THE TIMER1 LP OSCILLATOR

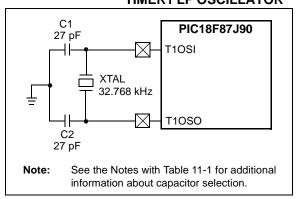


TABLE 11-1: CAPACITOR SELECTION FOR THE TIMER1
OSCILLATOR^(2,3,4)

Oscillator Type	Freq.	C1	C2	
LP	32.768 kHz	27 pF ⁽¹⁾	27 pF ⁽¹⁾	

- **Note 1:** Microchip suggests these values as a starting point in validating the oscillator circuit.
 - **2:** Higher capacitance increases the stability of the oscillator but also increases the start-up time.
 - 3: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.
 - **4:** Capacitor values are for design guidance only.

11.3.1 USING TIMER1 AS A CLOCK SOURCE

The Timer1 oscillator is also available as a clock source in power-managed modes. By setting the System Clock Select bits, SCS<1:0> (OSCCON<1:0>), to '01', the device switches to SEC_RUN mode; both the CPU and peripherals are clocked from the Timer1 oscillator. If the IDLEN bit (OSCCON<7>) is cleared and a SLEEP instruction is executed, the device enters SEC_IDLE mode. Additional details are available in **Section 3.0** "Power-Managed Modes".

Whenever the Timer1 oscillator is providing the clock source, the Timer1 system clock status flag, T1RUN (T1CON<6>), is set. This can be used to determine the controller's current clocking mode. It can also indicate the clock source being currently used by the Fail-Safe Clock Monitor. If the Clock Monitor is enabled and the Timer1 oscillator fails while providing the clock, polling the T1RUN bit will indicate whether the clock is being provided by the Timer1 oscillator or another source.

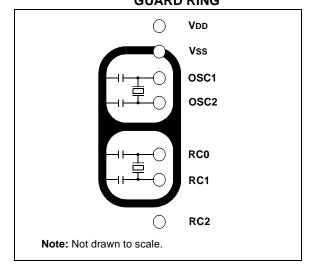
11.3.2 TIMER1 OSCILLATOR LAYOUT CONSIDERATIONS

The Timer1 oscillator circuit draws very little power during operation. Due to the low-power nature of the oscillator, it may also be sensitive to rapidly changing signals in close proximity.

The oscillator circuit, shown in Figure 11-3, should be located as close as possible to the microcontroller. There should be no circuits passing within the oscillator circuit boundaries other than Vss or VDD.

If a high-speed circuit must be located near the oscillator (such as the CCP1 pin in Output Compare or PWM mode, or the primary oscillator using the OSC2 pin), a grounded guard ring around the oscillator circuit, as shown in Figure 11-4, may be helpful when used on a single-sided PCB or in addition to a ground plane.

FIGURE 11-4: OSCILLATOR CIRCUIT WITH GROUNDED GUARD RING



11.4 Timer1 Interrupt

The TMR1 register pair (TMR1H:TMR1L) increments from 0000h to FFFFh and rolls over to 0000h. The Timer1 interrupt, if enabled, is generated on overflow which is latched in interrupt flag bit, TMR1IF (PIR1<0>). This interrupt can be enabled or disabled by setting or clearing the Timer1 Interrupt Enable bit, TMR1IE (PIE1<0>).

11.5 Resetting Timer1 Using the CCP Special Event Trigger

If CCP1 or CCP2 is configured to use Timer1 and to generate a Special Event Trigger in Compare mode (CCPxM<3:0> = 1011), this signal will reset Timer3. The trigger from CCP2 will also start an A/D conversion if the A/D module is enabled (see **Section 15.3.4** "**Special Event Trigger**" for more information).

The module must be configured as either a timer or a synchronous counter to take advantage of this feature. When used this way, the CCPRxH:CCPRxL register pair effectively becomes a period register for Timer1.

If Timer1 is running in Asynchronous Counter mode, this Reset operation may not work.

In the event that a write to Timer1 coincides with a Special Event Trigger, the write operation will take precedence.

Note: The Special Event Triggers from the CCPx module will not set the TMR1IF interrupt flag bit (PIR1<0>).

11.6 Using Timer1 as a Real-Time Clock

Adding an external LP oscillator to Timer1 (such as the one described in **Section 11.3** "Timer1 Oscillator" above) gives users the option to include RTC functionality to their applications. This is accomplished with an inexpensive watch crystal to provide an accurate time base and several lines of application code to calculate the time. When operating in Sleep mode and using a battery or supercapacitor as a power source, it can completely eliminate the need for a separate RTC device and battery backup.

The application code routine, RTCisr, shown in Example 11-1, demonstrates a simple method to increment a counter at one-second intervals using an Interrupt Service Routine. Incrementing the TMR1 register pair to overflow triggers the interrupt and calls the routine which increments the seconds counter by one. Additional counters for minutes and hours are incremented as the previous counter overflows.

Since the register pair is 16 bits wide, counting up to overflow the register directly from a 32.768 kHz clock would take 2 seconds. To force the overflow at the required one-second intervals, it is necessary to preload it. The simplest method is to set the MSb of TMR1H with a BSF instruction. Note that the TMR1L register is never preloaded or altered; doing so may introduce cumulative error over many cycles.

For this method to be accurate, Timer1 must operate in Asynchronous mode and the Timer1 overflow interrupt must be enabled (PIE1<0> = 1) as shown in the routine, RTCinit. The Timer1 oscillator must also be enabled and running at all times.

EXAMPLE 11-1: IMPLEMENTING A REAL-TIME CLOCK USING A TIMER1 INTERRUPT SERVICE

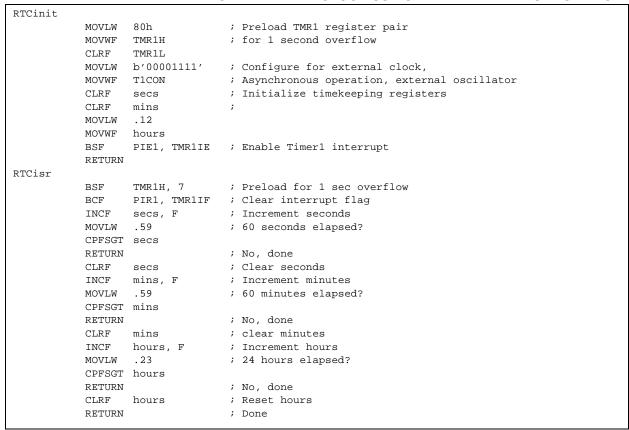


TABLE 11-2: REGISTERS ASSOCIATED WITH TIMER1 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53
PIR1	_	ADIF	RC1IF	TX1IF	SSPIF	_	TMR2IF	TMR1IF	56
PIE1	_	ADIE	RC1IE	TX1IE	SSPIE	_	TMR2IE	TMR1IE	56
IPR1	_	ADIP	RC1IP	TX1IP	SSPIP	_	TMR2IP	TMR1IP	56
TMR1L	IL Timer1 Register Low Byte							54	
TMR1H	Timer1 Register High Byte							54	
T1CON	RD16	T1RUN	T1CKPS1	T1CKPS0	T10SCEN	T1SYNC	TMR1CS	TMR10N	54

Legend: Shaded cells are not used by the Timer1 module.

NOTES:

12.0 TIMER2 MODULE

The Timer2 module incorporates the following features:

- · 8-bit Timer and Period registers (TMR2 and PR2, respectively)
- Readable and writable (both registers)
- Software programmable prescaler (1:1, 1:4 and 1:16)
- · Software programmable postscaler (1:1 through 1:16)
- Interrupt on TMR2 to PR2 match
- · Optional use as the shift clock for the MSSP module

The module is controlled through the T2CON register (Register 12-1) which enables or disables the timer and configures the prescaler and postscaler. Timer2 can be shut off by clearing control bit, TMR2ON (T2CON<2>), to minimize power consumption.

A simplified block diagram of the module is shown in Figure 12-1.

12.1 **Timer2 Operation**

In normal operation, TMR2 is incremented from 00h on each clock (Fosc/4). A 4-bit counter/prescaler on the clock input gives direct input, divide-by-4 and divide-by-16 prescale options. These are selected by prescaler control bits, T2CKPS<1:0> (T2CON<1:0>). The value of TMR2 is compared to that of the Period register, PR2, on each clock cycle. When the two values match, the comparator generates a match signal as the timer output. This signal also resets the value of TMR2 to 00h on the next cycle and drives the output counter/postscaler (see Section 12.2 "Timer2 Interrupt").

The TMR2 and PR2 registers are both directly readable and writable. The TMR2 register is cleared on any device Reset, while the PR2 register initializes at FFh. Both the prescaler and postscaler counters are cleared on the following events:

- a write to the TMR2 register
- · a write to the T2CON register
- any device Reset (Power-on Reset, MCLR Reset, Watchdog Timer Reset or Brown-out Reset)

TMR2 is not cleared when T2CON is written.

REGISTER 12-1: T2CON: TIMER2 CONTROL REGISTER

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0
bit 7							bit 0

-n = Value at POR

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

'1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 Unimplemented: Read as '0'

bit 6-3 T20UTPS<3:0>: Timer2 Output Postscale Select bits

> 0000 = 1:1 Postscale 0001 = 1:2 Postscale

Legend:

1111 = 1:16 Postscale

bit 2 TMR2ON: Timer2 On bit

> 1 = Timer2 is on 0 = Timer2 is off

bit 1-0 T2CKPS<1:0>: Timer2 Clock Prescale Select bits

> 00 = Prescaler is 1 01 = Prescaler is 4 1x = Prescaler is 16

12.2 Timer2 Interrupt

Timer2 can also generate an optional device interrupt. The Timer2 output signal (TMR2 to PR2 match) provides the input for the 4-bit output counter/postscaler. This counter generates the TMR2 match interrupt flag which is latched in TMR2IF (PIR1<1>). The interrupt is enabled by setting the TMR2 Match Interrupt Enable bit, TMR2IE (PIE1<1>).

A range of 16 postscale options (from 1:1 through 1:16 inclusive) can be selected with the postscaler control bits, T2OUTPS<3:0> (T2CON<6:3>).

12.3 Timer2 Output

The unscaled output of TMR2 is available primarily to the CCP modules, where it is used as a time base for operations in PWM mode.

Timer2 can be optionally used as the shift clock source for the MSSP module operating in SPI mode. Additional information is provided in Section 17.0 "Master Synchronous Serial Port (MSSP) Module".

FIGURE 12-1: TIMER2 BLOCK DIAGRAM

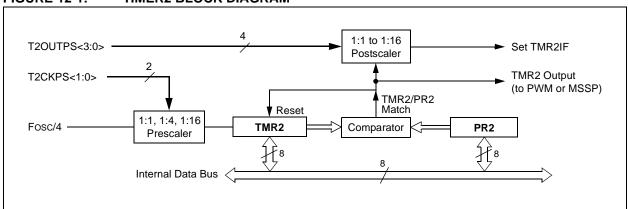


TABLE 12-1: REGISTERS ASSOCIATED WITH TIMER2 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53
PIR1	_	ADIF	RC1IF	TX1IF	SSPIF	1	TMR2IF	TMR1IF	56
PIE1	_	ADIE	RC1IE	TX1IE	SSPIE	-	TMR2IE	TMR1IE	56
IPR1	_	ADIP	RC1IP	TX1IP	SSPIP	-	TMR2IP	TMR1IP	56
TMR2	Timer2 Reg	jister							54
T2CON	_	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	54
PR2	Timer2 Peri	iod Register							54

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Timer2 module.

13.0 TIMER3 MODULE

The Timer3 timer/counter module incorporates these features:

- Software selectable operation as a 16-bit timer or counter
- Readable and writable 8-bit registers (TMR3H and TMR3L)
- Selectable clock source (internal or external) with device clock or Timer1 oscillator internal options
- · Interrupt on overflow
- Module Reset on CCP Special Event Trigger

A simplified block diagram of the Timer3 module is shown in Figure 13-1. A block diagram of the module's operation in Read/Write mode is shown in Figure 13-2.

The Timer3 module is controlled through the T3CON register (Register 13-1). It also selects the clock source options for the CCP modules. See **Section 15.2.2** "Timer1/Timer3 Mode **Selection**" for more information.

REGISTER 13-1: T3CON: TIMER3 CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
RD16	T3CCP2	T3CKPS1	T3CKPS0	T3CCP1	T3SYNC	TMR3CS	TMR3ON
bit 7							bit 0

Legend:				
R = Readable bit	Readable bit W = Writable bit U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

- bit 7 RD16: 16-Bit Read/Write Mode Enable bit
 - 1 = Enables register read/write of Timer3 in one 16-bit operation
 - 0 = Enables register read/write of Timer3 in two 8-bit operations
- bit 6,3 T3CCP<2:1>: Timer3 and Timer1 to CCPx Enable bits
 - 1x = Timer3 is the capture/compare clock source for the CCP modules
 - 01 = Timer3 is the capture/compare clock source for CCP2; Timer1 is the capture/compare clock source for CCP1
 - 00 = Timer1 is the capture/compare clock source for the CCP modules
- bit 5-4 T3CKPS<1:0>: Timer3 Input Clock Prescale Select bits
 - 11 = 1:8 Prescale value
 - 10 = 1:4 Prescale value
 - 01 = 1:2 Prescale value
 - 00 = 1:1 Prescale value
- bit 2 T3SYNC: Timer3 External Clock Input Synchronization Control bit

(Not usable if the device clock comes from Timer1/Timer3.)

When TMR3CS = 1:

- 1 = Do not synchronize external clock input
- 0 = Synchronize external clock input

When TMR3CS = 0:

This bit is ignored. Timer3 uses the internal clock when TMR3CS = 0.

- bit 1 TMR3CS: Timer3 Clock Source Select bit
 - 1 = External clock input from Timer1 oscillator or T13CKI (on the rising edge after the first falling edge)
 - 0 = Internal clock (Fosc/4)
- bit 0 TMR3ON: Timer3 On bit
 - 1 = Enables Timer3
 - 0 = Stops Timer3

13.1 Timer3 Operation

Timer3 can operate in one of three modes:

- Timer
- · Synchronous Counter
- · Asynchronous Counter

The operating mode is determined by the clock select bit, TMR3CS (T3CON<1>). When TMR3CS is cleared (= 0), Timer3 increments on every internal instruction cycle (Fosc/4). When the bit is set, Timer3 increments on every rising edge of the Timer1 external clock input or the Timer1 oscillator, if enabled.

As with Timer1, the RC1/T1OSI and RC0/T1OSO/T13CKI pins become inputs when the Timer1 oscillator is enabled. This means the values of TRISC<1:0> are ignored and the pins are read as '0'.

FIGURE 13-1: TIMER3 BLOCK DIAGRAM (8-BIT MODE)

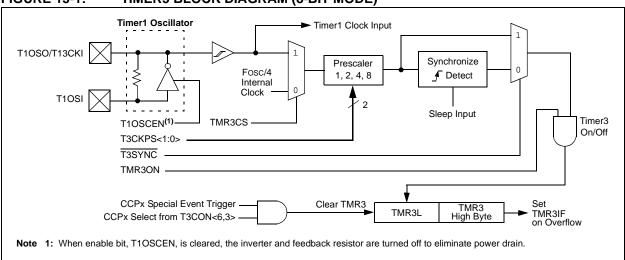
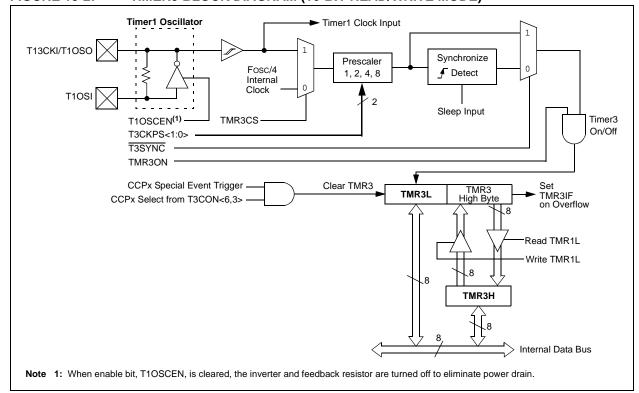


FIGURE 13-2: TIMER3 BLOCK DIAGRAM (16-BIT READ/WRITE MODE)



13.2 Timer3 16-Bit Read/Write Mode

Timer3 can be configured for 16-bit reads and writes (see Figure 13-2). When the RD16 control bit (T3CON<7>) is set, the address for TMR3H is mapped to a buffer register for the high byte of Timer3. A read from TMR3L will load the contents of the high byte of Timer3 into the Timer3 High Byte Buffer register. This provides the user with the ability to accurately read all 16 bits of Timer1 without having to determine whether a read of the high byte, followed by a read of the low byte, has become invalid due to a rollover between reads.

A write to the high byte of Timer3 must also take place through the TMR3H Buffer register. The Timer3 high byte is updated with the contents of TMR3H when a write occurs to TMR3L. This allows a user to write all 16 bits to both the high and low bytes of Timer3 at once.

The high byte of Timer3 is not directly readable or writable in this mode. All reads and writes must take place through the Timer3 High Byte Buffer register.

Writes to TMR3H do not clear the Timer3 prescaler. The prescaler is only cleared on writes to TMR3L.

13.3 Using the Timer1 Oscillator as the Timer3 Clock Source

The Timer1 internal oscillator may be used as the clock source for Timer3. The Timer1 oscillator is enabled by setting the T1OSCEN (T1CON<3>) bit. To use it as the Timer3 clock source, the TMR3CS bit must also be set. As previously noted, this also configures Timer3 to increment on every rising edge of the oscillator source.

The Timer1 oscillator is described in **Section 11.0** "Timer1 Module".

13.4 Timer3 Interrupt

The TMR3 register pair (TMR3H:TMR3L) increments from 0000h to FFFFh and overflows to 0000h. The Timer3 interrupt, if enabled, is generated on overflow and is latched in interrupt flag bit, TMR3IF (PIR2<1>). This interrupt can be enabled or disabled by setting or clearing the Timer3 Interrupt Enable bit, TMR3IE (PIE2<1>).

13.5 Resetting Timer3 Using the CCP Special Event Trigger

If CCP1 or CCP2 is configured to use Timer3 and to generate a Special Event Trigger in Compare mode (CCPxM<3:0>=1011), this signal will reset Timer3. The trigger from CCP2 will also start an A/D conversion if the A/D module is enabled (see **Section 15.3.4** "**Special Event Trigger**" for more information).

The module must be configured as either a timer or synchronous counter to take advantage of this feature. When used this way, the CCPRxH:CCPRxL register pair effectively becomes a period register for Timer3.

If Timer3 is running in Asynchronous Counter mode, the Reset operation may not work.

In the event that a write to Timer3 coincides with a Special Event Trigger from a CCP module, the write will take precedence.

Note: The Special Event Triggers from the CCPx module will not set the TMR3IF interrupt flag bit (PIR2<1>).

TABLE 13-1: REGISTERS ASSOCIATED WITH TIMER3 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53
PIR2	OSCFIF	CMIF	_	_	BCLIF	LVDIF	TMR3IF	_	56
PIE2	OSCFIE	CMIE	_	_	BCLIE	LVDIE	TMR3IE	_	56
IPR2	OSCFIP	CMIP	_	_	BCLIP	LVDIP	TMR3IP	_	56
TMR3L	Timer3 Reg	gister Low By	yte						55
TMR3H	BH Timer3 Register High Byte								
T1CON	RD16	T1RUN	T1CKPS1	T1CKPS0	T10SCEN	T1SYNC	TMR1CS	TMR10N	54
T3CON	RD16	T3CCP2	T3CKPS1	T3CKPS0	T3CCP1	T3SYNC	TMR3CS	TMR3ON	55

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Timer3 module.

NOTES:

14.0 REAL-TIME CLOCK AND CALENDAR (RTCC)

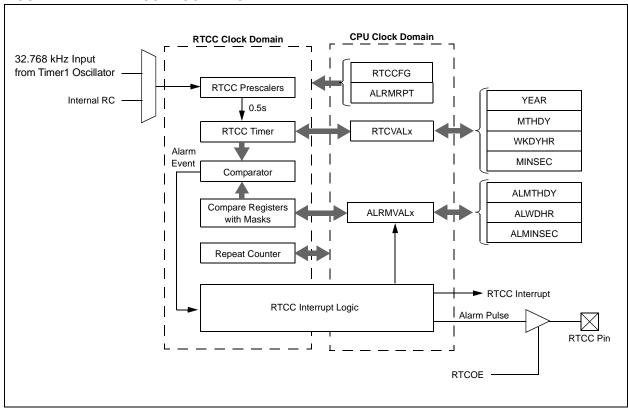
The key features of the Real-Time Clock and Calendar (RTCC) module are:

- · Time: hours, minutes and seconds
- 24-hour format (military time)
- · Calendar: weekday, date, month and year
- · Alarm configurable
- Year range: 2000 to 2099
- · Leap year correction
- · BCD format for compact firmware
- · Optimized for low-power operation
- · User calibration with auto-adjust
- Calibration range: ±2.64 seconds error per month
- · Requirements: external 32.768 kHz clock crystal
- · Alarm pulse or seconds clock output on RTCC pin

The RTCC module is intended for applications, where accurate time must be maintained for extended period with minimum to no intervention from the CPU. The module is optimized for low-power usage in order to provide extended battery life while keeping track of time.

The module is a 100-year clock and calendar with automatic leap-year detection. The range of the clock is from 00:00:00 (midnight) on January 1, 2000 to 23:59:59 on December 31, 2099. Hours are measured in 24-hour (military time) format. The clock provides a granularity of one second with half-second visibility to the user.

FIGURE 14-1: RTCC BLOCK DIAGRAM



14.1 RTCC MODULE REGISTERS

The RTCC module registers are divided into following categories:

RTCC Control Registers

- RTCCFG
- RTCCAL
- PADCFG1
- ALRMCFG
- ALRMRPT

RTCC Value Registers

- RTCVALH and RTCVALL Can access the following registers
 - YEAR
 - MONTH
 - DAY
 - WEEKDAY
 - HOUR
 - MINUTE
 - SECOND

Alarm Value Registers

- ALRMVALH and ALRMVALL Can access the following registers:
 - ALRMMNTH
 - ALRMDAY
 - ALRMWD
 - ALRMHR
 - ALRMMIN
 - ALRMSEC

Note: The RTCVALH and RTCVALL registers can be accessed through RTCRPT<1:0>.

ALRMVALH and ALRMVALL can be accessed through ALRMPTR<1:0>.

14.1.1 RTCC CONTROL REGISTERS

REGISTER 14-1: RTCCFG: RTCC CONFIGURATION REGISTER⁽¹⁾

R/W-0	U-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0
RTCEN ⁽²⁾	_	RTCWREN	RTCSYNC	HALFSEC ⁽³⁾	RTCOE	RTCPTR1	RTCPTR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 RTCEN: RTCC Enable bit⁽²⁾

bit 6

1 = RTCC module is enabled 0 = RTCC module is disabled Unimplemented: Read as '0'

bit 5 RTCWREN: RTCC Value Registers Write Enable bit

1 = RTCVALH and RTCVALL registers can be written to by the user

0 = RTCVALH and RTCVALL registers are locked out from being written to by the user

bit 4 RTCSYNC: RTCC Value Registers Read Synchronization bit

1 = RTCVALH, RTCVALL and ALRMRPT registers can change while reading due to a rollover ripple resulting in an invalid data read. If the register is read twice and results in the same data, the data can be assumed to be valid.

0 = RTCVALH, RTCVALL and ALCFGRPT registers can be read without concern over a rollover

ripple

bit 3 **HALFSEC:** Half-Second Status bit⁽³⁾

1 = Second half period of a second0 = First half period of a second

bit 2 RTCOE: RTCC Output Enable bit

1 = RTCC clock output enabled0 = RTCC clock output disabled

bit 1-0 RTCPTR<1:0>: RTCC Value Register Window Pointer bits

Points to the corresponding RTCC Value registers when reading RTCVALH and RTCVALL registers. The RTCPTR<1:0> value decrements on every read or write of RTCVALH<7:0> until it reaches '00'.

RTCVALH:

00 = Minutes

01 = Weekday

10 = Month

11 = Reserved

RTCVALL:

00 = Seconds

01 = Hours

10 = Day

11 = Year

Note 1: The RTCCFG register is only affected by a POR. For resets other than POR, RTCC will continue to run even if the device is in Reset.

2: A write to the RTCEN bit is only allowed when RTCWREN = 1.

3: This bit is read-only; it is cleared to '0' on a write to the lower half of the MINSEC register.

REGISTER 14-2: RTCCAL: RTCC CALIBRATION REGISTER

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| CAL7 | CAL6 | CAL5 | CAL4 | CAL3 | CAL2 | CAL1 | CAL0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 CAL<7:0>: RTC Drift Calibration bits

01111111 = Maximum positive adjustment; adds 508 RTC clock pulses every minute

.

00000001 = Minimum positive adjustment; adds four RTC clock pulses every minute

00000000 = No adjustment

11111111 = Minimum negative adjustment; subtracts four RTC clock pulses every minute

•

10000000 = Maximum negative adjustment; subtracts 512 RTC clock pulses every minute

REGISTER 14-3: PADCFG1: PAD CONFIGURATION REGISTER

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	U-0
_	_	_	_	_	RTSECSEL1 ⁽¹⁾	RTSECSEL0 ⁽¹⁾	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-3 Unimplemented: Read as '0'

bit 2-1 RTSECSEL<1:0>: RTCC Seconds Clock Output Select bit⁽¹⁾

11 = Reserved. Do not use

10 = RTCC source clock is selected for the RTCC pin (pin can be INTOSC or Timer1 oscillator⁽²⁾, depending on the RTCOSC (CONFIG3L<1>) bit setting)

01 DTCC accords clock in calcated for the DTCC min

01 = RTCC seconds clock is selected for the RTCC pin

00 = RTCC alarm pulse is selected for the RTCC pin

bit 0 **Unimplemented:** Read as '0'

Note 1: To enable the actual RTCC output, the RTCOE (RTCCFG<2>) bit must be set.

2: If the Timer1 oscillator is the clock source for RTCC, T1OSCEN bit should be set (T1CON<3> = 1).

REGISTER 14-4: ALRMCFG: ALARM CONFIGURATION REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ALRMEN	CHIME	AMASK3	AMASK2	AMASK1	AMASK0	ALRMPTR1	ALRMPTR0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 ALRMEN: Alarm Enable bit

1 = Alarm is enabled (cleared automatically after an alarm event whenever ARPT<7:0> = 00

and CHIME = 0)

0 = Alarm is disabled

bit 6 CHIME: Chime Enable bit

1 = Chime is enabled; ALRMPTR<1:0> bits are allowed to roll over from 00h to FFh

0 = Chime is disabled; ALRMPTR<1:0> bits stop once they reach 00h

bit 5-2 AMASK<3:0>: Alarm Mask Configuration bits

0000 = Every half second

0001 = Every second

0010 = Every 10 seconds

0011 = Every minute

0100 = Every 10 minutes

0101 = Every hour

0110 = Once a day

0111 = Once a week

1000 = Once a month

1001 = Once a year (except when configured for February 29th, once every four years)

101x = Reserved - do not use

11xx = Reserved - do not use

bit 1-0 ALRMPTR<1:0>: Alarm Value Register Window Pointer bits

Points to the corresponding Alarm Value registers when reading ALRMVALH and ALRMVALL registers. The ALRMPTR<1:0> value decrements on every read or write of ALRMVALH until it reaches '00'.

ALRMVALH:

00 = ALRMMIN

01 = ALRMWD

10 = ALRMMNTH

11 = Unimplemented

ALRMVALL:

00 = ALRMSEC

01 = ALRMHR

10 = ALRMDAY

11 = Unimplemented

REGISTER 14-5: ALRMRPT: ALARM CALIBRATION REGISTER

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| ARPT7 | ARPT6 | ARPT5 | ARPT4 | ARPT3 | ARPT2 | ARPT1 | ARPT0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 ARPT<7:0>: Alarm Repeat Counter Value bits

11111111 = Alarm will repeat 255 more times

00000000 = Alarm will not repeat

The counter decrements on any alarm event. The counter is prevented from rolling over from 00h to FFh unless CHIME = 1.

14.1.2 RTCVALH AND RTCVALL REGISTER MAPPINGS

REGISTER 14-6: RESERVED REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 **Unimplemented:** Read as '0'

REGISTER 14-7: YEAR: YEAR VALUE REGISTER⁽¹⁾

| R/W-x |
|--------|--------|--------|--------|--------|--------|--------|--------|
| YRTEN3 | YRTEN2 | YRTEN1 | YRTEN0 | YRONE3 | YRONE2 | YRONE1 | YRONE0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-4 YRTEN<3:0>: Binary Coded Decimal Value of Year's Tens Digit

Contains a value from 0 to 9.

bit 3-0 YRONE<3:0>: Binary Coded Decimal Value of Year's Ones Digit

Contains a value from 0 to 9.

Note 1: A write to the YEAR register is only allowed when RTCWREN = 1.

REGISTER 14-8: MONTH: MONTH VALUE REGISTER⁽¹⁾

U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
_	_	_	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-5 **Unimplemented:** Read as '0'

bit 4 MTHTEN0: Binary Coded Decimal Value of Month's Tens Digit

Contains a value of 0 or 1.

bit 3-0 MTHONE<3:0>: Binary Coded Decimal Value of Month's Ones Digit

Contains a value from 0 to 9.

Note 1: A write to this register is only allowed when RTCWREN = 1.

REGISTER 14-9: DAY: DAY VALUE REGISTER⁽¹⁾

U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
_	_	DAYTEN1	DAYTEN0	DAYONE3	DAYONE2	DAYONE1	DAYONE0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-6 Unimplemented: Read as '0'

bit 5-4 DAYTEN<1:0>: Binary Coded Decimal value of Day's Tens Digit

Contains a value from 0 to 3.

bit 3-0 DAYONE<3:0>: Binary Coded Decimal Value of Day's Ones Digit

Contains a value from 0 to 9.

Note 1: A write to this register is only allowed when RTCWREN = 1.

REGISTER 14-10: WEEKDAY: WEEKDAY VALUE REGISTER(1)

U-0	U-0	U-0	U-0	U-0	R/W-x	R/W-x	R/W-x
_	_	_	_	_	WDAY2	WDAY1	WDAY0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-3 **Unimplemented:** Read as '0'

bit 2-0 WDAY<2:0>: Binary Coded Decimal Value of Weekday Digit

Contains a value from 0 to 6.

Note 1: A write to this register is only allowed when RTCWREN = 1.

REGISTER 14-11: HOUR: HOUR VALUE REGISTER(1)

U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
_	_	HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-6 Unimplemented: Read as '0'

bit 5-4 HRTEN<1:0>: Binary Coded Decimal Value of Hour's Tens Digit

Contains a value from 0 to 2.

bit 3-0 HRONE<3:0>: Binary Coded Decimal Value of Hour's Ones Digit

Contains a value from 0 to 9.

Note 1: A write to this register is only allowed when RTCWREN = 1.

REGISTER 14-12: MINUTE: MINUTE VALUE REGISTER

U-0	R/W-x						
_	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 Unimplemented: Read as '0'

bit 6-4 MINTEN<2:0>: Binary Coded Decimal Value of Minute's Tens Digit

Contains a value from 0 to 5.

bit 3-0 MINONE<3:0>: Binary Coded Decimal Value of Minute's Ones Digit

Contains a value from 0 to 9.

REGISTER 14-13: SECOND: SECOND VALUE REGISTER

U-0	R/W-x						
_	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 **Unimplemented:** Read as '0'

bit 6-4 SECTEN<2:0>: Binary Coded Decimal Value of Second's Tens Digit

Contains a value from 0 to 5.

bit 3-0 SECONE<3:0>: Binary Coded Decimal Value of Second's Ones Digit

Contains a value from 0 to 9.

14.1.3 ALRMVALH AND ALRMVALL REGISTER MAPPINGS

REGISTER 14-14: ALRMMNTH: ALARM MONTH VALUE REGISTER⁽¹⁾

U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
_	_	_	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-5 **Unimplemented:** Read as '0'

bit 4 MTHTEN0: Binary Coded Decimal Value of Month's Tens Digit

Contains a value of 0 or 1.

bit 3-0 MTHONE<3:0>: Binary Coded Decimal Value of Month's Ones Digit

Contains a value from 0 to 9.

Note 1: A write to this register is only allowed when RTCWREN = 1.

REGISTER 14-15: ALRMDAY: ALARM DAY VALUE REGISTER⁽¹⁾

U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
_	_	DAYTEN1	DAYTEN0	DAYONE3	DAYONE2	DAYONE1	DAYONE0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-6 **Unimplemented:** Read as '0'

bit 5-4 DAYTEN<1:0>: Binary Coded Decimal Value of Day's Tens Digit

Contains a value from 0 to 3.

bit 3-0 DAYONE<3:0>: Binary Coded Decimal Value of Day's Ones Digit

Contains a value from 0 to 9.

Note 1: A write to this register is only allowed when RTCWREN = 1.

REGISTER 14-16: ALRMWD: ALARM WEEKDAY VALUE REGISTER(1)

U-0	U-0	U-0	U-0	U-0	R/W-x	R/W-x	R/W-x
_	_	_	_	_	WDAY2	WDAY1	WDAY0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-3 Unimplemented: Read as '0'

bit 2-0 WDAY<2:0>: Binary Coded Decimal Value of Weekday Digit

Contains a value from 0 to 6.

Note 1: A write to this register is only allowed when RTCWREN = 1.

REGISTER 14-17: ALRMHR: ALARM HOURS VALUE REGISTER⁽¹⁾

U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
_	_	HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-6 Unimplemented: Read as '0'

bit 5-4 HRTEN<1:0>: Binary Coded Decimal Value of Hour's Tens Digit

Contains a value from 0 to 2.

bit 3-0 **HRONE<3:0>:** Binary Coded Decimal Value of Hour's Ones Digit

Contains a value from 0 to 9.

Note 1: A write to this register is only allowed when RTCWREN = 1.

REGISTER 14-18: ALRMMIN: ALARM MINUTES VALUE REGISTER

U-0	R/W-x						
_	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 Unimplemented: Read as '0'

bit 6-4 MINTEN<2:0>: Binary Coded Decimal Value of Minute's Tens Digit

Contains a value from 0 to 5.

bit 3-0 MINONE<3:0>: Binary Coded Decimal Value of Minute's Ones Digit

Contains a value from 0 to 9.

REGISTER 14-19: ALRMSEC: ALARM SECONDS VALUE REGISTER

U-0	R/W-x						
_	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 **Unimplemented:** Read as '0'

bit 6-4 SECTEN<2:0>: Binary Coded Decimal Value of Second's Tens Digit

Contains a value from 0 to 5.

bit 3-0 SECONE<3:0>: Binary Coded Decimal Value of Second's Ones Digit

Contains a value from 0 to 9.

14.1.4 RTCEN BIT WRITE

An attempt to write to the RTCEN bit while RTCWREN = 0 will be ignored. RTCWREN must be set before a write to RTCEN can take place.

Like the RTCEN bit, the RTCVALH and RTCVALL registers can only be written to when RTCWREN = 1. A write to these registers, while RTCWREN = 0, will be ignored.

14.2 Operation

14.2.1 REGISTER INTERFACE

The register interface for the RTCC and alarm values is implemented using the Binary Coded Decimal (BCD) format. This simplifies the firmware, when using the module, as each of the digits is contained within its own 4-bit value (see Figure 14-2 and Figure 14-3).

FIGURE 14-2: TIMER DIGIT FORMAT

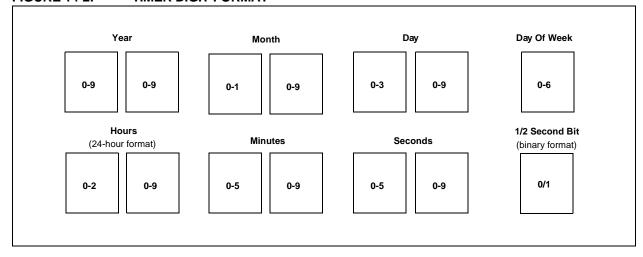
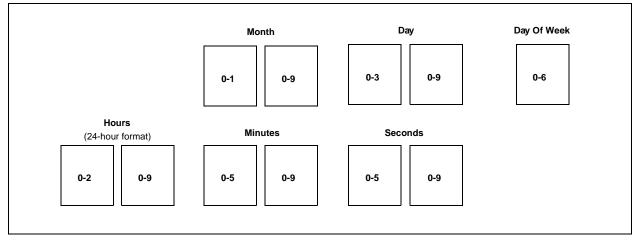


FIGURE 14-3: ALARM DIGIT FORMAT

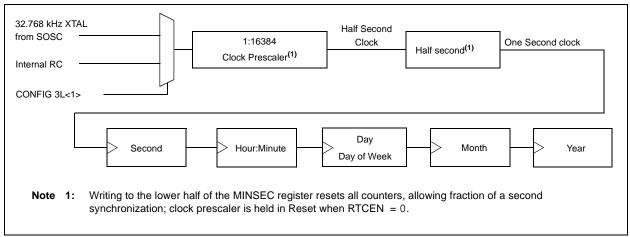


14.2.2 CLOCK SOURCE

As mentioned earlier, the RTCC module is intended to be clocked by an external Real-Time Clock crystal oscillating at 32.768 kHz, but can also be an internal oscillator. The RTCC clock selection is decided by the RTCOSC bit (CONFIG3L<1>).

Calibration of the crystal can be done through this module to yield an error of 3 seconds or less per month. (For further details, see **Section 14.2.9 "Calibration"**.)

FIGURE 14-4: CLOCK SOURCE MULTIPLEXING



14.2.2.1 Real-Time Clock Enable

The RTCC module can be clocked by an external, 32.768 kHz crystal (Timer1 oscillator) or the internal RC oscillator, which can be selected in CONFIG3L<1>.

If the external clock is used, the Timer1 oscillator should be enabled by setting the T1OSCEN bit (T1CON<3>=1). If INTRC is providing the clock, the INTRC clock can be brought out to the RTCC pin by the RTSECSEL<1:0> bits in the PADCFG register.

14.2.3 DIGIT CARRY RULES

This section explains which timer values are affected when there is a rollover.

- Time of Day: from 23:59:59 to 00:00:00 with a carry to the Day field
- Month: from 12/31 to 01/01 with a carry to the Year field
- Day of Week: from 6 to 0 with no carry (see Table 14-1)
- Year Carry: from 99 to 00; this also surpasses the use of the RTCC

For the day to month rollover schedule, see Table 14-2.

Considering that the following values are in BCD format, the carry to the upper BCD digit will occur at count of 10 and not at 16 (SECONDS, MINUTES, HOURS, WEEKDAY, DAYS and MONTHS).

TABLE 14-1: DAY OF WEEK SCHEDULE

Day of Week						
Sunday	0					
Monday	1					
Tuesday	2					
Wednesday	3					
Thursday	4					
Friday	5					
Saturday	6					

TABLE 14-2: DAY TO MONTH ROLLOVER SCHEDULE

Month	Maximum Day Field			
01 (January)	31			
02 (February)	28 or 29 ⁽¹⁾			
03 (March)	31			
04 (April)	30			
05 (May)	31			
06 (June)	30			
07 (July)	31			
08 (August)	31			
09 (September)	30			
10 (October)	31			
11 (November)	30			
12 (December)	31			

Note 1: See Section 14.2.4 "Leap Year".

14.2.4 LEAP YEAR

Since the year range on the RTCC module is 2000 to 2099, the leap year calculation is determined by any year divisible by 4 in the above range. Only February is effected in a leap year.

February will have 29 days in a leap year and 28 days in any other year.

14.2.5 GENERAL FUNCTIONALITY

All Timer registers containing a time value of seconds or greater are writable. The user configures the time by writing the required year, month, day, hour, minutes and seconds to the Timer registers, via Register Pointers (see Section 14.2.8 "Register Mapping").

The timer uses the newly written values and proceeds with the count from the required starting point.

The RTCC is enabled by setting the RTCEN bit (RTCCFG<7>). If enabled while adjusting these registers, the timer still continues to increment. However, any time the MINSEC register is written to, both of the timer prescalers are reset to '0'. This allows fraction of a second synchronization.

The Timer registers are updated in the same cycle as the write instruction's execution by the CPU. The user must ensure that when RTCEN = 1, the updated registers will not be incremented at the same time. This can be accomplished in several ways:

- By checking the RTCSYNC bit (RTCCFG<4>)
- By checking the preceding digits from which a carry can occur
- By updating the registers immediately following the seconds pulse (or alarm interrupt)

The user has visibility to the half-second field of the counter. This value is read-only and can be reset only by writing to the lower half of the SECONDS register.

14.2.6 SAFETY WINDOW FOR REGISTER READS AND WRITES

The RTCSYNC bit indicates a time window during which the RTCC clock domain registers can be safely read and written without concern about a rollover. When RTCSYNC = 0, the registers can be safely accessed by the CPU.

Whether RTCSYNC = 1 or 0, the user should employ a firmware solution to ensure that the data read did not fall on a rollover boundary, resulting in an invalid or partial read. This firmware solution would consist of reading each register twice and then comparing the two values. If the two values matched, then a rollover did not occur.

14.2.7 WRITE LOCK

In order to perform a write to any of the RTCC Timer registers, the RTCWREN bit (RTCCFG<5>) must be set.

To avoid accidental writes to the RTCC Timer register, it is recommended that the RTCWREN bit (RTCCFG<5>) be kept clear at any time other than while writing to it. For the RTCWREN bit to be set, there is only one instruction cycle time window allowed between the 55h/AA sequence and the setting of RTCWREN. For that reason, it is recommended that users follow the code example in Example 14-1.

EXAMPLE 14-1: SETTING THE RTCWREN BIT

movlw	0x55	
movwf	EECON2	
movlw	0xAA	
movwf	EECON2	
bsf	RTCCFG, RTCWREN	I

14.2.8 REGISTER MAPPING

To limit the register interface, the RTCC Timer and Alarm Timer registers are accessed through corresponding Register Pointers. The RTCC Value register window (RTCVALH and RTCVALL) uses the RTCPTR bits (RTCCFG<1:0>) to select the required Timer register pair.

By reading or writing to the RTCVALH register, the RTCC Pointer value (RTCPTR<1:0>) decrements by '1' until it reaches '00'. Once it reaches '00', the MINUTES and SECONDS value will be accessible through RTCVALH and RTCVALL until the pointer value is manually changed.

TABLE 14-3: RTCVALH AND RTCVALL REGISTER MAPPING

RTCPTR<1:0>	RTCC Value Register Window					
KICPIK<1.0>	RTCVALH	RTCVALL				
00	MINUTES	SECONDS				
01	WEEKDAY	HOURS				
10	MONTH	DAY				
11	_	YEAR				

The Alarm Value register window (ALRMVALH and ALRMVALL) uses the ALRMPTR bits (ALRMCFG<1:0>) to select the desired Alarm register pair.

By reading or writing to the ALRMVALH register, the Alarm Pointer value, ALRMPTR<1:0>, decrements by '1' until it reaches '00'. Once it reaches '00', the ALRMMIN and ALRMSEC value will be accessible through ALRMVALH and ALRMVALL until the pointer value is manually changed.

TABLE 14-4: ALRMVAL REGISTER MAPPING

ALRMPTR<1:0>	Alarm Value Register Window					
ALKIMPTK<1.0>	ALRMVALH	ALRMVALL				
0.0	ALRMMIN	ALRMSEC				
01	ALRMWD	ALRMHR				
10	ALRMMNTH	ALRMDAY				
11	_	_				

14.2.9 CALIBRATION

The real-time crystal input can be calibrated using the periodic auto-adjust feature. When properly calibrated, the RTCC can provide an error of less than three seconds per month.

To perform this calibration, find the number of error clock pulses and store the value into the lower half of the RTCCAL register. The 8-bit, signed value – loaded into RTCCAL – is multiplied by 4 and either will be added or subtracted from the RTCC timer, once every minute.

To calibrate the RTCC module:

- 1. Use another timer resource on the device to find the error of the 32.768 kHz crystal.
- Convert the number of error clock pulses per minute (see Equation 14-1).

EQUATION 14-1: CONVERTING ERROR-CLOCK PULSES

(Ideal Frequency (32,758) – Measured Frequency) * 60 = Error Clocks per Minute

- If the oscillator is faster than ideal (negative result from step 2), the RCFGCALL register value needs to be negative. This causes the specified number of clock pulses to be subtracted from the timer counter once every minute.
- If the oscillator is slower than ideal (positive result from step 2), the RCFGCALL register value needs to be positive. This causes the specified number of clock pulses to be added to the timer counter once every minute.
- Load the RTCCAL register with the correct value.

Writes to the RTCCAL register should occur only when the timer is turned off, or immediately after the rising edge of the seconds pulse.

Note: In determining the crystal's error value, it is the user's responsibility to include the crystal's initial error from drift due to temperature or crystal aging.

14.3 Alarm

The Alarm features and characteristics are:

- · Configurable from half a second to one year
- Enabled using the ALRMEN bit (ALRMCFG<7>, Register 14-4)
- · Offers one-time and repeat alarm options

14.3.1 CONFIGURING THE ALARM

The alarm feature is enabled using the ALRMEN bit.

This bit is cleared when an alarm is issued. The bit will not be cleared if the CHIME bit = 1 or if ALRMRPT \neq 0.

The interval selection of the alarm is configured through the ALRMCFG bits (AMASK<3:0>). (See Figure 14-5.) These bits determine which and how many digits of the alarm must match the clock value for the alarm to occur.

The alarm can also be configured to repeat based on a preconfigured interval. The number of times this occurs, after the alarm is enabled, is stored in the ALRMRPT register.

Note: While the alarm is enabled (ALRMEN = 1), changing any of the registers, other than the RTCCAL, ALRMCFG and ALRMRPT registers and the CHIME bit, can result in a false alarm event leading to a false alarm interrupt. To avoid this, only change the timer and alarm values while the alarm is disabled (ALRMEN = 0). It is recommended that the ALRMCFG and

changed when RTCSYNC = 0.

ALRMRPT registers and CHIME bit be

FIGURE 14-5: ALARM MASK SETTINGS

Alarm Mask Setting AMASK<3:0>	Day of the Week	Month D	ay Hours	Minutes	Seconds
0000 – Every half second 0001 – Every second					
0010 - Every 10 seconds					s
0011 – Every minute					ss
0100 – Every 10 minutes				m :	ss
0101 – Every hour				m m	ss
0110 – Every day			h h :	m m :	ss
0111 – Every week	d		h h :	m m :	s
1000 – Every month		/ d	d h h	m m :	ss
1001 – Every year ⁽¹⁾		m m $/$ d	d h h:	m m :	ss

When ALRMCFG = 00 and the CHIME bit = 0 (ALRMCFG<6>), the repeat function is disabled and only a single alarm will occur. The alarm can be repeated up to 255 times by loading the ALRMRPT register with FFh.

After each alarm is issued, the ALRMRPT register is decremented by one. Once the register has reached '00', the alarm will be issued one last time.

After the alarm is issued a last time, the ALRMEN bit is cleared automatically and the alarm turned off. Indefinite repetition of the alarm can occur if the CHIME bit = 1.

When CHIME = 1, the alarm is not disabled when the ALRMRPT register reaches '00', but it rolls over to FF and continues counting indefinitely.

14.3.2 ALARM INTERRUPT

At every alarm event, an interrupt is generated. Additionally, an alarm pulse output is provided that operates at half the frequency of the alarm.

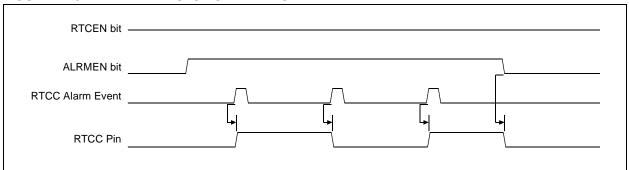
The alarm pulse output is completely synchronous with the RTCC clock and can be used as a trigger clock to other peripherals. This output is available on the RTCC pin. The output pulse is a clock with a 50% duty cycle and a frequency half that of the alarm event (see Figure 14-6).

The RTCC pin also can output the seconds clock. The user can select between the alarm pulse, generated by the RTCC module, or the seconds clock output.

The RTSECSEL<1:0> (PADCFG1<2:1>) bits select between these two outputs:

- Alarm pulse RTSECSEL<1:0> = 00
- Seconds clock RTSECSEL<1:0> = 01

FIGURE 14-6: TIMER PULSE GENERATION



14.4 Sleep Mode

The timer and alarm continue to operate while in Sleep mode. The operation of the alarm is not affected by Sleep, as an alarm event can always wake-up the CPU.

The Idle mode does not affect the operation of the timer or alarm.

14.5 Reset

14.5.1 DEVICE RESET

When a device Reset occurs, the ALCFGRPT register is forced to its Reset state causing the alarm to be disabled (if enabled prior to the Reset). If the RTCC was enabled, it will continue to operate when a basic device Reset occurs.

14.5.2 POWER-ON RESET (POR)

The RTCCFG and ALRMRPT registers are reset only on a POR. Once the device exits the POR state, the clock registers should be reloaded with the desired values.

The timer prescaler values can be reset only by writing to the SECONDS register. No device Reset can affect the prescalers.

14.6 Register Maps

Table 14-5, Table 14-6 and Table 14-7 summarize the registers associated with the RTCC module.

TABLE 14-5: RTCC CONTROL REGISTERS

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets on Page
RTCCFG	RTCEN		RTCWREN	RTCSYNC	HALFSEC	RTCOE	RTCPTR1	RTCPTR0	58
RTCCAL	CAL7	CAL6	CAL5	CAL4	CAL3	CAL2	CAL1	CAL0	58
PADCFG1	_	_	_	_	_	RTSECSEL1	RTSECSEL0	_	58
ALRMCFG	ALRMEN	CHIME	AMASK3	AMASK2	AMASK1	AMASK0	ALRMPTR1	ALRMPTR0	58
ALRMRPT	ARPT7	ARPT6	ARPT5	ARPT4	ARPT3	ARPT2	ARPT1	ARPT0	58

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal for 80-pin devices.

TABLE 14-6: RTCC VALUE REGISTERS

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets on Page
RTCVALH	RTCC Value High Register Window Based on RTCPTR<1:0>								58
RTCVALL	RTCC Value	Low Regist	er Window Ba	ased on RTC	PTR<1:0>				58

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal for 80-pin devices.

TABLE 14-7: ALARM VALUE REGISTERS

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets on Page
ALRMVALH	Alarm Value High Register Window Based on ALRMPTR<1:0>								58
ALRMVALL	Alarm Value Low Register Window Based on ALRMPTR<1:0>							58	

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal for 80-pin devices.

© 2009 Microchip Technology Inc. Preliminary DS39933C-page 165

NOTES:

15.0 CAPTURE/COMPARE/PWM (CCP) MODULES

PIC18F87J90 family devices have two CCP (Capture/Compare/PWM) modules, designated CCP1 and CCP2. Both modules implement standard capture, compare and Pulse-Width Modulation (PWM) modes.

Each CCP module contains two 8-bit registers that can operate as two 8-bit Capture registers, two 8-bit Compare registers or two PWM Master/Slave Duty Cycle registers. For the sake of clarity, all CCP module operation in the following sections is described with respect to CCP2, but is equally applicable to CCP1.

REGISTER 15-1: CCPxCON: CCPx CONTROL REGISTER (CCP1, CCP2 MODULES)

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	DCxB1	DCxB0	CCPxM3	CCPxM2	CCPxM1	CCPxM0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-6 **Unimplemented:** Read as '0'

bit 5-4 DCxB<1:0>: PWM Duty Cycle bit 1 and bit 0 for CCPx Module

Capture mode:

Unused.

Compare mode:

Unused.

PWM mode:

These bits are the two Least Significant bits (bit 1 and bit 0) of the 10-bit PWM duty cycle. The eight Most Significant bits (DCx<9:2>) of the duty cycle are found in CCPRxL.

bit 3-0 CCPxM<3:0>: CCPx Module Mode Select bits

0000 = Capture/Compare/PWM disabled (resets CCPx module)

0001 = Reserved

0010 = Compare mode, toggle output on match (CCPxIF bit is set)

0011 = Reserved

0100 = Capture mode, every falling edge

0101 = Capture mode, every rising edge

0110 = Capture mode, every 4th rising edge

0111 = Capture mode, every 16th rising edge

1000 = Compare mode: initialize CCPx pin low; on compare match, force CCPx pin high (CCPxIF bit is set)

1001 = Compare mode: initialize CCPx pin high; on compare match, force CCPx pin low (CCPxIF bit is set)

1010 = Compare mode: generate software interrupt on compare match (CCPxIF bit is set, CCPx pin reflects I/O state)

1011 = Compare mode: Special Event Trigger; reset timer; start A/D conversion on CCPx match (CCPxIF bit is set)⁽¹⁾

11xx = PWM mode

Note 1: CCPxM<3:0> = 1011 will only reset timer and not start A/D conversion on CCP1 match.

15.1 CCP Module Configuration

Each Capture/Compare/PWM module is associated with a control register (generically, CCPxCON) and a data register (CCPRx). The data register, in turn, is comprised of two 8-bit registers: CCPRxL (low byte) and CCPRxH (high byte). All registers are both readable and writable.

15.1.1 CCP MODULES AND TIMER RESOURCES

The CCP modules utilize timers 1, 2 or 3, depending on the mode selected. Timer1 and Timer3 are available to modules in Capture or Compare modes, while Timer2 is available for modules in PWM mode.

TABLE 15-1: CCP MODE – TIMER RESOURCE

CCP Mode	Timer Resource
Capture	Timer1 or Timer3
Compare PWM	Timer1 or Timer3 Timer2

The assignment of a particular timer to a module is determined by the Timer to CCP enable bits in the T3CON register (Register 13-1). Both modules may be active at any given time and may share the same timer resource if they are configured to operate in the same mode (Capture/Compare or PWM) at the same time. The interactions between the two modules are summarized in Table 15-2.

Depending on the configuration selected, up to four timers may be active at once, with modules in the same configuration (Capture/Compare or PWM) sharing timer resources. The possible configurations are shown in Figure 15-1.

15.1.2 OPEN-DRAIN OUTPUT OPTION

When operating in Output mode (i.e., in Compare or PWM modes), the drivers for the CCPx pins can be optionally configured as open-drain outputs. This feature allows the voltage level on the pin to be pulled to a higher level through an external pull-up resistor and allows the output to communicate with external circuits without the need for additional level shifters.

The open-drain output option is controlled by the CCP2OD and CCP1OD bits (TRISG<6:5>). Setting the appropriate bit configures the pin for the corresponding module for open-drain operation.

15.1.3 CCP2 PIN ASSIGNMENT

The pin assignment for CCP2 (capture input, compare and PWM output) can change, based on device configuration. The CCP2MX Configuration bit determines which pin CCP2 is multiplexed to. By default, it is assigned to RC1 (CCP2MX = 1). If the Configuration bit is cleared, CCP2 is multiplexed with RE7.

Changing the pin assignment of CCP2 does not automatically change any requirements for configuring the port pin. Users must always verify that the appropriate TRIS register is configured correctly for CCP2 operation, regardless of where it is located.

FIGURE 15-1: CCP AND TIMER INTERCONNECT CONFIGURATIONS

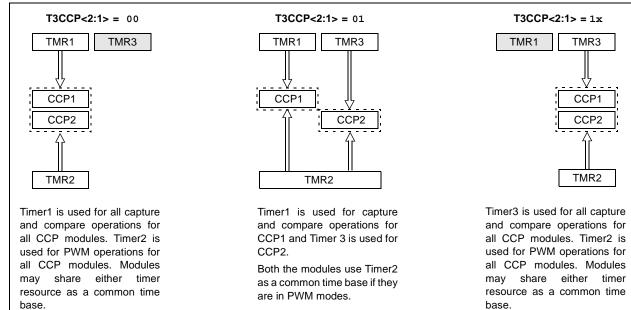


TABLE 15-2: INTERACTIONS BETWEEN CCP1 AND CCP2 FOR TIMER RESOURCES

CCP1 Mode	CCP2 Mode	Interaction
Capture	Capture	Each module can use TMR1 or TMR3 as the time base. The time base can be different for each CCP.
Capture	Compare	CCP2 can be configured for the Special Event Trigger to reset TMR1 or TMR3 (depending upon which time base is used). Automatic A/D conversions on trigger event can also be done. Operation of CCP1 could be affected if it is using the same timer as a time base.
Compare	Capture	CCP1 can be configured for the Special Event Trigger to reset TMR1 or TMR3 (depending upon which time base is used). Operation of CCP2 could be affected if it is using the same timer as a time base.
Compare	Compare	Either module can be configured for the Special Event Trigger to reset the time base. Automatic A/D conversions on CCP2 trigger event can be done. Conflicts may occur if both modules are using the same time base.
Capture	PWM	None
Compare	PWM	None
PWM	Capture	None
PWM	Compare	None
PWM	PWM	Both PWMs will have the same frequency and update rate (TMR2 interrupt).

15.2 Capture Mode

In Capture mode, the CCPR2H:CCPR2L register pair captures the 16-bit value of the TMR1 or TMR3 register when an event occurs on the CCP2 pin (RC1 or RE7, depending on device configuration). An event is defined as one of the following:

- · Every falling edge
- · Every rising edge
- · Every 4th rising edge
- · Every 16th rising edge

The event is selected by the mode select bits, CCP2M<3:0> (CCP2CON<3:0>). When a capture is made, the interrupt request flag bit, CCP2IF (PIR3<2>), is set; it must be cleared in software. If another capture occurs before the value in register CCPR2 is read, the old captured value is overwritten by the new captured value.

15.2.1 CCP PIN CONFIGURATION

In Capture mode, the appropriate CCPx pin should be configured as an input by setting the corresponding TRIS direction bit.

Note: If RC1/CCP2 or RE7/CCP2 is configured as an output, a write to the port can cause a capture condition.

15.2.2 TIMER1/TIMER3 MODE SELECTION

The timers that are to be used with the capture feature (Timer1 and/or Timer3) must be running in Timer mode or Synchronized Counter mode. In Asynchronous Counter mode, the capture operation may not work. The timer to be used with each CCP module is selected in the T3CON register (see Section 15.1.1 "CCP Modules and Timer Resources").

15.2.3 SOFTWARE INTERRUPT

When the Capture mode is changed, a false capture interrupt may be generated. The user should keep the CCP2IE bit (PIE3<2>) clear to avoid false interrupts and should clear the flag bit, CCP2IF, following any such change in operating mode.

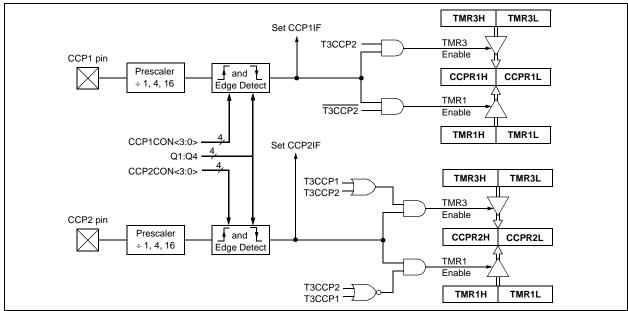
15.2.4 CCP PRESCALER

There are four prescaler settings in Capture mode. They are specified as part of the operating mode selected by the mode select bits (CCP2M<3:0>). Whenever the CCP module is turned off, or the CCP module is not in Capture mode, the prescaler counter is cleared. This means that any Reset will clear the prescaler counter.

Switching from one capture prescaler to another may generate an interrupt. Also, the prescaler counter will not be cleared; therefore, the first capture may be from a non-zero prescaler. Example 15-1 shows the recommended method for switching between capture prescalers. This example also clears the prescaler counter and will not generate the "false" interrupt.

EXAMPLE 15-1: CHANGING BETWEEN CAPTURE PRESCALERS

FIGURE 15-2: CAPTURE MODE OPERATION BLOCK DIAGRAM



15.3 Compare Mode

In Compare mode, the 16-bit CCPR2 register value is constantly compared against either the TMR1 or TMR3 register pair value. When a match occurs, the CCP2 pin can be:

- · driven high
- · driven low
- toggled (high-to-low or low-to-high)
- remain unchanged (that is, reflects the state of the I/O latch)

The action on the pin is based on the value of the mode select bits (CCP2M<3:0>). At the same time, the interrupt flag bit, CCP2IF, is set.

15.3.1 CCP PIN CONFIGURATION

The user must configure the CCPx pin as an output by clearing the appropriate TRIS bit.

Note: Clearing the CCP2CON register will force the RC1 or RE7 compare output latch (depending on device configuration) to the default low level. This is not the PORTC or PORTE I/O data latch.

15.3.2 TIMER1/TIMER3 MODE SELECTION

Timer1 and/or Timer3 must be running in Timer mode, or Synchronized Counter mode, if the CCP module is using the compare feature. In Asynchronous Counter mode, the compare operation may not work.

15.3.3 SOFTWARE INTERRUPT MODE

When the Generate Software Interrupt mode is chosen (CCP2M<3:0> = 1010), the CCP2 pin is not affected. Only a CCP interrupt is generated, if enabled, and the CCP2IE bit is set.

15.3.4 SPECIAL EVENT TRIGGER

Both CCP modules are equipped with a Special Event Trigger. This is an internal hardware signal generated in Compare mode to trigger actions by other modules. The Special Event Trigger is enabled by selecting the Compare Special Event Trigger mode (CCP2M<3:0> = 1011).

For either CCP module, the Special Event Trigger resets the Timer register pair for whichever timer resource is currently assigned as the module's time base. This allows the CCPRx registers to serve as a programmable period register for either timer.

The Special Event Trigger for CCP2 can also start an A/D conversion. In order to do this, the A/D converter must already be enabled.

Note: The Special Event Trigger of CCP1 only resets Timer1/Timer3 and cannot start an A/D conversion even when the A/D converter is enabled.

FIGURE 15-3: COMPARE MODE OPERATION BLOCK DIAGRAM

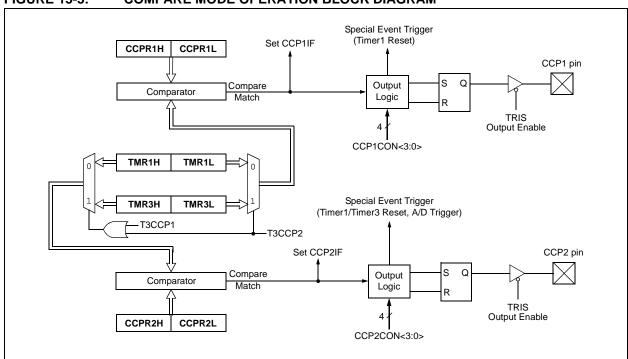


TABLE 15-3: REGISTERS ASSOCIATED WITH CAPTURE, COMPARE, TIMER1 AND TIMER3

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53
RCON	IPEN	_	CM	RI	TO	PD	POR	BOR	54
PIR3	_	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	56
PIE3	_	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	56
IPR3	_	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	56
PIR2	OSCFIF	CMIF	1	1	BCLIF	LVDIF	TMR3IF	1	56
PIE2	OSCFIE	CMIE			BCLIE	LVDIE	TMR3IE	1	56
IPR2	OSCFIP	CMIP	1	1	BCLIP	LVDIP	TMR3IP	-	56
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	56
TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	_	TRISE1	TRISE0	56
TRISG	SPIOD	CCP2OD	CCP10D	TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	56
TMR1L	Timer1 Register Low Byte								54
TMR1H	Timer1 Reg	gister High E	Byte						54
T1CON	RD16	T1RUN	T1CKPS1	T1CKPS0	T10SCEN	T1SYNC	TMR1CS	TMR10N	54
TMR3H	Timer3 Reg	gister High E	Byte						55
TMR3L	Timer3 Reg	gister Low B	yte						55
T3CON	RD16	T3CCP2	T3CKPS1	T3CKPS0	T3CCP1	T3SYNC	TMR3CS	TMR3ON	55
CCPR1L	Capture/Compare/PWM Register 1 Low Byte							57	
CCPR1H	Capture/Compare/PWM Register 1 High Byte							57	
CCP1CON	_	_	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	57
CCPR2L	Capture/Compare/PWM Register 2 Low Byte							58	
CCPR2H	Capture/Co	mpare/PWI	M Register 2	2 High Byte					57
CCP2CON	_	_	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	58

Legend: — = unimplemented, read as '0'. Shaded cells are not used by Capture/Compare, Timer1 or Timer3.

15.4 PWM Mode

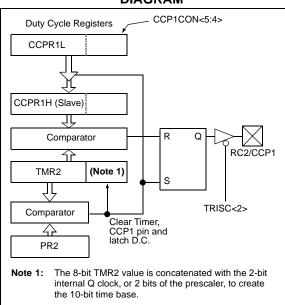
In Pulse-Width Modulation (PWM) mode, the CCP2 pin produces up to a 10-bit resolution PWM output. Since the CCP2 pin is multiplexed with a PORTC or PORTE data latch, the appropriate TRIS bit must be cleared to make the CCP2 pin an output.

Note: Clearing the CCP2CON register will force the RC1 or RE7 output latch (depending on device configuration) to the default low level. This is not the PORTC or PORTE I/O data latch.

Figure 15-4 shows a simplified block diagram of the CCP1 module in PWM mode.

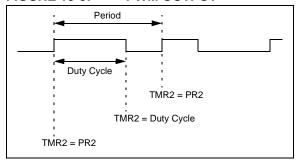
For a step-by-step procedure on how to set up the CCP module for PWM operation, see **Section 15.4.3** "Setup for PWM Operation".

FIGURE 15-4: SIMPLIFIED PWM BLOCK DIAGRAM



A PWM output (Figure 15-5) has a time base (period) and a time that the output stays high (duty cycle). The frequency of the PWM is the inverse of the period (1/period).

FIGURE 15-5: PWM OUTPUT



15.4.1 PWM PERIOD

The PWM period is specified by writing to the PR2 register. The PWM period can be calculated using the following formula:

EQUATION 15-1:

PWM frequency is defined as 1/[PWM period].

When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

- · TMR2 is cleared
- The CCP2 pin is set (exception: if PWM duty cycle = 0%, the CCP2 pin will not be set)
- The PWM duty cycle is latched from CCPR2L into CCPR2H

Note: The Timer2 postscalers (see Section 12.0 "Timer2 Module") are not used in the determination of the PWM frequency. The postscaler could be used to have a servo update rate at a different frequency than the PWM output.

15.4.2 PWM DUTY CYCLE

The PWM duty cycle is specified by writing to the CCPR2L register and to the CCP2CON<5:4> bits. Up to 10-bit resolution is available. The CCPR2L contains the eight MSbs and the CCP2CON<5:4> contains the two LSbs. This 10-bit value is represented by CCPR2L:CCP2CON<5:4>. The following equation is used to calculate the PWM duty cycle in time:

EQUATION 15-2:

CCPR2L and CCP2CON<5:4> can be written to at any time, but the duty cycle value is not latched into CCPR2H until after a match between PR2 and TMR2 occurs (i.e., the period is complete). In PWM mode, CCPR2H is a read-only register.

The CCPR2H register and a 2-bit internal latch are used to double-buffer the PWM duty cycle. This double-buffering is essential for glitchless PWM operation.

When the CCPR2H and 2-bit latch match TMR2, concatenated with an internal 2-bit Q clock or 2 bits of the TMR2 prescaler, the CCP2 pin is cleared.

The maximum PWM resolution (bits) for a given PWM frequency is given by the equation:

EQUATION 15-3:

PWM Resolution (max) =
$$\frac{\log(\frac{FOSC}{FPWM})}{\log(2)}$$
 bits

Note: If the PWM duty cycle value is longer than the PWM period, the CCP2 pin will not be cleared.

TABLE 15-4: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS AT 40 MHz

PWM Frequency	2.44 kHz	9.77 kHz	39.06 kHz	156.25 kHz	312.50 kHz	416.67 kHz
Timer Prescaler (1, 4, 16)	16	4	1	1	1	1
PR2 Value	FFh	FFh	FFh	3Fh	1Fh	17h
Maximum Resolution (bits)	14	12	10	8	7	6.58

15.4.3 SETUP FOR PWM OPERATION

The following steps should be taken when configuring the CCP module for PWM operation:

- 1. Set the PWM period by writing to the PR2 register.
- 2. Set the PWM duty cycle by writing to the CCPR2L register and CCP2CON<5:4> bits.
- 3. Make the CCP2 pin an output by clearing the appropriate TRIS bit.
- 4. Set the TMR2 prescale value, then enable Timer2 by writing to T2CON.
- 5. Configure the CCP2 module for PWM operation.

TABLE 15-5: REGISTERS ASSOCIATED WITH PWM AND TIMER2

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53
RCON	IPEN	_	CM	RI	TO	PD	POR	BOR	54
PIR1	_	ADIF	RC1IF	TX1IF	SSPIF	_	TMR2IF	TMR1IF	56
PIE1	_	ADIE	RC1IE	TX1IE	SSPIE		TMR2IE	TMR1IE	56
IPR1	_	ADIP	RC1IP	TX1IP	SSPIP	_	TMR2IP	TMR1IP	56
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	56
TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	_	TRISE1	TRISE0	56
TRISG	SPIOD	CCP2OD	CCP10D	TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	56
TMR2	Timer2 Register								54
PR2	Timer2 Period Register							54	
T2CON	_	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	54
CCPR1L	Capture/Compare/PWM Register 1 Low Byte							57	
CCPR1H	Capture/Compare/PWM Register 1 High Byte							57	
CCP1CON	-	_	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	57
CCPR2L	L Capture/Compare/PWM Register 2 Low Byte								58
CCPR2H	Capture/Co	mpare/PWM	1 Register 2	High Byte					57
CCP2CON	_	_	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	58

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PWM or Timer2.

© 2009 Microchip Technology Inc. Preliminary DS39933C-page 175

NOTES:

16.0 LIQUID CRYSTAL DISPLAY (LCD) DRIVER MODULE

The Liquid Crystal Display (LCD) driver module generates the timing control to drive a static or multiplexed LCD panel. It also provides control of the LCD pixel data. The module can drive panels of up to 192 pixels (48 segments by 4 commons) in PIC18F8XJ90 devices, and 132 pixels (33 segments by 4 commons) in PIC18F6XJ90 devices.

The LCD driver module supports these features:

- · Direct driving of LCD panel
- On-chip bias generator with dedicated charge pump to support a range of fixed and variable bias options
- Up to four commons, with four Multiplexing modes
- Up to 48 (PIC18F8XJ90 devices) or 33 (PIC18F6XJ90 devices) segments
- Three LCD clock sources with selectable prescaler, with a fourth source available for use with the LCD charge pump

A simplified block diagram of the module is shown in Figure 16-1.

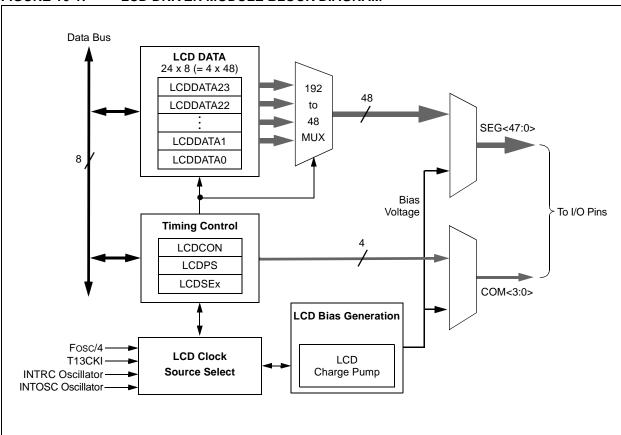


FIGURE 16-1: LCD DRIVER MODULE BLOCK DIAGRAM

© 2009 Microchip Technology Inc. Preliminary DS39933C-page 177

16.1 LCD Registers

The LCD driver module has 33 registers:

- LCD Control Register (LCDCON)
- LCD Phase Register (LCDPS)
- LCDREG Register (LCD Regulator Control)
- Six LCD Segment Enable Registers (LCDSE5:LCDSE0)
- 24 LCD Data Registers (LCDDATA23:LCDDATA0)

16.1.1 LCD CONTROL REGISTERS

The LCDCON register, shown in Register 16-1, controls the overall operation of the module. Once the module is configured, the LCDEN (LCDCON<7>) bit is used to enable or disable the LCD module. The LCD panel can also operate during Sleep by clearing the SLPEN (LCDCON<6>) bit.

The LCDPS register, shown in Register 16-2, configures the LCD clock source prescaler and the type of waveform: Type-A or Type-B. Details on these features are provided in Section 16.2 "LCD Clock Source", Section 16.3 "LCD Bias Generation" and Section 16.8 "LCD Waveform Generation".

The LCDREG register is described in **Section 16.3** "LCD Bias Generation".

The LCD Segment Enable registers (LCDSEx) configure the functions of the port pins. Setting the segment enable bit for a particular segment configures that pin as an LCD driver. The prototype LCDSE register is shown in Register 16-3. There are six LCDSE registers (LCDSE5:LCDSE0), listed in Table 16-1.

REGISTER 16-1: LCDCON: LCD CONTROL REGISTER

R/W-0	R/W-0	R/C-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	
LCDEN	SLPEN	WERR	_	CS1	CS0	LMUX1	LMUX0	
bit 7 bit 0								

Legend:	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 LCDEN: LCD Driver Enable bit

1 = LCD driver module is enabled 0 = LCD driver module is disabled

bit 6 SLPEN: LCD Driver Enable in Sleep mode bit

1 = LCD driver module is disabled in Sleep mode 0 = LCD driver module is enabled in Sleep mode

bit 5 WERR: LCD Write Failed Error bit

1 = LCDDATAx register written while LCDPS<4> = 0 (must be cleared in software)

0 = No LCD write error

bit 4 **Unimplemented:** Read as '0'

bit 3-2 Clock Source Select bits

1x = INTRC (31 kHz) 01 = T13CKI (Timer1) 00 = System clock (Fosc/4)

bit 1-0 LMUX<1:0>: Commons Select bits

LMUX<1:0>	Multipley Type	Maximum Nur	mber of Pixels:	Piec Type	
LIVIUA<1.U>	Multiplex Type	PIC18F6XJ90	PIC18F8XJ90	Bias Type	
00	Static (COM0)	33	48	Static	
01	1/2 (COM1:COM0)	66	96	1/2 or 1/3	
10	1/3 (COM2:COM0)	99	144	1/2 or 1/3	
11	1/4 (COM3:COM0)	132	192	1/3	

REGISTER 16-2: LCDPS: LCD PHASE REGISTER

R/W-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0
WFT	BIASMD	LCDA	WA	LP3	LP2	LP1	LP0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 WFT: Waveform Type Select bit

1 = Type-B waveform (phase changes on each frame boundary)

0 = Type-A waveform (phase changes within each common type)

bit 6 **BIASMD:** Bias Mode Select bit

When LMUX<1:0> = 00:

0 = Static Bias mode (do not set this bit to '1')

When LMUX<1:0> = 01 or 10:

1 = 1/2 Bias mode

0 = 1/3 Bias mode

When LMUX<1:0> = 11:

0 = 1/3 Bias mode (do not set this bit to '1')

bit 5 LCDA: LCD Active Status bit

1 = LCD driver module is active

0 = LCD driver module is inactive

bit 4 WA: LCD Write Allow Status bit

1 = Write into the LCDDATAx registers is allowed

0 = Write into the LCDDATAx registers is not allowed

bit 3-0 LP<3:0>: LCD Prescaler Select bits

1111 = 1:16

1110 = 1:15

1101 = 1:14

1100 = 1:13

1011 = 1:12

1010 = 1:11

1001 = 1:10

1000 = 1:90111 = 1:8

0110 = 1:7

0101 = 1:60100 = 1:5

0011 = 1:4

0010 = 1:3

0001 = 1:2

0000 = 1:1

REGISTER 16-3: LCDSEx: LCD SEGMENT ENABLE REGISTERS

R/W-0	R/W-0						
SE(n + 7)	SE(n + 6)	SE(n + 5)	SE(n + 4)	SE(n + 3)	SE(n + 2)	SE(n + 1)	SE(n)
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 **SEG(n + 7):SEG(n):** Segment Enable bits

For LCDSE0: n = 0For LCDSE1: n = 8For LCDSE2: n = 16For LCDSE3: n = 24For LCDSE4: n = 32For LCDSE5: n = 40

1 = Segment function of the pin is enabled, digital I/O disabled

0 = I/O function of the pin is enabled

TABLE 16-1: LCDSE REGISTERS AND ASSOCIATED SEGMENTS

Register	Segments
LCDSE0	7:0
LCDSE1	15:8
LCDSE2	23:16
LCDSE3	31:24
LCDSE4 ⁽¹⁾	39:32
LCDSE5 ⁽²⁾	47:40

Note 1: LCDSE4<7:1> (SEG<39:33>) are not implemented in PIC18F6XJ90 devices.

2: LCDSE5 is not implemented in PIC18F6XJ90 devices.

16.1.2 LCD DATA REGISTERS

Once the module is initialized for the LCD panel, the individual bits of the LCDDATA23:LCDDATA0 registers are cleared or set to represent a clear or dark pixel, respectively. Specific sets of LCDDATA registers are used with specific segments and common signals. Each bit represents a unique combination of a specific segment connected to a specific common.

Individual LCDDATA bits are named by the convention "SxxCy", with "xx" as the segment number and "y" as the common number. The relationship is summarized in Table 16-2. The prototype LCDDATA register is shown in Register 16-4.

Note: In 64-pin devices, writing into the registers LCDDATA5, LCDDATA11, LCDDATA17 and LCDDATA23 will not affect the status of any pixels.

REGISTER 16-4: LCDDATAX: LCD DATA REGISTERS

R/W-0	R/W-0						
S(n + 7)Cy	S(n + 6)Cy	S(n + 5)Cy	S(n + 4)Cy	S(n + 3)Cy	S(n + 2)Cy	S(n + 1)Cy	S(n)Cy
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 S(n + 7)Cy:S(n)Cy: Pixel On bits

For LCDDATA0 through LCDDATA5: n = (8x), y = 0For LCDDATA6 through LCDDATA11: n = (8(x - 6)), y = 1For LCDDATA12 through LCDDATA17: n = (8(x - 12)), y = 2For LCDDATA18 through LCDDATA23: n = (8(x - 18)), y = 3

1 = Pixel on (dark) 0 = Pixel off (clear)

TABLE 16-2: LCDDATA REGISTERS AND BITS FOR SEGMENT AND COM COMBINATIONS

Sagmenta	COM Lines						
Segments	0	1	2	3			
O through 7	LCDDATA0	LCDDATA6	LCDDATA12	LCDDATA18			
0 through 7	S00C0:S07C0	S00C1:S07C1	S00C2:S07C2	S00C3:S07C3			
0 through 1F	LCDDATA1	LCDDATA7	LCDDATA13	LCDDATA19			
8 through 15	S08C0:S15C0	S08C1:S15C1	S08C2:S15C2	S08C0:S15C3			
16 through 23	LCDDATA2	LCDDATA8	LCDDATA14	LCDDATA20			
	S16C0:S23C0	S16C1:S23C1	S16C2:S23C2	S16C3:S23C3			
24 through 21	LCDDATA3	LCDDATA9	LCDDATA15	LCDDATA21			
24 through 31	S24C0:S31C0	S24C1:S31C1	S24C2:S31C2	S24C3:S31C3			
32 through 39	LCDDATA4 ⁽¹⁾	LCDDATA10 ⁽¹⁾	LCDDATA16 ⁽¹⁾	LCDDATA22 ⁽¹⁾			
32 tillough 39	S32C0:S39C0	S32C1:S39C1	S32C2:S39C2	S32C3:S39C3			
40 th rough 47	LCDDATA5 ⁽²⁾	LCDDATA11 ⁽²⁾	LCDDATA17 ⁽²⁾	LCDDATA23 ⁽²⁾			
40 through 47	S40C0:S47C0	S40C1:S47C1	S40C2:S47C2	S40C3:S47C3			

Note 1: Bits<7:1> of these registers are not implemented in PIC18F6XJ90 devices. Bit 0 of these registers (SEG32Cy) is always implemented.

2: These registers are not implemented on PIC18F6XJ90 devices.

16.2 LCD Clock Source

The LCD driver module generates its internal clock from 3 possible sources:

- System clock (Fosc/4)
- · Timer1 oscillator
- INTRC source

The LCD clock generator uses a configurable divide-by-32/divide-by-8192 postscaler to produce a baseline frequency of about 1 kHz nominal, regardless of the source selected. The clock source selection and the postscaler configuration are determined by the Clock Source Select bits, CS<1:0> (LCDCON<3:2>).

An additional programmable prescaler is used to derive the LCD frame frequency from the 1 kHz baseline. The prescaler is configured using the LP<3:0> bits (LCDPS<3:0>) for any one of 16 options, ranging from 1:1 to 1:16.

Proper timing for waveform generation is set by the LMUX<1:0> bits (LCDCON<1:0>). These bits determine which Commons Multiplexing mode is to be used, and divide down the LCD clock source as required. They also determine the configuration of the ring counter that is used to switch the LCD commons on or off.

16.2.1 LCD VOLTAGE REGULATOR CLOCK SOURCE

In addition to the clock source for LCD timing, a separate 31 kHz nominal clock is required for the LCD charge pump. This is provided from a distinct branch of the LCD clock source.

The charge pump clock can use either the Timer1 oscillator or the INTRC source, as well as the 8 MHz INTOSC source (after being divided by 256 by a prescaler). The charge pump clock source is configured using the CKSEL<1:0> bits (LCDREG<1:0>).

16.2.2 CLOCK SOURCE CONSIDERATIONS

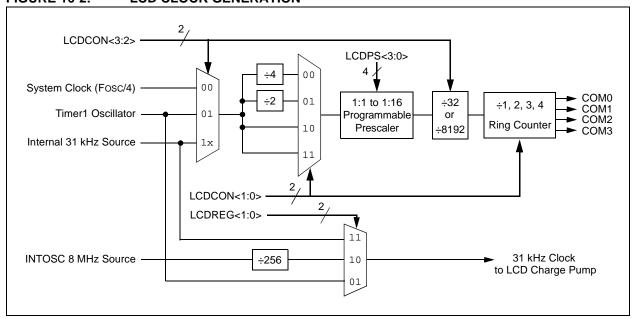
When using the system clock as the LCD clock source, it is assumed that the system clock frequency is a nominal 32 MHz (for a Fosc/4 frequency of 8 MHz). Because the prescaler option for the Fosc/4 clock selection is fixed at divide-by-8192, system clock speeds that differ from 32 MHz will produce frame frequencies and refresh rates different than discussed in this chapter. The user will need to keep this in mind when designing the display application.

The Timer1 and INTRC sources can be used as LCD clock sources when the device is in Sleep mode. To use the Timer1 oscillator, it is necessary to set the T1OSCEN bit (T1CON<3>). Selecting either Timer1 or INTRC as the LCD clock source will not automatically activate these sources.

Similarly, selecting the INTOSC as the charge pump clock source will not turn the oscillator on. To use INTOSC, it must be selected as the system clock source by using the FOSC2 Configuration bit.

If Timer1 is used as a clock source for the device, either as an LCD clock source or for any other purpose, LCD segment 32 become unavailable.

FIGURE 16-2: LCD CLOCK GENERATION



16.3 **LCD Bias Generation**

The LCD driver module is capable of generating the required bias voltages for LCD operation with a minimum of external components. This includes the ability to generate the different voltage levels required by the different bias types required by the LCD. The driver module can also provide bias voltages both above and below microcontroller VDD through the use of an on-chip LCD voltage regulator.

16.3.1 LCD BIAS TYPES

PIC18F87J90 family devices support three bias types based on the waveforms generated to control segments and commons:

Static (two discrete levels)

bit 1-0

- 1/2 Bias (three discrete levels
- 1/3 Bias (four discrete levels)

The use of different waveforms in driving the LCD is discussed in more detail in Section 16.8 "LCD Waveform Generation".

16.3.2 LCD VOLTAGE REGULATOR

The purpose of the LCD regulator is to provide proper bias voltage and good contrast for the LCD, regardless of VDD levels. This module contains a charge pump and internal voltage reference. The regulator can be configured by using external components to boost bias voltage above VDD. It can also operate a display at a constant voltage below VDD. The regulator can also be selectively disabled to allow bias voltages to be generated by an external resistor network.

The LCD regulator is controlled through the LCDREG register (Register 16-5). It is enabled or disabled using the CKSEL<1:0> bits, while the charge pump can be selectively enabled using the CPEN bit. When the regulator is enabled, the MODE13 bit is used to select the bias type. The peak LCD bias voltage, measured as a difference between the potentials of LCDBIAS3 and LCDBIASO, is configured with the BIAS bits.

REGISTER 16-5: LCDREG: VOLTAGE REGULATOR CONTROL REGISTER

U-0	RW-0	RW-1	RW-1	RW-1	RW-1	RW-0	RW-0
_	CPEN	BIAS2	BIAS1	BIAS0	MODE13	CKSEL1	CKSEL0
bit 7							bit 0

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 7	Unimplemented: Read as '0'
bit 6	CPEN: LCD Charge Pump Enable bit
	1 = Charge pump enabled; highest LCD bias voltage is 3.6V0 = Charge pump disabled; highest LCD bias voltage is AVDD
bit 5-3	BIAS<2:0>: Regulator Voltage Output Control bits
	111 = 3.60V peak (offset on LCDBIASO of 0V) 110 = 3.47V peak (offset on LCDBIASO of 0.13V) 101 = 3.34V peak (offset on LCDBIASO of 0.26V) 100 = 3.21V peak (offset on LCDBIASO of 0.39V) 011 = 3.08V peak (offset on LCDBIASO of 0.52V) 010 = 2.95V peak (offset on LCDBIASO of 0.65V) 001 = 2.82V peak (offset on LCDBIASO of 0.78V) 000 = 2.69V peak (offset on LCDBIASO of 0.91V)
bit 2	MODE13: 1/3 LCD Bias Enable bit
	1 = Regulator output supports 1/3 LCD Bias mode0 = Regulator output supports static LCD Bias mode

CKSEL<1:0>: Regulator Clock Source Select bits

10 = INTOSC 8 MHz source

01 = Timer1 oscillator

11 = INTRC

00 = LCD regulator disabled

16.3.3 BIAS CONFIGURATIONS

PIC18F87J90 family devices have four distinct circuit configurations for LCD bias generation:

- . M0: Regulator with Boost
- . M1: Regulator without Boost
- M2: Resistor Ladder with Software Contrast
- M3: Resistor Ladder with Hardware Contrast

16.3.3.1 M0 (Regulator with Boost)

In M0 operation, the LCD charge pump feature is enabled. This allows the regulator to generate voltages up to +3.6V to the LCD (as measured at LCDBIAS3).

M0 uses a flyback capacitor connected between VLCAP1 and VLCAP2, as well as filter capacitors on LCDBIAS0 through LCDBIAS3, to obtain the required voltage boost (Figure 16-3). The output voltage (VBIAS) is the difference of potential between LCDBIAS3 and LCDBIAS0. It is set by the BIAS<2:0> bits which adjust the offset between LCDBIAS0 and Vss. The flyback capacitor (CFLY) acts as a charge storage element for large LCD loads. This mode is useful in those cases where the voltage requirements of the LCD are higher than the microcontroller's VDD. It also permits software control of the display's contrast by adjustment of bias voltage by changing the value of the BIAS bits.

M0 supports Static and 1/3 Bias types. Generation of the voltage levels for 1/3 Bias is handled automatically, but must be configured in software.

M0 is enabled by selecting a valid regulator clock source (CKSEL<1:0> set to any value except '00') and setting the CPEN bit. If static Bias type is required, the MODE13 bit must be cleared.

16.3.3.2 M1 (Regulator without Boost)

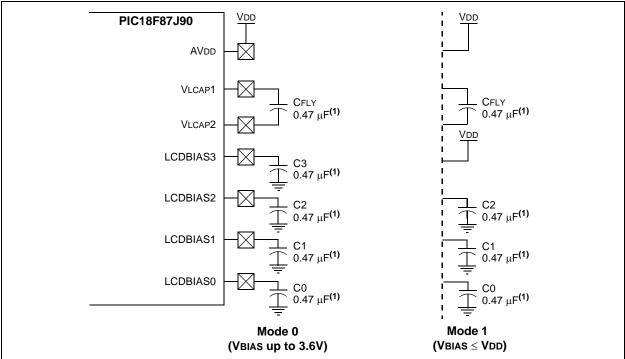
M1 operation is similar to M0, but does not use the LCD charge pump. It can provide VBIAS up to the voltage level supplied directly to LCDBIAS3. It can be used in cases where VDD for the application is expected to never drop below a level that can provide adequate contrast for the LCD. The connection of external components is very similar to M0, except that LCDBIAS3 must be tied directly to VDD (Figure 16-3).

The BIAS<2:0> bits can still be used to adjust contrast in software by changing VBIAS. As with M0, changing these bits changes the offset between LCDBIASO and Vss. In M1, this is reflected in the change between the LCDBIASO and the voltage tied to LCDBIAS3. Thus, if VDD should change, VBIAS will also change; where in M0, the level of VBIAS is constant.

Like M0, M1 supports Static and 1/3 Bias types. Generation of the voltage levels for 1/3 Bias is handled automatically but must be configured in software.

M1 is enabled by selecting a valid regulator clock source (CKSEL<1:0> set to any value except '00') and clearing the CPEN bit. If 1/3 Bias type is required, the MODE13 bit should also be set.

FIGURE 16-3: LCD REGULATOR CONNECTIONS FOR M0 AND M1 CONFIGURATIONS



Note 1: These values are provided for design guidance only; they should be optimized for the application by the designer based on the actual LCD specifications.

16.3.3.3 M2 (Resistor Ladder with Software Contrast)

M2 operation also uses the LCD regulator but disables the charge pump. The regulator's internal voltage reference remains active as a way to regulate contrast. It is used in cases where the current requirements of the LCD exceed the capacity of the regulator's charge pump.

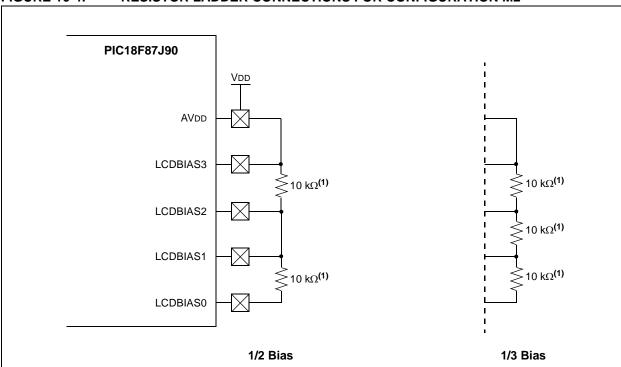
In this configuration, the LCD bias voltage levels are created by an external resistor voltage divider connected across LCDBIAS0 through LCDBIAS3, with the top of the divider tied to VDD (Figure 16-4). The potential at the bottom of the ladder is determined by the LCD regulator's voltage reference, tied internally to LCDBIAS0. The bias type is determined by the voltages on the LCDBIAS pins, which are controlled by the

configuration of the resistor ladder. Most applications using M2 will use a 1/3 or 1/2 Bias type. While Static Bias can also be used, it offers extremely limited contrast range and additional current consumption over other bias generation modes.

Like M1, the LCDBIAS bits can be used to control contrast, limited by the level of VDD supplied to the device. Also, since there is no capacitor required across VLCAP1 and VLCAP2, these pins are available as digital I/O ports, RG2 and RG3.

M2 is selected by clearing the CKSEL<1:0> bits and setting the CPEN bit.

FIGURE 16-4: RESISTOR LADDER CONNECTIONS FOR CONFIGURATION M2



Bias Level at Pin	Bias	Bias Type			
Bias Level at Pin	1/2 Bias	1/3 Bias			
LCDBIAS0	(Internal low reference voltage)	(Internal low reference voltage)			
LCDBIAS1	1/2 VBIAS	1/3 VBIAS			
LCDBIAS2	1/2 VBIAS	2/3 VBIAS			
LCDBIAS3	VBIAS (up to AVDD)	VBIAS (up to AVDD)			

Note 1: These values are provided for design guidance only; they should be optimized for the application by the designer based on the actual LCD specifications.

© 2009 Microchip Technology Inc. Preliminary DS39933C-page 185

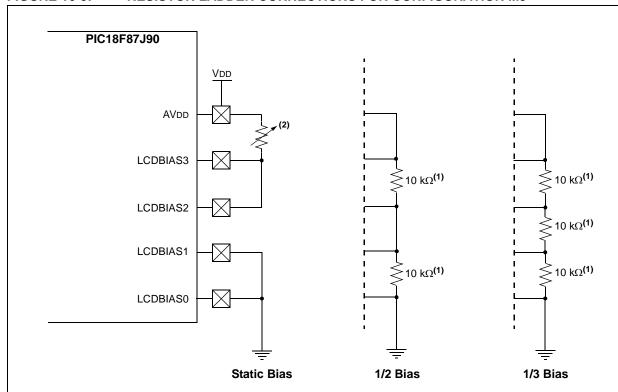
16.3.3.4 M3 (Hardware Contrast)

In M3, the LCD regulator is completely disabled. Like M2, LCD bias levels are tied to AVDD, and are generated using an external divider. The difference is that the internal voltage reference is also disabled and the bottom of the ladder is tied to ground (Vss); see Figure 16-5. The value of the resistors and the difference between Vss and VDD determine the contrast range; no software adjustment is possible. This configuration is also used where the LCD's current requirements exceed the capacity of the charge pump, and software contrast control is not needed.

Depending on the bias type required, resistors are connected between some or all of the pins. A potentiometer can also be connected between LCDBIAS3 and VDD to allow for hardware controlled contrast adjustment.

M3 is selected by clearing the CKSEL<1:0> and CPEN hits

FIGURE 16-5: RESISTOR LADDER CONNECTIONS FOR CONFIGURATION M3



Bias Level at Pin	Bias Type				
Dias Level at Fill	Static	1/2 Bias	1/3 Bias		
LCDBIAS0	AVss	AVss	AVss		
LCDBIAS1	AVss	1/2 AVDD	1/3 AVDD		
LCDBIAS2	AVDD	1/2 AVDD	2/3 AVDD		
LCDBIAS3	AVDD	AVDD	AVDD		

Note 1: These values are provided for design guidance only; they should be optimized for the application by the designer based on the actual LCD specifications.

2: Potentiometer for manual contrast adjustment is optional; it may be omitted entirely.

16.3.4 DESIGN CONSIDERATIONS FOR THE LCD CHARGE PUMP

When designing applications that use the LCD regulator with the charge pump enabled, users must always consider both the dynamic current and RMS (static) current requirements of the display, and what the charge pump can deliver. Both dynamic and static current can be determined by Equation 16-1:

EQUATION 16-1:

$$I = C x \frac{dV}{dT}$$

For dynamic current, C is the value of the capacitors attached to LCDBIAS3 and LCDBIAS2. The variable, dV, is the voltage drop allowed on C2 and C3 during a voltage switch on the LCD display, and dT is the duration of the transient current after a clock pulse occurs. For practical design purposes, these will be assumed to be 0.047 μ F for C, 0.1V for dV and 1 μ s for dT. This yields a dynamic current of 4.7 mA for 1 μ s.

RMS current is determined by the value of CFLY for C, the voltage across VLCAP1 and VLCAP2 for dV and the regulator clock period (TPER) for dT. Assuming CFLY of 0.047 μ F, a value of 1.02V across CFLY and TPER of 30 μ s, the maximum theoretical static current will be 1.8 mA. Since the charge pump must charge five capacitors, the maximum current becomes 360 μ A. For a real-world assumption of 50% efficiency, this yields a practical current of 180 μ A.

Users should compare the calculated current capacity against the requirements of the LCD. While dV and dT are relatively fixed by device design, the values of CFLY and the capacitors on the LCDBIAS pins can be changed to increase or decrease current. As always, any changes should be evaluated in the actual circuit for its impact on the application.

16.4 LCD Multiplex Types

The LCD driver module can be configured into four multiplex types:

- Static (only COM0 used)
- 1/2 Multiplex (COM0 and COM1 are used)
- 1/3 Multiplex (COM0, COM1 and COM2 are used)
- 1/4 Multiplex (all COM0, COM1, COM2 and COM3 are used)

The number of active commons used is configured by the LMUX<1:0> bits (LCDCON<1:0>), which determines the function of the PORTE<6:4> pins (see Table 16-3 for details). If the pin is configured as a COM drive, the port I/O function is disabled and the TRIS setting of that pin is overridden.

Note: On a Power-on Reset, the LMUX<1:0> bits are '00'.

TABLE 16-3: PORTE<6:4> FUNCTION

LMUX1: LMUX0	PORTE<6>	PORTE<5>	PORTE<4>
00	Digital I/O	Digital I/O	Digital I/O
01	Digital I/O	Digital I/O	COM1 Driver
10	Digital I/O	COM2 Driver	COM1 Driver
11	COM3 Driver	COM2 Driver	COM1 Driver

16.5 Segment Enables

The LCDSEx registers are used to select the pin function for each segment pin. Setting a bit configures the corresponding pin to function as a segment driver. LCDSEx registers do not override the TRIS bit settings, so the TRIS bits must be configured as input for that pin.

Note: On a Power-on Reset, these pins are configured as digital I/O.

16.6 Pixel Control

The LCDDATAx registers contain bits which define the state of each pixel. Each bit defines one unique pixel.

Table 16-2 shows the correlation of each bit in the LCDDATAx registers to the respective common and segment signals. Any LCD pixel location not being used for display can be used as general purpose RAM.

16.7 LCD Frame Frequency

The rate at which the COM and SEG outputs change is called the LCD frame frequency. Frame frequency is set by the LP<3:0> bits (LCDPS<3:0>), and is also affected by the Multiplex mode being used. The relationship between the Multiplex mode, LP bits setting and frame rate is shown in Table 16-4 and Table 16-5.

TABLE 16-4: FRAME FREQUENCY FORMULAS

Multiplex Mode	Frame Frequency (Hz)		
Static	Clock source/(4 x 1 x (LP<3:0> + 1))		
1/2	Clock source/(2 x 2 x (LP<3:0> + 1))		
1/3	Clock source/(1 x 3 x (LP<3:0> + 1))		
1/4	Clock source/(1 x 4 x (LP<3:0> + 1))		

TABLE 16-5: APPROXIMATE FRAME FREQUENCY (IN Hz) FOR LP PRESCALER SETTINGS

LP<3:0>	Multiplex Mode						
	Static	1/2	1/3	1/4			
1	125	125	167	125			
2	83	83	111	83			
3	62	62	83	62			
4	50	50	67	50			
5	42	42	56	42			
6	36	36	48	36			
7	31	31	42	31			

16.8 LCD Waveform Generation

LCD waveform generation is based on the principle that the net AC voltage across the dark pixel should be maximized and the net AC voltage across the clear pixel should be minimized. The net DC voltage across any pixel should be zero.

The COM signal represents the time slice for each common, while the SEG contains the pixel data. The pixel signal (COM-SEG) will have no DC component and it can take only one of the two rms values. The higher rms value will create a dark pixel and a lower rms value will create a clear pixel.

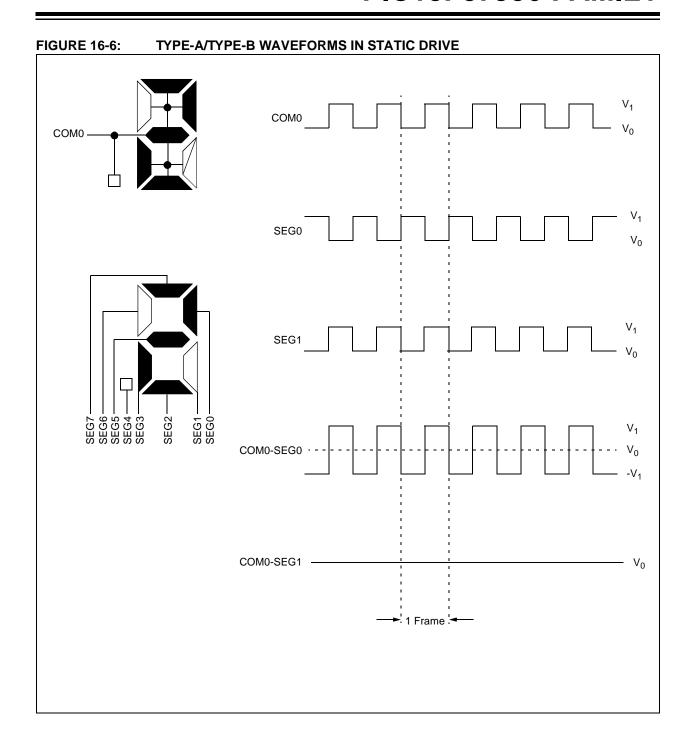
As the number of commons increases, the delta between the two rms values decreases. The delta represents the maximum contrast that the display can have.

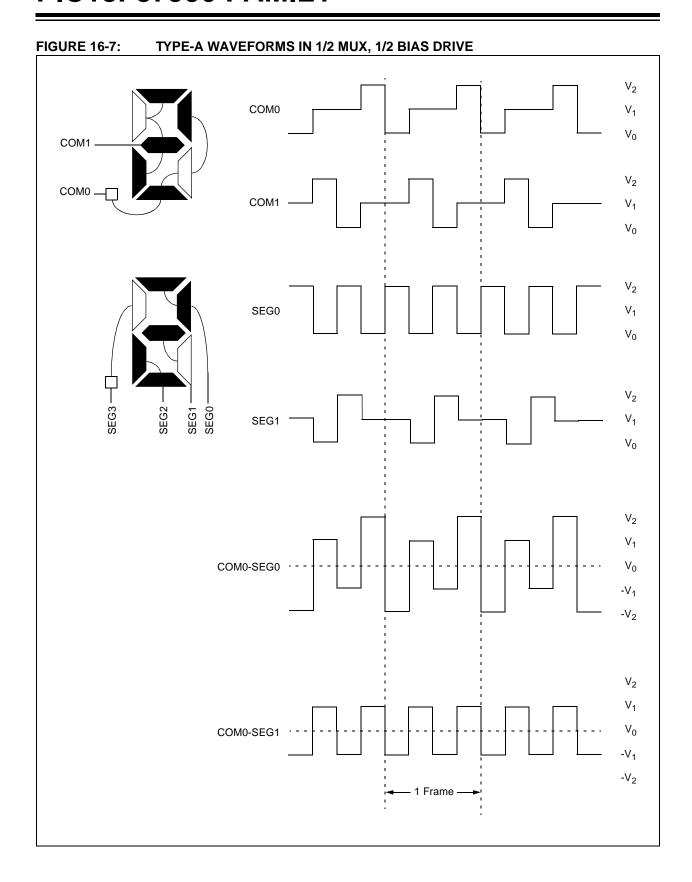
The LCDs can be driven by two types of waveform: Type-A and Type-B. In the Type-A waveform, the phase changes within each common type, whereas in the Type-B waveform, the phase changes on each frame boundary. Thus, the Type-A waveform maintains 0 VDC over a single frame, whereas the Type-B waveform takes two frames.

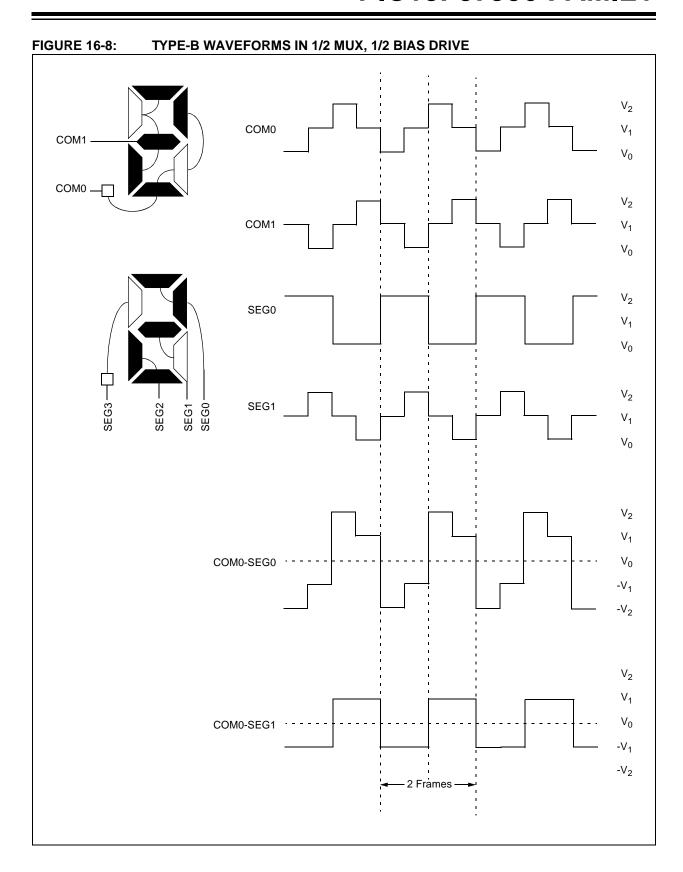
- Note 1: If the power-managed Sleep mode is invoked while the LCD Sleep bit is set (LCDCON<6> is '1'), take care to execute Sleep only when the VDC on all the pixels is '0'.
 - 2: When the LCD clock source is the system clock, the LCD module will go to Sleep if the microcontroller goes into Sleep mode, regardless of the setting of the SPLEN bit. Thus, always take care to see that the VDC on all pixels is '0' whenever Sleep mode is invoked.

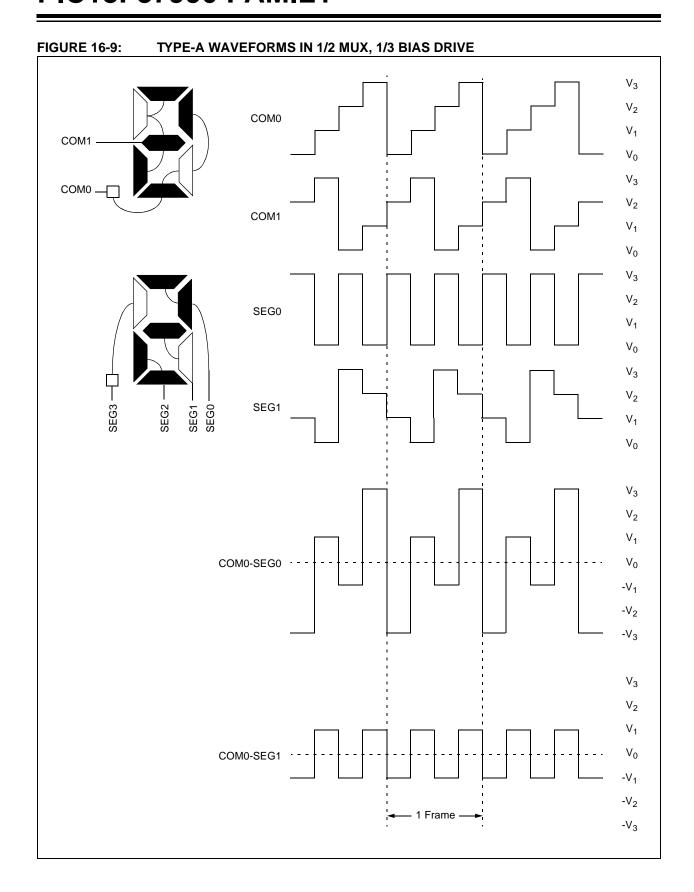
Figure 16-6 through Figure 16-16 provide waveforms for static, half multiplex, one-third multiplex and quarter multiplex drives for Type-A and Type-B waveforms.

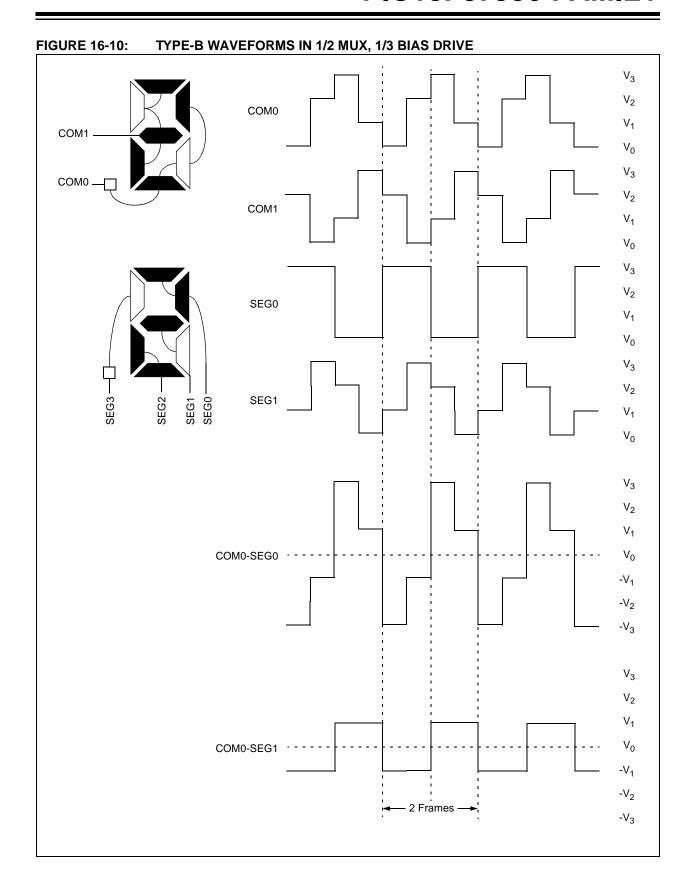
DS39933C-page 189

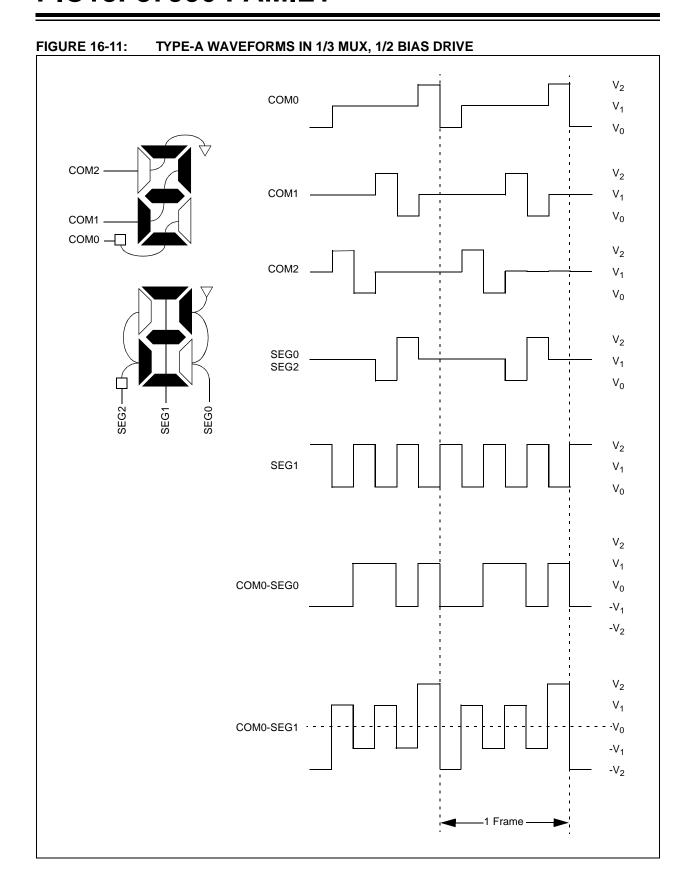


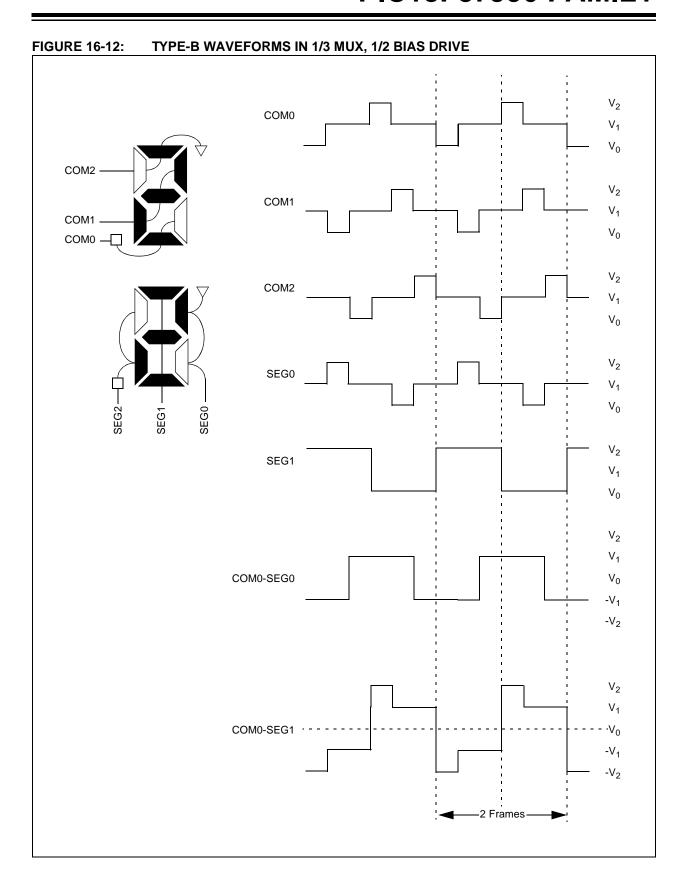


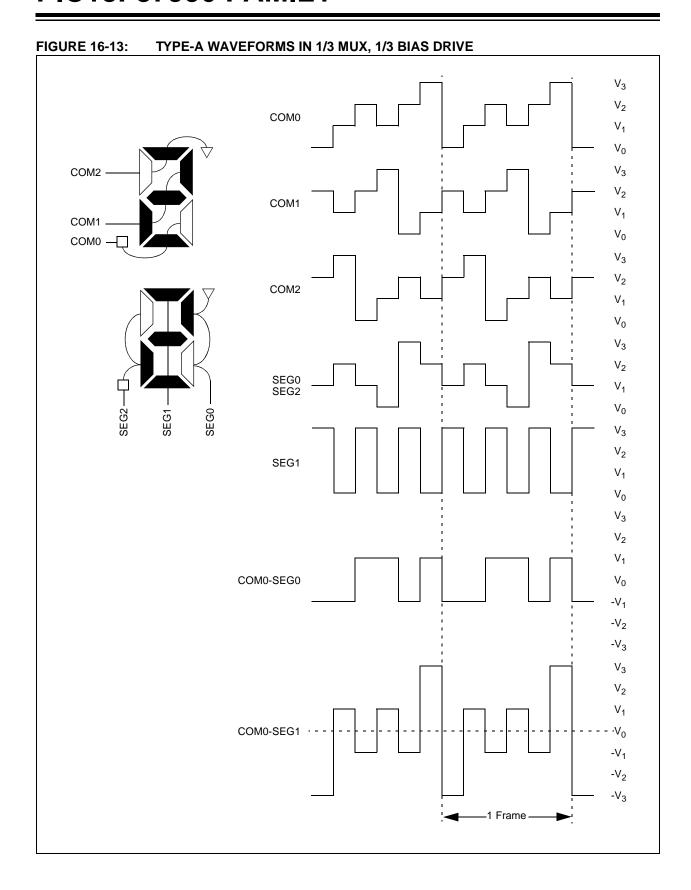


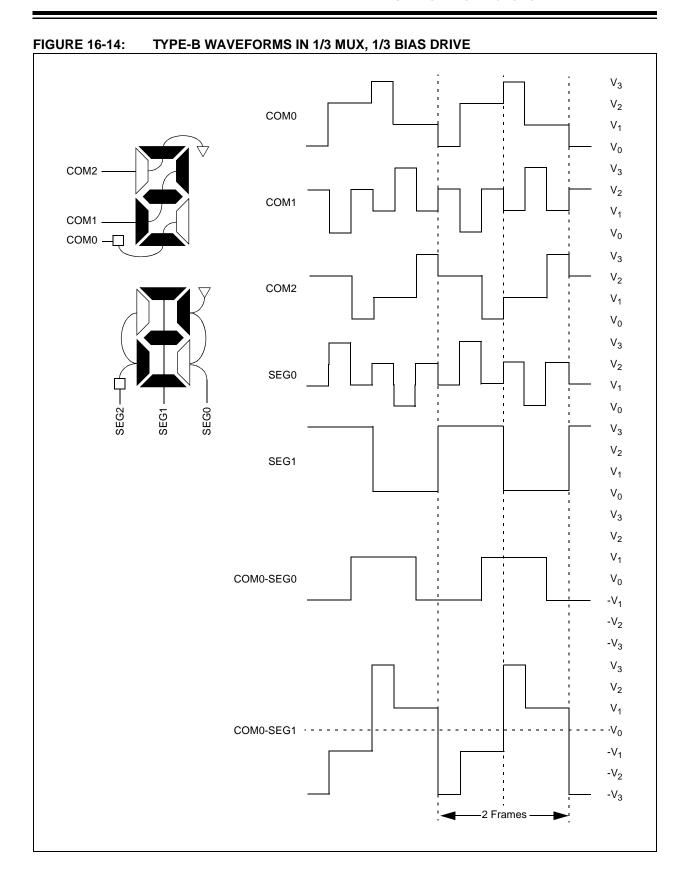


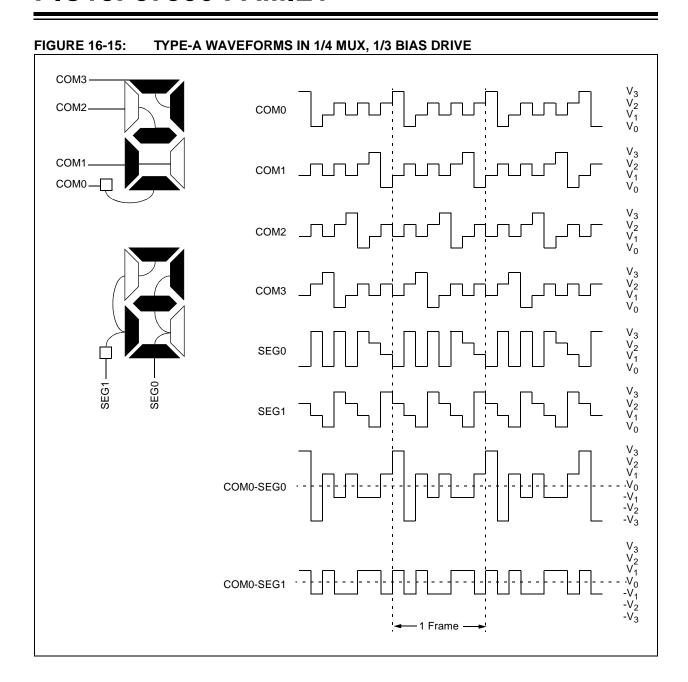




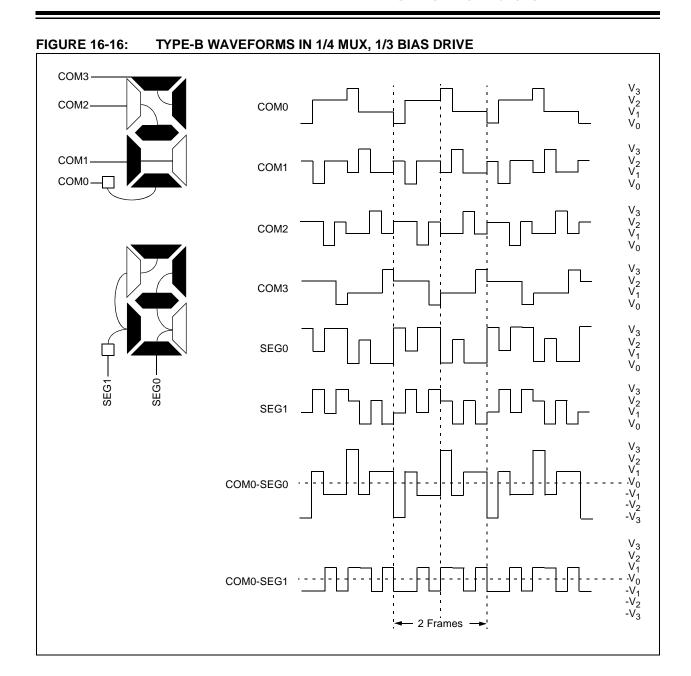








DS39933C-page 199



16.9 LCD Interrupts

The LCD timing generation provides an interrupt that defines the LCD frame timing. This interrupt can be used to coordinate the writing of the pixel data with the start of a new frame. Writing pixel data at the frame boundary allows a visually crisp transition of the image. This interrupt can also be used to synchronize external events to the LCD. For example, the interface to an external segment driver can be synchronized for segment data update to the LCD frame.

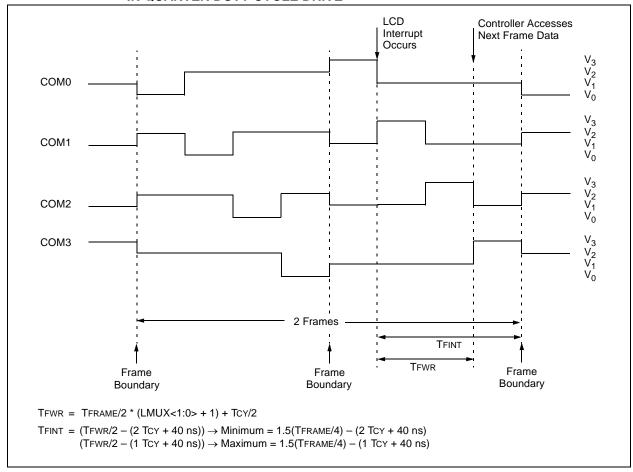
A new frame is defined to begin at the leading edge of the COM0 common signal. The interrupt will be set immediately after the LCD controller completes accessing all pixel data required for a frame. This will occur at a fixed interval before the frame boundary (TFINT), as shown in Figure 16-17. The LCD controller will begin to access data for the next frame within the interval from the interrupt to when the controller begins to access data after the interrupt (TFWR). New data must be written within TFWR, as this is when the LCD controller will begin to access the data for the next frame.

When the LCD driver is running with Type-B waveforms, and the LMUX<1:0> bits are not equal to '00', there are some additional issues that must be addressed. Since the DC voltage on the pixel takes two frames to maintain zero volts, the pixel data must not change between subsequent frames. If the pixel data were allowed to change, the waveform for the odd frames would not necessarily be the complement of the waveform generated in the even frames and a DC component would be introduced into the panel. Therefore, when using Type-B waveforms, the user must synchronize the LCD pixel updates to occur within a subframe after the frame interrupt.

To correctly sequence writing while in Type-B, the interrupt will only occur on complete phase intervals. If the user attempts to write when the write is disabled, the WERR (LCDCON<5>) bit is set.

Note: The interrupt is not generated when the Type-A waveform is selected and when the Type-B with no multiplex (static) is selected.

FIGURE 16-17: EXAMPLE WAVEFORMS AND INTERRUPT TIMING IN QUARTER DUTY CYCLE DRIVE



16.10 Operation During Sleep

The LCD module can operate during Sleep. The selection is controlled by the SLPEN bit (LCDCON<6>). Setting the SLPEN bit allows the LCD module to go to Sleep. Clearing the SLPEN bit allows the module to continue to operate during Sleep.

If a SLEEP instruction is executed and SLPEN = 1, the LCD module will cease all functions and go into a very low-current consumption mode. The module will stop operation immediately and drive the minimum LCD voltage on both segment and common lines. Figure 16-18 shows this operation.

To ensure that no DC component is introduced on the panel, the SLEEP instruction should be executed immediately after a LCD frame boundary. The LCD interrupt can be used to determine the frame boundary. See Section 16.9 "LCD Interrupts" for the formulas to calculate the delay.

If a SLEEP instruction is executed and SLPEN = 0, the module will continue to display the current contents of the LCDDATA registers. To allow the module to continue operation while in Sleep, the clock source must be either the Timer1 oscillator or one of the

internal oscillators (either INTRC or INTOSC as the default system clock). While in Sleep, the LCD data cannot be changed. The LCD module current consumption will not decrease in this mode; however, the overall consumption of the device will be lower due to shut down of the core and other peripheral functions.

If the system clock is selected and the module is not configured for Sleep operation, the module will ignore the SLPEN bit and stop operation immediately. The minimum LCD voltage will then be driven onto the segments and commons

USING THE LCD REGULATOR 16.10.1 **DURING SLEEP**

Applications that use the LCD regulator for bias generation may not achieve the same degree of power reductions in Sleep mode when compared to applications using Mode 3 (resistor ladder) biasing. This is particularly true with Mode 0 operation, where the charge pump is active.

If Modes 0, 1 or 2 are used for bias generation, software contrast control will not be available.

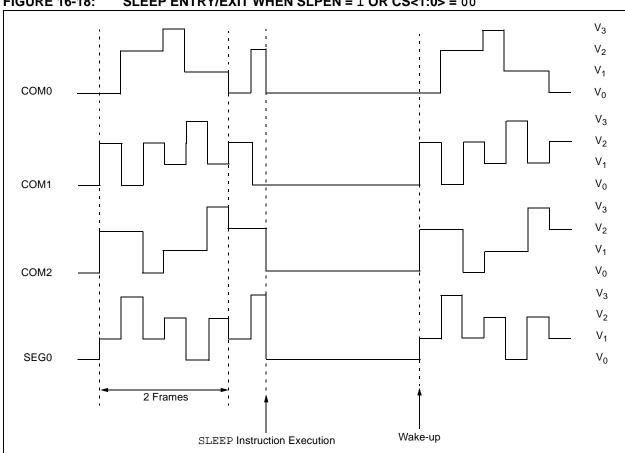


FIGURE 16-18: SLEEP ENTRY/EXIT WHEN SLPEN = 1 OR CS<1:0> = 00

Preliminary © 2009 Microchip Technology Inc. DS39933C-page 201

16.11 Configuring the LCD Module

The following is the sequence of steps to configure the LCD module.

- 1. Select the frame clock prescale using bits, LP<3:0> (LCDPS<3:0>).
- Configure the appropriate pins to function as segment drivers using the LCDSEx registers.
- 3. Configure the appropriate pins as inputs using TRISx registers.
- 4. Configure the LCD module for the following using the LCDCON register:
 - Multiplex and Bias mode (LMUX<1:0>)
 - Timing source (CS<1:0>)
 - Sleep mode (SLPEN)
- 5. Write initial values to pixel data registers, LCDDATA0 through LCDDATA23.

- 6. Configure the LCD regulator:
 - a) If M2 or M3 bias configuration is to be used, turn off the regulator by setting CKSEL<1:0> (LCDREG<1:0>) to '00'. Set or clear the CPEN bit (LCDREG<6>) to select Mode 2 or Mode 3, as appropriate.
 - b) If M0 or M1 bias generation is to be used:
 - Set the VBIAS level using the BIAS<2:0> bits (LCDREG<5:3>).
 - Set or clear the CPEN bit to enable or disable the charge pump.
 - Set or clear the MODE13 bit (LCDREG<2>) to select the Bias mode.
 - Select a regulator clock source using the CKSEL<1:0> bits.
- 7. Clear LCD Interrupt Flag, LCDIF (PIR3<6>), and if desired, enable the interrupt by setting the LCDIE bit (PIE3<6>).
- Enable the LCD module by setting the LCDEN bit (LCDCON<7>).

TABLE 16-6: REGISTERS ASSOCIATED WITH LCD OPERATION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53
PIR3	_	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	56
PIE3	_	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	56
IPR3	_	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	56
RCON	IPEN		CM	RI	TO	PD	POR	BOR	54
LCDDATA23 ⁽¹⁾	S47C3	S46C3	S45C3	S44C3	S43C3	S42C3	S41C3	S40C3	57
LCDDATA22	S39C3 ⁽¹⁾	S38C3 ⁽¹⁾	S37C3 ⁽¹⁾	S36C3 ⁽¹⁾	S35C3 ⁽¹⁾	S34C3 ⁽¹⁾	S33C3 ⁽¹⁾	S32C3	57
LCDDATA21	S31C3	S30C3	S29C3	S28C3	S27C3	S26C3	S25C3	S24C3	57
LCDDATA20	S23C3	S22C3	S21C3	S20C3	S19C3	S18C3	S17C3	S16C3	57
LCDDATA19	S15C3	S14C3	S13C3	S12C3	S11C3	S10C3	S09C3	S08C3	57
LCDDATA18	S07C3	S06C3	S05C3	S04C3	S03C3	S02C3	S01C3	S00C3	57
LCDDATA17 ⁽¹⁾	S47C2	S46C2	S45C2	S44C2	S43C2	S42C2	S41C2	S40C2	57
LCDDATA16	S39C2 ⁽¹⁾	S38C2 ⁽¹⁾	S37C2 ⁽¹⁾	S36C2 ⁽¹⁾	S35C2 ⁽¹⁾	S34C2 ⁽¹⁾	S33C2 ⁽¹⁾	S32C2	57
LCDDATA15	S31C2	S30C2	S29C2	S28C2	S27C2	S26C2	S25C2	S24C2	57
LCDDATA14	S23C2	S22C2	S21C2	S20C2	S19C2	S18C2	S17C2	S16C2	57
LCDDATA13	S15C2	S14C2	S13C2	S12C2	S11C2	S10C2	S09C2	S08C2	57
LCDDATA12	S07C2	S06C2	S05C2	S04C2	S03C2	S02C2	S01C2	S00C2	57
LCDDATA11 ⁽¹⁾	S47C1	S46C1	S45C1	S44C1	S43C1	S42C1	S41C1	S40C1	57
LCDDATA10	S39C1 ⁽¹⁾	S38C1 ⁽¹⁾	S37C1 ⁽¹⁾	S36C1 ⁽¹⁾	S35C1 ⁽¹⁾	S34C1 ⁽¹⁾	S33C1 ⁽¹⁾	S32C1	57
LCDDATA9	S31C1	S30C1	S29C1	S28C1	S27C1	S26C1	S25C1	S24C1	57
LCDDATA8	S23C1	S22C1	S21C1	S20C1	S19C1	S18C1	S17C1	S16C1	57
LCDDATA7	S15C1	S14C1	S13C1	S12C1	S11C1	S10C1	S09C1	S08C1	57
LCDDATA6	S07C1	S06C1	S05C1	S04C1	S03C1	S02C1	S01C1	S00C1	57
LCDDATA5 ⁽¹⁾	S47C0	S46C0	S45C0	S44C0	S43C0	S42C0	S41C0	S40C0	57
LCDDATA4	S39C0 ⁽¹⁾	S38C0 ⁽¹⁾	S37C0 ⁽¹⁾	S36C0 ⁽¹⁾	S35C0 ⁽¹⁾	S34C0 ⁽¹⁾	S33C0 ⁽¹⁾	S32C0	55
LCDDATA3	S31C0	S30C0	S29C0	S28C0	S27C0	S26C0	S25C0	S24C0	55
LCDDATA2	S23C0	S22C0	S21C0	S20C0	S19C0	S18C0	S17C0	S16C0	55
LCDDATA1	S15C0	S14C0	S13C0	S12C0	S11C0	S10C0	S09C0	S08C0	55
LCDDATA0	S07C0	S06C0	S05C0	S04C0	S03C0	S02C0	S01C0	S00C0	55
LCDSE5 ⁽¹⁾	SE47	SE46	SE45	SE44	SE43	SE42	SE41	SE40	55
LCDSE4	SE39 ⁽¹⁾	SE38 ⁽¹⁾	SE37 ⁽¹⁾	SE36 ⁽¹⁾	SE35 ⁽¹⁾	SE34 ⁽¹⁾	SE33 ⁽¹⁾	SE32	55
LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	55
LCDSE2	SE23	SE22	SE21	SE20	SE19	SE18	SE17	SE16	55
LCDSE1	SE15	SE14	SE13	SE12	SE11	SE10	SE09	SE08	55
LCDSE0	SE07	SE06	SE05	SE04	SE03	SE02	SE01	SE00	55
LCDCON	LCDEN	SLPEN	WERR	_	CS1	CS0	LMUX1	LMUX0	55
LCDPS	WFT	BIASMD	LCDA	WA	LP3	LP2	LP1	LP0	55
LCDREG	_	CPEN	BIAS2	BIAS1	BIAS0	MODE13	CKSEL1	CKSEL0	54

Legend: — = unimplemented, read as '0'. Shaded cells are not used for LCD operation.

Note 1: These registers or individual bits are unimplemented on PIC18F6XJ90 devices.

NOTES:

17.0 MASTER SYNCHRONOUS SERIAL PORT (MSSP) MODULE

17.1 Master SSP (MSSP) Module Overview

The Master Synchronous Serial Port (MSSP) module is a serial interface, useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, shift registers, display drivers, A/D converters, etc. The MSSP module can operate in one of two modes:

- Serial Peripheral Interface (SPI)
- Inter-Integrated Circuit (I²C[™])
 - Full Master mode
 - Slave mode (with general address call)

The I²C interface supports the following modes in hardware:

- · Master mode
- · Multi-Master mode
- · Slave mode

17.2 Control Registers

Each MSSP module has three associated control registers. These include a status register (SSPSTAT) and two control registers (SSPCON1 and SSPCON2). The use of these registers and their individual bits differ significantly depending on whether the MSSP module is operated in SPI or I^2C mode.

Additional details are provided under the individual sections.

17.3 SPI Mode

The SPI mode allows 8 bits of data to be synchronously transmitted and received simultaneously. All four modes of SPI are supported. To accomplish communication, typically three pins are used:

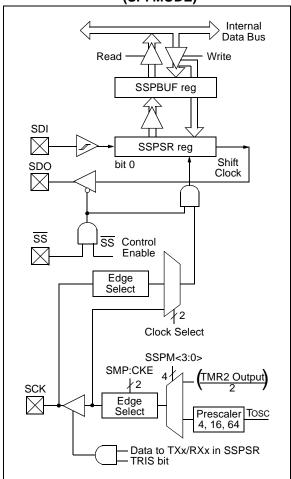
- Serial Data Out (SDO) RC5/SDO/SEG12
- Serial Data In (SDI) RC4/SDI/SDA/SEG16
- Serial Clock (SCK) RC3/SCK/SCL/SEG17

Additionally, a fourth pin may be used when in a Slave mode of operation:

• Slave Select (SS) - RF7/AN5/SS/SEG25

Figure 17-1 shows the block diagram of the MSSP module when operating in SPI mode.

FIGURE 17-1: MSSP BLOCK DIAGRAM (SPI MODE)



17.3.1 REGISTERS

Each MSSP module has four registers for SPI mode operation. These are:

- MSSP Control Register 1 (SSPCON1)
- MSSP Status Register (SSPSTAT)
- Serial Receive/Transmit Buffer Register (SSPBUF)
- MSSP Shift Register (SSPSR) Not directly accessible

SSPCON1 and SSPSTAT are the control and status registers in SPI mode operation. The SSPCON1 register is readable and writable. The lower 6 bits of the SSPSTAT are read-only. The upper two bits of the SSPSTAT are read/write.

SSPSR is the shift register used for shifting data in or out. SSPBUF is the buffer register to which data bytes are written to or read from.

In receive operations, SSPSR and SSPBUF together create a double-buffered receiver. When SSPSR receives a complete byte, it is transferred to SSPBUF and the SSPIF interrupt is set.

During transmission, the SSPBUF is not double-buffered. A write to SSPBUF will write to both SSPBUF and SSPSR.

REGISTER 17-1: SSPSTAT: MSSP STATUS REGISTER (SPI MODE)

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R0	R-0
SMP	CKE ⁽¹⁾	D/ A	Р	S	R/W	UA	BF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **SMP:** Sample bit

SPI Master mode:

1 = Input data sampled at end of data output time

0 = Input data sampled at middle of data output time

SPI Slave mode:

SMP must be cleared when SPI is used in Slave mode.

bit 6 **CKE:** SPI Clock Select bit⁽¹⁾

1 = Transmit occurs on transition from active to Idle clock state

0 = Transmit occurs on transition from Idle to active clock state

bit 5 D/A: Data/Address bit

Used in I^2C^{TM} mode only.

bit 4 **P:** Stop bit

Used in I²C mode only. This bit is cleared when the MSSP module is disabled, SSPEN is cleared.

bit 3 S: Start bit

Used in I²C mode only.

bit 2 R/W: Read/Write Information bit

Used in I²C mode only.

bit 1 UA: Update Address bit

Used in I²C mode only.

bit 0 **BF:** Buffer Full Status bit (Receive mode only)

1 = Receive complete, SSPBUF is full

0 = Receive not complete, SSPBUF is empty

Note 1: Polarity of clock state is set by the CKP bit (SSPCON1<4>).

REGISTER 17-2: SSPCON1: MSSP CONTROL REGISTER 1 (SPI MODE)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WCOL	SSPOV ⁽¹⁾	SSPEN ⁽²⁾	CKP	SSPM3 ⁽³⁾	SSPM2 ⁽³⁾	SSPM1 ⁽³⁾	SSPM0 ⁽³⁾
bit 7							bit 0

 Legend:
 R = Readable bit
 W = Writable bit
 U = Unimplemented bit, read as '0'

 -n = Value at POR
 '1' = Bit is set
 '0' = Bit is cleared
 x = Bit is unknown

bit 7 WCOL: Write Collision Detect bit (Transmit mode only)

1 = The SSPBUF register is written while it is still transmitting the previous word (must be cleared in software)

0 = No collision

bit 6 SSPOV: Receive Overflow Indicator bit⁽¹⁾

SPI Slave mode:

1 = A new byte is received while the SSPBUF register is still holding the previous data. In case of overflow, the data in SSPSR is lost. Overflow can only occur in Slave mode. The user must read the SSPBUF, even if only transmitting data, to avoid setting overflow (must be cleared in software).

0 = No overflow

bit 5 SSPEN: Master Synchronous Serial Port Enable bit (2)

1 = Enables serial port and configures SCK, SDO, SDI and \overline{SS} as serial port pins

0 = Disables serial port and configures these pins as I/O port pins

bit 4 CKP: Clock Polarity Select bit

1 = Idle state for clock is a high level

0 = Idle state for clock is a low level

bit 3-0 SSPM<3:0>: Master Synchronous Serial Port Mode Select bits⁽³⁾

0101 = SPI Slave mode, clock = SCK pin, SS pin control disabled, SS can be used as I/O pin

0100 = SPI Slave mode, clock = SCK pin, SS pin control enabled

0011 = SPI Master mode, clock = TMR2 output/2

0010 = SPI Master mode, clock = Fosc/64

0001 = SPI Master mode, clock = Fosc/16

0000 = SPI Master mode, clock = Fosc/4

Note 1: In Master mode, the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSPBUF register.

2: When enabled, these pins must be properly configured as input or output.

3: Bit combinations not specifically listed here are either reserved or implemented in I²C™ mode only.

17.3.2 OPERATION

When initializing the SPI, several options need to be specified. This is done by programming the appropriate control bits (SSPCON1<5:0> and SSPSTAT<7:6>). These control bits allow the following to be specified:

- Master mode (SCK is the clock output)
- Slave mode (SCK is the clock input)
- Clock Polarity (Idle state of SCK)
- Data Input Sample Phase (middle or end of data output time)
- Clock Edge (output data on rising/falling edge of SCK)
- · Clock Rate (Master mode only)
- Slave Select mode (Slave mode only)

Each MSSP consists of a transmit/receive shift register (SSPSR) and a buffer register (SSPBUF). The SSPSR shifts the data in and out of the device, MSb first. The SSPBUF holds the data that was written to the SSPSR until the received data is ready. Once the 8 bits of data have been received, that byte is moved to the SSPBUF register. Then, the Buffer Full detect bit, BF (SSPSTAT<0>), and the interrupt flag bit, SSPIF, are set. This double-buffering of the received data (SSPBUF) allows the next byte to start reception before

reading the data that was just received. Any write to the SSPBUF register during transmission/reception of data will be ignored and the Write Collision detect bit, WCOL (SSPCON1<7>), will be set. User software must clear the WCOL bit so that it can be determined if the following write(s) to the SSPBUF register completed successfully.

When the application software is expecting to receive valid data, the SSPBUF should be read before the next byte of data to transfer is written to the SSPBUF. The Buffer Full bit, BF (SSPSTAT<0>), indicates when SSPBUF has been loaded with the received data (transmission is complete). When the SSPBUF is read, the BF bit is cleared. This data may be irrelevant if the SPI is only a transmitter. Generally, the MSSP interrupt is used to determine when the transmission/reception has completed. The SSPBUF must be read and/or written. If the interrupt method is not going to be used, then software polling can be done to ensure that a write collision does not occur. Example 17-1 shows the loading of the SSPBUF (SSPSR) for data transmission.

The SSPSR is not directly readable or writable and can only be accessed by addressing the SSPBUF register. Additionally, the SSPSTAT register indicates the various status conditions.

EXAMPLE 17-1: LOADING THE SSPBUF (SSPSR) REGISTER

LOOP	BTFSS BRA	SSPSTAT, BF LOOP	;Has data been received (transmit complete)? ;No
	MOVF	SSPBUF, W	;WREG reg = contents of SSPBUF
	MOVWF	RXDATA	;Save in user RAM, if data is meaningful
	MOVF MOVWF	TXDATA, W SSPBUF	;W reg = contents of TXDATA ;New data to xmit

17.3.3 ENABLING SPI I/O

To enable the serial port, MSSP Enable bit, SSPEN (SSPCON1<5>), must be set. To reset or reconfigure SPI mode, clear the SSPEN bit, reinitialize the SSPCON registers and then set the SSPEN bit. This configures the SDI, SDO, SCK and SS pins as serial port pins. For the pins to behave as the serial port function, some must have their data direction bits (in the TRIS register) appropriately programmed as follows:

- SDI is automatically controlled by the SPI module
- SDO must have TRISC<5> bit cleared
- SCK (Master mode) must have TRISC<3> bit cleared
- SCK (Slave mode) must have TRISC<3> bit set
- SS must have TRISF<7> bit set

Any serial port function that is not desired may be overridden by programming the corresponding data direction (TRIS) register to the opposite value.

17.3.4 OPEN-DRAIN OUTPUT OPTION

The drivers for the SDO output and SCK clock pins can be optionally configured as open-drain outputs. This feature allows the voltage level on the pin to be pulled to a higher level through an external pull-up resistor, and allows the output to communicate with external circuits without the need for additional level shifters.

The open-drain output option is controlled by the SPIOD bit (TRISG<7>). Setting the bit configures both pins for open-drain operation.

17.3.5 TYPICAL CONNECTION

Figure 17-2 shows a typical connection between two microcontrollers. The master controller (Processor 1) initiates the data transfer by sending the SCK signal. Data is shifted out of both shift registers on their programmed clock edge and latched on the opposite edge of the clock. Both processors should be programmed to the same Clock Polarity (CKP), then both controllers would send and receive data at the same time. Whether the data is meaningful (or dummy data) depends on the application software. This leads to three scenarios for data transmission:

- Master sends data Slave sends dummy data
- Master sends data Slave sends data
- Master sends dummy data Slave sends data

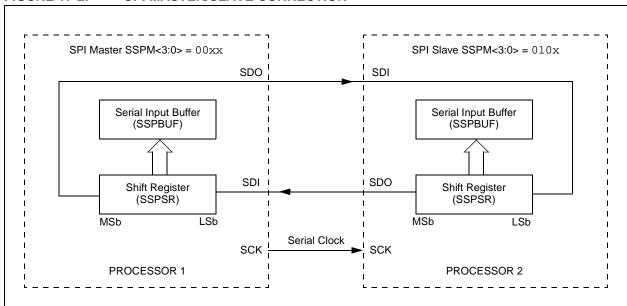


FIGURE 17-2: SPI MASTER/SLAVE CONNECTION

© 2009 Microchip Technology Inc. Preliminary DS39933C-page 209

17.3.6 MASTER MODE

The master can initiate the data transfer at any time because it controls the SCK. The master determines when the slave (Processor 2, Figure 17-2) will broadcast data by the software protocol.

In Master mode, the data is transmitted/received as soon as the SSPBUF register is written to. If the SPI is only going to receive, the SDO output could be disabled (programmed as an input). The SSPSR register will continue to shift in the signal present on the SDI pin at the programmed clock rate. As each byte is received, it will be loaded into the SSPBUF register as if a normal received byte (interrupts and status bits appropriately set). This could be useful in receiver applications as a "Line Activity Monitor" mode.

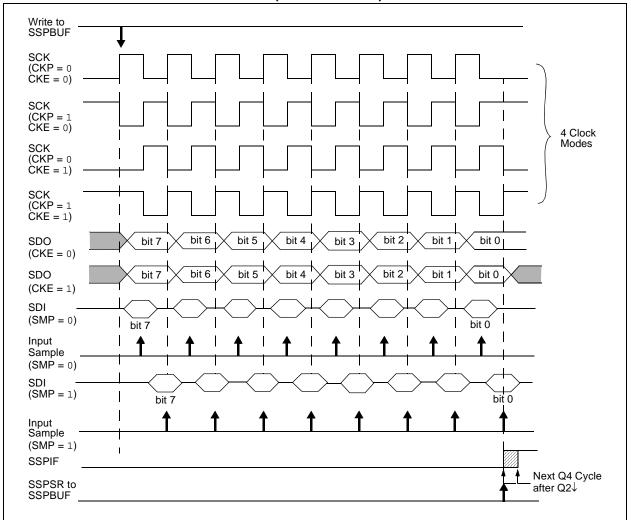
The clock polarity is selected by appropriately programming the CKP bit (SSPCON1<4>). This, then, would give waveforms for SPI communication as shown in Figure 17-3, Figure 17-5 and Figure 17-6, where the MSB is transmitted first. In Master mode, the SPI clock rate (bit rate) is user-programmable to be one of the following:

- Fosc/4 (or Tcy)
- Fosc/16 (or 4 Tcy)
- Fosc/64 (or 16 Tcy)
- Timer2 output/2

This allows a maximum data rate (at 40 MHz) of 10.00 Mbps.

Figure 17-3 shows the waveforms for Master mode. When the CKE bit is set, the SDO data is valid before there is a clock edge on SCK. The change of the input sample is shown based on the state of the SMP bit. The time when the SSPBUF is loaded with the received data is shown.

FIGURE 17-3: SPI MODE WAVEFORM (MASTER MODE)



17.3.7 SLAVE MODE

In Slave mode, the data is transmitted and received as the external clock pulses appear on SCK. When the last bit is latched, the SSPIF interrupt flag bit is set.

Before enabling the module in SPI Slave mode, the clock line must match the proper Idle state. The clock line can be observed by reading the SCK pin. The Idle state is determined by the CKP bit (SSPCON1<4>).

While in Slave mode, the external clock is supplied by the external clock source on the SCK pin. This external clock must meet the minimum high and low times as specified in the electrical specifications.

While in Sleep mode, the slave can transmit/receive data. When a byte is received, the device will wake-up from Sleep.

17.3.8 SLAVE SELECT SYNCHRONIZATION

The \overline{SS} pin allows a Synchronous Slave mode. The SPI must be in Slave mode with \overline{SS} pin control enabled (SSPCON1<3:0> = 04h). When the \overline{SS} pin is low, transmission and reception are enabled and the SDO pin is

driven. When the \overline{SS} pin goes high, the SDO pin is no longer driven, even if in the middle of a transmitted byte and becomes a floating output. External pull-up/pull-down resistors may be desirable depending on the application.

- Note 1: When the SPI is in Slave mode with \overline{SS} pin control enabled (SSPCON1<3:0> = 0100), the SPI module will reset if the \overline{SS} pin is set to VDD.
 - 2: If the SPI is used in Slave mode with CKE set, then the SS pin control must be enabled.

When the SPI module resets, the bit counter is forced to '0'. This can be done by either forcing the \overline{SS} pin to a high level or clearing the SSPEN bit.

To emulate two-wire communication, the SDO pin can be connected to the SDI pin. When the SPI needs to operate as a receiver, the SDO pin can be configured as an input. This disables transmissions from the SDO. The SDI can always be left as an input (SDI function) since it cannot create a bus conflict.



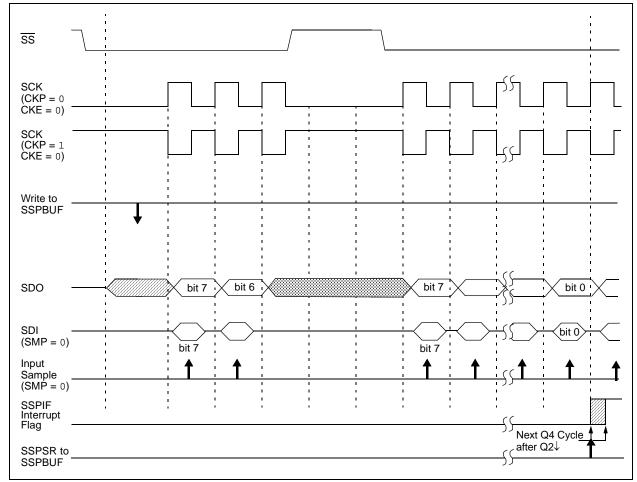


FIGURE 17-5: SPI MODE WAVEFORM (SLAVE MODE WITH CKE = 0)

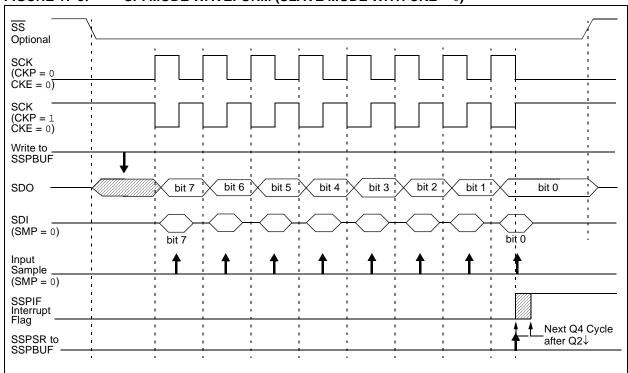
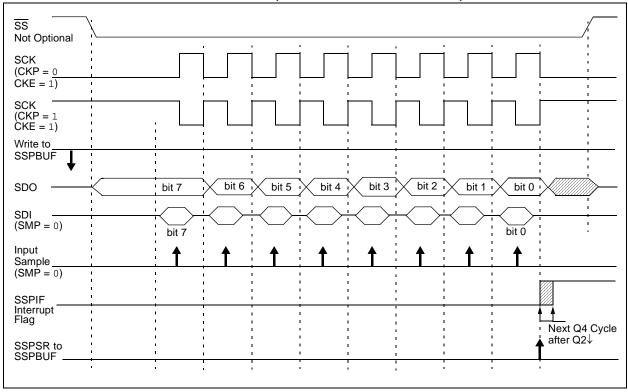


FIGURE 17-6: SPI MODE WAVEFORM (SLAVE MODE WITH CKE = 1)



17.3.9 OPERATION IN POWER-MANAGED MODES

In SPI Master mode, module clocks may be operating at a different speed than when in Full Power mode; in the case of Sleep mode, all clocks are halted.

In Idle modes, a clock is provided to the peripherals. That clock should be from the primary clock source, the secondary clock (Timer1 oscillator at 32.768 kHz) or the INTRC source. See **Section 2.3** "Clock Sources and Oscillator Switching" for additional information.

In most cases, the speed that the master clocks SPI data is not important; however, this should be evaluated for each system.

If MSSP interrupts are enabled, they can wake the controller from Sleep mode, or one of the Idle modes, when the master completes sending data. If an exit from Sleep or Idle mode is not desired, MSSP interrupts should be disabled.

If the Sleep mode is selected, all module clocks are halted and the transmission/reception will remain in that state until the devices wakes. After the device returns to Run mode, the module will resume transmitting and receiving data.

In SPI Slave mode, the SPI Transmit/Receive Shift register operates asynchronously to the device. This allows the device to be placed in any power-managed

mode and data to be shifted into the SPI Transmit/Receive Shift register. When all 8 bits have been received, the MSSP interrupt flag bit will be set, and if enabled, will wake the device.

17.3.10 EFFECTS OF A RESET

A Reset disables the MSSP module and terminates the current transfer.

17.3.11 BUS MODE COMPATIBILITY

Table 17-1 shows the compatibility between the standard SPI modes and the states of the CKP and CKE control bits.

TABLE 17-1: SPI BUS MODES

Standard SPI Mode	Control Bits State			
Terminology	CKP	CKE		
0, 0	0	1		
0, 1	0	0		
1, 0	1	1		
1, 1	1	0		

There is also an SMP bit which controls when the data is sampled.

TABLE 17-2: REGISTERS ASSOCIATED WITH SPI OPERATION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53
PIR1	_	ADIF	RC1IF	TX1IF	SSPIF	_	TMR2IF	TMR1IF	56
PIE1	_	ADIE	RC1IE	TX1IE	SSPIE	_	TMR2IE	TMR1IE	56
IPR1	_	ADIP	RC1IP	TX1IP	SSPIP	_	TMR2IP	TMR1IP	56
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	56
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	_	56
TRISG	SPIOD	CCP2OD	CCP10D	TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	56
SSPBUF	MSSP Receive Buffer/Transmit Register								
SSPCON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	54
SSPSTAT	SMP	CKE	D/\overline{A}	Р	S	R/W	UA	BF	54

Legend: Shaded cells are not used by the MSSP module in SPI mode.

17.4 I²C Mode

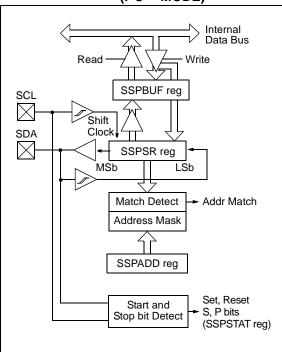
The MSSP module in I²C mode fully implements all master and slave functions (including general call support) and provides interrupts on Start and Stop bits in hardware to determine a free bus (multi-master function). The MSSP module implements the standard mode specifications as well as 7-bit and 10-bit addressing.

Two pins are used for data transfer:

- Serial clock (SCL) RC3/SCK/SCL
- Serial data (SDA) RC4/SDI/SDA

The user must configure these pins as inputs by setting the TRISC<4:3> bits.

FIGURE 17-7: MSSP BLOCK DIAGRAM (I²C™ MODE)



17.4.1 REGISTERS

The MSSP module has six registers for I²C operation. These are:

- MSSP Control Register 1 (SSPCON1)
- MSSP Control Register 2 (SSPCON2)
- MSSP Status Register (SSPSTAT)
- Serial Receive/Transmit Buffer Register (SSPBUF)
- MSSP Shift Register (SSPSR) Not directly accessible
- MSSP Address Register (SSPADD)

SSPCON1, SSPCON2 and SSPSTAT are the control and status registers in I^2C mode operation. The SSPCON1 and SSPCON2 registers are readable and writable. The lower 6 bits of the SSPSTAT are read-only. The upper two bits of the SSPSTAT are read/write.

Many of the bits in SSPCON2 assume different functions, depending on whether the module is operating in Master or Slave mode; bits <5:2> also assume different names in Slave mode. The different aspects of SSPCON2 are shown in Register 17-5 (for Master mode) and Register 17-6 (Slave mode).

SSPSR is the shift register used for shifting data in or out. SSPBUF is the buffer register to which data bytes are written to or read from.

SSPADD register holds the slave device address when the MSSP is configured in I^2C Slave mode. When the MSSP is configured in Master mode, the lower seven bits of SSPADD act as the Baud Rate Generator reload value.

In receive operations, SSPSR and SSPBUF together create a double-buffered receiver. When SSPSR receives a complete byte, it is transferred to SSPBUF and the SSPIF interrupt is set.

During transmission, the SSPBUF is not double-buffered. A write to SSPBUF will write to both SSPBUF and SSPSR.

REGISTER 17-3: SSPSTAT: MSSP STATUS REGISTER (I²C™ MODE)

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0
SMP	CKE	D/\overline{A}	P ⁽¹⁾	S ⁽¹⁾	R/W	UA	BF
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 SMP: Slew Rate Control bit

In Master or Slave mode:

1 = Slew rate control disabled for Standard Speed mode (100 kHz and 1 MHz)

0 = Slew rate control enabled for High-Speed mode (400 kHz)

bit 6 CKE: SMBus Select bit

In Master or Slave mode:

1 = Enable SMBus specific inputs0 = Disable SMBus specific inputs

bit 5 D/A: Data/Address bit

In Master mode:

Reserved.

In Slave mode:

1 = Indicates that the last byte received or transmitted was data

0 = Indicates that the last byte received or transmitted was address

bit 4 **P:** Stop bit⁽¹⁾

1 = Indicates that a Stop bit has been detected last

0 = Stop bit was not detected last

bit 3 S: Start bit⁽¹⁾

1 = Indicates that a Start bit has been detected last

0 = Start bit was not detected last

bit 2 R/\overline{W} : Read/ \overline{W} rite Information bit (I^2C^{TM} mode only)

In Slave mode: (2)

1 = Read

0 = Write

In Master mode: (3)

1 = Transmit is in progress

0 = Transmit is not in progress

bit 1 UA: Update Address bit (10-Bit Slave mode only)

1 = Indicates that the user needs to update the address in the SSPADD register

0 = Address does not need to be updated

bit 0 **BF:** Buffer Full Status bit

In Transmit mode:

1 = SSPBUF is full

0 = SSPBUF is empty

In Receive mode:

1 = SSPBUF is full (does not include the \overline{ACK} and Stop bits)

0 = SSPBUF is empty (does not include the \overline{ACK} and Stop bits)

Note 1: This bit is cleared on Reset and when SSPEN is cleared.

2: This bit holds the R/W bit information following the last address match. This bit is only valid from the address match to the next Start bit, Stop bit or not ACK bit.

3: ORing this bit with SEN, RSEN, PEN, RCEN or ACKEN will indicate if the MSSP is in Active mode.

REGISTER 17-4: SSPCON1: MSSP CONTROL REGISTER 1 (I²C™ MODE)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WCOL	SSPOV	SSPEN ⁽¹⁾	CKP	SSPM3	SSPM2	SSPM1	SSPM0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 WCOL: Write Collision Detect bit

In Master Transmit mode:

- 1 = A write to the SSPBUF register was attempted while the I^2C^{TM} conditions were not valid for a transmission to be started (must be cleared in software)
- 0 = No collision

In Slave Transmit mode:

- 1 = The SSPBUF register is written while it is still transmitting the previous word (must be cleared in software)
- 0 = No collision

In Receive mode (Master or Slave modes):

This is a "don't care" bit.

bit 6 SSPOV: Receive Overflow Indicator bit

In Receive mode:

- 1 = A byte is received while the SSPBUF register is still holding the previous byte (must be cleared in software)
- 0 = No overflow

In Transmit mode:

This is a "don't care" bit in Transmit mode.

bit 5 SSPEN: Master Synchronous Serial Port Enable bit (1)

- 1 = Enables the serial port and configures the SDA and SCL pins as the serial port pins
- 0 = Disables serial port and configures these pins as I/O port pins

bit 4 CKP: SCK Release Control bit

In Slave mode:

- 1 = Release clock
- 0 = Holds clock low (clock stretch), used to ensure data setup time

In Master mode:

Unused in this mode.

bit 3-0 SSPM<3:0>: Synchronous Serial Port Mode Select bits

- 1111 = I²C Slave mode, 10-bit address with Start and Stop bit interrupts enabled
- $1110 = I^2C$ Slave mode, 7-bit address with Start and Stop bit interrupts enabled
- 1011 = I²C Firmware Controlled Master mode (slave Idle)
- 1000 = I²C Master mode, clock = Fosc/(4 * (SSPADD + 1))
- $0111 = I^2C$ Slave mode, 10-bit address
- $0110 = I^2C$ Slave mode, 7-bit address

Bit combinations not specifically listed here are either reserved or implemented in SPI mode only.

Note 1: When enabled, the SDA and SCL pins must be configured as inputs.

REGISTER 17-5: SSPCON2: MSSP CONTROL REGISTER 2 (I²C™ MASTER MODE)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
GCEN	ACKSTAT	ACKDT ⁽¹⁾	ACKEN ⁽²⁾	RCEN ⁽²⁾	PEN ⁽²⁾	RSEN ⁽²⁾	SEN ⁽²⁾
bit 7							bit 0

 Legend:
 R = Readable bit
 W = Writable bit
 U = Unimplemented bit, read as '0'

 -n = Value at POR
 '1' = Bit is set
 '0' = Bit is cleared
 x = Bit is unknown

bit 7 GCEN: General Call Enable bit

Unused in Master mode.

bit 6 ACKSTAT: Acknowledge Status bit (Master Transmit mode only)

1 = Acknowledge was not received from slave0 = Acknowledge was received from slave

bit 5 ACKDT: Acknowledge Data bit (Master Receive mode only)⁽¹⁾

1 = Not Acknowledge0 = Acknowledge

bit 4 ACKEN: Acknowledge Sequence Enable bit (2)

1 = Initiate Acknowledge sequence on SDA and SCL pins and transmit ACKDT data bit. Automatically cleared by hardware.

0 = Acknowledge sequence Idle

bit 3 RCEN: Receive Enable bit (Master Receive mode only)(2)

1 = Enables Receive mode for I^2C^{TM}

0 = Receive Idle

bit 2 **PEN:** Stop Condition Enable bit⁽²⁾

1 = Initiate Stop condition on SDA and SCL pins. Automatically cleared by hardware.

0 = Stop condition Idle

bit 1 RSEN: Repeated Start Condition Enable bit⁽²⁾

1 = Initiate Repeated Start condition on SDA and SCL pins. Automatically cleared by hardware.

0 = Repeated Start condition Idle

bit 0 SEN: Start Condition Enable bit (2)

1 = Initiate Start condition on SDA and SCL pins. Automatically cleared by hardware.

0 = Start condition Idle

Note 1: Value that will be transmitted when the user initiates an Acknowledge sequence at the end of a receive.

2: If the I²C module is active, these bits may not be set (no spooling) and the SSPBUF may not be written (or writes to the SSPBUF are disabled).

REGISTER 17-6: SSPCON2: MSSP CONTROL REGISTER 2 (I²C™ SLAVE MODE)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
GCEN	ACKSTAT	ADMSK5	ADMSK4	ADMSK3	ADMSK2	ADMSK1	SEN ⁽¹⁾
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 GCEN: General Call Enable bit

1 = Enable interrupt when a general call address (0000h) is received in the SSPSR

0 = General call address disabled

bit 6 ACKSTAT: Acknowledge Status bit

Unused in Slave mode.

bit 5-2 ADMSK<5:2>: Slave Address Mask Select bits

 ${\tt 1 = Masking\ of\ corresponding\ bits\ of\ SSPADD\ enabled}$

0 = Masking of corresponding bits of SSPADD disabled

bit 1 ADMSK1: Slave Address Least Significant bit(s) Mask Select bit

In 7-Bit Addressing mode:

1 = Masking of SSPADD<1> only enabled

0 = Masking of SSPADD<1> only disabled

In 10-Bit Addressing mode:

1 = Masking of SSPADD<1:0> enabled

0 = Masking of SSPADD<1:0> disabled

bit 0 SEN: Stretch Enable bit⁽¹⁾

1 = Clock stretching is enabled for both slave transmit and slave receive (stretch enabled)

0 = Clock stretching is disabled

Note 1: If the I²C[™] module is active, this bit may not be set (no spooling) and the SSPBUF may not be written (or writes to the SSPBUF are disabled).

17.4.2 OPERATION

The MSSP module functions are enabled by setting the MSSP Enable bit, SSPEN (SSPCON1<5>).

The SSPCON1 register allows control of the I²C operation. Four mode selection bits (SSPCON1<3:0>) allow one of the following I²C modes to be selected:

- I²C Master mode, clock = (FOSC/4) x (SSPADD + 1)
- I²C Slave mode (7-bit address)
- I²C Slave mode (10-bit address)
- I²C Slave mode (7-bit address) with Start and Stop bit interrupts enabled
- I²C Slave mode (10-bit address) with Start and Stop bit interrupts enabled
- I²C Firmware Controlled Master mode, slave is Idle

Selection of any I²C mode, with the SSPEN bit set, forces the SCL and SDA pins to be open-drain, provided these pins are programmed to inputs by setting the appropriate TRISC or TRISD bits. To ensure proper operation of the module, pull-up resistors must be provided externally to the SCL and SDA pins.

17.4.3 SLAVE MODE

In Slave mode, the SCL and SDA pins must be configured as inputs (TRISC<4:3> set). The MSSP module will override the input state with the output data when required (slave-transmitter).

The I²C Slave mode hardware will always generate an interrupt on an exact address match. In addition, address masking will also allow the hardware to generate an interrupt for more than one address (up to 31 in 7-bit addressing and up to 63 in 10-bit addressing). Through the mode select bits, the user can also choose to interrupt on Start and Stop bits.

When an address is matched, or the data transfer after an address match is received, the hardware automatically will generate the Acknowledge (\overline{ACK}) pulse and load the SSPBUF register with the received value currently in the SSPSR register.

Any combination of the following conditions will cause the MSSP module not to give this $\overline{\text{ACK}}$ pulse:

- The Buffer Full bit, BF (SSPSTAT<0>), was set before the transfer was received.
- The overflow bit, SSPOV (SSPCON1<6>), was set before the transfer was received.

In this case, the SSPSR register value is not loaded into the SSPBUF, but bit SSPIF is set. The BF bit is cleared by reading the SSPBUF register, while bit SSPOV is cleared through software.

The SCL clock input must have a minimum high and low for proper operation. The high and low times of the I^2C specification, as well as the requirement of the MSSP module, are shown in timing parameter 100 and parameter 101.

17.4.3.1 Addressing

Once the MSSP module has been enabled, it waits for a Start condition to occur. Following the Start condition, the 8 bits are shifted into the SSPSR register. All incoming bits are sampled with the rising edge of the clock (SCL) line. The value of register SSPSR<7:1> is compared to the value of the SSPADD register. The address is compared on the falling edge of the eighth clock (SCL) pulse. If the addresses match and the BF and SSPOV bits are clear, the following events occur:

- The SSPSR register value is loaded into the SSPBUF register.
- 2. The Buffer Full bit, BF, is set.
- An ACK pulse is generated.
- The MSSP Interrupt Flag bit, SSPIF, is set (and interrupt is generated, if enabled) on the falling edge of the ninth SCL pulse.

In 10-Bit Addressing mode, two address bytes need to be received by the slave. The five Most Significant bits (MSbs) of the first address byte specify if this is a 10-bit address. Bit R/\overline{W} (SSPSTAT<2>) must specify a write so the slave device will receive the second address byte. For a 10-bit address, the first byte would equal '11110 A9 A8 0', where 'A9' and 'A8' are the two MSbs of the address. The sequence of events for 10-bit addressing is as follows, with steps 7 through 9 for the slave-transmitter:

- 1. Receive first (high) byte of address (bits SSPIF, BF and UA (SSPSTAT<1>) are set).
- Update the SSPADD register with second (low) byte of address (clears bit UA and releases the SCL line).
- Read the SSPBUF register (clears bit BF) and clear flag bit, SSPIF.
- Receive second (low) byte of address (SSPIF, BF and UA bits are set).
- Update the SSPADD register with the first (high) byte of address. If match releases SCL line, this will clear UA bit.
- Read the SSPBUF register (clears bit BF) and clear flag bit, SSPIF.
- 7. Receive Repeated Start condition.
- Receive first (high) byte of address (SSPIF and BF bits are set).
- Read the SSPBUF register (clears BF bit) and clear flag bit, SSPIF.

17.4.3.2 Address Masking

Masking an address bit causes that bit to become a "don't care". When one address bit is masked, two addresses will be Acknowledged and cause an interrupt. It is possible to mask more than one address bit at a time, which makes it possible to Acknowledge up to 31 addresses in 7-bit mode and up to 63 addresses in 10-bit mode (see Example 17-2).

The I²C Slave behaves the same way whether address masking is used or not. However, when address masking is used, the I²C slave can Acknowledge multiple addresses and cause interrupts. When this occurs, it is necessary to determine which address caused the interrupt by checking SSPBUF.

In 7-Bit Addressing mode, address mask bits, ADMSK<5:1> (SSPCON<5:1>), mask the corresponding address bits in the SSPADD register. For any ADMSK bits that are set (ADMSK<n> = 1), the corresponding address bit is ignored (SSPADD<n> = x). For the module to issue an address Acknowledge, it is sufficient to match only on addresses that do not have an active address mask.

In 10-Bit Addressing mode, ADMSK<5:2> bits mask the corresponding address bits in the SSPADD register. In addition, ADMSK1 simultaneously masks the two LSbs of the address (SSPADD<1:0>). For any ADMSK bits that are active (ADMSK<n> = 1), the corresponding address bit is ignored (SSPADD<n> = x). Also note that although in 10-Bit Addressing mode, the upper address bits reuse part of the SSPADD register bits, the address mask bits do not interact with those bits. They only affect the lower address bits.

- **Note 1:** ADMSK1 masks the two Least Significant bits of the address.
 - **2:** The two Most Significant bits of the address are not affected by address masking.

EXAMPLE 17-2: ADDRESS MASKING EXAMPLES

7-Bit Addressing:

SSPADD<7:1> = A0h (1010000) (SSPADD<0> is assumed to be '0')

ADMSK<5:1> = 00111

Addresses Acknowledged: A0h, A2h, A4h, A6h, A8h, AAh, ACh, AEh

10-Bit Addressing:

SSPADD<7:0> = A0h (10100000) (the two MSbs of the address are ignored in this example, since they are not affected by masking)

ADMSK<5:1> = 00111

Addresses Acknowledged: A0h, A1h, A2h, A3h, A4h, A5h, A6h, A7h, A8h, A9h, AAh, ABh, ACh, ADh, AEh, AFh

17.4.3.3 Reception

When the R/\overline{W} bit of the address byte is clear and an address match occurs, the R/\overline{W} bit of the SSPSTAT register is cleared. The received address is loaded into the SSPBUF register and the SDA line is held low (\overline{ACK}).

When the address byte overflow condition exists, then the no Acknowledge (ACK) pulse is given. An overflow condition is defined as either bit, BF (SSPSTAT<0>), is set or bit, SSPOV (SSPCON1<6>), is set.

An MSSP interrupt is generated for each data transfer byte. The interrupt flag bit, SSPIF, must be cleared in software. The SSPSTAT register is used to determine the status of the byte.

If SEN is enabled (SSPCON2<0> = 1), SCK/SCL will be held low (clock stretch) following each data transfer. The clock must be released by setting bit, CKP (SSPCON1<4>). See **Section 17.4.4** "Clock **Stretching**" for more details.

17.4.3.4 Transmission

When the R/W bit of the incoming address byte is set and an address match occurs, the R/W bit of the SSPSTAT register is set. The received address is loaded into the SSPBUF register. The ACK pulse will be sent on the ninth bit and pin RC3 is held low, regardless of SEN (see **Section 17.4.4 "Clock Stretching"** for more details). By stretching the clock, the master will be unable to assert another clock pulse until the slave is done preparing the transmit data. The transmit data must be loaded into the SSPBUF register which also loads the SSPSR register. Then, pin RC3 should be enabled by setting bit, CKP (SSPCON1<4>). The eight data bits are shifted out on the falling edge of the SCL input. This ensures that the SDA signal is valid during the SCL high time (Figure 17-10).

The ACK pulse from the master-receiver is latched on the rising edge of the ninth SCL input pulse. If the SDA line is high (not ACK), then the data transfer is complete. In this case, when the ACK is latched by the slave, the slave logic is reset (resets SSPSTAT register) and the slave monitors for another occurrence of the Start bit. If the SDA line was low (ACK), the next transmit data must be loaded into the SSPBUF register. Again, pin RC3 must be enabled by setting bit, CKP.

An MSSP interrupt is generated for each data transfer byte. The SSPIF bit must be cleared in software and the SSPSTAT register is used to determine the status of the byte. The SSPIF bit is set on the falling edge of the ninth clock pulse.

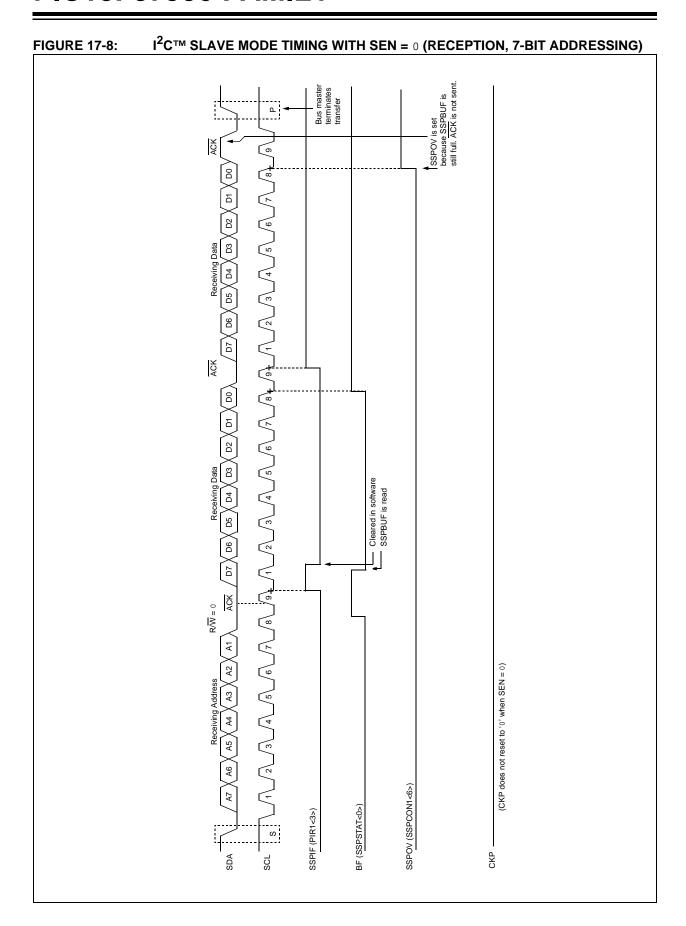
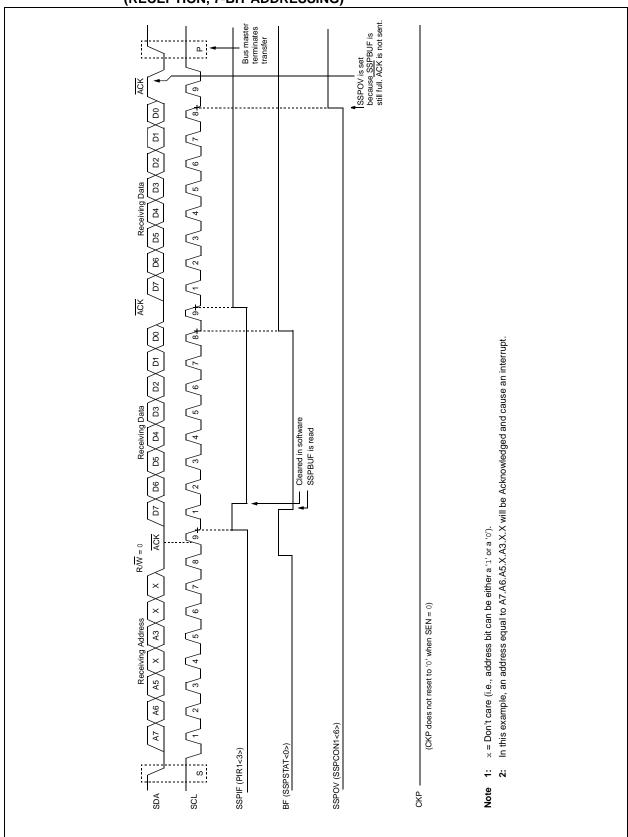
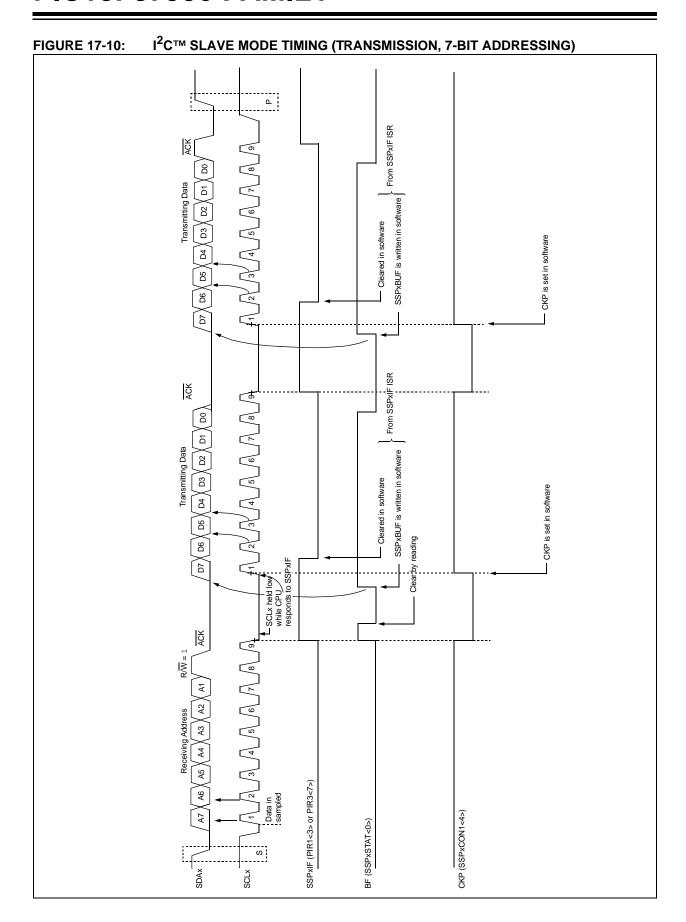


FIGURE 17-9: I^2C^{TM} SLAVE MODE TIMING WITH SEN = 0 AND ADMSK<5:1> = 01011 (RECEPTION, 7-BIT ADDRESSING)





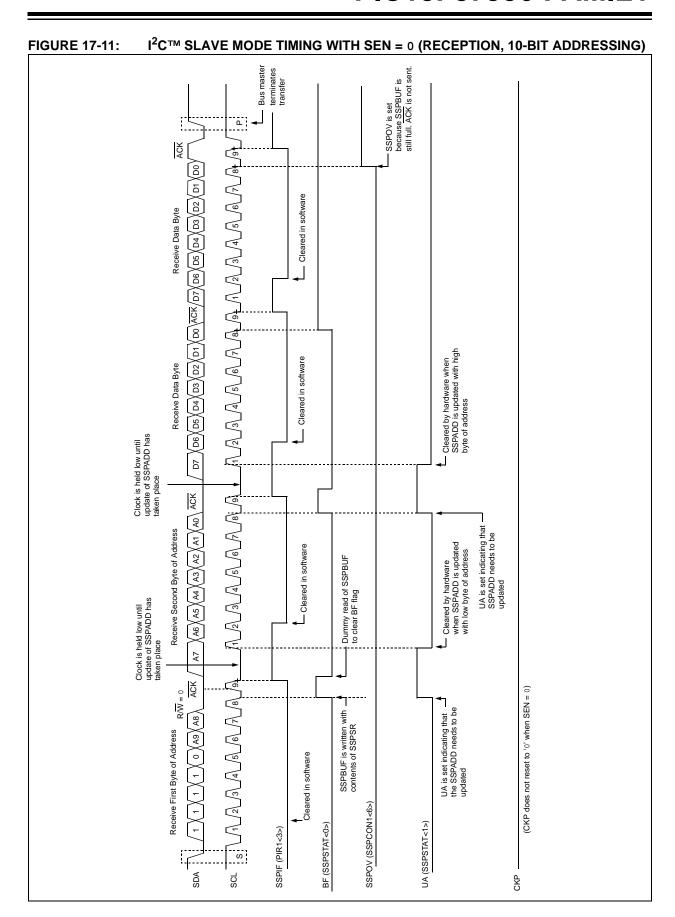
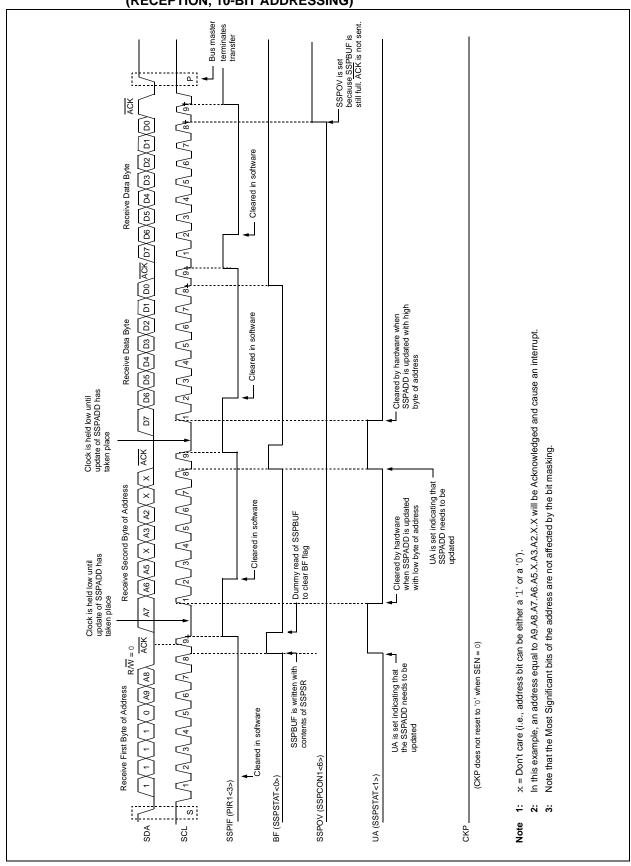
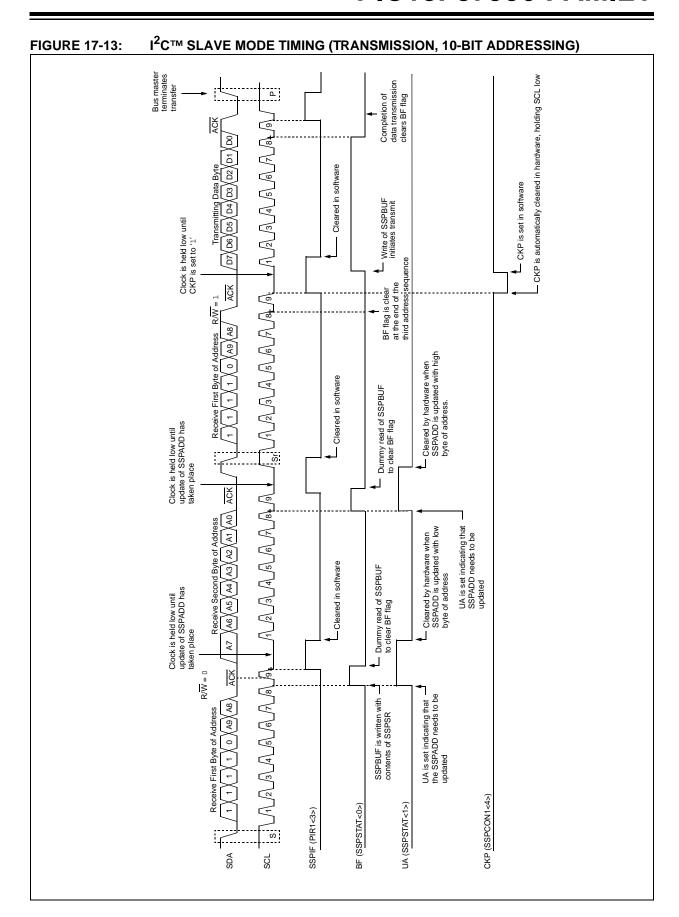


FIGURE 17-12: I^2C^{TM} SLAVE MODE TIMING WITH SEN = 0 AND ADMSK<5:1> = 01001 (RECEPTION, 10-BIT ADDRESSING)





17.4.4 CLOCK STRETCHING

Both 7-Bit and 10-Bit Slave modes implement automatic clock stretching during a transmit sequence.

The SEN bit (SSPCON2<0>) allows clock stretching to be enabled during receives. Setting SEN will cause the SCL pin to be held low at the end of each data receive sequence.

17.4.4.1 Clock Stretching for 7-Bit Slave Receive Mode (SEN = 1)

In 7-Bit Slave Receive mode, on the falling edge of the ninth clock at the end of the ACK sequence, if the BF bit is set, the CKP bit in the SSPCON1 register is automatically cleared, forcing the SCL output to be held low. The CKP being cleared to '0' will assert the SCL line low. The CKP bit must be set in the user's ISR before reception is allowed to continue. By holding the SCL line low, the user has time to service the ISR and read the contents of the SSPBUF before the master device can initiate another receive sequence. This will prevent buffer overruns from occurring (see Figure 17-15).

- Note 1: If the user reads the contents of the SSPBUF before the falling edge of the ninth clock, thus clearing the BF bit, the CKP bit will not be cleared and clock stretching will not occur.
 - 2: The CKP bit can be set in software regardless of the state of the BF bit. The user should be careful to clear the BF bit in the ISR before the next receive sequence in order to prevent an overflow condition.

17.4.4.2 Clock Stretching for 10-Bit Slave Receive Mode (SEN = 1)

In 10-Bit Slave Receive mode, during the address sequence, clock stretching automatically takes place but CKP is not cleared. During this time, if the UA bit is set after the ninth clock, clock stretching is initiated. The UA bit is set after receiving the upper byte of the 10-bit address and following the receive of the second byte of the 10-bit address with the R/W bit cleared to '0'. The release of the clock line occurs upon updating SSPADD. Clock stretching will occur on each data receive sequence as described in 7-bit mode.

Note: If the user polls the UA bit and clears it by updating the SSPADD register before the falling edge of the ninth clock occurs and if the user hasn't cleared the BF bit by reading the SSPBUF register before that time, then the CKP bit will still NOT be asserted low. Clock stretching on the basis of the state of the BF bit only occurs during a

data sequence, not an address sequence.

17.4.4.3 Clock Stretching for 7-Bit Slave Transmit Mode

The 7-Bit Slave Transmit mode implements clock stretching by clearing the CKP bit after the falling edge of the ninth clock if the BF bit is clear. This occurs regardless of the state of the SEN bit.

The user's ISR must set the CKP bit before transmission is allowed to continue. By holding the SCL line low, the user has time to service the ISR and load the contents of the SSPBUF before the master device can initiate another transmit sequence (see Figure 17-10).

- Note 1: If the user loads the contents of SSPBUF, setting the BF bit before the falling edge of the ninth clock, the CKP bit will not be cleared and clock stretching will not occur.
 - **2:** The CKP bit can be set in software regardless of the state of the BF bit.

17.4.4.4 Clock Stretching for 10-Bit Slave Transmit Mode

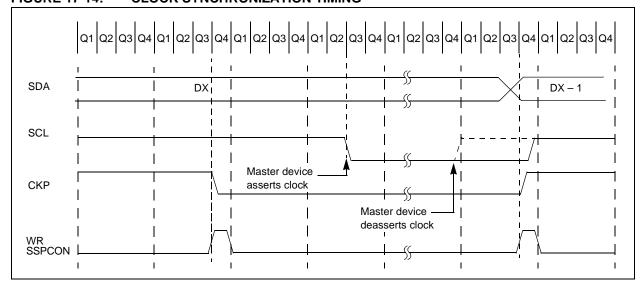
In 10-Bit Slave Transmit mode, clock stretching is controlled during the first two address sequences by the state of the UA bit, just as it is in 10-Bit Slave Receive mode. The first two addresses are followed by a third address sequence which contains the high-order bits of the 10-bit address and the R/W bit set to '1'. After the third address sequence is performed, the UA bit is not set, the module is now configured in Transmit mode and clock stretching is controlled by the BF flag as in 7-Bit Slave Transmit mode (see Figure 17-13).

17.4.4.5 Clock Synchronization and the CKP bit

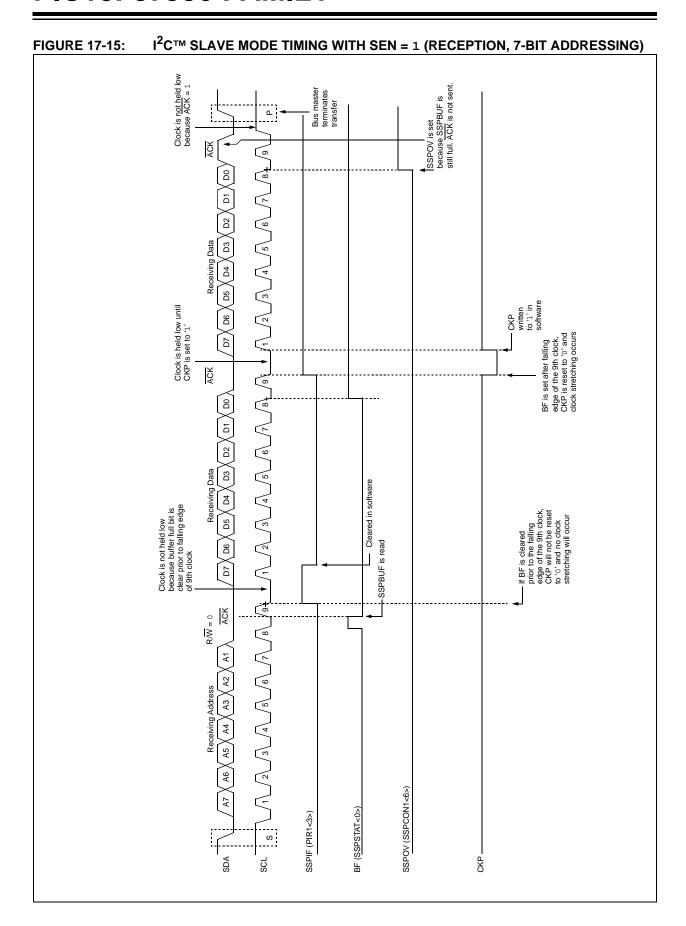
When the CKP bit is cleared, the SCL output is forced to '0'. However, clearing the CKP bit will not assert the SCL output low until the SCL output is already sampled low. Therefore, the CKP bit will not assert the SCL line until an external I²C master device has

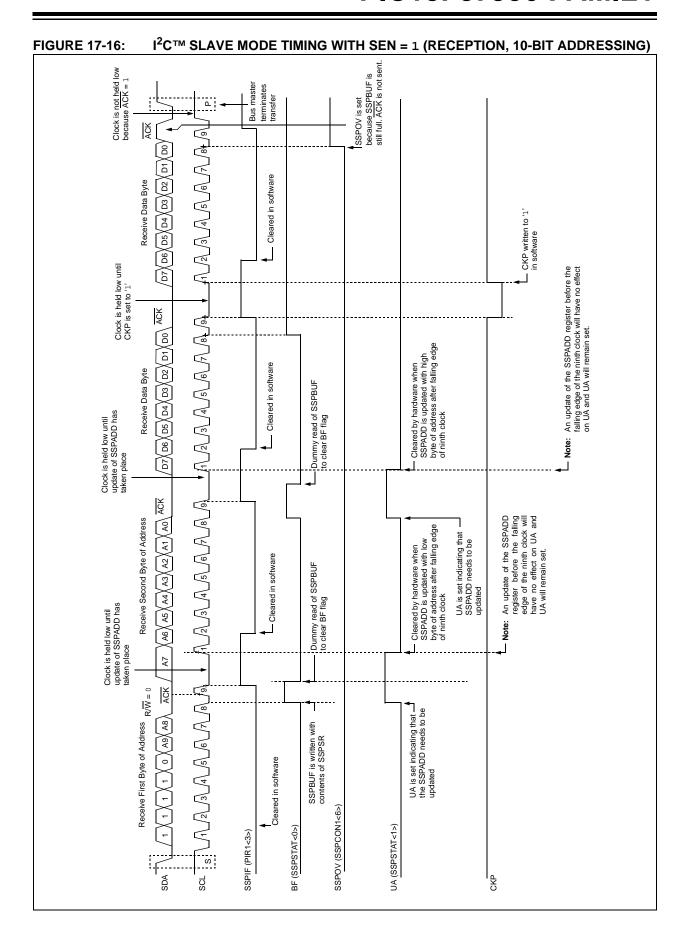
already asserted the SCL line. The SCL output will remain low until the CKP bit is set and all other devices on the I²C bus have deasserted SCL. This ensures that a write to the CKP bit will not violate the minimum high time requirement for SCL (see Figure 17-14).

FIGURE 17-14: CLOCK SYNCHRONIZATION TIMING



© 2009 Microchip Technology Inc. Preliminary DS39933C-page 229





17.4.5 GENERAL CALL ADDRESS SUPPORT

The addressing procedure for the I²C bus is such that the first byte after the Start condition usually determines which device will be the slave addressed by the master. The exception is the general call address which can address all devices. When this address is used, all devices should, in theory, respond with an Acknowledge.

The general call address is one of eight addresses reserved for specific purposes by the I^2C protocol. It consists of all '0's with R/W = 0.

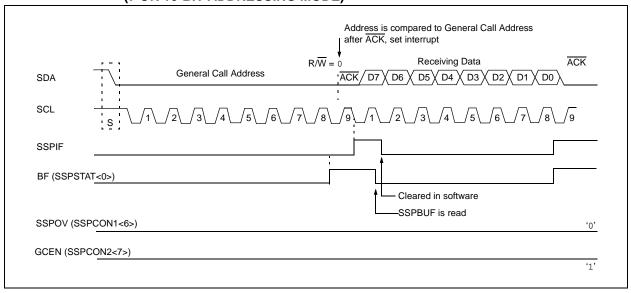
The general call address is recognized when the General Call Enable bit, GCEN, is enabled (SSPCON2<7> set). Following a Start bit detect, 8 bits are shifted into the SSPSR and the address is compared against the SSPADD. It is also compared to the general call address and fixed in hardware.

If the general call address matches, the SSPSR is transferred to the SSPBUF, the BF flag bit is set (eighth bit) and on the falling edge of the ninth bit (ACK bit), the SSPIF interrupt flag bit is set.

When the interrupt is serviced, the source for the interrupt can be checked by reading the contents of the SSPBUF. The value can be used to determine if the address was device specific or a general call address.

In 10-bit mode, the SSPADD is required to be updated for the second half of the address to match and the UA bit is set (SSPSTAT<1>). If the general call address is sampled when the GCEN bit is set, while the slave is configured in 10-Bit Addressing mode, then the second half of the address is not necessary, the UA bit will not be set and the slave will begin receiving data after the Acknowledge (Figure 17-17).

FIGURE 17-17: SLAVE MODE GENERAL CALL ADDRESS SEQUENCE (7 OR 10-BIT ADDRESSING MODE)



17.4.6 MASTER MODE

Master mode is enabled by setting and clearing the appropriate SSPM bits in SSPCON1 and by setting the SSPEN bit. In Master mode, the SCL and SDA lines are manipulated by the MSSP hardware.

Master mode of operation is supported by interrupt generation on the detection of the Start and Stop conditions. The Stop (P) and Start (S) bits are cleared from a Reset or when the MSSP module is disabled. Control of the I²C bus may be taken when the P bit is set, or the bus is Idle, with both the S and P bits clear.

In Firmware Controlled Master mode, user code conducts all ${\rm I}^2{\rm C}$ bus operations based on Start and Stop bit conditions.

Once Master mode is enabled, the user has six options.

- 1. Assert a Start condition on SDA and SCL.
- Assert a Repeated Start condition on SDA and SCL.
- Write to the SSPBUF register initiating transmission of data/address.
- 4. Configure the I²C port to receive data.
- Generate an Acknowledge condition at the end of a received byte of data.
- 6. Generate a Stop condition on SDA and SCL.

The MSSP module, when configured in I²C Master mode, does not allow queueing of events. For instance, the user is not allowed to initiate a Start condition and immediately write the SSPBUF register to initiate transmission before the Start condition is complete. In this case, the SSPBUF will not be written to and the WCOL bit will be set, indicating that a write to the SSPBUF did not occur.

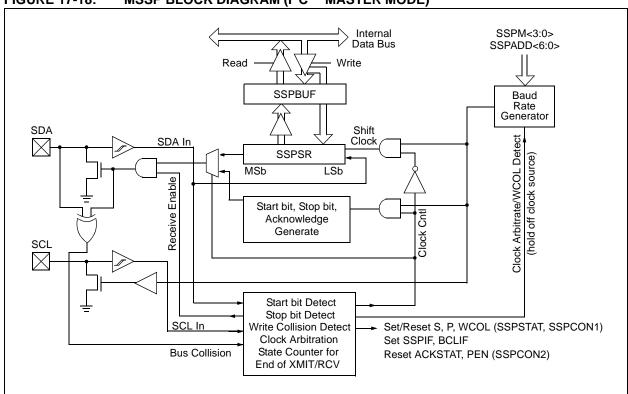
The following events will cause the MSSP Interrupt Flag bit, SSPIF, to be set (and MSSP interrupt, if enabled):

· Start condition

Note:

- · Stop condition
- · Data transfer byte transmitted/received
- · Acknowledge transmit
- Repeated Start

FIGURE 17-18: MSSP BLOCK DIAGRAM (I²C™ MASTER MODE)



17.4.6.1 I²C Master Mode Operation

The master device generates all of the serial clock pulses and the Start and Stop conditions. A transfer is ended with a Stop condition or with a Repeated Start condition. Since the Repeated Start condition is also the beginning of the next serial transfer, the I²C bus will not be released.

In Master Transmitter mode, serial data is output through SDA, while SCL outputs the serial clock. The first byte transmitted contains the slave <u>address</u> of the receiving device (7 bits) and the Read/Write (R/W) bit. In this case, the R/W bit will be logic '0'. Serial data is transmitted 8 bits at a time. After each byte is transmitted, an Acknowledge bit is received. Start and Stop conditions are output to indicate the beginning and the end of a serial transfer.

In Master Receive mode, the first byte transmitted contains the slave address of the transmitting device (7 bits) and the R/W bit. In this case, the R/W bit will be logic '1'. Thus, the first byte transmitted is a 7-bit slave address followed by a '1' to indicate the receive bit. Serial data is received via SDA, while SCL outputs the serial clock. Serial data is received 8 bits at a time. After each byte is received, an Acknowledge bit is transmitted. Start and Stop conditions indicate the beginning and end of transmission.

The Baud Rate Generator used for the SPI mode operation is used to set the SCL clock frequency for either 100 kHz, 400 kHz or 1 MHz I²C operation. See **Section 17.4.7 "Baud Rate"** for more detail.

A typical transmit sequence would go as follows:

- 1. The user generates a Start condition by setting the Start Enable bit, SEN (SSPCON2<0>).
- SSPIF is set. The MSSP module will wait the required start time before any other operation takes place.
- The user loads the SSPBUF with the slave address to transmit.
- Address is shifted out the SDA pin until all 8 bits are transmitted.
- 5. The MSSP module shifts in the ACK bit from the slave device and writes its value into the SSPCON2 register (SSPCON2<6>).
- The MSSP module generates an interrupt at the end of the ninth clock cycle by setting the SSPIF bit.
- The user loads the SSPBUF with eight bits of data.
- Data is shifted out the SDA pin until all 8 bits are transmitted.
- The MSSP module shifts in the ACK bit from the slave device and writes its value into the SSPCON2 register (SSPCON2<6>).
- The MSSP module generates an interrupt at the end of the ninth clock cycle by setting the SSPIF bit.
- 11. The user generates a Stop condition by setting the Stop Enable bit, PEN (SSPCON2<2>).
- Interrupt is generated once the Stop condition is complete.

17.4.7 BAUD RATE

In I²C Master mode, the Baud Rate Generator (BRG) reload value is placed in the lower 7 bits of the SSPADD register (Figure 17-19). When a write occurs to SSPBUF, the Baud Rate Generator will automatically begin counting. The BRG counts down to 0 and stops until another reload has taken place. The BRG count is decremented twice per instruction cycle (TcY) on the Q2 and Q4 clocks. In I²C Master mode, the BRG is reloaded automatically.

Once the given operation is complete (i.e., transmission of the last data bit is followed by \overline{ACK}), the internal clock will automatically stop counting and the SCL pin will remain in its last state.

Table 17-3 demonstrates clock rates based on instruction cycles and the BRG value loaded into SSPADD.

17.4.7.1 Baud Rate Generation in Power-Managed Modes

When the device is operating in one of the power-managed modes, the clock source to the BRG may change frequency or even stop, depending on the mode and clock source selected. Switching to a Run or Idle mode from either the secondary clock or internal oscillator is likely to change the clock rate to the BRG. In Sleep mode, the BRG will not be clocked at all.

FIGURE 17-19: BAUD RATE GENERATOR BLOCK DIAGRAM

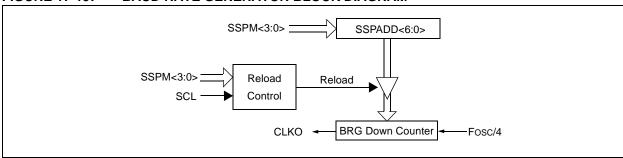


TABLE 17-3: I²C™ CLOCK RATE w/BRG

Fcy * 2	BRG Value	FSCL (2 Rollovers of BRG)
20 MHz	18h	400 kHz ⁽¹⁾
20 MHz	1Fh	312.5 kHz
20 MHz	63h	100 kHz
8 MHz	09h	400 kHz ⁽¹⁾
8 MHz	0Ch	308 kHz
8 MHz	27h	100 kHz
2 MHz	02h	333 kHz ⁽¹⁾
2 MHz	09h	100 kHz
2 MHz	00h	1 MHz ⁽¹⁾
	20 MHz 20 MHz 20 MHz 8 MHz 8 MHz 8 MHz 2 MHz 2 MHz	20 MHz 18h 20 MHz 1Fh 20 MHz 63h 8 MHz 09h 8 MHz 0Ch 8 MHz 27h 2 MHz 02h 2 MHz 09h

Note 1: The I²C[™] interface does not conform to the 400 kHz I²C specification (which applies to rates greater than 100 kHz) in all details, but may be used with care where higher rates are required by the application.

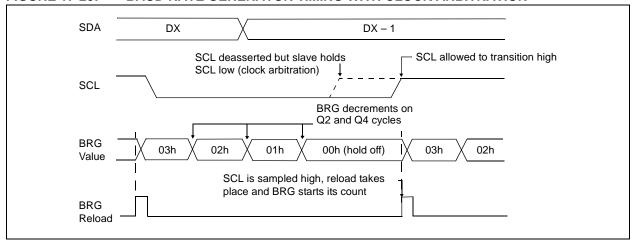
© 2009 Microchip Technology Inc. Preliminary DS39933C-page 235

17.4.7.2 Clock Arbitration

Clock arbitration occurs when the master, during any receive, transmit or Repeated Start/Stop condition, deasserts the SCL pin (SCL allowed to float high). When the SCL pin is allowed to float high, the Baud Rate Generator (BRG) is suspended from counting until the SCL pin is actually sampled high. When the

SCL pin is sampled high, the Baud Rate Generator is reloaded with the contents of SSPADD<6:0> and begins counting. This ensures that the SCL high time will always be at least one BRG rollover count in the event that the clock is held low by an external device (Figure 17-20).

FIGURE 17-20: BAUD RATE GENERATOR TIMING WITH CLOCK ARBITRATION



17.4.8 I²C MASTER MODE START CONDITION TIMING

To initiate a Start condition, the user sets the Start Enable bit, SEN (SSPCON2<0>). If the SDA and SCL pins are sampled high, the Baud Rate Generator is reloaded with the contents of SSPADD<6:0> and starts its count. If SCL and SDA are both sampled high when the Baud Rate Generator times out (TBRG), the SDA pin is driven low. The action of the SDA being driven low while SCL is high is the Start condition and causes the S bit (SSPSTAT<3>) to be set. Following this, the Baud Rate Generator is reloaded with the contents of SSPADD<6:0> and resumes its count. When the Baud Rate Generator times out (TBRG), the SEN bit (SSPCON2<0>) will be automatically cleared by hardware. The Baud Rate Generator is suspended, leaving the SDA line held low and the Start condition is complete.

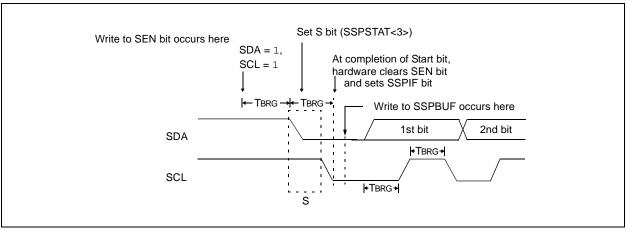
Note: If, at the beginning of the Start condition, the SDA and SCL pins are already sampled low, or if during the Start condition, the SCL line is sampled low before the SDA line is driven low, a bus collision occurs. The Bus Collision Interrupt Flag, BCLIF, is set, the Start condition is aborted and the I²C module is reset into its Idle state.

17.4.8.1 WCOL Status Flag

If the user writes the SSPBUF when a Start sequence is in progress, the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

Note: Because queueing of events is not allowed, writing to the lower 5 bits of SSPCON2 is disabled until the Start condition is complete.





© 2009 Microchip Technology Inc. Preliminary DS39933C-page 237

17.4.9 I²C MASTER MODE REPEATED START CONDITION TIMING

A Repeated Start condition occurs when the RSEN bit (SSPCON2<1>) is programmed high and the I²C logic module is in the Idle state. When the RSEN bit is set, the SCL pin is asserted low. When the SCL pin is sampled low, the Baud Rate Generator is loaded with the contents of SSPADD<6:0> and begins counting. The SDA pin is released (brought high) for one Baud Rate Generator count (TBRG). When the Baud Rate Generator times out, if SDA is sampled high, the SCL pin will be deasserted (brought high). When SCL is sampled high, the Baud Rate Generator is reloaded with the contents of SSPADD<6:0> and begins counting. SDA and SCL must be sampled high for one TBRG. This action is then followed by assertion of the SDA pin (SDA = 0) for one TBRG while SCL is high. Following this, the RSEN bit (SSPCON2<1>) will be automatically cleared and the Baud Rate Generator will not be reloaded, leaving the SDA pin held low. As soon as a Start condition is detected on the SDA and SCL pins, the S bit (SSPSTAT<3>) will be set. The SSPIF bit will not be set until the Baud Rate Generator has timed out.

Note 1: If RSEN is programmed while any other event is in progress, it will not take effect.

- **2:** A bus collision during the Repeated Start condition occurs if:
 - SDA is sampled low when SCL goes from low-to-high.
 - SCL goes low before SDA is asserted low. This may indicate that another master is attempting to transmit a data '1'.

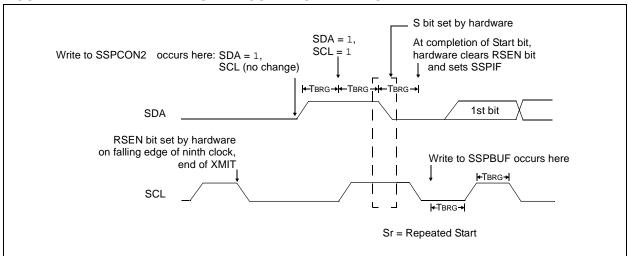
Immediately following the SSPIF bit getting set, the user may write the SSPBUF with the 7-bit address in 7-bit mode or the default first address in 10-bit mode. After the first eight bits are transmitted and an ACK is received, the user may then transmit an additional eight bits of address (10-bit mode) or eight bits of data (7-bit mode).

17.4.9.1 WCOL Status Flag

If the user writes the SSPBUF when a Repeated Start sequence is in progress, the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

Note: Because queueing of events is not allowed, writing of the lower 5 bits of SSPCON2 is disabled until the Repeated Start condition is complete.

FIGURE 17-22: REPEATED START CONDITION WAVEFORM



17.4.10 I²C MASTER MODE TRANSMISSION

Transmission of a data byte, a 7-bit address or the other half of a 10-bit address is accomplished by simply writing a value to the SSPBUF register. This action will set the Buffer Full bit, BF, and allow the Baud Rate Generator to begin counting and start the next transmission. Each bit of address/data will be shifted out onto the SDA pin after the falling edge of SCL is asserted (see data hold time specification parameter 106). SCL is held low for one Baud Rate Generator rollover count (TBRG). Data should be valid before SCL is released high (see data setup time specification parameter 107). When the SCL pin is released high, it is held that way for TBRG. The data on the SDA pin must remain stable for that duration and some hold time after the next falling edge of SCL. After the eighth bit is shifted out (the falling edge of the eighth clock), the BF flag is cleared and the master releases SDA. This allows the slave device being addressed to respond with an ACK bit during the ninth bit time if an address match occurred, or if data was received properly. The status of ACK is written into the ACKDT bit on the falling edge of the ninth clock. If the master receives an Acknowledge, the Acknowledge Status bit, ACKSTAT, is cleared; if not, the bit is set. After the ninth clock, the SSPIF bit is set and the master clock (Baud Rate Generator) is suspended until the next data byte is loaded into the SSPBUF, leaving SCL low and SDA unchanged (Figure 17-23).

After the write to the SSPBUF, each bit of the address will be shifted out on the falling edge of SCL until all seven address bits and the R/W bit are completed. On the falling edge of the eighth clock, the master will deassert the SDA pin, allowing the slave to respond with an Acknowledge. On the falling edge of the ninth clock, the master will sample the SDA pin to see if the address was recognized by a slave. The status of the ACK bit is loaded into the ACKSTAT status bit (SSPCON2<6>). Following the falling edge of the ninth clock transmission of the address, the SSPIF is set, the BF flag is cleared and the Baud Rate Generator is turned off until another write to the SSPBUF takes place, holding SCL low and allowing SDA to float.

17.4.10.1 BF Status Flag

In Transmit mode, the BF bit (SSPSTAT<0>) is set when the CPU writes to SSPBUF and is cleared when all 8 bits are shifted out.

17.4.10.2 WCOL Status Flag

If the user writes to the SSPBUF when a transmit is already in progress (i.e., SSPSR is still shifting out a data byte), the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur) after 2 TcY after the SSPBUF write. If SSPBUF is rewritten within 2 TcY, the WCOL bit is set and SSPBUF is updated. This may result in a corrupted transfer.

The user should verify that the WCOL is clear after each write to SSPBUF to ensure the transfer is correct. In all cases, WCOL must be cleared in software.

17.4.10.3 ACKSTAT Status Flag

In Transmit mode, the ACKSTAT bit (SSPCON2<6>) is cleared when the slave has sent an Acknowledge $(\overline{ACK}=0)$ and is set when the slave does not Acknowledge $(\overline{ACK}=1)$. A slave sends an Acknowledge when it has recognized its address (including a general call), or when the slave has properly received its data.

17.4.11 I²C MASTER MODE RECEPTION

Master mode reception is enabled by programming the Receive Enable bit, RCEN (SSPCON2<3>).

Note: The MSSP module must be in an Idle state before the RCEN bit is set or the RCEN bit will be disregarded.

The Baud Rate Generator begins counting and on each rollover, the state of the SCL pin changes (high-to-low/low-to-high) and data is shifted into the SSPSR. After the falling edge of the eighth clock, the receive enable flag is automatically cleared, the contents of the SSPSR are loaded into the SSPBUF, the BF flag bit is set, the SSPIF flag bit is set and the Baud Rate Generator is suspended from counting, holding SCL low. The MSSP is now in Idle state awaiting the next command. When the buffer is read by the CPU, the BF flag bit is automatically cleared. The user can then send an Acknowledge bit at the end of reception by setting the Acknowledge Sequence Enable bit, ACKEN (SSPCON2<4>).

17.4.11.1 BF Status Flag

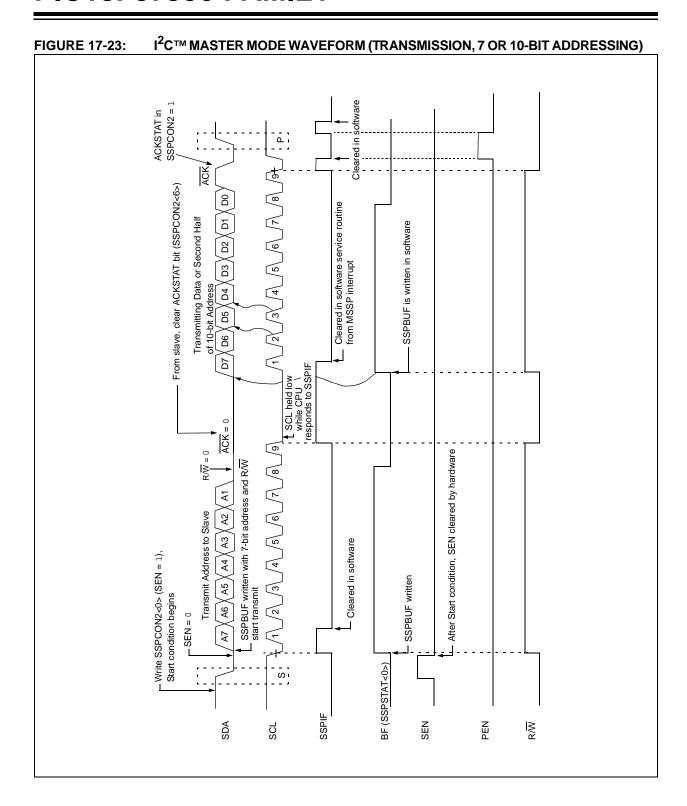
In receive operation, the BF bit is set when an address or data byte is loaded into SSPBUF from SSPSR. It is cleared when the SSPBUF register is read.

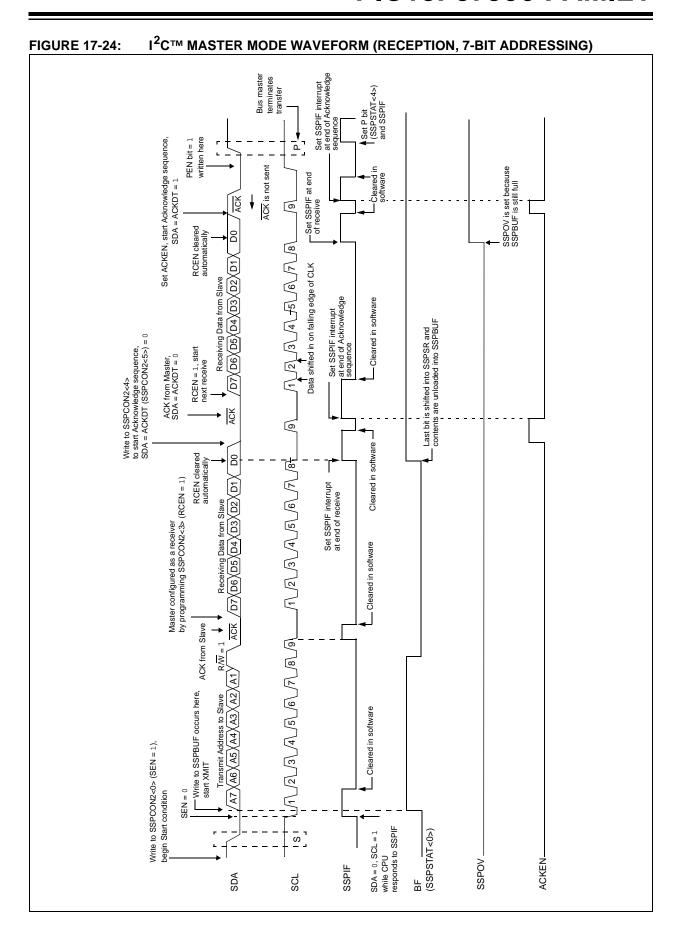
17.4.11.2 SSPOV Status Flag

In receive operation, the SSPOV bit is set when 8 bits are received into the SSPSR and the BF flag bit is already set from a previous reception.

17.4.11.3 WCOL Status Flag

If the user writes the SSPBUF when a receive is already in progress (i.e., SSPSR is still shifting in a data byte), the WCOL bit is set and the contents of the buffer are unchanged (the write doesn't occur).





17.4.12 ACKNOWLEDGE SEQUENCE TIMING

An Acknowledge sequence is enabled by setting the Acknowledge Sequence Enable bit. **ACKEN** (SSPCON2<4>). When this bit is set, the SCL pin is pulled low and the contents of the Acknowledge data bit are presented on the SDA pin. If the user wishes to generate an Acknowledge, then the ACKDT bit should be cleared. If not, the user should set the ACKDT bit before starting an Acknowledge sequence. The Baud Rate Generator then counts for one rollover period (TBRG) and the SCL pin is deasserted (pulled high). When the SCL pin is sampled high (clock arbitration), the Baud Rate Generator counts for TBRG. The SCL pin is then pulled low. Following this, the ACKEN bit is automatically cleared, the Baud Rate Generator is turned off and the MSSP module then goes into Idle mode (Figure 17-25).

17.4.12.1 WCOL Status Flag

If the user writes the SSPBUF when an Acknowledge sequence is in progress, then WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

17.4.13 STOP CONDITION TIMING

A Stop bit is asserted on the SDA pin at the end of a receive/transmit by setting the Stop Sequence Enable bit, PEN (SSPCON2<2>). At the end of a receive/transmit, the SCL line is held low after the falling edge of the ninth clock. When the PEN bit is set, the master will assert the SDA line low. When the SDA line is sampled low, the Baud Rate Generator is reloaded and counts down to 0. When the Baud Rate Generator times out, the SCL pin will be brought high and one TBRG (Baud Rate Generator rollover count) later, the SDA pin will be deasserted. When the SDA pin is sampled high while SCL is high, the P bit (SSPSTAT<4>) is set. A TBRG later, the PEN bit is cleared and the SSPIF bit is set (Figure 17-26).

17.4.13.1 WCOL Status Flag

If the user writes the SSPBUF when a Stop sequence is in progress, then the WCOL bit is set and the contents of the buffer are unchanged (the write doesn't occur).

FIGURE 17-25: ACKNOWLEDGE SEQUENCE WAVEFORM

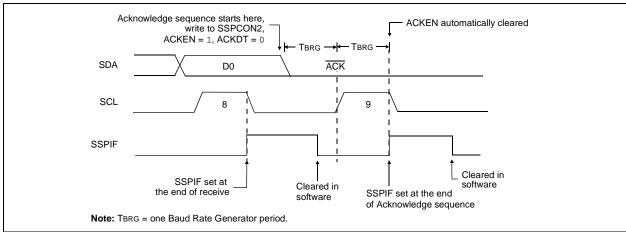
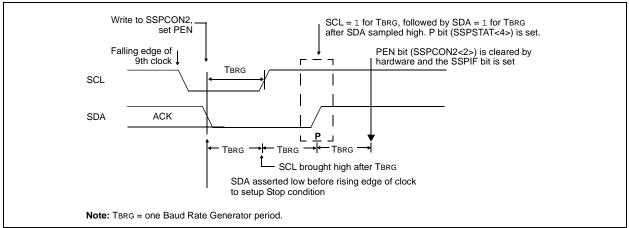


FIGURE 17-26: STOP CONDITION RECEIVE OR TRANSMIT MODE



17.4.14 SLEEP OPERATION

While in Sleep mode, the I²C module can receive addresses or data and when an address match or complete byte transfer occurs, wake the processor from Sleep (if the MSSP interrupt is enabled).

17.4.15 EFFECTS OF A RESET

A Reset disables the MSSP module and terminates the current transfer.

17.4.16 MULTI-MASTER MODE

In Multi-Master mode, the interrupt generation on the detection of the Start and Stop conditions allows the determination of when the bus is free. The Stop (P) and Start (S) bits are cleared from a Reset or when the MSSP module is disabled. Control of the I²C bus may be taken when the P bit (SSPSTAT<4>) is set, or the bus is Idle, with both the S and P bits clear. When the bus is busy, enabling the MSSP interrupt will generate the interrupt when the Stop condition occurs.

In multi-master operation, the SDA line must be monitored for arbitration to see if the signal level is the expected output level. This check is performed in hardware with the result placed in the BCLIF bit.

The states where arbitration can be lost are:

- · Address Transfer
- · Data Transfer
- · A Start Condition
- · A Repeated Start Condition
- An Acknowledge Condition

17.4.17 MULTI -MASTER COMMUNICATION, BUS COLLISION AND BUS ARBITRATION

Multi-Master mode support is achieved by bus arbitration. When the master outputs address/data bits onto the SDA pin, arbitration takes place when the master outputs a '1' on SDA by letting SDA float high, and another master asserts a '0'. When the SCL pin floats high, data should be stable. If the expected data on SDA is a '1' and the data sampled on the SDA pin = 0, then a bus collision has taken place. The master will set the Bus Collision Interrupt Flag, BCLIF and reset the I^2 C port to its Idle state (Figure 17-27).

If a transmit was in progress when the bus collision occurred, the transmission is halted, the BF flag is cleared, the SDA and SCL lines are deasserted and the SSPBUF can be written to. When the user services the bus collision Interrupt Service Routine and if the I²C bus is free, the user can resume communication by asserting a Start condition.

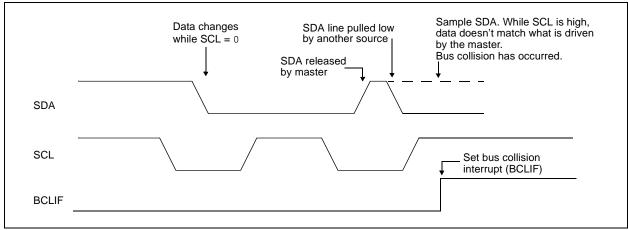
If a Start, Repeated Start, Stop or Acknowledge condition was in progress when the bus collision occurred, the condition is aborted, the SDA and SCL lines are deasserted and the respective control bits in the SSPCON2 register are cleared. When the user services the bus collision Interrupt Service Routine and if the $\rm I^2C$ bus is free, the user can resume communication by asserting a Start condition.

The master will continue to monitor the SDA and SCL pins. If a Stop condition occurs, the SSPIF bit will be set.

A write to the SSPBUF will start the transmission of data at the first data bit regardless of where the transmitter left off when the bus collision occurred.

In Multi-Master mode, the interrupt generation on the detection of Start and Stop conditions allows the determination of when the bus is free. Control of the I²C bus can be taken when the P bit is set in the SSPSTAT register, or the bus is Idle and the S and P bits are cleared.





17.4.17.1 Bus Collision During a Start Condition

During a Start condition, a bus collision occurs if:

- a) SDA or SCL are sampled low at the beginning of the Start condition (Figure 17-28).
- SCL is sampled low before SDA is asserted low (Figure 17-29).

During a Start condition, both the SDA and the SCL pins are monitored.

If the SDA pin is already low, or the SCL pin is already low, then all of the following occur:

- · the Start condition is aborted;
- · the BCLIF flag is set; and
- the MSSP module is reset to its Idle state (Figure 17-28).

The Start condition begins with the SDA and SCL pins deasserted. When the SDA pin is sampled high, the Baud Rate Generator is loaded from SSPADD<6:0> and counts down to 0. If the SCL pin is sampled low while SDA is high, a bus collision occurs, because it is assumed that another master is attempting to drive a data '1' during the Start condition.

If the SDA pin is sampled low during this count, the BRG is reset and the SDA line is asserted early (Figure 17-30). If, however, a '1' is sampled on the SDA pin, the SDA pin is asserted low at the end of the BRG count. The Baud Rate Generator is then reloaded and counts down to 0. If the SCL pin is sampled as '0' during this time, a bus collision does not occur. At the end of the BRG count, the SCL pin is asserted low.

The reason that bus collision is not a factor during a Start condition is that no two bus masters can assert a Start condition at the exact same time. Therefore, one master will always assert SDA before the other. This condition does not cause a bus collision because the two masters must be allowed to arbitrate the first address following the Start condition. If the address is the same, arbitration must be allowed to continue into the data portion, Repeated Start or Stop conditions.

FIGURE 17-28: BUS COLLISION DURING START CONDITION (SDA ONLY)

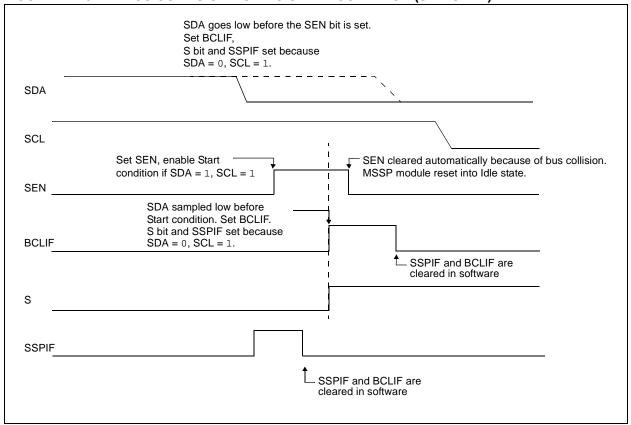


FIGURE 17-29: BUS COLLISION DURING START CONDITION (SCL = 0)

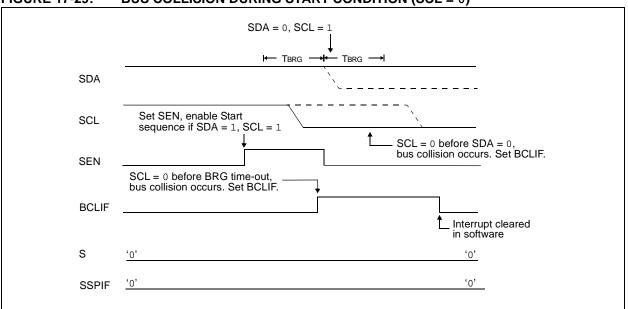
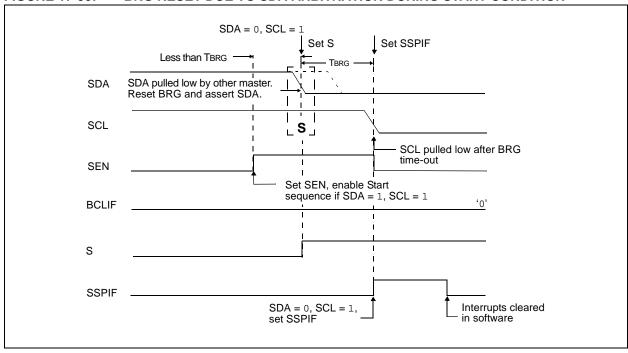


FIGURE 17-30: BRG RESET DUE TO SDA ARBITRATION DURING START CONDITION



© 2009 Microchip Technology Inc. Preliminary DS39933C-page 245

17.4.17.2 Bus Collision During a Repeated Start Condition

During a Repeated Start condition, a bus collision occurs if:

- a) A low level is sampled on SDA when SCL goes from low level to high level.
- SCL goes low before SDA is asserted low, indicating that another master is attempting to transmit a data '1'.

When the user deasserts SDA and the pin is allowed to float high, the BRG is loaded with SSPADD<6:0> and counts down to '0'. The SCL pin is then deasserted and when sampled high, the SDA pin is sampled.

If SDA is low, a bus collision has occurred (i.e., another master is attempting to transmit a data '0', see Figure 17-31). If SDA is sampled high, the BRG is reloaded and begins counting. If SDA goes from high-to-low before the BRG times out, no bus collision occurs because no two masters can assert SDA at exactly the same time.

If SCL goes from high-to-low before the BRG times out and SDA has not already been asserted, a bus collision occurs. In this case, another master is attempting to transmit a data '1' during the Repeated Start condition (see Figure 17-32).

If, at the end of the BRG time-out, both SCL and SDA are still high, the SDA pin is driven low and the BRG is reloaded and begins counting. At the end of the count, regardless of the status of the SCL pin, the SCL pin is driven low and the Repeated Start condition is complete.

FIGURE 17-31: BUS COLLISION DURING A REPEATED START CONDITION (CASE 1)

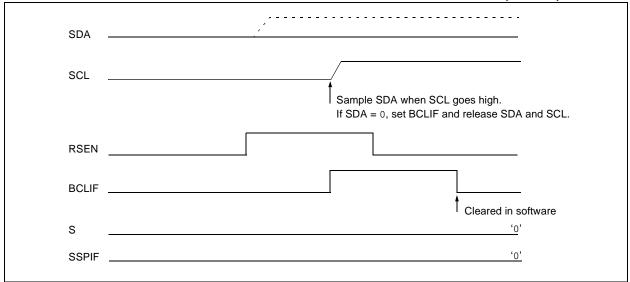
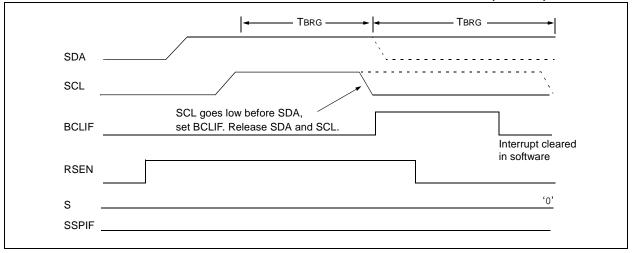


FIGURE 17-32: BUS COLLISION DURING REPEATED START CONDITION (CASE 2)



17.4.17.3 Bus Collision During a Stop Condition

Bus collision occurs during a Stop condition if:

- After the SDA pin has been deasserted and allowed to float high, SDA is sampled low after the BRG has timed out.
- b) After the SCL pin is deasserted, SCL is sampled low before SDA goes high.

The Stop condition begins with SDA asserted low. When SDA is sampled low, the SCL pin is allowed to float. When the pin is sampled high (clock arbitration), the Baud Rate Generator is loaded with SSPADD<6:0> and counts down to 0. After the BRG times out, SDA is sampled. If SDA is sampled low, a bus collision has occurred. This is due to another master attempting to drive a data '0' (Figure 17-33). If the SCL pin is sampled low before SDA is allowed to float high, a bus collision occurs. This is another case of another master attempting to drive a data '0' (Figure 17-34).

FIGURE 17-33: BUS COLLISION DURING A STOP CONDITION (CASE 1)

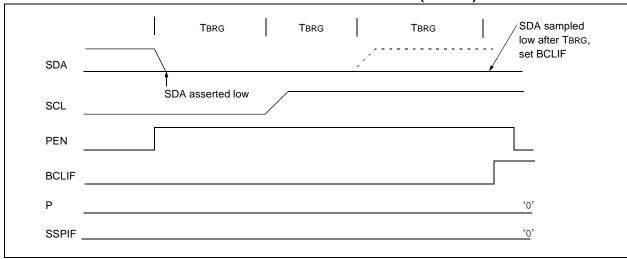
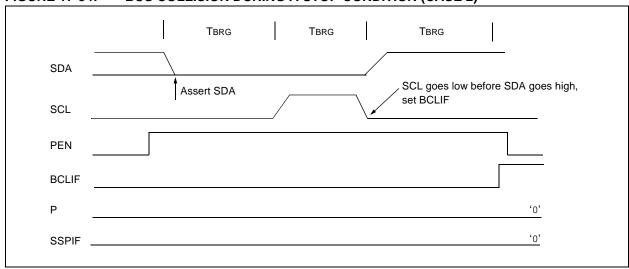


FIGURE 17-34: BUS COLLISION DURING A STOP CONDITION (CASE 2)



© 2009 Microchip Technology Inc. Preliminary DS39933C-page 247

TABLE 17-4: REGISTERS ASSOCIATED WITH I²C™ OPERATION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53
PIR1	_	ADIF	RC1IF	TX1IF	SSPIF	_	TMR2IF	TMR1IF	56
PIE1	_	ADIE	RC1IE	TX1IE	SSPIE	_	TMR2IE	TMR1IE	56
IPR1	_	ADIP	RC1IP	TX1IP	SSPIP	_	TMR2IP	TMR1IP	56
PIR2	OSCFIF	CMIF	-	_	BCLIF	LVDIF	TMR3IF	_	56
PIE2	OSCFIE	CMIE	_	_	BCLIE	LVDIE	TMR3IE	_	56
IPR2	OSCFIP	CMIP	_	_	BCLIP	LVDIP	TMR3IP	_	56
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	56
SSPBUF	MSSP Red	eive Buffer/	Transmit Re	gister					54
SSPADD	MSSP Address Register (I ² C™ Slave mode), MSSP Baud Rate Reload Register (I ² C Master mode)								54
SSPCON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	54
SSPCON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	54
	GCEN	ACKSTAT	ADMSK5 ⁽¹⁾	ADMSK4 ⁽¹⁾	ADMSK3 ⁽¹⁾	ADMSK2 ⁽¹⁾	ADMSK1 ⁽¹⁾	SEN	54
SSPSTAT	SMP	CKE	D/ A	Р	S	R/W	UA	BF	54

Legend: -= unimplemented, read as '0'. Shaded cells are not used by the MSSP module in I^2C^{TM} mode.

Note 1: Alternate bit definitions for use in I²C Slave mode operations only.

18.0 ENHANCED UNIVERSAL SYNCHRONOUS ASYNCHRONOUS RECEIVER TRANSMITTER (EUSART)

PIC18F87J90 family devices have three serial I/O modules: the MSSP module, discussed in the previous chapter and two Universal Synchronous Asynchronous Receiver Transmitter (USART) modules. (Generically, the USART is also known as a Serial Communications Interface or SCI.) The USART can be configured as a full-duplex asynchronous system that can communicate with peripheral devices, such as CRT terminals and personal computers. It can also be configured as a half-duplex synchronous system that can communicate with peripheral devices, such as A/D or D/A integrated circuits, serial EEPROMs, etc.

There are two distinct implementations of the USART module in these devices: the Enhanced USART (EUSART) discussed here and the Addressable USART discussed in the next chapter. For this device family, USART1 always refers to the EUSART, while USART2 is always the AUSART.

The EUSART and AUSART modules implement the same core features for serial communications; their basic operation is essentially the same. The EUSART module provides additional features, including Automatic Baud Rate Detection and calibration, automatic wake-up on Sync Break reception and 12-bit Break character transmit. These features make it ideally suited for use in Local Interconnect Network bus (LIN bus) systems.

The EUSART can be configured in the following modes:

- Asynchronous (full-duplex) with:
 - Auto-wake-up on character reception
 - Auto-baud calibration
 - 12-bit Break character transmission
- Synchronous Master (half-duplex) with selectable clock polarity
- Synchronous Slave (half-duplex) with selectable clock polarity

The pins of the EUSART are multiplexed with the functions of PORTC (RC6/TX1/CK1/SEG27 and RC7/RX1/DT1/SEG28). In order to configure these pins as an EUSART:

- bit SPEN (RCSTA1<7>) must be set (= 1)
- bit TRISC<7> must be set (= 1)
- bit TRISC<6> must be set (= 1)

Note: The EUSART control will automatically reconfigure the pin from input to output as needed.

The driver for the TX1 output pin can also be optionally configured as an open-drain output. This feature allows the voltage level on the pin to be pulled to a higher level through an external pull-up resistor, and allows the output to communicate with external circuits without the need for additional level shifters.

The open-drain output option is controlled by the U1OD bit (LATG<6>). Setting the bit configures the pin for open-drain operation.

18.1 Control Registers

The operation of the Enhanced USART module is controlled through three registers:

- Transmit Status and Control Register 1 (TXSTA1)
- Receive Status and Control Register 1 (RCSTA1)
- Baud Rate Control Register 1 (BAUDCON1)

The registers are described in Register 18-1, Register 18-2 and Register 18-3.

REGISTER 18-1: TXSTA1: EUSART TRANSMIT STATUS AND CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-1	R/W-0
CSRC	TX9	TXEN ⁽¹⁾	SYNC	SENDB	BRGH	TRMT	TX9D
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 CSRC: Clock Source Select bit

Asynchronous mode:

Don't care.

Synchronous mode:

1 = Master mode (clock generated internally from BRG)

0 = Slave mode (clock from external source)

bit 6 **TX9:** 9-Bit Transmit Enable bit

1 = Selects 9-bit transmission

0 = Selects 8-bit transmission

bit 5 **TXEN:** Transmit Enable bit⁽¹⁾

1 = Transmit enabled

0 = Transmit disabled

bit 4 SYNC: EUSART Mode Select bit

1 = Synchronous mode

0 = Asynchronous mode

bit 3 SENDB: Send Break Character bit

Asynchronous mode:

1 = Send Sync Break on next transmission (cleared by hardware upon completion)

0 = Sync Break transmission completed

Synchronous mode:

Don't care.

bit 2 BRGH: High Baud Rate Select bit

Asynchronous mode:

1 = High speed

0 = Low speed

Synchronous mode:

Unused in this mode.

bit 1 TRMT: Transmit Shift Register Status bit

1 = TSR empty

0 = TSR full

bit 0 **TX9D:** 9th bit of Transmit Data

Can be address/data bit or a parity bit.

Note 1: SREN/CREN overrides TXEN in Sync mode.

REGISTER 18-2: RCSTA1: EUSART RECEIVE STATUS AND CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0	R-x
SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 SPEN: Serial Port Enable bit

1 = Serial port enabled (configures RX1/DT1 and TX1/CK1 pins as serial port pins)

0 = Serial port disabled (held in Reset)

bit 6 **RX9:** 9-Bit Receive Enable bit

1 = Selects 9-bit reception0 = Selects 8-bit reception

bit 5 SREN: Single Receive Enable bit

Asynchronous mode:

Don't care.

Synchronous mode - Master:

1 = Enables single receive

0 = Disables single receive

This bit is cleared after reception is complete.

Synchronous mode - Slave:

Don't care.

bit 4 CREN: Continuous Receive Enable bit

Asynchronous mode:

1 = Enables receiver

0 = Disables receiver

Synchronous mode:

1 = Enables continuous receive until enable bit CREN is cleared (CREN overrides SREN)

0 = Disables continuous receive

bit 3 ADDEN: Address Detect Enable bit

Asynchronous mode 9-bit (RX9 = 1):

1 = Enables address detection, enables interrupt and loads the receive buffer when RSR<8> is set

0 = Disables address detection, all bytes are received and ninth bit can be used as parity bit

Asynchronous mode 9-bit (RX9 = 0):

Don't care.

bit 2 **FERR:** Framing Error bit

1 = Framing error (can be updated by reading RCREG1 register and receiving next valid byte)

0 = No framing error

bit 1 **OERR:** Overrun Error bit

1 = Overrun error (can be cleared by clearing bit CREN)

0 = No overrun error

bit 0 RX9D: 9th bit of Received Data

This can be address/data bit or a parity bit and must be calculated by user firmware.

REGISTER 18-3: BAUDCON1: BAUD RATE CONTROL REGISTER 1

R/W-0	R-1	R/W - 0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
ABDOVF	RCMT	RXDTP	TXCKP	BRG16	_	WUE	ABDEN
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 ABDOVF: Auto-Baud Acquisition Rollover Status bit

1 = A BRG rollover has occurred during Auto-Baud Rate Detect mode (must be cleared in software)

0 = No BRG rollover has occurred

bit 6 RCMT: Receive Operation Idle Status bit

1 = Receive operation is Idle0 = Receive operation is active

bit 5 RXDTP: Received Data Polarity Select bit

Asynchronous mode:

1 = RXx data is inverted

0 = RXx data is not inverted

Synchronous mode:

1 = CKx clocks are inverted

0 = CKx clocks are not inverted

bit 4 TXCKP: Clock and Data Polarity Select bit

Asynchronous mode:

1 = TXx data is inverted

0 = TXx data is not inverted

Synchronous mode:

1 = CKx clocks are inverted

0 = CKx clocks are not inverted

bit 3 BRG16: 16-Bit Baud Rate Register Enable bit

1 = 16-bit Baud Rate Generator - SPBRGH1 and SPBRG1

0 = 8-bit Baud Rate Generator - SPBRG1 only (Compatible mode), SPBRGH1 value ignored

bit 2 Unimplemented: Read as '0'

bit 1 WUE: Wake-up Enable bit

Asynchronous mode:

1 = EUSART will continue to sample the RX1 pin – interrupt generated on falling edge; bit cleared in hardware on following rising edge

0 = RX1 pin not monitored or rising edge detected

Synchronous mode:

Unused in this mode.

bit 0 ABDEN: Auto-Baud Detect Enable bit

Asynchronous mode:

1 = Enable baud rate measurement on the next character. Requires reception of a Sync field (55h); cleared in hardware upon completion.

0 = Baud rate measurement disabled or completed

Synchronous mode:

Unused in this mode.

18.2 EUSART Baud Rate Generator (BRG)

The BRG is a dedicated, 8-bit or 16-bit generator that supports both the Asynchronous and Synchronous modes of the EUSART. By default, the BRG operates in 8-bit mode; setting the BRG16 bit (BAUDCON1<3>) selects 16-bit mode.

The SPBRGH1:SPBRG1 register pair controls the period of a free-running timer. In Asynchronous mode, BRGH (TXSTA1<2>) and BRG16 (BAUDCON1<3>) bits also control the baud rate. In Synchronous mode, BRGH is ignored. Table 18-1 shows the formula for computation of the baud rate for different EUSART modes that only apply in Master mode (internally generated clock).

Given the desired baud rate and Fosc, the nearest integer value for the SPBRGH1:SPBRG1 registers can be calculated using the formulas in Table 18-1. From this, the error in baud rate can be determined. An example calculation is shown in Example 18-1. Typical baud rates and error values for the various Asynchronous modes are shown in Table 18-2. It may be advantageous to use

the high baud rate (BRGH = 1) or the 16-bit BRG to reduce the baud rate error, or achieve a slow baud rate for a fast oscillator frequency.

Writing a new value to the SPBRGH1:SPBRG1 registers causes the BRG timer to be reset (or cleared). This ensures the BRG does not wait for a timer overflow before outputting the new baud rate.

18.2.1 OPERATION IN POWER-MANAGED MODES

The device clock is used to generate the desired baud rate. When one of the power-managed modes is entered, the new clock source may be operating at a different frequency. This may require an adjustment to the value in the SPBRG1 register pair.

18.2.2 SAMPLING

The data on the RX1 pin is sampled three times by a majority detect circuit to determine if a high or a low level is present at the RX1 pin.

TABLE 18-1: BAUD RATE FORMULAS

C	onfiguration B	its	DDC/EUCADT Mode	Paud Bata Formula			
SYNC	BRG16	BRGH	BRG/EUSART Mode	Baud Rate Formula			
0	0	0	8-bit/Asynchronous	Fosc/[64 (n + 1)]			
0	0	1	8-bit/Asynchronous	F000/[40 (n + 4)]			
0	1	0	16-bit/Asynchronous	Fosc/[16 (n + 1)]			
0	1	1	16-bit/Asynchronous				
1	0	х	8-bit/Synchronous	Fosc/[4 (n + 1)]			
1	1	х	16-bit/Synchronous				

Legend: x = Don't care, n = Value of SPBRGH1:SPBRG1 register pair

EXAMPLE 18-1: CALCULATING BAUD RATE ERROR

For a device with Fosc of 16 MHz, desired baud rate of 9600, Asynchronous mode, 8-bit BRG:

Desired Baud Rate = Fosc/(64 ([SPBRGH1:SPBRG1] + 1))

Solving for SPBRGH1:SPBRG1:

X = ((Fosc/Desired Baud Rate)/64) - 1

= ((16000000/9600)/64) - 1

= [25.042] = 25

Calculated Baud Rate = 16000000/(64(25+1))

= 9615

Error = (Calculated Baud Rate – Desired Baud Rate)/Desired Baud Rate

= (9615 - 9600)/9600 = 0.16%

TABLE 18-2: REGISTERS ASSOCIATED WITH THE BAUD RATE GENERATOR

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page	
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	55	
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	55	
BAUDCON1	ABDOVF	RCMT	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	57	
SPBRGH1	EUSART E	JSART Baud Rate Generator Register High Byte								
SPBRG1	EUSART E	Baud Rate		55						

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the BRG.

TABLE 18-3: BAUD RATES FOR ASYNCHRONOUS MODES

					SYNC	= 0, BRGH	l = 0, BRG	316 = 0				
BAUD RATE	Fosc	= 40.000) MHz	Fosc	= 20.000) MHz	Fosc = 10.000 MHz			Fosc = 8.000 MHz		
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)
0.3	_		_	_	_	_	_	_	_	_	_	_
1.2	_		_	1.221	1.73	255	1.202	0.16	129	1.201	-0.16	103
2.4	2.441	1.73	255	2.404	0.16	129	2.404	0.16	64	2.403	-0.16	51
9.6	9.615	0.16	64	9.766	1.73	31	9.766	1.73	15	9.615	-0.16	12
19.2	19.531	1.73	31	19.531	1.73	15	19.531	1.73	7	_	_	_
57.6	56.818	-1.36	10	62.500	8.51	4	52.083	-9.58	2	_	_	_
115.2	125.000	8.51	4	104.167	-9.58	2	78.125	-32.18	1		_	_

		SYNC = 0, BRGH = 0, BRG16 = 0												
BAUD RATE	Fos	c = 4.000	MHz	Fos	c = 2.000	MHz	Fosc = 1.000 MHz							
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)					
0.3	0.300	0.16	207	0.300	-0.16	103	0.300	-0.16	51					
1.2	1.202	0.16	51	1.201	-0.16	25	1.201	-0.16	12					
2.4	2.404	0.16	25	2.403	-0.16	12	_	_	_					
9.6	8.929	-6.99	6	_	_	_	_	_	_					
19.2	20.833	8.51	2	_	_	_	_	_	_					
57.6	62.500	8.51	0	_	_	_	_	_	_					
115.2	62.500	-45.75	0		_	_	_	_	_					

					SYNC	= 0, BRG	l = 1, BRG	16 = 0				
BAUD RATE	Fosc	= 40.000) MHz	Fosc	= 20.000) MHz	Fosc	= 10.000) MHz	Fosc = 8.000 MHz		
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)
0.3	_	_	_	_	_	_	_	_	_	_	_	_
1.2	_		_	_	_	_	_		_	_	_	_
2.4	_	_	_	_	_	_	2.441	1.73	255	2.403	-0.16	207
9.6	9.766	1.73	255	9.615	0.16	129	9.615	0.16	64	9.615	-0.16	51
19.2	19.231	0.16	129	19.231	0.16	64	19.531	1.73	31	19.230	-0.16	25
57.6	58.140	0.94	42	56.818	-1.36	21	56.818	-1.36	10	55.555	3.55	8
115.2	113.636	-1.36	21	113.636	-1.36	10	125.000	8.51	4		_	_

			S	YNC = 0, E	BRGH = 1	, BRG16 =	0			
BAUD RATE	Fosc	c = 4.000	MHz	Fos	c = 2.000	MHz	Fosc = 1.000 MHz			
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	
0.3	_	_	_	_	_	_	0.300	-0.16	207	
1.2	1.202	0.16	207	1.201	-0.16	103	1.201	-0.16	51	
2.4	2.404	0.16	103	2.403	-0.16	51	2.403	-0.16	25	
9.6	9.615	0.16	25	9.615	-0.16	12	_	_	_	
19.2	19.231	0.16	12	_	_	_	_	_	_	
57.6	62.500	8.51	3	_	_	_	_	_	_	
115.2	125.000	8.51	1		_	_		_	_	

TABLE 18-3: BAUD RATES FOR ASYNCHRONOUS MODES (CONTINUED)

		SYNC = 0, BRGH = 0, BRG16 = 1													
BAUD RATE	Fosc	= 40.000) MHz	Fosc	= 20.000) MHz	Fosc	= 10.000) MHz	Fos	c = 8.000	MHz			
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)			
0.3	0.300	0.00	8332	0.300	0.02	4165	0.300	0.02	2082	0.300	-0.04	1665			
1.2	1.200	0.02	2082	1.200	-0.03	1041	1.200	-0.03	520	1.201	-0.16	415			
2.4	2.402	0.06	1040	2.399	-0.03	520	2.404	0.16	259	2.403	-0.16	207			
9.6	9.615	0.16	259	9.615	0.16	129	9.615	0.16	64	9.615	-0.16	51			
19.2	19.231	0.16	129	19.231	0.16	64	19.531	1.73	31	19.230	-0.16	25			
57.6	58.140	0.94	42	56.818	-1.36	21	56.818	-1.36	10	55.555	3.55	8			
115.2	113.636	-1.36	21	113.636	-1.36	10	125.000	8.51	4		_	_			

		SYNC = 0, BRGH = 0, BRG16 = 1												
BAUD RATE	Fosc	= 4.000	MHz	Fos	c = 2.000	MHz	Fosc = 1.000 MHz							
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)					
0.3	0.300	0.04	832	0.300	-0.16	415	0.300	-0.16	207					
1.2	1.202	0.16	207	1.201	-0.16	103	1.201	-0.16	51					
2.4	2.404	0.16	103	2.403	-0.16	51	2.403	-0.16	25					
9.6	9.615	0.16	25	9.615	-0.16	12	_	_	_					
19.2	19.231	0.16	12	_	_	_	_	_	_					
57.6	62.500	8.51	3	_	_	_	_	_	_					
115.2	125.000	8.51	1	_	_	_	_	_	_					

				SYNC = 0	, BRGH =	= 1, BRG16	= 1 or SY	NC = 1, l	BRG16 = 1			
BAUD RATE	Fosc	= 40.000) MHz	Fosc	= 20.000) MHz	Fosc	= 10.000) MHz	Fosc = 8.000 MHz		
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)									
0.3	0.300	0.00	33332	0.300	0.00	16665	0.300	0.00	8332	0.300	-0.01	6665
1.2	1.200	0.00	8332	1.200	0.02	4165	1.200	0.02	2082	1.200	-0.04	1665
2.4	2.400	0.02	4165	2.400	0.02	2082	2.402	0.06	1040	2.400	-0.04	832
9.6	9.606	0.06	1040	9.596	-0.03	520	9.615	0.16	259	9.615	-0.16	207
19.2	19.193	-0.03	520	19.231	0.16	259	19.231	0.16	129	19.230	-0.16	103
57.6	57.803	0.35	172	57.471	-0.22	86	58.140	0.94	42	57.142	0.79	34
115.2	114.943	-0.22	86	116.279	0.94	42	113.636	-1.36	21	117.647	-2.12	16

		SYNC = 0, BRGH = 1, BRG16 = 1 or SYNC = 1, BRG16 = 1												
BAUD RATE	Fos	c = 4.000	MHz	Fos	c = 2.000	MHz	Fosc = 1.000 MHz							
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)					
0.3	0.300	0.01	3332	0.300	-0.04	1665	0.300	-0.04	832					
1.2	1.200	0.04	832	1.201	-0.16	415	1.201	-0.16	207					
2.4	2.404	0.16	415	2.403	-0.16	207	2.403	-0.16	103					
9.6	9.615	0.16	103	9.615	-0.16	51	9.615	-0.16	25					
19.2	19.231	0.16	51	19.230	-0.16	25	19.230	-0.16	12					
57.6	58.824	2.12	16	55.555	3.55	8	_	_	_					
115.2	111.111	-3.55	8	_	_	_	_	_	_					

18.2.3 AUTO-BAUD RATE DETECT

The Enhanced USART module supports the automatic detection and calibration of baud rate. This feature is active only in Asynchronous mode and while the WUE bit is clear.

The automatic baud rate measurement sequence (Figure 18-1) begins whenever a Start bit is received and the ABDEN bit is set. The calculation is self-averaging.

In the Auto-Baud Rate Detect (ABD) mode, the clock to the BRG is reversed. Rather than the BRG clocking the incoming RX1 signal, the RX1 signal is timing the BRG. In ABD mode, the internal Baud Rate Generator is used as a counter to time the bit period of the incoming serial byte stream.

Once the ABDEN bit is set, the state machine will clear the BRG and look for a Start bit. The Auto-Baud Rate Detect must receive a byte with the value, 55h (ASCII "U", which is also the LIN bus Sync character), in order to calculate the proper bit rate. The measurement is taken over both a low and a high bit time in order to minimize any effects caused by asymmetry of the incoming signal. After a Start bit, the SPBRG1 begins counting up, using the preselected clock source on the first rising edge of RX1. After eight bits on the RX1 pin or the fifth rising edge, an accumulated value totalling proper BRG period is left SPBRGH1:SPBRG1 register pair. Once the 5th edge is seen (this should correspond to the Stop bit), the ABDEN bit is automatically cleared.

If a rollover of the BRG occurs (an overflow from FFFFh to 0000h), the event is trapped by the ABDOVF status bit (BAUDCON1<7>). It is set in hardware by BRG rollovers and can be set or cleared by the user in software. ABD mode remains active after rollover events and the ABDEN bit remains set (Figure 18-2).

While calibrating the baud rate period, the BRG registers are clocked at 1/8th the preconfigured clock rate. Note that the BRG clock will be configured by the BRG16 and BRGH bits. Independent of the BRG16 bit setting, both the SPBRG1 and SPBRGH1 will be used as a 16-bit counter. This allows the user to verify that no carry occurred for 8-bit modes by checking for 00h in the SPBRGH1 register. Refer to Table 18-4 for counter clock rates to the BRG.

While the ABD sequence takes place, the EUSART state machine is held in Idle. The RC1IF interrupt is set once the fifth rising edge on RX1 is detected. The value in the RCREG1 needs to be read to clear the RC1IF interrupt. The contents of RCREG1 should be discarded.

- **Note 1:** If the WUE bit is set with the ABDEN bit, Auto-Baud Rate Detection will occur on the byte *following* the Break character.
 - 2: It is up to the user to determine that the incoming character baud rate is within the range of the selected BRG clock source. Some combinations of oscillator frequency and EUSART baud rates are not possible due to bit error rates. Overall system timing and communication baud rates must be taken into consideration when using the Auto-Baud Rate Detection feature.

TABLE 18-4: BRG COUNTER CLOCK RATES

BRG16	BRGH	BRG Counter Clock
0	0	Fosc/512
0	1	Fosc/128
1	0	Fosc/128
1	1	Fosc/32

Note: During the ABD sequence, SPBRG1 and SPBRGH1 are both used as a 16-bit counter, independent of the BRG16 setting.

18.2.3.1 ABD and EUSART Transmission

Since the BRG clock is reversed during ABD acquisition, the EUSART transmitter cannot be used during ABD. This means that whenever the ABDEN bit is set, TXREG1 cannot be written to. Users should also ensure that ABDEN does not become set during a transmit sequence. Failing to do this may result in unpredictable EUSART operation.

FIGURE 18-1: AUTOMATIC BAUD RATE CALCULATION

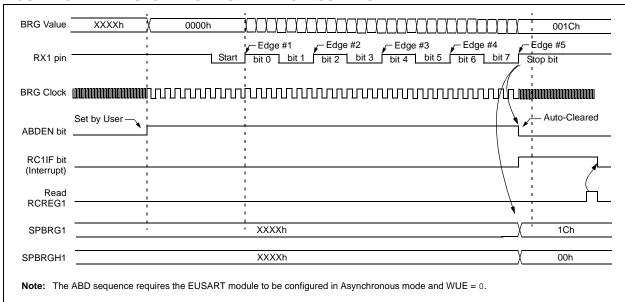
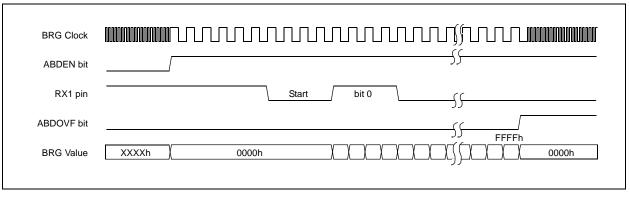


FIGURE 18-2: BRG OVERFLOW SEQUENCE



18.3 EUSART Asynchronous Mode

The Asynchronous mode of operation is selected by clearing the SYNC bit (TXSTA1<4>). In this mode, the EUSART uses standard Non-Return-to-Zero (NRZ) format (one Start bit, eight or nine data bits and one Stop bit). The most common data format is 8 bits. An on-chip dedicated 8-bit/16-bit Baud Rate Generator can be used to derive standard baud rate frequencies from the oscillator.

The EUSART transmits and receives the LSb first. The EUSART's transmitter and receiver are functionally independent, but use the same data format and baud rate. The Baud Rate Generator produces a clock, either x16 or x64 of the bit shift rate, depending on the BRGH and BRG16 bits (TXSTA1<2> and BAUDCON1<3>). Parity is not supported by the hardware but can be implemented in software and stored as the 9th data bit.

When operating in Asynchronous mode, the EUSART module consists of the following important elements:

- · Baud Rate Generator
- · Sampling Circuit
- · Asynchronous Transmitter
- · Asynchronous Receiver
- · Auto-Wake-up on Sync Break Character
- 12-Bit Break Character Transmit
- · Auto-Baud Rate Detection

18.3.1 EUSART ASYNCHRONOUS TRANSMITTER

The EUSART transmitter block diagram is shown in Figure 18-3. The heart of the transmitter is the Transmit (Serial) Shift register (TSR). The Shift register obtains its data from the Read/Write Transmit Buffer register, TXREG1. The TXREG1 register is loaded with data in software. The TSR register is not loaded until the Stop bit has been transmitted from the previous load. As soon as the Stop bit is transmitted, the TSR is loaded with new data from the TXREG1 register (if available).

Once the TXREG1 register transfers the data to the TSR register (occurs in one TcY), the TXREG1 register is empty and the TX1IF flag bit (PIR1<4>) is set. This interrupt can be enabled or disabled by setting or clearing the interrupt enable bit, TX1IE (PIE1<4>). TX1IF will be set regardless of the state of TX1IE; it cannot be cleared in software. TX1IF is also not cleared immediately upon loading TXREG1, but becomes valid in the second instruction cycle following the load instruction. Polling TX1IF immediately following a load of TXREG1 will return invalid results.

While TX1IF indicates the status of the TXREG1 register, another bit, TRMT (TXSTA1<1>), shows the status of the TSR register. TRMT is a read-only bit which is set when the TSR register is empty. No interrupt logic is tied to this bit so the user has to poll this bit in order to determine if the TSR register is empty.

- **Note 1:** The TSR register is not mapped in data memory so it is not available to the user.
 - 2: Flag bit, TX1IF, is set when enable bit, TXEN, is set.

To set up an Asynchronous Transmission:

- Initialize the SPBRGH1:SPBRG1 registers for the appropriate baud rate. Set or clear the BRGH and BRG16 bits, as required, to achieve the desired baud rate.
- Enable the asynchronous serial port by clearing bit, SYNC, and setting bit, SPEN.
- 3. If interrupts are desired, set enable bit, TX1IE.
- If 9-bit transmission is desired, set transmit bit, TX9; can be used as address/data bit.
- Enable the transmission by setting bit, TXEN, which will also set bit, TX1IF.
- If 9-bit transmission is selected, the ninth bit should be loaded in bit, TX9D.
- Load data to the TXREG1 register (starts transmission).
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set

FIGURE 18-3: EUSART TRANSMIT BLOCK DIAGRAM

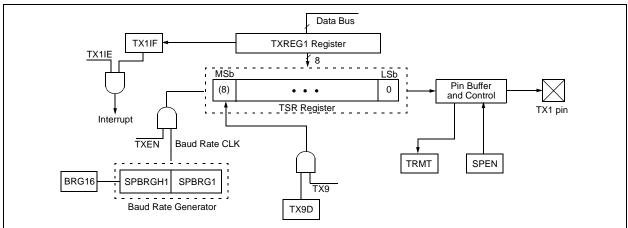


FIGURE 18-4: ASYNCHRONOUS TRANSMISSION

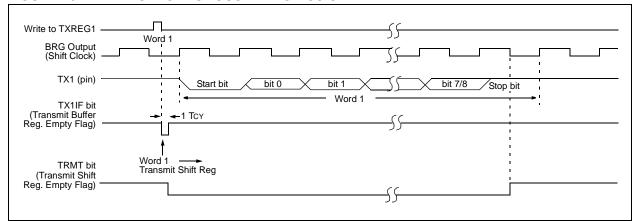


FIGURE 18-5: ASYNCHRONOUS TRANSMISSION (BACK TO BACK)

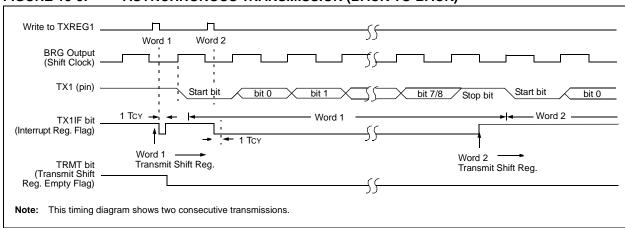


TABLE 18-5: REGISTERS ASSOCIATED WITH ASYNCHRONOUS TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53
PIR1	_	ADIF	RC1IF	TX1IF	SSPIF	_	TMR2IF	TMR1IF	56
PIE1	_	ADIE	RC1IE	TX1IE	SSPIE	_	TMR2IE	TMR1IE	56
IPR1	_	ADIP	RC1IP	TX1IP	SSPIP	_	TMR2IP	TMR1IP	56
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	55
TXREG1	EUSART T	ransmit Reg	ister						55
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	55
BAUDCON1	ABDOVF	RCMT	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	57
SPBRGH1	EUSART B	USART Baud Rate Generator Register High Byte							57
SPBRG1	EUSART B	EUSART Baud Rate Generator Register Low Byte							
LATG	U2OD	U10D	_	LATG4	LATG3	LATG2	LATG1	LATG0	56

Legend: — = unimplemented locations read as '0'. Shaded cells are not used for asynchronous transmission.

18.3.2 EUSART ASYNCHRONOUS RECEIVER

The receiver block diagram is shown in Figure 18-6. The data is received on the RX1 pin and drives the data recovery block. The data recovery block is actually a high-speed shifter operating at x16 times the baud rate, whereas the main receive serial shifter operates at the bit rate or at Fosc. This mode would typically be used in RS-232 systems.

To set up an Asynchronous Reception:

- Initialize the SPBRGH1:SPBRG1 registers for the appropriate baud rate. Set or clear the BRGH and BRG16 bits, as required, to achieve the desired baud rate.
- Enable the asynchronous serial port by clearing bit, SYNC, and setting bit, SPEN.
- 3. If interrupts are desired, set enable bit, RC1IE.
- 4. If 9-bit reception is desired, set bit, RX9.
- 5. Enable the reception by setting bit, CREN.
- Flag bit, RC1IF, will be set when reception is complete and an interrupt will be generated if enable bit, RC1IE, was set.
- 7. Read the RCSTA1 register to get the 9th bit (if enabled) and determine if any error occurred during reception.
- Read the 8-bit received data by reading the RCREG1 register.
- If any error occurred, clear the error by clearing enable bit, CREN.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

18.3.3 SETTING UP 9-BIT MODE WITH ADDRESS DETECT

This mode would typically be used in RS-485 systems. To set up an Asynchronous Reception with Address Detect Enable:

- Initialize the SPBRGH1:SPBRG1 registers for the appropriate baud rate. Set or clear the BRGH and BRG16 bits, as required, to achieve the desired baud rate.
- 2. Enable the asynchronous serial port by clearing the SYNC bit and setting the SPEN bit.
- If interrupts are required, set the RCEN bit and select the desired priority level with the RC1IP bit
- 4. Set the RX9 bit to enable 9-bit reception.
- 5. Set the ADDEN bit to enable address detect.
- 6. Enable reception by setting the CREN bit.
- The RC1IF bit will be set when reception is complete. The interrupt will be Acknowledged if the RC1IE and GIE bits are set.
- 8. Read the RCSTA1 register to determine if any error occurred during reception, as well as read bit 9 of data (if applicable).
- Read RCREG1 to determine if the device is being addressed.
- 10. If any error occurred, clear the CREN bit.
- 11. If the device has been addressed, clear the ADDEN bit to allow all received data into the receive buffer and interrupt the CPU.

FIGURE 18-6: EUSART RECEIVE BLOCK DIAGRAM

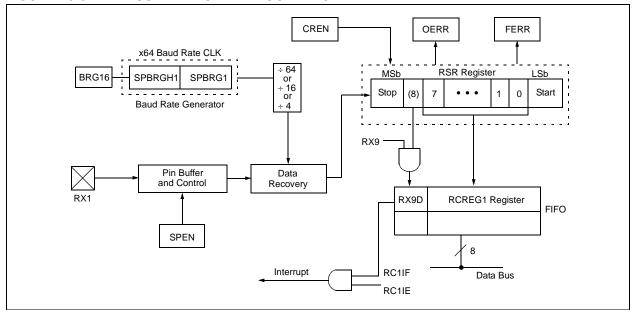


FIGURE 18-7: ASYNCHRONOUS RECEPTION

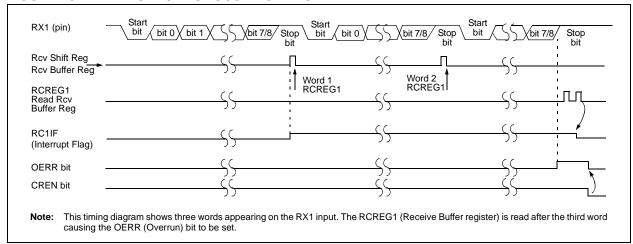


TABLE 18-6: REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page		
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53		
PIR1	_	ADIF	RC1IF	TX1IF	SSPIF	_	TMR2IF	TMR1IF	56		
PIE1	_	ADIE	RC1IE	TX1IE	SSPIE	_	TMR2IE	TMR1IE	56		
IPR1	_	ADIP	RC1IP	TX1IP	SSPIP	_	TMR2IP	TMR1IP	56		
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	55		
RCREG1	EUSART R	Receive Regi	ster						55		
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	55		
BAUDCON1	ABDOVF	RCMT	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	57		
SPBRGH1	EUSART B	EUSART Baud Rate Generator Register High Byte									
SPBRG1	EUSART B	aud Rate G	enerator Re	gister Low	Byte				55		

Legend: — = unimplemented locations read as '0'. Shaded cells are not used for asynchronous reception.

18.3.4 AUTO-WAKE-UP ON SYNC BREAK CHARACTER

During Sleep mode, all clocks to the EUSART are suspended. Because of this, the Baud Rate Generator is inactive and a proper byte reception cannot be performed. The auto-wake-up feature allows the controller to wake-up, due to activity on the RX1/DT1 line, while the EUSART is operating in Asynchronous mode.

The auto-wake-up feature is enabled by setting the WUE bit (BAUDCON<1>). Once set, the typical receive sequence on RX1/DT1 is disabled and the EUSART remains in an Idle state, monitoring for a wake-up event independent of the CPU mode. A wake-up event consists of a high-to-low transition on the RX1/DT1 line. (This coincides with the start of a Sync Break or a Wake-up Signal character for the LIN protocol.)

Following a wake-up event, the module generates an RC1IF interrupt. The interrupt is generated synchronously to the Q clocks in normal operating modes (Figure 18-8) and asynchronously, if the device is in Sleep mode (Figure 18-9). The interrupt condition is cleared by reading the RCREG1 register.

The WUE bit is automatically cleared once a low-to-high transition is observed on the RX1 line following the wake-up event. At this point, the EUSART module is in Idle mode and returns to normal operation. This signals to the user that the Sync Break event is over.

18.3.4.1 Special Considerations Using Auto-Wake-up

Since auto-wake-up functions by sensing rising edge transitions on RX1/DT1, information with any state changes before the Stop bit may signal a false

end-of-character and cause data or framing errors. Therefore, to work properly, the initial character in the transmission must be all '0's. This can be 00h (8 bytes) for standard RS-232 devices, or 000h (12 bits) for LIN bus.

Oscillator start-up time must also be considered, especially in applications using oscillators with longer start-up intervals (i.e., XT or HS mode). The Sync Break (or Wake-up Signal) character must be of sufficient length and be followed by a sufficient interval to allow enough time for the selected oscillator to start and provide proper initialization of the EUSART.

18.3.4.2 Special Considerations Using the WUE Bit

The timing of WUE and RC1IF events may cause some confusion when it comes to determining the validity of received data. As noted, setting the WUE bit places the EUSART in an Idle mode. The wake-up event causes a receive interrupt by setting the RC1IF bit. The WUE bit is cleared after this when a rising edge is seen on RX1/DT1. The interrupt condition is then cleared by reading the RCREG1 register. Ordinarily, the data in RCREG1 will be dummy data and should be discarded.

The fact that the WUE bit has been cleared (or is still set) and the RC1IF flag is set should not be used as an indicator of the integrity of the data in RCREG1. Users should consider implementing a parallel method in firmware to verify received data integrity.

To assure that no actual data is lost, check the RCMT bit to verify that a receive operation is not in process. If a receive operation is not occurring, the WUE bit may then be set just prior to entering the Sleep mode.

FIGURE 18-8: AUTO-WAKE-UP BIT (WUE) TIMINGS DURING NORMAL OPERATION

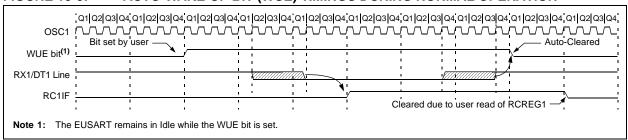
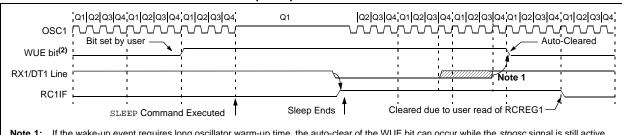


FIGURE 18-9: AUTO-WAKE-UP BIT (WUE) TIMINGS DURING SLEEP



Note 1: If the wake-up event requires long oscillator warm-up time, the auto-clear of the WUE bit can occur while the *stposc* signal is still active. This sequence should not depend on the presence of Q clocks.

2: The EUSART remains in Idle while the WUE bit is set.

18.3.5 BREAK CHARACTER SEQUENCE

The Enhanced USART module has the capability of sending the special Break character sequences that are required by the LIN bus standard. The Break character transmit consists of a Start bit, followed by twelve '0' bits and a Stop bit. The Frame Break character is sent whenever the SENDB and TXEN bits (TXSTA<3> and TXSTA<5>) are set while the Transmit Shift register is loaded with data. Note that the value of data written to TXREG1 will be ignored and all '0's will be transmitted.

The SENDB bit is automatically reset by hardware after the corresponding Stop bit is sent. This allows the user to preload the transmit FIFO with the next transmit byte following the Break character (typically, the Sync character in the LIN specification).

Note that the data value written to the TXREG1 for the Break character is ignored. The write simply serves the purpose of initiating the proper sequence.

The TRMT bit indicates when the transmit operation is active or Idle, just as it does during normal transmission. See Figure 18-10 for the timing of the Break character sequence.

18.3.5.1 Break and Sync Transmit Sequence

The following sequence will send a message frame header made up of a Break, followed by an Auto-Baud Sync byte. This sequence is typical of a LIN bus master.

- 1. Configure the EUSART for the desired mode.
- Set the TXEN and SENDB bits to set up the Break character.

- Load the TXREG1 with a dummy character to initiate transmission (the value is ignored).
- 4. Write '55h' to TXREG1 to load the Sync character into the transmit FIFO buffer.
- 5. After the Break has been sent, the SENDB bit is reset by hardware. The Sync character now transmits in the preconfigured mode.

When the TXREG1 becomes empty, as indicated by the TX1IF, the next data byte can be written to TXREG1.

18.3.6 RECEIVING A BREAK CHARACTER

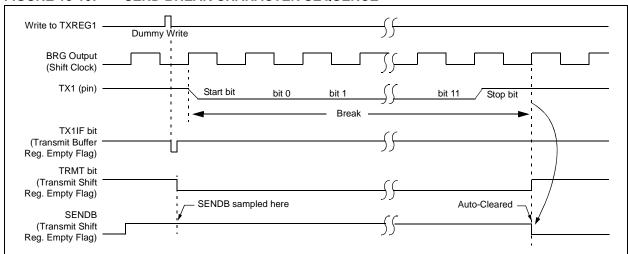
The Enhanced USART module can receive a Break character in two ways.

The first method forces configuration of the baud rate at a frequency of 9/13 the typical speed. This allows for the Stop bit transition to be at the correct sampling location (13 bits for Break versus Start bit and 8 data bits for typical data).

The second method uses the auto-wake-up feature described in **Section 18.3.4** "**Auto-Wake-up On Sync Break Character**". By enabling this feature, the EUSART will sample the next two transitions on RX1/DT1, cause an RC1IF interrupt and receive the next data byte followed by another interrupt.

Note that following a Break character, the user will typically want to enable the Auto-Baud Rate Detect feature. For both methods, the user can set the ABD bit once the TX1IF interrupt is observed.





18.4 EUSART Synchronous Master Mode

The Synchronous Master mode is entered by setting the CSRC bit (TXSTA<7>). In this mode, the data is transmitted in a half-duplex manner (i.e., transmission and reception do not occur at the same time). When transmitting data, the reception is inhibited and vice versa. Synchronous mode is entered by setting bit, SYNC (TXSTA<4>). In addition, enable bit, SPEN (RCSTA1<7>), is set in order to configure the TX1 and RX1 pins to CK1 (clock) and DT1 (data) lines, respectively.

The Master mode indicates that the processor transmits the master clock on the CK1 line. Clock polarity is selected with the SCKP bit (BAUDCON<4>). Setting SCKP sets the Idle state on CK1 as high, while clearing the bit sets the Idle state as low. This option is provided to support Microwire devices with this module.

18.4.1 EUSART SYNCHRONOUS MASTER TRANSMISSION

The EUSART transmitter block diagram is shown in Figure 18-3. The heart of the transmitter is the Transmit (Serial) Shift register (TSR). The Shift register obtains its data from the Read/Write Transmit Buffer register, TXREG1. The TXREG1 register is loaded with data in software. The TSR register is not loaded until the last bit has been transmitted from the previous load. As soon as the last bit is transmitted, the TSR is loaded with new data from the TXREG1 (if available).

Once the TXREG1 register transfers the data to the TSR register (occurs in one TCYCLE), the TXREG1 is empty and the TX1IF flag bit (PIR1<4>) is set. The interrupt can be enabled or disabled by setting or clearing the interrupt enable bit, TX1IE (PIE1<4>). TX1IF is set regardless of the state of enable bit TX1IE; it cannot be cleared in software. It will reset only when new data is loaded into the TXREG1 register.

While flag bit TX1IF indicates the status of the TXREG1 register, another bit, TRMT (TXSTA<1>), shows the status of the TSR register. TRMT is a read-only bit which is set when the TSR is empty. No interrupt logic is tied to this bit so the user has to poll this bit in order to determine if the TSR register is empty. The TSR is not mapped in data memory so it is not available to the user.

To set up a Synchronous Master Transmission:

- Initialize the SPBRGH1:SPBRG1 registers for the appropriate baud rate. Set or clear the BRG16 bit, as required, to achieve the desired baud rate.
- Enable the synchronous master serial port by setting bits, SYNC, SPEN and CSRC.
- 3. If interrupts are desired, set enable bit, TX1IE.
- 4. If 9-bit transmission is desired, set bit, TX9.
- 5. Enable the transmission by setting bit, TXEN.
- 6. If 9-bit transmission is selected, the ninth bit should be loaded in bit, TX9D.
- 7. Start transmission by loading data to the TXREG1 register.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

FIGURE 18-11: SYNCHRONOUS TRANSMISSION

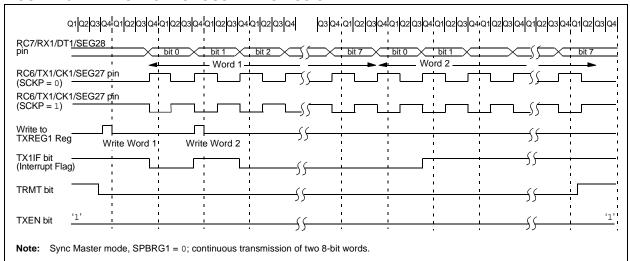


FIGURE 18-12: SYNCHRONOUS TRANSMISSION (THROUGH TXEN)

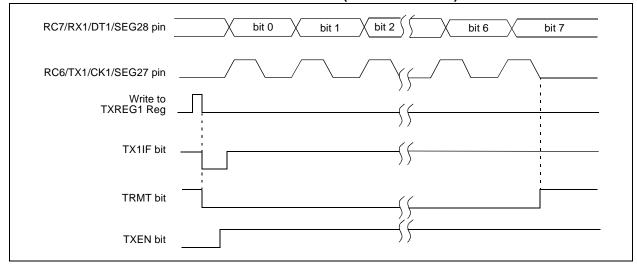


TABLE 18-7: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53
PIR1	_	ADIF	RC1IF	TX1IF	SSPIF	_	TMR2IF	TMR1IF	56
PIE1	_	ADIE	RC1IE	TX1IE	SSPIE	_	TMR2IE	TMR1IE	56
IPR1	_	ADIP	RC1IP	TX1IP	SSPIP	_	TMR2IP	TMR1IP	56
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	55
TXREG1	EUSART T	ransmit Reg	ister						55
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	55
BAUDCON1	ABDOVF	RCMT	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	57
SPBRGH1	EUSART Baud Rate Generator Register High Byte								57
SPBRG1	EUSART Baud Rate Generator Register Low Byte								55
LATG	U2OD	U10D	_	LATG4	LATG3	LATG2	LATG1	LATG0	56

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous master transmission.

18.4.2 EUSART SYNCHRONOUS MASTER RECEPTION

Once Synchronous mode is selected, reception is enabled by setting either the Single Receive Enable bit, SREN (RCSTA1<5>), or the Continuous Receive Enable bit, CREN (RCSTA1<4>). Data is sampled on the RX1 pin on the falling edge of the clock.

If enable bit, SREN, is set, only a single word is received. If enable bit, CREN, is set, the reception is continuous until CREN is cleared. If both bits are set, then CREN takes precedence.

To set up a Synchronous Master Reception:

- Initialize the SPBRGH1:SPBRG1 registers for the appropriate baud rate. Set or clear the BRG16 bit, as required, to achieve the desired baud rate.
- 2. Enable the synchronous master serial port by setting bits, SYNC, SPEN and CSRC.

- 3. Ensure bits, CREN and SREN, are clear.
- 4. If interrupts are desired, set enable bit, RC1IE.
- 5. If 9-bit reception is desired, set bit, RX9.
- 6. If a single reception is required, set bit, SREN. For continuous reception, set bit, CREN.
- Interrupt flag bit, RC1IF, will be set when reception is complete and an interrupt will be generated if the enable bit, RC1IE, was set.
- Read the RCSTA1 register to get the 9th bit (if enabled) and determine if any error occurred during reception.
- Read the 8-bit received data by reading the RCREG1 register.
- If any error occurred, clear the error by clearing bit, CREN.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

FIGURE 18-13: SYNCHRONOUS RECEPTION (MASTER MODE, SREN)

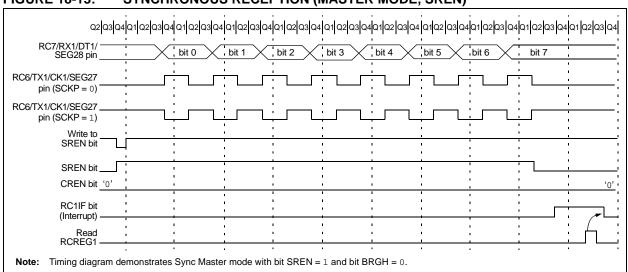


TABLE 18-8: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53	
PIR1	_	ADIF	RC1IF	TX1IF	SSPIF	_	TMR2IF	TMR1IF	56	
PIE1	_	ADIE	RC1IE	TX1IE	SSPIE	_	TMR2IE	TMR1IE	56	
IPR1	_	ADIP	RC1IP	TX1IP	SSPIP	_	TMR2IP	TMR1IP	56	
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	55	
RCREG1	EUSART R	eceive Regi	ster						55	
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	55	
BAUDCON1	ABDOVF	RCMT	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	57	
SPBRGH1	EUSART Baud Rate Generator Register High Byte									
SPBRG1	EUSART B	aud Rate Ge	enerator Re	gister Low E	Byte				55	

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous master reception.

18.5 EUSART Synchronous Slave Mode

Synchronous Slave mode is entered by clearing bit CSRC (TXSTA<7>). This mode differs from the Synchronous Master mode in that the shift clock is supplied externally at the CK1 pin (instead of being supplied internally in Master mode). This allows the device to transfer or receive data while in any low-power mode.

18.5.1 EUSART SYNCHRONOUS SLAVE TRANSMIT

The operation of the Synchronous Master and Slave modes are identical except in the case of the Sleep mode.

If two words are written to the TXREG1 and then the SLEEP instruction is executed, the following will occur:

- The first word will immediately transfer to the TSR register and transmit.
- b) The second word will remain in the TXREG1 register.
- c) Flag bit, TX1IF, will not be set.
- d) When the first word has been shifted out of TSR, the TXREG1 register will transfer the second word to the TSR and flag bit, TX1IF, will now be set.
- e) If enable bit, TX1IE, is set, the interrupt will wake the chip from Sleep. If the global interrupt is enabled, the program will branch to the interrupt vector.

To set up a Synchronous Slave Transmission:

- Enable the synchronous slave serial port by setting bits, SYNC and SPEN, and clearing bit, CSRC.
- 2. Clear bits, CREN and SREN.
- 3. If interrupts are desired, set enable bit, TX1IE.
- 4. If 9-bit transmission is desired, set bit, TX9.
- Enable the transmission by setting enable bit, TXEN.
- If 9-bit transmission is selected, the ninth bit should be loaded in bit, TX9D.
- 7. Start transmission by loading data to the TXREG1 register.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

TABLE 18-9: REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53	
PIR1	_	ADIF	RC1IF	TX1IF	SSPIF	_	TMR2IF	TMR1IF	56	
PIE1	_	ADIE	RC1IE	TX1IE	SSPIE	_	TMR2IE	TMR1IE	56	
IPR1	_	ADIP	RC1IP	TX1IP	SSPIP	_	TMR2IP	TMR1IP	56	
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	55	
TXREG1	EUSART T	ransmit Regi	ster						55	
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	55	
BAUDCON1	ABDOVF	RCMT	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	57	
SPBRGH1	EUSART B	Baud Rate Generator Register High Byte						57		
SPBRG1	EUSART B	USART Baud Rate Generator Register Low Byte								
LATG	U2OD	U1OD	_	LATG4	LATG3	LATG2	LATG1	LATG0	56	

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous slave transmission.

18.5.2 EUSART SYNCHRONOUS SLAVE RECEPTION

The operation of the Synchronous Master and Slave modes is identical except in the case of Sleep or any Idle mode, and bit SREN, which is a "don't care" in Slave mode.

If receive is enabled by setting the CREN bit prior to entering Sleep or any Idle mode, then a word may be received while in this low-power mode. Once the word is received, the RSR register will transfer the data to the RCREG1 register; if the RC1IE enable bit is set, the interrupt generated will wake the chip from the low-power mode. If the global interrupt is enabled, the program will branch to the interrupt vector.

To set up a Synchronous Slave Reception:

- Enable the synchronous master serial port by setting bits, SYNC and SPEN, and clearing bit, CSRC.
- 2. If interrupts are desired, set enable bit, RC1IE.
- 3. If 9-bit reception is desired, set bit, RX9.
- 4. To enable reception, set enable bit, CREN.
- Flag bit, RC1IF, will be set when reception is complete. An interrupt will be generated if enable bit, RC1IE, was set.
- 6. Read the RCSTA1 register to get the 9th bit (if enabled) and determine if any error occurred during reception.
- Read the 8-bit received data by reading the RCREG1 register.
- If any error occurred, clear the error by clearing bit, CREN.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

TABLE 18-10: REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53	
PIR1	_	ADIF	RC1IF	TX1IF	SSPIF	_	TMR2IF	TMR1IF	56	
PIE1	_	ADIE	RC1IE	TX1IE	SSPIE	_	TMR2IE	TMR1IE	56	
IPR1	_	ADIP	RC1IP	TX1IP	SSPIP	1	TMR2IP	TMR1IP	56	
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	55	
RCREG1	EUSART R	Receive Regi	ster						55	
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	55	
BAUDCON1	ABDOVF	RCMT	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	57	
SPBRGH1	EUSART Baud Rate Generator Register High Byte									
SPBRG1	EUSART B	aud Rate G	enerator Re	gister Low I	3yte				55	

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous slave reception.

19.0 ADDRESSABLE UNIVERSAL SYNCHRONOUS ASYNCHRONOUS RECEIVER TRANSMITTER (AUSART)

The Addressable Universal Synchronous Asynchronous Receiver Transmitter (AUSART) module is very similar in function to the Enhanced USART module, discussed in the previous chapter. It is provided as an additional channel for serial communication with external devices, for those situations that do not require auto-baud detection or LIN bus support.

The AUSART can be configured in the following modes:

- Asynchronous (full-duplex)
- Synchronous Master (half-duplex)
- Synchronous Slave (half-duplex)

The pins of the AUSART module are multiplexed with the functions of PORTG (RG1/TX2/CK2 and RG2/RX2/DT2/VLCAP1, respectively). In order to configure these pins as an AUSART:

- bit SPEN (RCSTA2<7>) must be set (= 1)
- bit TRISG<2> must be set (= 1)
- bit TRISG<1> must be cleared (= 0) for Asynchronous and Synchronous Master modes
- bit TRISG<1> must be set (= 1) for Synchronous Slave mode

Note: The AUSART control will automatically reconfigure the pin from input to output as needed.

The driver for the TX2 output pin can also be optionally configured as an open-drain output. This feature allows the voltage level on the pin to be pulled to a higher level through an external pull-up resistor, and allows the output to communicate with external circuits without the need for additional level shifters.

The open-drain output option is controlled by the U2OD bit (LATG<7>). Setting the bit configures the pin for open-drain operation.

19.1 Control Registers

The operation of the Addressable USART module is controlled through two registers, TXSTA2 and RXSTA2. These are detailed in Register 19-1 and Register 19-2, respectively.

REGISTER 19-1: TXSTA2: AUSART TRANSMIT STATUS AND CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R-1	R/W-0
CSRC	TX9	TXEN ⁽¹⁾	SYNC	_	BRGH	TRMT	TX9D
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 CSRC: Clock Source Select bit

Asynchronous mode:

Don't care.

Synchronous mode:

1 = Master mode (clock generated internally from BRG)

0 = Slave mode (clock from external source)

bit 6 **TX9:** 9-Bit Transmit Enable bit

1 = Selects 9-bit transmission0 = Selects 8-bit transmission

bit 5 **TXEN:** Transmit Enable bit⁽¹⁾

1 = Transmit enabled

0 = Transmit disabled

bit 4 SYNC: AUSART Mode Select bit

1 = Synchronous mode

0 = Asynchronous mode

bit 3 **Unimplemented:** Read as '0'

bit 2 BRGH: High Baud Rate Select bit

Asynchronous mode:

1 = High speed

0 = Low speed

Synchronous mode:

Unused in this mode.

bit 1 TRMT: Transmit Shift Register Status bit

1 = TSR empty

0 = TSR full

bit 0 **TX9D:** 9th bit of Transmit Data

Can be address/data bit or a parity bit.

Note 1: SREN/CREN overrides TXEN in Sync mode.

REGISTER 19-2: RCSTA2: AUSART RECEIVE STATUS AND CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0	R-x
SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 SPEN: Serial Port Enable bit

1 = Serial port enabled (configures RX2/DT2 and TX2/CK2 pins as serial port pins)

0 = Serial port disabled (held in Reset)

bit 6 **RX9:** 9-Bit Receive Enable bit

1 = Selects 9-bit reception0 = Selects 8-bit reception

bit 5 SREN: Single Receive Enable bit

Asynchronous mode:

Don't care.

Synchronous mode - Master:

1 = Enables single receive

0 = Disables single receive

This bit is cleared after reception is complete.

Synchronous mode - Slave:

Don't care.

bit 4 CREN: Continuous Receive Enable bit

Asynchronous mode:

1 = Enables receiver

0 = Disables receiver

Synchronous mode:

1 = Enables continuous receive until enable bit, CREN, is cleared (CREN overrides SREN)

0 = Disables continuous receive

bit 3 ADDEN: Address Detect Enable bit

Asynchronous mode 9-bit (RX9 = 1):

1 = Enables address detection, enables interrupt and loads the receive buffer when RSR<8> is set

0 = Disables address detection, all bytes are received and ninth bit can be used as parity bit

Asynchronous mode 9-bit (RX9 = 0):

Don't care.

bit 2 FERR: Framing Error bit

1 = Framing error (can be updated by reading RCREG2 register and receiving next valid byte)

0 = No framing error

bit 1 OERR: Overrun Error bit

1 = Overrun error (can be cleared by clearing bit CREN)

0 = No overrun error

bit 0 RX9D: 9th bit of Received Data

This can be address/data bit or a parity bit and must be calculated by user firmware.

19.2 AUSART Baud Rate Generator (BRG)

The BRG is a dedicated, 8-bit generator that supports both the Asynchronous and Synchronous modes of the AUSART.

The SPBRG2 register controls the period of a free-running timer. In Asynchronous mode, bit BRGH (TXSTA<2>) also controls the baud rate. In Synchronous mode, BRGH is ignored. Table 19-1 shows the formula for computation of the baud rate for different AUSART modes, which only apply in Master mode (internally generated clock).

Given the desired baud rate and Fosc, the nearest integer value for the SPBRG2 register can be calculated using the formulas in Table 19-1. From this, the error in baud rate can be determined. An example calculation is shown in Example 19-1. Typical baud rates and error values for the various Asynchronous modes are shown in Table 19-2. It may be advantageous to use the high baud rate (BRGH = 1) to reduce the baud rate error, or achieve a slow baud rate for a fast oscillator frequency.

Writing a new value to the SPBRG2 register causes the BRG timer to be reset (or cleared). This ensures the BRG does not wait for a timer overflow before outputting the new baud rate.

19.2.1 OPERATION IN POWER-MANAGED MODES

The device clock is used to generate the desired baud rate. When one of the power-managed modes is entered, the new clock source may be operating at a different frequency. This may require an adjustment to the value in the SPBRG2 register.

19.2.2 SAMPLING

The data on the RX2 pin is sampled three times by a majority detect circuit to determine if a high or a low level is present at the RX2 pin.

TABLE 19-1: BAUD RATE FORMULAS

Configu	ration Bits	BRG/AUSART Mode	Poud Pata Formula		
SYNC	BRGH	BRG/AUSART Mode	Baud Rate Formula		
0	0	Asynchronous	Fosc/[64 (n + 1)]		
0	1	Asynchronous	Fosc/[16 (n + 1)]		
1	х	Synchronous	Fosc/[4 (n + 1)]		

Legend: x = Don't care, n = Value of SPBRG2 register

EXAMPLE 19-1: CALCULATING BAUD RATE ERROR

For a device with Fosc of 16 MHz, desired baud rate of 9600, Asynchronous mode, BRGH = 0:

Desired Baud Rate = Fosc/(64 ([SPBRG2] + 1))

Solving for SPBRG2:

X = ((Fosc/Desired Baud Rate)/64) - 1

= ((16000000/9600)/64) - 1

= [25.042] = 25

Calculated Baud Rate = 16000000/(64(25+1))

= 9615

Error = (Calculated Baud Rate – Desired Baud Rate)/Desired Baud Rate

= (9615 - 9600)/9600 = 0.16%

TABLE 19-2: REGISTERS ASSOCIATED WITH THE BAUD RATE GENERATOR

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page
TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	58
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	58
SPBRG2	AUSART Baud Rate Generator Register								

Legend: Shaded cells are not used by the BRG.

TABLE 19-3: BAUD RATES FOR ASYNCHRONOUS MODES

						BRG	H = 0					
	Fosc	= 40.000) MHz	Fosc = 20.000 MHz			Fosc = 10.000 MHz			Fosc = 8.000 MHz		
BAUD RATE (K)	Actual Rate (K)	% Error	SPBRG value (decimal)									
0.3	_		_	_		_	_	_	_	_	_	_
1.2	_	_	_	1.221	1.73	255	1.202	0.16	129	1.201	-0.16	103
2.4	2.441	1.73	255	2.404	0.16	129	2.404	0.16	64	2.403	-0.16	51
9.6	9.615	0.16	64	9.766	1.73	31	9.766	1.73	15	9.615	-0.16	12
19.2	19.531	1.73	31	19.531	1.73	15	19.531	1.73	7	_	_	_
57.6	56.818	-1.36	10	62.500	8.51	4	52.083	-9.58	2	_	_	_
115.2	125.000	8.51	4	104.167	-9.58	2	78.125	-32.18	1	_	_	_

				I	BRGH =	0			
	Fosc = 4.000 MHz			Fos	c = 2.000	MHz	Fosc = 1.000 MHz		
BAUD RATE (K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)
0.3	0.300	0.16	207	0.300	-0.16	103	0.300	-0.16	51
1.2	1.202	0.16	51	1.201	-0.16	25	1.201	-0.16	12
2.4	2.404	0.16	25	2.403	-0.16	12	_	_	_
9.6	8.929	-6.99	6	_	_	_	_	_	_
19.2	20.833	8.51	2	_	_	_	_	_	_
57.6	62.500	8.51	0	_	_	_	_	_	_
115.2	62.500	-45.75	0	_	_	_	_	_	_

						BRG	H = 1					
BAUD RATE	Fosc	= 40.000) MHz	Fosc = 20.000 MHz			Fosc = 10.000 MHz			Fosc = 8.000 MHz		
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)									
0.3	_		_	_	_	_	_	_	_	_	_	_
1.2	_	_	_	_	_	_	_	_	_	_	_	_
2.4	_	_	_	_	_	_	2.441	1.73	255	2.403	-0.16	207
9.6	9.766	1.73	255	9.615	0.16	129	9.615	0.16	64	9.615	-0.16	51
19.2	19.231	0.16	129	19.231	0.16	64	19.531	1.73	31	19.230	-0.16	25
57.6	58.140	0.94	42	56.818	-1.36	21	56.818	-1.36	10	55.555	3.55	8
115.2	113.636	-1.36	21	113.636	-1.36	10	125.000	8.51	4	_	_	_

					BRGH =	1			
BAUD RATE	Fosc	c = 4.000	MHz	Fosc = 2.000 MHz			Fosc = 1.000 MHz		
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)
0.3	_	_	_	_	_	_	0.300	-0.16	207
1.2	1.202	0.16	207	1.201	-0.16	103	1.201	-0.16	51
2.4	2.404	0.16	103	2.403	-0.16	51	2.403	-0.16	25
9.6	9.615	0.16	25	9.615	-0.16	12	_	_	_
19.2	19.231	0.16	12	_	_	_	_	_	_
57.6	62.500	8.51	3	_	_	_	_	_	_
115.2	125.000	8.51	1	_	_	_	_	_	_

19.3 AUSART Asynchronous Mode

The Asynchronous mode of operation is selected by clearing the SYNC bit (TXSTA2<4>). In this mode, the AUSART uses standard Non-Return-to-Zero (NRZ) format (one Start bit, eight or nine data bits and one Stop bit). The most common data format is 8 bits. An on-chip, dedicated, 8-bit Baud Rate Generator can be used to derive standard baud rate frequencies from the oscillator.

The AUSART transmits and receives the LSb first. The AUSART's transmitter and receiver are functionally independent but use the same data format and baud rate. The Baud Rate Generator produces a clock, either x16 or x64 of the bit shift rate, depending on the BRGH bit (TXSTA2<2>). Parity is not supported by the hardware but can be implemented in software and stored as the 9th data bit.

When operating in Asynchronous mode, the AUSART module consists of the following important elements:

- · Baud Rate Generator
- Sampling Circuit
- · Asynchronous Transmitter
- · Asynchronous Receiver

19.3.1 AUSART ASYNCHRONOUS TRANSMITTER

The AUSART transmitter block diagram is shown in Figure 19-1. The heart of the transmitter is the Transmit (Serial) Shift register (TSR). The Shift register obtains its data from the Read/Write Transmit Buffer register, TXREG2. The TXREG2 register is loaded with data in software. The TSR register is not loaded until the Stop bit has been transmitted from the previous load. As soon as the Stop bit is transmitted, the TSR is loaded with new data from the TXREG2 register (if available).

Once the TXREG2 register transfers the data to the TSR register (occurs in one Tcy), the TXREG2 register is empty and the TX2IF flag bit (PIR3<4>) is set. This interrupt can be enabled or disabled by setting or clearing the interrupt enable bit, TX2IE (PIE3<4>). TX2IF will be set regardless of the state of TX2IE; it cannot be cleared in software. TX2IF is also not cleared immediately upon loading TXREG2, but becomes valid in the second instruction cycle following the load instruction. Polling TX2IF immediately following a load of TXREG2 will return invalid results.

While TX2IF indicates the status of the TXREG2 register, another bit, TRMT (TXSTA2<1>), shows the status of the TSR register. TRMT is a read-only bit which is set when the TSR register is empty. No interrupt logic is tied to this bit so the user has to poll this bit in order to determine if the TSR register is empty.

- **Note 1:** The TSR register is not mapped in data memory so it is not available to the user.
 - 2: Flag bit, TX2IF, is set when enable bit, TXEN, is set.

To set up an Asynchronous Transmission:

- Initialize the SPBRG2 register for the appropriate baud rate. Set or clear the BRGH bit, as required, to achieve the desired baud rate.
- Enable the asynchronous serial port by clearing bit, SYNC, and setting bit, SPEN.
- 3. If interrupts are desired, set enable bit, TX2IE.
- 4. If 9-bit transmission is desired, set transmit bit, TX9. Can be used as address/data bit.
- Enable the transmission by setting bit, TXEN, which will also set bit, TX2IF.
- If 9-bit transmission is selected, the ninth bit should be loaded in bit, TX9D.
- Load data to the TXREG2 register (starts transmission).
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

FIGURE 19-1: AUSART TRANSMIT BLOCK DIAGRAM

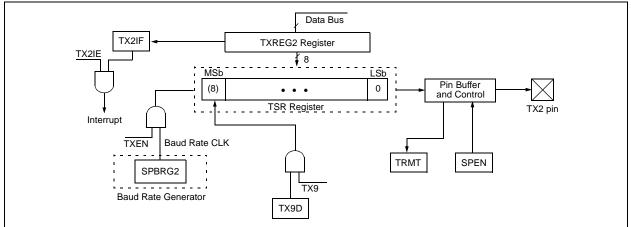


FIGURE 19-2: ASYNCHRONOUS TRANSMISSION

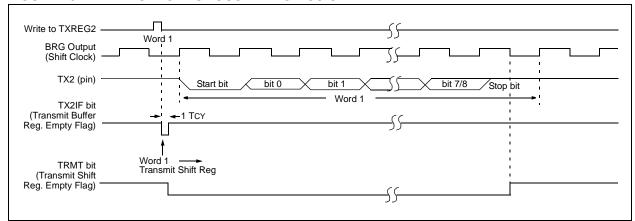


FIGURE 19-3: ASYNCHRONOUS TRANSMISSION (BACK TO BACK)

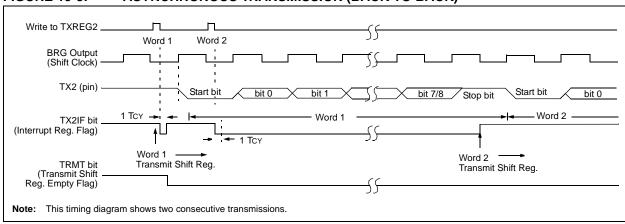


TABLE 19-4: REGISTERS ASSOCIATED WITH ASYNCHRONOUS TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53	
PIR3	_	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	56	
PIE3	_	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	56	
IPR3	_	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	56	
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	58	
TXREG2	AUSART T	ransmit Reg	jister						58	
TXSTA2	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	58	
SPBRG2	AUSART B	AUSART Baud Rate Generator Register								
LATG	U2OD	U1OD	_	LATG4	LATG3	LATG2	LATG1	LATG0	56	

Legend: — = unimplemented locations read as '0'. Shaded cells are not used for asynchronous transmission.

19.3.2 AUSART ASYNCHRONOUS RECEIVER

The receiver block diagram is shown in Figure 19-4. The data is received on the RX2 pin and drives the data recovery block. The data recovery block is actually a high-speed shifter operating at x16 times the baud rate, whereas the main receive serial shifter operates at the bit rate or at Fosc. This mode would typically be used in RS-232 systems.

To set up an Asynchronous Reception:

- 1. Initialize the SPBRG2 register for the appropriate baud rate. Set or clear the BRGH bit, as required, to achieve the desired baud rate.
- Enable the asynchronous serial port by clearing bit, SYNC, and setting bit, SPEN.
- 3. If interrupts are desired, set enable bit, RC2IE.
- 4. If 9-bit reception is desired, set bit, RX9.
- 5. Enable the reception by setting bit, CREN.
- Flag bit, RC2IF, will be set when reception is complete and an interrupt will be generated if enable bit, RC2IE, was set.
- Read the RCSTA2 register to get the 9th bit (if enabled) and determine if any error occurred during reception.
- Read the 8-bit received data by reading the RCREG2 register.
- If any error occurred, clear the error by clearing enable bit, CREN.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

19.3.3 SETTING UP 9-BIT MODE WITH ADDRESS DETECT

This mode would typically be used in RS-485 systems. To set up an Asynchronous Reception with Address Detect Enable:

- Initialize the SPBRG2 register for the appropriate baud rate. Set or clear the BRGH and BRG16 bits, as required, to achieve the desired baud rate.
- Enable the asynchronous serial port by clearing the SYNC bit and setting the SPEN bit.
- If interrupts are required, set the RCEN bit and select the desired priority level with the RC2IP bit
- 4. Set the RX9 bit to enable 9-bit reception.
- 5. Set the ADDEN bit to enable address detect.
- 6. Enable reception by setting the CREN bit.
- The RC2IF bit will be set when reception is complete. The interrupt will be Acknowledged if the RC2IE and GIE bits are set.
- 8. Read the RCSTA2 register to determine if any error occurred during reception, as well as read bit 9 of data (if applicable).
- Read RCREG2 to determine if the device is being addressed.
- 10. If any error occurred, clear the CREN bit.
- 11. If the device has been addressed, clear the ADDEN bit to allow all received data into the receive buffer and interrupt the CPU.

FIGURE 19-4: AUSART RECEIVE BLOCK DIAGRAM

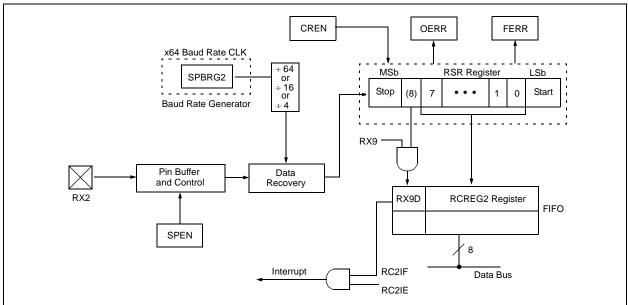


FIGURE 19-5: ASYNCHRONOUS RECEPTION

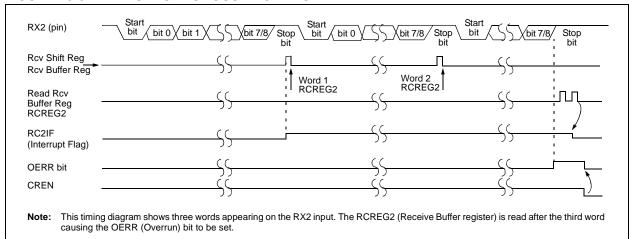


TABLE 19-5: REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page		
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53		
PIR3	_	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	56		
PIE3	_	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	56		
IPR3	_	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	56		
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	58		
RCREG2	AUSART R	AUSART Receive Register									
TXSTA2	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	58		
SPBRG2	AUSART E	JSART Baud Rate Generator Register									

Legend: — = unimplemented locations read as '0'. Shaded cells are not used for asynchronous reception.

19.4 AUSART Synchronous Master Mode

The Synchronous Master mode is entered by setting the CSRC bit (TXSTA2<7>). In this mode, the data is transmitted in a half-duplex manner (i.e., transmission and reception do not occur at the same time). When transmitting data, the reception is inhibited and vice versa. Synchronous mode is entered by setting bit, SYNC (TXSTA2<4>). In addition, enable bit, SPEN (RCSTA2<7>), is set in order to configure the TX2 and RX2 pins to CK2 (clock) and DT2 (data) lines, respectively.

The Master mode indicates that the processor transmits the master clock on the CK2 line.

19.4.1 AUSART SYNCHRONOUS MASTER TRANSMISSION

The AUSART transmitter block diagram is shown in Figure 19-1. The heart of the transmitter is the Transmit (Serial) Shift register (TSR). The Shift register obtains its data from the Read/Write Transmit Buffer register, TXREG2. The TXREG2 register is loaded with data in software. The TSR register is not loaded until the last bit has been transmitted from the previous load. As soon as the last bit is transmitted, the TSR is loaded with new data from the TXREG2 (if available).

Once the TXREG2 register transfers the data to the TSR register (occurs in one TCYCLE), the TXREG2 is empty and the TX2IF flag bit (PIR3<4>) is set. The interrupt can be enabled or disabled by setting or clearing the interrupt enable bit, TX2IE (PIE3<4>). TX2IF is set regardless of the state of enable bit, TX2IE; it cannot be cleared in software. It will reset only when new data is loaded into the TXREG2 register.

While flag bit, TX2IF, indicates the status of the TXREG2 register, another bit, TRMT (TXSTA2<1>), shows the status of the TSR register. TRMT is a read-only bit which is set when the TSR is empty. No interrupt logic is tied to this bit so the user has to poll this bit in order to determine if the TSR register is empty. The TSR is not mapped in data memory so it is not available to the user.

To set up a Synchronous Master Transmission:

- Initialize the SPBRG2 register for the appropriate baud rate.
- Enable the synchronous master serial port by setting bits, SYNC, SPEN and CSRC.
- 3. If interrupts are desired, set enable bit, TX2IE.
- 4. If 9-bit transmission is desired, set bit, TX9.
- Enable the transmission by setting bit, TXEN.
- If 9-bit transmission is selected, the ninth bit should be loaded in bit, TX9D.
- 7. Start transmission by loading data to the TXREG2 register.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

FIGURE 19-6: SYNCHRONOUS TRANSMISSION

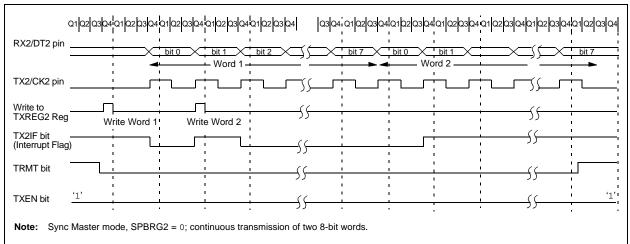


FIGURE 19-7: SYNCHRONOUS TRANSMISSION (THROUGH TXEN)

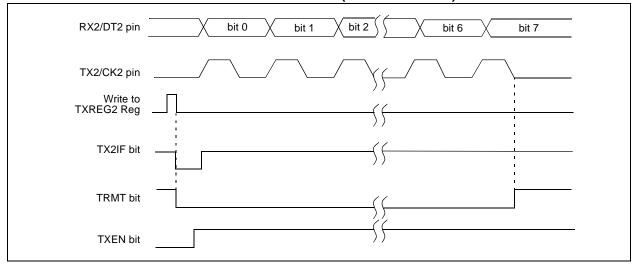


TABLE 19-6: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53
PIR3	_	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	56
PIE3	_	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	56
IPR3	_	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	56
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	58
TXREG2	AUSART T	ransmit Reg	ister						58
TXSTA2	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	58
SPBRG2	AUSART E	AUSART Baud Rate Generator Register							
LATG	U2OD	U1OD	_	LATG4	LATG3	LATG2	LATG1	LATG0	56

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous master transmission.

19.4.2 AUSART SYNCHRONOUS MASTER RECEPTION

Once Synchronous mode is selected, reception is enabled by setting either the Single Receive Enable bit, SREN (RCSTA2<5>), or the Continuous Receive Enable bit, CREN (RCSTA2<4>). Data is sampled on the RX2 pin on the falling edge of the clock.

If enable bit, SREN, is set, only a single word is received. If enable bit, CREN, is set, the reception is continuous until CREN is cleared. If both bits are set, then CREN takes precedence.

To set up a Synchronous Master Reception:

- Initialize the SPBRG2 register for the appropriate baud rate.
- 2. Enable the synchronous master serial port by setting bits, SYNC, SPEN and CSRC.
- 3. Ensure bits, CREN and SREN, are clear.

- 4. If interrupts are desired, set enable bit, RC2IE.
- 5. If 9-bit reception is desired, set bit, RX9.
- 6. If a single reception is required, set bit, SREN. For continuous reception, set bit, CREN.
- 7. Interrupt flag bit, RC2IF, will be set when reception is complete and an interrupt will be generated if the enable bit, RC2IE, was set.
- Read the RCSTA2 register to get the 9th bit (if enabled) and determine if any error occurred during reception.
- Read the 8-bit received data by reading the RCREG2 register.
- If any error occurred, clear the error by clearing bit, CREN.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

FIGURE 19-8: SYNCHRONOUS RECEPTION (MASTER MODE, SREN)

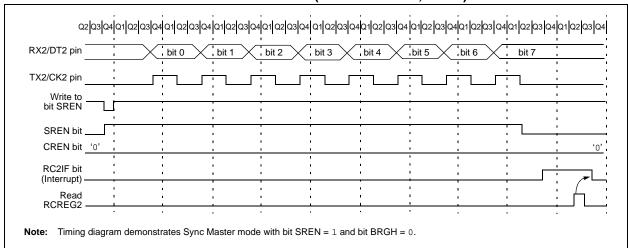


TABLE 19-7: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53	
PIR3	_	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	56	
PIE3	_	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	56	
IPR3	_	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	56	
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	58	
RCREG2	AUSART Receive Register									
TXSTA2	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	58	
SPBRG2	AUSART Baud Rate Generator Register									

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous master reception.

19.5 AUSART Synchronous Slave Mode

Synchronous Slave mode is entered by clearing bit, CSRC (TXSTA2<7>). This mode differs from the Synchronous Master mode in that the shift clock is supplied externally at the CK2 pin (instead of being supplied internally in Master mode). This allows the device to transfer or receive data while in any low-power mode.

19.5.1 AUSART SYNCHRONOUS SLAVE TRANSMIT

The operation of the Synchronous Master and Slave modes are identical except in the case of the Sleep mode.

If two words are written to the TXREG2 and then the SLEEP instruction is executed, the following will occur:

- The first word will immediately transfer to the TSR register and transmit.
- b) The second word will remain in TXREG2 register.
- c) Flag bit, TX2IF, will not be set.
- d) When the first word has been shifted out of TSR, the TXREG2 register will transfer the second word to the TSR and flag bit, TX2IF, will now be set.
- e) If enable bit, TX2IE, is set, the interrupt will wake the chip from Sleep. If the global interrupt is enabled, the program will branch to the interrupt vector.

To set up a Synchronous Slave Transmission:

- Enable the synchronous slave serial port by setting bits, SYNC and SPEN, and clearing bit, CSRC.
- 2. Clear bits, CREN and SREN.
- 3. If interrupts are desired, set enable bit, TX2IE.
- 4. If 9-bit transmission is desired, set bit, TX9.
- Enable the transmission by setting enable bit, TXEN.
- If 9-bit transmission is selected, the ninth bit should be loaded in bit, TX9D.
- Start transmission by loading data to the TXREG2 register.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

TABLE 19-8: REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53	
PIR3	_	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	56	
PIE3	_	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	56	
IPR3	_	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	56	
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	58	
TXREG2	AUSART T	ransmit Regi	ster						58	
TXSTA2	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	58	
SPBRG2	AUSART B	AUSART Baud Rate Generator Register								
LATG	U2OD	U1OD	_	LATG4	LATG3	LATG2	LATG1	LATG0	56	

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous slave transmission.

19.5.2 AUSART SYNCHRONOUS SLAVE RECEPTION

The operation of the Synchronous Master and Slave modes is identical except in the case of Sleep or any Idle mode, and bit SREN, which is a "don't care" in Slave mode.

If receive is enabled by setting the CREN bit prior to entering Sleep, or any Idle mode, then a word may be received while in this low-power mode. Once the word is received, the RSR register will transfer the data to the RCREG2 register; if the RC2IE enable bit is set, the interrupt generated will wake the chip from low-power mode. If the global interrupt is enabled, the program will branch to the interrupt vector.

To set up a Synchronous Slave Reception:

- Enable the synchronous master serial port by setting bits, SYNC and SPEN, and clearing bit, CSRC.
- 2. If interrupts are desired, set enable bit, RC2IE.
- 3. If 9-bit reception is desired, set bit, RX9.
- 4. To enable reception, set enable bit, CREN.
- 5. Flag bit, RC2IF, will be set when reception is complete. An interrupt will be generated if enable bit, RC2IE, was set.
- 6. Read the RCSTA2 register to get the 9th bit (if enabled) and determine if any error occurred during reception.
- Read the 8-bit received data by reading the RCREG2 register.
- If any error occurred, clear the error by clearing bit, CREN.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

TABLE 19-9: REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page		
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53		
PIR3	_	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	56		
PIE3	_	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	56		
IPR3	_	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	56		
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	58		
RCREG2	AUSART R	AUSART Receive Register									
TXSTA2	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	58		
SPBRG2	AUSART B	USART Baud Rate Generator Register									

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous slave reception.

20.0 10-BIT ANALOG-TO-DIGITAL CONVERTER (A/D) MODULE

The Analog-to-Digital (A/D) converter module has 12 inputs for all PIC18F87J90 family devices. This module allows conversion of an analog input signal to a corresponding 10-bit digital number.

The module has five registers:

- A/D Result High Register (ADRESH)
- A/D Result Low Register (ADRESL)
- A/D Control Register 0 (ADCON0)
- A/D Control Register 1 (ADCON1)
- A/D Control Register 2 (ADCON2)

The ADCON0 register, shown in Register 20-1, controls the operation of the A/D module. The ADCON1 register, shown in Register 20-2, configures the functions of the port pins. The ADCON2 register, shown in Register 20-3, configures the A/D clock source, programmed acquisition time and justification.

REGISTER 20-1: ADCON0: A/D CONTROL REGISTER 0

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADCAL	_	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 ADCAL: A/D Calibration bit

1 = Calibration is performed on next A/D conversion

0 = Normal A/D converter operation (no calibration is performed)

bit 6 **Unimplemented:** Read as '0'

bit 5-2 CHS<3:0>: Analog Channel Select bits

0000 = Channel 00 (AN0)

0001 = Channel 01 (AN1)

0010 = Channel 02 (AN2)

0011 = Channel 03 (AN3)

0100 = Channel 04 (AN4)

0101 = Channel 05 (AN5)

0110 = Channel 06 (AN6)

0111 = Channel 07 (AN7)

1000 = Channel 08 (AN8)

1001 = Channel 09 (AN9) 1010 = Channel 10 (AN10)

1011 = Channel 11 (AN11)

11xx = Unused

bit 1 GO/DONE: A/D Conversion Status bit

When ADON = 1:

1 = A/D conversion in progress

0 = A/D Idle

bit 0 **ADON:** A/D On bit

1 = A/D converter module is enabled 0 = A/D converter module is disabled

REGISTER 20-2: ADCON1: A/D CONTROL REGISTER 1

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
TRIGSEL	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 TRIGSEL: Special Trigger Select bit

1 = Selects the special trigger from the CTMU0 = Selects the special trigger from the CCP2

bit 6 **Unimplemented:** Read as '0'

bit 5 **VCFG1:** Voltage Reference Configuration bit (VREF- source)

1 = VREF- (AN2)

0 = AVss

bit 4 VCFG0: Voltage Reference Configuration bit (VREF+ source)

1 = VREF+ (AN3)

0 = AVDD

bit 3-0 **PCFG<3:0>:** A/D Port Configuration Control bits:

PCFG<3:0>	AN11	AN10	AN9	AN8	AN7	AN6	AN5	AN4	AN3	AN2	AN1	AN0
0000	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0001	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0010	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0011	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0100	D	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0101	D	D	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0110	D	D	D	Α	Α	Α	Α	Α	Α	Α	Α	Α
0111	D	D	D	D	Α	Α	Α	Α	Α	Α	Α	Α
1000	D	D	D	D	D	Α	Α	Α	Α	Α	Α	Α
1001	D	D	D	D	D	D	Α	Α	Α	Α	Α	Α
1010	D	D	D	D	D	D	D	Α	Α	Α	Α	Α
1011	D	D	D	D	D	D	D	D	Α	Α	Α	Α
1100	D	D	D	D	D	D	D	D	D	Α	Α	Α
1101	D	D	D	D	D	D	D	D	D	D	Α	Α
1110	D	D	D	D	D	D	D	D	D	D	D	Α
1111	D	D	D	D	D	D	D	D	D	D	D	D

A = Analog input

D = Digital I/O

REGISTER 20-3: ADCON2: A/D CONTROL REGISTER 2

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADFM	_	ACQT2	ACQT1	ACQT0	ADCS2	ADCS1	ADCS0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 ADFM: A/D Result Format Select bit

1 = Right justified

0 = Left justified

bit 6 **Unimplemented:** Read as '0'

bit 5-3 ACQT<2:0>: A/D Acquisition Time Select bits

111 = 20 TAD

110 = 16 TAD

101 = **12** TAD

100 = 8 TAD

011 = 6 TAD

010 = 4 TAD

001 = 2 TAD

 $000 = 0 \text{ TAD}^{(1)}$

bit 2-0 ADCS<2:0>: A/D Conversion Clock Select bits

111 = FRC (clock derived from A/D RC oscillator)(1)

110 = Fosc/64

101 = Fosc/16

100 = Fosc/4

011 = FRC (clock derived from A/D RC oscillator)⁽¹⁾

010 = Fosc/32

001 = Fosc/8

000 = Fosc/2

Note 1: If the A/D FRC clock source is selected, a delay of one Tcy (instruction cycle) is added before the A/D clock starts. This allows the SLEEP instruction to be executed before starting a conversion.

The analog reference voltage is software selectable to either the device's positive and negative supply voltage (AVDD and AVSS), or the voltage level on the RA3/AN3/VREF+ and RA2/AN2/VREF- pins.

The A/D converter has a unique feature of being able to operate while the device is in Sleep mode. To operate in Sleep, the A/D conversion clock must be derived from the A/D's internal RC oscillator.

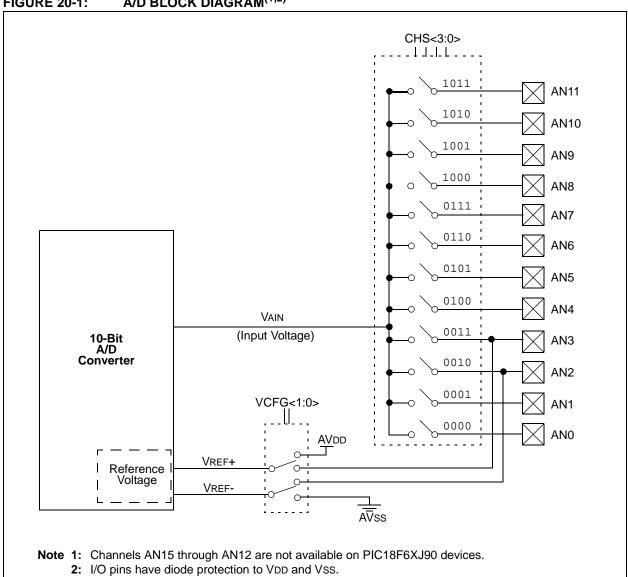
The output of the sample and hold is the input into the converter, which generates the result via successive approximation.

Each port pin associated with the A/D converter can be configured as an analog input or as a digital I/O. The ADRESH and ADRESL registers contain the result of the A/D conversion. When the A/D conversion is complete, the result is loaded into the ADRESH:ADRESL register pair, the GO/DONE bit (ADCON0<1>) is cleared and A/D Interrupt Flag bit, ADIF, is set.

A device Reset forces all registers to their Reset state. This forces the A/D module to be turned off and any conversion in progress is aborted. The value in the ADRESH:ADRESL register pair is not modified for a Power-on Reset. These registers will contain unknown data after a Power-on Reset.

The block diagram of the A/D module is shown in Figure 20-1.

A/D BLOCK DIAGRAM^(1,2) **FIGURE 20-1:**



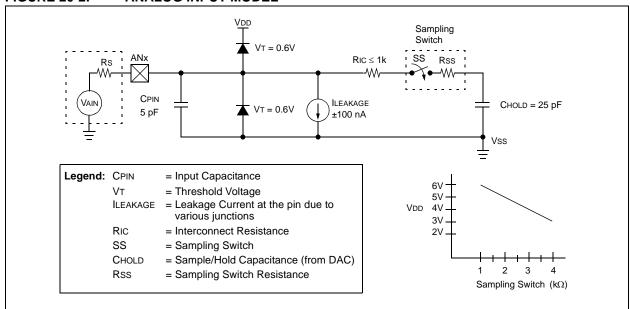
After the A/D module has been configured as desired, the selected channel must be acquired before the conversion is started. The analog input channels must have their corresponding TRIS bits selected as an input. To determine acquisition time, see **Section 20.1** "A/D Acquisition Requirements". After this acquisition time has elapsed, the A/D conversion can be started. An acquisition time can be programmed to occur between setting the GO/DONE bit and the actual start of the conversion.

The following steps should be followed to do an A/D conversion:

- 1. Configure the A/D module:
 - Configure analog pins, voltage reference and digital I/O (ADCON1)
 - Select A/D input channel (ADCON0)
 - Select A/D acquisition time (ADCON2)
 - Select A/D conversion clock (ADCON2)
 - Turn on A/D module (ADCON0)
- 2. Configure A/D interrupt (if desired):
 - · Clear ADIF bit
 - · Set ADIE bit
 - · Set GIE bit

- 3. Wait the required acquisition time (if required).
- 4. Start conversion:
 - Set GO/DONE bit (ADCON0<1>)
- 5. Wait for A/D conversion to complete, by either:
 - Polling for the GO/DONE bit to be cleared OR
 - Waiting for the A/D interrupt
- Read A/D Result registers (ADRESH:ADRESL); clear ADIF bit, if required.
- 7. For next conversion, go to step 1 or step 2, as required. The A/D conversion time per bit is defined as TAD. A minimum wait of 2 TAD is required before next acquisition starts.

FIGURE 20-2: ANALOG INPUT MODEL



20.1 A/D Acquisition Requirements

For the A/D converter to meet its specified accuracy, the charge holding capacitor (CHOLD) must be allowed to fully charge to the input channel voltage level. The analog input model is shown in Figure 20-2. The source impedance (Rs) and the internal sampling switch (Rss) impedance directly affect the time required to charge the capacitor CHOLD. The sampling switch (Rss) impedance varies over the device voltage (VDD). The source impedance affects the offset voltage at the analog input (due to pin leakage current). The maximum recommended impedance for analog sources is 2.5 k Ω . After the analog input channel is selected (changed), the channel must be sampled for at least the minimum acquisition time before starting a conversion.

Note: When the conversion is started, the holding capacitor is disconnected from the input pin.

To calculate the minimum acquisition time, Equation 20-1 may be used. This equation assumes that 1/2 LSb error is used (1024 steps for the A/D). The 1/2 LSb error is the maximum error allowed for the A/D to meet its specified resolution.

Equation 20-3 shows the calculation of the minimum required acquisition time, TACQ. This calculation is based on the following application system assumptions:

 $\begin{array}{lll} \text{CHOLD} & = & 25 \text{ pF} \\ \text{Rs} & = & 2.5 \text{ k}\Omega \\ \text{Conversion Error} & \leq & 1/2 \text{ LSb} \end{array}$

VDD = $3V \rightarrow Rss = 2 k\Omega$ Temperature = $85^{\circ}C$ (system max.)

EQUATION 20-1: ACQUISITION TIME

```
TACQ = Amplifier Settling Time + Holding Capacitor Charging Time + Temperature Coefficient
= TAMP + TC + TCOFF
```

EQUATION 20-2: A/D MINIMUM CHARGING TIME

```
\begin{array}{lll} V_{HOLD} & = & (V_{REF} - (V_{REF}/2048)) \bullet (1 - e^{(-T_{C}/C_{HOLD}(R_{IC} + R_{SS} + R_{S}))}) \\ \text{or} \\ T_{C} & = & -(C_{HOLD})(R_{IC} + R_{SS} + R_{S}) \ln(1/2048) \end{array}
```

EQUATION 20-3: CALCULATING THE MINIMUM REQUIRED ACQUISITION TIME

```
TACQ = TAMP + TC + TCOFF

TAMP = 0.2 μs

TCOFF = (Temp - 25°C)(0.02 μs/°C) (85°C - 25°C)(0.02 μs/°C) 1.2 μs

Temperature coefficient is only required for temperatures > 25°C. Below 25°C, TCOFF = 0 ms.

TC = -(CHOLD)(RIC + RSS + RS) ln(1/2048) μs -(25 pF) (1 kΩ + 2 kΩ + 2.5 kΩ) ln(0.0004883) μs 1.05 μs

TACQ = 0.2 μs + 1 μs + 1.2 μs 2.4 μs
```

20.2 Selecting and Configuring Automatic Acquisition Time

The ADCON2 register allows the user to select an acquisition time that occurs each time the GO/DONE bit is set.

When the GO/DONE bit is set, sampling is stopped and a conversion begins. The user is responsible for ensuring the required acquisition time has passed between selecting the desired input channel and setting the GO/DONE bit. This occurs when the ACQT<2:0> bits (ADCON2<5:3>) remain in their Reset state ('000') and is compatible with devices that do not offer programmable acquisition times.

If desired, the ACQT bits can be set to select a programmable acquisition time for the A/D module. When the GO/DONE bit is set, the A/D module continues to sample the input for the selected acquisition time, then automatically begins a conversion. Since the acquisition time is programmed, there may be no need to wait for an acquisition time between selecting a channel and setting the GO/DONE bit.

In either case, when the conversion is completed, the GO/DONE bit is cleared, the ADIF flag is set and the A/D begins sampling the currently selected channel again. If an acquisition time is programmed, there is nothing to indicate if the acquisition time has ended or if the conversion has begun.

20.3 Selecting the A/D Conversion Clock

The A/D conversion time per bit is defined as TAD. The A/D conversion requires 11 TAD per 10-bit conversion. The source of the A/D conversion clock is software selectable.

There are seven possible options for TAD:

- 2 Tosc
- 4 Tosc
- 8 Tosc
- 16 Tosc
- 32 Tosc
- 64 Tosc

· Internal RC Oscillator

For correct A/D conversions, the A/D conversion clock (TAD) must be as short as possible but greater than the

(TAD) must be as short as possible but greater than the minimum TAD (see parameter 130 in Table 27-25 for more information).

Table 20-1 shows the resultant TAD times derived from the device operating frequencies and the A/D clock source selected.

TABLE 20-1: TAD VS. DEVICE OPERATING FREQUENCIES

AD Clock S	Source (TAD)	Maximum
Operation	ADCS<2:0>	Device Frequency
2 Tosc	000	2.86 MHz
4 Tosc	100	5.71 MHz
8 Tosc	001	11.43 MHz
16 Tosc	101	22.86 MHz
32 Tosc	010	40.0 MHz
64 Tosc	110	40.0 MHz
RC ⁽²⁾	x11	1.00 MHz ⁽¹⁾

- Note 1: The RC source has a typical TAD time of $4 \mu s$.
 - 2: For device frequencies above 1 MHz, the device must be in Sleep mode for the entire conversion or the A/D accuracy may be out of specification.

20.4 Configuring Analog Port Pins

The ADCON1, TRISA, TRISF and TRISH registers control the operation of the A/D port pins. The port pins needed as analog inputs must have their corresponding TRIS bits set (input). If the TRIS bit is cleared (output), the digital output level (VOH or VOL) will be converted.

The A/D operation is independent of the state of the CHS<3:0> bits and the TRIS bits.

- Note 1: When reading the PORT register, all pins configured as analog input channels will read as cleared (a low level). Pins configured as digital inputs will convert an analog input. Analog levels on a digitally configured input will be accurately converted.
 - 2: Analog levels on any pin defined as a digital input may cause the digital input buffer to consume current out of the device's specification limits.

20.5 A/D Conversions

Figure 20-3 shows the operation of the A/D converter after the GO/DONE bit has been set and the ACQT<2:0> bits are cleared. A conversion is started after the following instruction to allow entry into Sleep mode before the conversion begins.

Figure 20-4 shows the operation of the A/D converter after the GO/DONE bit has been set, the ACQT<2:0> bits are set to '010' and selecting a 4 TAD acquisition time before the conversion starts.

Clearing the GO/DONE bit during a conversion will abort the current conversion. The A/D Result register pair will NOT be updated with the partially completed A/D conversion sample. This means the ADRESH:ADRESL registers will continue to contain the value of the last completed conversion (or the last value written to the ADRESH:ADRESL registers).

After the A/D conversion is completed or aborted, a 2 TAD wait is required before the next acquisition can be started. After this wait, acquisition on the selected channel is automatically started.

e: The GO/DONE bit should **NOT** be set in the same instruction that turns on the A/D.

20.6 Use of the CCP2 Trigger

An A/D conversion can be started by the "Special Event Trigger" of the CCP2 module. This requires that the CCP2M<3:0> bits (CCP2CON<3:0>) be programmed as '1011' and that the A/D module is enabled (ADON bit is set). When the trigger occurs, the GO/DONE bit will be set, starting the A/D acquisition and conversion and the Timer1 (or Timer3) counter will be reset to zero. Timer1 (or Timer3) is reset to automatically repeat the A/D acquisition period with minimal software overhead (moving ADRESH:ADRESL to the desired location). The appropriate analog input channel must be selected and the minimum acquisition period is either timed by the user, or an appropriate TACQ time is selected before the Special Event Trigger sets the GO/DONE bit (starts a conversion).

If the A/D module is not enabled (ADON is cleared), the Special Event Trigger will be ignored by the A/D module but will still reset the Timer1 (or Timer3) counter.

FIGURE 20-3: A/D CONVERSION TAD CYCLES (ACQT<2:0> = 000, TACQ = 0)

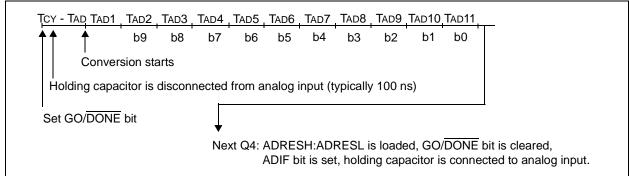
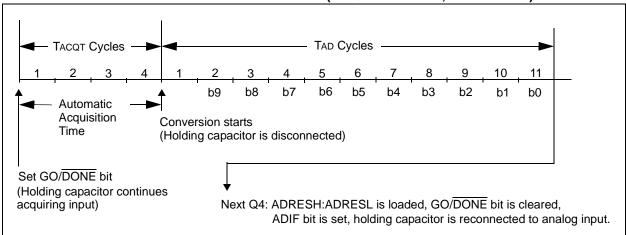


FIGURE 20-4: A/D CONVERSION TAD CYCLES (ACQT<2:0> = 010, TACQ = 4 TAD)



20.7 A/D Converter Calibration

The A/D converter in the PIC18F87J90 family of devices includes a self-calibration feature which compensates for any offset generated within the module. The calibration process is automated and is initiated by setting the ADCAL bit (ADCON0<7>). The next time the GO/DONE bit is set, the module will perform a "dummy" conversion (that is, with reading none of the input channels) and store the resulting value internally to compensate for offset. Thus, subsequent offsets will be compensated.

The calibration process assumes that the device is in a relatively steady-state operating condition. If A/D calibration is used, it should be performed after each device Reset or if there are other major changes in operating conditions.

20.8 Operation in Power-Managed Modes

The selection of the automatic acquisition time and A/D conversion clock is determined in part by the clock source and frequency while in a power-managed mode.

If the A/D is expected to operate while the device is in a power-managed mode, the ACQT<2:0> and ADCS<2:0> bits in ADCON2 should be updated in accordance with the power-managed mode clock that will be used. After the power-managed mode is entered (either of the power-managed Run modes), an A/D acquisition or conversion may be started. Once an acquisition or conversion is started, the device should continue to be clocked by the same power-managed mode clock source until the conversion has been completed. If desired, the device may be placed into the corresponding power-managed Idle mode during the conversion.

If the power-managed mode clock frequency is less than 1 MHz, the A/D RC clock source should be selected.

Operation in the Sleep mode requires the A/D RC clock to be selected. If bits ACQT<2:0> are set to '000' and a conversion is started, the conversion will be delayed one instruction cycle to allow execution of the SLEEP instruction and entry to Sleep mode. The IDLEN and SCSx bits in the OSCCON register must have already been cleared prior to starting the conversion.

TABLE 20-2: SUMMARY OF A/D REGISTERS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53	
PIR1	_	ADIF	RC1IF	TX1IF	SSPIF	_	TMR2IF	TMR1IF	56	
PIE1	_	ADIE	RC1IE	TX1IE	SSPIE	_	TMR2IE	TMR1IE	56	
IPR1	_	ADIP	RC1IP	TX1IP	SSPIP	_	TMR2IP	TMR1IP	56	
PIR3	_	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	56	
PIE3	_	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	56	
IPR3	_	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	56	
ADRESH	A/D Resul	t Register Hi	gh Byte						55	
ADRESL	A/D Resul	t Register Lo	w Byte						55	
ADCON0	ADCAL	_	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON	55	
ADCON1	TRIGSEL	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	55	
ADCON2	ADFM	_	ACQT2	ACQT1	ACQT0	ADCS2	ADCS1	ADCS0	55	
CCP2CON	_	_	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	58	
PORTA	RA7 ⁽¹⁾	RA6 ⁽¹⁾	RA5	RA4	RA3	RA2	RA1	RA0	57	
TRISA	TRISA7 ⁽¹⁾	TRISA6 ⁽¹⁾	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	56	
PORTF	RF7	RF6	RF5	RF4	RF3	RF2	RF1	_	56	
TRISF	TRISF5	TRISF4	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	_	56	

Legend: — = unimplemented, read as '0'. Shaded cells are not used for A/D conversion.

Note 1: RA<7:6> and their associated latch and direction bits are configured as port pins only when the internal oscillator is selected as the default clock source (FOSC2 Configuration bit = 0); otherwise, they are disabled and these bits read as '0'.

NOTES:

21.0 COMPARATOR MODULE

The analog comparator module contains two comparators that can be configured in a variety of ways. The inputs can be selected from the analog inputs multiplexed with pins RF1 through RF6, as well as the on-chip voltage reference (see **Section 22.0** "Comparator Voltage Reference Module"). The digital outputs (normal or inverted) are available at the pin level and can also be read through the control register.

The CMCON register (Register 21-1) selects the comparator input and output configuration. Block diagrams of the various comparator configurations are shown in Figure 21-1.

REGISTER 21-1: CMCON: COMPARATOR MODULE CONTROL REGISTER

R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-1	R/W-1	R/W-1
C2OUT	C1OUT	C2INV	C1INV	CIS	CM2	CM1	CM0
bit 7							bit 0

Legend:					
R = Readable bit	adable bit W = Writable bit U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 7 C2OUT: Comparator 2 Output bit

When C2INV = 0:

1 = C2 VIN+ > C2 VIN-

0 = C2 VIN+ < C2 VIN-

When C2INV = 1:

1 = C2 VIN+ < C2 VIN-

0 = C2 VIN+ > C2 VIN-

bit 6 **C10UT**: Comparator 1 Output bit

When C1INV = 0:

1 = C1 VIN+ > C1 VIN-

0 = C1 VIN+ < C1 VIN-

When C1INV = 1:

1 = C1 VIN+ < C1 VIN-

0 = C1 Vin+ > C1 Vin-

bit 5 C2INV: Comparator 2 Output Inversion bit

1 = C2 output inverted

0 = C2 output not inverted

bit 4 C1INV: Comparator 1 Output Inversion bit

1 = C1 output inverted

0 = C1 output not inverted

bit 3 CIS: Comparator Input Switch bit

When CM<2:0> = 110:

1 = C1 Vin- connects to RF5/AN10/CVREF/SEG23/C1INB

C2 VIN- connects to RF3/AN8/SEG21/C2INB

0 = C1 Vin- connects to RF6/AN11/SEG24/C1INA

C2 VIN- connects to RF4/AN9/SEG22/C2INA

bit 2-0 **CM<2:0>**: Comparator Mode bits

Figure 21-1 shows the Comparator modes and the CM<2:0> bit settings.

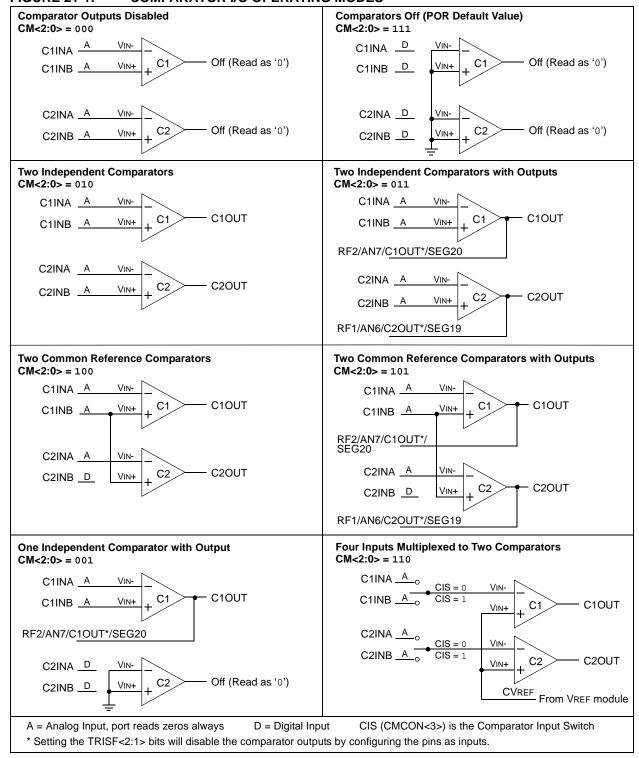
21.1 Comparator Configuration

There are eight modes of operation for the comparators, shown in Figure 21-1. Bits CM<2:0> of the CMCON register are used to select these modes. The TRISF register controls the data direction of the comparator pins for each mode. If the Comparator

mode is changed, the comparator output level may not be valid for the specified mode change delay shown in **Section 27.0** "Electrical Characteristics".

Note: Comparator interrupts should be disabled during a Comparator mode change; otherwise, a false interrupt may occur.

FIGURE 21-1: COMPARATOR I/O OPERATING MODES



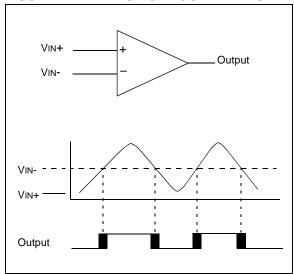
21.2 Comparator Operation

A single comparator is shown in Figure 21-2, along with the relationship between the analog input levels and the digital output. When the analog input at VIN+ is less than the analog input VIN-, the output of the comparator is a digital low level. When the analog input at VIN+ is greater than the analog input VIN-, the output of the comparator is a digital high level. The shaded areas of the output of the comparator in Figure 21-2 represent the uncertainty due to input offsets and response time.

21.3 Comparator Reference

Depending on the comparator operating mode, either an external or internal voltage reference may be used. The analog signal present at VIN- is compared to the signal at VIN+ and the digital output of the comparator is adjusted accordingly (Figure 21-2).

FIGURE 21-2: SINGLE COMPARATOR



21.3.1 EXTERNAL REFERENCE SIGNAL

When external voltage references are used, the comparator module can be configured to have the comparators operate from the same or different reference sources. However, threshold detector applications may require the same reference. The reference signal must be between Vss and VDD and can be applied to either pin of the comparator(s).

21.3.2 INTERNAL REFERENCE SIGNAL

The comparator module also allows the selection of an internally generated voltage reference from the comparator voltage reference module. This module is described in more detail in **Section 22.0 "Comparator Voltage Reference Module"**.

The internal reference is only available in the mode where four inputs are multiplexed to two comparators (CM<2:0> = 110). In this mode, the internal voltage reference is applied to the VIN+ pin of both comparators.

21.4 Comparator Response Time

Response time is the minimum time, after selecting a new reference voltage or input source, before the comparator output has a valid level. If the internal reference is changed, the maximum delay of the internal voltage reference must be considered when using the comparator outputs. Otherwise, the maximum delay of the comparators should be used (see **Section 27.0** "**Electrical Characteristics**").

21.5 Comparator Outputs

The comparator outputs are read through the CMCON register. These bits are read-only. The comparator outputs may also be directly output to the RF1 and RF2 I/O pins. When enabled, multiplexors in the output path of the RF1 and RF2 pins will switch and the output of each pin will be the unsynchronized output of the comparator. The uncertainty of each of the comparators is related to the input offset voltage and the response time given in the specifications. Figure 21-3 shows the comparator output block diagram.

The TRISF bits will still function as an output enable/ disable for the RF1 and RF2 pins while in this mode.

The polarity of the comparator outputs can be changed using the C2INV and C1INV bits (CMCON<5:4>).

- Note 1: When reading the PORT register, all pins configured as analog inputs will read as '0'. Pins configured as digital inputs will convert an analog input according to the Schmitt Trigger input specification.
 - **2:** Analog levels on any pin defined as a digital input may cause the input buffer to consume more current than is specified.

© 2009 Microchip Technology Inc. Preliminary DS39933C-page 295

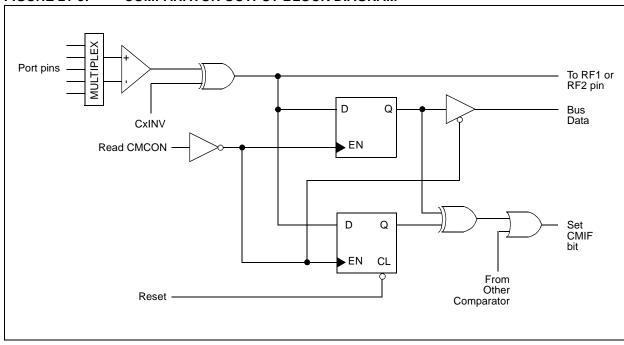


FIGURE 21-3: COMPARATOR OUTPUT BLOCK DIAGRAM

21.6 Comparator Interrupts

The comparator interrupt flag is set whenever there is a change in the output value of either comparator. Software will need to maintain information about the status of the output bits, as read from CMCON<7:6>, to determine the actual change that occurred. The CMIF bit (PIR2<6>) is the Comparator Interrupt Flag. The CMIF bit must be reset by clearing it. Since it is also possible to write a '1' to this register, a simulated interrupt may be initiated.

Both the CMIE bit (PIE2<6>) and the PEIE bit (INTCON<6>) must be set to enable the interrupt. In addition, the GIE bit (INTCON<7>) must also be set. If any of these bits are clear, the interrupt is not enabled, though the CMIF bit will still be set if an interrupt condition occurs.

Note: If a change in the CMCON register (C1OUT or C2OUT) should occur when a read operation is being executed (start of the Q2 cycle), then the CMIF (PIR2<6>) interrupt flag may not get set.

The user, in the Interrupt Service Routine, can clear the interrupt in the following manner:

- a) Any read or write of CMCON will end the mismatch condition.
- b) Clear flag bit, CMIF.

A mismatch condition will continue to set flag bit, CMIF. Reading CMCON will end the mismatch condition and allow flag bit, CMIF, to be cleared.

21.7 Comparator Operation During Sleep

When a comparator is active and the device is placed in Sleep mode, the comparator remains active and the interrupt is functional, if enabled. This interrupt will wake-up the device from Sleep mode, when enabled. Each operational comparator will consume additional current, as shown in the comparator specifications. To minimize power consumption while in Sleep mode, turn off the comparators (CM<2:0> = 111) before entering Sleep. If the device wakes up from Sleep, the contents of the CMCON register are not affected.

21.8 Effects of a Reset

A device Reset forces the CMCON register to its Reset state, causing the comparator modules to be turned off (CM<2:0> = 111). However, the input pins (RF3 through RF6) are configured as analog inputs by default on device Reset. The I/O configuration for these pins is determined by the setting of the PCFG<3:0> bits (ADCON1<3:0>). Therefore, device current is minimized when analog inputs are present at Reset time.

21.9 Analog Input Connection Considerations

A simplified circuit for an analog input is shown in Figure 21-4. Since the analog pins are connected to a digital output, they have reverse biased diodes to VDD and Vss. The analog input, therefore, must be between Vss and VDD. If the input voltage deviates from this

range by more than 0.6V in either direction, one of the diodes is forward biased and a latch-up condition may occur. A maximum source impedance of 10 $k\Omega$ is recommended for the analog sources. Any external component connected to an analog input pin, such as a capacitor or a Zener diode, should have very little leakage current.

FIGURE 21-4: COMPARATOR ANALOG INPUT MODEL

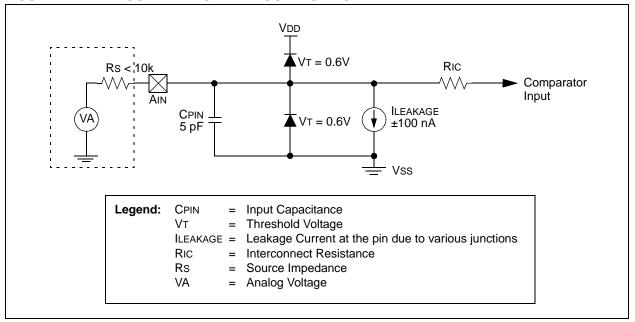


TABLE 21-1: REGISTERS ASSOCIATED WITH COMPARATOR MODULE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	53
PIR2	OSCFIF	CMIF	_	_	BCLIF	LVDIF	TMR3IF	_	56
PIE2	OSCFIE	CMIE	_	_	BCLIE	LVDIE	TMR3IE	_	56
IPR2	OSCFIP	CMIP		-	BCLIP	LVDIP	TMR3IP	1	56
CMCON	C2OUT	C1OUT	C2INV	C1INV	CIS	CM2	CM1	CM0	55
CVRCON	CVREN	CVROE	CVRR	CVRSS	CVR3	CVR2	CVR1	CVR0	55
PORTF	RF7	RF6	RF5	RF4	RF3	RF2	RF1	_	56
LATF	LATF7	LATF6	LATF5	LATF4	LATF3	LATF2	LATF1		56
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	_	56

Legend: — = unimplemented, read as '0'. Shaded cells are unused by the comparator module.

© 2009 Microchip Technology Inc. Preliminary DS39933C-page 297

NOTES:

22.0 COMPARATOR VOLTAGE REFERENCE MODULE

The comparator voltage reference is a 16-tap resistor ladder network that provides a selectable reference voltage. Although its primary purpose is to provide a reference for the analog comparators, it may also be used independently of them.

A block diagram of the module is shown in Figure 22-1. The resistor ladder is segmented to provide two ranges of CVREF values and has a power-down function to conserve power when the reference is not being used. The module's supply reference can be provided from either device VDD/VSS or an external voltage reference.

22.1 Configuring the Comparator Voltage Reference

The comparator voltage reference module is controlled through the CVRCON register (Register 22-1). The comparator voltage reference provides two ranges of output voltage, each with 16 distinct levels.

The range to be used is selected by the CVRR bit (CVRCON<5>). The primary difference between the ranges is the size of the steps selected by the CVREF Selection bits (CVR3:CVR0), with one range offering finer resolution. The equations used to calculate the output of the comparator voltage reference are as follows:

```
If CVRR = 1:
CVREF = ((CVR<3:0>)/24) x (CVRSRC)

If CVRR = 0:
CVREF = (CVRSRC/4) + ((CVR<3:0>)/32) x
(CVRSRC)
```

The comparator reference supply voltage can come from either VDD and Vss, or the external VREF+ and VREF- that are multiplexed with RA2 and RA3. The voltage source is selected by the CVRSS bit (CVRCON<4>).

The settling time of the comparator voltage reference must be considered when changing the CVREF output (see Table 27-3 in **Section 27.0 "Electrical Characteristics"**).

REGISTER 22-1: CVRCON: COMPARATOR VOLTAGE REFERENCE CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CVREN	CVROE ⁽¹⁾	CVRR	CVRSS	CVR3	CVR2	CVR1	CVR0
bit 7							bit 0

Legend:					
R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'					
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

```
bit 7
              CVREN: Comparator Voltage Reference Enable bit
              1 = CVREF circuit powered on
              0 = CVREF circuit powered down
              CVROE: Comparator VREF Output Enable bit<sup>(1)</sup>
bit 6
              1 = CVREF voltage level is also output on the RF5/AN10/CVREF/SEG23/C1INB pin
              0 = CVREF voltage is disconnected from the RF5/AN10/CVREF/SEG23/C1INB pin
bit 5
              CVRR: Comparator VREF Range Selection bit
              1 = 0 to 0.667 CVRSRC, with CVRSRC/24 step size (low range)
              0 = 0.25 CVRSRC to 0.75 CVRSRC, with CVRSRC/32 step size (high range)
bit 4
              CVRSS: Comparator VREF Source Selection bit
              1 = Comparator reference source, CVRSRC = (VREF+) - (VREF-)
              0 = Comparator reference source, CVRSRC = VDD - VSS
bit 3-0
              CVR<3:0>: Comparator VREF Value Selection bits (0 \le (CVR<3:0>) \le 15)
              When CVRR = 1:
              CVREF = ((CVR < 3:0 >)/24) \bullet (CVRSRC)
              When CVRR = 0:
              CVREF = (CVRSRC/4) + ((CVR<3:0>)/32) \bullet (CVRSRC)
```

Note 1: CVROE overrides the TRISF<5> bit setting.

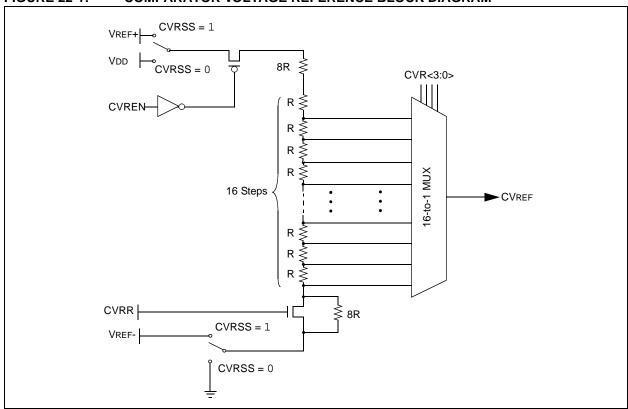


FIGURE 22-1: COMPARATOR VOLTAGE REFERENCE BLOCK DIAGRAM

22.2 Voltage Reference Accuracy/Error

The full range of voltage reference cannot be realized due to the construction of the module. The transistors on the top and bottom of the resistor ladder network (Figure 22-1) keep CVREF from approaching the reference source rails. The voltage reference is derived from the reference source; therefore, the CVREF output changes with fluctuations in that source. The tested absolute accuracy of the voltage reference can be found in **Section 27.0 "Electrical Characteristics"**.

22.3 Operation During Sleep

When the device wakes up from Sleep through an interrupt or a Watchdog Timer time-out, the contents of the CVRCON register are not affected. To minimize current consumption in Sleep mode, the voltage reference should be disabled.

22.4 Effects of a Reset

A device Reset disables the voltage reference by clearing bit, CVREN (CVRCON<7>). This Reset also disconnects the reference from the RA2 pin by clearing bit, CVROE (CVRCON<6>) and selects the high-voltage range by clearing bit, CVRR (CVRCON<5>). The CVR value select bits are also cleared.

22.5 Connection Considerations

The voltage reference module operates independently of the comparator module. The output of the reference generator may be connected to the RF5 pin if the CVROE bit is set. Enabling the voltage reference output onto RA2 when it is configured as a digital input will increase current consumption. Connecting RF5 as a digital output with CVRSS enabled will also increase current consumption.

The RF5 pin can be used as a simple D/A output with limited drive capability. Due to the limited current drive capability, a buffer must be used on the voltage reference output for external connections to VREF. Figure 22-2 shows an example buffering technique.

FIGURE 22-2: COMPARATOR VOLTAGE REFERENCE OUTPUT BUFFER EXAMPLE

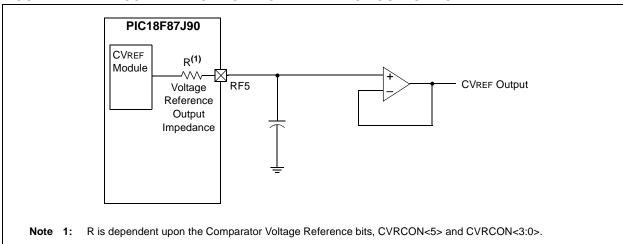


TABLE 22-1: REGISTERS ASSOCIATED WITH COMPARATOR VOLTAGE REFERENCE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
CVRCON	CVREN	CVROE	CVRR	CVRSS	CVR3	CVR2	CVR1	CVR0	55
CMCON	C2OUT	C1OUT	C2INV	C1INV	CIS	CM2	CM1	CM0	55
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1		56

Legend: — = unimplemented, read as '0'. Shaded cells are not used with the comparator voltage reference.

© 2009 Microchip Technology Inc. Preliminary DS39933C-page 301

NOTES:

23.0 CHARGE TIME MEASUREMENT UNIT (CTMU)

The Charge Time Measurement Unit (CTMU) is a flexible analog module that provides accurate differential time measurement between pulse sources, as well as asynchronous pulse generation. By working with other on-chip analog modules, the CTMU can be used to precisely measure time, measure capacitance, measure relative changes in capacitance or generate output pulses with a specific time delay. The CTMU is ideal for interfacing with capacitive-based sensors.

The module includes the following key features:

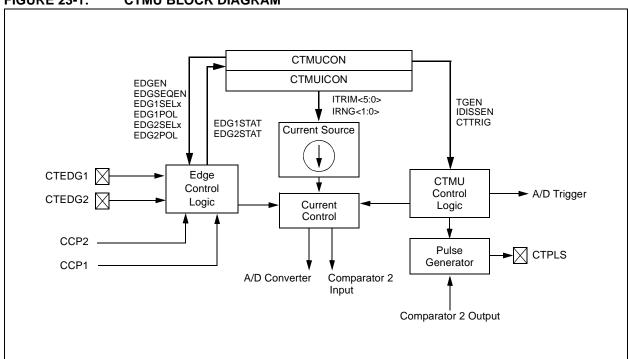
- Up to 13 channels available for capacitive or time measurement input
- · On-chip precision current source
- Four-edge input trigger sources
- · Polarity control for each edge source

- · Control of edge sequence
- · Control of response to edges
- Time measurement resolution of 1 nanosecond
- · High precision time measurement
- Time delay of external or internal signal asynchronous to system clock
- Accurate current source suitable for capacitive measurement

The CTMU works in conjunction with the A/D Converter to provide up to 13 channels for time or charge measurement, depending on the specific device and the number of A/D channels available. When configured for time delay, the CTMU is connected to one of the analog comparators. The level-sensitive input edge sources can be selected from four sources: two external inputs or CCP1/CCP2 Special Event Triggers.

Figure 23-1 provides a block diagram of the CTMU.

FIGURE 23-1: CTMU BLOCK DIAGRAM



© 2009 Microchip Technology Inc. Preliminary DS39933C-page 303

23.1 CTMU Operation

The CTMU works by using a fixed current source to charge a circuit. The type of circuit depends on the type of measurement being made. In the case of charge measurement, the current is fixed, and the amount of time the current is applied to the circuit is fixed. The amount of voltage read by the A/D is then a measurement of the capacitance of the circuit. In the case of time measurement, the current, as well as the capacitance of the circuit, is fixed. In this case, the voltage read by the A/D is then representative of the amount of time elapsed from the time the current source starts and stops charging the circuit.

If the CTMU is being used as a time delay, both capacitance and current source are fixed, as well as the voltage supplied to the comparator circuit. The delay of a signal is determined by the amount of time it takes the voltage to charge to the comparator threshold voltage.

23.1.1 THEORY OF OPERATION

The operation of the CTMU is based on the equation for charge:

$$C = I \cdot \frac{dV}{dT}$$

More simply, the amount of charge measured in coulombs in a circuit is defined as current in amperes (I) multiplied by the amount of time in seconds that the current flows (t). Charge is also defined as the capacitance in farads (C) multiplied by the voltage of the circuit (V). It follows that:

$$I \cdot t = C \cdot V.$$

The CTMU module provides a constant, known current source. The A/D Converter is used to measure (V) in the equation, leaving two unknowns: capacitance (C) and time (t). The above equation can be used to calculate capacitance or time, by either the relationship using the known fixed capacitance of the circuit:

$$t = (C \cdot V)/I$$

or by:

$$C = (I \cdot t)/V$$

using a fixed time that the current source is applied to the circuit.

23.1.2 CURRENT SOURCE

At the heart of the CTMU is a precision current source, designed to provide a constant reference for measurements. The level of current is user-selectable across three ranges or a total of two orders of magnitude, with the ability to trim the output in ±2% increments (nominal). The current range is selected by the IRNG<1:0> bits (CTMUICON<9:8>), with a value of '00' representing the lowest range.

Current trim is provided by the ITRIM<5:0> bits (CTMUICON<7:2>). These six bits allow trimming of the current source in steps of approximately 2% per step. Note that half of the range adjusts the current source positively and the other half reduces the current source. A value of '000000' is the neutral position (no change). A value of '100000' is the maximum negative adjustment (approximately -62%), and '011111' is the maximum positive adjustment (approximately +62%).

23.1.3 EDGE SELECTION AND CONTROL

CTMU measurements are controlled by edge events occurring on the module's two input channels. Each channel, referred to as Edge 1 and Edge 2, can be configured to receive input pulses from one of the edge input pins (CTEDG1 and CTEDG2) or CCPx Special Event Triggers. The input channels are level-sensitive, responding to the instantaneous level on the channel rather than a transition between levels. The inputs are selected using the EDG1SEL and EDG2SEL bit pairs (CTMUCONL<3:2, 6:5>).

In addition to source, each channel can be configured for event polarity using the EDGE2POL and EDGE1POL bits (CTMUCONL<7,4>). The input channels can also be filtered for an edge event sequence (Edge 1 occurring before Edge 2) by setting the EDGSEQEN bit (CTMUCONH<2>).

23.1.4 EDGE STATUS

The CTMUCON register also contains two status bits, EDG2STAT and EDG1STAT (CTMUCONL<1:0>). Their primary function is to show if an edge response has occurred on the corresponding channel. The CTMU automatically sets a particular bit when an edge response is detected on its channel. The level-sensitive nature of the input channels also means that the status bits become set immediately if the channel's configuration is changed and is the same as the channel's current state.

The module uses the edge status bits to control the current source output to external analog modules (such as the A/D Converter). Current is only supplied to external modules when only one (but not both) of the status bits is set, and shuts current off when both bits are either set or cleared. This allows the CTMU to measure current only during the interval between edges. After both status bits are set, it is necessary to clear them before another measurement is taken. Both bits should be cleared simultaneously, if possible, to avoid re-enabling the CTMU current source.

In addition to being set by the CTMU hardware, the edge status bits can also be set by software. This is also the user's application to manually enable or disable the current source. Setting either one (but not both) of the bits enables the current source. Setting or clearing both bits at once disables the source.

23.1.5 INTERRUPTS

The CTMU sets its interrupt flag (PIR3<2>) whenever the current source is enabled, then disabled. An interrupt is generated only if the corresponding interrupt enable bit (PIE3<2>) is also set. If edge sequencing is not enabled (i.e., Edge 1 must occur before Edge 2), it is necessary to monitor the edge status bits and determine which edge occurred last and caused the interrupt.

23.2 CTMU Module Initialization

The following sequence is a general guideline used to initialize the CTMU module:

- Select the current source range using the IRNG bits (CTMUICON<1:0>).
- 2. Adjust the current source trim using the ITRIM bits (CTMUICON<7:2>).
- 3. Configure the edge input sources for Edge 1 and Edge 2 by setting the EDG1SEL and EDG2SEL bits (CTMUCONL<3:2 and 6:5>).
- Configure the input polarities for the edge inputs using the EDG1POL and EDG2POL bits (CTMUCONL<4,7>). The default configuration is for negative edge polarity (high-to-low transitions).
- Enable edge sequencing using the EDGSEQEN bit (CTMUCONH<2>). By default, edge sequencing is disabled.
- Select the operating mode (Measurement or Time Delay) with the TGEN bit. The default mode is Time/Capacitance Measurement.
- Configure the module to automatically trigger an A/D conversion when the second edge event has occurred using the CTTRIG bit (CTMUCONH<0>). The conversion trigger is disabled by default.
- Discharge the connected circuit by setting the IDISSEN bit (CTMUCONH<1>); after waiting a sufficient time for the circuit to discharge, clear IDISSEN.
- Disable the module by clearing the CTMUEN bit (CTMUCONH<7>).
- 10. Clear the Edge Status bits, EDG2STAT and EDG1STAT (CTMUCONL<1:0>).
- 11. Enable both edge inputs by setting the EDGEN bit (CTMUCONH<3>).
- 12. Enable the module by setting the CTMUEN bit.

Depending on the type of measurement or pulse generation being performed, one or more additional modules may also need to be initialized and configured with the CTMU module:

- Edge Source Generation: In addition to the external edge input pins, CCPx Special Event Triggers can be used as edge sources for the CTMU.
- Capacitance or Time Measurement: The CTMU module uses the A/D Converter to measure the voltage across a capacitor that is connected to one of the analog input channels.
- Pulse Generation: When generating system clock independent output pulses, the CTMU module uses Comparator 2 and the associated comparator voltage reference.

23.3 Calibrating the CTMU Module

The CTMU requires calibration for precise measurements of capacitance and time, as well as for accurate time delay. If the application only requires measurement of a relative change in capacitance or time, calibration is usually not necessary. An example of this type of application would include a capacitive touch switch, in which the touch circuit has a baseline capacitance, and the added capacitance of the human body changes the overall capacitance of a circuit.

If actual capacitance or time measurement is required, two hardware calibrations must take place: the current source needs calibration to set it to a precise current, and the circuit being measured needs calibration to measure and/or nullify all other capacitance other than that to be measured.

23.3.1 CURRENT SOURCE CALIBRATION

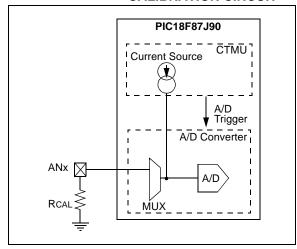
The current source onboard the CTMU module has a range of ±60% nominal for each of three current ranges. Therefore, for precise measurements, it is possible to measure and adjust this current source by placing a high precision resistor, RCAL, onto an unused analog channel. An example circuit is shown in Figure 23-2. The current source measurement is performed using the following steps:

- 1. Initialize the A/D Converter.
- 2. Initialize the CTMU.
- 3. Enable the current source by setting EDG1STAT (CTMUCONL<0>).
- 4. Issue settling time delay.
- 5. Perform A/D conversion.
- 6. Calculate the current source current using I = V/RCAL, where RCAL is a high precision resistance and V is measured by performing an A/D conversion.

The CTMU current source may be trimmed with the trim bits in CTMUICON using an iterative process to get an exact desired current. Alternatively, the nominal value without adjustment may be used; it may be stored by the software for use in all subsequent capacitive or time measurements.

To calculate the value for RCAL , the nominal current must be chosen, and then the resistance can be calculated. For example, if the A/D Converter reference voltage is 3.3V, use 70% of full scale, or 2.31V as the desired approximate voltage to be read by the A/D Converter. If the range of the CTMU current source is selected to be 0.55 μ A, the resistor value needed is calculated as $\mathit{RCAL} = 2.31 V/0.55 \, \mu$ A, for a value of 4.2 M Ω . Similarly, if the current source is chosen to be 5.5 μ A, RCAL would be 420,000 Ω , and 42,000 Ω if the current source is set to 55 μ A.

FIGURE 23-2: CTMU CURRENT SOURCE CALIBRATION CIRCUIT



A value of 70% of full-scale voltage is chosen to make sure that the A/D Converter was in a range that is well above the noise floor. Keep in mind that if an exact current is chosen to incorporate the trimming bits from CTMUICON, the resistor value of RCAL may need to be adjusted accordingly. RCAL may be also adjusted to allow for available resistor values. RCAL should be of the highest precision available, keeping in mind the amount of precision needed for the circuit that the CTMU will be used to measure. A recommended minimum would be 0.1% tolerance.

The following examples show one typical method for performing a CTMU current calibration. Example 23-1 demonstrates how to initialize the A/D Converter and the CTMU; this routine is typical for applications using both modules. Example 23-2 demonstrates one method for the actual calibration routine. Note that this method manually triggers the A/D Converter; this is done to demonstrate the entire stepwise process. It is also possible to automatically trigger the conversion by setting the CTMU's CTTRIG bit (CTMUCONH<0>).

EXAMPLE 23-1: SETUP FOR CTMU CALIBRATION ROUTINES

```
#include "p18cxxx.h"
void setup(void)
{ //CTMUCON - CTMU Control register
   CTMUCONH = 0 \times 00;
                          //make sure CTMU is disabled
   CTMUCONL = 0X90;
   //CTMU continues to run when emulator is stopped,CTMU continues
   //to run in idle mode, Time Generation mode disabled, Edges are blocked
   //No edge sequence order, Analog current source not grounded, trigger
   //output disabled, Edge2 polarity = positive level, Edge2 source =
   //source 0, Edgel polarity = positive level, Edgel source = source 0,
   // Set Edge status bits to zero
   //CTMUICON - CTMU Current Control Register
   CTMUICON = 0 \times 01;
                          //0.55uA, Nominal - No Adjustment
//Setup AD converter;
TRISA=0 \times 04;
                           //set channel 2 as an input
   // Configured AN2 as an analog channel
   // ANCONO
   ANCON0 = 0XFB;
   // ANCON1
   ANCON1 = 0X1F;
   // ADCON1
                        // Resulst format 1= Right justified
   ADCON1bits.ADFM=1;
                          // Normal A/D conversion operation
   ADCON1bits.ADCAL=0;
   ADCON1bits.ACQT=1;
                          // Acquition time 7 = 20TAD 2 = 4TAD 1=2TAD
                          // Clock conversion bits 6= FOSC/64 2=FOSC/32
   ADCON1bits.ADCS=2;
  ANCON1bits.VBGEN=1;
                          // Turn on the Bandgap needed for Rev AO parts
   // ADCON0
  ADCONObits.VCFG0 =0;
                          // Vref+ = AVdd
  ADCONObits.VCFG1 =0;
                          // Vref- = AVss
  ADCONObits.CHS=2;
                          // Select ADC channel
   ADCONObits.ADON=1;
                           // Turn on ADC
```

EXAMPLE 23-2: CURRENT CALIBRATION ROUTINE

```
#include "p18cxxx.h"
#define COUNT 500
                                         //@ 8MHz = 125uS.
#define DELAY for(i=0;i<COUNT;i++)</pre>
#define RCAL .027
                                         //R value is 4200000 (4.2M)
                                         //scaled so that result is in
                                         //1/100th of uA
#define ADSCALE 1023
                                         //for unsigned conversion 10 sig bits
#define ADREF 3.3
                                         //Vdd connected to A/D Vr+
int main(void)
   int i;
   int j = 0; //index for loop
   unsigned int Vread = 0;
   double VTot = 0;
   float Vavg=0, Vcal=0, CTMUISrc = 0; //float values stored for calcs
//assume CTMU and A/D have been setup correctly
//see Example 25-1 for CTMU & A/D setup
setup();
CTMUCONHbits.CTMUEN = 1;
                                         //Enable the CTMU
   for(j=0;j<10;j++)
                                         //drain charge on the circuit
       CTMUCONHbits.IDISSEN = 1;
                                         //wait 125us
       DELAY;
       CTMUCONHbits.IDISSEN = 0;
                                         //end drain of circuit
       CTMUCONLbits.EDG1STAT = 1;
                                         //Begin charging the circuit
                                         //using CTMU current source
                                         //wait for 125us
       DELAY;
                                         //Stop charging circuit
       CTMUCONLbits.EDG1STAT = 0;
       PIR1bits.ADIF = 0;
                                         //make sure A/D Int not set
       ADCONObits.GO=1;
                                         //and begin A/D conv.
       while(!PIR1bits.ADIF);
                                         //Wait for A/D convert complete
       Vread = ADRES;
                                         //Get the value from the A/D
       PIR1bits.ADIF = 0;
                                         //Clear A/D Interrupt Flag
       VTot += Vread;
                                         //Add the reading to the total
   Vavg = (float)(VTot/10.000);
                                         //Average of 10 readings
   Vcal = (float)(Vavg/ADSCALE*ADREF);
   CTMUISrc = Vcal/RCAL;
                                         //CTMUISrc is in 1/100ths of uA
```

23.3.2 CAPACITANCE CALIBRATION

There is a small amount of capacitance from the internal A/D Converter sample capacitor as well as stray capacitance from the circuit board traces and pads that affect the precision of capacitance measurements. A measurement of the stray capacitance can be taken by making sure the desired capacitance to be measured has been removed. The measurement is then performed using the following steps:

- 1. Initialize the A/D Converter and the CTMU.
- 2. Set EDG1STAT (= 1).
- 3. Wait for a fixed delay of time, t.
- 4. Clear EDG1STAT.
- 5. Perform an A/D conversion.
- 6. Calculate the stray and A/D sample capacitances:

$$C_{\text{OFFSET}} = C_{\text{STRAY}} + C_{\text{AD}} = (I \cdot t)/V$$

where I is known from the current source measurement step, t is a fixed delay and V is measured by performing an A/D conversion.

This measured value is then stored and used for calculations of time measurement, or subtracted for capacitance measurement. For calibration, it is expected that the capacitance of CSTRAY + CAD is approximately known. CAD is approximately 4 pF.

An iterative process may need to be used to adjust the time, t, that the circuit is charged to obtain a reasonable voltage reading from the A/D Converter. The value of t may be determined by setting COFFSET to a theoretical value, then solving for t. For example, if CSTRAY is theoretically calculated to be 11 pF, and V is expected to be 70% of VDD, or 2.31V, then t would be:

$$(4 pF + 11 pF) \cdot 2.31V/0.55 \mu A$$

or 63 μs.

See Example 23-3 for a typical routine for CTMU capacitance calibration.

EXAMPLE 23-3: CAPACITANCE CALIBRATION ROUTINE

```
#include "p18cxxx.h"
#define COUNT 25
                                         //@ 8MHz INTFRC = 62.5 us.
#define ETIME COUNT*2.5
                                         //time in uS
#define DELAY for(i=0;i<COUNT;i++)</pre>
#define ADSCALE 1023
                                         //for unsigned conversion 10 sig bits
#define ADREF 3.3
                                         //Vdd connected to A/D Vr+
#define RCAL .027
                                         //R value is 4200000 (4.2M)
                                         //scaled so that result is in
                                         //1/100th of uA
int main(void)
    int i;
   int j = 0;
                                         //index for loop
   unsigned int Vread = 0;
   float CTMUISrc, CTMUCap, Vavg, VTot, Vcal;
//assume CTMU and A/D have been setup correctly
//see Example 25-1 for CTMU & A/D setup
setup();
CTMUCONHbits.CTMUEN = 1;
                                         //Enable the CTMU
    for(j=0;j<10;j++)
        CTMUCONHbits.IDISSEN = 1;
                                         //drain charge on the circuit
       DELAY;
                                         //wait 125us
       CTMUCONHbits.IDISSEN = 0;
                                         //end drain of circuit
        CTMUCONLbits.EDG1STAT = 1;
                                         //Begin charging the circuit
                                         //using CTMU current source
        DELAY;
                                         //wait for 125us
        CTMUCONLbits.EDG1STAT = 0;
                                         //Stop charging circuit
        PIR1bits.ADIF = 0;
                                         //make sure A/D Int not set
       ADCONObits.GO=1;
                                         //and begin A/D conv.
        while(!PIR1bits.ADIF);
                                         //Wait for A/D convert complete
        Vread = ADRES;
                                         //Get the value from the A/D
        PIR1bits.ADIF = 0;
                                         //Clear A/D Interrupt Flag
        VTot += Vread;
                                         //Add the reading to the total
    }
    Vavg = (float)(VTot/10.000);
                                         //Average of 10 readings
    Vcal = (float)(Vavg/ADSCALE*ADREF);
                                         //CTMUISrc is in 1/100ths of uA
    CTMUISrc = Vcal/RCAL;
    CTMUCap = (CTMUISrc*ETIME/Vcal)/100;
```

23.4 Measuring Capacitance with the CTMU

There are two separate methods of measuring capacitance with the CTMU. The first is the absolute method, in which the actual capacitance value is desired. The second is the relative method, in which the actual capacitance is not needed, rather an indication of a change in capacitance is required.

23.4.1 ABSOLUTE CAPACITANCE MEASUREMENT

For absolute capacitance measurements, both the current and capacitance calibration steps found in **Section 23.3 "Calibrating the CTMU Module"** should be followed. Capacitance measurements are then performed using the following steps:

- 1. Initialize the A/D Converter.
- 2. Initialize the CTMU.
- 3. Set EDG1STAT.
- 4. Wait for a fixed delay, T.
- 5. Clear EDG1STAT.
- 6. Perform an A/D conversion.
- 7. Calculate the total capacitance, CTOTAL = (I * T)/V, where I is known from the current source measurement step (Section 23.3.1 "Current Source Calibration"), T is a fixed delay and V is measured by performing an A/D conversion.
- Subtract the stray and A/D capacitance (COFFSET from Section 23.3.2 "Capacitance Calibration") from CTOTAL to determine the measured capacitance.

23.4.2 RELATIVE CHARGE MEASUREMENT

An application may not require precise capacitance measurements. For example, when detecting a valid press of a capacitance-based switch, detecting a relative change of capacitance is of interest. In this type of application, when the switch is open (or not touched), the total capacitance is the capacitance of the combination of the board traces, the A/D Converter, etc. A larger voltage will be measured by the A/D Converter. When the switch is closed (or is touched), the total capacitance is larger due to the addition of the capacitance of the human body to the above listed capacitances, and a smaller voltage will be measured by the A/D Converter.

Detecting capacitance changes is easily accomplished with the CTMU using these steps:

- 1. Initialize the A/D Converter and the CTMU.
- Set EDG1STAT.
- 3. Wait for a fixed delay.
- 4. Clear EDG1STAT.
- Perform an A/D conversion.

The voltage measured by performing the A/D conversion is an indication of the relative capacitance. Note that in this case, no calibration of the current source or circuit capacitance measurement is needed. See Example 23-4 for a sample software routine for a capacitive touch switch.

EXAMPLE 23-4: ROUTINE FOR CAPACITIVE TOUCH SWITCH

```
#include "p18cxxx.h"
#define COUNT 500
                                         //@ 8MHz = 125uS.
#define DELAY for(i=0;i<COUNT;i++)</pre>
#define OPENSW 1000
                                         //Un-pressed switch value
#define TRIP 300
                                         //Difference between pressed
                                         //and un-pressed switch
#define HYST 65
                                         //amount to change
                                         //from pressed to un-pressed
#define PRESSED 1
#define UNPRESSED 0
int main(void)
   unsigned int Vread;
                                         //storage for reading
   unsigned int switchState;
   int i;
   //assume CTMU and A/D have been setup correctly
   //see Example 25-1 for CTMU & A/D setup
   setup();
   CTMUCONHbits.CTMUEN = 1;
                                        //Enable the CTMU
   CTMUCONHbits.IDISSEN = 1;
                                        //drain charge on the circuit
                                         //wait 125us
   DELAY;
                                         //end drain of circuit
   CTMUCONHbits.IDISSEN = 0;
   CTMUCONLbits.EDG1STAT = 1;
                                        //Begin charging the circuit
                                         //using CTMU current source
                                         //wait for 125us
   DELAY;
   CTMUCONLbits.EDG1STAT = 0;
                                         //Stop charging circuit
   PIR1bits.ADIF = 0;
                                         //make sure A/D Int not set
   ADCONObits.GO=1;
                                         //and begin A/D conv.
   while(!PIR1bits.ADIF);
                                         //Wait for A/D convert complete
   Vread = ADRES;
                                         //Get the value from the A/D
   if(Vread < OPENSW - TRIP)</pre>
        switchState = PRESSED;
   else if(Vread > OPENSW - TRIP + HYST)
       switchState = UNPRESSED;
```

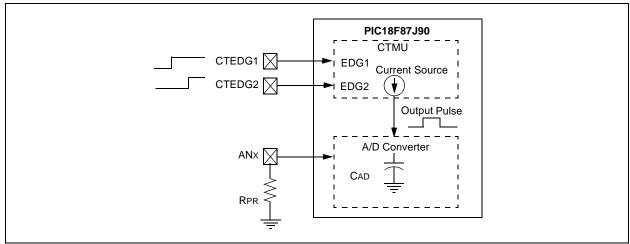
23.5 Measuring Time with the CTMU Module

Time can be precisely measured after the ratio (*C/I*) is measured from the current and capacitance calibration step by following these steps:

- 1. Initialize the A/D Converter and the CTMU.
- 2. Set EDG1STAT.
- 3. Set EDG2STAT.
- 4. Perform an A/D conversion.
- 5. Calculate the time between edges as T = (C/I) * V, where I is calculated in the current calibration step (Section 23.3.1 "Current Source Calibration"), C is calculated in the capacitance calibration step (Section 23.3.2 "Capacitance Calibration") and V is measured by performing the A/D conversion.

It is assumed that the time measured is small enough that the capacitance *C*OFFSET provides a valid voltage to the A/D Converter. For the smallest time measurement, always set the A/D Channel Select register (AD1CHS) to an unused A/D channel; the corresponding pin for which is not connected to any circuit board trace. This minimizes added stray capacitance, keeping the total circuit capacitance close to that of the A/D Converter itself (25 pF). To measure longer time intervals, an external capacitor may be connected to an A/D channel, and this channel selected when making a time measurement.

FIGURE 23-3: TYPICAL CONNECTIONS AND INTERNAL CONFIGURATION FOR TIME MEASUREMENT



© 2009 Microchip Technology Inc. Preliminary DS39933C-page 313

23.6 Creating a Delay with the CTMU Module

A unique feature on board the CTMU module is its ability to generate system clock independent output pulses based on an external capacitor value. This is accomplished using the internal comparator voltage reference module, Comparator 2 input pin and an external capacitor. The pulse is output onto the CTPLS pin. To enable this mode, set the TGEN bit.

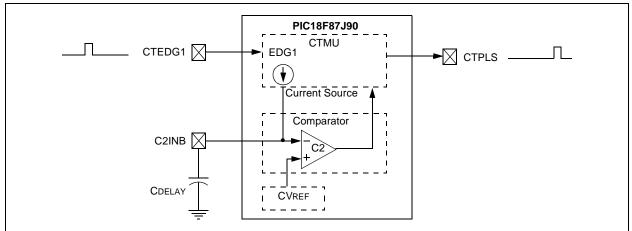
See Figure 23-4 for an example circuit. $C_{\rm PULSE}$ is chosen by the user to determine the output pulse width on CTPLS. The pulse width is calculated by $T = (C_{\rm PULSE}/I)*V$, where I is known from the current source measurement step (Section 23.3.1 "Current Source Calibration") and V is the internal reference voltage (CVREF).

An example use of this feature is for interfacing with variable capacitive-based sensors, such as a humidity sensor. As the humidity varies, the pulse-width output on CTPLS will vary. The CTPLS output pin can be connected to an input capture pin and the varying pulse width is measured to determine the humidity in the application.

Follow these steps to use this feature:

- 1. Initialize Comparator 2.
- 2. Initialize the comparator voltage reference.
- Initialize the CTMU and enable time delay generation by setting the TGEN bit.
- 4. Set EDG1STAT.
- When CPULSE charges to the value of the voltage reference trip point, an output pulse is generated on CTPLS.

FIGURE 23-4: TYPICAL CONNECTIONS AND INTERNAL CONFIGURATION FOR PULSE DELAY GENERATION



23.7 Operation During Sleep/Idle Modes

23.7.1 SLEEP MODE AND DEEP SLEEP MODES

When the device enters any Sleep mode, the CTMU module current source is always disabled. If the CTMU is performing an operation that depends on the current source when Sleep mode is invoked, the operation may not terminate correctly. Capacitance and time measurements may return erroneous values.

23.7.2 IDLE MODE

The behavior of the CTMU in Idle mode is determined by the CTMUSIDL bit (CTMUCONH<5>). If CTMUSIDL is cleared, the module will continue to operate in Idle mode. If CTMUSIDL is set, the module's current source is disabled when the device enters Idle mode. If the module is performing an operation when Idle mode is invoked, in this case, the results will be similar to those with Sleep mode.

23.8 Effects of a Reset on CTMU

Upon Reset, all registers of the CTMU are cleared. This leaves the CTMU module disabled, its current source is turned off and all configuration options return to their default settings. The module needs to be re-initialized following any Reset.

If the CTMU is in the process of taking a measurement at the time of Reset, the measurement will be lost. A partial charge may exist on the circuit that was being measured, and should be properly discharged before the CTMU makes subsequent attempts to make a measurement. The circuit is discharged by setting and then clearing the IDISSEN bit (CTMUCONH<1>) while the A/D Converter is connected to the appropriate channel.

23.9 Registers

There are three control registers for the CTMU:

- CTMUCONH
- CTMUCONL
- CTMUICON

Legend:

R = Readable bit

The CTMUCONH and CTMUCONL registers (Register 23-1 and Register 23-2) contains control bits for configuring the CTMU module edge source selection, edge source polarity selection, edge sequencing, A/D trigger, analog circuit capacitor discharge and enables. The CTMUICON register (Register 23-3) has bits for selecting the current source range and current source trim.

x = Bit is unknown

REGISTER 23-1: CTMUCONH: CTMU CONTROL HIGH REGISTER

W = Writable bit

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CTMUEN	_	CTMUSIDL	TGEN	EDGEN	EDGSEQEN	IDISSEN	CTTRIG
bit 7							bit 0

U = Unimplemented bit, read as '0'

-n = Value at	POR '1' = Bit	is set	'0' = Bit is cleared
bit 7	CTMUEN: CTMU Enak	ole bit	
	1 = Module is enabled		
	0 = Module is disabled		
bit 6	Unimplemented: Read	d as '0'	
bit 5	CTMUSIDL: Stop in Idl	e Mode bit	
	1 = Discontinue module0 = Continue module of	•	
bit 4	TGEN: Time Generation	n Enable bit	
	1 = Enables edge dela0 = Disables edge dela	, 0	
bit 3	EDGEN: Edge Enable	bit	
	1 = Edges are not bloc	ked	
	0 = Edges are blocked	İ	
bit 2	EDGSEQEN: Edge Se	quence Enable bit	
	1 = Edge 1 event mus0 = No edge sequence		2 event can occur
bit 1	IDISSEN: Analog Curre	ent Source Control b	pit
	1 = Analog current sou	irce output is ground	ded
	0 = Analog current sou	irce output is not gro	ounded
bit 0	CTTRIG: Trigger Contr	ol bit	
	1 = Trigger output is e		
	0 = Trigger output is d	sabled	

REGISTER 23-2: CTMUCONL: CTMU CONTROL LOW REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
EDG2POL	EDG2SEL1	EDG2SEL0	EDG1POL	EDG1SEL1	EDG1SEL0	EDG2STAT	EDG1STAT
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 EDG2POL: Edge 2 Polarity Select bit

1 = Edge 2 programmed for a positive edge response0 = Edge 2 programmed for a negative edge response

bit 6-5 EDG2SEL<1:0>: Edge 2 Source Select bits

11 = CTEDG1 pin 10 = CTEDG2 pin

01 = CCP1 Special Event Trigger00 = CCP2 Special Event Trigger

bit 4 EDG1POL: Edge 1 Polarity Select bit

1 = Edge 1 programmed for a positive edge response 0 = Edge 1 programmed for a negative edge response

bit 3-2 EDG1SEL<1:0>: Edge 1 Source Select bits

11 = CTEDG1 pin 10 = CTEDG2 pin

01 = CCP1 Special Event Trigger 00 = CCP2 Special Event Trigger

bit 1 **EDG2STAT:** Edge 2 Status bit

1 = Edge 2 event has occurred0 = Edge 2 event has not occurred

bit 0 EDG1STAT: Edge 1 Status bit

1 = Edge 1 event has occurred0 = Edge 1 event has not occurred

REGISTER 23-3: CTMUICON: CTMU CURRENT CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ITRIM5	ITRIM4	ITRIM3	ITRIM2	ITRIM1	ITRIM0	IRNG1	IRNG0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-2 ITRIM<5:0>: Current Source Trim bits

011111 = Maximum positive change from nominal current

011110

•

.

000001 = Minimum positive change from nominal current

000000 = Nominal current output specified by IRNG<1:0>

111111 = Minimum negative change from nominal current

•

•

100010

100001 = Maximum negative change from nominal current

bit 1-0 IRNG<1:0>: Current Source Range Select bits

11 = 100 x Base current

10 = 10 x Base current

01 = Base current level (0.55 μ A nominal)

00 = Current source disabled

TABLE 23-1: REGISTERS ASSOCIATED WITH CTMU MODULE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page:
CTMUCONH	CTMUEN	_	CTMUSIDL	TGEN	EDGEN	EDGSEQEN	IDISSEN	CTTRIG	_
CTMUCONL	EDG2POL	EDG2SEL1	EDG2SEL0	EDG1POL	EDG1SEL1	EDG1SEL0	EDG2STAT	EDG1STAT	_
CTMUICON	ITRIM5	ITRIM4	ITRIM3	ITRIM2	ITRIM1	ITRIM0	IRNG1	IRNG0	_

Legend: — = unimplemented, read as '0'. Shaded cells are not used during ECCP operation.

NOTES:

24.0 SPECIAL FEATURES OF THE CPU

PIC18F87J90 family devices include several features intended to maximize reliability and minimize cost through elimination of external components. These are:

- · Oscillator Selection
- · Resets:
 - Power-on Reset (POR)
 - Power-up Timer (PWRT)
 - Oscillator Start-up Timer (OST)
 - Brown-out Reset (BOR)
- Interrupts
- Watchdog Timer (WDT)
- Fail-Safe Clock Monitor
- Two-Speed Start-up
- · Code Protection
- In-Circuit Serial Programming

The oscillator can be configured for the application depending on frequency, power, accuracy and cost. All of the options are discussed in detail in **Section 2.0** "Oscillator Configurations".

A complete discussion of device Resets and interrupts is available in previous sections of this data sheet.

In addition to their Power-up and Oscillator Start-up Timers provided for Resets, the PIC18F87J90 family family of devices have a configurable Watchdog Timer which is controlled in software.

The inclusion of an internal RC oscillator also provides the additional benefits of a Fail-Safe Clock Monitor (FSCM) and Two-Speed Start-up. FSCM provides for background monitoring of the peripheral clock and automatic switchover in the event of its failure. Two-Speed Start-up enables code to be executed almost immediately on start-up, while the primary clock source completes its start-up delays.

All of these features are enabled and configured by setting the appropriate Configuration register bits.

24.1 Configuration Bits

The Configuration bits can be programmed (read as '0'), or left unprogrammed (read as '1'), to select various device configurations. These bits are mapped starting at program memory location 300000h. A complete list is shown in Table 24-2. A detailed explanation of the various bit functions is provided in Register 24-1 through Register 24-6.

24.1.1 CONSIDERATIONS FOR CONFIGURING PIC18F87J90 FAMILY DEVICES

Devices of the PIC18F87J90 family do not use persistent memory registers to store configuration information. The configuration bytes are implemented as volatile memory which means that configuration data must be programmed each time the device is powered up.

Configuration data is stored in the four words at the top of the on-chip program memory space, known as the Flash Configuration Words. It is stored in program memory in the same order shown in Table 24-2, with CONFIG1L at the lowest address and CONFIG3H at the highest. The data is automatically loaded in the proper Configuration registers during device power-up.

When creating applications for these devices, users should always specifically allocate the location of the Flash Configuration Word for configuration data. This is to make certain that program code is not stored in this address when the code is compiled.

The volatile memory cells used for the Configuration bits always reset to '1' on Power-on Resets. For all other types of Reset events, the previously programmed values are maintained and used without reloading from program memory.

The four Most Significant bits of CONFIG1H, CONFIG2H and CONFIG3H in program memory should also be '1111'. This makes these Configuration Words appear to be NOP instructions in the remote event that their locations are ever executed by accident. Since Configuration bits are not implemented in the corresponding locations, writing '1's to these locations has no effect on device operation.

To prevent inadvertent configuration changes during code execution, all programmable Configuration bits are write-once. After a bit is initially programmed during a power cycle, it cannot be written to again. Changing a device configuration requires that power to the device be cycled.

TABLE 24-1: MAPPING OF THE FLASH
CONFIGURATION WORDS TO
THE CONFIGURATION
REGISTERS

Configuration Byte	Code Space Address	Configuration Register Address		
CONFIG1L	XXXF8h	300000h		
CONFIG1H	XXXF9h	300001h		
CONFIG2L	XXXFAh	300002h		
CONFIG2H	XXXFBh	300003h		
CONFIG3L	XXXFCh	300004h		
CONFIG3H	XXXFDh	300005h		

TABLE 24-2: CONFIGURATION BITS AND DEVICE IDs

File	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default/ Unprogrammed Value ⁽¹⁾
300000h	CONFIG1L	DEBUG	XINST	STVREN	_	_	_	_	WDTEN	1111
300001h	CONFIG1H	(2)	(2)	(2)	(2)	(3)	CP0	_	_	01
300002h	CONFIG2L	IESO	FCMEN	_	LPT1OSC	T1DIG	FOSC2	FOSC1	FOSC0	11-1 1111
300003h	CONFIG2H	(2)	(2)	(2)	(2)	WDTPS3	WDTPS2	WDTPS1	WDTPS0	1111
300004h	CONFIG3L	(2)	(2)	(2)	(2)	_	_	RTCOSC	_	1-
300005h	CONFIG3H	(2)	(2)	(2)	(2)	_	_	_	CCP2MX	1
3FFFEh	DEVID1	DEV2	DEV1	DEV0	REV4	REV3	REV2	REV1	REV0	xxxx xxxx ⁽⁴⁾
3FFFFFh	DEVID2	DEV10	DEV9	DEV8	DEV7	DEV6	DEV5	DEV4	DEV3	0000 10x1 ⁽⁴⁾

Legend: x = unknown, - = unimplemented. Shaded cells are unimplemented, read as '0'.

- 3: This bit should always be maintained as '0'.
- 4: See Register 24-7 and Register 24-8 for DEVID values. These registers are read-only and cannot be programmed by the user.

Note 1: Values reflect the unprogrammed state as received from the factory and following Power-on Resets. In all other Reset states, the configuration bytes maintain their previously programmed states.

^{2:} The value of these bits in program memory should always be '1'. This ensures that the location is executed as a NOP if it is accidentally executed.

REGISTER 24-1: CONFIG1L: CONFIGURATION REGISTER 1 LOW (BYTE ADDRESS 300000h)

R/WO-1	R/WO-1	R/WO-1	U-0	U-0	U-0	U-0	R/WO-1
DEBUG	XINST	STVREN	_	_	_		WDTEN
bit 7							bit 0

Legend:

R = Readable bit WO = Write-Once bit U = Unimplemented bit, read as '0'

-n = Value when device is unprogrammed '1' = Bit is set '0' = Bit is cleared

bit 7 **DEBUG:** Background Debugger Enable bit

1 = Background debugger disabled; RB6 and RB7 configured as general purpose I/O pins

0 = Background debugger enabled; RB6 and RB7 are dedicated to In-Circuit Debug

bit 6 XINST: Extended Instruction Set Enable bit

1 = Instruction set extension and Indexed Addressing mode enabled

0 = Instruction set extension and Indexed Addressing mode disabled (Legacy mode)

bit 5 STVREN: Stack Overflow/Underflow Reset Enable bit

1 = Reset on stack overflow/underflow enabled0 = Reset on stack overflow/underflow disabled

bit 4-1 **Unimplemented:** Read as '0'

bit 0 WDTEN: Watchdog Timer Enable bit

1 = WDT enabled

0 = WDT disabled (control is placed on SWDTEN bit)

REGISTER 24-2: CONFIG1H: CONFIGURATION REGISTER 1 HIGH (BYTE ADDRESS 300001h)

U-0	U-0	U-0	U-0	U-0	R/WO-1	U-0	U-0
(1)	_(1)	_(1)	_(1)	(2)	CP0	_	_
bit 7							bit 0

Legend:

R = Readable bit WO = Write-Once bit U = Unimplemented bit, read as '0'

-n = Value when device is unprogrammed '1' = Bit is set '0' = Bit is cleared

bit 7-3 Unimplemented: Read as '0'

bit 2 CP0: Code Protection bit

1 = Program memory is not code-protected

0 = Program memory is code-protected

bit 1-0 **Unimplemented:** Read as '0'

Note 1: The value of these bits in program memory should always be '1'. This ensures that the location is executed as a NOP if it is accidentally executed.

2: This bit should always be maintained as '0'.

REGISTER 24-3: CONFIG2L: CONFIGURATION REGISTER 2 LOW (BYTE ADDRESS 300002h)

R/WO-1	R/WO-1	U-0	R/WO-1	R/WO-1	R/WO-1	R/WO-1	R/WO-1
IESO	FCMEN	_	LPT1OSC	T1DIG	FOSC2	FOSC1	FOSC0
bit 7	•	•					bit 0

Legend:

R = Readable bit WO = Write-Once bit U = Unimplemented bit, read as '0' -n = Value when device is unprogrammed '1' = Bit is set '0' = Bit is cleared

bit 7 IESO: Two-Speed Start-up (Internal/External Oscillator Switchover) Control bit

1 = Two-Speed Start-up enabled0 = Two-Speed Start-up disabled

bit 6 FCMEN: Fail-Safe Clock Monitor Enable bit

1 = Fail-Safe Clock Monitor enabled0 = Fail-Safe Clock Monitor disabled

bit 5 **Unimplemented:** Read as '0'

bit 4 LPT10SC: T10SC/SOSC Power Selection Configuration bit

1 = High-power T1OSC/SOSC circuit selected 0 = Low-power T1OSC/SOSC circuit selected

bit 3 T1DIG: T1CKI for Digital Input Clock Enable bit

1 = T1CKI is available as a digital input without enabling T1OSCEN 0 = T1CKI is not available as a digital input without enabling T1OSCEN

bit 2-0 FOSC<2:0>: Oscillator Selection bits

111 = ECPLL OSC1/OSC2 as primary; ECPLL oscillator with PLL enabled; CLKO on RA6

110 = EC OSC1/OSC2 as primary; External clock with Fosc/4 output

101 = HSPLL OSC1/OSC2 as primary; high-speed crystal/resonator with software PLL control

100 = HS OSC1/OSC2 as primary; high-speed crystal/resonator

011 = INTPLL1 internal oscillator block with software PLL control; FOSC/4 output 010 = INTIO1 internal oscillator block with FOSC/4 output on RA6 and I/O on RA7

001 = INTPLL2 internal oscillator block with software PLL control and I/O on RA6 and RA7

000 = INTIO2 internal oscillator block with I/O on RA6 and RA7

REGISTER 24-4: CONFIG2H: CONFIGURATION REGISTER 2 HIGH (BYTE ADDRESS 300003h)

U-0	U-0	U-0	U-0	R/WO-1	R/WO-1	R/WO-1	R/WO-1
(1)	_(1)	_(1)	_(1)	WDTPS3	WDTPS2	WDTPS1	WDTPS0
bit 7							bit 0

Legend:

R = Readable bit WO = Write-Once bit U = Unimplemented bit, read as '0'

-n = Value when device is unprogrammed '1' = Bit is set '0' = Bit is cleared

bit 7-4 Unimplemented: Read as '0'

bit 3-0 WDTPS<3:0>: Watchdog Timer Postscale Select bits

1111 = 1:32,768

1110 = 1:16,384

1101 = 1:8,192

1100 = 1:4,096

1011 = 1:2.048

1010 = 1:1,024

1001 = 1:512

1000 = 1:256

0111 = 1:128

0110 = 1:64

0101 = 1:32

0100 = 1:16

0011 = 1:80010 = 1:4

0001 = 1:2

0000 = 1:1

Note 1: The value of these bits in program memory should always be '1'. This ensures that the location is executed as a NOP if it is accidentally executed.

REGISTER 24-5: CONFIG3L: CONFIGURATION REGISTER 3 LOW (BYTE ADDRESS 300004h)

U-0	U-0	U-0	U-0	U-0	U-0	R/WO-1	U-0
(1)	_(1)	(1)	(1)	_	_	RTCOSC	_
bit 7							bit 0

Legend:

R = Readable bit WO = Write-Once bit U = Unimplemented bit, read as '0'

-n = Value when device is unprogrammed '1' = Bit is set '0' = Bit is cleared

bit 7-2 **Unimplemented:** Read as '0'

bit 1 RTCOSC: RTCC Reference Clock Select bit

1 = RTCC uses T1OSC/T1CKI as the reference clock

0 = RTCC uses INTRC as the reference clock

bit 0 **Unimplemented:** Read as '0'

Note 1: The value of these bits in program memory should always be '1'. This ensures that the location is executed as a NOP if it is accidentally executed.

REGISTER 24-6: CONFIG3H: CONFIGURATION REGISTER 3 HIGH (BYTE ADDRESS 300005h)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/WO-1
(1)	_(1)	_(1)	(1)	_	_	_	CCP2MX
bit 7							bit 0

Legend:

R = Readable bit WO = Write-Once bit U = Unimplemented bit, read as `0'

-n = Value when device is unprogrammed '1' = Bit is set '0' = Bit is cleared

bit 7-1 **Unimplemented:** Read as '0' bit 0 **CCP2MX:** CCP2 MUX bit

1 = CCP2 is multiplexed with RC1 0 = CCP2 is multiplexed with RE7

Note 1: The value of these bits in program memory should always be '1'. This ensures that the location is executed as a NOP if it is accidentally executed.

REGISTER 24-7: DEVID1: DEVICE ID REGISTER 1 FOR PIC18F87J90 FAMILY DEVICES

R	R	R	R	R	R	R	R
DEV2	DEV1	DEV0	REV4	REV3	REV2	REV1	REV0
bit 7							bit 0

Legend:

R = Read-only bit

bit 7-5 **DEV<2:0>:** Device ID bits

101 = PIC18F87J90

100 = PIC18F86J90

001 = PIC18F67J90

000 = PIC18F66J90

bit 4-0 **REV<4:0>:** Revision ID bits

These bits are used to indicate the device revision.

REGISTER 24-8: DEVID2: DEVICE ID REGISTER 2 FOR PIC18F87J90 FAMILY DEVICES

R	R	R	R	R	R	R	R
DEV10 ⁽¹⁾	DEV9 ⁽¹⁾	DEV8 ⁽¹⁾	DEV7 ⁽¹⁾	DEV6 ⁽¹⁾	DEV5 ⁽¹⁾	DEV4 ⁽¹⁾	DEV3 ⁽¹⁾
bit 7							bit 0

Legend:

R = Read-only bit

bit 7-0 **DEV<10:3>:** Device ID bits⁽¹⁾

These bits are used with the DEV<2:0> bits in the Device ID Register 1 to identify the part number. 0101 0000 = PIC18F87J90 family devices

Note 1: The values for DEV<10:3> may be shared with other device families. The specific device is always identified by using the entire DEV<10:0> bit sequence.

24.2 Watchdog Timer (WDT)

For PIC18F87J90 family devices, the WDT is driven by the INTRC oscillator. When the WDT is enabled, the clock source is also enabled. The nominal WDT period is 4 ms and has the same stability as the INTRC oscillator.

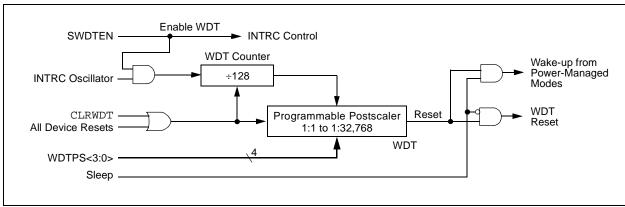
The 4 ms period of the WDT is multiplied by a 16-bit postscaler. Any output of the WDT postscaler is selected by a multiplexor, controlled by the WDTPS bits in Configuration Register 2H. Available periods range from 4 ms to 131.072 seconds (2.18 minutes). The WDT and postscaler are cleared whenever a SLEEP or CLRWDT instruction is executed, or a clock failure (primary or Timer1 oscillator) has occurred.

- **Note 1:** The CLRWDT and SLEEP instructions clear the WDT and postscaler counts when executed.
 - **2:** When a CLRWDT instruction is executed, the postscaler count will be cleared.

24.2.1 CONTROL REGISTER

The WDTCON register (Register 24-9) is a readable and writable register. The SWDTEN bit enables or disables WDT operation. This allows software to override the WDTEN Configuration bit and enable the WDT only if it has been disabled by the Configuration bit.

FIGURE 24-1: WDT BLOCK DIAGRAM



© 2009 Microchip Technology Inc. Preliminary DS39933C-page 325

REGISTER 24-9: WDTCON: WATCHDOG TIMER CONTROL REGISTER

R/W-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
REGSLP ⁽¹⁾	_	_	_	_	_	_	SWDTEN ⁽²⁾
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 **REGSLP:** Voltage Regulator Low-Power Operation Enable bit⁽¹⁾

1 = On-chip regulator enters low-power operation when device enters Sleep mode

0 = On-chip regulator continues to operate normally in Sleep mode

bit 6-1 **Unimplemented**: Read as '0'

bit 0 **SWDTEN:** Software Controlled Watchdog Timer Enable bit⁽²⁾

1 = Watchdog Timer is on0 = Watchdog Timer is off

Note 1: The REGSLP bit is automatically cleared when a Low-Voltage Detect condition occurs.

2: This bit has no effect if the Configuration bit, WDTEN, is enabled.

TABLE 24-3: SUMMARY OF WATCHDOG TIMER REGISTERS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
RCON	IPEN	_	CM	RI	TO	PD	POR	BOR	54
WDTCON	REGSLP	_	_	_	_	_	_	SWDTEN	54

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Watchdog Timer.

24.3 On-Chip Voltage Regulator

All of the PIC18F87J90 family devices power their core digital logic at a nominal 2.5V. For designs that are required to operate at a higher typical voltage, such as 3.3V, all devices in the PIC18F87J90 family incorporate an on-chip regulator that allows the device to run its core logic from VDD.

The regulator is controlled by the ENVREG pin. Tying VDD to the pin enables the regulator, which in turn, provides power to the core from the other VDD pins. When the regulator is enabled, a low-ESR filter capacitor must be connected to the VDDCORE/VCAP pin (Figure 24-2). This helps to maintain the stability of the regulator. The recommended value for the filter capacitor is provided in **Section 27.3 "DC Characteristics: PIC18F87J90 Family (Industrial)"**.

If ENVREG is tied to Vss, the regulator is disabled. In this case, separate power for the core logic at a nominal 2.5V must be supplied to the device on the VDDCORE/VCAP pin to run the I/O pins at higher voltage levels, typically 3.3V. Alternatively, the VDDCORE/VCAP and VDD pins can be tied together to operate at a lower nominal voltage. Refer to Figure 24-2 for possible configurations.

24.3.1 VOLTAGE REGULATION AND LOW-VOLTAGE DETECTION

When it is enabled, the on-chip regulator provides a constant voltage of 2.5V nominal to the digital core logic. The regulator can provide this level from a VDD of about 2.5V, all the way up to the device's VDDMAX. It does not have the capability to boost VDD levels below 2.5V.

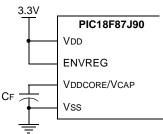
In order to prevent "brown-out" conditions, when the voltage drops too low for the regulator, the regulator enters Tracking mode. In Tracking mode, the regulator output follows VDD, with a typical voltage drop of 100 mV.

The on-chip regulator includes a simple Low-Voltage Detect (LVD) circuit. If VDD drops too low to maintain approximately 2.45V on VDDCORE, the circuit sets the Low-Voltage Detect Interrupt Flag, LVDIF (PIR2<2>) and clears the REGSLP (WDTCON<7>) bit, if it was set.

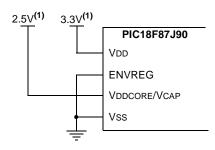
This can be used to generate an interrupt and put the application into a low-power operational mode, or trigger an orderly shutdown. Low-Voltage Detection is only available when the regulator is enabled.

FIGURE 24-2: CONNECTIONS FOR THE ON-CHIP REGULATOR

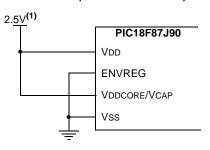
Regulator Enabled (ENVREG tied to VDD):



Regulator Disabled (ENVREG tied to ground):



Regulator Disabled (VDD tied to VDDCORE):



Note 1: These are typical operating voltages. For the full operating ranges of VDD and VDDCORE, refer to Section 27.1 "DC Characteristics: Supply Voltage PIC18F87J90 Family (Industrial)".

24.3.2 ON-CHIP REGULATOR AND BOR

When the on-chip regulator is enabled, PIC18F87J90 family devices also have a simple Brown-out Reset capability. If the voltage supplied to the regulator falls to a level that is inadequate to maintain a regulated output for full-speed operation, the regulator Reset circuitry will generate a Brown-out Reset. This event is captured by the $\overline{\text{BOR}}$ flag bit (RCON<0>).

The operation of the BOR is described in more detail in Section 4.4 "Brown-out Reset (BOR)" and Section 4.4.1 "Detecting BOR".

24.3.3 POWER-UP REQUIREMENTS

The on-chip regulator is designed to meet the power-up requirements for the device. If the application does not use the regulator, then strict power-up conditions must be adhered to. While powering up, VDDCORE must never exceed VDD by 0.3 volts.

24.3.4 OPERATION IN SLEEP MODE

When enabled, the on-chip regulator always consumes a small incremental amount of current over IDD. This includes when the device is in Sleep mode, even though the core digital logic does not require power. To provide additional savings in applications where power resources are critical, the regulator can be configured to automatically disable itself whenever the device goes into Sleep mode. This feature is controlled by the REGSLP bit (WDTCON<7>). Setting this bit disables the regulator in Sleep mode, and reduces its current consumption to a minimum.

Substantial Sleep mode power savings can be obtained by setting the REGSLP bit, but device wake-up time will increase in order to ensure the regulator has enough time to stabilize.

The REGSLP bit is automatically cleared by hardware when a Low-Voltage Detect condition occurs. The REGSLP bit can be set again in software, which would continue to keep the voltage regulator in Low-Power mode. This, however, is not recommended if any write operations to the Flash will be performed.

24.4 Two-Speed Start-up

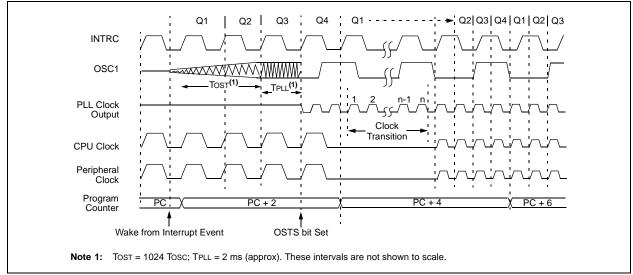
The Two-Speed Start-up feature helps to minimize the latency period, from oscillator start-up to code execution, by allowing the microcontroller to use the INTRC oscillator as a clock source until the primary clock source is available. It is enabled by setting the IESO Configuration bit.

Two-Speed Start-up should be enabled only if the primary oscillator mode is HS or HSPLL (Crystal-Based) modes. Since the EC and ECPLL modes do not require an OST start-up delay, Two-Speed Start-up should be disabled.

When enabled, Resets and wake-ups from Sleep mode cause the device to configure itself to run from the internal oscillator block as the clock source, following the time-out of the Power-up Timer after a Power-on Reset is enabled. This allows almost immediate code execution while the primary oscillator starts and the OST is running. Once the OST times out, the device automatically switches to PRI_RUN mode.

In all other power-managed modes, Two-Speed Start-up is not used. The device will be clocked by the currently selected clock source until the primary clock source becomes available. The setting of the IESO bit is ignored.





24.4.1 SPECIAL CONSIDERATIONS FOR USING TWO-SPEED START-UP

While using the INTRC oscillator in Two-Speed Start-up, the device still obeys the normal command sequences for entering power-managed modes, including serial SLEEP instructions (refer to Section 3.1.4 "Multiple Sleep Commands"). In practice, this means that user code can change the SCS1:SCS0 bit settings or issue SLEEP instructions before the OST times out. This would allow an application to briefly wake-up, perform routine "housekeeping" tasks and return to Sleep before the device starts to operate from the primary oscillator.

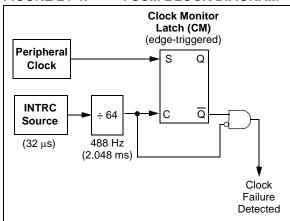
User code can also check if the primary clock source is currently providing the device clocking by checking the status of the OSTS bit (OSCCON<3>). If the bit is set, the primary oscillator is providing the clock. Otherwise, the internal oscillator block is providing the clock during wake-up from Reset or Sleep mode.

24.5 Fail-Safe Clock Monitor

The Fail-Safe Clock Monitor (FSCM) allows the microcontroller to continue operation in the event of an external oscillator failure by automatically switching the device clock to the internal oscillator block. The FSCM function is enabled by setting the FCMEN Configuration bit

When FSCM is enabled, the INTRC oscillator runs at all times to monitor clocks to peripherals and provides a backup clock in the event of a clock failure. Clock monitoring (shown in Figure 24-4) is accomplished by creating a sample clock signal which is the INTRC output divided by 64. This allows ample time between FSCM sample clocks for a peripheral clock edge to occur. The peripheral device clock and the sample clock are presented as inputs to the Clock Monitor latch (CM). The CM is set on the falling edge of the device clock source but cleared on the rising edge of the sample clock.

FIGURE 24-4: FSCM BLOCK DIAGRAM



Clock failure is tested for on the falling edge of the sample clock. If a sample clock falling edge occurs while CM is still set, a clock failure has been detected (Figure 24-5). This causes the following:

- the FSCM generates an oscillator fail interrupt by setting bit, OSCFIF (PIR2<7>);
- the device clock source is switched to the internal oscillator block (OSCCON is not updated to show the current clock source – this is the fail-safe condition); and
- · the WDT is reset.

During switchover, the postscaler frequency from the internal oscillator block may not be sufficiently stable for timing sensitive applications. In these cases, it may be desirable to select another clock configuration and enter an alternate power-managed mode. This can be done to attempt a partial recovery or execute a controlled shutdown. See Section 3.1.4 "Multiple Sleep Commands" and Section 24.4.1 "Special Considerations for Using Two-Speed Start-up" for more details.

The FSCM will detect failures of the primary or secondary clock sources only. If the internal oscillator block fails, no failure would be detected, nor would any action be possible.

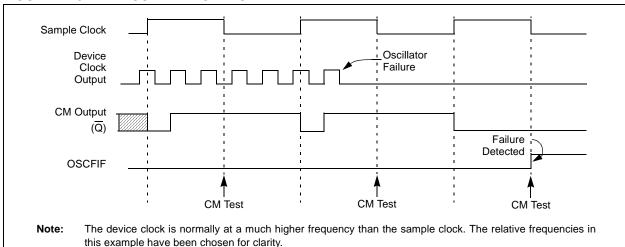
24.5.1 FSCM AND THE WATCHDOG TIMER

Both the FSCM and the WDT are clocked by the INTRC oscillator. Since the WDT operates with a separate divider and counter, disabling the WDT has no effect on the operation of the INTRC oscillator when the FSCM is enabled.

As already noted, the clock source is switched to the INTRC clock when a clock failure is detected; this may mean a substantial change in the speed of code execution. If the WDT is enabled with a small prescale value, a decrease in clock speed allows a WDT time-out to occur and a subsequent device Reset. For this reason, Fail-Safe Clock Monitor events also reset the WDT and postscaler, allowing it to start timing from when execution speed was changed and decreasing the likelihood of an erroneous time-out.

If the interrupt is disabled, subsequent interrupts while in Idle mode will cause the CPU to begin executing instructions while being clocked by the INTRC source.





24.5.2 EXITING FAIL-SAFE OPERATION

The fail-safe condition is terminated by either a device Reset or by entering a power-managed mode. On Reset, the controller starts the primary clock source specified in Configuration Register 2H (with any required start-up delays that are required for the oscillator mode, such as OST or PLL timer). The INTRC oscillator provides the device clock until the primary clock source becomes ready (similar to a Two-Speed Start-up). The clock source is then switched to the primary clock (indicated by the OSTS bit in the OSCCON register becoming set). The Fail-Safe Clock Monitor then resumes monitoring the peripheral clock.

The primary clock source may never become ready during start-up. In this case, operation is clocked by the INTOSC multiplexor. The OSCCON register will remain in its Reset state until a power-managed mode is entered.

24.5.3 FSCM INTERRUPTS IN POWER-MANAGED MODES

By entering a power-managed mode, the clock multiplexor selects the clock source selected by the OSCCON register. Fail-Safe Clock Monitoring of the power-managed clock source resumes in the power-managed mode.

If an oscillator failure occurs during power-managed operation, the subsequent events depend on whether or not the oscillator failure interrupt is enabled. If enabled (OSCFIF = 1), code execution will be clocked by the INTRC multiplexor. An automatic transition back to the failed clock source will not occur.

24.5.4 POR OR WAKE-UP FROM SLEEP

The FSCM is designed to detect oscillator failure at any point after the device has exited Power-on Reset (POR) or low-power Sleep mode. When the primary device clock is either EC or INTRC mode, monitoring can begin immediately following these events.

For HS or HSPLL modes, the situation is somewhat different. Since the oscillator may require a start-up time considerably longer than the FSCM sample clock time, a false clock failure may be detected. To prevent this, the internal oscillator block is automatically configured as the device clock and functions until the primary clock is stable (the OST and PLL timers have timed out). This is identical to Two-Speed Start-up mode. Once the primary clock is stable, the INTRC returns to its role as the FSCM source.

Note: The same logic that prevents false oscillator failure interrupts on POR, or wake from Sleep, will also prevent the detection of the oscillator's failure to start at all following these events. This can be avoided by monitoring the OSTS bit and using a timing routine to determine if the oscillator is taking too long to start. Even so, no oscillator failure interrupt will be flagged.

As noted in **Section 24.4.1 "Special Considerations for Using Two-Speed Start-up"**, it is also possible to select another clock configuration and enter an alternate power-managed mode while waiting for the primary clock to become stable. When the new power-managed mode is selected, the primary clock is disabled.

24.6 Program Verification and Code Protection

For all devices in the PIC18F87J90 family of devices, the on-chip program memory space is treated as a single block. Code protection for this block is controlled by one Configuration bit, CP0. This bit inhibits external reads and writes to the program memory space. It has no direct effect in normal execution mode.

24.6.1 CONFIGURATION REGISTER PROTECTION

The Configuration registers are protected against untoward changes or reads in two ways. The primary protection is the write-once feature of the Configuration bits which prevents reconfiguration once the bit has been programmed during a power cycle. To safeguard against unpredictable events, Configuration bit changes resulting from individual cell-level disruptions (such as ESD events) will cause a parity error and trigger a device Reset.

The data for the Configuration registers is derived from the Flash Configuration Words in program memory. When the CP0 bit set, the source data for device configuration is also protected as a consequence.

24.7 In-Circuit Serial Programming

PIC18F87J90 family microcontrollers can be serially programmed while in the end application circuit. This is simply done with two lines for clock and data and three other lines for power, ground and the programming voltage. This allows customers to manufacture boards with unprogrammed devices and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed.

24.8 In-Circuit Debugger

When the DEBUG Configuration bit is programmed to a '0', the In-Circuit Debugger functionality is enabled. This function allows simple debugging functions when used with MPLAB® IDE. When the microcontroller has this feature enabled, some resources are not available for general use. Table 24-4 shows which resources are required by the background debugger.

TABLE 24-4: DEBUGGER RESOURCES

I/O pins:	RB6, RB7
Stack:	2 levels
Program Memory:	512 bytes
Data Memory:	10 bytes

NOTES:

25.0 INSTRUCTION SET SUMMARY

The PIC18F87J90 family of devices incorporate the standard set of 75 PIC18 core instructions, as well as an extended set of 8 new instructions for the optimization of code that is recursive or that utilizes a software stack. The extended set is discussed later in this section.

25.1 Standard Instruction Set

The standard PIC18 MCU instruction set adds many enhancements to the previous PIC® MCU instruction sets, while maintaining an easy migration from these PIC MCU instruction sets. Most instructions are a single program memory word (16 bits), but there are four instructions that require two program memory locations.

Each single-word instruction is a 16-bit word divided into an opcode, which specifies the instruction type and one or more operands, which further specify the operation of the instruction.

The instruction set is highly orthogonal and is grouped into four basic categories:

- · Byte-oriented operations
- · Bit-oriented operations
- · Literal operations
- · Control operations

The PIC18 instruction set summary in Table 25-2 lists byte-oriented, bit-oriented, literal and control operations. Table 25-1 shows the opcode field descriptions.

Most byte-oriented instructions have three operands:

- 1. The file register (specified by 'f')
- 2. The destination of the result (specified by 'd')
- 3. The accessed memory (specified by 'a')

The file register designator, 'f', specifies which file register is to be used by the instruction. The destination designator, 'd', specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the WREG register. If 'd' is one, the result is placed in the file register specified in the instruction.

All **bit-oriented** instructions have three operands:

- 1. The file register (specified by 'f')
- The bit in the file register (specified by 'b')
- 3. The accessed memory (specified by 'a')

The bit field designator, 'b', selects the number of the bit affected by the operation, while the file register designator, 'f', represents the number of the file in which the bit is located.

The **literal** instructions may use some of the following operands:

- A literal value to be loaded into a file register (specified by 'k')
- The desired FSR register to load the literal value into (specified by 'f')
- No operand required (specified by '—')

The **control** instructions may use some of the following operands:

- A program memory address (specified by 'n')
- The mode of the CALL or RETURN instructions (specified by 's')
- The mode of the table read and table write instructions (specified by 'm')
- No operand required (specified by '—')

All instructions are a single word, except for four double-word instructions. These instructions were made double-word to contain the required information in 32 bits. In the second word, the 4 MSbs are '1's. If this second word is executed as an instruction (by itself), it will execute as a NOP.

All single-word instructions are executed in a single instruction cycle, unless a conditional test is true or the program counter is changed as a result of the instruction. In these cases, the execution takes two instruction cycles with the additional instruction cycle(s) executed as a NOP.

The double-word instructions execute in two instruction cycles.

One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1 μ s. If a conditional test is true, or the program counter is changed as a result of an instruction, the instruction execution time is 2 μ s. Two-word branch instructions (if true) would take 3 μ s.

Figure 25-1 shows the general formats that the instructions can have. All examples use the convention 'nnh' to represent a hexadecimal number.

The Instruction Set Summary, shown in Table 25-2, lists the standard instructions recognized by the Microchip MPASM™ Assembler.

Section 25.1.1 "Standard Instruction Set" provides a description of each instruction.

TABLE 25-1: OPCODE FIELD DESCRIPTIONS

Field	Description
a	RAM access bit:
	a = 0: RAM location in Access RAM (BSR register is ignored)
	a = 1: RAM bank is specified by BSR register
bbb	Bit address within an 8-bit file register (0 to 7).
BSR	Bank Select Register. Used to select the current RAM bank.
C, DC, Z, OV, N	ALU Status bits: Carry, Digit Carry, Zero, Overflow, Negative.
d	Destination select bit:
	d = 0: store result in WREG d = 1: store result in file register f
dest	Destination: either the WREG register or the specified register file location.
f	8-bit Register file address (00h to FFh), or 2-bit FSR designator (0h to 3h).
f _s	12-bit Register file address (000h to FFFh). This is the source address.
f _d	12-bit Register file address (000h to FFFh). This is the destination address.
GIE	Global Interrupt Enable bit.
k	Literal field, constant data or label (may be either an 8-bit, 12-bit or a 20-bit value).
label	Label name.
	The mode of the TBLPTR register for the table read and table write instructions.
mm	Only used with table read and table write instructions:
*	No Change to register (such as TBLPTR with table reads and writes)
*+	Post-Increment register (such as TBLPTR with table reads and writes)
*-	Post-Decrement register (such as TBLPTR with table reads and writes)
+*	Pre-Increment register (such as TBLPTR with table reads and writes)
n	The relative address (2's complement number) for relative branch instructions or the direct address for
	Call/Branch and Return instructions.
PC	Program Counter.
PCL	Program Counter Low Byte.
PCH	Program Counter High Byte.
PCLATH	Program Counter High Byte Latch.
PCLATU	Program Counter Upper Byte Latch.
PD	Power-Down bit.
PRODH	Product of Multiply High Byte.
PRODL	Product of Multiply Low Byte.
s	Fast Call/Return mode select bit:
	s = 0: do not update into/from shadow registers
	s = 1: certain registers loaded into/from shadow registers (Fast mode)
TBLPTR	21-bit Table Pointer (points to a Program Memory location).
TABLAT	8-bit Table Latch.
TO	Time-out bit.
TOS	Top-of-Stack.
u	Unused or Unchanged.
WDT	Watchdog Timer.
WREG	Working register (accumulator).
x	Don't care ('0' or '1'). The assembler will generate code with $x = 0$. It is the recommended form of use for compatibility with all Microchip software tools.
Z _S	7-bit offset value for Indirect Addressing of register files (source).
z _d	7-bit offset value for Indirect Addressing of register files (destination).
{ }	Optional argument.
[text]	Indicates an Indexed Address.
(text)	The contents of text.
[expr] <n></n>	Specifies bit n of the register indicated by the pointer expr.
\rightarrow	Assigned to.
< >	Register bit field.
€	In the set of.
italics	User-defined term (font is Courier New).

FIGURE 25-1: GENERAL FORMAT FOR INSTRUCTIONS

Byte-oriented file register operations **Example Instruction** 10 9 8 7 OPCODE d а f (FILE #) ADDWF MYREG, W, B d = 0 for result destination to be WREG register d = 1 for result destination to be file register (f) a = 0 to force Access Bank a = 1 for BSR to select bank f = 8-bit file register address Byte to Byte move operations (2-word) 12 11 0 OPCODE f (Source FILE #) MOVFF MYREG1, MYREG2 15 12 11 0 1111 f (Destination FILE #) f = 12-bit file register address Bit-oriented file register operations 12 11 9 8 7 OPCODE b (BIT #) а f (FILE #) BSF MYREG, bit, B b = 3-bit position of bit in file register (f) a = 0 to force Access Bank a = 1 for BSR to select bank f = 8-bit file register address Literal operations 15 MOVLW 7Fh **OPCODE** k (literal) k = 8-bit immediate value **Control** operations CALL, GOTO and Branch operations 15 0 **OPCODE** n<7:0> (literal) GOTO Label 12 11 15 0 1111 n<19:8> (literal) n = 20-bit immediate value 15 CALL MYFUNC **OPCODE** n<7:0> (literal) 15 12 11 1111 n<19:8> (literal) S = Fast bit 15 11 10 0 OPCODE n<10:0> (literal) BRA MYFUNC 15 8 7 OPCODE BC MYFUNC n<7:0> (literal)

TABLE 25-2: PIC18F87J90 FAMILY INSTRUCTION SET

Mnemo	nic,	Description	Cycles	16-E	Bit Instr	uction V	Vord	Status	Notes
Operar	nds	Description	Cycles	MSb			LSb	Affected	Notes
BYTE-ORIE	ENTED (PERATIONS							
ADDWF	f, d, a	Add WREG and f	1	0010	01da	ffff	ffff	C, DC, Z, OV, N	1, 2
ADDWFC	f, d, a	Add WREG and Carry bit to f	1	0010	00da	ffff	ffff	C, DC, Z, OV, N	1, 2
ANDWF	f, d, a	AND WREG with f	1	0001	01da	ffff	ffff	Z, N	1,2
CLRF	f, a	Clear f	1	0110	101a	ffff	ffff	Z	2
COMF	f, d, a	Complement f	1	0001	11da	ffff	ffff	Z, N	1, 2
CPFSEQ	f, a	Compare f with WREG, Skip =	1 (2 or 3)	0110	001a	ffff	ffff	None	4
CPFSGT	f, a	Compare f with WREG, Skip >	1 (2 or 3)	0110	010a	ffff	ffff	None	4
CPFSLT	f, a	Compare f with WREG, Skip <	1 (2 or 3)	0110	000a	ffff	ffff	None	1, 2
DECF	f, d, a	Decrement f	1	0000	01da	ffff	ffff	C, DC, Z, OV, N	1, 2, 3, 4
DECFSZ	f, d, a	Decrement f, Skip if 0	1 (2 or 3)	0010	11da	ffff	ffff	None	1, 2, 3, 4
DCFSNZ	f, d, a	Decrement f, Skip if Not 0	1 (2 or 3)	0100	11da	ffff	ffff	None	1, 2
INCF	f, d, a	Increment f	1	0010	10da	ffff	ffff	C, DC, Z, OV, N	1, 2, 3, 4
INCFSZ	f, d, a	Increment f, Skip if 0	1 (2 or 3)	0011	11da	ffff	ffff	None	4
INFSNZ	f, d, a	Increment f, Skip if Not 0	1 (2 or 3)	0100	10da	ffff	ffff	None	1, 2
IORWF	f, d, a	Inclusive OR WREG with f	1 `	0001	00da	ffff	ffff	Z, N	1, 2
MOVF	f, d, a	Move f	1	0101	00da	ffff	ffff	Z, N	1
MOVFF	f_s, f_d	Move f _s (source) to 1st word	2	1100	ffff	ffff	ffff	None	
	o	f _d (destination) 2nd word		1111	ffff	ffff	ffff		
MOVWF	f, a	Move WREG to f	1	0110	111a	ffff	ffff	None	
MULWF	f, a	Multiply WREG with f	1	0000	001a	ffff	ffff	None	1, 2
NEGF	f, a	Negate f	1	0110	110a	ffff	ffff	C, DC, Z, OV, N	
RLCF	f, d, a	Rotate Left f through Carry	1	0011	01da	ffff	ffff	C, Z, N	1, 2
RLNCF	f, d, a	Rotate Left f (No Carry)	1	0100	01da	ffff	ffff	Z, N	
RRCF	f, d, a	Rotate Right f through Carry	1	0011	00da	ffff	ffff	C, Z, N	
RRNCF	f, d, a	Rotate Right f (No Carry)	1	0100	00da	ffff	ffff	Z, N	
SETF	f, a	Set f	1	0110	100a	ffff	ffff	None	1, 2
SUBFWB	f, d, a	Subtract f from WREG with	1	0101	01da	ffff	ffff	C, DC, Z, OV, N	
		Borrow							
SUBWF	f, d, a	Subtract WREG from f	1	0101	11da	ffff	ffff	C, DC, Z, OV, N	1, 2
SUBWFB	f, d, a	Subtract WREG from f with	1	0101	10da	ffff		C, DC, Z, OV, N	
		Borrow							
SWAPF	f, d, a	Swap Nibbles in f	1	0011	10da	ffff	ffff	None	4
TSTFSZ	f, a	Test f, Skip if 0	1 (2 or 3)	0110	011a	ffff	ffff	None	1, 2
XORWF	f, d, a	Exclusive OR WREG with f	1 ` ′	0001	10da	ffff	ffff	Z, N	

Note 1: When a PORT register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

^{2:} If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned.

^{3:} If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

^{4:} Some instructions are two-word instructions. The second word of these instructions will be executed as a NOP unless the first word of the instruction retrieves the information embedded in these 16 bits. This ensures that all program memory locations have a valid instruction.

TABLE 25-2: PIC18F87J90 FAMILY INSTRUCTION SET (CONTINUED)

Mnemo	onic,	Description	Cycles	16-E	Bit Instr	uction V	Vord	Status	Notes
Opera	nds	Description	Cycles	MSb			LSb	Affected	Notes
BIT-ORIEN	ITED OP	ERATIONS							
BCF	f, b, a	Bit Clear f	1	1001	bbba	ffff	ffff	None	1, 2
BSF	f, b, a	Bit Set f	1	1000	bbba	ffff	ffff	None	1, 2
BTFSC	f, b, a	Bit Test f, Skip if Clear	1 (2 or 3)	1011	bbba	ffff	ffff	None	3, 4
BTFSS	f, b, a	Bit Test f, Skip if Set	1 (2 or 3)	1010	bbba	ffff	ffff	None	3, 4
BTG	f, b, a	Bit Toggle f	1	0111	bbba	ffff	ffff	None	1, 2
CONTROL	OPERA	TIONS		•					•
ВС	n	Branch if Carry	1 (2)	1110	0010	nnnn	nnnn	None	
BN	n	Branch if Negative	1 (2)	1110	0110	nnnn	nnnn	None	
BNC	n	Branch if Not Carry	1 (2)	1110	0011	nnnn	nnnn	None	
BNN	n	Branch if Not Negative	1 (2)	1110	0111	nnnn	nnnn	None	
BNOV	n	Branch if Not Overflow	1 (2)	1110	0101	nnnn	nnnn	None	
BNZ	n	Branch if Not Zero	1 (2)	1110	0001	nnnn	nnnn	None	
BOV	n	Branch if Overflow	1 (2)	1110	0100	nnnn	nnnn	None	
BRA	n	Branch Unconditionally	2	1101	0nnn	nnnn	nnnn	None	
BZ	n	Branch if Zero	1 (2)	1110	0000	nnnn	nnnn	None	
CALL	n, s	Call Subroutine 1st word	2	1110	110s	kkkk	kkkk	None	
		2nd word		1111	kkkk	kkkk	kkkk		
CLRWDT	_	Clear Watchdog Timer	1	0000	0000	0000	0100	TO, PD	
DAW	_	Decimal Adjust WREG	1	0000	0000	0000	0111	С	
GOTO	n	Go to Address 1st word	2	1110	1111	kkkk	kkkk	None	
		2nd word		1111	kkkk	kkkk	kkkk		
NOP	_	No Operation	1	0000	0000	0000	0000		
NOP	_	No Operation	1	1111	XXXX	XXXX	xxxx		4
POP	_	Pop Top of Return Stack (TOS)	1	0000	0000	0000	0110	None	
PUSH	_	Push Top of Return Stack (TOS)	1	0000	0000	0000	0101	None	
RCALL	n	Relative Call	2	1101	1nnn	nnnn	nnnn		
RESET		Software Device Reset	1	0000	0000	1111	1111	All	
RETFIE	S	Return from Interrupt Enable	2	0000	0000	0001	000s	GIE/GIEH,	
								PEIE/GIEL	
RETLW	k	Return with Literal in WREG	2	0000	1100	kkkk	kkkk		
RETURN	S	Return from Subroutine	2	0000	0000	0001		<u>None</u>	
SLEEP	_	Go into Standby mode	1	0000	0000	0000	0011	TO, PD	

Note 1: When a PORT register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

- 2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned.
- 3: If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.
- **4:** Some instructions are two-word instructions. The second word of these instructions will be executed as a NOP unless the first word of the instruction retrieves the information embedded in these 16 bits. This ensures that all program memory locations have a valid instruction.

© 2009 Microchip Technology Inc. Preliminary DS39933C-page 337

TABLE 25-2: PIC18F87J90 FAMILY INSTRUCTION SET (CONTINUED)

Mnemo	onic,	Description	Cycles	16-1	Bit Inst	ruction	Word	Status	Notes
Opera	nds	Description	Cycles	MSb			LSb	Affected	Notes
LITERAL (PERATI	IONS							
ADDLW	k	Add Literal and WREG	1	0000	1111	kkkk	kkkk	C, DC, Z, OV, N	
ANDLW	k	AND Literal with WREG	1	0000	1011	kkkk	kkkk	Z, N	
IORLW	k	Inclusive OR Literal with WREG	1	0000	1001	kkkk	kkkk	Z, N	
LFSR	f, k	Move literal (12-bit) 2nd word	2	1110	1110	OOff	kkkk	None	
		to FSR(f) 1st word		1111	0000	kkkk	kkkk		
MOVLB	k	Move Literal to BSR<3:0>	1	0000	0001	0000	kkkk	None	
MOVLW	k	Move Literal to WREG	1	0000	1110	kkkk	kkkk	None	
MULLW	k	Multiply Literal with WREG	1	0000	1101	kkkk	kkkk	None	
RETLW	k	Return with Literal in WREG	2	0000	1100	kkkk		None	
SUBLW	k	Subtract WREG from Literal	1	0000	1000	kkkk	kkkk	C, DC, Z, OV, N	
XORLW	k	Exclusive OR Literal with WREG	1	0000	1010	kkkk	kkkk	Z, N	
DATA MEN	MORY ↔	PROGRAM MEMORY OPERATION	ONS						
TBLRD*		Table Read	2	0000	0000	0000	1000	None	
TBLRD*+		Table Read with Post-Increment		0000	0000	0000	1001	None	
TBLRD*-		Table Read with Post-Decrement		0000	0000	0000	1010	None	
TBLRD+*		Table Read with Pre-Increment		0000	0000	0000	1011	None	
TBLWT*		Table Write	2	0000	0000	0000	1100	None	
TBLWT*+		Table Write with Post-Increment		0000	0000	0000	1101	None	
TBLWT*-		Table Write with Post-Decrement		0000	0000	0000	1110	None	
TBLWT+*		Table Write with Pre-Increment		0000	0000	0000	1111	None	

Note 1: When a PORT register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

- 2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned.
- 3: If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.
- 4: Some instructions are two-word instructions. The second word of these instructions will be executed as a NOP unless the first word of the instruction retrieves the information embedded in these 16 bits. This ensures that all program memory locations have a valid instruction.

25.1.1 STANDARD INSTRUCTION SET

ADD	LW	ADD Literal to W					
Synta	ax:	ADDLW	k				
Oper	ands:	$0 \leq k \leq 255$					
Oper	ation:	$(W) + k \rightarrow W$					
Status Affected: N, OV, C, DC, Z							
Enco	ding:	0000	1111	kkkk	kkkk		
Desc	ription:	The conter 8-bit literal W.					
Word	ls:	1	1				
Cycle	es:	1					
Q Cycle Activity:							
	Q1	Q2	Q3	3	Q4		
	Decode	Read literal 'k'	Proce Data		/rite to W		

Example: ADDLW 15h

 $\begin{array}{rcl} \text{Before Instruction} & & \\ W & = & 10\text{h} \\ \text{After Instruction} & & \\ W & = & 25\text{h} \end{array}$

ADDWF	ADD W to	f				
Syntax:	ADDWF	ADDWF f {,d {,a}}				
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$					
Operation:	$(W) + (f) \rightarrow$	dest				
Status Affected:	N, OV, C, E	C, Z				
Encoding:	0010	01da	fff	f	ffff	
Description:	Add W to register 'f'. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default).					
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).					
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.					
Words:	1					
Cycles:	1					
Q Cycle Activity:						
Q1	Q2	Q3		(Q 4	
Decode	Read register 'f'	Proces Data			te to nation	
Example:	ADDWE	PFG (

Example: ADDWF REG, 0, 0

Before Instruction

W = 17h REG = 0C2h

After Instruction

W = 0D9hREG = 0C2h

Note: All PIC18 instructions may take an optional label argument preceding the instruction mnemonic for use in symbolic addressing. If a label is used, the instruction format then becomes: {label} instruction argument(s).

© 2009 Microchip Technology Inc. Preliminary DS39933C-page 339

ADDWFC	ADD W and Carry bit to f				
Syntax:	ADDWFC f {,d {,a}}				
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$				
Operation:	$(W) + (f) + (C) \rightarrow dest$				
Status Affected:	N,OV, C, DC, Z				
Encoding:	0010 00da ffff ffff				
Description:	Add W, the Carry flag and data memory location 'f'. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed in data memory location 'f'. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).				
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Words:	1				
Cycles:	1				
Q Cycle Activity:					

AND	LW	AND Liter	al with W	1	
Synta	ax:	ANDLW	k		
Oper	ands:	$0 \le k \le 25$	5		
Oper	ation:	(W) .AND.	$k\toW$		
Statu	s Affected:	N, Z			
Enco	oding:	0000	1011	kkkk	kkkk
Description:		The conter 8-bit literal			
Word	ds:	1			
Cycle	es:	1			
QC	ycle Activity:				
	Q1	Q2	Q3	3	Q4
	Decode	Read literal	Proce	ess V	Vrite to
		'k'	Data	a	W
Exan	<u>nple:</u>	ANDLW	05Fh		

Before Instruction

W = A3h

After Instruction

W = 03h

Q2

Read

register 'f'

Q3

Process

Data

Q4 Write to

destination

Carry bit = 0 REG = 02h W = 50h

Q1

Decode

ANDWF	AND W with f				
Syntax:	ANDWF f {,d {,a}}				
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$				
Operation:	(W) .AND. (f) \rightarrow dest				
Status Affected:	N, Z				
Encoding:	0001 01da ffff ffff				
Description:	The contents of W are ANDed with register 'f'. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default). If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the				
	GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Words:	1				
Cycles:	1				
Q Cycle Activity:					

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

<u>Example:</u>	ANI	DWF	REG,	0,	C
Before Instructi	on				
	= =	17h C2h			
After Instruction	1				
W	=	02h C2h			

ВС		Branch if C	Branch if Carry				
Synta	ax:	BC n	BC n				
Oper	ands:	-128 ≤ n ≤ ′	127				
Oper	ation:	if Carry bit i (PC) + 2 + 2					
Statu	s Affected:	None					
Enco	ding:	1110	0010	nnnn	nnnn		
Desc	ription:	If the Carry will branch.	-	then the	program		
		added to the incremente instruction, PC + 2 + 2r	The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a two-cycle instruction.				
Word	ls:	1	1				
Cycle	es:	1(2)	1(2)				
Q C	ycle Activity: mp:						
	Q1	Q2	Q3		Q4		
	Decode	Read literal 'n'	Proces Data		Write to PC		
	No	No	No		No		
	operation	operation	operati	ion c	peration		
If No Jump:							
	Q1	Q2	Q3		Q4		
	Decode	Read literal 'n'	Proces Data		No peration		

Example:	HERE	BC	5
Before Instruction PC After Instruction	=	address	(HERE)
If Carry PC If Carry PC PC	= = = =	0;	(HERE + 12)

BCF	Bit Clear f				
Syntax:	BCF f, b {,a}				
Operands:	$0 \le f \le 255$ $0 \le b \le 7$ $a \in [0,1]$				
Operation:	$0 \rightarrow f < b >$				
Status Affected:	None				
Encoding:	1001 bbba ffff ffff				
Description:	Bit 'b' in register 'f' is cleared.				
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the				

GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 25.2.3 "Byte-Oriented and **Bit-Oriented Instructions in Indexed** Literal Offset Mode" for details.

Words: Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	register 'f'

Example: BCF FLAG_REG, 7, 0

Before Instruction $FLAG_REG = C7h$ After Instruction $FLAG_REG = 47h$

BN	Branch if	Negative	•			
Syntax:	BN n	BN n				
Operands:	$-128 \le n \le 127$					
Operation:	if Negative bit is '1', $(PC) + 2 + 2n \rightarrow PC$					
Status Affected:	None					
Encoding:	1110	0110	nnnn	nnnn		
Description:	If the Negative bit is '1', then the program will branch.					
	The 2's complement number '2n' is					

instruction, the new address will be PC + 2 + 2n. This instruction is then a two-cycle instruction.

incremented to fetch the next

added to the PC. Since the PC will have

Cycles: 1(2)

Q Cycle Activity: If Jump:

Words:

Q1	Q2	Q3	Q4	
Decode	Decode Read literal		Write to	
	'n'	Data	PC	
No	No	No	No	
operation	operation	operation	operation	

If No Jump:

Q1	Q2	Q3	Q4	
Decode	Read literal	Process	No	
	ʻn'	Data	operation	

Example: HERE BN Jump

Before Instruction

PC address (HERE)

After Instruction

address (Jump)

If Negative PC If Negative PC

0; address (HERE + 2)

BNC	Branch if Not Carry				
Syntax:	BNC n				
Operands:	$-128 \le n \le 127$				
Operation:	if Carry bit is '0', $(PC) + 2 + 2n \rightarrow PC$				
Status Affected:	None				
Encoding:	1110 0011 nnnn nnnn				
Description:	If the Carry bit is '0', then the program will branch.				
	The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next				

Words: 1
Cycles: 1(2)

Q Cycle Activity: If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to
	ʻn'	Data	PC
No	No	No	No
operation	operation	operation	operation

two-cycle instruction.

instruction, the new address will be PC + 2 + 2n. This instruction is then a

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	ʻn'	Data	operation

Example:	HERE	BNC Jump
Before Instruction PC After Instruction	=	address (HERE)
If Carry PC If Carry PC	= = = =	0; address (Jump) 1; address (HERE + 2)

BNN	Branch if Not Negative				
Syntax:	BNN n				
Operands:	$-128 \le n \le 127$				
Operation:	if Negative bit is '0', $(PC) + 2 + 2n \rightarrow PC$				
Status Affected:	None				
Encoding:	1110	0111	nnnn	nnnn	
Description:	If the Negative bit is '0', then the program will branch.				
	The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a two-cycle instruction.				
Words:	1				
Cycles:	1(2)				
Q Cycle Activity:					

If Ju	mp:			
	Q1	Q2	Q3	Q4
	Decode	Read literal 'n'	Process Data	Write to PC
	No	No	No	No
	operation	operation	operation	operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	ʻn'	Data	operation

Example:	HERE	BNN	Jump
Before Instruction PC After Instruction	=	address	(HERE)
If Negative PC If Negative PC	=	0; address 1; address	(Jump) (HERE + 2)

BNOV Branch if Not Overflow						
Synta	ax:	BNOV n	BNOV n			
Oper	ands:	-128 ≤ n ≤	-128 ≤ n ≤ 127			
Oper	ration:		if Overflow bit is '0', $(PC) + 2 + 2n \rightarrow PC$			
Statu	s Affected:	None	None			
Enco	oding:	1110	0101	nnn	n	nnnn
Desc	cription:	If the Overflow bit is '0', then the program will branch.				
		The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a two-cycle instruction.				
Word	ds:	1				
Cycle	es:	1(2)				
Q Cycle Activity: If Jump:						
	Q1	Q2	Q3			Q4
	Decode	Read literal	Proce	ss	V	/rite to

	Q1	Q1 Q2		Q4	
	Decode	Read literal	Process	Write to	
		ʻn'	Data	PC	
	No	No	No	No	
	operation	operation	operation	operation	
. '		•	•		

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	ʻn'	Data	operation

Example:	HERE	BNOV	Jump
Before Instruction PC After Instruction	=	address	(HERE)
If Overflow PC If Overflow PC	=	0; address 1; address	(Jump) (HERE + 2)

BNZ	Branch if	Not Zero		
Syntax:	BNZ n			
Operands:	-128 ≤ n ≤	127		
Operation:	if Zero bit is '0', (PC) + 2 + 2n \rightarrow PC			
Status Affected:	None			
Encoding:	1110	0001	nnnn	nnnn
Description:	If the Zero will branch	-	then the p	rogram
	The 2's co added to the incremental instruction PC + 2 + 2 two-cycle	he PC. Sined to fetch the new 2n. This in	nce the PC n the next address wastruction is	will have
Words:	1			
Cycles:	1(2)			
Q Cycle Activity: If Jump:				

	Q1	Q2	Q3	Q4
	Decode	Read literal	Process	Write to
		'n'	Data	PC
	No	No	No	No
	operation	operation	operation	operation
١c	lumn:			

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	ʻn'	Data	operation

Example: HERE BNZ Jump

Before Instruction
PC = address (HERE)

After Instruction

If Zero = 0;
PC = address (Jump)

If Zero = 1;
PC = address (HERE + 2)

BRA	Unconditional Branch			
Syntax:	BRA n			
Operands:	$-1024 \le n \le 1023$			
Operation:	$(PC) + 2 + 2n \rightarrow PC$			
Status Affected:	None			
Encoding:	1101 Onnn nnnn nnnn			
Description:	Add the 2's complement number '2n' to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is a			

Words: 1 Cycles: 2

Q Cycle Activity:

	Q1	Q2	Q3	Q4
ſ	Decode	Read literal	Process	Write to
		ʻn'	Data	PC
ĺ	No	No	No	No
	operation	operation	operation	operation

two-cycle instruction.

Example: HERE BRA Jump

Before Instruction

PC = address (HERE)

After Instruction

PC = address (Jump)

BSF	Bit Set f				
Syntax:	BSF f, b {	,a}			
Operands:	$0 \le f \le 255$ $0 \le b \le 7$ $a \in [0,1]$	$0 \le b \le 7$ $a \in [0,1]$			
Operation:	$1 \rightarrow f{<}b{>}$				
Status Affected:	None				
Encoding:	1000	bbba	ffff	ffff	
Description:	Bit 'b' in req	gister 'f' is	s set.		
	If 'a' is '0', t If 'a' is '1', t GPR bank	he BSR i	s used to		
	If 'a' is '0' and the extended instruction set is enabled, this instruction operate in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexe Literal Offset Mode" for details.				
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3		Q4	
Decode	Read	Proce	SS	Write	

Example: BSF FLAG_REG, 7, 1

register 'f'

Data

register 'f'

DS39933C-page 345

Before Instruction

FLAG_REG = 0Ah

After Instruction

FLAG_REG = 8Ah

BTFSC		Bit Test File	, Skip if Clear		BTFS	ss	Bit Test File	, Skip if Set	
Syntax:		BTFSC f, b	{,a}		Synta	ax:	BTFSS f, b {	,a}	
Operands: $ 0 \leq f \leq 255 \\ 0 \leq b \leq 7 \\ a \in [0,1] $		Oper	ands:	$0 \le f \le 255$ $0 \le b < 7$ $a \in [0,1]$					
Operation: $skip if (f < b >) = 0$		Oper	ation:	skip if (f)	= 1				
Status Affecte	ed:	None			Statu	s Affected:	None		
Encoding:		1011	bbba ff	ff ffff	Enco	ding:	1010	bbba ff	ff ffff
Description: If bit instruction in the current and		instruction is the next instruction current instru and a NOP is	If bit 'b' in register 'f' is '0', then the next instruction is skipped. If bit 'b' is '0', then the next instruction fetched during the current instruction execution is discarded and a NOP is executed instead, making this a two-cycle instruction.		Desc	ription:	instruction is the next instruction current instru and a NOP is	gister 'f' is '1', the skipped. If bit ruction fetched uction execution executed instruction.	'b' is '1', then during the in is discarded ead, making
		If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).					•	BSR is used to	is selected. If a select the
		is enabled, the Indexed Lite whenever f ≤ Section 25.2 Bit-Oriented	d the extended his instruction ral Offset Addr § 95 (5Fh). See 2.3 "Byte-Orie I Instructions et Mode" for d	essing mode ented and in Indexed			set is enable Indexed Lite whenever f ≤ Section 25.2 Bit-Oriented	d the extended d, this instructi ral Offset Addr s 95 (5Fh). See 2.3 "Byte-Orie I Instructions Mode" for d	on operates in essing mode ented and in Indexed
Words:		1			Word	s:	1		
Cycles:			cles if skip and 2-word instruc		Cycle	es:		cles if skip an 2-word instru	
Q Cycle Activ	vity:				Q C	cle Activity:			
Q1	l .	Q2	Q3	Q4		Q1	Q2	Q3	Q4
Deco	de	Read register 'f'	Process Data	No operation		Decode	Read register 'f'	Process Data	No operation
If skip:					If sk				
Q1		Q2	Q3	Q4		Q1	Q2	Q3	Q4
No operat		No operation	No operation	No operation		No operation	No operation	No operation	No operation
	-	by 2-word ins	· · · · · · · · · · · · · · · · · · ·	operation	lf ek		d by 2-word ins	· · · · · · · · · · · · · · · · · · ·	operation
Q1		Q2	Q3	Q4	II OK	Q1	Q2	Q3	Q4
No		No	No	No No		No	No	No	No No
operat		operation	operation	operation		operation	operation	operation	operation
No	1	No	No	No		No	No	No	No
operat	tion	operation	operation	operation		operation	operation	operation	operation
Example:		HERE BTFALSE :	TFSC FLAG	t, 1, 0	Exam	nple:	HERE BT FALSE : TRUE :	FSS FLAG	, 1, 0
		= add n l> = 0; = add l> = 1;	ress (HERE) ress (TRUE) ress (FALSE)		Before Instruc PC After Instructio If FLAG< PC If FLAG< PC	= add on 1> = 0; = add 1> = 1;	ress (HERE) ress (FALSE ress (TRUE))

BTG	Bit Toggle	e f		
Syntax:	BTG f, b {,a}			
Operands:	$0 \le f \le 255$ $0 \le b < 7$ $a \in [0,1]$			
Operation:	$(\overline{f < b >}) \rightarrow f$			
Status Affected:	None			
Encoding:	0111	bbba	ffff	ffff
Description:	Bit 'b' in dinverted.	ata memor	y location	'f' is
	,	the Acces the BSR is (default).		
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.			operates essing See ed and Indexed
Words:	1			

Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	register 'f'

Example: PORTC, 4, 0 BTG

Before Instruction:

PORTC = 0111 0101 **[75h]**

After Instruction:

PORTC = 0110 0101 [65h]

BOV	Branch if Overflow		
Syntax:	BOV n		
Operands:	$-128 \le n \le 127$		
Operation:	if Overflow bit is '1', $(PC) + 2 + 2n \rightarrow PC$		
Status Affected:	None		
Encoding:	1110 0100 nnnn nnnn		
Description:	If the Overflow bit is '1', then the program will branch.		
	The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be		

Words: Cycles: 1(2)

Q Cycle Activity: If Jump:

_	Q1	Q2	Q3	Q4
	Decode	Read literal	Process	Write to PC
		'n'	Data	
	No	No	No	No
	operation	operation	operation	operation

two-cycle instruction.

PC + 2 + 2n. This instruction is then a

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	ʻn'	Data	operation

Example: HERE BOV Jump

Before Instruction

PC address (HERE)

After Instruction

If Overflow PC

address (Jump) If Overflow PC

address (HERE + 2)

BZ	Branch if Zero			
Syntax:	BZ n			
Operands:	$-128 \le n \le 127$			
Operation:	if Zero bit is '1', $(PC) + 2 + 2n \rightarrow PC$			
Status Affected:	None			
Encoding:	1110 0000 nnnn nnnn			
Description:	If the Zero bit is '1', then the program will branch.			
	The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be			

Words: Cycles: 1(2)

Q Cycle Activity: If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to
	ʻn'	Data	PC
No	No	No	No
operation	operation	operation	operation

two-cycle instruction.

PC + 2 + 2n. This instruction is then a

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	ʻn'	Data	operation

Example: HERE BZJump

Before Instruction

PC address (HERE)

After Instruction

If Zero PC

address (Jump) If Zero

PC address (HERE + 2)

CALL	Subroutine Call			
Syntax:	CALL k {	,s}		
Operands:	$0 \le k \le 104$ $s \in [0,1]$	48575		
Operation:	$\begin{split} &(\text{PC}) + 4 \rightarrow \text{TOS}, \\ &k \rightarrow \text{PC} < 20:1 >; \\ &\text{if s} = 1 \\ &(\text{W}) \rightarrow \text{WS}, \\ &(\text{STATUS}) \rightarrow \text{STATUSS}, \\ &(\text{BSR}) \rightarrow \text{BSRS} \end{split}$			
Status Affected:	None			
Encoding: 1st word (k<7:0>) 2nd word(k<19:8>)	1110 1111	110s k ₁₉ kkk	k ₇ kkk kkkk	kkkk ₀ kkkk ₈

Description: Subroutine call of entire 2-Mbyte memory range. First, return address

> (PC+4) is pushed onto the return stack. If 's' = 1, the W, STATUS and BSR registers are also pushed into their respective shadow registers, WS, STATUSS and BSRS. If 's' = 0, no update occurs (default). Then, the 20-bit value 'k' is loaded into PC<20:1>.

CALL is a two-cycle instruction.

Words: 2 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal	Push PC to	Read literal
	'k'<7:0>,	stack	'k'<19:8>,
			Write to PC
No	No	No	No
operation	operation	operation	operation

Example: CALL THERE, 1 HERE

Before Instruction

PC address (HERE)

After Instruction

address (THERE) address (HERE + 4) PC TOS WS

= BSR STATUS BSRS STATUSS =

CLRF	Clear f			
Syntax:	CLRF f {,a}			
Operands:	$0 \le f \le 255$ a $\in [0,1]$			
Operation:	$000h \to f,$ $1 \to Z$			
Status Affected:	Z			
Encoding:	0110 101a	ffff	ffff	
Description:	Clears the contents of the specified register.			
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).			
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 25.2.3 "Byte-Oriented and			

Words: 1
Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	register 'f'

Bit-Oriented Instructions in Indexed

Literal Offset Mode" for details.

Example:
CLRF FLAG_REG,1

Before Instruction

FLAG_REG = 5Ah

After Instruction

 $FLAG_REG = 00h$

CLR	CLRWDT Clear Watchdog Timer						
Synta	ax:	CLRWDT					
Oper	ands:	None					
Oper	Operation: $000h \rightarrow WDT$, $000h \rightarrow WDT$ postscaler, $1 \rightarrow \overline{TO}$, $1 \rightarrow \overline{PD}$						
Statu	s Affected:	TO, PD	TO, PD				
Enco	ding:	0000	0000	000	0 0	0100	
Desc	ription:	CLRWDT instruction resets the Watchdog Timer. It also resets the post-scaler of the WDT. Status bits, $\overline{\text{TO}}$ and $\overline{\text{PD}}$, are set.					
Word	ls:	1					
Cycles:		1	1				
Q Cycle Activity:							
	Q1	Q2	Q3			Q4	
	Decode	No	Proce	SS		No	

Example: CLRWDT

Before Instruction

WDT Counter = ?

operation

Data

operation

After Instruction

COMF	Complem	ent f		
Syntax:	COMF 1	f {,d {,a}}		
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$	5		
Operation:	$\overline{f} \to dest$			
Status Affected:	N, Z			
Encoding:	0001	11da	ffff	ffff
Description:	The contents of register 'f' are complemented. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default).			
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).			
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.			operates essing See ed and Indexed
Words:	1			
Cycles:	1			
Q Cycle Activity:				
Q1	Q2	Q	3	Q4

Example:		OMF	REG,	0,	0
Before Instru	ıction				
REG	=	13h			
After Instruct	tion				
REG	=	13h			
١٨/	_	ECh			

Read

register 'f'

Process

Data

Write to

destination

Decode

CPFSEQ Compare f with W, Skip if f = W						
Syntax:	CPFSEQ	f {,a}				
Operands:	$0 \le f \le 255$ $a \in [0,1]$					
Operation:	(f) – (W), skip if (f) = (W) (unsigned comparison)					
Status Affected:	None					
Encoding:	0110	001a fff	f ffff			
Description:	location 'f' t	he contents of o the contents an unsigned s	of W by			
	discarded a	en the fetched nd a NOP is ex king this a two	recuted			
		he Access Bar ne BSR is use (default).				
	set is enabl in Indexed I mode when Section 25 Bit-Oriente	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Words:	1					
Cycles:		Note: 3 cycles if skip and followed				
	by a	2-word instruc	ction.			
Q Cycle Activity: Q1	Q2	Q3	Q4			
Decode	Read	Process	No			
200000	register 'f'	Data	operation			
If skip:						
Q1	Q2	Q3	Q4			
No	No	No	No			
operation If skip and follower	operation	operation	operation			
Q1	Q2	Q3	Q4			
No	No.	No	No No			
operation	operation	operation	operation			
No	No	No	No			
operation	operation	operation	operation			
Example:	HERE	CPFSEQ REG	, 0			
·	NEQUAL	:				
	EQUAL	:				
Before Instruc						
PC Addro W	ess = HE = ?	RE				
REG	= ?					
After Instruction						
If REG PC	= W; = Ad		T.)			
If REG PC	= Address (EQUAL) ≠ W; = Address (NEQUAL)					

CPFSGT		Compare f with W, Skip if f > W		CPF	SLT	Compare f with W, Skip if f < W						
Syntax:		CPFSGT	f {,a}		Synt	ax:	CPFSLT 1	f {,a}				
Operands:		$0 \le f \le 255$ $a \in [0,1]$			Ope	Operands:		Operands: $0 \le f \le 255$ $a \in [0,1]$				
Operation:		(f) - (W), skip if $(f) > ($ (unsigned of			Ope	ration:	a ∈ [0,1] (f) − (W), skip if (f) < (W) (unsigned comparison)					
Status Affe	cted:	None			Statu	ıs Affected:	None	. ,				
Encoding:		0110	010a ff	ff ffff	Enco	oding:	0110	000a ff	ff ffff			
Description	n:	location 'f' to	the contents of the contents an unsigned s	•		cription:	Compares to location 'f' to		f data memory of W by			
		If the contents of 'f' are greater than the contents of WREG, then the fetched instruction is discarded and a NOP is executed instead, making this a two-cycle instruction. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).					If the conte contents of instruction i	nts of 'f' are le W, then the fe is discarded a istead, making	ess than the etched nd a NOP is			
							If 'a' is '0', t	he Access Ba he BSR is use	nk is selected. ed to select the			
			nd the extend		Word	ds.	1	(doladit).				
		in Indexed I mode when	ed, this instru Literal Offset A ever f ≤ 95 (5 . 2.3 "Byte-O r	Fh). See	Cycl		1(2) Note: 3 cy	cles if skip ar				
			d Instruction		0.0	and Andrew	ру а	a 2-word instru	action.			
		Literal Offs	set Mode" for	details.	QC	cycle Activity:	02	02	04			
Words:		1				Q1 Decode	Q2 Read	Q3 Process	Q4 No			
Cycles:		1(2)				Decode	register 'f'	Data	operation			
			ycles if skip a		lf sk	kip:	1 3					
		by	a 2-word instr	uction.		Q1	Q2	Q3	Q4			
Q Cycle A	_	Q2	Q3	Q4		No	No	No	No			
	Q1 code	Read	Process	No No		operation	operation	operation	operation			
	oodo	register 'f'	Data	operation	If sk	kip and followe	ed by 2-word in	struction:				
If skip:	<u> </u>			<u>, , , , , , , , , , , , , , , , , , , </u>		Q1	Q2	Q3	Q4			
(Q1	Q2	Q3	Q4		No	No	No	No			
	No	No	No	No		operation	operation	operation	operation			
	ration	operation	operation	operation		No operation	No operation	No operation	No operation			
	_	d by 2-word in:		04		operation	Operation	operation	Operation			
	Q1 No	Q2 No	Q3 No	Q4 No	Fyor	mmla.	HEDE (1			
	ration	operation	operation	operation	<u> Exal</u>	nple:		CPFSLT REG	, 1			
	No	No	No	No				• :				
	ration	operation	operation	operation		Before Instruc						
Example:		HERE NGREATER GREATER	CPFSGT RE	EG, O		PC W After Instructi	= Ad = ?	dress (HERE)			
Refore	e Instruc					PC	= Ad	dress (LESS)			
F	N SC N		dress (HERE)		If REG PC	≥ W; = Ad	dress (NLES	S)			
ľ	Instruction f REG PC f REG PC	> W; = Ad ≤ W;	dress (GREA	,								

DAW	1	Decimal A	djust W Re	egister				
Synta	ax:	DAW	DAW					
Oper	ands:	None	None					
Oper	ation:	(W<3:0>) + else	If [W<3:0> > 9] or [DC = 1], then (W<3:0>) + 6 \rightarrow W<3:0>; else (W<3:0>) \rightarrow W<3:0>					
		If [W<7:4> > 9] or [C = 1], then (W<7:4>) + 6 \rightarrow W<7:4>; C = 1; else (W<7:4>) \rightarrow W<7:4>						
Statu	s Affected:	С						
Enco	ding:	0000	0000	0000	0111			
Desc	ription:	DAW adjust resulting fro variables (e and product result.	om the earli each in pacl	er addit ked BCI	ion of two O format)			
Word	ls:	1						
Cycle	es:	1						
Q Cycle Activity:								
	Q1	Q2	Q3		Q4			
	Decode	Read register W	Process Data		Write W			

Example 1:	DA	AM.
Before Instru	ction	
W	=	A5h
С	=	0
DC	=	0
After Instruct	ion	
W	=	05h
С	=	1
DC	=	0
Example 2:		
Before Instru	ction	
W	=	CEh
С	=	0
DC	=	0
After Instruct	ion	
W	=	34h
С	=	1
DC	=	0

DEC	F	Decremen	t f			
Synta	ax:	DECF f {,c	d {,a}}			
Oper	rands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$				
Oper	ration:	$(f)-1\to de$	est			
Statu	is Affected:	C, DC, N, C	OV, Z			
Enco	oding:	0000	01da	ffff	ffff	
Desc	cription:	Decrement register 'f'. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default).				
			he BSR i	s used	is selected. to select the	
		If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Word	ds:	1				
Cycle	es:	1				
QC	ycle Activity:					
	Q1	Q2	Q3	3	Q4	
	Decode	Read register 'f'	Proce Data		Write to destination	

Example:	DI	ECF	CNT,	1,	0
Before Instruc	ction				
	=	01h			
Z	=	0			
After Instruction	on				
CNT	=	00h			
Z	=	1			

DECFSZ	Decrement	t f, Skip if 0		DCFSNZ	Dec	rement	t f, Skip if Not	: 0
Syntax:	DECFSZ 1	f {,d {,a}}		Syntax:	DCI	SNZ	f {,d {,a}}	
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$		Operands:	$d \in$	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$			
Operation:	(f) $-1 \rightarrow \text{dest}$, skip if result = 0		Operation:	` '	1 o de			
Status Affected:	None			Status Affect	ted: Non	e		
Encoding:	0010	11da ff	ff ffff	Encoding:	0	100	11da ffi	f ffff
Description:	decremente placed in W	ts of register 'ed. If 'd' is '0', /. If 'd' is '1', the control of the control	the result is he result is	Description	dec plac	remente ed in W	ts of register 'i ed. If 'd' is '0', /. If 'd' is '1', th k in register 'f'	the result is ne result is
	which is alroand a NOP in the atwo-cyc	le instruction.	is discarded stead, making		inst disc inst	ruction varded a	is not '0', the which is alread and a NOP is eaking it a two-d	dy fetched is xecuted
	If 'a' is '1', the GPR bank	he BSR is use (default).	nk is selected. ed to select the		If 'a'	is '1', tl	he Access Bai he BSR is use (default).	
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.			If 'a set in Ir mod Sec Bit-	is '0' a is enabled dexed de when tion 25 Oriente	nd the extend ed, this instructional Offset Anever $f \le 95$ (5 .2.3 "Byte-Ored Instruction	ction operates Addressing Fh). See iented and s in Indexed	
Words:	1					rai Offs	set Mode" for	details.
Cycles:		cles if skip ar 2-word instru		Words: Cycles:	1 1(2) Not		ycles if skip a	nd followed
Q Cycle Activity:						by	a 2-word instr	uction.
Q1	Q2	Q3	Q4	Q Cycle A	-			•
Decode	Read register 'f'	Process Data	Write to destination			22 ead	Q3 Process	Q4 Write to
If skip:					regis	ter 'f'	Data	destination
Q1	Q2	Q3	Q4	If skip:			00	0.4
No	No	No	No			Q2 	Q3	Q4
operation If skip and follower	operation	operation	operation			lo ation	No operation	No operation
Q1	Q2	Q3	Q4		followed by 2-			operation.
No	No No	No	No	•	•	22	Q3	Q4
operation	operation	operation	operation	N	o N	lo	No	No
No	No	No	No	oper	ation oper	ation	operation	operation
operation	operation	operation	operation	N		lo	No	No
Example:	HERE CONTINUE	DECFSZ GOTO	CNT, 1, 1 LOOP	Example:	HER ZER	.0	:	operation
Before Instru	ction				NZE	RO	:	
PC After Instructi	on	S (HERE)		Т	Instruction EMP	=	?	
CNT If CNT	= CNT - ' = 0;	1			nstruction EMP	=	TEMP – 1,	
PC	= Address	S (CONTINUE	₤)		TEMP	=	0;	
If CNT	≠ 0;				PC	=	Address (ν τ.π.Ο. \

GOTO	Unconditional Branch					
Syntax:	GOTO k					
Operands:	$0 \leq k \leq 1048575$					
Operation:	$k \rightarrow PC < 20:1 >$					
Status Affected:	None					
Encoding: 1st word (k<7:0>) 2nd word(k<19:8>)	1110 1111 k ₇ kkk kkkk ₀ 1111 k ₁₉ kkk kkkk kkkk ₈					
Description:	GOTO allows an unconditional branch anywhere within entire 2-Mbyte memory range. The 20-bit value 'k' is loaded into PC<20:1>. GOTO is always a two-cycle instruction.					
Words:	2					
Cycles:	2					

Q Cycle Activity:

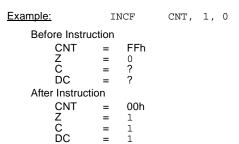
Q1	Q2	Q3	Q4
Decode	Read literal 'k'<7:0>,	No operation	Read literal 'k'<19:8>, Write to PC
No operation	No operation	No operation	No operation

Example: GOTO THERE

After Instruction

PC = Address (THERE)

INCF	Increment	f			
Syntax:	INCF f {,	d {,a}}			
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$				
Operation:	(f) + $1 \rightarrow d$	est			
Status Affected:	C, DC, N,	OV, Z			
Encoding:	0010	10da	fff	f ffff	
Description:	The contents of register 'f' are incremented. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default).				
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).				
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3		Q4	
Decode	Read register 'f'	Proces Data		Write to destination	



DS39933C-page 355

INCF	SZ	Increment	f, Skip if 0		INFS	SNZ	Increment	f, Skip if Not	0
Synta	x:	INCFSZ f	{,d {,a}}		Synt	ax:	INFSNZ f	{,d {,a}}	
Opera	ands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$			Ope	rands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$		
Opera	ation:	(f) + 1 \rightarrow description (f) the skip if results	-		Ope	ration:	(f) + 1 \rightarrow do skip if result		
Status	Affected:	None				us Affected:	None		
Encod	ding: iption:	incremente placed in W	11da ff: ts of register 'f d. If 'd' is '0', tl /. If 'd' is '1', th	are ne result is ne result is		oding: cription:	incremente placed in W	10da ff ts of register 'd. If 'd' is '0', the k in register 'f'	f' are he result is ne result is
		If the result which is alr and a NOP i	is '0', the nex eady fetched is executed instelled instruction.	t instruction s discarded			instruction discarded a	is not '0', the which is alread and a NOP is eaking it a two-d	dy fetched is xecuted
		,	he BSR is use	nk is selected. d to select the				he BSR is use	nk is selected. ed to select the
		set is enabl in Indexed mode when Section 25 Bit-Oriente	nd the extended, this instruction of the control o	ction operates Addressing Fh). See iented and s in Indexed			If 'a' is '0' and the extended ins set is enabled, this instruction of in Indexed Literal Offset Address mode whenever f ≤ 95 (5Fh). Section 25.2.3 "Byte-Oriented Bit-Oriented Instructions in In Literal Offset Mode" for detail		ction operates Addressing Fh). See iented and is in Indexed
Words	3:	1			Word	ds:	1		
Cycle	s:		cycles if skip a a 2-word instr		Cycl	es:		/cles if skip ar a 2-word instru	
Q Cv	cle Activity:	,			0.0	cycle Activity:	~, `	2	
,	Q1	Q2	Q3	Q4		Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process Data	Write to destination		Decode	Read register 'f'	Process Data	Write to destination
lf ski	p:	•	•	•	If sk	kip:			
-	Q1	Q2	Q3	Q4	Ì	Q1	Q2	Q3	Q4
	No	No	No	No		No	No	No	No
If oki	operation	operation d by 2-word in	operation	operation	14 -1	operation	operation	operation	operation
II SKI	Q1	Q2	Q3	Q4	II Sr	•	d by 2-word in		04
Г	No	No	No No	No No		Q1 No	Q2 No	Q3 No	Q4 No
	operation	operation	operation	operation		operation	operation	operation	operation
	No operation	No operation	No operation	No operation		No operation	No operation	No operation	No operation
<u>Exam</u>	ple:	NZERO	INCFSZ CN :	IT, 1, 0	<u>Exar</u>	mple:	HERE ZERO NZERO	INFSNZ REC	G, 1, 0
	Before Instruction PC After Instruction CNT If CNT PC If CNT PC PC	= Address on = CNT + 7 = 0; = Address ≠ 0;	S (HERE) 1 S (ZERO) S (NZERO)			Before Instruction PC After Instruction REG If REG PC If REG PC PC	= Address on = REG +	S (HERE) 1 S (NZERO) S (ZERO)	

IORLW	Inclusive OR Literal with W						
Syntax:	IORLW k						
Operands:	$0 \le k \le 25$	5					
Operation:	(W) .OR. k	$x \to W$					
Status Affected:	N, Z						
Encoding:	0000	1001	kkkk	kkkk			
Description:		The contents of W are ORed with the eight-bit literal 'k'. The result is placed in W.					
Words:	1						
Cycles:	1						
Q Cycle Activity:							
Q1	Q2	Q3	3	Q4			

Write to

W

Example:	TORLW	35h

Read

literal 'k'

Process

Data

 $\begin{array}{cccc} \text{Before Instruction} & & & \\ W & = & 9\text{Ah} \\ \text{After Instruction} & & \\ W & = & B\text{Fh} \end{array}$

Decode

IORV	VF	Inclusive C	OR W wi	th f		
Synta	ax:	IORWF f	{,d {,a}}			
Oper	ands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$				
Oper	ation:	(W) .OR. (f)	\rightarrow dest			
Statu	s Affected:	N, Z				
Enco	ding:	0001	00da	fff	f	ffff
Desc	ription:	Inclusive OR W with register 'f'. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default).				
		If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).				
		If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Word	ls:	1				
Cycles:		1				
Q C	ycle Activity:					
	Q1	Q2	Q3	3		Q4
	Decode	Read register 'f'	Proce Data			rite to stination

LFSR Load FSR

Syntax: LFSR f, k

Operands: $0 \le f \le 2$ $0 \le k \le 4095$ Operation: $k \to FSRf$ Status Affected: None

Encoding: 1110 1110 00ff k k kkk

Description: The 12-bit literal 'k' is loaded into the file select register pointed to by 'f'.

Words: 2 Cycles: 2

Q Cycle Activity:

	Q1	Q2	Q3	Q4
	Decode	Read literal	Process	Write
		'k' MSB	Data	literal 'k'
				MSB to
L				FSRfH
	Decode	Read literal	Process	Write literal
L		'k' LSB	Data	'k' to FSRfL

Example: LFSR 2, 3ABh

After Instruction

FSR2H = 03h FSR2L = ABh

MOVF	Move f			
Syntax:	MOVF f	{,d {,a}}		
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$			
Operation:	$f \to dest \\$			
Status Affected:	N, Z			
Encoding:	0101	00da	ffff	ffff
Description:	The contents of register 'f' are moved to a destination dependent upon the status of 'd'. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default). Location 'f' can be anywhere in the 256-byte bank.			
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).			
If 'a' is '0' and the extended instru set is enabled, this instruction ope in Indexed Literal Offset Addressi			operates	

Words: 1 Cycles: 1

Q Cycle Activity:

	Q1	Q2	Q3	Q4
Ī	Decode	Read	Process	Write
		register 'f'	Data	W

mode whenever f \leq 95 (5Fh). See Section 25.2.3 "Byte-Oriented and

Literal Offset Mode" for details.

Bit-Oriented Instructions in Indexed

Example: MOVF REG, 0, 0

Before Instruction

REG = 22h W = FFh

After Instruction

REG = 22h W = 22h

MOVFF	Move f to f		
Syntax:	MOVFF f _s ,f _d		
Operands:	$0 \le f_s \le 4095$ $0 \le f_d \le 4095$		
Operation:	$(f_s) \rightarrow f_d$		
Status Affected:	None		
Encoding: 1st word (source) 2nd word (destin.)	1100 ffff ffff ffffs 1111 ffff ffff ffffd		
Description:	The contents of source register 'f _s ' are moved to destination register 'f _d '. Location of source 'f _s ' can be anywhere		

Location of source 'f_s' can be anywher in the 4096-byte data space (000h to FFFh) and location of destination 'f_d' can also be anywhere from 000h to FFFh.

Either source or destination can be W

(a useful special situation).

MOVFF is particularly useful for transferring a data memory location to a peripheral register (such as the transmit buffer or an I/O port).

The ${\tt MOVFF}$ instruction cannot use the PCL, TOSU, TOSH or TOSL as the

destination register

Words: 2 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f' (src)	Process Data	No operation
Decode	No operation No dummy read	No operation	Write register 'f' (dest)

Example: MOVFF REG1, REG2

Before Instruction

 $\begin{array}{rcl} \mathsf{REG1} & = & 33\mathsf{h} \\ \mathsf{REG2} & = & 11\mathsf{h} \end{array}$

After Instruction

REG1 = 33h REG2 = 33h

MOV	LB	Move Literal to Low Nibble in BSR				
Synta	ax:	MOVLW k				
Oper	ands:	$0 \le k \le 255$	$0 \leq k \leq 255$			
Oper	ation:	$k \to BSR$				
Statu	s Affected:	None				
Enco	ding:	0000	0000 0001 kkkk kkkk			
Description: The eight-bit literal 'k' is loaded Bank Select Register (BSR). To f BSR<7:4> always remains 'regardless of the value of k ₇ :k ₄). The value ns '0'			
Words: 1						
Cycle	Cycles: 1					
Q Cycle Activity:						
	Q1	Q2	Q3	3	Q4	
	Decode	Read	Proce	ess '	Write literal	
		literal 'k'	Data	а	'k' to BSR	

Example: MOVLB 5

Before Instruction

BSR Register = 02h

After Instruction

BSR Register = 05h

MOVLW	Move Literal to W			
Syntax:	MOVLW	k		
Operands:	$0 \le k \le 25$	5		
Operation:	$k\toW$			
Status Affected:	None			
Encoding:	0000	1110	kkkk	kkkk
Description:	The eight-	bit literal '	k' is loade	d into W.
Words:	1			
Cycles:	1			
Q Cycle Activity:				

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	literal 'k'	Data	W

Example: MOVLW 5Ah

After Instruction

W 5Ah

MOVWF	Move W to f		
Syntax:	MOVWF f {,a}		
Operands:	$0 \le f \le 255$ a $\in [0,1]$		
Operation:	$(W) \rightarrow f$		
Status Affected:	None		
Encoding:	0110 111a ffff fff	f	
Description:	Move data from W to register 'f'. Location 'f' can be anywhere in the 256-byte bank.		
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the		

GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 25.2.3 "Byte-Oriented and **Bit-Oriented Instructions in Indexed** Literal Offset Mode" for details.

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	register 'f'

Example: MOVWF REG, 0

Before Instruction

4Fh FFh REG

After Instruction

REG 4Fh

MULLW	Multiply Literal with W			
Syntax:	MULLW	k		
Operands:	$0 \leq k \leq 255$			
Operation:	(W) $x k \rightarrow PRODH:PRODL$			
Status Affected:	None			
Encoding:	0000	1101	kkkk	kkkk
Description:	An unsigne out betwee 8-bit literal placed in the pair. PROD	en the cor 'k'. The ' he PROD	ntents of V 16-bit resu H:PRODI	V and the Ilt is register
	W is uncha	anged.		
	None of the	e Status f	lags are a	iffected.
	Note that n possible in is possible	this oper	ation. A Z	•
\\/	4			

Words: Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
İ	literal 'k'	Data	registers
			PRODH:
			PRODL

Example: MULLW 0C4h

Before Instruction

E2h ? PRODH = PRODL After Instruction

> PRODH ADh **PRODL** 08h

MULWF	Multiply W with f		
Syntax:	MULWF f {,a}		
Operands:	$0 \le f \le 255$ a $\in [0,1]$		
Operation:	(W) x (f) \rightarrow PRODH:PRODI		

Status Affected: None

Encoding: 0000 001a ffff ffff An unsigned multiplication is carried out Description: between the contents of W and the

register file location 'f'. The 16-bit result is stored in the PRODH:PRODL register pair. PRODH contains the high byte. Both

W and 'f' are unchanged.

None of the Status flags are affected. Note that neither Overflow nor Carry is possible in this operation. A Zero result is

possible but not detected.

If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the

GPR bank (default).

If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode

whenever $f \le 95$ (5Fh). See

Section 25.2.3 "Byte-Oriented and **Bit-Oriented Instructions in Indexed** Literal Offset Mode" for details.

Words: Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write registers PRODH: PRODI
			FRODE

Example: MULWF REG, 1

Before Instruction

W C4h B5h REG PRODH PRODL

After Instruction

W C4h REG B5h PRODH 8Ah PRODL 94h

NEGF	Negate f			
Syntax:	NEGF f	{,a}		
Operands:	$0 \le f \le 255$ $a \in [0,1]$	i		
Operation:	$(\overline{f}) + 1 \rightarrow f$			
Status Affected:	N, OV, C, I	DC, Z		
Encoding:	0110	110a	ffff	ffff
Description:	Location 'f compleme data memo If 'a' is '0', If 'a' is '1', GPR bank	nt. The re ory location the Acces the BSR i	esult is place on 'f'. ss Bank is s used to	ced in the selected.
	If 'a' is '0' a set is enab in Indexed mode whe Section 2! Bit-Orient Literal Off	and the expled, this in Literal On the property of the propert	xtended in nstruction ffset Addre 95 (5Fh). te-Oriente actions in	operates essing See ed and Indexed
Morde:	1			

Words: 1
Cycles: 1
Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	register 'f'

Example: NEGF REG, 1

Before Instruction

REG = 0011 1010 [3Ah]

After Instruction

REG = 1100 0110 [C6h]

NOP		No Operation				
Synta	ax:	NOP				
Oper	ands:	None				
Oper	ation:	No operation				
Statu	s Affected:	None				
Enco	ding:	0000	0000	000	0	0000
		1111	XXXX	XXX	x	XXXX
Desc	ription:	No operati	on.			
Word	ls:	1				
Cycle	es:	1				
Q C	ycle Activity:					
	Q1	Q2	Q3	3		Q4
	Decode	No	No			No
		operation	opera	tion	op	eration

Example:

None.

РОР		Pop Top of Return Stack					
Synta	ax:	POP					
Oper	ands:	None	None				
Oper	ation:	$(TOS) \rightarrow b$	$(TOS) \rightarrow bit bucket$				
Statu	s Affected:	None					
Enco	ding:	0000	0000	0000	0110		
Description: The TOS value is pulled off the return stack and is discarded. The TOS value then becomes the previous value that was pushed onto the return stack. This instruction is provided to enable the user to properly manage the return stack to incorporate a software stack.			OS value alue that ack. enable he return				
Word	ls:	1					
Cycle	es:	1	1				
Q Cycle Activity:							
	Q1	Q2	Q3	1	Q4		
	Decode	No	POP T	os	No		

Example: POP GOTO NEW

operation

Before Instruction

TOS Stack (1 level down) 0031A2h 014332h

value

operation

After Instruction

TOS PC 014332h NEW

PUSH	Push Top of Return Stack			
Syntax:	PUSH			
Operands:	None			
Operation:	$(PC + 2) \rightarrow TOS$			
Status Affected:	None			
Encoding:	0000	0000	0000	0101
Description:	The PC + the return value is put This instru software sufficient then pushi	stack. The shed dov ction allow tack by m	e previous vn on the s ws implem odifying To	TOS stack. enting a OS and
Words:	1			
Cycles:	1			

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	PUSH	No	No
	PC + 2 onto	operation	operation
	return stack		

Example: Before Instruction TOS PC 345Ah

0124h

After Instruction

0126h 0126h 345Ah PC TOS Stack (1 level down)

RCALL	Relative Call			
Syntax:	RCALL r	n		
Operands:	$-1024 \le n \le 1023$			
Operation:	$(PC) + 2 \rightarrow TOS,$ $(PC) + 2 + 2n \rightarrow PC$			
Status Affected:	None			
Encoding:	1101	1nnn	nnnn	nnnn
Description:	Subroutine call with a jump up to 1K from the current location. First, return address (PC + 2) is pushed onto the stack. Then, add the 2's complement number '2n' to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is a two-cycle instruction.			
Words:	1			
Cycles:	2			

Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to PC
	'n'	Data	
	PUSH PC to stack		
No	No	No	No
operation	operation	operation	operation

Example: HERE RCALL Jump

Before Instruction

PC = Address (HERE)

After Instruction

PC = Address (Jump) TOS = Address (HERE + 2)

RES	ET	Reset				
Synta	ax:	RESET	RESET			
Oper	ands:	None	None			
Oper	ation:	Reset all registers and flags that are affected by a MCLR Reset.				
Statu	Status Affected: All					
Enco	ding:	0000 0000 1111 111			1111	
Desc	ription:	This instruction				•
Word	ls:	1				
Cycle	es:	1				
QC	ycle Activity:					
	Q1	Q2	Q3	3		Q4
	Decode	Start	No			No
		reset	operat	ion	ор	eration

Example: RESET

After Instruction

Registers = Reset Value Flags* = Reset Value

RETFIE	Return from Interrupt			
Syntax:	RETFIE {	[s}		
Operands:	$s \in [0,\!1]$			
Operation:	$(TOS) \rightarrow PC$, 1 → GIE/GIEH or PEIE/GIEL; if s = 1, $(WS) \rightarrow W$, $(STATUSS) \rightarrow STATUS$, $(BSRS) \rightarrow BSR$, PCLATU, PCLATH are unchanged			
Status Affected:	GIE/GIEH, PEIE/GIEL.			
Encoding:	0000 0000 0001 000s			
Description:	Return from interrupt. Stack is popped			

tion: Return from interrupt. Stack is popped and Top-of-Stack (TOS) is loaded into the PC. Interrupts are enabled by setting either the high or low-priority global interrupt enable bit. If 's' = 1, the contents of the shadow registers WS, STATUSS and BSRS are loaded into their corresponding registers W,

STATUS and BSR. If 's' = 0, no update of these registers occurs (default).

Words: 1 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	No	No	POP PC
	operation	operation	from stack
			Set GIEH or
			GIEL
No	No	No	No
operation	operation	operation	operation

Example: RETFIE 1

After Interrupt

DS39933C-page 364

 $\begin{array}{ccccc} \mathsf{PC} & & = & \mathsf{TOS} \\ \mathsf{W} & & = & \mathsf{WS} \\ \mathsf{BSR} & & = & \mathsf{BSRS} \\ \mathsf{STATUS} & & = & \mathsf{STATUSS} \\ \mathsf{GIE/GIEH, PEIE/GIEL} & = & 1 \end{array}$

RETLW	Return Literal to W			
Syntax:	RETLW k			
Operands:	$0 \leq k \leq 255$			
Operation:	$k \rightarrow W$, (TOS) $\rightarrow F$ PCLATU, I		are unchar	nged
Status Affected:	None			
Encoding:	0000	1100	kkkk	kkkk
Description:	W is loaded with the eight-bit literal 'k'. The program counter is loaded from the top of the stack (the return address). The high address latch (PCLATH)			

Words: 1 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	POP PC
	literal 'k'	Data	from stack,
			write to W
No	No	No	No
operation	operation	operation	operation

remains unchanged.

Example:

```
CALL TABLE ; W contains table ; offset value ; W now has ; table value : 
TABLE

ADDWF PCL ; W = offset RETLW k0 ; Begin table RETLW k1 ; : 
: RETLW kn ; End of table

Before Instruction
```

Before Instruction

W = 07h

After Instruction

W = value of kn

RET	JRN	Return from Subroutine				
Synta	ax:	RETURN	{s}		_	
Oper	ands:	$s \in [0,\!1]$	s ∈ [0,1]			
Oper	ation:	$\begin{split} &(TOS) \to PC;\\ &\text{if } s = 1,\\ &(WS) \to W,\\ &(STATUSS) \to STATUS,\\ &(BSRS) \to BSR,\\ &PCLATU, PCLATH \text{ are unchanged} \end{split}$				
Statu	s Affected:	None				
Enco	ding:	0000	0000	0001 001s		
Desc	ription:	Return from subroutine. The stack is popped and the top of the stack (TOS) is loaded into the program counter. If 's'= 1, the contents of the shadow registers WS, STATUSS and BSRS are loaded into their corresponding registers W, STATUS and BSR. If 's' = 0, no update of these registers occurs (default).				
Word	ls:	1				
Cycles: 2						
Q C	ycle Activity:					
	Q1	Q2	Q3		Q4	
	Decode	No operation	Proces Data		POP PC from stack	

Example: RETURN

No

operation

No

operation

No

operation

No

operation

After Instruction: PC = TOS

RLC	F	Rotate Left f through Carry				
Synta	ax:	RLCF f	{,d {,a}}			
Oper	ands:	$\begin{array}{l} 0 \leq f \leq 255 \\ d \in [0,1] \\ a \in [0,1] \end{array}$				
Oper	ation:	$(f) \rightarrow de$ $(f<7>) \rightarrow C$ $(C) \rightarrow dest$,	>,		
Statu	s Affected:	C, N, Z				
Enco	ding:	0011	01da	fff	f	ffff
Desc	ription:	The contents of register 'f' are rotated one bit to the left through the Carry flag. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f' (default).				
		If 'a' is '0', t If 'a' is '1', t GPR bank	he BSR i			
		If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
		С	← r	egiste	r f	<u></u>
Word	le·	1				
Cycle		1				
•	ycle Activity:	•				
Q O	Q1	Q2	Q:	3		Q4
	Decode	Read register 'f'	Proce Dat			rite to tination
<u>Exan</u>	nple:	RLCF	REC	3, 0,	0	
	Before Instruc REG	etion = 1110	0110			

RLNCF	Rotate Let	ft f (No C	arry)		
Syntax:	RLNCF	f {,d {,a}}	}		
Operands:	$0 \le f \le 255$ d $\in [0,1]$ a $\in [0,1]$	• • •			
Operation:	$(f < n >) \rightarrow d$ $(f < 7 >) \rightarrow d$		L>,		
Status Affected:	N, Z				
Encoding:	0100	01da	ffff	ffff	
Description:	one bit to t is placed in	The contents of register 'f' are rotated one bit to the left. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f' (default).			
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
	 	regi	ister f	-	
Words:	1				
Cycles:	1				
Q Cycle Activity:	'				
Q1	Q2	Q3		Q4	
Decode	Read register 'f'	Proces	ss	Write to destination	
Example: Before Instruc	RLNCF	REG,	1, 0		

0101 0111

RRCF	Rotate Rig	Rotate Right f through Carry				
Syntax:	RRCF f {,	d {,a}}				
Operands:	$\begin{array}{l} 0 \leq f \leq 255 \\ d \in [0,1] \\ a \in [0,1] \end{array}$					
Operation:	$(f) \rightarrow de$ $(f<0>) \rightarrow C$ $(C) \rightarrow dest$,	.>,			
Status Affected:	C, N, Z	C, N, Z				
Encoding:	0011	00da	ffff	ffff		
Description:	one bit to th flag. If 'd' is If 'd' is '1', t	The contents of register 'f' are rotated one bit to the right through the Carry flag. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default).				
	If 'a' is '0', ti If 'a' is '1', ti GPR bank (he BSR i	s used to			
	set is enabl in Indexed I mode when Section 25 Bit-Oriente	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
	C	re	egister f	-		
Manda.	1					
Words:	1					
Cycles:	Į					
Q Cycle Activity: Q1	Q2	Q3	ı	Q4		
Decode	Read register 'f'	Proce Data	ess	Write to estination		
Example: Before Instru REG C	RRCF ction = 1110 0 = 0	REG,	0, 0			

After Instruction REG =

RRNCF	Rotate Right f (No Carry)				
Syntax:	RRNCF f {,d {,a}}				
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$				
Operation:	$(f) \rightarrow dest,$ $(f<0>) \rightarrow dest<7>$				
Status Affected:	N, Z				
Encoding:	0100 00da ffff ffff				
Description:	The contents of register 'f' are rotated one bit to the right. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default).				
	If 'a' is '0', the Access Bank will be selected, overriding the BSR value. If 'a' is '1', then the bank will be selected as per the BSR value (default).				

If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 25.2.3 "Byte-Oriented and **Bit-Oriented Instructions in Indexed** Literal Offset Mode" for details.



Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example 1: REG, 1, 0 RRNCF

Before Instruction

REG 1101 0111

After Instruction

REG 1110 1011

Example 2: RRNCF REG, 0, 0

Before Instruction

W REG . 1101 0111

After Instruction

1110 1011 1101 0111 $^{\mathrm{W}}$ REG

SETF	Set f			
Syntax:	SETF f{	,a}		
Operands:	$0 \le f \le 255$ $a \in [0,1]$	5		
Operation:	$FFh \to f$			
Status Affected:	None			
Encoding:	0110	100a	ffff	ffff
Description:	The contents of the specified register are set to FFh. If 'a' is '0', the Access Bank is selected If 'a' is '1', the BSR is used to select the GPR bank (default).			register
	If 'a' is '0' and the extended instruct set is enabled, this instruction opera in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Index Literal Offset Mode" for details.			
Words:	1			
Cycles:	1			

Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	register 'f'

Example: SETF REG,1

Before Instruction

REG 5Ah

After Instruction

REG FFh

SLEI	ΕP	Enter Sleep Mode				
Synta	ax:	SLEEP				
Oper	ands:	None				
Oper	ation:					
Status Affected: $\overline{TO}, \overline{PD}$						
Enco	ding:	0000 0000 0000 0011				
Desc	Description: The Power-Down status bit (PD) is cleared. The Time-out status bit (is set. The Watchdog Timer and its postscaler are cleared.			bit (TO)		
		The proce with the os	•			ep mode
Word	ls:	1				
Cycle	es:	1				
QC	ycle Activity:					
	Q1	Q2	Q3			Q4
	Decode	No operation	Proces Data			Go to Sleep

Example:		SL	EEP
Before Ir	stru	ction	
TO	=	?	
PD	=	?	
After Inst	tructi	on	
TO	=	1 †	
PD	=	0	

† If WDT causes wake-up, this bit is cleared.

SUB	FWB	Subtra	ct f fr	om W with Bo	orrow
Synta	ax:	SUBF	VB f	{,d {,a}}	
Oper	ands:	$0 \le f \le$	255		
		$d \in [0,$	•		
		a ∈ [0,	-		
Oper	ation:		, ,) → dest	
Statu	is Affected:	N, OV,	C, DC	, Z	
Enco	oding:	010	1 (01da fff	f ffff
Desc	cription:	(borrov	v) from d). If 'd l' is '1',	ster 'f' and Can n W (2's compl ' is '0', the resu , the result is sefault).	ement ult is stored in
		'a' is '1	', the E	e Access Bank BSR is used to efault).	
		set is e Indexe whene Sectio Bit-Ori	nabled d Liter ver f ≤ n 25.2 ented	d the extended d, this instruction al Offset Address 95 (5Fh). See .3 "Byte-Orie Instructions t Mode" for de	on operates in essing mode nted and in Indexed
Word	ds:	1			
Cycle	es:	1			
QC	ycle Activity:				
	Q1	Q:	2	Q3	Q4
	Decode	Rea		Process	Write to
	Decode	Rea registe		Process Data	Write to destination
Exan	nple 1:	registe SUB			
Exan	nple 1: Before Instruc	registe SUB	er 'f'	Data	
<u>Exan</u>	nple 1: Before Instruc REG W	register SUB stion = 3 = 2	er 'f'	Data	
	nple 1: Before Instruc REG W C	SUB tion = 3 = 2 = 1	er 'f'	Data	
	nple 1: Before Instruc REG W	SUB tion = 3 = 2 = 1	er 'f'	Data	
	nple 1: Before Instruction REG W C After Instruction REG W	SUB tion = 3 = 2 = 1 on = F = 2	er 'f'	Data	
	nple 1: Before Instruction REG W C After Instruction REG	register SUB stion = 3 = 2 = 1 on = 5 = 0 = 0	er'f' FWB	Data REG, 1, 0	destination
	nple 1: Before Instruction REG W C After Instruction REG W C Z N	register SUB tion = 3 = 2 = 1 on = 2 = 0 = 1	er 'f' FWB F	Data REG, 1, 0	destination
	nple 1: Before Instruction REG W C After Instruction REG W C Z N nple 2:	register SUB tion = 3 = 2 = 1 on = F = 0 = 0 = 1 SUB	er'f' FWB	Data REG, 1, 0	destination
	nple 1: Before Instruction REG W C After Instruction REG W C Z N nple 2: Before Instruct	registriction = 3	er 'f' FWB F	Data REG, 1, 0	destination
	nple 1: Before Instruction REG W C After Instruction REG W C Z N nple 2: Before Instruction REG W REG W	registricon	er 'f' FWB F	Data REG, 1, 0	destination
Exan	nple 1: Before Instruction REG W C After Instruction REG W C Z N nple 2: Before Instruction REG W C	registricon = 3	er 'f' FWB F	Data REG, 1, 0	destination
Exan	nple 1: Before Instruction REG W C After Instruction REG W C Z N nple 2: Before Instruction REG W REG W	registricon = 3	er 'f' FWB F	Data REG, 1, 0	destination
Exan	nple 1: Before Instruction REG W C After Instruction REG W C Z N nple 2: Before Instruction REG W C After Instruction REG W C After Instruction REG W C After Instruction	registriction = 3	er 'f' FWB F	Data REG, 1, 0	destination
Exan	nple 1: Before Instruction REG W C After Instruction REG W C Z N nple 2: Before Instruction REG W C After Instruction REG W C Z After Instruction REG W C Z	registriction = 3	er 'f' FWB F ; r	Data REG, 1, 0 esult is negativ REG, 0, 0	destination /e
Exan	nple 1: Before Instruction REG W C After Instruction REG W C Z N nple 2: Before Instruction REG W C After Instruction REG W C Z N N N N N N N N N N N N N N N N N N	registriction = 3	er 'f' FWB F ; r FWB	Data REG, 1, 0 esult is negative REG, 0, 0	destination /e
Exan	nple 1: Before Instruction REG W C After Instruction REG W C Z N nple 2: Before Instruction REG W C C After Instruction REG W C Z N nple 2: N nple 2: N nple 3:	registriction = 3	er 'f' FWB F ; r	Data REG, 1, 0 esult is negativ REG, 0, 0	destination /e
Exan	nple 1: Before Instruction REG W C After Instruction REG W C Z N nple 2: Before Instruction REG W C C After Instruction REG W C Z N nple 3: Before Instruction REG W C Z N nple 3: Before Instruction	registrict SUB tion = 3 2 = 1 on = F = 0 = 0 0 = 1 SUB tion = 2 = 5 = 1 on = 1 = 0 = 0 = 0 SUB tion	er 'f' FWB F ; r FWB	Data REG, 1, 0 esult is negative REG, 0, 0	destination
Exan	nple 1: Before Instruction REG W C After Instruction REG W C Z N nple 2: Before Instruction REG W C After Instruction REG W C Z N nple 3: Before Instruction REG W C REG W C REG W C REG W C REG W C REG W C REG W C REG W C REG W C REG W C REG W C REG W C REG W	registricon = 3	er 'f' FWB F ; r FWB	Data REG, 1, 0 esult is negative REG, 0, 0	destination
Exan Exan	nple 1: Before Instruction REG W C After Instruction REG W C Z N nple 2: Before Instruction REG W C After Instruction REG W C Z N nple 3: Before Instruction REG W C Z N nple 3: REG W C C C REG W C C REG W C C REG W C C REG W C C REG W C C REG W C C REG W C C C REG W C C C REG W C C C C REG W C C C C REG W C C C C C REG W C C C C C C C C C C C C C C C C C C	registricon = 3	er 'f' FWB F ; r FWB	Data REG, 1, 0 esult is negative REG, 0, 0	destination
Exan Exan	nple 1: Before Instruction REG W C After Instruction REG W C Z N nple 2: Before Instruction REG W C After Instruction REG W C Z N nple 3: Before Instruction REG W C REG W C REG W C REG W C REG W C REG W C REG W C REG W C REG W C REG W C REG W C REG W C REG W	registricon = 3	er 'f' FWB F ; r FWB	Data REG, 1, 0 esult is negative REG, 0, 0	destination
Exan Exan	nple 1: Before Instruction REG W C After Instruction REG W C Z N nple 2: Before Instruction REG W C After Instruction REG W C Z After Instruction REG W C After Instruction REG W C After Instruction REG W C C After Instruction REG W C REG W REG	registriction = 3	er 'f' FWB F ; r FWB	Data REG, 1, 0 esult is negative REG, 0, 0	destination /e
Exan Exan	nple 1: Before Instruction REG W C After Instruction REG W C Z N nple 2: Before Instruction REG W C After Instruction REG W C Z N nple 3: Before Instruction REG W C After Instruction REG W C After Instruction REG W C After Instruction REG W C After Instruction REG W C After Instruction	registricon	FWB ; r FWB	Data REG, 1, 0 esult is negative REG, 0, 0	destination ve

SUB	LW	Subtract	Subtract W from Literal				
Synta	ax:	SUBLW	SUBLW k				
Oper	ands:	$0 \le k \le 25$	$0 \leq k \leq 255$				
Oper	ation:	$k-(W)\to$	$k - (W) \rightarrow W$				
Statu	atus Affected: N, OV, C, DC, Z						
Enco	ding:	0000	0000 1000 kkkk kkkk				
Desc	ription:		W is subtracted from the eight-bit literal 'k'. The result is placed in W.				
Word	ls:	1					
Cycle	es:	1					
QC	ycle Activity:						
	Q1	Q2	Q3		Q4		
	Decode	Read literal 'k'	Proces Data		Vrite to W		
Exan	nple 1:	SUBLW	02h				
	Before Instruc	tion					

Before Instruc	ction		
W	=	01h	
С	=	?	
After Instructi	on		
W	=	01h	
С	=	1	; result is positive
Z	=	0	
N	=	0	
Example 2:		SUBLW	02h

 $\begin{array}{lll} W & = & 00h \\ C & = & 1 \\ Z & = & 1 \\ N & = & 0 \end{array} ; \mbox{ result is zero}$

Example 3: SUBLW 02h

W = FFh ; (2's complement)
C = 0 ; result is negative
Z = 0
N = 1

SUBWF	Subtract W	/ from f			
Syntax:	SUBWF f	{,d {,a}}			
Operands:	$\begin{array}{l} 0 \leq f \leq 255 \\ d \in [0,1] \\ a \in [0,1] \end{array}$				
Operation:	$(f) - (W) \rightarrow dest$				
Status Affected:	N, OV, C, DC, Z				
Encoding:	0101 11da ffff ffff				
Description:	Subtract W from register 'f' (2's complement method). If 'd' is '0', the result is stored in W. If 'd' is '1', the resul is stored back in register 'f' (default).				
	If 'a' is '0', t If 'a' is '1', t GPR bank	he BSR i			
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q	3	Q4	
Decode	Read register 'f'	Proc Da		Write to estination	
Example 1:	SUBWF	REG,	1, 0		

Before Instruction REG W 3 2 ? After Instruction REG W C Z N 1 2 1 0 ; result is positive 0 Example 2: SUBWF REG, 0, 0 Before Instruction REG W 2 2 ? Ċ After Instruction REG W CZN ; result is zero 0 Example 3: SUBWF REG, 1, 0 Before Instruction REG W С After Instruction ;(2's complement) ; result is negative

SUBWFB		/ from f with Borro	ow	SWAPF		Swap f		
Syntax:	SUBWFB	f {,d {,a}}		Syntax:		SWAPF f	,d {,a}}	
Operands:	$0 \leq f \leq 255$			Operands	s:	$0 \le f \le 255$		
	d ∈ [0,1] a ∈ [0,1]					$d \in [0,1]$		
Operation:	$a \in [0,1]$ (f) - (W) - ((C) \ dest				a ∈ [0,1]		
Status Affected:	(i) = (vv) = (N, OV, C, E	•		Operation	n:	$(f<3:0>) \rightarrow$		
Encoding:	0101	10da ffff	ffff	01-1 1	((l	$(f<7:4>) \rightarrow$	dest<3:0>	
Description:		and the Carry flag		Status Af		None	<u> </u>	
Description.		er 'f' (2's compleme	` ,	Encoding		0011	10da ff	
	method). If	'd' is '0', the result	is stored	Description	on:		and lower nibb	
		s '1', the result is sto	ored back				anged. If 'd' is W. If 'd' is '1'.	
	in register "	,				•	gister 'f' (defa	
		he Access Bank is he BSR is used to s				If 'a' is '0', tl	ne Access Ba	nk is selected
	GPR bank		SCICCI IIIC					d to select the
	If 'a' is '0' a	nd the extended in:	struction			GPR bank (default).	
		led, this instruction	•					ed instruction
		Literal Offset Addre	•				ea, this instru Literal Offset <i>i</i>	ction operates Addressing
		never f ≤ 95 (5Fh). \$ 5.2.3 "Byte-Oriente					ever f ≤ 95 (5	
		ed Instructions in					2.3 "Byte-Or	
	Literal Offs	set Mode" for detail	ils.				d Instruction et Mode" for	s in Indexed
Words:	1			Words:			et wode 101	uetalis.
Cycles:	1					1		
Q Cycle Activity:				Cycles:		1		
Q1	Q2	Q3	Q4	Q Cycle	•	00	00	0.4
Decode	Read register 'f'		Vrite to stination		Q1 ecode	Q2 Read	Q3 Process	Q4 Write to
Example 1:	SUBWFB	REG, 1, 0			ccodc	register 'f'	Data	destination
Before Instru								
REG	= 19h	(0001 1001)		Example:	<u>.</u>	SWAPF R	EG, 1, 0	
w C	= 0Dh = 1	(0000 1101)		Befo	ore Instruc	tion		
After Instructi	ion				REG	= 53h		
REG W	= 0Ch = 0Dh	(0000 1011) (0000 1101)		Afte	r Instructio REG			
С	= 1	(0000 1101)			KEG	= 35h		
Z N	= 0 = 0	; result is positiv	re.					
Example 2:		REG, 0, 0						
Before Instru								
REG	= 1Bh	(0001 1011)						
W C	= 1Ah	(0001 1010)						
	= 0							
After Instructi	ion							
REG	ion = 1Bh	(0001 1011)						
REG W C	on = 1Bh = 00h = 1							
REG W	on = 1Bh = 00h	(0001 1011); result is zero						
REG W C Z	ion = 1Bh = 00h = 1 = 1							
REG W C Z N	= 1Bh = 00h = 1 = 1 = 0	; result is zero						
REG W C Z N Example 3: Before Instruc REG	SUBWFB Ction Solution Subwfb Ction ; result is zero REG, 1, 0 (0000 0011)							
REG W C Z N Example 3: Before Instru	SUBWFB STATE STA	; result is zero						
REG W C Z N Example 3: Before Instruc REG W C	son	; result is zero REG, 1, 0 (0000 0011) (0000 1101)						
REG W C Z N Example 3: Before Instruc REG W C	Subsection	; result is zero REG, 1, 0 (0000 0011) (0000 1101) (1111 0100)						
REG W C Z N Example 3: Before Instruction REG W C After Instruction REG	SUBWFB S	; result is zero REG, 1, 0 (0000 0011) (0000 1101)						
REG W C Z N Example 3: Before Instruc REG W C After Instructi REG	SUBWFB S	; result is zero REG, 1, 0 (0000 0011) (0000 1101) (1111 0100) ; [2's comp]						

TBLRD	Table Read				
Syntax:	TBLRD (*;	*+; *-; +*)			
Operands:	None				
Operation:	if TBLRD *, (Prog Mem (TBLPTR)) → TABLAT; TBLPTR – No Change if TBLRD *+, (Prog Mem (TBLPTR)) → TABLAT; (TBLPTR) + 1 → TBLPTR if TBLRD *-, (Prog Mem (TBLPTR)) → TABLAT; (TBLPTR) – 1 → TBLPTR if TBLRD +*, (TBLPTR) + 1 → TBLPTR; (Prog Mem (TBLPTR)) → TABLAT				
Status Affected:	None				
Encoding:	0000	0000	0000	10nn nn=0 * =1 *+ =2 *- =3 +*	
Description:	This instruction is used to read the contents of Program Memory (P.M.). To address the program memory, a pointer called Table Pointer (TBLPTR) is used. The TBLPTR (a 21-bit pointer) points to each byte in the program memory. TBLPTR has a 2-Mbyte address range.				
	TBLPTR[(ast Significa gram Memo		
	TBLPTR[0] = 1: Most Significant Byte of Program Memory Word				
	The TBLRD instruction can modify the value of TBLPTR as follows:				
	no change				
	 post-incre 	ement			
	 post-decr 	ement			

TBLRD	Table Read (Continued)			
Example 1:	TBLRD	*+	;	
Before Instruction	on			
TABLAT			=	55h
TBLPTR MEMORY(00 4 2 E C L)		=	00A356h 34h
After Instruction	00A33011	'	-	3411
TABLAT			=	34h
TBLPTR			=	00A357h
Example 2:	TBLRD	+*	;	
Before Instruction	on			
TABLAT			=	AAh
TBLPTR	0440571		=	0 17 100 1 11
MEMORY(MEMORY(01A35/h) 01A358h)	=	12h 34h
After Instruction	01/100011	'	_	U+11
TABLAT			=	34h
TBLPTR			=	01A358h

• pre-increment

2

Words:

Cycles:

Q Cycle Activity:

TBLWT	Table Wri	te				
Syntax:	TBLWT ('	*; *+; *-; + [*]	')			
Operands:	None					
Operation:	if TBLWT*, (TABLAT) → Holding Register; TBLPTR – No Change if TBLWT*+, (TABLAT) → Holding Register; (TBLPTR) + 1 → TBLPTR if TBLWT*-, (TABLAT) → Holding Register; (TBLPTR) – 1 → TBLPTR if TBLWT+*, (TBLPTR) + 1 → TBLPTR; (TBLPTR) + 1 → TBLPTR; (TABLAT) → Holding Register					
Status Affected:	None	,	g rrogioto.			
Encoding:	0000	0000	0000	11nn nn=0 * =1 *+ =2 *-		
Description:	This instruction uses the 3 LSBs of TBLPTR to determine which of the 8 holding registers the TABLAT is written to. The holding registers are used to program the contents of Program Memory (P.M.). (Refer to Section 5.0 "Memory Organization" for additional details on programming Flash memory.) The TBLPTR (a 21-bit pointer) points to each byte in the program memory. TBLPTR has a 2-Mbyte address range. The LSb of the TBLPTR selects which byte of the program memory location to access.					
	TBLPT			nificant Byte m Memory		
	TBLPT			nificant Byte m Memory		
	The TBLWT instruction can modify the value of TBLPTR as follows: no change post-increment post-decrement					
	• pre-inci	rement				
Words:	1					
Cycles:	2					
Q Cycle Activity:	Q1	Q2	Q3	Q4		
	Decode	No	No	No		
		_	operation	operation		
	No operation	No operation (Read TABLAT)	No operation	No operation (Write to Holding Register)		

TBLWT	Table Write (0	Contin	auad)
IDLWI	Table Write (C	JOHUI	iueu)
Example	1: TBLWT *+;		
Befo	ore Instruction		
	TABLAT TBLPTR HOLDING REGISTER	= =	55h 00A356h
	(00A356h)	=	FFh
Afte	r Instructions (table write	comp	letion)
	TABLAT	=	55h
	TBLPTR HOLDING REGISTER	=	00A357h
	(00A356h)	=	55h
Example	<u>2:</u> TBLWT +*;		
Befo	ore Instruction		
	TABLAT	=	34h
	TBLPTR HOLDING REGISTER	=	01389Ah
	(01389Ah)	=	FFh
	HOLDING REGISTER		
A (1 -	(01389Bh)	=	FFh
Arte	r Instruction (table write o TABLAT	•	etion) 34h
	TBLPTR	=	01389Bh
	HOLDING REGISTER		
	(01389Ah) HOLDING REGISTER	=	FFh
	(01389Bh)	=	34h

Holding Register)

TSTFSZ	Test f, Skip if 0			
Syntax:	TSTFSZ f {,a}			
Operands:	$0 \le f \le 255$ a $\in [0,1]$			
Operation:	skip if $f = 0$			
Status Affected:	None			
Encoding:	0110 011a ffff ffff			
Description:	If 'f' = 0, the next instruction fetched during the current instruction execution is discarded and a NOP is executed, making this a two-cycle instruction.			

If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the

GPR bank (default).

If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 25.2.3 "Byte-Oriented and **Bit-Oriented Instructions in Indexed** Literal Offset Mode" for details.

Words: Cycles: 1(2)

Note: 3 cycles if skip and followed

by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	No
	register 'f'	Data	operation

If skip:

Q1	Q2	Q3	Q4		
No	No	No	No		
operation	operation	operation	operation		

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No	No No		No
operation	operation	operation	operation
No	No	No	No
operation	operation	operation	operation

Example: HERE TSTFSZ CNT, 1

NZERO ZERO

Before Instruction

PC Address (HERE)

After Instruction

00h.

Address (ZERO)

If CNT PC If CNT PC 00h, Address (NZERO)

XOR	LW	Exclusive OR Literal with W					
Synta	ax:	XORLW	k				
Oper	ands:	$0 \le k \le 25$	5				
Oper	ation:	(W) .XOR	$k \to W$				
Statu	s Affected:	N, Z					
Enco	ding:	0000	1010	kkk	k	kkkk	
Desc	ription:	The conte the 8-bit li in W.					
Word	ls:	1					
Cycle	es:	1					
QC	ycle Activity:						
Q1		Q2	Q3			Q4	
	Decode	Read literal 'k'			V	Vrite to W	

Example: XORLW 0AFh

Before Instruction

W B5h

After Instruction

W 1Ah

XORWF Exclusive OR W with f

Syntax: XORWF $f \{ d \{,a\} \}$

Operands: $0 \le f \le 255$

 $d\in [0,1]$ $a\in [0,1]$

Operation: (W) .XOR. (f) \rightarrow dest

Status Affected: N, Z

Encoding: 0001 10da ffff ffff

Description: Exclusive OR the contents of W with register 'f'. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back

in the register 'f' (default).

If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the

GPR bank (default).

If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example: XORWF REG, 1, 0

Before Instruction

 $\begin{array}{ccc} \mathsf{REG} & = & \mathsf{AFh} \\ \mathsf{W} & = & \mathsf{B5h} \end{array}$

After Instruction

 $\begin{array}{ccc} \mathsf{REG} & = & \mathsf{1Ah} \\ \mathsf{W} & = & \mathsf{B5h} \end{array}$

25.2 Extended Instruction Set

In addition to the standard 75 instructions of the PIC18 instruction set, the PIC18F87J90 family family of devices also provide an optional extension to the core CPU functionality. The added features include eight additional instructions that augment Indirect and Indexed Addressing operations and the implementation of Indexed Literal Offset Addressing for many of the standard PIC18 instructions.

The additional features of the extended instruction set are enabled by default on unprogrammed devices. Users must properly set or clear the XINST Configuration bit during programming to enable or disable these features.

The instructions in the extended set can all be classified as literal operations, which either manipulate the File Select Registers, or use them for Indexed Addressing. Two of the instructions, ADDFSR and SUBFSR, each have an additional special instantiation for using FSR2. These versions (ADDULNK and SUBULNK) allow for automatic return after execution.

The extended instructions are specifically implemented to optimize re-entrant program code (that is, code that is recursive or that uses a software stack) written in high-level languages, particularly C. Among other things, they allow users working in high-level languages to perform certain operations on data structures more efficiently. These include:

- Dynamic allocation and deallocation of software stack space when entering and leaving subroutines
- Function Pointer invocation
- Software Stack Pointer manipulation
- Manipulation of variables located in a software stack

A summary of the instructions in the extended instruction set is provided in Table 25-3. Detailed descriptions are provided in **Section 25.2.2 "Extended Instruction Set"**. The opcode field descriptions in Table 25-1 (page 334) apply to both the standard and extended PIC18 instruction sets.

Note: The instruction set extension and the Indexed Literal Offset Addressing mode were designed for optimizing applications written in C; the user may likely never use these instructions directly in assembler. The syntax for these commands is provided as a reference for users who may be reviewing code that has been generated by a compiler.

25.2.1 EXTENDED INSTRUCTION SYNTAX

Most of the extended instructions use indexed arguments, using one of the File Select Registers and some offset to specify a source or destination register. When an argument for an instruction serves as part of Indexed Addressing, it is enclosed in square brackets ("[]"). This is done to indicate that the argument is used as an index or offset. The MPASM™ Assembler will flag an error if it determines that an index or offset value is not bracketed.

When the extended instruction set is enabled, brackets are also used to indicate index arguments in byte-oriented and bit-oriented instructions. This is in addition to other changes in their syntax. For more details, see Section 25.2.3.1 "Extended Instruction Syntax with Standard PIC18 Commands".

Note: In the past, square brackets have been used to denote optional arguments in the PIC18 and earlier instruction sets. In this text and going forward, optional arguments are denoted by braces ("{ }").

TABLE 25-3: EXTENSIONS TO THE PIC18 INSTRUCTION SET

Mnemonic, Operands		Description	Cycles	16-Bit Instruction Word				Status
		Description	Cycles	MSb			LSb	Affected
ADDFSR	f, k	Add Literal to FSR	1	1110	1000	ffkk	kkkk	None
ADDULNK	k	Add Literal to FSR2 and Return	2	1110	1000	11kk	kkkk	None
CALLW		Call Subroutine using WREG	2	0000	0000	0001	0100	None
MOVSF	z_s , f_d	Move z _s (source) to 1st word	2	1110	1011	0zzz	ZZZZ	None
	o. u	f _d (destination) 2nd word		1111	ffff	ffff	ffff	
MOVSS	z_s, z_d	Move z _s (source) to 1st word	2	1110	1011	1zzz	ZZZZ	None
	٠ ٠	z _d (destination) 2nd word		1111	xxxx	XZZZ	ZZZZ	
PUSHL	k	Store Literal at FSR2, Decrement FSR2	1	1110	1010	kkkk	kkkk	None
SUBFSR	f, k	Subtract Literal from FSR	1	1110	1001	ffkk	kkkk	None
SUBULNK	k	Subtract Literal from FSR2 and return	2	1110	1001	11kk	kkkk	None

25.2.2 EXTENDED INSTRUCTION SET

ADD	FSR	Add Literal to FSR					
Synta	ax:	ADDFSR	ADDFSR f, k				
Oper	ands:	$0 \le k \le 63$					
		$f \in [0, 1, 1]$	2]				
Oper	ation:	$FSR(f) + k \rightarrow FSR(f)$					
Status Affected: None							
Enco	ding:	1000	ffk	k	kkkk		
Desc	ription:	The 6-bit l	The 6-bit literal 'k' is added to the				
		contents of	of the FSF	R spe	cifie	d by 'f'.	
Word	ls:	1					
Cycle	es:	1					
QC	ycle Activity:						
	Q1	Q2	Q3			Q4	
	Decode	Read	Proces	SS	W	/rite to	
		literal 'k'	Data			FSR	

Example: ADDFSR 2, 23h

Before Instruction

FSR2 = 03FFh

After Instruction

FSR2 = 0422h

ADDULNK	Add Literal to FSR2 and Return				
Syntax:	ADDULNI	< k			
Operands:	$0 \le k \le 63$				
Operation:	FSR2 + k $(TOS) \rightarrow$,		
Status Affected:	None				
Encoding:	1110	1000	11kk	kkkk	
Description:	The 6-bit literal 'k' is added to the contents of FSR2. A RETURN is then executed by loading the PC with the TOS.				
	The instruction takes two cycles to execute; a NOP is performed during the second cycle.				
	This may be thought of as a special case of the ADDFSR instruction, where f = 3 (binary '11'); it operates only on FSR2.				
Words:	1				
Cycles:	2				
Q Cycle Activity:					
Q1	Q2	Q3		Q4	
D I.	D I	D		Later Co	

Q I	QZ	QS	Q4
Decode	Read	Process	Write to
	literal 'k'	Data	FSR
No	No	No	No
Operation	Operation	Operation	Operation

Example: ADDULNK 23h

Before Instruction

FSR2 = 03FFh PC = 0100h

After Instruction

FSR2 = 0422hPC = (TOS)

Note: All PIC18 instructions may take an optional label argument preceding the instruction mnemonic for use in symbolic addressing. If a label is used, the instruction format then becomes: {label} instruction argument(s).

ALLW Subroutine Call Using WRE
LLW Subroutine Call Using WRE

Syntax: **CALLW**

Operands: None

Operation: $(PC + 2) \rightarrow TOS$, $(W) \rightarrow PCL$

> $(PCLATH) \rightarrow PCH,$ (PCLATU) → PCU

Status Affected: None

Encoding: 0000

Description First, the return address (PC + 2) is

> pushed onto the return stack. Next, the contents of W are written to PCL; the existing value is discarded. Then, the contents of PCLATH and PCLATU are

0001

0100

0000

latched into PCH and PCU, respectively. The second cycle is executed as a NOP instruction while the new next instruction is fetched.

Unlike CALL, there is no option to update W, STATUS or BSR.

Words: 1 2 Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Push PC to	No
	WREG	stack	operation
No	No	No	No
operation	operation	operation	operation

Example: HERE CALLW

Before Instruction

address (HERE)

PCLATH 10h **PCLATU** 00h 06h

After Instruction

PC 001006h

TOS address (HERE + 2) PCLATH =

PCLATU 00h 06h **MOVSF** Move Indexed to f

 $\overline{\text{MOVSF}}$ [z_s], f_d Syntax: $0 \le z_s \le 127$ Operands: $0 \le f_d \le 4095$

 $((FSR2) + z_s) \rightarrow f_d$ Operation:

Status Affected: None

Encoding:

Description:

1st word (source) 2nd word (destin.)

11 0z	zzz zzzz	s
ff ff	fff ffff	d
	02	0222 2222

The contents of the source register are moved to destination register 'fd'. The actual address of the source register is determined by adding the 7-bit literal offset 'zs', in the first word, to the value of FSR2. The address of the destination register is specified by the 12-bit literal 'f_d' in the second word. Both addresses can be anywhere in the 4096-byte data

space (000h to FFFh).

The MOVSF instruction cannot use the PCL, TOSU, TOSH or TOSL as the

destination register.

If the resultant source address points to an Indirect Addressing register, the

value returned will be 00h.

Words: 2 2 Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Determine	Determine	Read
	source addr	source addr	source reg
Decode	No	No	Write
	operation	operation	register 'f'
	No dummy		(dest)
	read		

80h

Example: MOVSF [05h], REG2

Before Instruction

FSR2 80h Contents of 85h 33h REG2 11h

After Instruction FSR2 Contents

33h of 85h REG2 33h

MOVSS Move Indexed to Indexed Syntax: MOVSS $[z_s], [z_d]$ Operands: $0 \le z_s \le 127$ $0 \le z_d \le 127$ $((\text{FSR2}) + z_{\text{S}}) \rightarrow ((\text{FSR2}) + z_{\text{d}})$ Operation: Status Affected: None Encoding: 1st word (source) 1110 1011 1zzz $zzzz_s$ 2nd word (dest.) 1111 zzzzd xxxx XZZZ Description The contents of the source register are moved to the destination register. The

The contents of the source register are moved to the destination register. The addresses of the source and destination registers are determined by adding the 7-bit literal offsets, 'z_s' or 'z_d',

respectively, to the value of FSR2. Both registers can be located anywhere in the 4096-byte data memory space (000h to FFFh).

The Movss instruction cannot use the PCL, TOSU, TOSH or TOSL as the destination register.

If the resultant source address points to an Indirect Addressing register, the value returned will be 00h. If the resultant destination address points to an Indirect Addressing register, the instruction will execute as a NOP.

Words: 2 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Determine	Determine	Read
	source addr	source addr	source reg
Decode	Determine	Determine	Write
	dest addr	dest addr	to dest reg

Example: MOVSS [05h], [06h]

Before Instruction FSR2 80h Contents 33h of 85h Contents of 86h 11h After Instruction FSR2 80h Contents 33h of 85h Contents 33h of 86h

PUS	HL	Store Literal at FSR2, Decrement FSR2			
Synta	ax:	PUSHL k			
Oper	ands:	$0 \le k \le 255$			
Oper	ation:	$k \rightarrow (FSR2),$ $FSR2 - 1 \rightarrow FSR2$			
Statu	s Affected:	None			
Enco	ding:	1111	1010	kkkk	kkkk
Desc	ription:	The 8-bit literal 'k' is written to the data memory address specified by FSR2. FSR2 is decremented by 1 after the operation.			
		This instruction			•
Word	ls:	1			
Cycle	es:	1			
QC	Q Cycle Activity:				
	Q1	Q2	C	13	Q4
	Decode	Read 'k'	Prod da		Write to destination

Example: PUSHL 08h

Before Instruction

 $\begin{array}{lll} \text{FSR2H:FSR2L} & = & \text{01ECh} \\ \text{Memory (01ECh)} & = & \text{00h} \end{array}$

After Instruction

FSR2H:FSR2L = 01EBh Memory (01ECh) = 08h

SUBFSR Subtract Literal from FSR Syntax: SUBFSR f, k Operands: $0 \le k \le 63$ $f \in [\ 0,\,1,\,2\]$ Operation: $FSRf-k \to FSRf$ Status Affected: None Encoding: 1110 1001 ffkk kkkk Description: The 6-bit literal 'k' is subtracted from the contents of the FSR specified by 'f'.

Words: 1
Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example: SUBFSR 2, 23h

Before Instruction

FSR2 = 03FFh

After Instruction

FSR2 = 03DCh

SUBULNK	Subtract Literal from FSR2 and Return			
Syntax:	SUBULN	(k		
Operands:	$0 \le k \le 63$			
Operation:	$FSR2 - k$ $(TOS) \rightarrow I$,		
Status Affected:	None			
Encoding:	1110	1001	11kk	kkkk
Description:	The 6-bit literal 'k' is subtracted from the contents of the FSR2. A RETURN is then executed by loading the PC with the TOS.			
	The instruction takes two cycles to execute; a NOP is performed during the second cycle.			
	This may be thought of as a special case of the SUBFSR instruction, where f = 3 (binary '11'); it operates only on FSR2.			
Words:	1			
Cycles:	2			
Q Cycle Activity:				
Q1	Q2		23	Q4

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination
No	No	No	No
Operation	Operation	Operation	Operation

Example: SUBULNK 23h

Before Instruction

FSR2 = 03FFhPC = 0100h

After Instruction

FSR2 = 03DChPC = (TOS)

25.2.3 BYTE-ORIENTED AND BIT-ORIENTED INSTRUCTIONS IN INDEXED LITERAL OFFSET MODE

Note: Enabling the PIC18 instruction set extension may cause legacy applications to behave erratically or fail entirely.

In addition to eight new commands in the extended set, enabling the extended instruction set also enables Indexed Literal Offset Addressing (Section 5.6.1 "Indexed Addressing with Literal Offset"). This has a significant impact on the way that many commands of the standard PIC18 instruction set are interpreted.

When the extended set is disabled, addresses embedded in opcodes are treated as literal memory locations: either as a location in the Access Bank (a=0) or in a GPR bank designated by the BSR (a=1). When the extended instruction set is enabled and a=0, however, a file register argument of 5Fh or less is interpreted as an offset from the pointer value in FSR2 and not as a literal address. For practical purposes, this means that all instructions that use the Access RAM bit as an argument – that is, all byte-oriented and bit-oriented instructions, or almost half of the core PIC18 instructions – may behave differently when the extended instruction set is enabled.

When the content of FSR2 is 00h, the boundaries of the Access RAM are essentially remapped to their original values. This may be useful in creating backward-compatible code. If this technique is used, it may be necessary to save the value of FSR2 and restore it when moving back and forth between C and assembly routines in order to preserve the Stack Pointer. Users must also keep in mind the syntax requirements of the extended instruction set (see Section 25.2.3.1 "Extended Instruction Syntax with Standard PIC18 Commands").

Although the Indexed Literal Offset mode can be very useful for dynamic stack and pointer manipulation, it can also be very annoying if a simple arithmetic operation is carried out on the wrong register. Users who are accustomed to the PIC18 programming must keep in mind that, when the extended instruction set is enabled, register addresses of 5Fh or less are used for Indexed Literal Offset Addressing.

Representative examples of typical byte-oriented and bit-oriented instructions in the Indexed Literal Offset mode are provided on the following page to show how execution is affected. The operand conditions shown in the examples are applicable to all instructions of these types.

25.2.3.1 Extended Instruction Syntax with Standard PIC18 Commands

When the extended instruction set is enabled, the file register argument 'f' in the standard byte-oriented and bit-oriented commands is replaced with the literal offset value 'k'. As already noted, this occurs only when 'f' is less than or equal to 5Fh. When an offset value is used, it must be indicated by square brackets ("[]"). As with the extended instructions, the use of brackets indicates to the compiler that the value is to be interpreted as an index or an offset. Omitting the brackets, or using a value greater than 5Fh within the brackets, will generate an error in the MPASM Assembler.

If the index argument is properly bracketed for Indexed Literal Offset Addressing, the Access RAM argument is never specified; it will automatically be assumed to be '0'. This is in contrast to standard operation (extended instruction set disabled), when 'a' is set on the basis of the target address. Declaring the Access RAM bit in this mode will also generate an error in the MPASM Assembler.

The destination argument 'd' functions as before.

In the latest versions of the MPASM Assembler, language support for the extended instruction set must be explicitly invoked. This is done with either the command line option, /y, or the PE directive in the source listing.

25.2.4 CONSIDERATIONS WHEN ENABLING THE EXTENDED INSTRUCTION SET

It is important to note that the extensions to the instruction set may not be beneficial to all users. In particular, users who are not writing code that uses a software stack may not benefit from using the extensions to the instruction set.

Additionally, the Indexed Literal Offset Addressing mode may create issues with legacy applications written to the PIC18 assembler. This is because instructions in the legacy code may attempt to address registers in the Access Bank below 5Fh. Since these addresses are interpreted as literal offsets to FSR2 when the instruction set extension is enabled, the application may read or write to the wrong data addresses.

When porting an application to the PIC18F87J90 family family, it is very important to consider the type of code. A large, re-entrant application that is written in C and would benefit from efficient compilation will do well when using the instruction set extensions. Legacy applications that heavily use the Access Bank will most likely not benefit from using the extended instruction set.

ADD W to Indexed **ADDWF** (Indexed Literal Offset mode)

Syntax: ADDWF [k] {,d}

Operands: $0 \le k \le 95$ $d \in [0,1]$

(W) + ((FSR2) + k) \rightarrow dest Operation:

N, OV, C, DC, Z Status Affected:

Encoding: 0010 01d0 kkkk kkkk

Description: The contents of W are added to the contents of the register indicated by

FSR2, offset by the value 'k'.

If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in

register 'f' (default).

Words: Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read 'k'	Process	Write to
		Data	destination

Example: ADDWF [OFST],0

Before Instruction

17h = **OFST** 2Ch FSR2 0A00h Contents of 0A2Ch 20h

After Instruction

W 37h Contents of 0A2Ch 20h

Bit Set Indexed **BSF**

(Indexed Literal Offset mode)

Syntax: BSF [k], b Operands: $0 \le f \le 95$ $0 \le b \le 7$

 $1 \rightarrow ((FSR2) + k) < b >$ Operation:

Status Affected: None

Encoding: 1000 bbb0 kkkk kkkk

Description: Bit 'b' of the register indicated by FSR2,

offset by the value 'k', is set.

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example: [FLAG_OFST], 7 BSF

Before Instruction

FLAG_OFST 0AhFSR2 0A00h Contents of 0A0Ah 55h

After Instruction

Contents of 0A0Ah D5h

Set Indexed **SETF**

(Indexed Literal Offset mode)

Syntax: SETF [k] Operands: $0 \le k \le 95$

Operation: $FFh \rightarrow ((FSR2) + k)$

Status Affected: None

1000 kkkk kkkk Encoding: 0110

The contents of the register indicated by Description:

FSR2, offset by 'k', are set to FFh.

Words: 1 Cycles: 1

Q Cycle Activity:

Q1 Q2 Q3 Q4 Decode Read 'k' Process Write Data register

Example: SETF [OFST]

Before Instruction

OFST 2Ch FSR2 0A00h Contents of 0A2Ch 00h

After Instruction Contents

FFh of 0A2Ch

25.2.5 SPECIAL CONSIDERATIONS WITH MICROCHIP MPLAB® IDE TOOLS

The latest versions of Microchip's software tools have been designed to fully support the extended instruction set for the PIC18F87J90 family family. This includes the MPLAB C18 C Compiler, MPASM assembly language and MPLAB Integrated Development Environment (IDE).

When selecting a target device for software development, MPLAB IDE will automatically set default Configuration bits for that device. The default setting for the XINST Configuration bit is '0', disabling the extended instruction set and Indexed Literal Offset Addressing. For proper execution of applications developed to take advantage of the extended instruction set, XINST must be set during programming.

To develop software for the extended instruction set, the user must enable support for the instructions and the Indexed Addressing mode in their language tool(s). Depending on the environment being used, this may be done in several ways:

- A menu option or dialog box within the environment that allows the user to configure the language tool and its settings for the project
- · A command line option
- · A directive in the source code

These options vary between different compilers, assemblers and development environments. Users are encouraged to review the documentation accompanying their development systems for the appropriate information.

26.0 DEVELOPMENT SUPPORT

The PIC[®] microcontrollers are supported with a full range of hardware and software development tools:

- · Integrated Development Environment
 - MPLAB® IDE Software
- · Assemblers/Compilers/Linkers
 - MPASMTM Assembler
 - MPLAB C18 and MPLAB C30 C Compilers
 - MPLINKTM Object Linker/ MPLIBTM Object Librarian
 - MPLAB ASM30 Assembler/Linker/Library
- Simulators
 - MPLAB SIM Software Simulator
- Emulators
 - MPLAB ICE 2000 In-Circuit Emulator
 - MPLAB REAL ICE™ In-Circuit Emulator
- · In-Circuit Debugger
 - MPLAB ICD 2
- · Device Programmers
 - PICSTART® Plus Development Programmer
 - MPLAB PM3 Device Programmer
 - PICkit™ 2 Development Programmer
- Low-Cost Demonstration and Development Boards and Evaluation Kits

26.1 MPLAB Integrated Development Environment Software

The MPLAB IDE software brings an ease of software development previously unseen in the 8/16-bit micro-controller market. The MPLAB IDE is a Windows® operating system-based application that contains:

- A single graphical interface to all debugging tools
 - Simulator
 - Programmer (sold separately)
 - Emulator (sold separately)
 - In-Circuit Debugger (sold separately)
- · A full-featured editor with color-coded context
- A multiple project manager
- Customizable data windows with direct edit of contents
- · High-level source code debugging
- Visual device initializer for easy register initialization
- Mouse over variable inspection
- Drag and drop variables from source to watch windows
- Extensive on-line help
- Integration of select third party tools, such as HI-TECH Software C Compilers and IAR C Compilers

The MPLAB IDE allows you to:

- Edit your source files (either assembly or C)
- One touch assemble (or compile) and download to PIC MCU emulator and simulator tools (automatically updates all project information)
- · Debug using:
 - Source files (assembly or C)
 - Mixed assembly and C
 - Machine code

MPLAB IDE supports multiple debugging tools in a single development paradigm, from the cost-effective simulators, through low-cost in-circuit debuggers, to full-featured emulators. This eliminates the learning curve when upgrading to tools with increased flexibility and power.

26.2 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for all PIC MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code and COFF files for debugging.

The MPASM Assembler features include:

- Integration into MPLAB IDE projects
- User-defined macros to streamline assembly code
- Conditional assembly for multi-purpose source files
- Directives that allow complete control over the assembly process

26.3 MPLAB C18 and MPLAB C30 C Compilers

The MPLAB C18 and MPLAB C30 Code Development Systems are complete ANSI C compilers for Microchip's PIC18 and PIC24 families of microcontrollers and the dsPIC30 and dsPIC33 family of digital signal controllers. These compilers provide powerful integration capabilities, superior code optimization and ease of use not found with other compilers.

For easy source level debugging, the compilers provide symbol information that is optimized to the MPLAB IDE debugger.

26.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler and the MPLAB C18 C Compiler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

26.5 MPLAB ASM30 Assembler, Linker and Librarian

MPLAB ASM30 Assembler produces relocatable machine code from symbolic assembly language for dsPIC30F devices. MPLAB C30 C Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- · Support for the entire dsPIC30F instruction set
- · Support for fixed-point and floating-point data
- · Command line interface
- Rich directive set
- · Flexible macro language
- · MPLAB IDE compatibility

26.6 MPLAB SIM Software Simulator

The MPLAB SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC® DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB SIM Software Simulator fully supports symbolic debugging using the MPLAB C18 and MPLAB C30 C Compilers, and the MPASM and MPLAB ASM30 Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

26.7 MPLAB ICE 2000 High-Performance In-Circuit Emulator

The MPLAB ICE 2000 In-Circuit Emulator is intended to provide the product development engineer with a complete microcontroller design tool set for PIC microcontrollers. Software control of the MPLAB ICE 2000 In-Circuit Emulator is advanced by the MPLAB Integrated Development Environment, which allows editing, building, downloading and source debugging from a single environment.

The MPLAB ICE 2000 is a full-featured emulator system with enhanced trace, trigger and data monitoring features. Interchangeable processor modules allow the system to be easily reconfigured for emulation of different processors. The architecture of the MPLAB ICE 2000 In-Circuit Emulator allows expansion to support new PIC microcontrollers.

The MPLAB ICE 2000 In-Circuit Emulator system has been designed as a real-time emulation system with advanced features that are typically found on more expensive development tools. The PC platform and Microsoft[®] Windows[®] 32-bit operating system were chosen to best make these features available in a simple, unified application.

26.8 MPLAB REAL ICE In-Circuit Emulator System

MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs PIC[®] Flash MCUs and dsPIC[®] Flash DSCs with the easy-to-use, powerful graphical user interface of the MPLAB Integrated Development Environment (IDE), included with each kit.

The MPLAB REAL ICE probe is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with the popular MPLAB ICD 2 system (RJ11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

MPLAB REAL ICE is field upgradeable through future firmware downloads in MPLAB IDE. In upcoming releases of MPLAB IDE, new devices will be supported, and new features will be added, such as software breakpoints and assembly code trace. MPLAB REAL ICE offers significant advantages over competitive emulators including low-cost, full-speed emulation, real-time variable watches, trace analysis, complex breakpoints, a ruggedized probe interface and long (up to three meters) interconnection cables.

26.9 MPLAB ICD 2 In-Circuit Debugger

Microchip's In-Circuit Debugger, MPLAB ICD 2, is a powerful, low-cost, run-time development tool, connecting to the host PC via an RS-232 or high-speed USB interface. This tool is based on the Flash PIC MCUs and can be used to develop for these and other PIC MCUs and dsPIC DSCs. The MPLAB ICD 2 utilizes the in-circuit debugging capability built into the Flash devices. This feature, along with Microchip's In-Circuit Serial Programming[™] (ICSP[™]) protocol, offers costeffective, in-circuit Flash debugging from the graphical user interface of the MPLAB Integrated Development Environment. This enables a designer to develop and debug source code by setting breakpoints, single stepping and watching variables, and CPU status and peripheral registers. Running at full speed enables testing hardware and applications in real time. MPLAB ICD 2 also serves as a development programmer for selected PIC devices.

26.10 MPLAB PM3 Device Programmer

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at VDDMIN and VDDMAX for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages and a modular, detachable socket assembly to support various package types. The ICSP™ cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices and incorporates an SD/MMC card for file storage and secure data applications.

26.11 PICSTART Plus Development Programmer

The PICSTART Plus Development Programmer is an easy-to-use, low-cost, prototype programmer. It connects to the PC via a COM (RS-232) port. MPLAB Integrated Development Environment software makes using the programmer simple and efficient. The PICSTART Plus Development Programmer supports most PIC devices in DIP packages up to 40 pins. Larger pin count devices, such as the PIC16C92X and PIC17C76X, may be supported with an adapter socket. The PICSTART Plus Development Programmer is CE compliant.

26.12 PICkit 2 Development Programmer

The PICkit™ 2 Development Programmer is a low-cost programmer and selected Flash device debugger with an easy-to-use interface for programming many of Microchip's baseline, mid-range and PIC18F families of Flash memory microcontrollers. The PICkit 2 Starter Kit includes a prototyping development board, twelve sequential lessons, software and HI-TECH's PICC™ Lite C compiler, and is designed to help get up to speed quickly using PIC® microcontrollers. The kit provides everything needed to program, evaluate and develop applications using Microchip's powerful, mid-range Flash memory family of microcontrollers.

26.13 Demonstration, Development and Evaluation Boards

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM™ and dsPICDEM™ demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, Keeloq® security ICs, CAN, IrDA®, PowerSmart battery management, SEEVAL® evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

27.0 ELECTRICAL CHARACTERISTICS

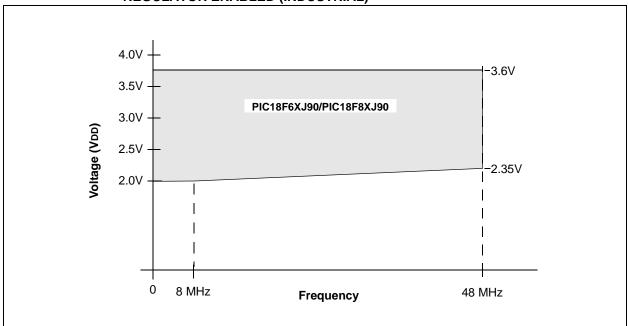
Absolute Maximum Ratings^(†)

Ambient temperature under bias40°C to +100°C
Storage temperature65°C to +150°C
Voltage on any digital only I/O pin or MCLR with respect to Vss (except VDD)
Voltage on any combined digital and analog pin with respect to Vss (except VDD and \overline{MCLR})0.3V to (VDD + 0.3V)
Voltage on VDDCORE with respect to Vss0.3V to 2.75V
Voltage on VDD with respect to Vss0.3V to 3.6V
Total power dissipation (Note 1)
Maximum current out of Vss pin
Maximum current into VDD pin
Maximum output current sunk by PORTA<7:6> and any PORTB and PORTC I/O pins25 mA
Maximum output current sunk by any PORTD, PORTE and PORTJ I/O pins
Maximum output current sunk by PORTA<5:0> and any PORTF, PORTG and PORTH I/O pins2 mA
Maximum output current sourced by PORTA<7:6> and any PORTB and PORTC I/O pins25 mA
Maximum output current sourced by any PORTD, PORTE and PORTJ I/O pins8 mA
Maximum output current sourced by PORTA<5:0> and any PORTF, PORTG and PORTH I/O pins2 mA
Maximum current sunk by all ports combined

Note 1: Power dissipation is calculated as follows: Pdis = VDD x {IDD $- \sum$ IOH} + \sum {(VDD - VOH) x IOH} + \sum (VOL x IOL)

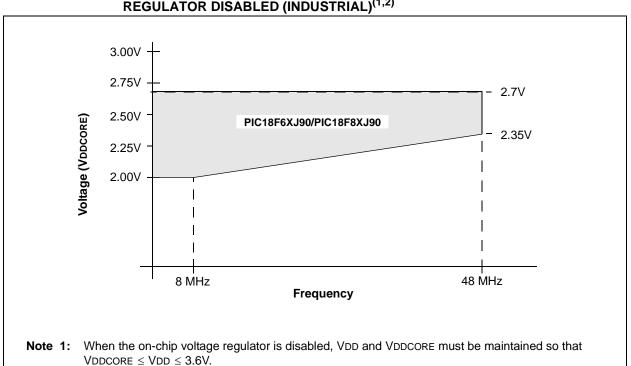
† **NOTICE**: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

FIGURE 27-1: VOLTAGE-FREQUENCY GRAPH, REGULATOR ENABLED (INDUSTRIAL)⁽¹⁾



Note 1: When the on-chip regulator is enabled, its BOR circuit will automatically trigger a device Reset before VDD reaches a level at which full-speed operation is not possible.

FIGURE 27-2: VOLTAGE-FREQUENCY GRAPH, REGULATOR DISABLED (INDUSTRIAL)^(1,2)



27.1 DC Characteristics: Supply Voltage

PIC18F87J90 Family (Industrial)

PIC18F87J90 Family (Industrial)			Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial					
Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions	
D001	VDD	Supply Voltage	VDDCORE 2.0	_	3.6 3.6	V V	ENVREG tied to Vss ENVREG tied to VDD	
D001B	VDDCORE	External Supply for Microcontroller Core	2.0	_	2.70	V	ENVREG tied to Vss	
D001C	AVdd	Analog Supply Voltage	VDD - 0.3	_	VDD + 0.3	V		
D001D	AVss	Analog Ground Potential	Vss - 0.3	_	Vss + 0.3	V		
D002	VDR	RAM Data Retention Voltage ⁽¹⁾	1.5	_	_	V		
D003	VPOR	VDD Start Voltage to Ensure Internal Power-on Reset Signal	_	_	0.7	V	See Section 4.3 "Power-on Reset (POR)" for details	
D004	SVDD	VDD Rise Rate to Ensure Internal Power-on Reset Signal	0.05	_	_	V/ms	See Section 4.3 "Power-on Reset (POR)" for details	
D005	VBOR	Brown-out Reset Voltage	_	1.8	_	V		

Note 1: This is the limit to which VDD can be lowered in Sleep mode, or during a device Reset, without losing RAM data.

27.2 DC Characteristics: Power-Down and Supply Current PIC18F87J90 Family (Industrial)

PIC18F8 (Indu	7J90 Family strial)	Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial						
Param No.	Device	Тур	Max	units Conditions				
	Power-Down Current (IPD)	1)						
	All devices	0.5	1.4	μА	-40°C	(4)		
		0.5	1.4	μА	+25°C	VDD = 2.0V ⁽⁴⁾ (Sleep mode)		
		5.5	10.2	μА	+85°C	(Sieep mode)		
	All devices	0.6	1.5	μΑ	-40°C	(4)		
		0.6	1.5	μА	+25°C	V _{DD} = 2.5V ⁽⁴⁾ (Sleep mode)		
		6.8	12.6	μА	+85°C	(Cieep mode)		
	All devices	2.9	7	μА	-40°C			
		3.6	7	μА	+25°C	VDD = 3.3V ⁽⁵⁾ (Sleep mode)		
		9.6	19	μА	+85°C	(Cieep mode)		

- Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or Vss and all features that add delta current disabled (such as WDT, Timer1 oscillator, BOR, etc.).
 - 2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD; WDT enabled/disabled as specified.

- 3: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.
- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss).
- **5:** Voltage regulator enabled (ENVREG = 1, tied to VDD, REGSLP = 1).

27.2 DC Characteristics: Power-Down and Supply Current PIC18F87J90 Family (Industrial) (Continued)

PIC18F87J90 Family (Industrial)		Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{Ta} \le +85^{\circ}\text{C}$ for industrial						
Param No.	Device	Тур	Max	Units		Condition	s	
	Supply Current (IDD) ^(2,3)							
	All devices	5	14.2	μА	-40°C			
		5.5	14.2	μΑ	+25°C	VDD = 2.0V, $VDDCORE = 2.0V(4)$		
		10	19.0	μΑ	+85°C	VBBOOKE = 2.0V		
	All devices	6.8	16.5	μΑ	-40°C)/ 0.5)/	Fosc = 31 kHz	
		7.6	16.5	μΑ	+25°C	VDD = 2.5V, $VDDCORE = 2.5V(4)$	(RC_RUN mode,	
		14	22.4	μΑ	+85°C	VBB00KE = 2.0V	internal oscillator source)	
	All devices	37	84	μΑ	-40°C			
		51	84	μΑ	+25°C	$VDD = 3.3V^{(5)}$		
		72	108	μΑ	+85°C			
	All devices	0.43	0.82	mA	-40°C)/ 0.01/	FOSC = 1 MHz	
		0.47	0.82	mA	+25°C	VDD = 2.0V, $VDDCORE = 2.0V(4)$		
		0.52	0.95	mA	+85°C	VBBOOKE = 2.0V		
	All devices	0.52	0.98	mA	-40°C			
		0.57	0.98	mA	+25°C	VDD = 2.5V, $VDDCORE = 2.5V(4)$		
		0.63	1.10	mA	+85°C	VBB00KE = 2.0V		
	All devices	0.59	0.96	mA	-40°C			
		0.65	0.96	mA	+25°C	$VDD = 3.3V^{(5)}$		
		0.72	1.18	mA	+85°C			
	All devices	0.88	1.45	mA	-40°C)/ 0.01/		
		1	1.45	mA	+25°C	VDD = 2.0V, $VDDCORE = 2.0V(4)$		
		1.1	1.58	mA	+85°C	VBB00KE = 2.0V		
	All devices	1.2	1.72	mA	-40°C)/== 0.5) <i>′</i>	Fosc = 4 MHz	
		1.3	1.72	mA	+25°C	VDD = 2.5V, VDDCORE = 2.5V ⁽⁴⁾	/PC PUN made	
		1.4	1.85	mA	+85°C			
	All devices	1.3	2.87	mA	-40°C			
		1.4	2.87	mA	+25°C	$VDD = 3.3V^{(5)}$		
		1.5	2.96	mA	+85°C			

- Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or Vss and all features that add delta current disabled (such as WDT, Timer1 oscillator, BOR, etc.).
 - 2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

 $\frac{\mathsf{OSC1}}{\mathsf{MCLR}} = \mathsf{external}$ square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD; $\frac{\mathsf{MCLR}}{\mathsf{MCLR}} = \mathsf{VDD}$; WDT enabled/disabled as specified.

- 3: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.
- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss).
- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, REGSLP = 1).

27.2 DC Characteristics: Power-Down and Supply Current PIC18F87J90 Family (Industrial) (Continued)

PIC18F87J90 Family (Industrial)		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial							
Param No.	Device	Тур	Max	Units	Conditions				
	Supply Current (IDD) Cont.	(2,3)							
	All devices	3	9.4	μА	-40°C	.,			
		3.3	9.4	μΑ	+25°C	VDD = 2.0V, $VDDCORE = 2.0V^{(4)}$			
		8.5	17.2	μΑ	+85°C	VDDCORE = 2.0V			
	All devices	4	10.5	μА	-40°C		Fosc = 31 kHz		
		4.3	10.5	μΑ	+25°C	VDD = 2.5V, $VDDCORE = 2.5V^{(4)}$	(RC_IDLE mode,		
		10.3	19.5	μΑ	+85°C	VDDCORE = 2.5V	internal oscillator source)		
	All devices	34	82	μА	-40°C				
		48	82	μΑ	+25°C	$VDD = 3.3V^{(5)}$			
		69	105	μΑ	+85°C				
	All devices	0.33	0.75	mA	-40°C	.,	Fosc = 1 MHz (RC_IDLE mode, internal oscillator source)		
		0.37	0.75	mA	+25°C	VDD = 2.0V, $VDDCORE = 2.0V^{(4)}$			
		0.41	0.84	mA	+85°C	VDDCORE = 2.0V			
	All devices	0.39	0.78	mA	-40°C				
		0.42	0.78	mA	+25°C	VDD = 2.5V, $VDDCORE = 2.5V^{(4)}$			
		0.47	0.91	mA	+85°C	VDDCORL = 2.5V			
	All devices	0.43	0.82	mA	-40°C				
		0.48	0.82	mA	+25°C	$VDD = 3.3V^{(5)}$			
		0.54	0.95	mA	+85°C				
	All devices	0.53	0.98	mA	-40°C	1/ 0.01/			
		0.57	0.98	mA	+25°C	VDD = 2.0V, $VDDCORE = 2.0V^{(4)}$			
		0.61	1.12	mA	+85°C	- VDDOORE - 2.0V			
	All devices	0.63	1.14	mA	-40°C	VDD = 2.5V, VDDCORE = 2.5V ⁽⁴⁾	Fosc = 4 MHz		
		0.67	1.14	mA	+25°C		/DC IDI E made		
		0.72	1.25	mA	+85°C				
	All devices	0.7	1.27	mA	-40°C				
		0.76	1.27	mA	+25°C	$VDD = 3.3V^{(5)}$			
		0.82	1.45	mA	+85°C				

- Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or Vss and all features that add delta current disabled (such as WDT, Timer1 oscillator, BOR, etc.).
 - 2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

 $\underline{\mathsf{OSC1}}$ = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD; WDT enabled/disabled as specified.

- 3: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.
- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss).
- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, REGSLP = 1).

27.2 DC Characteristics: Power-Down and Supply Current PIC18F87J90 Family (Industrial) (Continued)

PIC18F87J90 Family (Industrial)		Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for industrial										
Param No.	Device	Тур	Max	Units	Conditions							
	Supply Current (IDD) Cont. (2,3)											
	All devices	0.17	0.35	mA	-40°C							
		0.18	0.35	mA	+25°C	VDD = 2.0V, $VDDCORE = 2.0V(4)$						
		0.20	0.42	mA	+85°C	VDDCORE = 2.0V						
	All devices	0.29	0.52	mA	-40°C		Fosc = 1 MHz					
		0.31	0.52	mA	+25°C	$VDD = 2.5V,$ $VDDCORE = 2.5V^{(4)}$	(PRI_RUN mode, EC oscillator)					
		0.34	0.61	mA	+85°C	VDDCORL = 2.5V						
	All devices	0.59	1.1	mA	-40°C							
		0.44	0.85	mA	+25°C	$VDD = 3.3V^{(5)}$						
		0.42	0.85	mA	+85°C							
	All devices	0.70	1.25	mA	-40°C) /= - 0 0) /	Fosc = 4 MHz (PRI_RUN mode,					
		0.75	1.25	mA	+25°C	VDD = 2.0V, $VDDCORE = 2.0V(4)$						
		0.79	1.36	mA	+85°C	VBBOOKE = 2.0V						
	All devices	1.10	1.7	mA	-40°C)/ 0.5)/						
		1.10	1.7	mA	+25°C	VDD = 2.5V, $VDDCORE = 2.5V(4)$						
		1.12	1.82	mA	+85°C	VBB00KE = 2.0V	EC oscillator)					
	All devices	1.55	1.95	mA	-40°C							
		1.47	1.89	mA	+25°C	$VDD = 3.3V^{(5)}$						
		1.54	1.92	mA	+85°C							
	All devices	9.9	14.8	mA	-40°C	\/ 0.5\/						
		9.5	14.8	mA	+25°C	$VDD = 2.5V,$ $VDDCORE = 2.5V^{(4)}$	FOSC = 48 MHz (PRI_RUN mode, EC oscillator)					
		10.1	15.2	mA	+85°C	11200.12 2.0 V						
	All devices	13.3	23.2	mA	-40°C							
		12.2	22.7	mA	+25°C	$VDD = 3.3V^{(5)}$						
		12.1	22.7	mA	+85°C							

- Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or VSS and all features that add delta current disabled (such as WDT, Timer1 oscillator, BOR, etc.).
 - 2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

 $\frac{\text{OSC1}}{\text{MCLR}} = \text{xternal square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD; }{\frac{\text{MCLR}}{\text{MCLR}}} = \text{VDD; WDT enabled/disabled as specified.}$

- 3: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.
- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss).
- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, REGSLP = 1).

27.2 DC Characteristics: Power-Down and Supply Current PIC18F87J90 Family (Industrial) (Continued)

PIC18F87J90 Family (Industrial)		Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{Ta} \le +85^{\circ}\text{C}$ for industrial									
Param No.	Device Typ Max Units Conditions						s				
	Supply Current (IDD) Cont. (2,3)										
	All devices	4.5	5.2	mA	-40°C	.,					
		4.4	5.2	mA	+25°C	VDD = 2.5V, $VDDCORE = 2.5V^{(4)}$	Fosc = 4 MHz, 16 MHz internal (PRI_RUN HSPLL mode)				
		4.5	5.2	mA	+85°C	VBBOOKE = 2.0 V					
	All devices	5.7	6.7	mA	-40°C						
		5.5	6.3	mA	+25°C	$VDD = 3.3V^{(5)}$					
		5.3	6.3	mA	+85°C						
	All devices	10.8	13.5	mA	-40°C	\/ 0.5\/	Fosc = 10 MHz, 40 MHz internal (PRI_RUN HSPLL mode)				
		10.8	13.5	mA	+25°C	VDD = 2.5V, $VDDCORE = 2.5V^{(4)}$					
		9.9	13.0	mA	+85°C	$VDD = 3.3V^{(5)}$					
	All devices	13.4	24.1	mA	-40°C						
		12.3	20.2	mA	+25°C						
		11.2	19.5	mA	+85°C						

- Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or Vss and all features that add delta current disabled (such as WDT, Timer1 oscillator, BOR, etc.).
 - 2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

<u>OSC1</u> = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD; WDT enabled/disabled as specified.

- 3: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.
- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss).
- **5:** Voltage regulator enabled (ENVREG = 1, tied to VDD, REGSLP = 1).

27.2 DC Characteristics: Power-Down and Supply Current PIC18F87J90 Family (Industrial) (Continued)

	87J90 Family estrial)	Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{Ta} \le +85^{\circ}\text{C}$ for industrial								
Param No.	Device	Тур	Max	Units		Conditions				
	Supply Current (IDD) Cont.	(2,3)								
	All devices	0.10	0.26	mA	-40°C	.,				
		0.07	0.18	mA	+25°C	VDD = 2.0V, $VDDCORE = 2.0V^{(4)}$				
		0.09	0.22	mA	+85°C	V D D O O N E = 2.0 V				
	All devices	0.25	0.48	mA	-40°C)/ 0.5)/	Fosc = 1 MHz			
		0.13	0.30	mA	+25°C	VDD = 2.5V, $VDDCORE = 2.5V^{(4)}$	(PRI_IDLE mode,			
		0.10	0.26	mA	+85°C	V D D O O N E = 2.0 V	EC oscillator)			
	All devices	0.45	0.68	mA	-40°C					
		0.26	0.45	mA	+25°C	$VDD = 3.3V^{(5)}$				
		0.30	0.54	mA	+85°C					
	All devices	0.36	0.60	mA	-40°C	\/ 0.0\/				
		0.33	0.56	mA	+25°C	VDD = 2.0V, $VDDCORE = 2.0V^{(4)}$				
		0.35	0.56	mA	+85°C	V D D O O N E = 2.0 V				
	All devices	0.52	0.81	mA	-40°C)/ 0.5)/	Fosc = 4 MHz			
		0.45	0.70	mA	+25°C	VDD = 2.5V, $VDDCORE = 2.5V^{(4)}$	(PRI_IDLE mode,			
		0.46	0.70	mA	+85°C	V B B G G K E = 2.6 V	EC oscillator)			
	All devices	0.80	1.15	mA	-40°C					
		0.66	0.98	mA	+25°C	$VDD = 3.3V^{(5)}$				
		0.65	0.98	mA	+85°C					
	All devices	5.2	6.5	mA	-40°C	\/ 0.5\/				
		4.9	5.9	mA	+25°C	VDD = 2.5V, $VDDCORE = 2.5V^{(4)}$	FOSC = 48 MHz			
		3.4	4.5	mA	+85°C	1 2 3 3 1 2 3 7				
	All devices	6.2	12.4	mA	-40°C		(PRI_IDLE mode, EC oscillator)			
		5.9	11.5	mA	+25°C	$VDD = 3.3V^{(5)}$	Lo oddinator)			
		5.8	11.5	mA	+85°C					

- Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or VSS and all features that add delta current disabled (such as WDT, Timer1 oscillator, BOR, etc.).
 - 2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

 $\frac{\mathsf{OSC1}}{\mathsf{MCLR}} = \mathsf{external}$ square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD; $\frac{\mathsf{MCLR}}{\mathsf{MCLR}} = \mathsf{VDD}$; WDT enabled/disabled as specified.

- 3: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.
- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss).
- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, REGSLP = 1).

27.2 DC Characteristics: Power-Down and Supply Current PIC18F87J90 Family (Industrial) (Continued)

	7J90 Family strial)	Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial								
Param No.	Device	Тур	Max	Units		Conditions				
	Supply Current (IDD) Cont.	(2,3)								
	All devices	18	35	μA	-40°C)/ 0.0\/				
		19	35	μA	+25°C	VDD = 2.0V, $VDDCORE = 2.0V(4)$				
		28	49	μA	+85°C	VBB00KE = 2.0V				
	All devices	20	45	μΑ	-40°C	\/ 0.5\/	Fosc = 32 kHz ⁽³⁾ (SEC_RUN mode, Timer1 as clock)			
		21	45	μΑ	+25°C	VDD = 2.5V, $VDDCORE = 2.5V^{(4)}$				
		32	61	μA	+85°C	VBB00KE = 2.0V				
	All devices	0.06	0.11	mA	-40°C					
		0.07	0.11	mA	+25°C	$VDD = 3.3V^{(5)}$				
		0.09	0.15	mA	+85°C					
	All devices	14	28	μΑ	-40°C	\/22 0.0\/				
		15	28	μΑ	+25°C	VDD = 2.0V, $VDDCORE = 2.0V(4)$				
		24	43	μΑ	+85°C	13300K2 2 .01				
	All devices	15	31	μΑ	-40°C	\/ 0.5\/	Fosc = 32 kHz ⁽³⁾			
		16	31	μΑ	+25°C	VDD = 2.5V, $VDDCORE = 2.5V^{(4)}$	(SEC_IDLE mode,			
		27	50	μA	+85°C	15555.12 - 2.01	Timer1 as clock)			
	All devices	0.05	0.10	mA	-40°C					
		0.06	0.10	mA	+25°C	$VDD = 3.3V^{(5)}$				
	_	0.08	0.14	mA	+85°C					

- Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or Vss and all features that add delta current disabled (such as WDT, Timer1 oscillator, BOR, etc.).
 - 2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD; WDT enabled/disabled as specified.

- 3: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.
- **4:** Voltage regulator disabled (ENVREG = 0, tied to Vss).
- **5:** Voltage regulator enabled (ENVREG = 1, tied to VDD, REGSLP = 1).

27.2 DC Characteristics: Power-Down and Supply Current PIC18F87J90 Family (Industrial) (Continued)

PIC18F87 (Indus	7J90 Family strial)	Standard C Operating t			itions (unless ot $-40^{\circ}\text{C} \le \text{TA} \le +$	herwise stated) -85°C for industrial				
Param No.	Device	Тур	Max	Units		Condition	s			
D022	Module Differential Curren	ts (∆lwdt, ∆	Ioscb, /	\lad)						
	Watchdog Timer	2.1	7.0	μА	-40°C	\/pp				
		2.2	7.0	μА	+25°C	VDD = 2.0V, $VDDCORE = 2.0V^{(4)}$				
		4.3	9.5	μА	+85°C	VBBOOKE = 2.0V				
		3.0	8.0	μΑ	-40°C	VDD = 2.5V,				
		3.1	8.0	μΑ	+25°C	VDD = 2.5V, $VDDCORE = 2.5V^{(4)}$				
		5.5	10.4	μА	+85°C	VDDCORL = 2.3V				
		5.9	12.1	μΑ	-40°C					
		6.2	12.1	μΑ	+25°C	VDD = 3.3V				
		6.9	13.6	μΑ	+85°C					
D024	LCD Module	2 ^(6,7)	5	μΑ	+25°C	VDD = 2.0V	Resistive Ladder CPEN = 0;			
(∆ILCD)		2.7 ^(6,7)	5	μΑ	+25°C	VDD = 2.5V				
		3.5 ^(6,7)	7	μΑ	+25°C	VDD = 3.0V	CKSEL<1:0> = 00; CS<1:0> = 10; LP<3:0> = 0100			
		16 ⁽⁷⁾	25	μA	+25°C	VDD = 2.0V	Charge Pump			
		17 ⁽⁷⁾	25	μA	+25°C	VDD = 2.5V	BIAS<2:0> = 111;			
		24 ⁽⁷⁾	40	μΑ	+25°C	VDD = 3.0V	CPEN = 1; CKSEL<1:0> = 11; CS<1:0> = 10			
D025	RTCC + Timer1 Osc. with	0.9	4.0	μА	-10°C	\/pp 0.0\/				
(∆loscb)	32 kHz Crystal ⁽⁶⁾	1.0	4.5	μА	+25°C	$VDD = 2.0V,$ $VDDCORE = 2.0V^{(4)}$	32 kHz on Timer1 ⁽³⁾			
		1.1	4.5	μА	+85°C	VDDCORL = 2.0V				
		1.1	4.5	μΑ	-10°C	VDD = 2.5V,				
		1.2	5.0	μΑ	+25°C	VDD = 2.5V, $VDDCORE = 2.5V^{(4)}$	32 kHz on Timer1 ⁽³⁾			
		1.2	5.0	μА	+85°C	V D D O O N L - 2.0 V				
		1.6	6.5	μΑ	-10°C					
		1.6	6.5	μΑ	+25°C	VDD = 3.3V	32 kHz on Timer1 ⁽³⁾			
		2.1	8.0	μΑ	+85°C					
D026 (ΔIAD)	A/D Converter	3.0	10.0	μΑ	-40°C to +85°C	$VDD = 2.0V,$ $VDDCORE = 2.0V^{(4)}$	A/D on, not converting			
		3.0	10.0	μΑ	-40°C to +85°C	VDD = 2.5V,				

- Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or Vss and all features that add delta current disabled (such as WDT, Timer1 oscillator, BOR, etc.).
 - 2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD; MCLR = VDD; WDT enabled/disabled as specified.

- 3: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.
- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss).
- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, REGSLP = 1).

27.3 DC Characteristics: PIC18F87J90 Family (Industrial)

DC CHA	ARACTE	RISTICS				ınless otherwise stated) ≤ +85°C for industrial
Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
	VIL	Input Low Voltage				
		All I/O Ports:				
D030		with TTL Buffer	Vss	0.15 VDD	V	
D031		with Schmitt Trigger Buffer	Vss	0.2 VDD	V	
D032		MCLR	Vss	0.2 VDD	V	
D033		OSC1	Vss	0.3 VDD	V	HS, HSPLL modes
D033A		OSC1	Vss	0.2 VDD	V	EC, ECPLL modes
D034		T13CKI	Vss	0.3	V	
	VIH	Input High Voltage				
		I/O Ports with Analog Functions:				
D040		with TTL Buffer	0.25 VDD + 0.8V	VDD	V	VDD < 3.3V
D041		with Schmitt Trigger Buffer	0.8 VDD	VDD	V	
		Digital Only I/O Ports:				
		with TTL Buffer	0.25 VDD + 0.8V	5.5	V	VDD < 3.3V
			2.0	5.5	V	$3.3 \text{V} \leq \text{VDD} \leq 3.6 \text{V}$
		with Schmitt Trigger Buffer	0.8 VDD	5.5	V	
D042		MCLR	0.8 VDD	VDD	V	
D043		OSC1	0.7 VDD	VDD	V	HS, HSPLL modes
D043A		OSC1	0.8 VDD	VDD	V	EC, ECPLL modes
D044		T13CKI	1.6	VDD	V	
	lı∟	Input Leakage Current ⁽¹⁾				
D060		I/O Ports with Analog Functions	_	±1	μА	VSS ≤ VPIN ≤ VDD, Pin at high-impedance
		Digital Only I/O Ports	_	±1	μΑ	VSS ≤ VPIN ≤ 5.5V
D061		MCLR	_	±1	μΑ	$Vss \le VPIN \le VDD$
D063		OSC1	_	±5	μΑ	$Vss \leq VPIN \leq VDD$
	IPU	Weak Pull-up Current				
D070	IPURB	PORTB Weak Pull-up Current	80	400	μΑ	VDD = 3.3V, VPIN = VSS

Note 1: Negative current is defined as current sourced by the pin.

27.3 DC Characteristics: PIC18F87J90 Family (Industrial) (Continued)

DC CHA	ARACTE	RISTICS				unless otherwise stated) ≤ +85°C for industrial
Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
	Vol	Output Low Voltage				
D080		I/O Ports:				
		PORTA, PORTF, PORTG, PORTH	_	0.4	V	IOL = 2 mA, VDD = 3.3V, -40°C to +85°C
		PORTD, PORTE, PORTJ	_	0.4	V	IOL = 3.4 mA , VDD = 3.3V , -40°C to $+85^{\circ}\text{C}$
		PORTB, PORTC	_	0.4	V	IOL = 3.4 mA , VDD = 3.3V , -40°C to $+85^{\circ}\text{C}$
D083		OSC2/CLKO (EC, ECPLL modes)	_	0.4	V	IOL = 1.6 mA , VDD = 3.3V , -40°C to $+85^{\circ}\text{C}$
	Vон	Output High Voltage ⁽¹⁾				
D090		I/O Ports:			V	
		PORTA, PORTF, PORTG, PORTH	2.4	_	V	IOH = -2 mA, VDD = 3.3 V, -40 °C to $+85$ °C
		PORTD, PORTE, PORTJ	2.4	_	V	IOH = -2 mA, VDD = 3.3V, -40°C to +85°C
		PORTB, PORTC	2.4	_	V	IOH = -2 mA, VDD = 3.3V, -40°C to +85°C
D092		OSC2/CLKO (INTOSC, EC, ECPLL modes)	2.4	_	V	IOH = -1 mA, VDD = 3.3V, -40°C to +85°C
		Capacitive Loading Specs on Output Pins				
D100 ⁽⁴⁾	COSC2	OSC2 Pin	_	15	pF	In HS mode when external clock is used to drive OSC1
D101	Сю	All I/O Pins and OSC2	_	50	pF	To meet the AC Timing Specifications
D102	Св	SCL, SDA	_	400	pF	I ² C™ Specification

Note 1: Negative current is defined as current sourced by the pin.

27.4 DC Characteristics: CTMU Current Source Specifications

					•				
DC CHARACTERISTICS			Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{Ta} \le +85^{\circ}\text{C}$ for Industrial						
Param No.	Param No. Sym Characteristic			Typ ⁽¹⁾	Max	Units	Conditions		
	IOUT1	CTMU Current Source, Base Range	_	550	_	nA	CTMUICON<1:0> = 01		
	IOUT2	CTMU Current Source, 10x Range	_	5.5	_	μΑ	CTMUICON<1:0> = 10		
	Іоит3	CTMU Current Source, 100x Range	_	55	_	μΑ	CTMUICON<1:0> = 11		

Note 1: Nominal value at center point of current trim range (CTMUICON<7:2> = 000000).

TABLE 27-1: MEMORY PROGRAMMING REQUIREMENTS

DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial				
Param No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
		Program Flash Memory					
D130	EР	Cell Endurance	10K	_	_	E/W	-40°C to +85°C
D131	VPR	VDD for Read	VMIN	_	3.6	V	VMIN = Minimum operating voltage
D132B	VPEW	Voltage for Self-Timed Erase or Write operations					
		VDD	2.35	_	3.6	V	ENVREG tied to VDD
		VDDCORE	2.25	_	2.7	V	ENVREG tied to Vss
D133A	Tıw	Self-Timed Write Cycle Time		2.8	_	ms	
D133B	TIE	Self-Timed Block Erased Cycle Time	_	33	_	ms	
D134	TRETD	Characteristic Retention	20	_	_	Year	Provided no other specifications are violated
D135	IDDP	Supply Current during Programming	_	3	14	mA	
D140	TWE	Writes per Erase Cycle	_	_	1		For each physical address

[†] Data in "Typ" column is at 3.3V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

TABLE 27-2: COMPARATOR SPECIFICATIONS

Operating Conditions: $3.0V \le VDD \le 3.6V$, $-40^{\circ}C \le TA \le +85^{\circ}C$ (unless otherwise stated) **Param** Units Sym **Characteristics** Min Max Comments Тур No. D300 VIOFF Input Offset Voltage ±5.0 ±25 mV D301 VICM Input Common Mode Voltage 0 AVDD - 1.5 V D302 **CMRR** Common Mode Rejection Ratio 55 dΒ Response Time⁽¹⁾ D303 TRESP 150 400 ns D304 Тмс2о۷ Comparator Mode Change to 10 μS Output Valid*

Note 1: Response time measured with one comparator input at (AVDD – 1.5)/2, while the other input transitions from Vss to VDD.

TABLE 27-3: VOLTAGE REFERENCE SPECIFICATIONS

Operating	Operating Conditions: $3.0V \le VDD \le 3.6V$, $-40^{\circ}C \le TA \le +85^{\circ}C$ (unless otherwise stated)							
Param No.	Sym	Characteristics	Min	Тур	Max	Units	Comments	
D310	VRES	Resolution	VDD/24	_	VDD/32	LSb		
D311	VRAA	Absolute Accuracy	_	_	1/2	LSb		
D312	VRur	Unit Resistor Value (R)	_	2k	_	Ω		
310	TSET	Settling Time ⁽¹⁾	_	_	10	μS		

Note 1: Settling time measured while CVRR = 1 and CVR<3:0> transitions from '0000' to '1111'.

TABLE 27-4: INTERNAL VOLTAGE REGULATOR SPECIFICATIONS

Operatir	Operating Conditions: $-40^{\circ}C \le TA \le +85^{\circ}C$ (unless otherwise stated)						
Param No.	Sym	Characteristics	Min	Тур	Max	Units	Comments
	VRGOUT	Regulator Output Voltage*	_	2.5	_	V	
	CEFC	External Filter Capacitor Value*	4.7	10	_	μF	Capacitor must be low-ESR, a low series resistance ($< 5\Omega$)

TABLE 27-5: INTERNAL LCD VOLTAGE REGULATOR SPECIFICATIONS

Operatir	Operating Conditions: $2.0V \le VDD \le 3.6V$, $-40^{\circ}C \le TA \le +85^{\circ}C$ (unless otherwise stated)						
Param No.	Sym	Characteristics	Min	Тур	Max	Units	Comments
	CFLY	Fly Back Capacitor	0.47	4.7		μF	Capacitor must be low-ESR
	VBIAS	VPK-PK between LCDBIAS0 &	_	3.40	3.6	V	BIAS<2:0> = 111
		LCDBIAS3	_	3.27	_	V	BIAS<2:0> = 110
		_	3.14	_	V	BIAS<2:0> = 101	
			_	3.01	_	V	BIAS<2:0> = 100
			_	2.88	_	V	BIAS<2:0> = 011
		_	2.75	_	V	BIAS<2:0> = 010	
			_	2.62	_	V	BIAS<2:0> = 001
			_	2.49	_	V	BIAS<2:0> = 000

27.5 AC (Timing) Characteristics

27.5.1 TIMING PARAMETER SYMBOLOGY

The timing parameter symbols have been created following one of the following formats:

1. TppS2pp	oS	3. Tcc:st	(I ² C specifications only)
2. TppS		4. Ts	(I ² C specifications only)
Т			
F	Frequency	Т	Time
Lowercase	letters (pp) and their meanings:		
рр			
СС	CCP1	osc	OSC1
ck	CLKO	rd	RD
cs	CS	rw	RD or WR
di	SDI	sc	SCK
do	SDO	SS	SS
dt	Data in	tO	TOCKI
io	I/O port	t1	T13CKI
mc	MCLR	wr	WR
Uppercase	letters and their meanings:		
S	-		
F	Fall	Р	Period
Н	High	R	Rise
1	Invalid (High-impedance)	V	Valid
L	Low	Z	High-impedance
I ² C only			
AA	output access	High	High
BUF	Bus free	Low	Low
Tcc:st (I ² C	specifications only)		
CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	Stop condition
STA	Start condition		

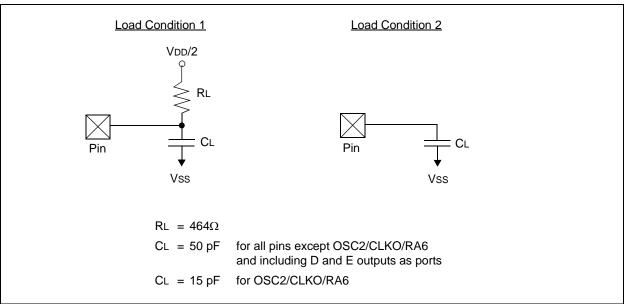
27.5.2 TIMING CONDITIONS

The temperature and voltages specified in Table 27-6 apply to all timing specifications unless otherwise noted. Figure 27-3 specifies the load conditions for the timing specifications.

TABLE 27-6: TEMPERATURE AND VOLTAGE SPECIFICATIONS - AC

	Standard Operating Conditions (unless otherwise stated)
AC CHARACTERISTICS	Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for industrial
	Operating voltage VDD range as described in Section 27.1 and Section 27.3 .

FIGURE 27-3: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



© 2009 Microchip Technology Inc. Preliminary DS39933C-page 403

27.5.3 TIMING DIAGRAMS AND SPECIFICATIONS

FIGURE 27-4: EXTERNAL CLOCK TIMING

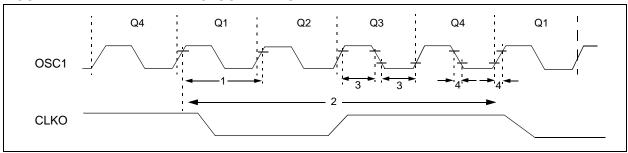


TABLE 27-7: EXTERNAL CLOCK TIMING REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions
1A	Fosc	External CLKI Frequency ⁽¹⁾	DC	48	MHz	EC Oscillator mode
			DC	10		ECPLL Oscillator mode
		Oscillator Frequency ⁽¹⁾	4	25	MHz	HS Oscillator mode
			4	10		HSPLL Oscillator mode
1	Tosc	External CLKI Period ⁽¹⁾	20.8	_	ns	EC Oscillator mode
			100	_		ECPLL Oscillator mode
		Oscillator Period ⁽¹⁾	40.0	250	ns	HS Oscillator mode
			100	250		HSPLL Oscillator mode
2	Tcy	Instruction Cycle Time ⁽¹⁾	83.3	_	ns	Tcy = 4/Fosc, Industrial
3	TosL, TosH	External Clock in (OSC1) High or Low Time	10	_	ns	HS Oscillator mode
4	TosR, TosF	External Clock in (OSC1) Rise or Fall Time	_	7.5	ns	HS Oscillator mode

Note 1: Instruction cycle period (TcY) equals four times the input oscillator time base period for all configurations except PLL. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKI pin. When an external clock input is used, the "max." cycle time limit is "DC" (no clock) for all devices.

TABLE 27-8: PLL CLOCK TIMING SPECIFICATIONS (VDD = 2.15V TO 3.6V)

Param No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
F10	Fosc	Oscillator Frequency Range	4	_	10	MHz	HS mode only
F11	Fsys	On-Chip VCO System Frequency	16	_	40	MHz	HS mode only
F12	t _{rc}	PLL Start-up Time (Lock Time)	_	_	2	ms	
F13	Δ CLK	CLKO Stability (Jitter)	-2	_	+2	%	

Data in "Typ" column is at 3.3V, 25°C, unless otherwise stated. These parameters are for design guidance only and are not tested.

TABLE 27-9: INTERNAL RC ACCURACY (INTOSC AND INTRC SOURCES)

	87J90 Family ustrial)		Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for industrial						
Param No.	Device		Тур	Max	Units	Conditions			
	INTOSC Accuracy @ Fre	q = 8 MH	z, 4 MHz,	2 MHz, 1	MHz, 500) kHz, 250 kHz, 125 kl	Hz, 31 kHz ⁽¹⁾		
	All Devices	-2	+/-1	2	%	+25°C	VDD = 2.7-3.3V		
		-5	_	5	%	-10°C to +85°C	VDD = 2.0-3.3V		
			+/-1	10	%	-40°C to +85°C	VDD = 2.0-3.3V		
	INTRC Accuracy @ Freq	= 31 kHz	(1)	•					
	All Devices	21.7	_	40.3	kHz	-40°C to +85°C	VDD = 2.0-3.3V		

Note 1: The accuracy specification of the 31 kHz clock is determined by which source is providing it at a given time. When INTSRC (OSCTUNE<7>) is '1', use the INTOSC accuracy specification. When INTSRC is '0', use the INTRC accuracy specification.

© 2009 Microchip Technology Inc. Preliminary DS39933C-page 405

FIGURE 27-5: CLKO AND I/O TIMING

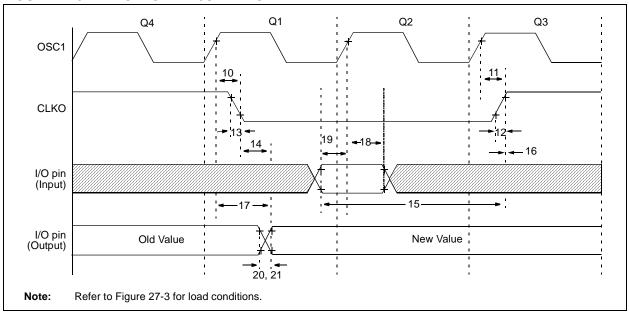


TABLE 27-10: CLKO AND I/O TIMING REQUIREMENTS

Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions
10	TosH2ckL	OSC1 ↑ to CLKO ↓	_	75	200	ns	(Note 1)
11	TosH2ckH	OSC1 ↑ to CLKO ↑	_	75	200	ns	(Note 1)
12	TCKR	CLKO Rise Time	_	15	30	ns	(Note 1)
13	TCKF	CLKO Fall Time	_	15	30	ns	(Note 1)
14	TckL2ioV	CLKO ↓ to Port Out Valid	_	_	0.5 Tcy + 20	ns	
15	TioV2ckH	Port In Valid before CLKO ↑	0.25 Tcy + 25	_	_	ns	
16	TckH2iol	Port In Hold after CLKO ↑	0	_	_	ns	
17	TosH2IoV	OSC1 ↑ (Q1 cycle) to Port Out Valid	_	50	150	ns	
18	TosH2ioI	OSC1 ↑ (Q2 cycle) to Port Input Invalid (I/O in hold time)	100	_	_	ns	
19	TioV2osH	Port Input Valid to OSC1 ↑ (I/O in setup time)	0	_	_	ns	
20	TioR	Port Output Rise Time	_	_	6	ns	
21	TioF	Port Output Fall Time	_	_	5	ns	
22†	TINP	INTx pin High or Low Time	Tcy	_	_	ns	
23†	Тквр	RB<7:4> Change INTx High or Low Time	Tcy	_	_	ns	

[†] These parameters are asynchronous events not related to any internal clock edges.

Note 1: Measurements are taken in EC mode, where CLKO output is 4 x Tosc.

FIGURE 27-6: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

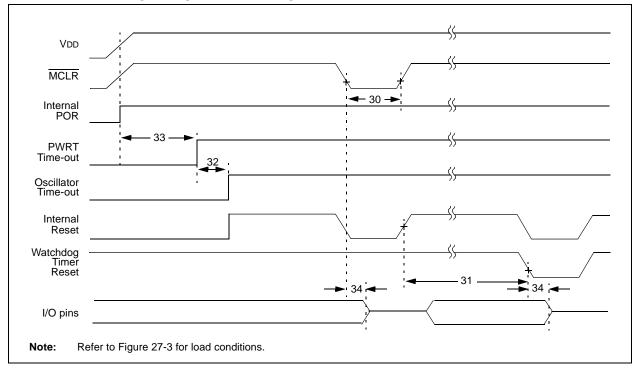


TABLE 27-11: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER AND BROWN-OUT RESET REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions
30	ТмсL	MCLR Pulse Width (low)	2 Tcy	10 Tcy	_		(Note 1)
31	TWDT	Watchdog Timer Time-out Period (no postscaler)	3.4	4.0	4.6	ms	
32	Tost	Oscillation Start-up Timer Period	1024 Tosc	_	1024 Tosc		Tosc = OSC1 period
33	TPWRT	Power-up Timer Period	45.8	65.5	85.2	ms	
34	Tioz	I/O High-Impedance from MCLR Low or Watchdog Timer Reset	_	2	_	μs	
38	TCSD	CPU Start-up Time	_	10	_	μs	
				200		μs	Voltage Regulator enabled and put to sleep
39	TIOBST	Time for INTOSC to Stabilize	_	1	_	μs	

Note 1: To ensure device Reset, MCLR must be low for at least 2 Tcγ or 400 μs, whichever is lower.

© 2009 Microchip Technology Inc. Preliminary DS39933C-page 407

FIGURE 27-7: TIMERO AND TIMER1 EXTERNAL CLOCK TIMINGS

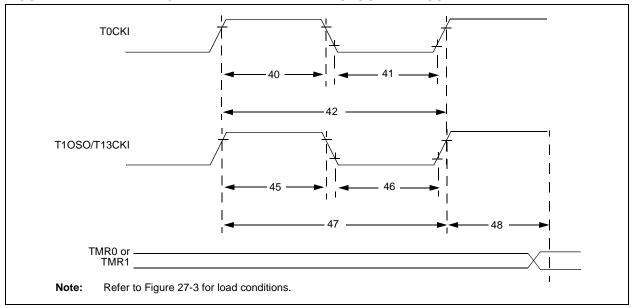


TABLE 27-12: TIMERO AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Symbol		Characteristic	;	Min	Max	Units	Conditions
40	Тт0Н	T0CKI High P	ulse Width	No prescaler	0.5 Tcy + 20	_	ns	
				With prescaler	10	_	ns	
41	TT0L	T0CKI Low Po	ulse Width	No prescaler	0.5 Tcy + 20	_	ns	
				With prescaler	10	_	ns	
42	TT0P	T0CKI Period		No prescaler	Tcy + 10	_	ns	
				With prescaler	Greater of: 20 ns or (TcY + 40)/N	_	ns	N = prescale value (1, 2, 4,, 256)
45	T⊤1H	T13CKI High	Synchronous, n	o prescaler	0.5 Tcy + 20	_	ns	
		Time	Synchronous, w	ith prescaler	10	_	ns	
			Asynchronous		30	_	ns	
46	T⊤1L	T13CKI Low	Synchronous, n	o prescaler	0.5 Tcy + 5	_	ns	
		Time	Synchronous, w	ith prescaler	10	_	ns	
			Asynchronous		30	_	ns	
47	TT1P	T13CKI Input Period	Synchronous		Greater of: 20 ns or (TcY + 40)/N	_	ns	N = prescale value (1, 2, 4, 8)
			Asynchronous		60	_	ns	
	FT1	T13CKI Oscill	ator Input Frequency Range		DC	50	kHz	
48	TCKE2TMRI	Delay from Ex Timer Increme	kternal T13CKI C ent	lock Edge to	2 Tosc	7 Tosc	_	

FIGURE 27-8: CAPTURE/COMPARE/PWM TIMINGS (CCP1, CCP2 MODULES)

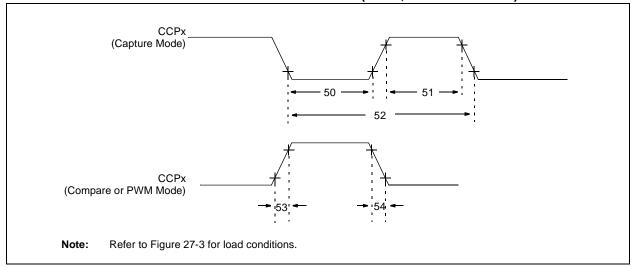


TABLE 27-13: CAPTURE/COMPARE/PWM REQUIREMENTS (CCP1, CCP2 MODULES)

Param No.	Symbol	С	haracteristic	Min	Max	Units	Conditions
50	TccL	CCPx Input Low	No prescaler	0.5 Tcy + 20	_	ns	
		Time	With prescaler	10	_	ns	
51	TccH	CCPx Input	No prescaler	0.5 Tcy + 20	_	ns	
		High Time	With prescaler	10	_	ns	
52	TCCP	CCPx Input Perio	od	3 Tcy + 40 N	_	ns	N = prescale value (1, 4 or 16)
53	TccR	CCPx Output Fal	I Time	_	25	ns	
54	TccF	CCPx Output Fal	I Time	_	25	ns	

© 2009 Microchip Technology Inc. Preliminary DS39933C-page 409

SS SCK (CKP = 0)SCK (CKP = 1)80 MSb bit 6 LSb SDO 75, 76 SDI LSb In MSb In 74 Note: Refer to Figure 27-3 for load conditions.

FIGURE 27-9: EXAMPLE SPI MASTER MODE TIMING (CKE = 0)

TABLE 27-14: EXAMPLE SPI MODE REQUIREMENTS (MASTER MODE, CKE = 0)

Param No.	Symbol	Characteristic		Min	Max	Units	Conditions
70	TssL2scH, TssL2scL	SS ↓ to SCK ↓ or SCK ↑ Input		Tcy	_	ns	
71	TscH	SCK Input High Time	Continuous	1.25 Tcy + 30	_	ns	
71A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
72	TscL	SCK Input Low Time	Continuous	1.25 Tcy + 30	_	ns	
72A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
73	TDIV2SCH, TDIV2SCL	Setup Time of SDI Data Input t	Setup Time of SDI Data Input to SCK Edge		_	ns	
73A	Тв2в	Last Clock Edge of Byte 1 to the of Byte 2	e 1st Clock Edge	1.5 Tcy + 40	_	ns	(Note 2)
74	TSCH2DIL, TSCL2DIL	Hold Time of SDI Data Input to	SCK Edge	100	_	ns	
75	TDOR	SDO Data Output Rise Time		_	25	ns	
76	TDOF	SDO Data Output Fall Time		_	25	ns	
78	TscR	SCK Output Rise Time (Master mode)		_	25	ns	
79	TscF	SCK Output Fall Time (Master mode)		_	25	ns	
80	TscH2DoV, TscL2DoV	SDO Data Output Valid after S	CK Edge	_	50	ns	

Note 1: Requires the use of Parameter #73A.

2: Only if Parameter #71A and #72A are used.

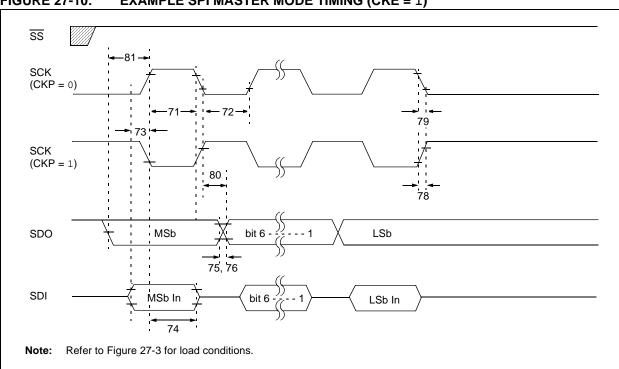


FIGURE 27-10: EXAMPLE SPI MASTER MODE TIMING (CKE = 1)

TABLE 27-15: EXAMPLE SPI MODE REQUIREMENTS (MASTER MODE, CKE = 1)

Param. No.	Symbol	Characterist	Characteristic		Max	Units	Conditions
71	TscH	SCK Input High Time	Continuous	1.25 Tcy + 30	_	ns	
71A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
72	TscL	SCK Input Low Time	Continuous	1.25 Tcy + 30	_	ns	
72A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
73	TDIV2SCH, TDIV2SCL	Setup Time of SDI Data Input	to SCK Edge	100	_	ns	
73A	Тв2в	Last Clock Edge of Byte 1 to the 1st Clock Edge of Byte 2		1.5 Tcy + 40	_	ns	(Note 2)
74	TSCH2DIL, TSCL2DIL	Hold Time of SDI Data Input to	o SCK Edge	100	_	ns	
75	TDOR	SDO Data Output Rise Time		_	25	ns	
76	TDOF	SDO Data Output Fall Time		_	25	ns	
78	TscR	SCK Output Rise Time (Maste	er mode)	_	25	ns	
79	TscF	SCK Output Fall Time (Master mode)		_	25	ns	
80	TscH2DoV, TscL2DoV	SDO Data Output Valid after SCK Edge		_	50	ns	
81	TDOV2SCH, TDOV2SCL	SDO Data Output Setup to SO	CK Edge	Tcy	_	ns	

Note 1: Requires the use of Parameter #73A.

2: Only if Parameter #71A and #72A are used.

© 2009 Microchip Technology Inc. Preliminary DS39933C-page 411

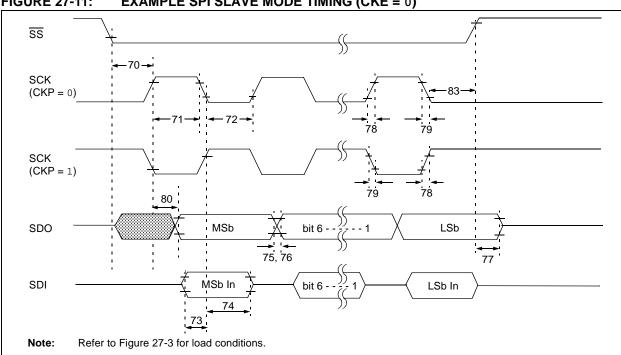


FIGURE 27-11: **EXAMPLE SPI SLAVE MODE TIMING (CKE = 0)**

TABLE 27-16: EXAMPLE SPI MODE REQUIREMENTS (SLAVE MODE TIMING, CKE = 0)

Param No.	Symbol	Characteristic		Min	Max	Units	Conditions
70	TssL2scH, TssL2scL	SS ↓ to SCK ↓ or SCK ↑ Input		3 TcY		ns	
70A	TssL2WB	SS to write to SSPBUF		3 Tcy	_	ns	
71	TscH	SCK Input High Time	Continuous	1.25 Tcy + 30	_	ns	
71A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
72	TscL	SCK Input Low Time	Continuous	1.25 Tcy + 30	_	ns	
72A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
73	TDIV2SCH, TDIV2SCL	Setup Time of SDI Data Input to SCK E	p Time of SDI Data Input to SCK Edge		_	ns	
73A	Тв2в	Last Clock Edge of Byte 1 to the First Clo	ck Edge of Byte 2	1.5 Tcy + 40	_	ns	(Note 2)
74	TscH2DIL, TscL2DIL	Hold Time of SDI Data Input to SCK Ed	ge	100	_	ns	
75	TDOR	SDO Data Output Rise Time		_	25	ns	
76	TDOF	SDO Data Output Fall Time		_	25	ns	
77	TssH2DoZ	SS ↑ to SDO Output High-impedance		10	50	ns	
78	TscR	SCK Output Rise Time (Master mode)		_	25	ns	
79	TscF	SCK Output Fall Time (Master mode)		_	25	ns	
80	TscH2DoV, TscL2DoV	SDO Data Output Valid after SCK Edge		_	50	ns	
83	TscH2ssH, TscL2ssH	SS ↑ after SCK Edge		1.5 Tcy + 40	_	ns	

Note 1: Requires the use of Parameter #73A.

2: Only if Parameter #71A and #72A are used.

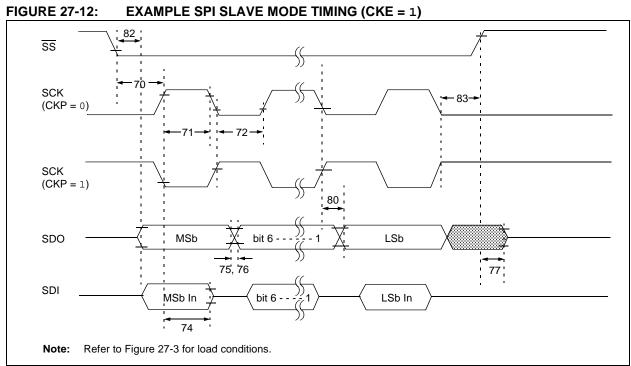


TABLE 27-17: EXAMPLE SPI SLAVE MODE REQUIREMENTS (CKE = 1)

Param No.	Symbol	Characteristic	·	Min	Max	Units	Conditions
70	TssL2scH, TssL2scL	SS ↓ to SCK ↓ or SCK ↑ Input		3 Tcy	-	ns	
70A	TssL2WB	SS to write to SSPBUF		3 Tcy	_	ns	
71	TscH	SCK Input High Time	Continuous	1.25 Tcy + 30	_	ns	
71A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
72	TscL	SCK Input Low Time	Continuous	1.25 Tcy + 30	_	ns	
72A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
73A	Тв2в	Last Clock Edge of Byte 1 to the First	Clock Edge of Byte 2	1.5 Tcy + 40	_	ns	(Note 2)
74	TscH2dlL, TscL2dlL	Hold Time of SDI Data Input to SCK	Edge	100		ns	
75	TDOR	SDO Data Output Rise Time		_	25	ns	
76	TDOF	SDO Data Output Fall Time		_	25	ns	
77	TssH2DoZ	SS ↑ to SDO Output High-Impedance	ce	10	50	ns	
78	TscR	SCK Output Rise Time (Master mod	e)	_	25	ns	
79	TscF	SCK Output Fall Time (Master mode	e)	_	25	ns	
80	TSCH2DOV, TSCL2DOV	SDO Data Output Valid after SCK Edge		_	50	ns	
82	TssL2DoV	SDO Data Output Valid after SS ↓ Edge		_	50	ns	
83	TscH2ssH, TscL2ssH	SS ↑ after SCK Edge		1.5 Tcy + 40	_	ns	

Note 1: Requires the use of Parameter #73A.

2: Only if Parameter #71A and #72A are used.

FIGURE 27-13: I²C™ BUS START/STOP BITS TIMING

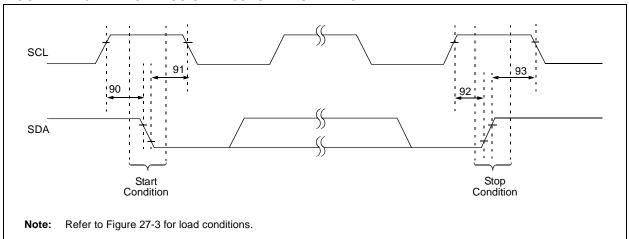


TABLE 27-18: I^2C^{TM} BUS START/STOP BITS REQUIREMENTS (SLAVE MODE)

Param. No.	Symbol	Characte	ristic	Min	Max	Units	Conditions
90	Tsu:sta	Start Condition	100 kHz mode	4700	_	ns	Only relevant for Repeated
		Setup Time	400 kHz mode	600	_		Start condition
91	THD:STA	Start Condition	100 kHz mode	4000	_	ns	After this period, the first
		Hold Time	400 kHz mode	600	_		clock pulse is generated
92	Tsu:sto	Stop Condition	100 kHz mode	4700	_	ns	
		Setup Time	400 kHz mode	600	_		
93	THD:STO	Stop Condition	100 kHz mode	4000	_	ns	
		Hold Time	400 kHz mode	600	_		

FIGURE 27-14: I²C™ BUS DATA TIMING

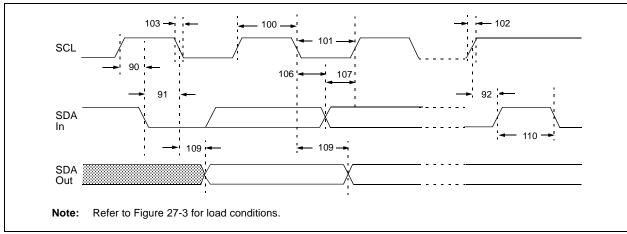


TABLE 27-19: I²C™ BUS DATA REQUIREMENTS (SLAVE MODE)

Param. No.	Symbol	Characteris	tic	Min	Max	Units	Conditions	
100	THIGH	Clock High Time	100 kHz mode	4.0	_	μS		
			400 kHz mode	0.6	_	μS		
			MSSP Module	1.5 TcY	_			
101	TLOW	Clock Low Time	100 kHz mode	4.7	_	μS		
			400 kHz mode	1.3	_	μS		
			MSSP Module	1.5 TcY	_			
102	TR	SDA and SCL Rise Time	100 kHz mode	_	1000	ns		
			400 kHz mode	20 + 0.1 CB	300	ns	CB is specified to be from 10 to 400 pF	
103	TF	SDA and SCL Fall Time	100 kHz mode	_	300	ns		
			400 kHz mode	20 + 0.1 CB	300	ns	CB is specified to be from 10 to 400 pF	
90	Tsu:sta	Start Condition Setup Time	100 kHz mode	4.7	_	μS	Only relevant for Repeated	
			400 kHz mode	0.6	_	μS	Start condition	
91	THD:STA	Start Condition Hold Time	100 kHz mode	4.0	_	μS	After this period, the first clock	
			400 kHz mode	0.6	_	μS	pulse is generated	
106	THD:DAT	Data Input Hold Time	100 kHz mode	0	_	ns		
			400 kHz mode	0	0.9	μS		
107	TSU:DAT	Data Input Setup Time	100 kHz mode	250		ns	(Note 2)	
			400 kHz mode	100		ns		
92	Tsu:sto	Stop Condition Setup Time	100 kHz mode	4.7		μS		
			400 kHz mode	0.6		μS		
109	TAA	Output Valid from Clock	100 kHz mode		3500	ns	(Note 1)	
			400 kHz mode		_	ns		
110	TBUF	Bus Free Time	100 kHz mode	4.7	_	μS	Time the bus must be free before	
			400 kHz mode	1.3	_	μS	a new transmission can start	
D102	Св	Bus Capacitive Loading		_	400	pF		

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of Start or Stop conditions.

2: A Fast mode I²C™ bus device can be used in a Standard mode I²C bus system, but the requirement, Tsu:DAT ≥ 250 ns, must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line, TR max. + Tsu:DAT = 1000 + 250 = 1250 ns (according to the Standard mode I²C bus specification), before the SCL line is released.

FIGURE 27-15: MSSP I²C™ BUS START/STOP BITS TIMING WAVEFORMS

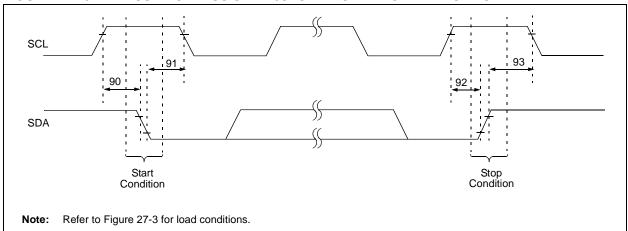


TABLE 27-20: MSSP I²C™ BUS START/STOP BITS REQUIREMENTS

Param. No.	Symbol	Characte	ristic	Min	Max	Units	Conditions
90	Tsu:sta	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ns	Only relevant for
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_		Repeated Start
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_		condition
91	THD:STA	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ns	After this period, the
		Hold Time	400 kHz mode	2(Tosc)(BRG + 1)	_		first clock pulse is
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_		generated
92	Tsu:sto	Stop Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ns	
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_		
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_		
93	THD:STO	Stop Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ns	
		Hold Time	400 kHz mode	2(Tosc)(BRG + 1)	_		
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)			

Note 1: Maximum pin capacitance = 10 pF for all I^2C^{TM} pins.

FIGURE 27-16: MSSP I²C™ BUS DATA TIMING

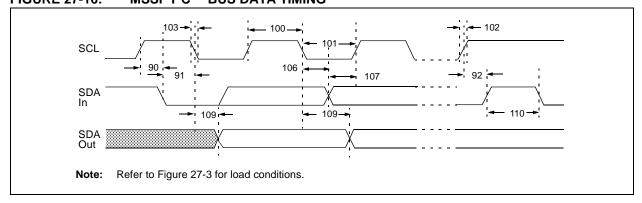


TABLE 27-21: MSSP I²C™ BUS DATA REQUIREMENTS

Param. No.	Symbol	Charac	teristic	Min	Max	Units	Conditions
100	THIGH	Clock High	100 kHz mode	2(Tosc)(BRG + 1)	_	ms	
		Time	400 kHz mode	2(Tosc)(BRG + 1)	_	ms	
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_	ms	
101	TLOW	Clock Low Time	100 kHz mode	2(Tosc)(BRG + 1)	_	ms	
			400 kHz mode	2(Tosc)(BRG + 1)	_	ms	
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_	ms	
102	TR	SDA and SCL	100 kHz mode	_	1000	ns	CB is specified to be from
		Rise Time	400 kHz mode	20 + 0.1 CB	300	ns	10 to 400 pF
			1 MHz mode ⁽¹⁾	_	300	ns	
103	TF	SDA and SCL	100 kHz mode	_	300	ns	CB is specified to be from
		Fall Time	400 kHz mode	20 + 0.1 CB	300	ns	10 to 400 pF
			1 MHz mode ⁽¹⁾	_	100	ns	
90	Tsu:sta	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ms	Only relevant for Repeated
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_	ms	Start condition
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_	ms	
91	THD:STA	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ms	After this period, the first
		Hold Time	400 kHz mode	2(Tosc)(BRG + 1)	_	ms	clock pulse is generated
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_	ms	
106	THD:DAT	Data Input	100 kHz mode	0	_	ns	
		Hold Time	400 kHz mode	0	0.9	ms	
			1 MHz mode ⁽¹⁾	TBD	_	ns	
107	Tsu:dat	Data Input	100 kHz mode	250	_	ns	(Note 2)
		Setup Time	400 kHz mode	100	_	ns	
			1 MHz mode ⁽¹⁾	TBD	_	ns	
92	Tsu:sto	Stop Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ms	
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_	ms	
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_	ms	
109	TAA	Output Valid	100 kHz mode	_	3500	ns	
		from Clock	400 kHz mode	_	1000	ns	
			1 MHz mode ⁽¹⁾	_	_	ns	
110	TBUF	Bus Free Time	100 kHz mode	4.7	_	ms	Time the bus must be free
			400 kHz mode	1.3	_	ms	before a new transmission
			1 MHz mode ⁽¹⁾	TBD	_	ms	can start
D102	Св	Bus Capacitive L	oading	_	400	pF	

Legend: TBD = To Be Determined

Note 1: Maximum pin capacitance = 10 pF for all I^2C^{TM} pins.

2: A Fast mode I²C bus device can be used in a Standard mode I²C bus system, but parameter #107 ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line, parameter #102 + parameter #107 = 1000 + 250 = 1250 ns (for 100 kHz mode), before the SCL line is released.

FIGURE 27-17: EUSART/AUSART SYNCHRONOUS TRANSMISSION (MASTER/SLAVE) TIMING

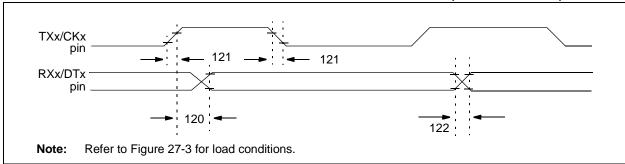


TABLE 27-22: EUSART/AUSART SYNCHRONOUS TRANSMISSION REQUIREMENTS

Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
120		SYNC XMIT (MASTER and SLAVE) Clock High to Data Out Valid	_	40	ns	
121	TCKRF	Clock Out Rise Time and Fall Time (Master mode)	_	20	ns	
122	TDTRF	Data Out Rise Time and Fall Time	_	20	ns	

FIGURE 27-18: EUSART/AUSART SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING

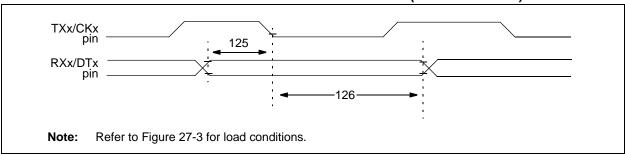


TABLE 27-23: EUSART/AUSART SYNCHRONOUS RECEIVE REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions
125	TDTV2CKL	SYNC RCV (MASTER and SLAVE) Data Hold before CKx ↓ (DTx hold time)	10	_	ns	
126	TCKL2DTL	Data Hold after CKx ↓ (DTx hold time)	15	_	ns	

TABLE 27-24: A/D CONVERTER CHARACTERISTICS: PIC18F87J90 FAMILY (INDUSTRIAL)

Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions
A01	NR	Resolution	_	_	10	bits	
A03	EIL	Integral Linearity Error	_	_	<±1	LSb	$\Delta VREF \ge 3.0V$
A04	EDL	Differential Linearity Error	_	_	<±1	LSb	$\Delta VREF \ge 3.0V$
A06	EOFF	Offset Error	_	_	<±3	LSb	$\Delta VREF \ge 3.0V$
A07	Egn	Gain Error	_	_	<±3	LSb	$\Delta VREF \ge 3.0V$
A10	_	Monotonicity	Gı	uarantee	d ⁽¹⁾	_	VSS ≤ VAIN ≤ VREF
A20	ΔV REF	Reference Voltage Range (VREFH – VREFL)	2.0 2.0		_	V	VDD < 3.0V VDD > 3.0V
A21	VREFH	Reference Voltage High	Vss	_	VREFH	V	
A22	VREFL	Reference Voltage Low	Vss - 0.3V	_	VDD - 3.0V	V	
A25	VAIN	Analog Input Voltage	VREFL	_	VREFH	V	
A30	ZAIN	Recommended Impedance of Analog Voltage Source	_	_	2.5	kΩ	
A50	IREF	VREF Input Current ⁽²⁾		_ _	5 150	μA μA	During VAIN acquisition. During A/D conversion cycle.

Note 1: The A/D conversion result never decreases with an increase in the input voltage and has no missing codes.

© 2009 Microchip Technology Inc. Preliminary DS39933C-page 419

^{2:} VREFH current is from RA3/AN3/VREF+ pin or VDD, whichever is selected as the VREFH source. VREFL current is from RA2/AN2/VREF- pin or VSS, whichever is selected as the VREFL source.

FIGURE 27-19: A/D CONVERSION TIMING

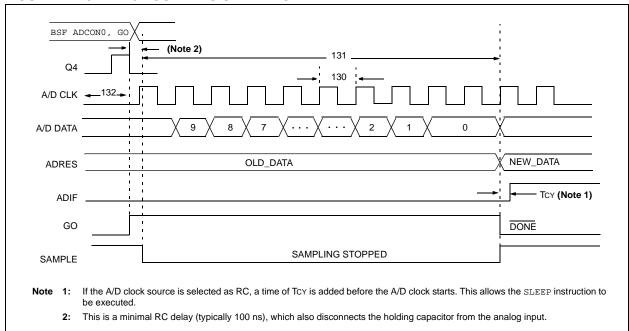


TABLE 27-25: A/D CONVERSION REQUIREMENTS

Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
130	TAD	A/D Clock Period	0.7	25.0 ⁽¹⁾	μS	Tosc based, VREF ≥ 3.0V
			TBD	1	μS	A/D RC mode
131		Conversion Time (not including acquisition time) ⁽²⁾	11	12	TAD	
132	TACQ	Acquisition Time ⁽³⁾	1.4	_	μS	-40°C to +85°C
135	Tswc	Switching Time from Convert → Sample	_	(Note 4)		
TBD	TDIS	Discharge Time	0.2	_	μS	

Legend: TBD = To Be Determined

Note 1: The time of the A/D clock period is dependent on the device frequency and the TAD clock divider.

2: ADRES registers may be read on the following TcY cycle.

3: The time for the holding capacitor to acquire the "New" input voltage when the voltage changes full scale after the conversion (VDD to VSS or VSS to VDD). The source impedance (RS) on the input channels is 50Ω.

4: On the following cycle of the device clock.

28.0 PACKAGING INFORMATION

28.1 Package Marking Information

64-Lead TQFP



Example

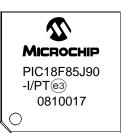


80-Lead TQFP



Note:

Example



Legend: XX...X Customer-specific information

Y Year code (last digit of calendar year)
YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')

NNN Alphanumeric traceability code

(e3) Pb-free JEDEC designator for Matte Tin (Sn)

This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.

In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available

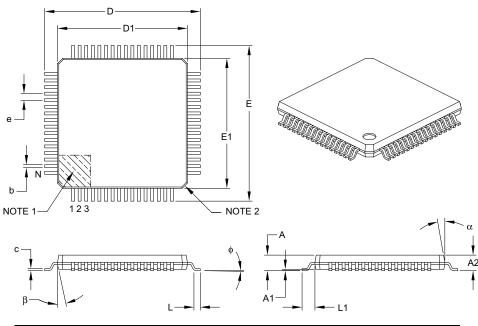
characters for customer-specific information.

28.2 Package Details

The following sections give the technical details of the packages.

64-Lead Plastic Thin Quad Flatpack (PT) – 10x10x1 mm Body, 2.00 mm [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units			MILLIMETERS		
Di	mension Limits	MIN	NOM	MAX		
Number of Leads	N		64			
Lead Pitch	е		0.50 BSC			
Overall Height	А	ı	_	1.20		
Molded Package Thickness	A2	0.95	1.00	1.05		
Standoff	A1	0.05	_	0.15		
Foot Length	L	0.45	0.60	0.75		
Footprint	L1		1.00 REF			
Foot Angle	ф	0°	3.5°	7°		
Overall Width	E		12.00 BSC			
Overall Length	D		12.00 BSC			
Molded Package Width	E1		10.00 BSC			
Molded Package Length	D1		10.00 BSC			
Lead Thickness	С	0.09	_	0.20		
Lead Width	b	0.17	0.22	0.27		
Mold Draft Angle Top	α	11°	12°	13°		
Mold Draft Angle Bottom	β	11°	12°	13°		

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Chamfers at corners are optional; size may vary.
- 3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.

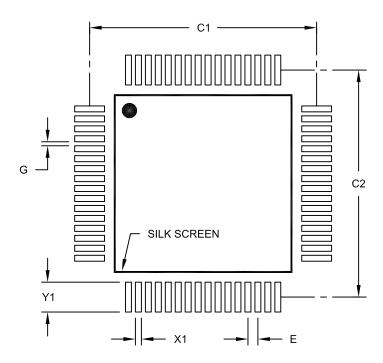
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-085B

64-Lead Plastic Thin Quad Flatpack (PT) – 10x10x1 mm Body, 2.00 mm [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	Units	MILLIM	ETERS	
Dimensior	Limits	MIN	NOM	MAX
Contact Pitch	E		0.50 BSC	
Contact Pad Spacing	C1		11.40	
Contact Pad Spacing	C2		11.40	
Contact Pad Width (X64)	X1			0.30
Contact Pad Length (X64)	Y1			1.50
Distance Between Pads	G	0.20		

Notes:

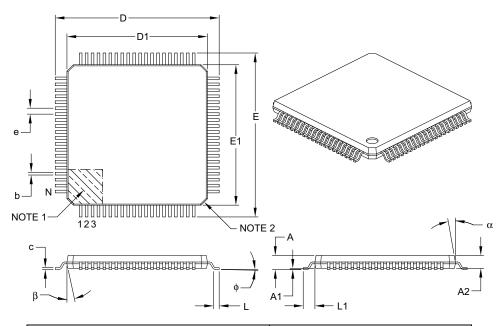
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2085A

80-Lead Plastic Thin Quad Flatpack (PT) – 12x12x1 mm Body, 2.00 mm [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		MILLIMETERS	3
Dime	ension Limits	MIN	NOM	MAX
Number of Leads	N		80	
Lead Pitch	е		0.50 BSC	
Overall Height	Α	_	-	1.20
Molded Package Thickness	A2	0.95	1.00	1.05
Standoff	A1	0.05	-	0.15
Foot Length	L	0.45	0.60	0.75
Footprint	L1		1.00 REF	
Foot Angle	ф	0°	3.5°	7°
Overall Width	E		14.00 BSC	
Overall Length	D		14.00 BSC	
Molded Package Width	E1		12.00 BSC	
Molded Package Length	D1		12.00 BSC	
Lead Thickness	С	0.09	-	0.20
Lead Width	b	0.17	0.22	0.27
Mold Draft Angle Top	α	11°	12°	13°
Mold Draft Angle Bottom	β	11°	12°	13°

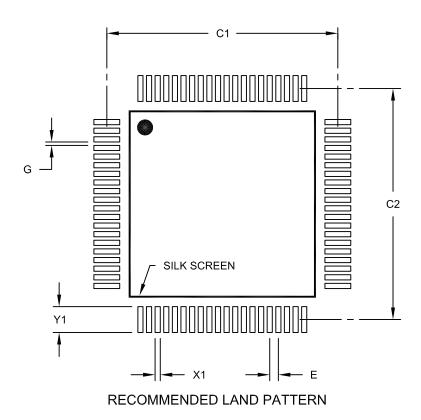
Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Chamfers at corners are optional; size may vary.
- 3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
 - REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-092B

80-Lead Plastic Thin Quad Flatpack (PT) - 12x12x1 mm Body, 2.00 mm [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIM	ETERS		
Dimension	Limits	MIN	NOM	MAX
Contact Pitch	E		0.50 BSC	
Contact Pad Spacing	C1		13.40	
Contact Pad Spacing	C2		13.40	
Contact Pad Width (X80)	X1			0.30
Contact Pad Length (X80)	Y1			1.50
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2092A

NOTES:

APPENDIX A: REVISION HISTORY

Revision A (October 2008)

Original data sheet for PIC18F87J90 family devices.

Revision B (December 2008)

Changes to Section 27.2 "DC Characteristics: Power-Down and Supply Current PIC18F87J90 Family (Industrial)" and removal of Section 27.5 "DC Characteristics: RTCC Power-Down Current (IPD)".

Revision C (February 2009)

Added register CONFIG3L to Section 24.0 "Special Features of the CPU" and made minor corrections.

APPENDIX B: MIGRATION FROM PIC18F85J90 TO PIC18F87J90

Devices in the PIC18F87J90 and PIC18F85J90 families are almost similar in their functions and features. Code can be migrated from the 18F85J90 to the PIC18F87J90 without many changes. The differences between the two device families are listed in Table B-1.

TABLE B-1: NOTABLE DIFFERENCES BETWEEN PIC18F87J90 AND PIC18F85J90 FAMILIES

Characteristic	PIC18F87J90 Family	18F85J90 Family
Max Operating frequency	48 MHz	40 MHz
Max Program Memory	128 Kbytes	32 Kbytes
Data Memory	3,923 Bytes	2,048 Bytes
Program Memory Endurance	10,000 Write/Erase (minimum)	1,000 Write/Erase (minimum)
Single Word write for Flash	Yes	No
Oscillator options	PLL can be used with INTOSC	PLL cannot be used with INTOSC
СТМU	Yes	No
RTCC	Yes	No
Timer1 Oscillator Options	Low-power oscillator option for Timer1	No
TICKI Clock	T1CKI can be used as a clock without enabling the Timer1 oscillator	No

NOTES:

INDEX

A	Operation in Power-Managed Modes27
A/D	Sampling27
A/D Converter Interrupt, Configuring287	Synchronous Master Mode278
Acquisition Requirements	Associated Registers, Receive28
ADCAL Bit291	Associated Registers, Transmit
ADCON0 Register283	Reception28
ADCON1 Register283	Transmission 278
ADCON2 Register283	Synchronous Slave Mode28
ADRESH Register	Associated Registers, Receive282
ADRESL Register	Associated Registers, Transmit
Analog Port Pins, Configuring289	Reception
Associated Registers	Transmission
Automatic Selecting and Configuring	В
Acquisition Time289	_
Configuring the Module	Baud Rate Generator23
Conversion Clock (TAD)	BC
Conversion Requirements	BCF
Conversion Status (GO/DONE Bit)	BF23
Conversions	BF Status Flag23
Converter Calibration	Bias Generation (LCD)
Converter Characteristics	Charge Pump Design Considerations 18
Operation in Power-Managed Modes	Block Diagrams
•	A/D280
Special Event Trigger (CCP)	Analog Input Model28
	AUSART Receive270
Absolute Maximum Ratings	AUSART Transmit274
AC (Timing) Characteristics	Baud Rate Generator23
Load Conditions for Device Timing Specifications 403	Capture Mode Operation 170
Parameter Symbology	Comparator Analog Input Model
Temperature and Voltage Specifications	Comparator I/O Operating Modes
Timing Conditions	Comparator Output29
ACKSTAT	Comparator Voltage Reference
ACKSTAT Status Flag	Comparator Voltage Reference Output Buffer
ADCAL Bit	Example
ADCON0 Register	Compare Mode Operation 17
GO/DONE Bit	Connections for On-Chip Voltage Regulator 32
ADCON1 Register	CTMU 30:
ADCON2 Register	CTMU Current Source Calibration Circuit 300
ADDFSR	CTMU Typical Connections and Internal
ADDLW	Configuration for Pulse Delay Generation 314
Addressable Universal Synchronous Asynchronous	CTMU Typical Connections and Internal
Receiver Transmitter (AUSART). See AUSART.	Configuration for Time Measurement 313
ADDULNK	Device Clock29
ADDWF	EUSART Receive
ADDWFC	EUSART Transmit
ADRESH Register	External Power-on Reset Circuit (Slow VDD
ADRESL Register	Power-up)4
Analog-to-Digital Converter. See A/D.	Fail-Safe Clock Monitor
ANDLW	Generic I/O Port Operation11
ANDWF341	Interrupt Logic9
Assembler	LCD Clock Generation
MPASM Assembler	LCD Driver Module17
AUSART	LCD Regulator Connections (M0 and M1) 18-
Asynchronous Mode274	MSSP (I ² C Master Mode)23
Associated Registers, Receive277	MSSP (I ² C Mode)21
Associated Registers, Transmit275	MSSP (SPI Mode)
Receiver	On-Chip Reset Circuit
Setting up 9-Bit Mode with Address Detect 276	PIC18F6XJ90
Transmitter274	PIC18F8XJ90
Baud Rate Generator (BRG)272	PLL
Associated Registers272	PWM Operation (Simplified)
Baud Rate Error, Calculating272	Reads From Flash Program Memory8
Baud Rates, Asynchronous Modes273	Resistor Ladder Connections for
High Baud Rate Select (BRGH Bit)272	Configuration M218
	Corniguration iviz

Resistor Ladder Connections for		Measuring Time	313
Configuration M3	186	Module Initialization	
RTCC		Operation	
Single Comparator		During Sleep and Idle Modes	
SPI Master/Slave Connection		Clock Sources	
Table Read Operation		Default System Clock on Reset	
Table Write Operation		Selection Using OSCCON Register	
·		<u> </u>	
Table Writes to Flash Program Memory		CLRF	
Timer0 in 16-Bit Mode		CLRWDT	349
Timer0 in 8-Bit Mode		Code Examples	
Timer1 (16-Bit Read/Write Mode)		16 x 16 Signed Multiply Routine	
Timer1 (8-Bit Mode)	138	16 x 16 Unsigned Multiply Routine	94
Timer2	144	8 x 8 Signed Multiply Routine	
Timer3 (16-Bit Read/Write Mode)	146	8 x 8 Unsigned Multiply Routine	93
Timer3 (8-Bit Mode)	146	Capacitance Calibration Routine	310
Watchdog Timer		Changing Between Capture Prescalers	
BN	342	Computed GOTO Using an Offset Value	
BNC		Current Calibration Routine	
BNN		Erasing a Flash Program Memory Row	
BNOV		Fast Register Stack	
BNZ	-	How to Clear RAM (Bank 1) Using	
BOR. See Brown-out Reset.	344	Indirect Addressing	76
	0.47		/ (
BOV		Implementing a Real-Time Clock Using	
BRA		a Timer1 Interrupt Service	
Break Character (12-Bit) Transmit and Receive	263	Initializing PORTA	
BRG. See Baud Rate Generator.		Initializing PORTB	
BRGH Bit		Initializing PORTC	
TXSTA1 Register	253	Initializing PORTD	120
TXSTA2 Register	272	Initializing PORTE	122
Brown-out Reset (BOR)	49	Initializing PORTF	124
and On-Chip Voltage Regulator		Initializing PORTG	
Detecting		Initializing PORTH	
BSF		Initializing PORTJ	
BTFSC		Loading the SSPBUF (SSPSR) Register	
BTFSS		Reading a Flash Program Memory Word	
BTG		Routine for Capacitive Touch Switch	
BZ	-	Saving STATUS, WREG and BSR	312
DZ	340		110
C		Registers in RAM	
		Setting the RTCWREN Bit	
C Compilers	004	Setup for CTMU Calibration Routines	
MPLAB C18		Single-Word Write to Flash Program Memory	
MPLAB C30		Writing to Flash Program Memory	
CALL		Code Protection	
CALLW		COMF	
Capture (CCP Module)		Comparator	293
Associated Registers	172	Analog Input Connection Considerations	
CCP Pin Configuration	170	Associated Registers	297
CCPR2H:CCPR2L Registers	170	Configuration	
Software Interrupt		Effects of a Reset	
Timer1/Timer3 Mode Selection	170	Interrupts	
Capture/Compare/PWM (CCP)		Operation	
Capture Mode. See Capture.		Operation During Sleep	
CCP Mode and Timer Resources	168	Outputs	
CCPRxH Register			
		Reference	
CCPRxL Register	100	External Signal	
Compare Mode. See Compare.	400	Internal Signal	
Configuration	168	Response Time	
Interaction of CCP1 and CCP2 for		Comparator Specifications	
Timer Resources		Comparator Voltage Reference	
Interconnect Configurations		Accuracy and Error	300
Charge Time Measurement Unit (CTMU)		Associated Registers	
Associated Registers	317	Configuring	299
Calibrating the Module	305	Connection Considerations	
Creating a Delay	314	Effects of a Reset	
Effects of a Reset		Operation During Sleep	
Measuring Capacitance with the CTMU		-1	

Compare (CCP Module)	171	Enhanced Universal Synchronous Asynchronous	
Associated Registers		Receiver Transmitter (EUSART). See EUSART.	
CCP Pin Configuration		ENVREG Pin	328
CCPR2 Register		Equations	
Software Interrupt		A/D Acquisition Time	288
Special Event Trigger14		A/D Minimum Charging Time	
Timer1/Timer3 Mode Selection		Calculating the Minimum Required	
Computed GOTO	63	Acquisition Time	288
Configuration Bits		LCD Static and Dynamic Current	
Configuration Mismatch (CM)		Errata	
Configuration Register Protection		EUSART	
Core Features		Asynchronous Mode	258
Easy Migration	7	12-Bit Break Transmit and Receive	
Extended Instruction Set		Associated Registers, Receive	
Memory Options		Associated Registers, Transmit	
nanoWatt Technology		Auto-Wake-up on Sync Break Character	
Oscillator Options and Features		Receiver	
CPFSEQ		Setting up 9-Bit Mode with Address Detect	
CPFSGT		Transmitter	
CPFSLT		Baud Rate Generator (BRG)	
Crystal Oscillator/Ceramic Resonator		Associated Registers	
Customer Change Notification Service		Auto-Baud Rate Detect	
•			
Customer Notification Service		Baud Rate Error, Calculating	
Customer Support	439	Baud Rates, Asynchronous Modes	
D		High Baud Rate Select (BRGH Bit)	
Data Addressing Modes	76	Operation in Power-Managed Modes	
Comparing Addressing Modes with the	70	Sampling	
Extended Instruction Set Enabled	90	Synchronous Master Mode	
		Associated Registers, Receive	
Direct		Associated Registers, Transmit	
Indexed Literal Offset	-	Reception	
BSR		Transmission	
Instructions Affected		Synchronous Slave Mode	
Mapping Access Bank		Associated Registers, Receive	
Indirect		Associated Registers, Transmit	
Inherent and Literal		Reception	
Data Memory		Transmission	267
Access Bank		Extended Instruction Set	
Bank Select Register (BSR)		ADDFSR	
Extended Instruction Set		ADDULNK	
General Purpose Registers	68	CALLW	
Memory Maps		MOVSF	-
PIC18FX6J90/X7J90 Devices		MOVSS	
Special Function Registers	69	PUSHL	378
Special Function Registers		SUBFSR	379
DAW		SUBULNK	379
DC Characteristics		External Oscillator Modes	
Power-Down and Supply Current		Clock Input (EC Modes)	34
Supply Voltage	389	HS	33
DCFSNZ	353	F	
DECF	352	F	
DECFSZ	353	Fail-Safe Clock Monitor 31	9, 330
Default System Clock	32	Exiting Fail-Safe Operation	331
Details on Individual Family Members	8	Interrupts in Power-Managed Modes	331
Development Support	383	POR or Wake-up From Sleep	331
Device Overview	7	WDT During Oscillator Failure	330
Features (64-Pin Devices)	9	Fast Register Stack	
Features (80-Pin Devices)	9	Firmware Instructions	
Direct Addressing	77	Flash Configuration Words	319
_		Flash Program Memory	
E		Associated Registers	
Effect on Standard PIC18 Instructions	380	Control Registers	
Effects of Power-Managed Modes on Various		EECON1 and EECON2	
Clock Sources	37	TABLAT (Table Latch) Register	
Electrical Characteristics	387	TBLPTR (Table Pointer) Register	
		Erase Sequence	

Erasing	88	Sleep Operation	243
Operation During Code-Protect		Stop Condition Timing	
Reading		INCF	
Table Pointer		INCFSZ	
Boundaries Based on Operation	86	In-Circuit Debugger	
Table Pointer Boundaries		In-Circuit Serial Programming (ICSP)	
Table Reads and Table Writes		Indexed Literal Offset Addressing	0 .0, 002
Write Sequence		and Standard PIC18 Instructions	380
Write Sequence (Word Programming)		Indexed Literal Offset Mode	
Writing		Indirect Addressing	
Unexpected Termination		INFSNZ	
Write Verify		Initialization Conditions for all Registers	
FSCM. See Fail-Safe Clock Monitor.	92	Instruction Cycle	
F3CW. See Fall-Sale Clock Worldon.		Clocking Scheme	
G		Flow/Pipelining	
GOTO	354	Instruction Set	
GO10			
Н		ADDLW	
Hardware Multiplier	03	ADDWF	
8 x 8 Multiplication Algorithms		ADDWF (Indexed Literal Offset Mode)	
Operation		ADDWFC	
Performance Comparison (table)		ANDLW	
renormance Companson (table)	93	ANDWF	
Ī		BC	_
I/O Ports	111	BCF	_
		BN	
Input Voltage Considerations		BNC	
Open-Drain Outputs		BNN	
Output Pin Drive		BNOV	
Pin Capabilities		BNZ	344
Pull-up Configuration		BOV	347
I ² C Mode (MSSP)		BRA	345
Acknowledge Sequence Timing		BSF	345
Associated Registers		BSF (Indexed Literal Offset Mode)	381
Baud Rate Generator	235	BTFSC	346
Bus Collision		BTFSS	346
During a Repeated Start Condition		BTG	347
During a Stop Condition		BZ	348
Clock Arbitration		CALL	348
Clock Stretching		CLRF	349
10-Bit Slave Receive Mode (SEN = 1)	228	CLRWDT	349
10-Bit Slave Transmit Mode	228	COMF	
7-Bit Slave Receive Mode (SEN = 1)	228	CPFSEQ	350
7-Bit Slave Transmit Mode	228	CPFSGT	351
Clock Synchronization and the CKP Bit	229	CPFSLT	
Effects of a Reset	243	DAW	
General Call Address Support	232	DCFSNZ	
I ² C Clock Rate w/BRG	235	DECF	
Master Mode	233	DECFSZ	
Baud Rate Generator	235	Extended Instructions	
Operation	234	Considerations when Enabling	
Reception		=	
Repeated Start Condition Timing		SyntaxUse with MPLAB IDE Tools	
Start Condition Timing			
Transmission		General Format	
Multi-Master Communication, Bus Collision	200	GOTO	
and Arbitration	243	INCF	
Multi-Master Mode		INCFSZ	
Operation		INFSNZ	
· — — —		IORLW	
Read/Write Bit Information (R/W Bit)		IORWF	
Registers		LFSR	
Serial Clock (SCK/SCL)		MOVF	
Slave Mode		MOVFF	358
Address Masking		MOVLB	358
Addressing		MOVLW	359
Reception		MOVWF	359
Transmission	221		

MULLW	360	L	
MULWF	360	LCD	
NEGF	361	Associated Registers	203
NOP		Bias Generation	
Opcode Field Descriptions	334	Bias Configurations	
POP	362	M0 and M1	
PUSH	362	M2	
RCALL	363	M3	
RESET	363	Bias Types	
RETFIE	364	Voltage Regulator	
RETLW	364	Charge Pump184	
RETURN	365	Clock Source Selection	
RLCF	365	Configuring the Module	
RLNCF	366		
RRCF	366	Frame Frequency	
RRNCF	367	Interrupts	
SETF	367	LCDCON Register	
SETF (Indexed Literal Offset Mode)		LCDDATA Register	
SLEEP		LCDPS Register	
Standard Instructions		LCDREG Register	
SUBFWB		LCDSE Register	
SUBLW		Multiplex Types	
SUBWF		Operation During Sleep	
SUBWFB		Pixel Control	
SWAPF		Segment Enables	
TBLRD		Waveform Generation	
TBLWT		LCD Driver	
TSTFSZ		LCDCON Register	. 178
		LCDDATA Register	. 178
XORLW		LCDPS Register	. 178
XORWF	374	LCDREG Register	. 178
NTCON Register	444	LCDSE Register	. 178
RBIF Bit	114	LFSR	. 357
nter-Integrated Circuit. See I ² C Mode.	404	Liquid Crystal Display (LCD) Driver	. 177
nternal LCD Voltage Regulator Specifications		Low-Voltage Detection	
nternal Oscillator Block		••	
Adjustment		M	
INTIO Modes		Master Clear (MCLR)	49
INTOSC Frequency Drift		Master Synchronous Serial Port (MSSP). See MSSP.	
INTOSC Output Frequency		Memory Organization	59
INTPLL Modes	35	Data Memory	
nternal RC Oscillator		Program Memory	59
Use with WDT		Memory Programming Requirements	
nternal Voltage Regulator Specifications	401	Microchip Internet Web Site	
nternet Address	439	Migration From PIC18F85J90 to PIC18F87J90	
nterrupt Sources	319	MOVF	
A/D Conversion Complete	287	MOVFF	
Capture Complete (CCP)	170	MOVLB	
Compare Complete (CCP)	171	MOVLW	
Interrupt-on-Change (RB7:RB4)		MOVSF	
TMR0 Overflow		MOVSS	
TMR1 Overflow			
TMR2 to PR2 Match (PWM)		MOVWF	
TMR3 Overflow		MPLAB ASM30 Assembler, Linker, Librarian	
nterrupts		MPLAB ICD 2 In-Circuit Debugger	. 385
During, Context Saving		MPLAB ICE 2000 High-Performance Universal	
INTx Pin		In-Circuit Emulator	. 385
		MPLAB Integrated Development	
PORTB, Interrupt-on-Change		Environment Software	
TMR0	110	MPLAB PM3 Device Programmer	. 385
nterrupts, Flag Bits		MPLAB REAL ICE In-Circuit Emulator System	. 385
laterative to Observe (DDZ DDA) Fig. (DDE DV)		Wil END RENE ICE III Girout Emalator Gystem	
Interrupt-on-Change (RB7:RB4) Flag (RBIF Bit)) 114	MPLINK Object Linker/MPLIB Object Librarian	
NTOSC, INTRC. See Internal Oscillator Block.			
NTOSC, INTRC. See Internal Oscillator Block. ORLW	356	MPLINK Object Linker/MPLIB Object Librarian	. 384
NTOSC, INTRC. See Internal Oscillator Block.	356	MPLINK Object Linker/MPLIB Object LibrarianMSSP	. 384 , 221
NTOSC, INTRC. See Internal Oscillator Block. ORLW	356	MPLINK Object Linker/MPLIB Object Librarian MSSP ACK Pulse219	. 384 , 221 . 205

SSPSR Register	210	RD0/SEG1	15
MULLW	360	RD1/SEG1	22
MULWF		RD2/SEG2	
		RD3/SEG3	
N		RD4/SEG4	,
NEGF	361	RD5/SEG5	
NOP		RD6/SEG6	
Notable Differences Between PIC18F87J90			- /
	407	RD7/SEG7	
and PIC18F85J90 Families	427	RE0/LCDBIAS1	
0		RE1/LCDBIAS2	,
	22	RE3/COM0	16, 23
Oscillator Configuration		RE4/COM1	16, 23
EC		RE5/COM2	16, 23
ECPLL		RE6/COM3	16, 23
HS	29	RE7/CCP2/SEG31	16, 23
HSPLL		RF1/AN6/C2OUT/SEG19	17, 24
Internal Oscillator Block	35	RF2/AN7/C1OUT/SEG20	
INTIO1	29	RF3/AN8/SEG21/C2INB	
INTIO2	29	RF4/AN9/SEG22/C2INA	
INTPLL1	29	RF5/AN10/CVREF/SEG23/C1INB	
INTPLL2	29	RF6/AN11/SEG24/C1INA	,
Oscillator Selection		RF7/AN5/SS/SEG25	
Oscillator Start-up Timer (OST)		RG0/LCDBIAS0	,
Oscillator Switching			,
Oscillator Transitions		RG1/TX2/CK2	-, -
Oscillator, Timer1		RG2/RX2/DT2/VLCAP1	,
•	•	RG3/VLCAP2	
Oscillator, Timer3	145	RG4/SEG26/RTCC	
P		RH0/SEG47	26
	404	RH1/SEG46	26
Packaging		RH2/SEG45	26
Details		RH3/SEG44	26
Marking		RH4/SEG40	26
PICSTART Plus Development Programmer	386	RH5/SEG41	26
Pin Functions		RH6/SEG42	26
AVDD	18	RH7/SEG43	
AVDD	27	RJ0	
AVss	18	RJ1/SEG33	
AVss	27	RJ2/SEG34	
ENVREG	18, 27	RJ3/SEG35	
LCDBIAS3	16. 23	RJ4/SEG39	
MCLR	•		
OSC1/CLKI/RA7	,	RJ5/SEG38	
OSC2/CLKO/RA6	,	RJ6/SEG37	
RA0/AN0	•	RJ7/SEG36	
RA1/AN1/SEG18	· ·	VDD	
RA2/AN2/VREF		VDD	
		VDDCORE/VCAP	18, 27
RA3/AN3/VREF+		Vss	18
RA4/T0CKI/SEG14	·	Vss	27
RA5/AN4/SEG15	•	Pinout I/O Descriptions	
RB0/INT0/SEG30	•	PIC18F6XJ90	12
RB1/INT1/SEG8	13, 20	PIC18F8XJ90	
RB2/INT2/SEG9/CTED1	13, 20	PLL	
RB3/INT3/SEG10/CTED2	13, 20	HSPLL and ECPLL Oscillator Modes	
RB4/KBI0/SEG11	13, 20	Use with INTOSC	
RB5/KBI1/SEG29	13, 20	POP	
RB6/KBI2/PGC	•		302
RB7/KBI3/PGD	,	POR. See Power-on Reset.	
RC0/T10S0/T13CKI	· ·	PORTA	
RC1/T10SI/CCP2/SEG32		Associated Registers	
RC2/CCP1/SEG13	•	LATA Register	
		PORTA Register	
RC3/SCK/SCL/SEG17		TRISA Register	112
RC4/SDI/SDA/SEG16		PORTB	
RC5/SDO/SEG12		Associated Registers	116
RC6/TX1/CK1/SEG27		LATB Register	114
RC7/RX1/DT1/SEG28		PORTB Register	
RD0/SEG0/CTPLS	15, 22	÷	

TRISB Register 114 Prescaler, Timer0 Prescaler, Timer0 Prescaler, Timer2 Prescaler, Timer0 Prescaler, Timer2 Prescaler, Timer2 </th <th></th>	
Associated Registers 119 PRI_IDLE Mode LATC Register 117 PRI_RUN Mode PORTC Register 117 Program Counter RC3/SCK/SCL/SEG17 Pin 221 PCL, PCH and PCU Register TRISC Register 117 PCLATH and PCLATU Register	
LATC Register 117 PRI_RUN Mode PORTC Register 117 Program Counter RC3/SCK/SCL/SEG17 Pin 221 PCL, PCH and PCU Register TRISC Register 117 PCLATH and PCLATU Register	40
PORTC Register	
RC3/SCK/SCL/SEG17 Pin221 PCL, PCH and PCU Register117 PCLATH and PCLATU Re	
TRISC Register117 PCLATH and PCLATU Re	
PORTD Program Memory	gisters61
o	78
· · · · · · · · · · · · · · · · · · ·	60
	60
•	65
	65
·	60
	63
	nfiguration Words 60
Associated Registers	
LATF Register	
PORTF Register	· ·
TRISF Register	
Associated Registers	
LATG Register	
	175
· · · · · · · · · · · · · · · · · · ·	olutions 174
	173
	175
	173
TRISH Register 129	
PORTJ	
Associated Registers	174
LAT L Pegister	
PORTJ Register	
TRISJ Register	
Power-Managed Modes	
and SPI Operation213 RC_RUN Mode	
Clock Sources	363
Clock Transitions and Status Indicators40 RCON Register	
	ion 52
Exiting Idle and Sleep Modes	
By Interrupt	
	159
-, · · - · · · · · · · · · · · · · · · ·	
Trial dat direction of the policy minimum to	
D 14 ET 0	
ADOONS (A/D O	283
<u></u>	284
AL DMOCO (Alexan Oct.)	ration)153
ALDMDAY (Alexes Dev.)/a	ue)157
	ılue) 158
	Value) 158
Colouring	value)157
	ion) 154
	s Value) 158
Cultillary (table)	y Value)157
ALDANA/D /AL	Control)252
Power-on Reset (POR)	
Power-on Reset (POR) 49 ALRMWD (Alarm Weekda Power-up Delays 37 BAUDCON1 (Baud Rate C) 167
Power-on Reset (POR) 49 ALRMWD (Alarm Weekda Power-up Delays 37 BAUDCON1 (Baud Rate Of CCPx Control Power-up Timer (PWRT) 37, 50 CCPxCON (CCPx Control)

CONFIG1L (Configuration 1 Low)	321	MCLR Reset, Normal Operation	47
CONFIG2H (Configuration 2 High)		Power-on Reset (POR)	
CONFIG2L (Configuration 2 Low)		RESET Instruction	
CONFIG3H (Configuration 3 High)		Stack Full Reset	
CTMUCONH (CTMU Control High)		Stack Underflow Reset	
CTMUCONL (CTMU Control Low)		Watchdog Timer (WDT) Reset	
CTMUICON (CTMU Current Control)		Resets	
CVRCON (Comparator Voltage		Brown-out Reset (BOR)	
Reference Control)	200	Oscillator Start-up Timer (OST)	
DAY (Day Value)		Power-on Reset (POR)	
DEVID1 (Device ID Register 1)		Power-up Timer (PWRT)	
DEVID1 (Device ID Register 1) DEVID2 (Device ID Register 2)		RETFIE	
EECON1 (EEPROM Control 1)		RETLW	
,		RETURN	
HOUR (Hour Value)		Return Address Stack	
INTCON (Interrupt Control)			
INTCON2 (Interrupt Control 2)		Return Stack Pointer (STKPTR)	
INTCON3 (Interrupt Control 3)		Revision History	
IPR1 (Peripheral Interrupt Priority 1)		RLCF	
IPR2 (Peripheral Interrupt Priority 2)		RLNCF	
IPR3 (Peripheral Interrupt Priority 3)		RRCF	
LCDCON (LCD Control)		RRNCF	367
LCDDATAx (LCD Data)		RTCC	
LCDPS (LCD Phase)		Alarm	
LCDREG (LCD Voltage Regulator Control)	183	Configuring	162
LCDSEx (LCD Segment Enable)	180	Interrupt	
MINUTE (Minute Value)	156	Mask Settings	163
MONTH (Month Value)	155	Alarm Value Registers (ALRMVAL)	
OSCCON (Oscillator Control)		Control Registers	
OSCTUNE (Oscillator Tuning)	31	Operation	
PADCFG1 (Pad Configuration)		Calibration	162
PIE1 (Peripheral Interrupt Enable 1)		Clock Source	
PIE2 (Peripheral Interrupt Enable 2)		Digit Carry Rules	
PIE3 (Peripheral Interrupt Enable 3)		General Functionality	
PIR1 (Peripheral Interrupt Request (Flag) 1)		Leap Year	
PIR2 (Peripheral Interrupt Request (Flag) 2)		Register Mapping	
PIR3 (Peripheral Interrupt Request (Flag) 3)		ALRMVAL	
RCON (Reset Control)		RTCVAL	10
RCSTA1 (EUSART Receive Status and Control)		Safety Window for Register Reads	404
RCSTA2 (AUSART Receive Status and Control)	•	and Writes	
Reserved		Write Lock	
RTCCAL (RTCC Calibration)		Register Interface	
RTCCFG (RTCC Configuration)		Register Maps	
SECOND (Second Value)		Reset	
SSPCON1 (MSSP Control 1, I ² C Mode)	216	Device	
SSPCON1 (MSSP Control 1, SPI Mode)	207	Power-on Reset (POR)	
SSPCON2 (MSSP Control 2, I ² C Master Mode)	217	Sleep Mode	164
SSPCON2 (MSSP Control 2, I ² C Slave Mode)	218	Value Registers (RTCVAL)	154
SSPSTAT (MSSP Status, I ² C Mode)	215	RTCEN Bit Write	159
SSPSTAT (MSSP Status, SPI Mode)	206		
STATUS		S	
STKPTR (Stack Pointer)	62	SCK	205
T0CON (Timer0 Control)		SDI	205
T1CON (Timer1 Control)		SDO	205
T2CON (Timer2 Control)		SEC_IDLE Mode	44
T3CON (Timer3 Control)		SEC_RUN Mode	
TXSTA1 (EUSART Transmit Status and Control		Serial Clock, SCK	
· ·	,	Serial Data In (SDI)	
TXSTA2 (AUSART Transmit Status and Control		Serial Data III (SDI)	
WDTCON (Watchdog Timer Control)		Serial Peripheral Interface. See SPI Mode.	200
WEEKDAY (Weekday Value)		•	26-
YEAR (Year Value)		SETFSlave Salact (SS)	
RESET		Slave Select (SS)	
Reset		SLEEP	
Brown-out Reset (BOR)		Software Simulator (MPLAB SIM)	384
Configuration Mismatch (CM)	47	Special Event Trigger. See Compare (CCP Module).	
MCLR Reset, During Power-Managed Modes	47	Special Features of the CPU	319
		SPI Mode (MSSP)	

© 2009 Microchip Technology Inc.

DS39933C-page 436

Associated Registers	213	TMR2 to PR2 Match Interrupt	
Bus Mode Compatibility		Timer3	. 145
Effects of a Reset	213	16-Bit Read/Write Mode	. 147
Enabling SPI I/O	209	Associated Registers	. 147
Master Mode	210	Operation	. 146
Operation	208	Oscillator145	, 147
Operation in Power-Managed Modes		Overflow Interrupt	
Serial Clock		Special Event Trigger (CCP)	
Serial Data In		TMR3H Register	
Serial Data Out		TMR3L Register	
Slave Mode		Timing Diagrams	
Slave Select		A/D Conversion	420
Slave Select Synchronization		Acknowledge Sequence	
•		·	
SPI Clock		Asynchronous Reception	
Typical Connection		Asynchronous Transmission	
<u>SS</u>		Asynchronous Transmission (Back to Back) 259	
SSPOV		Automatic Baud Rate Calculation	. 257
SSPOV Status Flag	239	Auto-Wake-up Bit (WUE) During	
SSPSTAT Register		Normal Operation	
R/W Bit		Auto-Wake-up Bit (WUE) During Sleep	
Stack Full/Underflow Resets		Baud Rate Generator with Clock Arbitration	
SUBFSR	379	BRG Overflow Sequence	. 257
SUBFWB	368	BRG Reset Due to SDA Arbitration During	
SUBLW	369	Start Condition	. 245
SUBULNK	379	Bus Collision During a Repeated Start	
SUBWF	369	Condition (Case 1)	. 246
SUBWFB	370	Bus Collision During a Repeated Start	
SWAPF	370	Condition (Case 2)	. 246
_		Bus Collision During a Start Condition (SCL = 0)	
Т		Bus Collision During a Stop Condition (Case 1)	. 247
Table Pointer Operations (table)	86	Bus Collision During a Stop Condition (Case 2)	
Table Reads/Table Writes		Bus Collision During Start Condition (SDA Only)	
TBLRD	371	Bus Collision for Transmit and Acknowledge	
TBLWT		Capture/Compare/PWM	
Timer0	133	CLKO and I/O	
Associated Registers	135	Clock Synchronization	
Clock Source Select (T0CS Bit)		Clock/Instruction Cycle	
Operation		EUSART/AUSART Synchronous	0
Overflow Interrupt		Receive (Master/Slave)	418
Prescaler		EUSART/AUSART Synchronous	. +10
Switching Assignment		Transmission (Master/Slave)	/119
Prescaler Assignment (PSA Bit)		Example SPI Master Mode (CKE = 0)	
Prescaler Select (T0PS2:T0PS0 Bits)		Example SPI Master Mode (CKE = 0)	
Prescaler. See Prescaler, Timer0.		Example SPI Slave Mode (CKE = 1)	
Reads and Writes in 16-Bit Mode	12/		
		Example SPI Slave Mode (CKE = 1)	
Source Edge Select (T0SE Bit)		External Clock	
		Fail-Safe Clock Monitor	
16-Bit Read/Write Mode		First Start Bit Timing	
Associated Registers		I ² C Bus Data	
Interrupt		I ² C Bus Start/Stop Bits	
Operation		I ² C Master Mode (7 or 10-Bit Transmission)	
Oscillator		I ² C Master Mode (7-Bit Reception)	. 241
Layout Considerations		I ² C Slave Mode (10-Bit Reception,	
Oscillator, as Secondary Clock		SEN = 0, ADMSK = 01001)	
Overflow Interrupt		I^2 C Slave Mode (10-Bit Reception, SEN = 0)	
Resetting, Using the CCP Special Event T	rigger 140	I ² C Slave Mode (10-Bit Reception, SEN = 1)	
TMR1H Register	137	I ² C Slave Mode (10-Bit Transmission)	. 227
TMR1L Register		I^2C Slave Mode (7-Bit Reception, SEN = 0,	
Use as a Clock Source		ADMSK = 01011)	. 223
Use as a Real-Time Clock		I ² C Slave Mode (7-Bit Reception, SEN = 0)	
Timer2	143	I ² C Slave Mode (7-Bit Reception, SEN = 1)	
Associated Registers		I ² C Slave Mode (7-Bit Transmission)	
Interrupt		I ² C Slave Mode General Call Address	
Operation		Sequence (7 or 10-Bit Addressing Mode)	. 232
Output		I ² C Stop Condition Receive or Transmit Mode	
PR2 Register			

LCD Interrupt in Quarter Duty Cycle Drive LCD Sleep Entry/Exit When SLPEN = 1 or CS1:CS0 = 00	
MSSP I ² C Bus Data	
MSSP I ² C Bus Start/Stop Bits	
PWM Output	
Repeated Start Condition	
Reset, Watchdog Timer (WDT), Oscillator Start-	
Timer (OST) and Power-up Timer (PWRT)	407
Send Break Character Sequence	263
Slave Synchronization	211
Slow Rise Time (MCLR Tied to VDD,	
VDD Rise > TPWRT)	51
SPI Mode (Master Mode)	
SPI Mode (Slave Mode, CKE = 0)	
SPI Mode (Slave Mode, CKE = 1)	
	∠ ۱∠
Synchronous Reception	200 000
(Master Mode, SREN)	
Synchronous Transmission	
Synchronous Transmission (Through TXEN) 2	265, 279
Time-out Sequence on Power-up (MCLR	
Not Tied to VDD), Case 1	50
Time-out Sequence on Power-up (MCLR	
Not Tied to VDD), Case 2	51
Time-out Sequence on Power-up (MCLR	
Tied to VDD, VDD Rise Tpwrt)	50
Timer Pulse Generation	164
Timer0 and Timer1 External Clock	408
Transition for Entry to Idle Mode	44
Transition for Entry to SEC_RUN Mode	
Transition for Entry to Sleep Mode	
Transition for Two-Speed Start-up	
(INTRC to HSPLL)	329
Transition for Wake From Idle to Run Mode	
Transition for Wake From Sleep (HSPLL)	
Transition From RC_RUN Mode to	
PRI_RUN Mode	12
Transition From SEC_RUN Mode to	42
PRI_RUN Mode (HSPLL)	11
Transition to RC_RUN Mode	
Type-A in 1/2 MUX, 1/2 Bias Drive	
Type-A in 1/2 MUX, 1/3 Bias Drive	
Type-A in 1/3 MUX, 1/2 Bias Drive	
Type-A in 1/3 MUX, 1/3 Bias Drive	
Type-A in 1/4 MUX, 1/3 Bias Drive	
Type-A/Type-B in Static Drive	
Type-B in 1/2 MUX, 1/2 Bias Drive	191
Type-B in 1/2 MUX, 1/3 Bias Drive	193
Type-B in 1/3 MUX, 1/2 Bias Drive	195
Type-B in 1/3 MUX, 1/3 Bias Drive	197
Type-B in 1/4 MUX, 1/3 Bias Drive	199
Timing Diagrams and Specifications	
Capture/Compare/PWM Requirements	409
CLKO and I/O Requirements	
EUSART/AUSART Synchronous Receive	
Requirements	418
EUSART/AUSART Synchronous Transmission	
Requirements	418
Example SPI Mode Requirements	
(Master Mode, CKE = 0)	410
Example SPI Mode Requirements	
(Master Mode, CKE = 1)	<i>A</i> 11
Example SPI Mode Requirements	

Example SPI Slave Mode	
Requirements (CKE = 1)	413
External Clock Requirements	404
I ² C Bus Data Requirements (Slave Mode)	415
I ² C Bus Start/Stop Bits Requirements	
(Slave Mode)	
Internal RC Accuracy (INTOSC and INTRC)	
MSSP I ² C Bus Data Requirements	417
MSSP I ² C Bus Start/Stop Bits Requirements	
PLL Clock	405
Reset, Watchdog Timer, Oscillator Start-up	
Timer, Power-up Timer and Brown-out	
Reset Requirements	407
Timer0 and Timer1 External Clock	
Requirements	
Top-of-Stack Access	
TSTFSZ	373
Two-Speed Start-up319,	329
Two-Word Instructions	
Example Cases	65
V	
VDDCORE/VCAP Pin	328
Voltage Reference Specifications	
Voltage Regulator (On-Chip)	
Brown-out Reset (BOR)	
Low-Voltage Detection (LVD)	
Operation in Sleep Mode	
Power-up Requirements	
w	
	
Watchdog Timer (WDT)319,	
Associated Registers	
Control Register	
During Oscillator Failure	
Programming Considerations	
NCOL	
NCOL Status Flag	
NWW Address	
WWW, On-Line Support	ხ
X	
XORLW	373
XORWF	

THE MICROCHIP WEB SITE

Microchip provides online support via our WWW site at www.microchip.com. This web site is used as a means to make files and information easily available to customers. Accessible by using your favorite Internet browser, the web site contains the following information:

- Product Support Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- General Technical Support Frequently Asked Questions (FAQ), technical support requests, online discussion groups, Microchip consultant program member listing
- Business of Microchip Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives

CUSTOMER CHANGE NOTIFICATION SERVICE

Microchip's customer notification service helps keep customers current on Microchip products. Subscribers will receive e-mail notification whenever there are changes, updates, revisions or errata related to a specified product family or development tool of interest.

To register, access the Microchip web site at www.microchip.com, click on Customer Change Notification and follow the registration instructions.

CUSTOMER SUPPORT

Users of Microchip products can receive assistance through several channels:

- · Distributor or Representative
- · Local Sales Office
- · Field Application Engineer (FAE)
- Technical Support

Customers should contact their distributor, representative or field application engineer (FAE) for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in the back of this document.

Technical support is available through the web site at: http://support.microchip.com

READER RESPONSE

It is our intention to provide you with the best documentation possible to ensure successful use of your Microchip product. If you wish to provide your comments on organization, clarity, subject matter, and ways in which our documentation can better serve you, please FAX your comments to the Technical Publications Manager at (480) 792-4150.

Please list the following information, and use this outline to provide us with your comments about this document.

lo:	Technical Publications Manager	Total Pages Sent
RE:	Reader Response	
Fror	n: Name	
	Company	
	Telephone: ()	FAX: ()
	lication (optional):	
Wou	uld you like a reply?YN	
Dev	ice: PIC18F87J90 Family	Literature Number: DS39933C
Que	estions:	
1.	What are the best features of this docu	ument?
•		
2.	How does this document meet your ha	rdware and software development needs?
3.	Do you find the organization of this doo	cument easy to follow? If not, why?
4.	What additions to the document do you	u think would enhance the structure and subject?
5.	What deletions from the document cou	ald be made without affecting the overall usefulness?
6.	Is there any incorrect or misleading infe	ormation (what and where)?
7.	How would you improve this document	??

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO. Device	X /XX XXX Temperature Package Pattern Range	Examples: a) PIC18F87J90-I/PT 301 = Industrial temperature, TQFP package, QTP pattern #301. b) PIC18F87J90T-I/PT = Tape and reel, Industrial temperature, TQFP package.
Device ^(1,2)	PIC18F66J90, PIC18F66J90T PIC18F67J90, PIC18F67J90T PIC18F86J90, PIC18F86J90T PIC18F87J90, PIC18F87J90T	
Temperature Range	I = -40°C to +85°C (Industrial)	
Package	PT = TQFP (Thin Quad Flatpack)	
Pattern	QTP, SQTP, Code or Special Requirements (blank otherwise)	Note 1: F = Standard Voltage Range 2: T = In tape and reel

© 2009 Microchip Technology Inc. Preliminary DS39933C-page 441



WORLDWIDE SALES AND SERVICE

AMERICAS

Corporate Office

2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277

http://support.microchip.com

Web Address: www.microchip.com

Technical Support:

Atlanta

Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Boston

Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL

Tel: 630-285-0071 Fax: 630-285-0075

Cleveland

Independence, OH Tel: 216-447-0464 Fax: 216-447-0643

Dallas

Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit

Farmington Hills, MI Tel: 248-538-2250 Fax: 248-538-2260

Kokomo

Kokomo, IN Tel: 765-864-8360 Fax: 765-864-8387

Los Angeles

Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608

Santa Clara

Santa Clara, CA Tel: 408-961-6444 Fax: 408-961-6445

Toronto

Mississauga, Ontario,

Canada

Tel: 905-673-0699 Fax: 905-673-6509

ASIA/PACIFIC

Asia Pacific Office

Suites 3707-14, 37th Floor Tower 6, The Gateway Harbour City, Kowloon

Hong Kong Tel: 852-2401-1200

Fax: 852-2401-3431

Australia - Sydney Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

China - Beijing

Tel: 86-10-8528-2100 Fax: 86-10-8528-2104

China - Chengdu

Tel: 86-28-8665-5511 Fax: 86-28-8665-7889

China - Hong Kong SAR

Tel: 852-2401-1200 Fax: 852-2401-3431

China - Nanjing

Tel: 86-25-8473-2460 Fax: 86-25-8473-2470

China - Qingdao

Tel: 86-532-8502-7355 Fax: 86-532-8502-7205

China - Shanghai

Tel: 86-21-5407-5533 Fax: 86-21-5407-5066

China - Shenyang

Tel: 86-24-2334-2829 Fax: 86-24-2334-2393

China - Shenzhen

Tel: 86-755-8203-2660 Fax: 86-755-8203-1760

China - Wuhan

Tel: 86-27-5980-5300 Fax: 86-27-5980-5118

China - Xiamen

Tel: 86-592-2388138 Fax: 86-592-2388130

China - Xian

Tel: 86-29-8833-7252 Fax: 86-29-8833-7256

China - Zhuhai

Tel: 86-756-3210040 Fax: 86-756-3210049

ASIA/PACIFIC

India - Bangalore

Tel: 91-80-3090-4444 Fax: 91-80-3090-4080

India - New Delhi

Tel: 91-11-4160-8631 Fax: 91-11-4160-8632

India - Pune

Tel: 91-20-2566-1512 Fax: 91-20-2566-1513

Japan - Yokohama

Tel: 81-45-471- 6166 Fax: 81-45-471-6122

Korea - Daegu

Tel: 82-53-744-4301 Fax: 82-53-744-4302

Korea - Seoul

Tel: 82-2-554-7200 Fax: 82-2-558-5932 or 82-2-558-5934

Malaysia - Kuala Lumpur

Tel: 60-3-6201-9857 Fax: 60-3-6201-9859

Malaysia - Penang

Tel: 60-4-227-8870 Fax: 60-4-227-4068

Philippines - Manila

Tel: 63-2-634-9065 Fax: 63-2-634-9069

Singapore

Tel: 65-6334-8870 Fax: 65-6334-8850

Taiwan - Hsin Chu

Tel: 886-3-572-9526 Fax: 886-3-572-6459

Taiwan - Kaohsiung Tel: 886-7-536-4818

Fax: 886-7-536-4803

Taiwan - Taipei

Tel: 886-2-2500-6610 Fax: 886-2-2508-0102

Thailand - Bangkok

Tel: 66-2-694-1351 Fax: 66-2-694-1350

EUROPE

Austria - Wels

Tel: 43-7242-2244-39 Fax: 43-7242-2244-393 Denmark - Copenhagen

Tel: 45-4450-2828

Fax: 45-4485-2829

France - Paris

Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany - Munich

Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Italy - Milan

Tel: 39-0331-742611 Fax: 39-0331-466781

Netherlands - Drunen

Tel: 31-416-690399 Fax: 31-416-690340

Spain - Madrid

Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

UK - Wokingham Tel: 44-118-921-5869 Fax: 44-118-921-5820

02/04/09